

Errata

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HP References in this Manual

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Table 7-4. Adjustment Procedures

A3 INPUT ATTENUATOR

Equipment:

- HP 3480A/3482A DVM
- Extender Cable 05345-60205
- HP 180A Oscilloscope with 1810A Sampler
- HP 8640B Signal Generator

Setup:

1. Set LEVEL controls to PRESET.
2. Connect DVM between common and the cathode of diode A4CR1. Adjust A4R11 for an indication of 0 volts ± 50 millivolts. Connect DVM between common and cathode of diode A4CR2. Adjust A4R13 for 0 volts ± 50 millivolts.

NOTE

Allow a 5-minute warmup before performing adjustment procedure.

Bias Adjustment

1. Remove front panel display assembly, as outlined in Section III. Connect display assembly to counter, using extender cable. Place side of cable with "CINCH" on side of board with part number (05345-60004).
2. Connect DVM to U2 pin 15 (Channel B, U1 pin 15).
3. Adjust bias pot A4R44 (Channel B, A3R47) for a reading of 1.00V ± 50 mV.

The following adjustments are done with the bottom cover and bottom air filter removed. The front panel display assembly is installed in the instrument.

Sensitivity Adjustment:

1. Set 5345A controls as follows:

Input Impedance	50 Ω
ATTEN (A&B)	X1
Input Coupling	DC
Input Amplifier Control	SEP
SLOPE (A&B)	+
LEVEL Control	PRESET

2. Set 8640B Signal Generator output to 100 MHz at 100 mV rms into 50 Ω .
3. Set 180A Oscilloscope controls as follows:

AC/DC	DC
MAGNIFIER	X1
DISPLAY	INT



Table 7-4. Adjustment Procedures (Continued)

4. Set 1810A Sampler controls as follows:

DISPLAY	FILTERED
MODE	A
POLARITY	+ UP
mV/DIV	200
TIME/DIV (outer knob)	10 nSEC
TIME/DIV (inner knob)	2 nSEC
CW SLOPE	+
SCAN	SWEEP
DIRECT/EXPANDED	EXPANDED
SCAN knob	almost fully cw

5. Disconnect the two white cables connected to the A9 board. Channel A output cable is the longer of the two. Connect these cables through an adapter connector (HP part number 1250-0831) to the oscilloscope's inputs.
6. Adjust A4R2 and A4R11 (Channel B, A4R5 and A4R13) for a signal on oscilloscope.
7. Adjust A4R11 (Channel B, A4R13) for no change in signal when SLOPE switch changes position.
8. Adjust A4R2 (Channel B, A4R5) for 50% duty cycle.
9. Set 8640B output to 20 mV rms.
10. Adjust A4R11 (Channel B, A4R13) for no change in signal when SLOPE switch changes position. Readjust A4R2 (Channel B, A4R5) for 50% duty cycle if required.

A4 INPUT TRIGGER

Equipment:

HP 3480A/3482A DVM
HP 180A Oscilloscope with 1810A Sampler
HP 8640B Signal Generator

NOTE

Allow a 5-minute warmup before performing adjustment procedure.

The following adjustments are done with the bottom cover and bottom air filter removed. The front panel display assembly is installed in the instrument. See Section III for removal of air filter.

Bias Adjustment:

1. Adjust A4R2 (Channel B, A4R5) offset pot to midpoint.
2. Connect 412A to A4U2 pin 3 (Channel B, A4U1 pin 3).
3. Adjust A4R16 (Channel B, A4R19) bias pot for a reading of +800 mV \pm 50 mV.

NOTE

NOTE — If A4U2 (Channel A) or A4U1 (Channel B) are replaced, the value of A4R15 (Channel A) or A4R18 (Channel B) may have to be increased in value to meet the 800 mV \pm 50 mV specifications. An increase of approximately 10 Ω increases adjustment range of A4R16 or A4R19 approximately 100 mV.

Sensitivity Adjustment:

1. Set 5345A controls as follows:

Input Impedance	50 Ω
ATTEN (A&B)	X1
Input Coupling	DC
Input Amplifier Control	SEP
SLOPE (A&B)	+
LEVEL Control	PRESET

Table 5-6. Adjustment Procedures (Continued)

2. Set 8640B Signal Generator output to 100 MHz at 100 mV rms into 50Ω.
3. Set 180A Oscilloscope controls as follows:

AC/DC	DC
MAGNIFIER	X1
DISPLAY	INT
4. Set 1810 Sampler controls as follows:

DISPLAY	FILTERED
MODE	A
POLARITY	+ UP
mV/DIV	200
TIME/DIV (outer knob)	10 nSEC
TIME/DIV (inner knob)	2 nSEC
CW SLOPE	+
SCAN	SWEEP
DIRECT/EXPANDED	EXPANDED
SCAN knob	almost fully cw
5. Disconnect the two white cables connected to the A9 board. Channel A output cable is the longer of the two. Connect these cables through an adapter connector (HP part number 1250-0831) to the oscilloscope's inputs.
6. Adjust A4R2 (Channel B, A4R5) for a signal on oscilloscope.
7. Adjust A4R11 (Channel B, A4R13) for no change in signal when SLOPE switch changes position.
8. Set 8640B output to 10 mV rms.
9. Adjust A4R2 (Channel B, A4R5) for 50% duty cycle.
10. Adjust A4R11 (Channel B, A4R13) for no change in signal when SLOPE switch changes position. Readjust A4R2 (Channel B, A4R5) for 50% duty cycle if required.

Table 7-5. A3/A4 Parts List

Reference Designation	HP Part Number	Qty	Description	Mfr Code	Mfr Part Number
A3	05345-60039	1	INPUT ATTENUATOR (OPTION 012)	28480	05345-60039
A3	05345-60038	1	INPUT ATTENUATOR ASSY (SERIES 1644)	28480	05345-60038
A3C1	0160-0551	2	CAPACITOR-FXD .01UF +100-0% 400WVDC CER	28480	0160-0551
A3C2	0160-0551	2	CAPACITOR-FXD .01UF +100-0% 400WVDC CER	28480	0160-0551
A3C3			STRAY CAPACITANCE		
A3C4	0160-4531	2	CAPACITOR-FXD 2.2 ±.25PF 50WVDC CER CHIP	28480	0160-4531
A3C5			NOT ASSIGNED		
A3C6			STRAY CAPACITANCE		
A3C7	0160-4531		CAPACITOR-FXD 2.2 ±.25PF 50WVDC CER CHIP	28480	0160-4531
A3C8			NOT ASSIGNED		
A3C9	0160-0552	2	CAPACITOR-FXD 100PF ±5% 400WVDC CER	28480	0160-0552
A3C10	0150-0072	2	CAPACITOR-FXD 200PF ±5% 1000WVDC CER	28480	0150-0072
A3C11	0160-0552		CAPACITOR-FXD 100PF ±5% 400WVDC CER	28480	0160-0552
A3C12	0150-0072		CAPACITOR-FXD 200PF ±5% 1000WVDC CER	28480	0150-0072
A3C13	0160-3879	55	CAPACITOR-FXD .01UF ±20% 100WVDC CER	28480	0160-3879
A3C14	0160-3879		CAPACITOR-FXD .01UF ±20% 100WVDC CER	28480	0160-3879
A3C15	0160-3879		CAPACITOR-FXD .01UF ±20% 100WVDC CER	28480	0160-3879
A3C16	0160-3879		CAPACITOR-FXD .01UF ±20% 100WVDC CER	28480	0160-3879
A3C17			NOT ASSIGNED		
A3C18			NOT ASSIGNED		
A3C19	0160-3876	11	CAPACITOR-FXD 47PF ±20% 200WVDC CER	28480	0160-3876
A3C20	0160-3878	41	CAPACITOR-FXD 1000PF ±20% 100WVDC CER	28480	0160-3878
A3C21	0160-3876		CAPACITOR-FXD 47PF ±20% 200WVDC CER	28480	0160-3876
A3C22	0160-3878		CAPACITOR-FXD 1000PF ±20% 100WVDC CER	28480	0160-3878
A3C23	0160-3878		CAPACITOR-FXD 1000PF ±20% 100WVDC CER	28480	0160-3878
A3C24	0160-3878		CAPACITOR-FXD 1000PF ±20% 100WVDC CER	28480	0160-3878
A3C25	0160-3878		CAPACITOR-FXD 1000PF ±20% 100WVDC CER	28480	0160-3878
A3C26	0160-3878		CAPACITOR-FXD 1000PF ±20% 100WVDC CER	28480	0160-3878
A3C27	0160-3879		CAPACITOR-FXD 0.01UF ±20% 100WVDC CER	28480	0160-3879
A3CR1	1901-0376	4	DIODE-GEN PRP 35V 50MA	28480	1901-0376
A3CR2	1901-0376		DIODE-GEN PRP 35V 50MA	28480	1901-0376
A3CR3	1901-0376		DIODE-GEN PRP 35V 50MA	28480	1901-0376
A3CR4	1901-0376		DIODE-GEN PRP 35V 50MA	28480	1901-0376
A3CR5	1901-0040	32	DIODE-SWITCHING 2NS 30V 50MA	28480	1901-0040
A3CR6	1901-0040		DIODE-SWITCHING 2NS 30V 50MA	28480	1901-0040
A3CP7	1901-0040		DIODE-SWITCHING 2NS 30V 50MA	28480	1901-0040
A3CP8	1901-0040		DIODE-SWITCHING 2NS 30V 50MA	28480	1901-0040
A3J1A	1251-2034	8	CONNECTOR: PC EDGE; 10-COMT; DIP SOLDER	71785	252-10-30-300
A3J1B	1251-2034		CONNECTOR: PC EDGE; 10-COMT; DIP SOLDER	71785	252-10-30-300
A3J2	1250-1163	2	CONNECTOR-RF BNC FEM SGL HOLE RR	28480	1250-1163
A3J3	1250-1163		CONNECTOR-RF BNC FEM SGL HOLE RR	28480	1250-1163
A3Q1	1855-0225	2	TRANSISTOR, JFET, DUAL N-CHAN D-MODE SI	28480	1855-0225
A3Q2	1855-0225		TRANSISTOR, JFET, DUAL N-CHAN D-MODE SI	28480	1855-0225
A3Q3	1854-0215	9	TRANSISTOR NPN SI PD=310MHZ FT=300MHZ	04713	SPS 3611
A3Q4	1854-0215		TRANSISTOR NPN SI PD=310MHZ FT=300MHZ	04713	SPS 3611
A3Q5	1854-0215		TRANSISTOR NPN SI PD=310MHZ FT=300MHZ	04713	SPS 3611
A3Q6	1854-0215		TRANSISTOR NPN SI PD=310MHZ FT=300MHZ	04713	SPS 3611
A3R1	0698-8382	1	RESISTOR 25 5% .25W C TC=0±150	28480	0698-8382
A3R2			NOT ASSIGNED		
A3R3	0757-0072	2	RESISTOR 49.9 1% .5W F TC=0±100	19701	WF7C1/2-T0-49R9-F
(FOR R3)	1251-2229	2	CONNECTOR: 1-COMT SKT .333 DIA	00779	1-331677-3
A3R4	0698-8881	2	RESISTOR 900K 5% .25W C TC=0±150	28480	0698-8881
A3R5	0698-8880	2	RESISTOR 100K 5% .15W C TC=0±150	28480	0698-8880
A3R6	0757-0072		RESISTOR 49.9 1% .5W F TC=0±100	19701	WF7C1/2-T0-49R9-F
(FOR R6)	1251-2229		CONNECTOR: 1-COMT SKT .333 DIA	00779	1-331677-3
A3R7	0698-8881		RESISTOR 900K 5% .25W C TC=0±150	28480	0698-8881
A3R8	0698-8880		RESISTOR 100K 5% .15W C TC=0±150	28480	0698-8880
A3R9	2100-0597	2	RESISTOR-VAR W/SW 100K 20% CC SPST-SW	28480	2100-0597
A3R10	0683-2025	9	RESISTOR 2K 5% .25W FC TC=-400/+700	01121	CB2025
A3R11	2100-0597		RESISTOR-VAR W/SW 100K 20% CC SPST-SW	28480	2100-0597
A3R12	0683-2025		RESISTOR 2K 5% .25W FC TC=-400/+700	01121	CB2025
A3R13	0698-8381	2	RESISTOR 50 5% .15W C TC=0±150	28480	0698-8381
A3R14	0683-5115	14	RESISTOR 510 5% .25W FC TC=-400/+600	01121	CB5115
A3R15	0698-8381		RESISTOR 50 5% .15W C TC=0±150	28480	0698-8381
A3R16	0683-5115		RESISTOR 510 5% .25W FC TC=-400/+600	01121	CB5115
A3R17	0683-1055	2	RESISTOR 1M 5% .25W FC TC=-800/+900	01121	CB1055
A3R18	0683-1055		RESISTOR 1M 5% .25W FC TC=-800/+900	01121	CB1055
A3R19	0698-8615	4	RESISTOR 75K 1% 1/20W	28480	0698-8615
A3R20	0698-8615		RESISTOR 75K 1% 1/20W	28480	0698-8615
A3R21	0757-0420	6	RESISTOR 750 1% .125W F TC=0±100	24546	C4-1/R-T0-751-F
A3R22	0698-6241	2	RESISTOR 750 5% .125W CC TC=0±802	01121	BB7515
A3R23	0757-0420		RESISTOR 750 1% .125W F TC=0±100	24546	C4-1/B-T0-751-F
A3R24	0757-0420		RESISTOR 750 1% .125W F TC=0±100	24546	C4-1/B-T0-751-F
A3R25	0698-6241		RESISTOR 750 5% .125W CC TC=0±802	01121	BB7515
A3R26	0757-0420		RESISTOR 750 1% .125W F TC=0±100	24546	C4-1/B-T0-751-F
A3R27	0683-1125		RESISTOR 1.1K 5% .25W FC TC=-400/+700	01121	CB1125
A3R28	0698-8615		RESISTOR 75K 1% 1/20W	28480	0698-8615

▶ NOT IN OPTION 012.

See introduction to this section for ordering information

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Table 7-5. A3/A4 Parts List (Continued)

Reference Designation	HP Part Number	Qty	Description	Mfr Code	Mfr Part Number
A3R29	0698-8615	2	RESISTOR 75K 1% 1/20W	28480	0698-8615
A3R30	0698-6283		RESISTOR 10 5% .125W CC TC=0+588	01121	881205
A3R31	0683-1925		RESISTOR 1.5K 5% .25W FC TC=-400/+700	01121	CB1525
A3R32	0698-5178		RESISTOR 1.5K 5% .125W CC TC=0+882	01121	881525
A3R33	0698-3113		RESISTOR 100 5% .125W CC TC=0+588	01121	8F1015
A3R34	0757-0802	2	RESISTOR 162 1% .5W F TC=0+100	19701	MF7C-1/2-TD-162P-F
A3R35	0698-3113		RESISTOR 100 5% .125W CC TC=0+588	01121	881015
A3R36	0757-0802	17	RESISTOR 162 1% .5W F TC=0+100	19701	MF7C-1/2-TD-162P-F
A3R37	0698-3378		RESISTOR 51 5% .125W CC TC=0+588	01121	885105
A3R38	0683-1025		RESISTOR 1000 5% .25W CC TC=-400/+800	01121	CB1025
A3R39	0698-3378		RESISTOR 51 5% .25W CC TC=-400/+800	01121	885105
A3R40	0683-1025		RESISTOR 1000 5% .25W CC TC=-400/+800	01121	CB1025
A3R41	0698-3113	2	RESISTOR 100 5% .125W CC TC=0+588	01121	881015
A3R42	0698-3113		RESISTOR 100 5% .125W CC TC=0+588	01121	881015
A3R43	0698-6984		RESISTOR 470 5% .125W CC TC=0+882	01121	8F4715
A3R44	2100-1788		RESISTOR-VAR TMR 500 OHM 10% C TOP ADJ	84048	170-501
A3R45	0683-2415		RESISTOR 240 5% .25W FC TC=-400/+600	01121	CB2415
A3R46	0698-6984	1	RESISTOR 470 5% .125W CC TC=0+882	01121	8F4715
A3R47	2100-1788		RESISTOR-VAR TRMR 500 OHM 10% C TOP ADJ	84048	170-501
A3R48	0698-5544	RESISTOR 240 5% .125W CC TC=0+882	01121	882415	
A3R49	0698-6283	4	RESISTOR 10 5% .125W CC TC=0+588	01121	881005
A3R50	0683-1125		RESISTOR 1.1K 5% .25W FC TC=-400/+700	01121	CB1125
A3R51 TO A3R54	0683-1125		RESISTOR 1.1K 5% .25W FC TC=-400/+700	01121	CB1125
A3R55	0698-3378		RESISTOR 51 5% .125W CC TC=0+588	01121	885105
A3R56	0683-4715		RESISTOR 470 5% .25W FC TC=-400/+600	01121	CB4715
A3R57	0698-3378	6	RESISTOR 51 5% .125W CC TC=0+588	01121	885105
A3R58	0683-4715		RESISTOR 470 5% .25W FC TC=-400/+600	01121	CB4715
A3R59 TO A3R62	0683-5105		RESISTOR 51 OHM 5% KW CF	01121	CB5105
A3S1 (FOR S1)	05345-60100		LEVER/SLIDE ASSY	28480	05345-60100
A3S2 (FOR S2)	1460-0603		SPRING WFRM .014-OD MUM	28480	1460-0603
A3S3 (FOR S3)	05345-60100	LEVER/SLIDE ASSY	28480	05345-60100	
A3S4 (FOR S4)	1460-0603	SPRING WFRM .014-OD MUM	28480	1460-0603	
A3S5 (FOR S5)	05345-60100	LEVER/SLIDE ASSY	28480	05345-60100	
A3S6 (FOR S6)	1460-0603	SPRING WFRM .014-OD MUM	28480	1460-0603	
A3S7 (FOR S7)	05345-60100	LEVER/SLIDE ASSY	28480	05345-60100	
A3S8	1460-0603	SPRING WFRM .014-OD MUM	28480	1460-0603	
A3S9	3101-1596	SWITCH-SL OPDT-NS MINTR 1A 125VAC	28480	3101-1596	
A3U1	1826-0088	2	IC, LIN 114-BIT WIRE BAND AMPL	28480	1826-0088
A3U2	1826-0088		IC, LIN 114-BIT WIRE BAND AMPL	28480	1826-0088
A4	05345-40002	4	GUIDE (SWITCH TRACK)	28480	05345-40002
A4	05345-60004	1	INPUT TRIGGER ASSY (SERIES 1612)	28480	05345-60004
A4C1	0160-3879	4	CAPACITOR-FXD .01UF +-20% 100MVDC CER	28480	0160-3879
A4C2	0160-3879		CAPACITOR-FXD .01UF +-20% 100MVDC CER	28480	0160-3879
A4C3	0160-3879		CAPACITOR-FXD .01UF +-20% 100MVDC CER	28480	0160-3879
A4C4	0160-3879		CAPACITOR-FXD .01UF +-20% 100MVDC CER	28480	0160-3879
A4C5	0160-3878		CAPACITOR-FXD 1000PF +-20% 100MVDC CER	28480	0160-3878
A4C6	0160-3878		CAPACITOR-FXD 1000PF +-20% 100MVDC CER	28480	0160-3878
A4C7	0160-3878		CAPACITOR-FXD 1000PF +-20% 100MVDC CER	28480	0160-3878
A4C8	0160-3878		CAPACITOR-FXD 1000PF +-20% 100MVDC CER	28480	0160-3878
A4C9	0160-3878		CAPACITOR-FXD 1000PF +-20% 100MVDC CER	28480	0160-3878
A4C10	0160-3878		CAPACITOR-FXD 1000PF +-20% 100MVDC CER	28480	0160-3878
A4C11	0160-3876		CAPACITOR-FXD 47PF +-20% 200MVDC CER	28480	0160-3876
A4C12	0180-0428		CAPACITOR-FXD: 68UF+-20% 6VDC TA-SOLID	28480	0180-0428
A4C13	0180-0428		CAPACITOR-FXD: 68UF+-20% 6VDC TA-SOLID	28480	0180-0428
A4C14	0160-3876		CAPACITOR-FXD 47PF +-20% 200MVDC CER	28480	0160-3876
A4C15	0180-0428		CAPACITOR-FXD: 68UF+-20% 6VDC TA-SOLID	28480	0180-0428
A4C16	0180-0428	CAPACITOR-FXD: 68UF+-20% 6VDC TA-SOLID	28480	0180-0428	
A4C17	0160-3876	CAPACITOR-FXD 47PF +-20% 200MVDC CER	28480	0160-3876	
A4C18	0160-3878	CAPACITOR-FXD 1000PF +-20% 100MVDC CER	28480	0160-3878	
A4C19	0160-3879	CAPACITOR-FXD .01UF +-20% 100MVDC CER	28480	0160-3879	
A4C20	0160-3876	CAPACITOR-FXD 47PF +-20% 200MVDC CER	28480	0160-3876	
A4C21	0160-3879	3	CAPACITOR-FXD 1000PF +-20% 100MVDC CER	28480	0160-3879
A4C22	0160-3876		CAPACITOR-FXD 47PF +-20% 200MVDC CER	28480	0160-3876
A4C23	0160-3876		CAPACITOR-FXD 47PF +-20% 200MVDC CER	28480	0160-3876
A4C24	0160-3876	CAPACITOR-FXD 47PF +-20% 200MVDC CER	28480	0160-3876	
A4C25	0160-3876	CAPACITOR-FXD 47PF +-20% 200MVDC CER	28480	0160-3876	
A4CR1	1902-0074	3	DIODE-ZNR 7.15V 5% DO-7 PD=.4W TC=-.047%	04713	SZ 10939-140
A4CR2	1902-0074		DIODE-ZNR 7.15V 5% DO-7 PD=.4W TC=-.047%	04713	SZ 10939-140

NOT IN OPTION 012.

See introduction to this section for ordering information

Table 7-5. A3/A4 Parts List (Continued)

Reference Designation	HP Part Number	Qty	Description	Mfr Code	Mfr Part Number
A4CR3	1902-3036	5	DIODE ZENER 3.16V 5% DO-7 .4W	04713	SZ 10939-38
A4CR4	1902-3036		DIODE ZENER 3.16V 5% DO-7 .4W	04713	SZ 10939-38
A4L1	9100-1788		COIL: FXD: NON-MOLDED RF CHOKE: .75UH	02114	VK200-20/48
A4L2	9100-1788		C7IL: FXD: NON-MOLDED RF CHOKE: .75UH	02114	VK200-20/48
A4L3	9100-1788		COIL: FXD: NON-MOLDED RF CHOKE: .75UH	02114	VK200-20/48
A4L4	9100-1788	COIL: FXD: NON-MOLDED RF CHOKE: .75UH	02114	VK200-20/48	
A4L5	9100-1620	2	COIL-FXD MOLDED RF CHOKE 15UH 10%	24226	15/152
A4L6	9100-1620		COIL-FXD MOLDED RF CHOKE 15UH 10%	24226	15/152
A4L7	9100-0549	2	COIL-FXD MOLDED RF CHOKE 22UH 10%	06560	4422-8K
A4L8	9100-0549		COIL-FXD MOLDED RF CHOKE 22UH 10%	06560	4422-8K
A4R1	0698-5178	2	RESISTOR 1.5K 5% .125W CC TC=0+882	01121	881525
A4R2	2100-1788		RESISTOR-VAR TRMR 500 OHM 10% C TOP ADJ	84048	170-501
A4R3	0698-5178		RESISTOR 1.5K 5% .125W CC TC=0+882	01121	881525
A4R4	0698-5178		RESISTOR 1.5K 5% .125W CC TC=0+882	01121	881525
A4R5	2100-1789		RESISTOR-VAR TRMR 500 OHM 10% C TOP ADJ	84048	170-501
A4R6	0698-5178	2	RESISTOR 1.5K 5% .125W CC TC=0+882	01121	881525
A4R7	0698-3378		RESISTOR 51 5% .125W CC TC=0+588	01121	885105
A4R8	0698-3378		RESISTOR 51 5% .125W CC TC=0+588	01121	885105
A4R9	0698-3378		RESISTOR 51 5% .125W CC TC=0+588	01121	885105
A4R10	0698-3378		RESISTOR 51 5% .125W CC TC=0+588	01121	885105
A4R11	2100-3216	2	RESISTOR-VAR TRMR 10KOHM 20% C TOP ADJ	32997	3339H-1-103
A4R12	0698-8623		RESISTOR-VAR TRMR 10KOHM 20% C TOP ADJ	28480	0698-8623
A4R13	2100-3216	2	RESISTOR-VAR TRMR 10KOHM 20% C TOP ADJ	32997	3339H-1-103
A4R14	0698-8623		RESISTOR-VAR TRMR 10KOHM 20% C TOP ADJ	28480	0698-8623
A4R15	0757-0913	3	RESISTOR 360 2% .125W F TC=0+-100	24546	C4-1/8-TC-361-G
A4R16	2100-1984	2	RESISTOR-VAR TRMR 100 OHM 10% C TOP ADJ	84048	170-101
A4R17	0698-5183		RESISTOR 4.3K 5% .125W CC TC=0+882	01121	884325
A4R18	0757-0913	2	RESISTOR 360 2% .125W F TC=0+-100	24546	C4-1/8-TC-361-G
A4R19	2100-1984		RESISTOR-VAR TRMR 100 OHM 10% C TOP ADJ	84048	170-101
A4R20	0698-5183	2	RESISTOR 4.3K 5% .125W CC TC=0+882	01121	884325
A4R21	0686-6815	2	RESISTOR 680 5% .5W CC TC=0+529	01121	E86815
A4R22	0757-0407		RESISTOR 200 1% .125W F TC=0+-100	24546	C4-1/8-TC-201-F
A4R23	0686-6815	7	RESISTOR 680 5% .5W CC TC=0+529	01121	E86815
A4R24	0757-0407		RESISTOR 200 1% .125W F TC=0+-100	24546	C4-1/8-TC-201-F
A4R25	0683-1125	2	RESISTOR 1.1K 5% .25W FC TC=-400/+700	01121	C81125
A4R26	0683-1125	9	RESISTOR 1.1K 5% .25W FC TC=-400/+700	01121	C81125
A4R27*	0683-5105		RESISTOR 51 5% .25W FC TC=-400/+500	01121	C85105
A4R28	0683-1125	2	*FACTORY SELECTED PART		
A4R29*	0683-5105		RESISTOR 1.1K 5% .25W FC TC=-400/+700	01121	C81125
A4R30	0693-1125	2	RESISTOR 51 5% .25W FC TC=-400/+500	01121	C85105
A4R31	0698-3378		RESISTOR 1.1K 5% .25W FC TC=-400/+700	01121	C81125
A4R32	0683-4715	4	RESISTOR 51 5% .125W CC TC=0+588	01121	885105
A4R33	0698-3378		RESISTOR 470 5% .25W FC TC=-400/+600	01121	C84715
A4R34	0683-4715	2	RESISTOR 51 5% .125W CC TC=0+588	01121	885105
A4R35	0683-2425		RESISTOR 470 5% .25W FC TC=-400/+600	01121	C84715
A4R36	0693-2425	4	RESISTOR 2.4K 5% .25W FC TC=-400/+700	01121	C82425
A4R37	0698-3111		RESISTOR 2.4K 5% .25W FC TC=-400/+700	01121	C82425
A4R38	0698-3111	2	RESISTOR 30 5% .125W CC TC=0+-850	01121	883005
A4R39	0698-3111		RESISTOR 30 5% .125W CC TC=0+-850	01121	883005
A4R40	0698-3378	2	RESISTOR 51 5% .125W CC TC=0+588	01121	885105
A4R41	0698-3378		RESISTOR 51 5% .125W CC TC=0+588	01121	885105
A4R42	0683-1615	2	RESISTOR 160 5% .25W FC TC=-400/+600	01121	C81615
A4R43	0698-3378		RESISTOR 51 5% .125W CC TC=0+588	01121	885105
A4R44	0683-1615	2	RESISTOR 160 5% .25W FC TC=-400/+600	01121	C81615
A4U1	1826-0290	2	IC:AMPLIFIER	28480	1826-0290
A4U2	1826-0290		IC:AMPLIFIER	28480	1826-0290
A4U3	1826-0021	2	IC:LM310H	27014	LM310H
A4U4	1826-0021		IC:LM310H	27014	LM310H

See introduction to this section for ordering information

VI

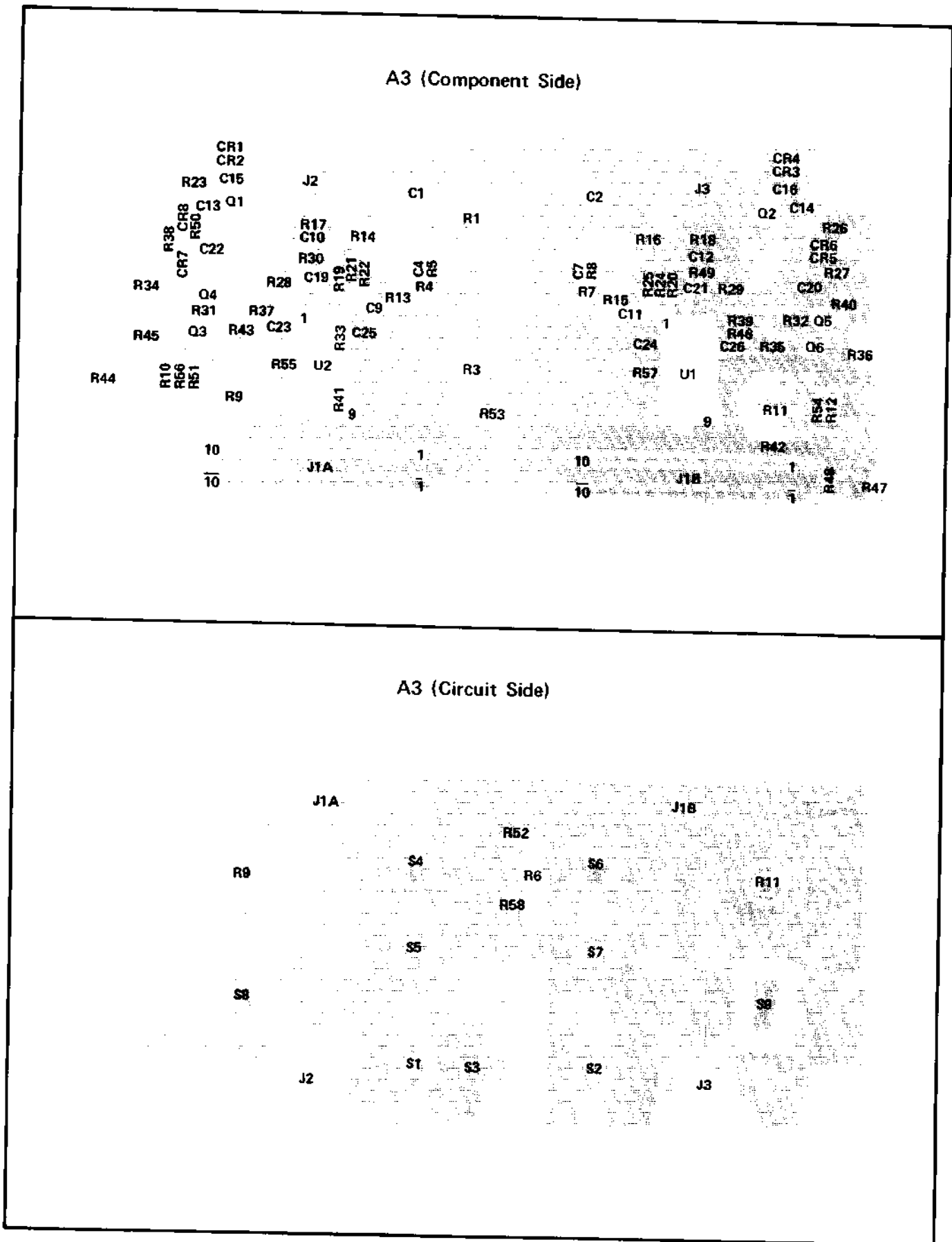


Figure 7-3. A3 Input Attenuator Assembly

VII

NOTES

1. ORIGINAL EQUIPMENT OPERATING INSTRUCTIONS SHOULD BE REFERRED TO FOR COMPLETE INFORMATION ON THE OPERATION OF THIS EQUIPMENT.
2. THIS EQUIPMENT IS NOT TO BE OPERATED WITHOUT THE PROPER TRAINING AND SUPERVISION.
3. THIS EQUIPMENT IS NOT TO BE OPERATED WITHOUT THE PROPER TRAINING AND SUPERVISION.

REVISIONS

NO.	DATE	DESCRIPTION
1	10/1/53	ISSUED
2	10/1/53	ISSUED
3	10/1/53	ISSUED

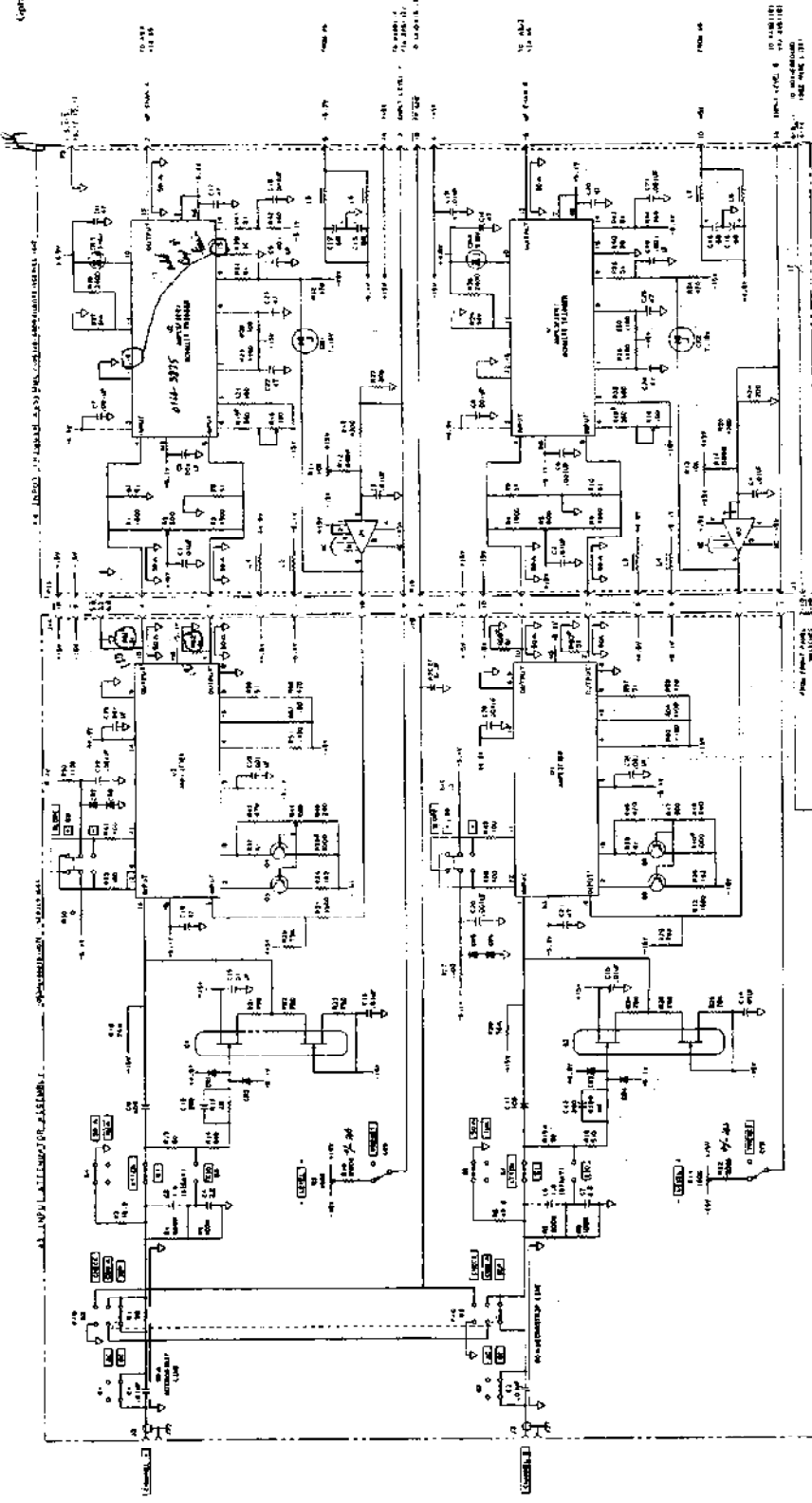
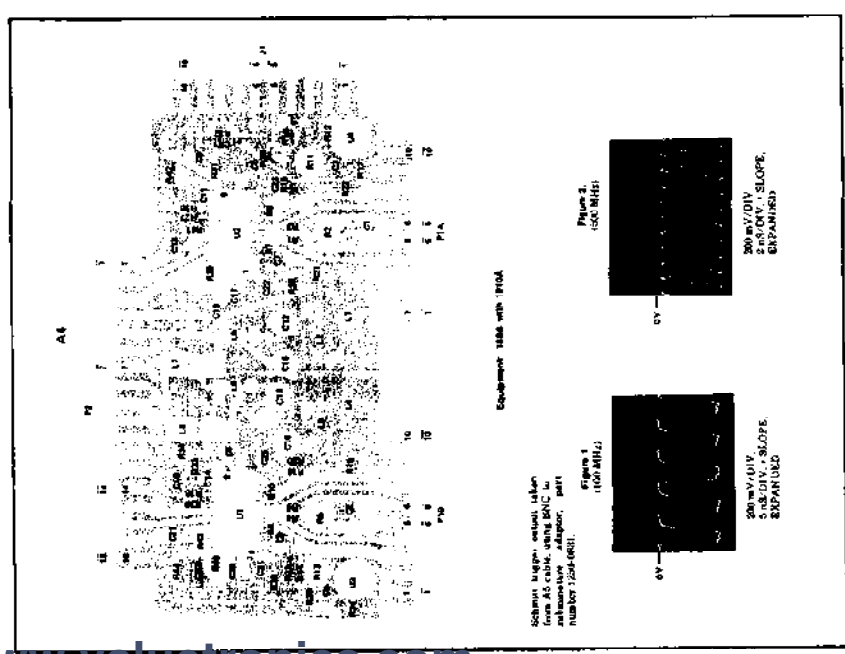
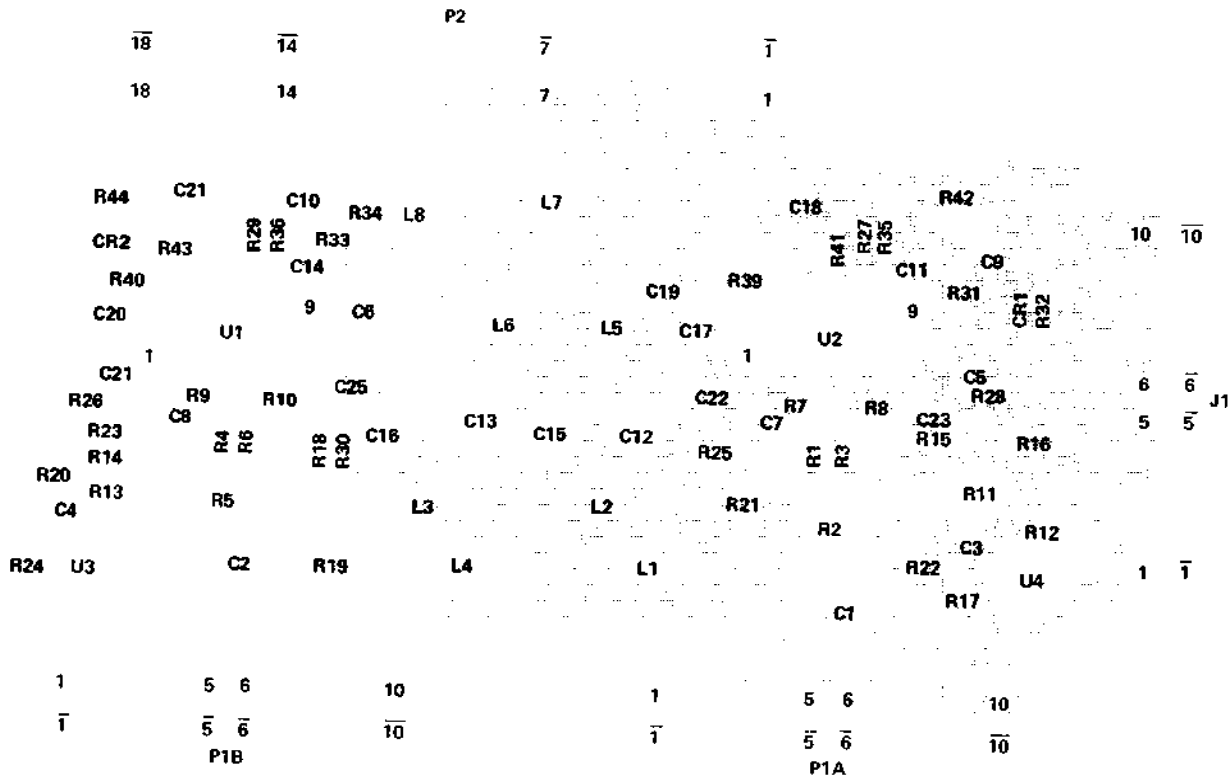


Figure 7-4 A4 Input Trigger Assembly



A4



Equipment: 180A with 1810A

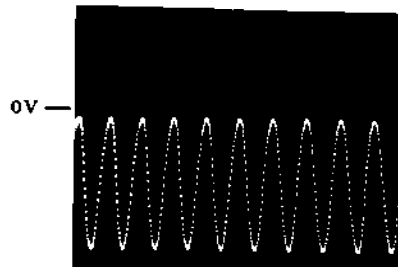
Schmitt trigger output taken from A5 cable, using BNC-to-subminiature adaptor, part number 1250-0831.

Figure 1.
(100 MHz)



200 mV/DIV,
5 nS/DIV, + SLOPE,
EXPANDED

Figure 2.
(500 MHz)



200 mV/DIV,
2 nS/DIV, + SLOPE,
EXPANDED



**Operating and
Service Manual**

**HP 5345A
Electronic Counter**

HP 5345A ELECTRONIC COUNTER

OPERATING AND SERVICE MANUAL

HP 5345A SERIAL PREFIX: 3103

This manual applies directly to HP 5345A Electronic Counters having serial number prefix 3103.

NEWER INSTRUMENTS

This manual, with enclosed "Manual Changes" sheet, applies to HP 5345A Electronic Counters having serial number prefixes as listed on the "Manual Changes" sheets.

OLDER INSTRUMENTS

For serial prefixes below 3103, refer to Section VII for manual backdating.

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5301 STEVENS CREEK BLVD, SANTA CLARA, CA 95052-8059

MANUAL PART NUMBER : 05345-90060

Printed: MAY 1994



CERTIFICATION

Hewlett-Packard Company certifies that this product met its published specifications at the time of shipment from the factory. Hewlett-Packard further certifies that its calibration measurements are traceable to the United States National Bureau of Standards, to the extent allowed by the Bureau's calibration facility, and to the calibration facilities of other International Standards Organization members.

WARRANTY

This Hewlett-Packard instrument product is warranted against defects in material and workmanship for a period of one year from date of shipment. During the warranty period, Hewlett-Packard Company will, at its option, either repair or replace products which prove to be defective.

For warranty service or repair, this product must be returned to a service facility designated by HP. Buyer shall prepay shipping charges to HP and HP shall pay shipping charges to return the product to Buyer. However, Buyer shall pay all shipping charges, duties, and taxes for products returned to HP from another country.

HP warrants that its software and firmware designated by HP for use with an instrument will execute its programming instructions when properly installed on that instrument. HP does not warrant that the operation of the instrument, or software, or firmware will be uninterrupted or error free.

LIMITATION OF WARRANTY

The foregoing warranty shall not apply to defects resulting from improper or inadequate maintenance by Buyer, Buyer-supplied software or interfacing, unauthorized modification or misuse, operation outside of the environmental specifications for the product, or improper site preparation or maintenance.

NO OTHER WARRANTY IS EXPRESSED OR IMPLIED. HP SPECIFICALLY DISCLAIMS THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE.

EXCLUSIVE REMEDIES

THE REMEDIES PROVIDED HEREIN ARE BUYER'S SOLE AND EXCLUSIVE REMEDIES. HP SHALL NOT BE LIABLE FOR ANY DIRECT, INDIRECT, SPECIAL, INCIDENTAL, OR CONSEQUENTIAL DAMAGES, WHETHER BASED ON CONTRACT, TORT, OR ANY OTHER LEGAL THEORY.

ASSISTANCE

Product maintenance agreements and other customer assistance agreements are available for Hewlett-Packard products.

For any assistance, contact your nearest Hewlett-Packard Sales and Service Office. Addresses are provided at the back of this manual.

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SAFETY CONSIDERATIONS

GENERAL

This is a Safety Class I instrument. This instrument has been designed and tested according to IEC Publication 348, "Safety Requirements for electronic Measuring Apparatus", and has been supplied in safe condition.

OPERATION

BEFORE APPLYING POWER verify that the power transformer primary is matched to the available line voltage and the correct fuse is installed (see Section II, Paragraph 2-6.) Make sure that only fuses with the required rated current and of the specified type (normal blow, time delay, etc.) are used for replacement. The use of repaired fuses and the short-circuiting of fuseholders must be avoided.

SERVICE

Although this instrument has been designed in accordance with international safety standards, this manual contains information, cautions, and warnings which must be followed to ensure safe operation and to retain the instrument in safe condition. Service and adjustments should be performed only by qualified service personnel.

Any adjustment, maintenance, and repair of the opened instrument under voltage should be avoided as much as possible, and when inevitable, should be carried out only by a skilled person who is aware of the hazard involved.

Capacitors inside the instrument may be charged even if the instrument has been disconnected from its source of supply.

Whenever it is likely that the protection has been impaired, the instrument must be made inoperative and be secured against any unintended operation.

ACCOUSTIC NOISE EMISSION:

LpA 56 dB at operator position, at normal operation, tested per EN27779. All data are the results from type test

GERAeUSCHEMISSION:

LpA 56 dB am Arbeitsplatz, normaler Betrieb, Geprueft nach EN27779 Teil 19. Die Angaben beruhen auf Ergebnissen von Typpruefungen.

WARNING

IF THIS INSTRUMENT IS TO BE ENERGIZED VIA AN AUTO-TRANSFORMER (FOR VOLTAGE REDUCTION) MAKE SURE THE COMMON TERMINAL IS CONNECTED TO THE EARTHED POLE OF THE POWER SOURCE.

WARNING

BEFORE SWITCHING ON THE INSTRUMENT, THE PROTECTIVE EARTH TERMINALS OF THE INSTRUMENT MUST BE CONNECTED TO THE PROTECTIVE CONDUCTOR OF THE (MAINS) POWER CORD. THE MAINS PLUG SHALL ONLY BE INSERTED IN A SOCKET OUTLET PROVIDED WITH A PROTECTIVE EARTH CONTACT. THE PROTECTIVE ACTION MUST NOT BE NEGATED BY THE USE OF AN EXTENSION CORD (POWER CABLE) WITHOUT A PROTECTIVE CONDUCTOR (GROUNDING).

WARNING

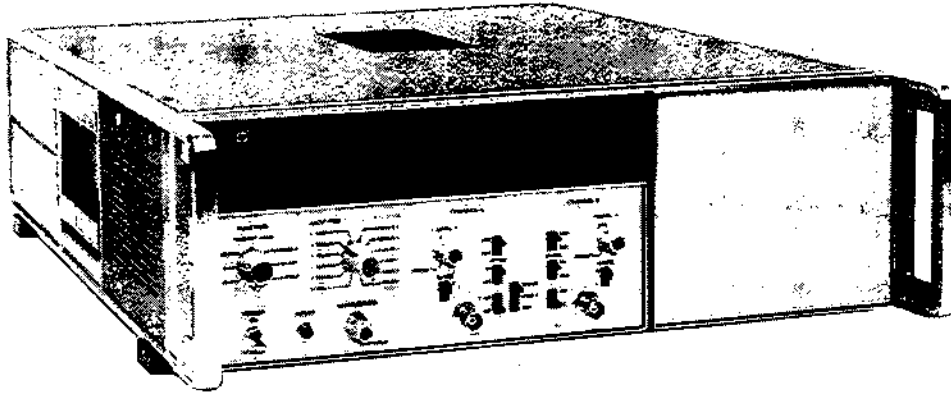
THE SERVICE INFORMATION FOUND IN THIS MANUAL IS OFTEN USED WITH POWER SUPPLIED AND PROTECTIVE COVERS REMOVED FROM THE INSTRUMENT. ENERGY AVAILABLE AT MANY POINTS MAY, IF CONTACTED, RESULT IN PERSONAL INJURY.

CAUTION

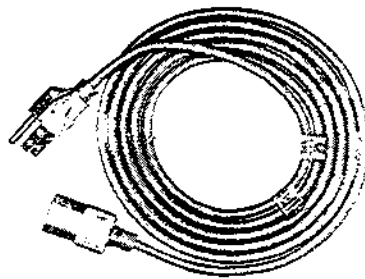
BEFORE SWITCHING ON THIS INSTRUMENT:

1. MAKE SURE THE INSTRUMENT IS SET TO THE VOLTAGE OF THE POWER SOURCE.
2. ENSURE THAT ALL DEVICES CONNECTED TO THIS INSTRUMENT ARE CONNECTED TO THE PROTECTIVE (EARTH) GROUND.
3. ENSURE THAT THE LINE POWER (MAINS) PLUG IS CONNECTED TO A THREE-CONDUCTOR LINE POWER OUTLET THAT HAS A PROTECTIVE (EARTH) GROUND. (GROUNDING ONE CONDUCTOR OF A TWO-CONDUCTOR OUTLET IS NOT SUFFICIENT.)
4. MAKE SURE THAT ONLY FUSES WITH THE REQUIRED RATED CURRENT AND OF THE SPECIFIED TYPE (NORMAL BLOW, TIME DELAY, ETC.) ARE USED FOR REPLACEMENT. THE USE OF REPAIRED FUSES AND THE SHORT-CIRCUITING OF FUSE HOLDERS MUST BE AVOIDED.

HP 5345A
General Information



MODEL 5345A



POWER CABLE HP NO. 8120-1378
U.S.A., Canada

Figure 1-1. Model 5345A Electronic Counter with Accessories Supplied

SECTION I GENERAL INFORMATION

1-1. DESCRIPTION

1-2. The Hewlett-Packard Model 5345A Electronic Counter is a reciprocal counter capable of direct measurements to 500 MHz. The counter's ability to accept plug-in accessories extends its inherent capabilities and provides for a variety of additional measurements.

1-3. The instrument measures frequency, period, period average, single-shot time interval, time interval average, and ratio. It also provides a totalize function, whereby two signals can be simultaneously totalized with the displayed result being the sum of difference in the total number of counts.

1-4. INSTRUMENT IDENTIFICATION AND MANUAL CHANGES

1-5. Hewlett-Packard instruments have a 2-section, 10-character serial number (0000A00000), which is located on the rear panel. The 4-digit serial prefix identifies instrument changes. If the serial prefix of your instrument differs from that listed on the title page of this manual, there are differences between this manual and your instrument. Instruments having lower serial prefixes than that listed on the title page are documented in Section VII, and higher serial prefixes are covered with manual change sheets included with the manual. If the manual change sheet is missing, contact the nearest Hewlett-Packard Sales office listed at the back of this manual.

1-6. OPTIONS

1-7. The following is a list of options: Option 011, General Purpose I/O (provides digital output and input control over all functions, except input amplifier); Option 012, similar to Option 011, but includes slope and level control. Option 908, Rack Mounting Kit, is available at an additional cost when ordered at the same time as the instrument.

1-8. ACCESSORIES

1-9. Table 1-1 lists equipment supplied and Table 1-2 list accessories available.

Table 1-1. Equipment Supplied

DESCRIPTION	HP PART NO.
Detachable Power Cord, 231 cm (7½ ft. long)	8120-1378

Table 1-2. Accessories Available

DESCRIPTION	HP PART NO.
Rack Mounting Kit	5060-8740
Board Extender Kit	10595A
Plug-In Adapter	10590A
10 MΩ Probe Kit	10004D
50Ω Probe Kit	10020A

LATEST

Table 1-3. HP 5345A Specifications

Input Characteristics Channel A and Channel B

SEPARATE INPUTS

Range:

DC coupled: 0 to 500 MHz
AC coupled: 1 M Ω , 200 Hz to 500 MHz
50 Ω , 4 MHz to 500 MHz

Impedance: Switch selectable, 1 M Ω (nominal) shunted by approximately 45 pF or 50 Ω (nominal).

Sensitivity: (preset) 50 Ω and 1 M Ω

50 Ω DC coupled 0 to 300 MHz, 25 mV rms
300 MHz to 500 MHz, 50 mV rms
50 Ω AC coupled ~~200 Hz to 300 MHz~~, 25 mVrms
4 MHz 300 MHz to 500 MHz, 50 mV rms
X1: 25 mV rms sine wave, 75 mV p-p pulse
X10: 300 mV rms sine wave, 900 mV p-p pulse

Dynamic Range: (preset) 50 Ω and 1 M Ω

X1: 25 mV to 300 mV rms sine wave
75 mV to 900 mV p-p pulse
X10: 300 mV to 2.0V rms sine wave
900 mV to 6.0V p-p pulse

Linear Operating Range: -2.0 to +2.0V dc (nominal).

Trigger Level: Adjustable over $\pm 2.0V$ dc

Preset: Centers trigger level to 0V dc (nominal) at 25°C
Drift: ± 10 mV dc max., 0°C to 50°C
Output: Channel A & B trigger voltages (X ATTEN)
available at rear panel BNC connectors.
Accuracy: X1: ± 15 mV
X10: ± 150 mV (nominal)

Slope: Independent selection of positive or negative slope.

Maximum Input: Damage may occur beyond specified level. For larger inputs, voltage divider probes 10020A for 50 Ω and 10004D for 10M Ω are recommended.

50 Ω X1: $\pm 7V$ dc
7V rms below 5 MHz
3.5V rms (+24 dBm) 5 MHz and above
X10: 7V dc, 7V rms (+30 dBm)
1M Ω X1: $\pm 350V$ dc
250V rms to 20 kHz, decreasing to 3.5V rms
above 5 MHz
X10: $\pm 350V$ dc
250V rms to 20 kHz, decreasing to 35V rms
above 5 MHz

Cross Talk: No effects if inputs to Channel A and B are both above or below 100 MHz. With one signal above 100 MHz and the other below, there are no effects if the lower frequency has a slew rate of $\geq 10V/\mu s$.

COMMON INPUT

In this mode the signal is applied to Channel A through a power splitter which equalizes impedances and delays to the input amplifiers. Channel B input is disabled. Both input impedance switches should be in the same position. All specifications are the same as for separate operation with the following differences.

Range:

DC coupled: 0. to 400 MHz
AC coupled: 1 M Ω , 300 Hz to 400 MHz
AC coupled: 50 Ω , 4 MHz to 400 MHz

Impedance: 1 M Ω becomes 500 k Ω shunted by approximately 80 pF. 50 Ω no change.

Sensitivity: (preset)

50 Ω X1: 50 mV rms sine wave, 150mV p-p pulse
X10: 600 mV rms sine wave, 1.8V p-p pulse
1M Ω DC coupled: 0 to 50 MHz, 25 mVrms
50 MHz to 200 MHz, 75 mVrms
200 MHz to 400 MHz, 120 mV rms
AC coupled: 300 Hz to 50 MHz, 25 mV rms
50 MHz to 200 MHz, 75 mV rms
200 MHz to 400 MHz, 120 mV rms

Dynamic Range:

50 Ω X1: 50 mV to 600 mV rms sine wave
50 Ω X1: 150 mV to 1.8V p-p pulse
X10: 600 mV to 4.0V rms sine wave
X10: 1.8V to 12V p-p pulse
1 M Ω Same as in SEPARATE

Maximum Input:

50 Ω : $\pm 5.0V$ dc or 5V rms
1 M Ω Same as in SEPARATE

Trigger Level: Adjustable over the range $\pm 4.0V$ dc (X ATTEN) in 50 Ω or $\pm 2.0V$ dc in M Ω (XATTEN).

Trigger Level Output: Channel A and B trigger voltages times 2 (X ATTEN) available at rear panel BNC connectors.

Accuracy:

50 Ω X1: ± 30 mV (nominal)
X10: ± 300 mV (nominal)
1 M Ω : Same as in SEPARATE

**Frequency/Frequency Average,
Period/Period Average**

Both frequency and period are measured by measuring the total elapsed time, T, for the integral number of cycles, N of the input waveform. Computation, involving the quantities of N and T, provides direct readout of either frequency or period.

Range: 50 μ Hz to 500 mHz; 2 ns to 20,000 s.

Measurement Time: Consists of GATE TIME plus the time required to reach the next STOP trigger level. When in MIN the GATE TIME is 50 ns or one period of the input signal, whichever is greater. when the GATE TIME is set to one of the decade steps, the counter will reset if a stop trigger is not reached within 3.5 times the GATE TIME setting. Decade GATE TIME settings range from 100 ns to 1000 s.

Table 1-3. HP 5345A Specifications (Continued)

When using EXT GATE, the measurement cycle time consists of the GATE TIME divided by the duty cycle of the EXT GATE signal plus the time required to reach the next STOP trigger level after the end of the EXT GATE pulse.

Accuracy: Resolution is nine digits per second of measurement time. With the DISPLAY POSITION switch is AUTO the least significant digit error is ± 1 count if the most significant digit is 1 through 4, and ± 2 counts if the most significant digit is 5 through 9.

Accuracy is \pm least significant digit (LSD) counts

\pm Time Base error \times (Frequency or Period)

$\pm \frac{\text{Trigger Error}^*}{\text{Gate Time}} \times (\text{Frequency or Period}).$

Time Interval/Time Interval Average

Range: 10 ns to 20,000 s

Minimum Dead Time: 10 ns (nominal)

Dead time is the time between the preceding time interval's STOP event and the current time interval's START event.

Minimum Trigger Pulse Width: 1 ns (typical) width input at minimum voltage input.

Accuracy:

Time Interval:

\pm Trigger error* ± 2 ns \pm Time Base Error \times Time Interval.

Time Interval Averaging:

$\pm \frac{\text{Trigger Error}^* \pm 2\text{ns}}{\sqrt{\text{intervals averaged}}} \pm 0.7\text{ns} \pm \text{Time Base Error} \times \text{T.I. Average}.$

Not affected by harmonics of clock frequency.

Resolution:

Time Interval: 2 ns

Time Interval Averaging:

$\pm \frac{2\text{ns}}{\sqrt{\text{intervals averaged}}} \pm 2 \text{ ps}$

Measurement Time: For single time interval measurement time the GATE TIME switch should be in MIN. Measurement time will be the displayed time interval.

When a decade GATE TIME is selected, the counter will be in the TIME INTERVAL AVERAGE mode. The GATE TIME selected should be greater than the displayed time interval. The measurement time is now the GATE TIME divided by the duty cycle of the time interval waveform plus the time required to reach the next trigger stop level after the total GATE TIME has been accumulated.

$$\text{*trigger error} = \frac{1.4 \sqrt{(150 \mu\text{V})^2 + e_n^2}}{\text{Input Voltage slew rate at trigger point (V / s)}} \text{ seconds rms}$$

where 150 μV is the typical rms input amplifier noise on the 5345A and e_n is the rms noise of the input signal for a 500 MHz bandwidth.

Ratio B/A

Range: Both channels accept dc to 500 MHz

Accuracy:

$\pm \text{LSD} \pm \frac{\text{Trigger Error}^* (\text{of Channel A})}{\text{Measurement Time}} \times \text{Ratio}$

LSD is described under FREQUENCY ACCURACY

Measurement Time:

$= \text{GATE TIME} \times \frac{500 \text{ MHz}}{\text{Channel B input frequency}}$

Start/Stop

Range: Both inputs may have repetition rates from dc to 500 MHz.

Modes: A, A+B, and A-B is determined by a rear panel switch.

Resolution: Not affected by GATE TIME setting. Resolution is one count up to 11 digits.

Accuracy: Coincident pulses may be applied to both inputs. One count is required to initiate each input, i.e., in Mode A add one count to display, in Mode A+B add two counts to display, in Mode A-B add two counts to display, in Mode A-B add no counts to display.

Scaling

Range: DC to 500 MHz

Scaling Factor: Selectable by GATE TIME setting. As GATE TIME is varied from the 100 ns position to the 1000 s position, scaling factor increases from 10^2 to 10^{12} .

$$\frac{\text{GATE TIME}}{10^{-9} \text{ SECONDS}}$$

Input: Input signal through Channel A

Output: Output frequency equals input frequency divided by scaling factor. Rear panel BNC supplies 80% duty cycle (typical) TTL compatible pulses.

GENERAL

Display: Eleven-digit LED display and sign. Annunciator displays ks to ns, k to n, μHz to GHz. Decimal point is positioned with DISPLAY POSITION control or positioned after the first, second, or third most significant digit if DISPLAY POSITION is in AUTO. Leading zeros are suppressed.

Overflow: Asterisk is illuminated when display is overflowed or underflowed.

Sample Rate: Continuously variable from $<0.1\text{s}$ to $>5\text{s}$ with front panel control. In HOLD position the last reading is maintained until the counter is manually reset or an EXTERNAL ARM signal is applied. Number of readings per second will generally be limited by the output device, i.e., Printer or Computer.

Measurement Speed:

Normal operation (Max. Sample Rate): Up to 10 readings per second.

Table 1-3. HP 5345A Specifications (Continued)

Externally Armed or Gated: Up to 500 readings per second.
Computer Dump: Up to 9000 readings per second.

External Arm Input: Arming will be initiated by -1.0V (-5.0V max.) into 50Ω rear BNC input for greater than 500 ns. Minimum time between EXT ARM and acceptance of start pulse is <1 μs (typical).

External Gate Input: EXT GATE feature will respond to a 0.0V pulse into 50Ω with 50 ns or faster rise and fall time pulse edges. Maximum pulse height (damage level) is -5V. Minimum pulse width is 20 ns. Time delay of the leading edge of EXT GATE to the acceptance of input signal is less than 20 ns.

Gate Output: ≥+1 volt into 50 Ω.

Reset: Counter resets at initial turn-on. Can be reset at any time with front panel pushbutton or through HP-IB control.

Operating Temperature: 0°C to 50°C.

Power Requirements: 100/120/220/240V rms +5% to -10%, 48 Hz to 66 Hz, maximum power 250 VA.

Weight: 17 kg (37 lbs.) net.

Size: 132.6 mm H x 425 mm W x 495 mm D
5-7/32" x 16-3/4" x 19-1/2".

Time Base:

High Stability Time Base (Standard): 10 MHz (crystal frequency) oven oscillator.

Stability:

Long Term (Aging Rate):

- A. $<5 \times 10^{-10}$ per day after 24-hour warm-up when:
1. oscillator off-time was less than 24 hours
 2. oscillator aging rate was $<5 \times 10^{-10}$ per day prior to turn off.
- B. $<5 \times 10^{-10}$ per day in less than 30 days of continuous operation for off-time greater than 24 hours.
- C. $<1 \times 10^{-7}$ per year for continuous operation.

Warmup:

Within 5×10^{-9} of final value (see below) 10 minutes after turn-on when:

1. oscillator is operated in a 25°C environment with 20 Vdc Oven supply voltage applied.
2. oscillator off-time was less than 24 hours.
3. oscillator aging rate was $<5 \times 10^{-10}$ per day prior to turn-off.

Final value is defined as oscillator frequency 24 hours after turn-on.

Short Term: $<1 \times 10^{-11}$ for a 1 s average

Temperature: $<7 \times 10^{-9}$, 0°C to 50°C.

Line Voltage: $<1 \times 10^{-10}$, ±10% from nominal (15 min. after change).

External Frequency Standard Input: 1, 2, 2.5, 5, or 10 MHz $\pm 5 \times 10^{-8}$, with input voltage >1V rms into 1 KΩ.

Frequency Standard Output: 10 MHz, >1V rms, high purity ($<2 \times 10^{-11}$ for a 1 s average) sine wave from 50Ω source.

External Frequency Standard Input: 1, 2, 2.5, 5, or 10 MHz $\pm 5 \times 10^{-5}$, with input voltage >1V rms into 1KΩ.

Options

Option 011: Digital Input/Output. Full compatibility with HP interface Bus. Provides digital output as well as input for control over all functions except input amplifier.

Option 012: Similar to Option 011, but includes slope and level control. Recommended for computer or dedicated calculator applications. Programming codes differ slightly from Option 011.

Option 908: Rack Mounting Kit (P/N 5060-8740).

Option W30: (Extended Hardware Support) provides two additional years of return-to-HP hardware-service support. Option W30 is available only at time of purchase. Service contracts are available from Hewlett-Packard for instruments which did not include Option W30 at time of purchase. For more information, contact your nearest Hewlett-Packard Sales office (offices are listed at the back of this manual).

SECTION II INSTALLATION

2-1. INTRODUCTION

2-2. This section contains information for unpacking, inspection, and storage of the HP 5345A Electronic Counter.

2-3. UNPACKING AND INSPECTION

2-4. If the shipping carton is damaged, inspect the instrument for visible damage (scratches, dents, etc.). If the instrument is damaged, notify the carrier and the nearest Hewlett-Packard Sales and Service Office immediately (offices are listed at the back of this manual). Keep the shipping and packing material for the carrier's inspection. The Hewlett-Packard Sales and Service Office will arrange for repair or replacement of your instrument without waiting for the claim to be settled.

2-5. POWER REQUIREMENTS

2-6. The HP 5345A requires a power source of 100, 120, 220, or 240 volts ac at 48 to 66 Hz single phase.

2-7. LINE VOLTAGE SELECTION

2-8. The instrument is equipped with an ac power module that contains a printed-circuit line voltage selector to select 100-, 120-, 220-, or 240-volt ac operation. Before applying power, the voltage selector must be set to the correct position and the correct fuse must be installed as described in paragraphs 2-8 and 2-9.

2-9. Power line connections are selected by the position of the plug-in circuit card in the module. When the card is plugged into the module, the only visible marking on the card indicates the line voltage to be used. The correct value of line fuse must be installed after the card is inserted. This instrument uses a 2.5A time delay fuse for 100/120V operation, and a 1.25A time delay fuse for 220/240V operation.

2-10. To convert from one line voltage to another, the power cord must first be disconnected from the power module. The sliding window covering the fuse compartment can then be moved to expose the fuse and circuit card. See Figure 2-1.



BEFORE CONNECTING THE UNIT TO AC POWER LINES, BE SURE THAT THE CORRECT FUSE IS INSTALLED AND THAT THE VOLTAGE SELECTOR IS PROPERLY POSITIONED AS DESCRIBED BELOW

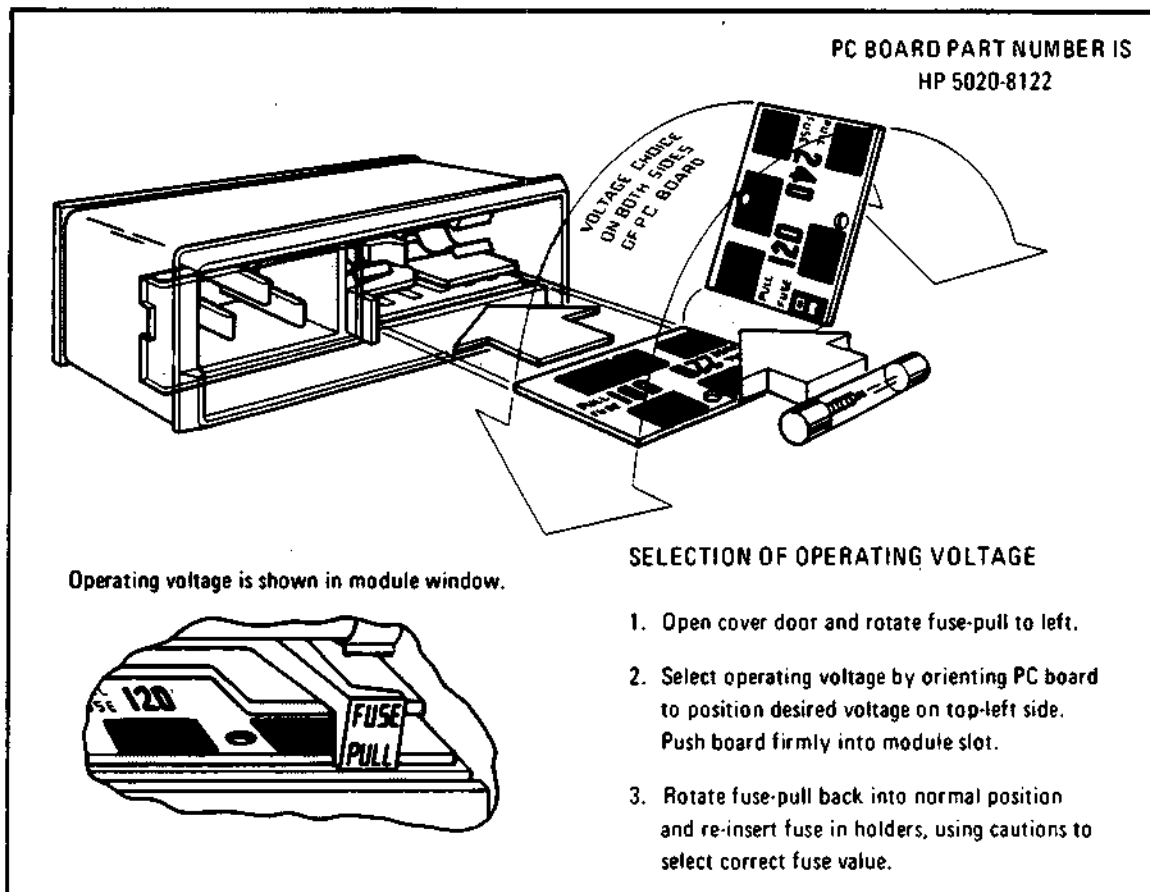


Figure 2-1. Line Voltage Selection

2-11. Pull on the fuse lever to remove the fuse and then pull the card out of the module. The fuse lever must be held to one side to extract and insert the card. Insert the card so the marking that agrees with the line voltage to be used is visible.

2-12. Return the fuse lever to normal position, insert the correct fuse, slide the plastic window over the compartment, and connect the power cord to complete the conversion.

2-13. POWER CABLE

2-14. To protect the operator, the counter uses a grounded three-conductor power cable. The male connector end is a NEMA type connector, and the female connector end is a C.E.E. type connector that mates with the 5345A rear panel connector. Connect the power cable to a power source receptacle with a NEMA grounded third conductor. If the line power receptacle is a standard two-pin type instead of the NEMA three-pin receptacle, use a two-to-three pin adapter (HP PART No. 1251-0048) and connect the green pigtail on the adapter to ground.

WARNING

BEFORE SWITCHING ON THIS INSTRUMENT, THE PROTECTIVE EARTH TERMINAL OF THIS INSTRUMENT MUST BE CONNECTED TO THE PROTECTIVE CONDUCTOR OF THE (MAINS) POWER CORD. THE PROTECTIVE ACTION MUST NOT BE NEGATED BY THE USE OF A POWER CORD EXTENSION CABLE WITHOUT A PROTECTIVE GROUNDING (EARTHING) CONDUCTOR.

2-15. HP-IB INTERFACE CONNECTIONS

2-16. HEWLETT-PACKARD INTERFACE BUS. The counter with HP-IB is compatible with the Hewlett-Packard Interface Bus. Interconnection data concerning the rear panel connector is provided in Figure 2-2. This connector is compatible with the HP 10833A/B/C/D cables. (See Table 2-1 for cable descriptions). The HP-IB system allows interconnection of up to 15 (including the controller) HP-IB compatible instruments.

Table 2-1. HP-IB Cable Descriptions

MODEL NUMBER	CABLE LENGTH
10833A	1 metre (3.3 ft.)
10833B	2 metres (6.6 ft.)
10833C	4 metres (13.2 ft.)
10833D	0.5 metres (1.6 ft.)

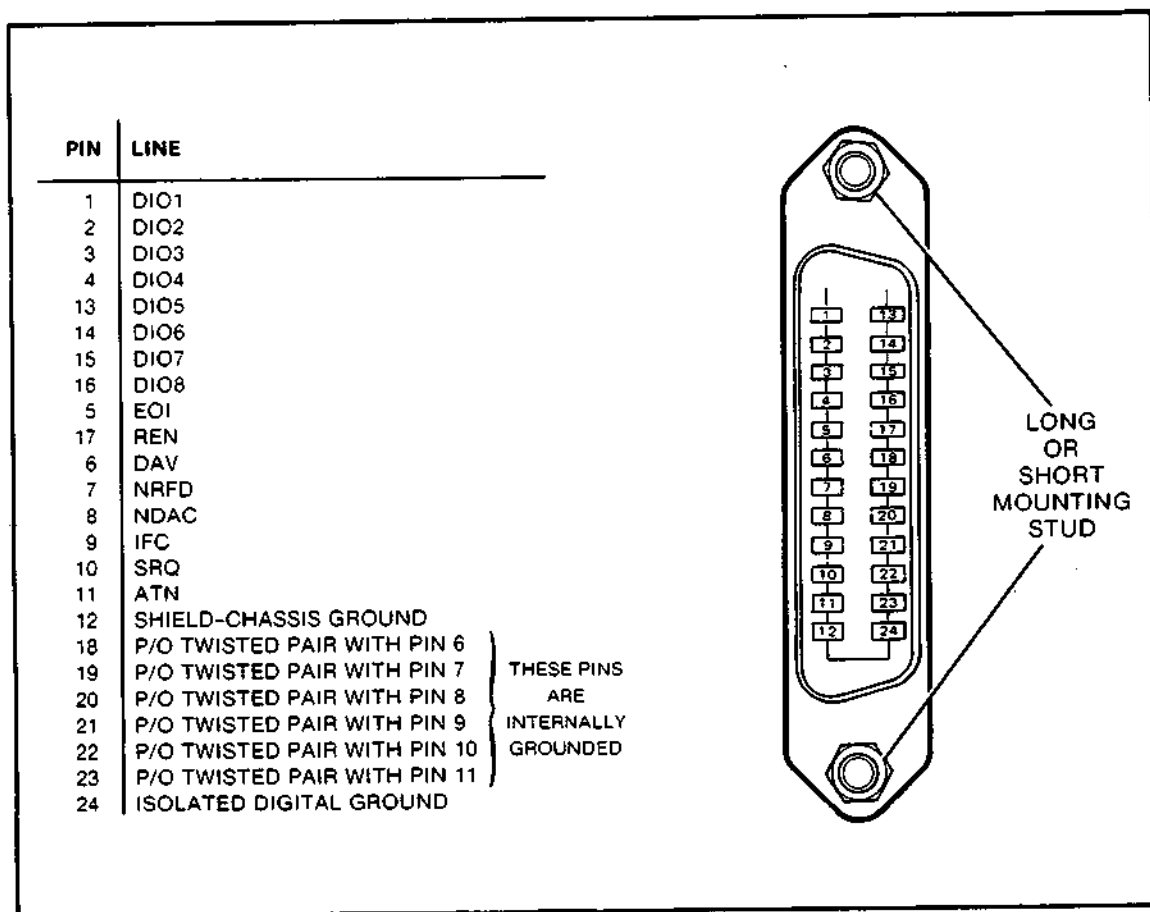


Figure 2-2. Hewlett-Packard Interface Bus Connection

2-17. The HP-IB cables have identical "piggy-back" connectors on both ends so that several cables can be connected to a single source without special adapters or switch boxes. System components and devices may be connected in virtually any configuration desired. There must, of course, be a path from the calculator (or controller) to every device operating on the bus. As a practical matter, avoid stacking more than three or four connectors on any one connector. If the stack gets too large, the force on the stack produces great leverage which can damage the connector mounting. Be sure each connector is firmly (finger tight) screwed in place to keep it from working loose during use.

2-18. **CABLE LENGTH RESTRICTIONS.** To achieve design performance with the HP-IB, the proper voltage levels and timing relationships must be maintained. If the system cable is too long, the lines cannot be driven properly, and the system will fail to perform properly. Therefore, when interconnecting an HP-IB system, it is important to observe the following rules:

- a. The total cable length for the system must be less than or equal to 20 metres (65.6 feet).
- b. The total cable length for the system must be less than or equal to 2 metres (6.6 feet) times the total number of devices connected to the bus.
- c. The total number of instruments connected to the bus must not exceed 15.

2-19. HP-IB TALK/LISTEN AND ADDRESS SWITCHES

2-20. The HP 5345A provides a rear panel HP-IB TALK/LISTEN selection switch. This switch determines the mode of remote operation as "Talk Only" or "Addressable".

2-21. The ADDRESS switches on the counter rear panel are used to manually set the remote control address of the counter. The addresses 20 and 21 are reserved for the controller, and only even numbered addresses may be programmed because the counter A1 bit has been internally tied low. Odd numbered addresses are used to access computer dump mode which will be discussed in Section III.

2-22. HP-IB DESCRIPTIONS

2-23. A description of the HP-IB is provided in Section III of this manual. A study of this information is necessary if the user is not familiar with the HP-IB concept. Additional information concerning the design criteria and operation of the bus is available in IEEE Standard 488-1978, titled "*IEEE Standard Digital Interface for Programmable Instrumentation*".

2-24. REPACKING FOR SHIPMENT

2-25. If it becomes necessary to reship the counter, good commercial packing should be used. Contract packaging companies in many cities can provide dependable custom packaging on short notice. Instruments should be packed securely in a strong corrugated container (350 lb./sq. inch bursting test) with suitable filler pads between the instrument and container. *The 4-corner support is not adequate, the counter must also have center support.* Before returning instruments to Hewlett-Packard, contact the nearest Hewlett-Packard Sales and Service Office for instructions.

2-26. ENVIRONMENT DURING STORAGE AND SHIPMENT

2-27. Conditions during storage and shipment should normally be limited as follows:

- a. Maximum altitude: 25,000 feet.
- b. Minimum temperature: -40°F (-40°C).
- c. Maximum temperature: +167°F (+75°C).

SECTION III OPERATION AND PROGRAMMING

3-1. INTRODUCTION

3-2. Section III contains operating and programming information that is helpful in realizing the best performance from the instrument. This includes a general description of the operating modes, the function of controls and indicators, operator's maintenance, a self-check procedure, setup procedures for making basic measurements, and remote programming instructions.

3-3. MEASUREMENT TECHNIQUE

3-4. The counter uses a period average technique to make measurements. The counts (or pulses) that are generated from the input and time base signals are collected in separate scalers during the measurement time. The counter compares these pulses arithmetically and displays the result on the front panel.

3-5. OPERATING MODES

3-6. The following paragraphs describe the operating modes for frequency, period, time interval, ratio, and totalize measurements.

3-7. Frequency Mode

3-8. Channel A accepts input frequencies from 50 μ Hz to 500 MHz with a minimum level of 25 mV rms sine wave. These frequencies are counted directly with no prescaling techniques applied. Extended frequency capability is available with the use of plug-ins. The counter is capable of measuring pulsed RF in either a single burst or an average of several bursts. The measurement time within the burst may be varied in length and position for detecting frequency variations within a burst.

3-9. The measurement time is the selected gate time plus the time until the next trigger pulse occurs. For example, if the selected gate time is 1 ms, the event gate will close on the next trigger after 1 ms has elapsed. If the input frequency were 20 kHz (.05 ms period), the measurement time would be 1 ms + .05 ms = 1.05 ms. The difference encountered does not affect the accuracy of the measurement.

3-10. Period Modes

3-11. Two modes of period measurements are available: single period and period average. These modes are described in the following paragraphs.

3-12. **SINGLE PERIOD.** Single period measurements are made with with the GATE TIME switch set to MIN. In this position, the gate time is one period or 50 ns, whichever is greater. Therefore, the input frequency range for a single period measurement is 50 μ Hz to 20 MHz. Frequencies greater than 20 MHz may be applied, but they will be averaged during a 50 ns gate time.

3-13. **PERIOD AVERAGE.** When the GATE TIME switch is set to any other position than MIN, the counter averages multiple periods. Averaging increases the accuracy and resolution of the measurement. Input frequencies are in the 50 μ Hz to 500 MHz range. The actual gate time is determined in the same manner as that described under Frequency Mode.

3-14. **Number of Periods Averaged.** To determine the number of periods averaged during a measurement, divide the displayed answer into the selected gate time.

Example:
$$\frac{\text{Gate Time setting (sec)}}{\text{Displayed Period (sec)}} = \frac{1 \text{ ms}}{20.492 \mu\text{s}} = 48.799 = 49 \text{ periods}$$

The number of periods averaged will always be a whole number. Therefore, should the calculated answer contain any digits to the right of the decimal point, drop these digits and increment the remainder by one. This is due to the extended gate time. The answer for this example, then, is 49 periods averaged.

3-15. Time Interval Modes

3-16. The counter measures time intervals from Channel A to Channel B; that is, Channel A starts the measurement and Channel B stops the measurement. Time between points on a single waveform can be measured by connecting the input signal to CHANNEL A jack and placing the Input Amplifier Control switch to COM A. Under these conditions, the slope and level controls of Channel A and Channel B allow variable triggering on either the + or - slope. With the Input Amplifier Control switch set to SEP, measurements can be made between points on separate waveforms.

3-17. SINGLE TIME INTERVALS. Single time intervals down to 10 ns are measured with the GATE TIME switch set to MIN. The gate time is one time interval for repetition rates of less than 20 MHz. Thus, if two or more time intervals occur within 50 ns, they will be averaged.

3-18. TIME INTERVAL AVERAGE. The counter averages multiple time intervals when the GATE TIME switch is set to any position other than MIN. The maximum repetition rate is 50 MHz (10 ns time interval plus 10 ns deadtime = 20 ns period or 50 MHz). To average, the time interval must be less than the selected gate time.

NOTE

If the time interval is greater than the gate time, but not more than 3.5 times greater, a single period will be measured. The MIN gate time position is preferred for single periods.

3-19. When averaging, white noise modulates the internal clock signal to prevent any harmonic relationship between the input signal and the clock. This increases the measurement accuracy. The noise is not generated when the GATE TIME switch is set to MIN.

3-20. INITIATING A MEASUREMENT. The front-panel ARM and GATE lights and the rear-panel dc trigger levels are helpful when setting up a time interval measurement. Place the GATE TIME switch to 100 μ s. The ARM light is an indication that Channel A is not triggering, possibly due to insufficient signal amplitude or misadjusted front-panel controls. A flashing GATE light indicates that Channel A is triggering. If the counter is gating and *lamp test* (paragraph 3-63) is flashing or appears to be steady, the counter has gone into *excessive gate time* (paragraph 3-36). This means the counter has reset because Channel B was not triggered with a stop signal. This could be caused by the stop pulse failing to arrive until after the maximum allowable time, which is 3.5 times the selected gate time. In this case, increase the gate time. Other causes could be insufficient signal amplitude or misadjusted front-panel controls.

3-21. MEASUREMENT TIME. In time interval average, the time needed to complete a measurement may be much longer than the selected gate time. This is because the counter collects a *gate time's worth of time intervals*. The factors which would increase the measurement time are short time intervals and extended time between intervals (see Figure 3-1).

3-22. Occasionally, when increased resolution is needed, it may be convenient to estimate the total time of a measurement. To calculate this, use the equation below.

$$\text{Measurement Time} = \frac{\text{Gate Time (sec)}}{\text{Time Interval (sec) X Number of Time Intervals per sec}}$$

$$\text{Example: } \frac{1 \text{ msec}}{100 \text{ ns X } 800/\text{sec}} = \frac{1 \text{ X } 10^{-3} \text{ sec}}{8 \text{ X } 10^{-5}} = 12.5 \text{ seconds}$$

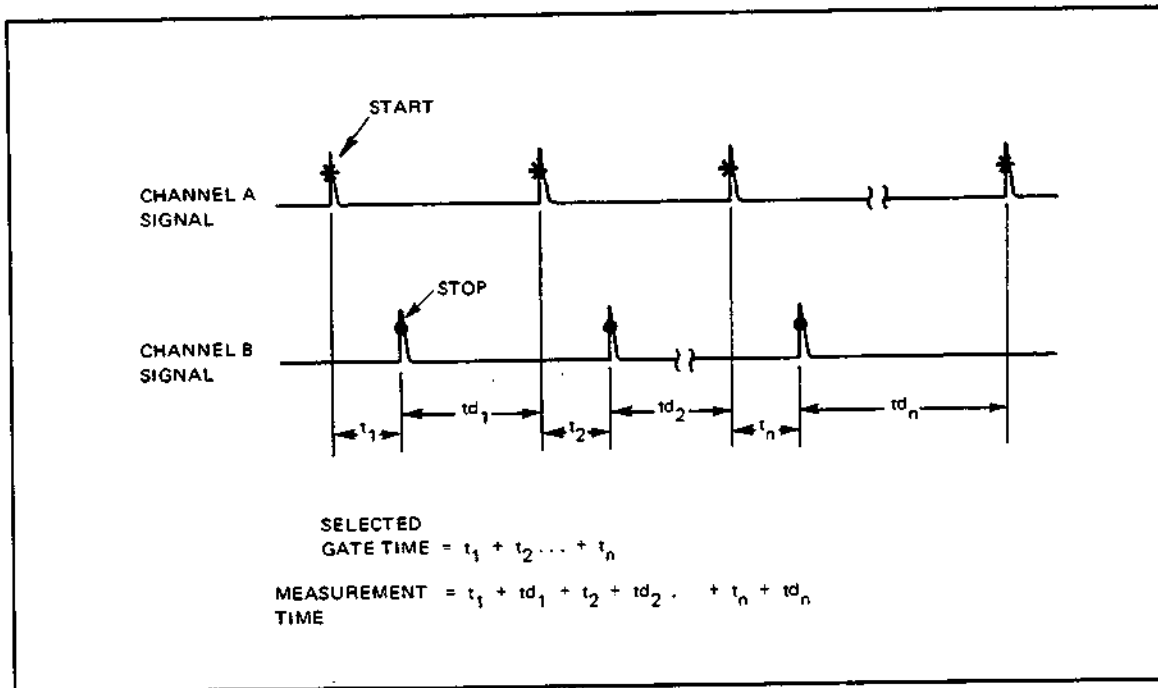


Figure 3-1. Measurement Time for Time Interval Average

3-23. If the time interval used in the equation is unknown, it can be obtained from the counter by selecting MIN. The number of time intervals per second can be taken from an oscilloscope reading. For most purposes, these figures need be only approximate to give a reasonable indication of the waiting time involved.

3-24. Ratio Measurements

3-25. The ratio between two frequencies (FB/FA) is measured by connecting one signal to Channel A and the other to Channel B. Both channels operate in the 50 μ Hz to 500 MHz range. If the higher frequency is connected to Channel B, the ratio will be greater than one. The answer for a ratio measurement is a unitless figure.

3-26. MEASUREMENT TIME. The difference between the selected gate time and the total measurement time depends on the frequency applied to Channel B. In the Ratio mode, the Channel B signal substitutes for the internal 500 MHz time base.

3-27. With the GATE TIME switch set to 1 s, for example, 5×10^8 time base counts are needed to end the measurement. When the 500 MHz internal time base is used, the 5×10^8 counts are accumulated in 1 second. If, for example, 70 MHz were applied to Channel B and used as the time base, it would take about 7 times as long (7.14 seconds) to accumulate the 5×10^8 counts needed to disarm the gate.

3-28. To estimate the measurement time, use the equation below.

$$\text{Measurement Time} = \frac{5 \times 10^8 \text{ Hz}}{\text{Channel B Freq.}} \times \text{Gate Time}$$

$$\text{Example: } \frac{5 \times 10^8 \text{ Hz}}{25 \text{ MHz}} \times 1 \text{ ms} = \frac{5 \times 10^8}{2.5 \times 10^7} \times 1 \times 10^{-3} \text{ sec} = 20 \text{ ms}$$

3-29. Totalize Mode

3-30. The START and STOP positions on the FUNCTION switch allow manual opening and closing of the counter's main gate. The Input Amplifier Control switch must be placed in SEP. When the switch is in the START position, the counter totalizes the number of times the input signal passes through the Channel A trigger point. The GATE TIME switch does not affect the displayed result in any way.

3-31. BOTH CHANNELS TOTALIZED. When the Input Amplifier Control switch is set to SEP, Channel A and Channel B signals can be totalized simultaneously. The displayed result is a function of the ACCUM MODE START/STOP switch, located on the rear panel. The two signals are added (A+B) or subtracted (A-B), depending on the switch position. When the Input Amplifier Control switch is set to CHECK, the counter always selects A+B.

3-32. A minus sign on the display indicates that during a subtraction (A-B) the B events have outnumbered the A events. With the switch in A-B, the instrument functions like an up-down or reversible counter. That is, the counter will count down from a previously-given positive number. As an example of this, assume that the A frequency is greater than the B frequency and the switch is in A-B. The display accumulates positive numbers at a rate equal to the difference between the two input frequencies. If the frequency of B now becomes greater than A, the displayed count will decrease towards zero, again, at a rate equal to the difference between the two frequencies. Once the declining number passes through zero, the minus sign lights and the display continues to accumulate.

3-33. SCALED OUTPUT. With the FUNCTION switch set to START and SAMPLE RATE to HOLD, the counter scales (divides) the Channel A input frequency by powers of 10. This scaled signal is available on the rear-panel CHAN A SCALER OUTPUT jack. Although the display is not functioning, the counter is accumulating. The GATE TIME switch controls the division factor, as shown in Table 3-1.

Table 3-1. Scaler Output for Channel A

GATE TIME SETTING	SCALING FACTOR	SCALED OUTPUT (100 MHz IN OR CHECK)
100 ns	10^2	1 MHz
1 μ s	10^3	100 kHz
10 μ s	10^4	10 kHz
100 μ s	10^5	1 kHz
1 ms	10^6	100 Hz
10 ms	10^7	10 Hz
100 ms	10^8	1 Hz
1 s	10^9	100 mHz
10 s	10^{10}	10 mHz
100 s	10^{11}	1 mHz
1000 s	10^{12}	100 μ Hz

3-34. INPUT TRIGGERING

3-35. The input circuits provide triggering over a range of -2.0V to +2.0V. The point at which triggering occurs is adjustable with the front-panel LEVEL control. Each input channel has a small amount of hysteresis (about 10 mV). If the SLOPE switch is set to "+," the trigger pulse occurs at the top of the hysteresis window. If the SLOPE switch is set to "-", the pulse occurs on the bottom line of the window. In other words, the signal must pass through the entire hysteresis window before a trigger pulse is generated (see Figure 3-2). The LEVEL control must be placed to allow at least a 1 ns pulse width for the Schmitt Trigger.

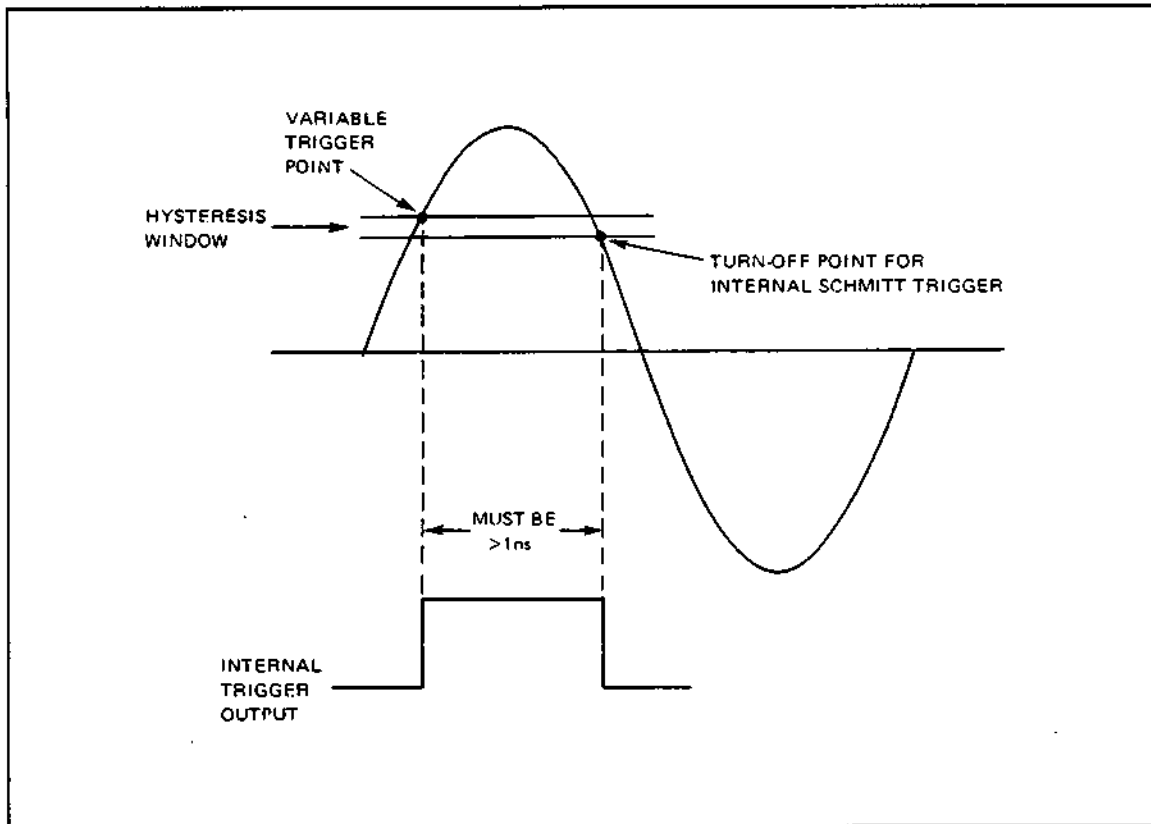


Figure 3-2. Internal Triggering

3-36. EXCESSIVE GATE TIME

3-37. In every measurement involving a gate time, the counter depends on the input signal to terminate the measurement. The measurement concludes one clock pulse after the next input pulse following the end of the gate time, not with the gate time itself. If the period of the input signal is much longer than the gate time or if the signal is interrupted sometime during the gate time, the excessive gate time circuits prevent the counter from waiting indefinitely for the terminating pulse. The counter will wait for about 3.5 times the selected gate time before resetting. At the end of excessive gate time, the display will flash instantaneously to lamp test before displaying all zeros. Excessive gate time is especially useful during the time interval measurement; see paragraph 3-20 for a further description.

3-38. EXTERNAL ARMING AND GATING

3-39. The GATE CONTROL INPUT jack (rear panel) allows the counter to be externally armed and gated. The jack works in conjunction with the Gate Control switch, located directly below the jack.

3-40. External Arming

3-41. When externally arming, set the Gate Control switch to EXT ARM and the SAMPLE RATE switch to HOLD. The counter will ARM when the instrument is first turned on because of the internal arming of the sample rate circuits. After the first measurement, however, the counter's arming circuits are fully controlled by the external source. The counter is armed within 1 μ s of receiving the arm pulse (500 ns to dc at -1V). Once the counter is armed, the measurement begins with the first Channel A trigger pulse. The counter makes only one measurement for each arm pulse.

3-42. External Gating

3-43. When the Gate Control switch is set to EXT GATE, the counter's arming and gating is under full external control. The gating can be accomplished in two ways: single gating or multiple gating.

3-44. SINGLE PULSE GATING. Single gating is accomplished with a single, external gate pulse. The width of this pulse can be varied from 20 ns to 20,000 seconds. When using a single gate, set the GATE TIME switch to MIN. This assures the measurement will always take place during a single, external gate pulse. This will not be true for other settings of the GATE TIME switch.

3-45. MULTIPLE PULSE GATING. This method requires an arming pulse, which is automatically taken from the external gate pulse train. When the GATE TIME switch is in any position other than MIN, the counter accumulates as many external gate pulses as are needed to equal or exceed the gate time selected by the switch. As an example, assume a GATE TIME setting of 10 ms and external gate pulses of 4 ms. The counter requires three of these pulses before a measurement can be completed. The total gate time is 12 ms.

3-46. One of the uses of multiple gating is *frequency averaging*, i.e., an average of frequency measured over multiple bursts. Using the same values as above, Figure 3-3 shows the type of gating in frequency averaging.

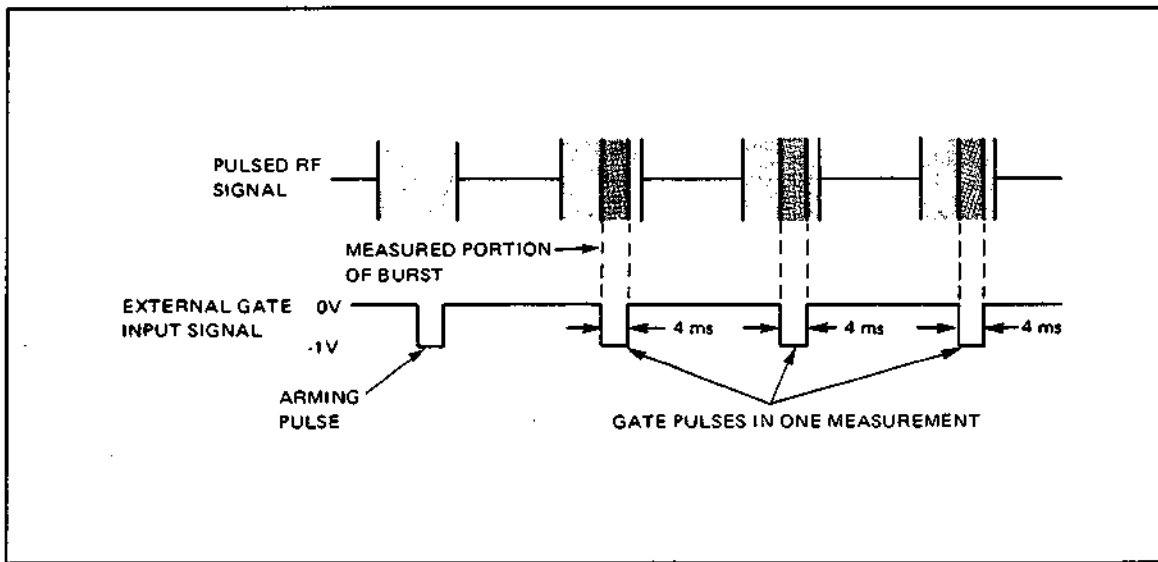


Figure 3-3. Multiple Gating

3-47. Time Interval Measurements

3-48. External gating is valuable when measuring the time between two events while ignoring the events occurring between them. The external gate signal must go low (-1 V) before the start pulse and return high (0 V) before the stop pulse.

3-49. SINGLE TIME INTERVALS. As previously mentioned for external gating, a measurement using a single external gate requires the GATE TIME switch to be set to MIN. The counter arms automatically and the external gate pulse provides a control over the time interval measurement. Varying the width of the pulse determines which time interval is measured, as can be seen in Figure 3-4.

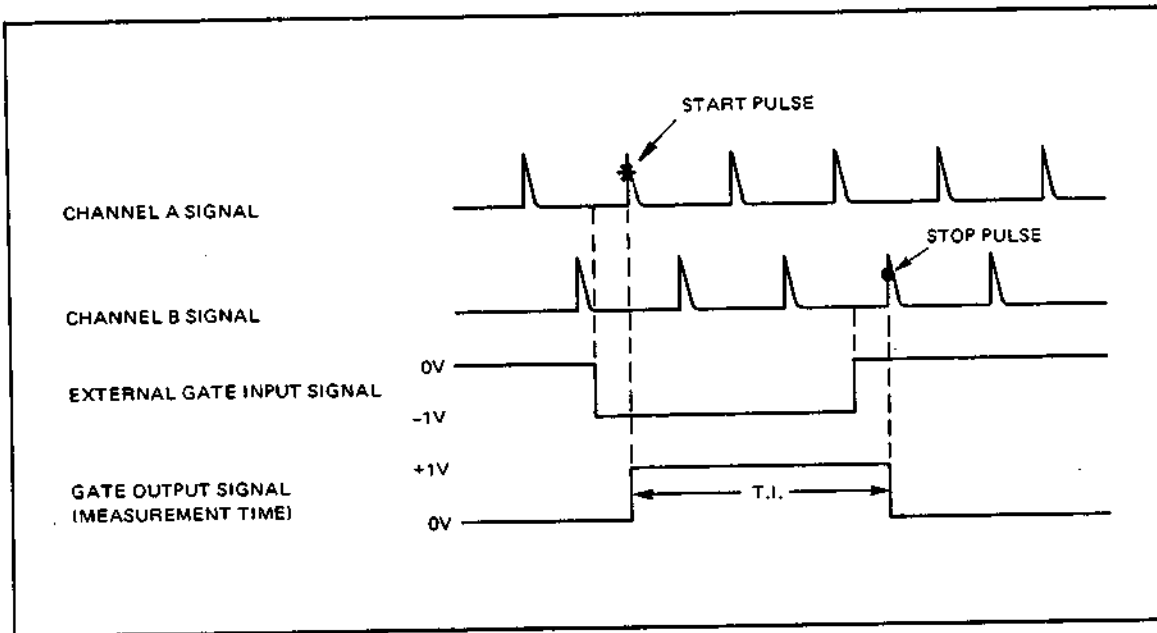


Figure 3-4. External Gating for Single Time Interval

3-50. MULTIPLE TIME INTERVALS. An average of time intervals can be measured using the external gating method. This method, as in single time intervals, allows certain pulses of the waveform to be ignored. The GATE TIME switch must be set to any other position than MIN. See Figure 3-5 for an example of time interval averaging. This method does require an arming pulse for each measurement cycle.

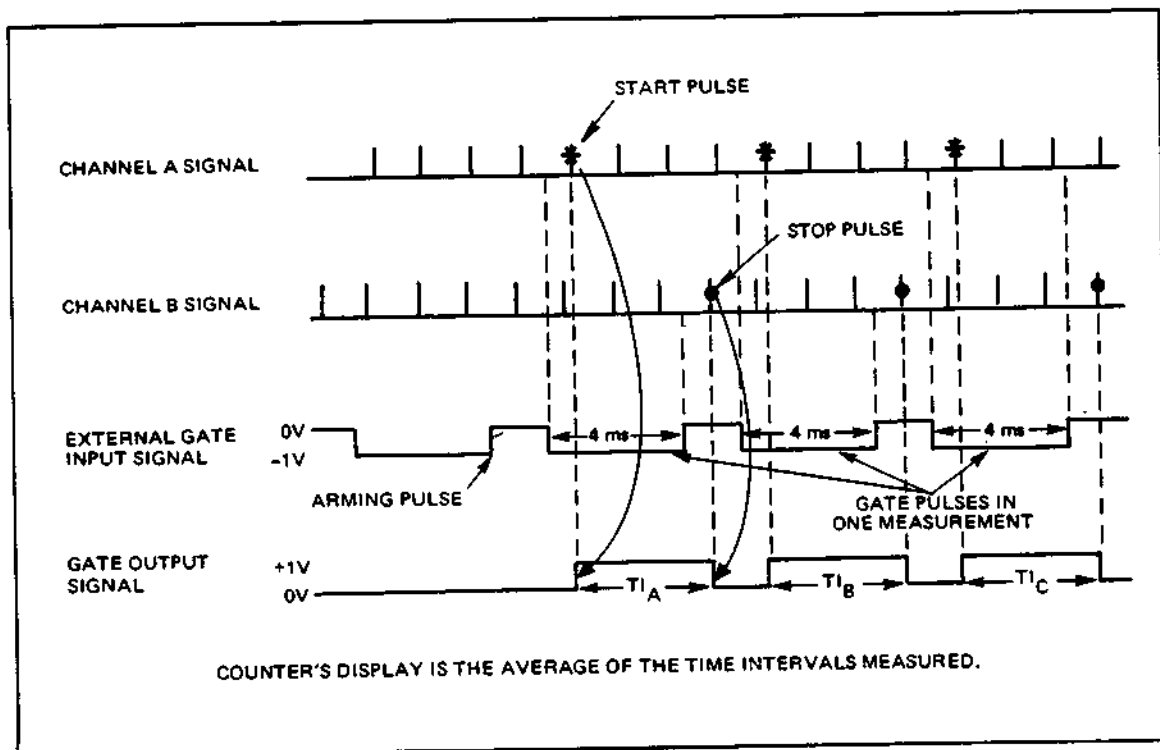


Figure 3-5. External Gating for Time Interval Averaging

3-51. DISPLAY

3-52. The counter uses a 12-digit display: 11 digits of data and 1-digit for the minus sign. Unlike most counters, the number of digits displayed in a measurement is not a function of the input frequency and is not related to the FUNCTION switch. The number of digits is constant for each setting of the GATE TIME switch.

3-53. Display Position

3-54. When the DISPLAY POSITION switch is set to AUTO, the counter automatically positions the display's least-significant digit in the right-most column. Rotating the switch to each of its counterclockwise positions (blue dots) shifts the decimal point, hence the display, one place to the left. Once the switch is placed to any position other than AUTO, the annunciator (k, M, n, etc.) stays fixed, regardless of changing input frequency. The annunciator remains fixed until the RESET button is pushed or the FUNCTION switch setting is changed. Manually fixing the decimal point and the annunciator is convenient when collecting measurement data with a digital-to-analog converter. As an example, the DAC can continually record any 3 digits in a possible display of 11, regardless of changing input data.

3-55. Asterisk

3-56. The asterisk lamp will light under any one of four conditions: overflow, underflow, factitious zeros, or insufficient oven temperature (standard only). Overflow occurs when the placement of the DISPLAY POSITION switch has positioned the display's most-significant digit(s) so far to the left that it is out of viewable range. Underflow occurs when the placement of the DISPLAY POSITION switch has positioned the display's least-significant digit(s) so far to the right that it is out of viewable range. If the counter is equipped with an oven-controlled oscillator (standard), the operating temperature of the oven must remain constant for the crystal to perform properly. Should the oven temperature drop below its normal operating range, the asterisk light will come on as an indication of this condition.

3-57. *Factitious* zeros occur when the settings of the GATE TIME switch and DISPLAY POSITION switch has been combined to give fewer significant digits than the DISPLAY POSITION demanded. In this combination, the display attempts to blank one or more of the significant digits located to left of decimal point. Instead of blanking the digit, the display substitutes an artificial and meaningless zero to keep that portion of the display filled.

3-58. Although the presence of factitious zeros is a rare occurrence, its appearance can be demonstrated with the counter set-up as follows: FUNCTION to FREQ A, connect input signal of 125 MHz, turn DISPLAY POSITION switch out of AUTO to about mid-range, turn GATE TIME switch ccw until the display is 125 MHz. The next switch position changes the display to 120 MHz and lights the asterisk. The zero now displayed is a factitious or filler zero.

3-59. Arm Light

3-60. An illuminated ARM light indicates that Channel A is not triggering. The condition of this indicator should be observed when adjusting the front-panel controls for a first-time measurement. Insufficient amplitude of the input signal or improper setting of the input controls (LEVEL, ATTEN, etc.) are common causes for the failure of the GATE light to turn on.

3-61. Gate Light

3-62. Once Channel A triggers, the ARM light turns off and the GATE light turns on. The GATE indicator lights during the time the counter's event gate is open. For short-duration gate times, the GATE light circuits include a 40 ms one-shot mV to allow a visible flash of the light. The SAMPLE RATE control sets the time between flashes (or measurement cycles).

3-63. Lamp Test

3-64. To ensure that all segments of the display are capable of lighting, the counter provides a lamp test. The display should appear like the representation shown on the next page (Figure 3-6).

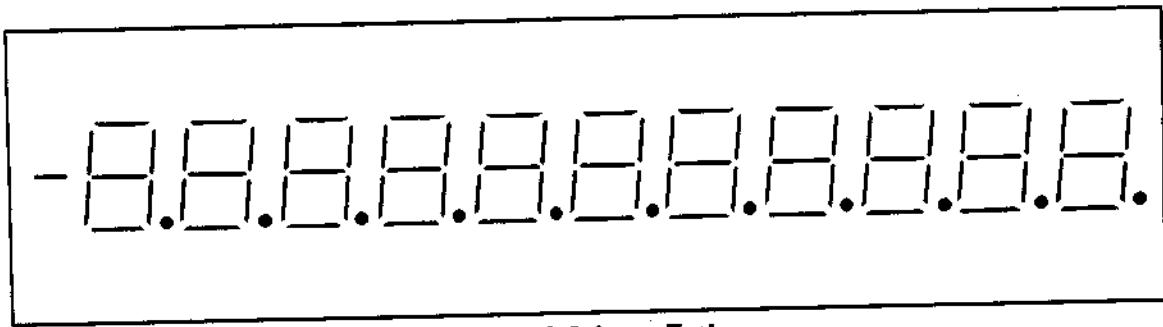


Figure 3-6. Lamp Test

3-65. Lamp test occurs under several conditions:

- a. When the RESET button is pushed.
- b. When the POWER switch is placed to ON, lamp test will light for about 2 seconds.
- c. When switching between detent positions of the GATE TIME switch, FUNCTION switch, or DISPLAY POSITION switch.
- d. When counter is attempting to phase lock the internal oscillator to an external standard.
- e. When the counter has gone into excessive gate time.
- f. When operating with an external frequency standard (rear panel INT STD-EXT STD set to EXT STD) and the external frequency is lost or disconnected.

3-66. COOLING

3-67. The counter's fan, located behind the display assembly, provides forced-air cooling to the electronic components throughout the instrument. The fan takes air in through the left side panel and bottom cover and exhausts it through the top cover and right side cover via the plug-in compartment.

NOTE

Check for proper air flow each time the instrument is turned on. If the unit is operated for extended periods of time without adequate cooling, the counter will automatically turn off.

3-68. AIR FILTER CLEANING

NOTE

Instruments with serial number 1708A02576 or higher are supplied less the air filters. Hewlett-Packard recommends removing the filters from all previous units. If desired to retain the filter protection, follow the step-by-step instructions below.

3-69. When the instrument is placed into service, the air filters should be inspected frequently to determine the rate at which they collect dirt in their particular environment. Under average conditions, the air filters should be cleaned about every 3 months. To remove these filters, proceed as follows:

- a. Remove power cord at rear panel.
- b. Remove the top and bottom covers (4 screws each).
- c. Remove the 4 screws holding in display assembly (see Figure 3-7). Remove display assembly from mainframe and disconnect its power cable at bulkhead.
- d. Remove left-front side cover (4 screws).
- e. On left side frame, remove right-most top and bottom screws (1 ea.) and extract side air filter.
- f. Remove the 4 screws holding the 2 internal brackets and extract bottom air filter.

Use the following procedure to clean the air filters.

- a. Wash air filters with water.
- b. Let stand until completely dry.
- c. Recoat filters with *RP Super Filter Coat Adhesive*, Research Products Corporation.

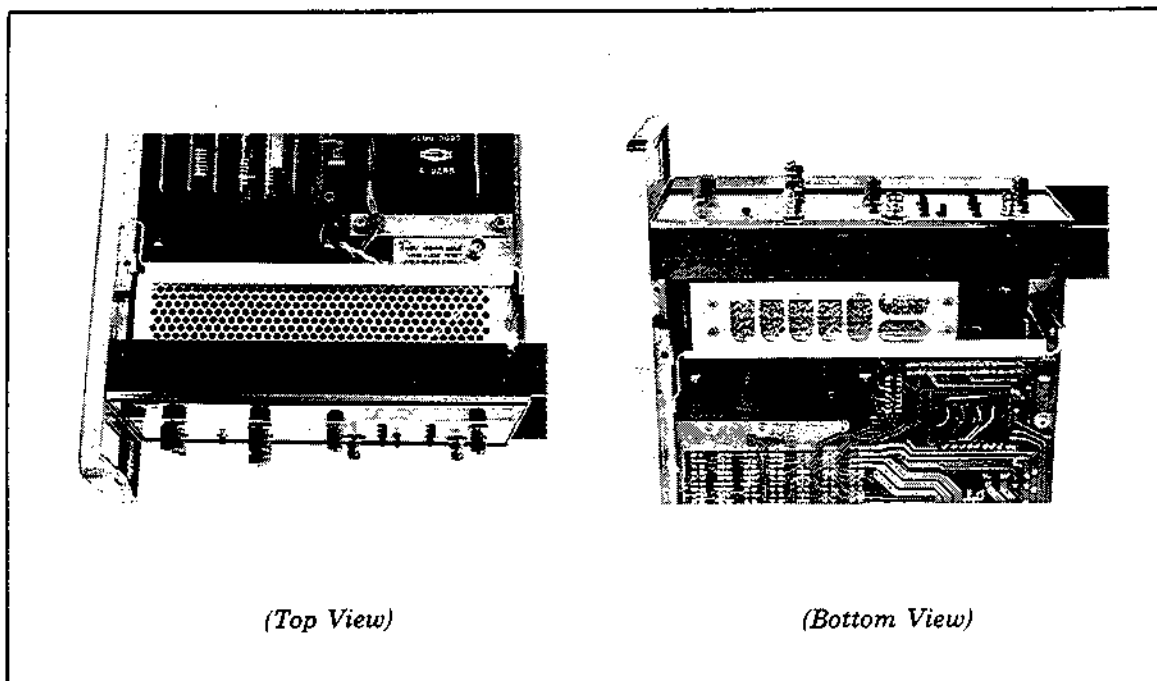


Figure 3-7. Location of Display Assembly Screws

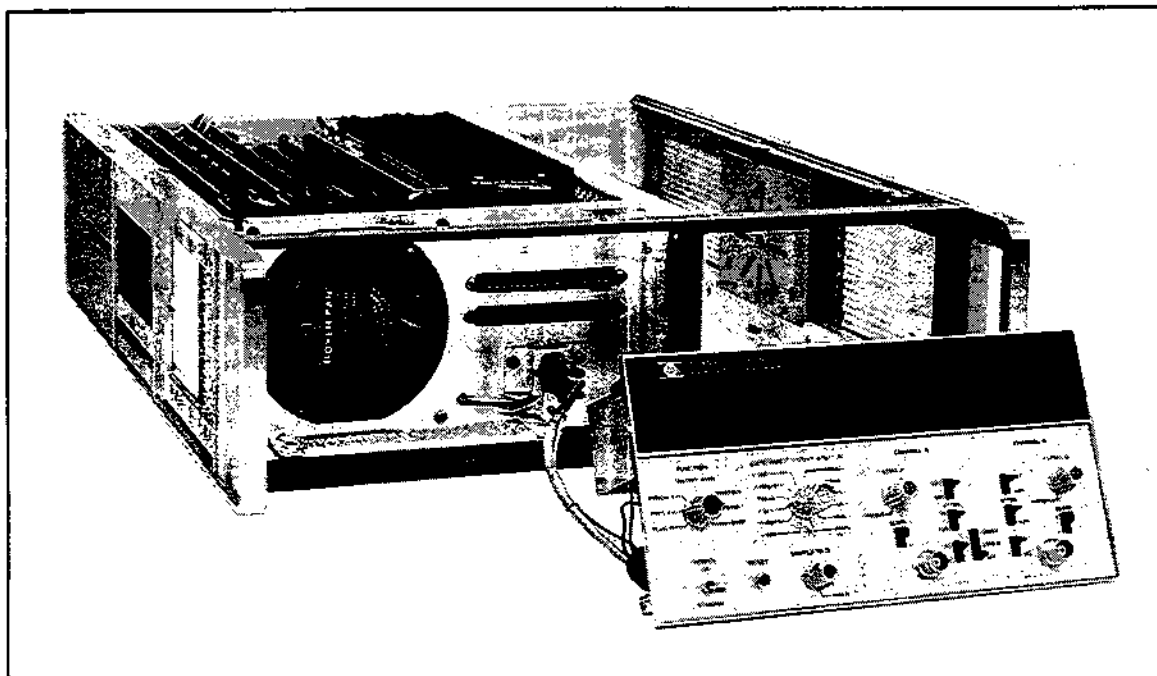
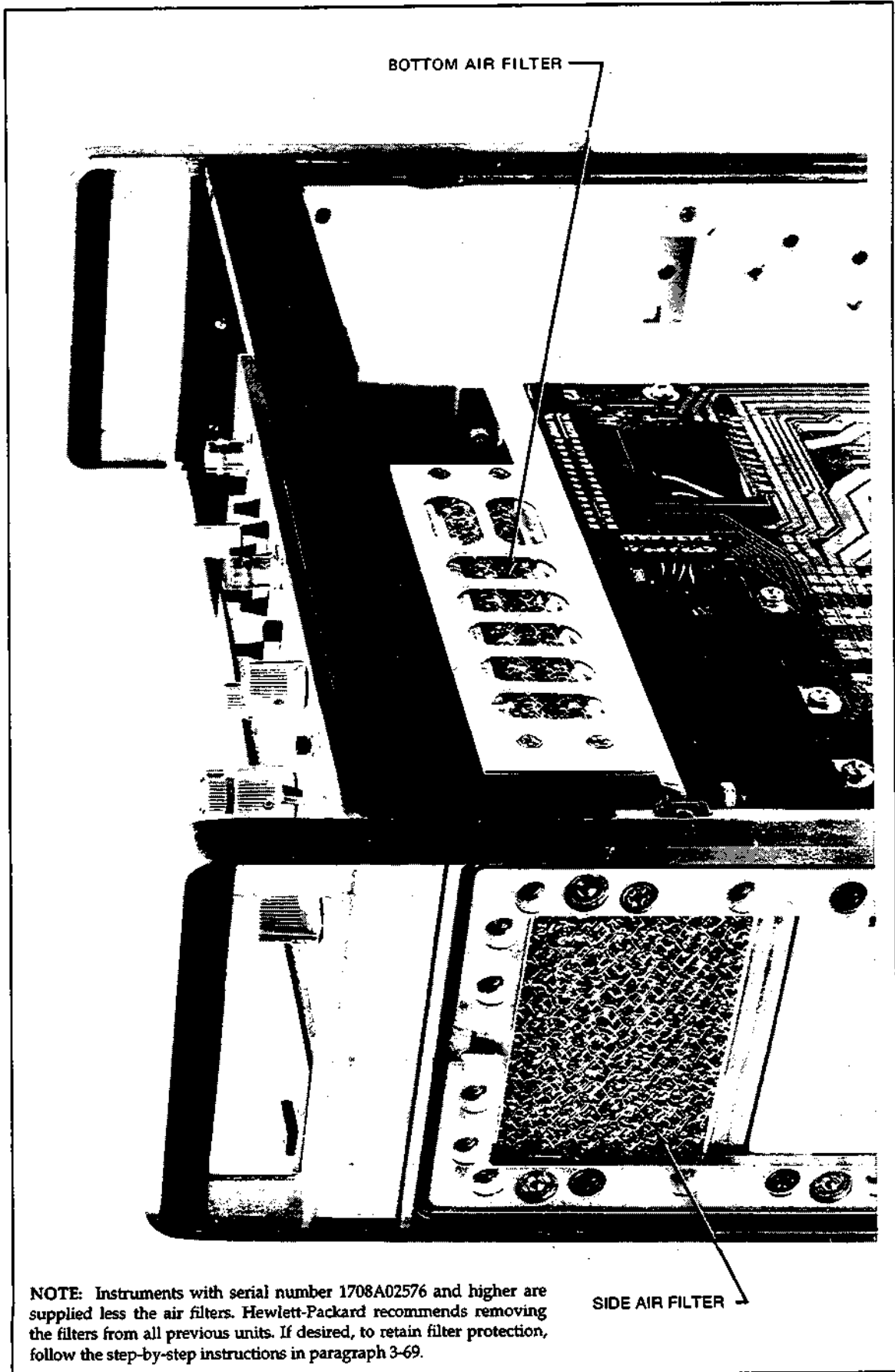


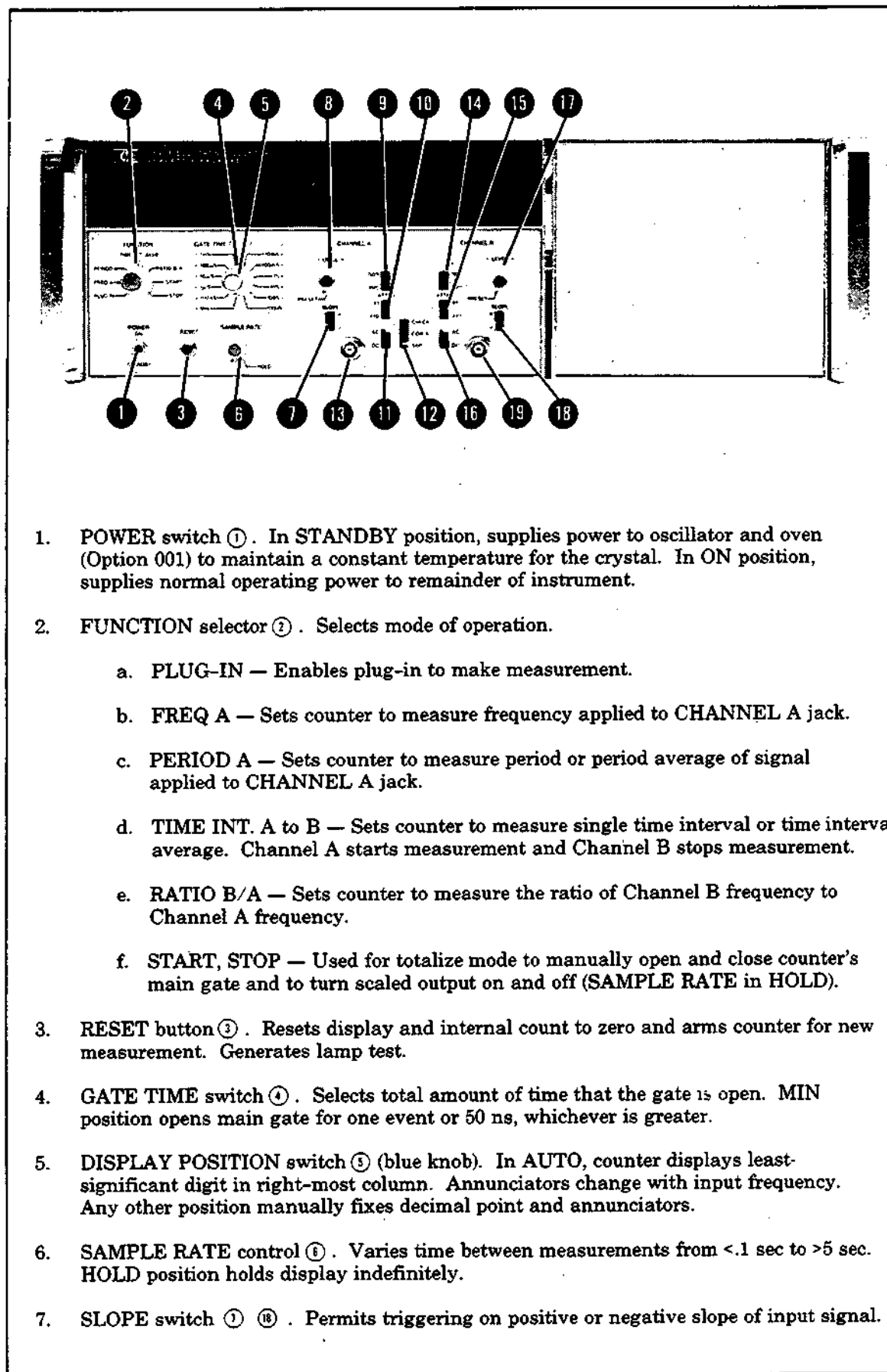
Figure 3-8. Removal of Display Assembly



NOTE: Instruments with serial number 1708A02576 and higher are supplied less the air filters. Hewlett-Packard recommends removing the filters from all previous units. If desired, to retain filter protection, follow the step-by-step instructions in paragraph 3-69.

SIDE AIR FILTER

Figure 3-9. Location of Air Filters



1. POWER switch ① . In STANDBY position, supplies power to oscillator and oven (Option 001) to maintain a constant temperature for the crystal. In ON position, supplies normal operating power to remainder of instrument.
2. FUNCTION selector ② . Selects mode of operation.
 - a. PLUG-IN — Enables plug-in to make measurement.
 - b. FREQ A — Sets counter to measure frequency applied to CHANNEL A jack.
 - c. PERIOD A — Sets counter to measure period or period average of signal applied to CHANNEL A jack.
 - d. TIME INT. A to B — Sets counter to measure single time interval or time interval average. Channel A starts measurement and Channel B stops measurement.
 - e. RATIO B/A — Sets counter to measure the ratio of Channel B frequency to Channel A frequency.
 - f. START, STOP — Used for totalize mode to manually open and close counter's main gate and to turn scaled output on and off (SAMPLE RATE in HOLD).
3. RESET button ③ . Resets display and internal count to zero and arms counter for new measurement. Generates lamp test.
4. GATE TIME switch ④ . Selects total amount of time that the gate is open. MIN position opens main gate for one event or 50 ns, whichever is greater.
5. DISPLAY POSITION switch ⑤ (blue knob). In AUTO, counter displays least-significant digit in right-most column. Annunciators change with input frequency. Any other position manually fixes decimal point and annunciators.
6. SAMPLE RATE control ⑥ . Varies time between measurements from <.1 sec to >5 sec. HOLD position holds display indefinitely.
7. SLOPE switch ⑦ ⑧ . Permits triggering on positive or negative slope of input signal.

Figure 3-10. Front Panel Controls and Connectors

8. LEVEL control ⑧ ⑰. Used in conjunction with ATTEN switch to select voltage at which triggering occurs. With X1 attenuator setting, level is variable $\pm 2.0V$; on X10, $\pm 20V$.
9. Input Impedance switch ⑨ ⑱. Selects input impedance to 50Ω or $1 M\Omega$ shunted by approximately $45 pF$.
10. ATTEN switch ⑩ ⑲. Selects attenuation for input signal. Used in conjunction with LEVEL control to set trigger point. Input level is not affected in X1 position. Signal amplitude is reduced by factor of 10 in X10 position.
11. Coupling switch ⑪ ⑳. Selects direct or capacitor coupling for input signal.
12. Input Amplifier Control switch ㉑.
 - a. CHECK — Checks that counter is functioning properly by connecting internal 100 MHz test signal to Channel A and B.
 - b. COM A — Operationally connects A and B channels in parallel. Used for single source time interval measurements. Channel B jack is not active. Channel A and B Input Impedance switches must be set to same position.
 - c. SEP — Allows independent operation of Channel A and B.
13. Input jacks ⑬ ㉒. Inputs for Channel A and Channel B. Each input can accept signals from $50 \mu Hz$ to 500 MHz.

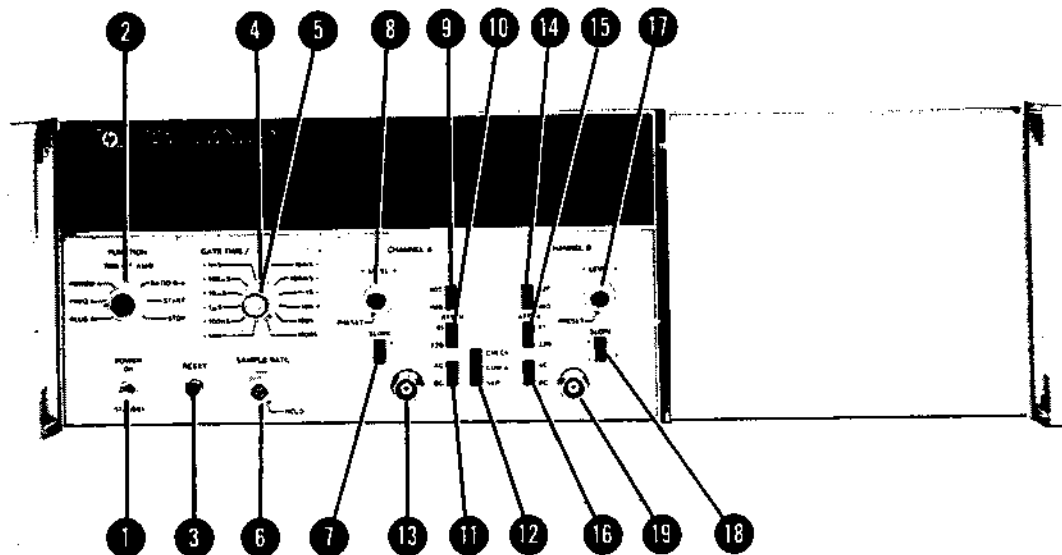
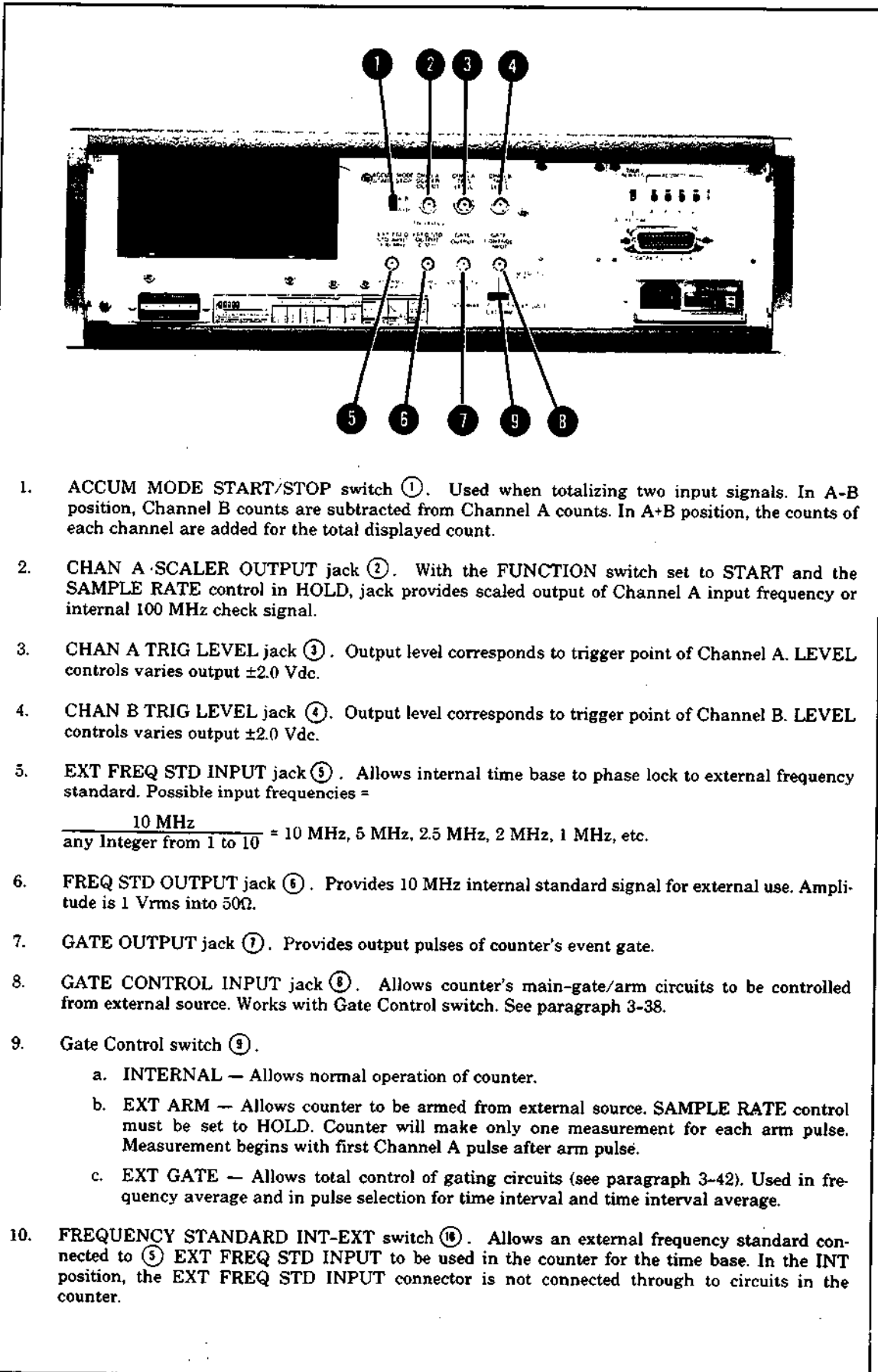


Figure 3-10. Front Panel Controls and Connectors (Continued)



1. **ACCUM MODE START/STOP switch ①.** Used when totalizing two input signals. In A-B position, Channel B counts are subtracted from Channel A counts. In A+B position, the counts of each channel are added for the total displayed count.
2. **CHAN A SCALER OUTPUT jack ②.** With the FUNCTION switch set to START and the SAMPLE RATE control in HOLD, jack provides scaled output of Channel A input frequency or internal 100 MHz check signal.
3. **CHAN A TRIG LEVEL jack ③.** Output level corresponds to trigger point of Channel A. LEVEL controls varies output ± 2.0 Vdc.
4. **CHAN B TRIG LEVEL jack ④.** Output level corresponds to trigger point of Channel B. LEVEL controls varies output ± 2.0 Vdc.
5. **EXT FREQ STD INPUT jack ⑤.** Allows internal time base to phase lock to external frequency standard. Possible input frequencies =

$$\frac{10 \text{ MHz}}{\text{any Integer from 1 to 10}} = 10 \text{ MHz, 5 MHz, 2.5 MHz, 2 MHz, 1 MHz, etc.}$$
6. **FREQ STD OUTPUT jack ⑥.** Provides 10 MHz internal standard signal for external use. Amplitude is 1 Vrms into 50Ω .
7. **GATE OUTPUT jack ⑦.** Provides output pulses of counter's event gate.
8. **GATE CONTROL INPUT jack ⑧.** Allows counter's main-gate/arm circuits to be controlled from external source. Works with Gate Control switch. See paragraph 3-38.
9. **Gate Control switch ⑨.**
 - a. **INTERNAL** — Allows normal operation of counter.
 - b. **EXT ARM** — Allows counter to be armed from external source. SAMPLE RATE control must be set to HOLD. Counter will make only one measurement for each arm pulse. Measurement begins with first Channel A pulse after arm pulse.
 - c. **EXT GATE** — Allows total control of gating circuits (see paragraph 3-42). Used in frequency average and in pulse selection for time interval and time interval average.
10. **FREQUENCY STANDARD INT-EXT switch ⑩.** Allows an external frequency standard connected to ⑤ EXT FREQ STD INPUT to be used in the counter for the time base. In the INT position, the EXT FREQ STD INPUT connector is not connected through to circuits in the counter.

Figure 3-11. Rear Panel Controls and Connectors

Table 3-2. Self Check

1. Set the counter controls as follows:
 Input Amplifier Control switch to CHECK.
 FUNCTION switch to PLUG-IN.
 GATE TIME switch to MIN.
 DISPLAY POSITION switch to AUTO.
 SAMPLE RATE control to maximum ccw.
2. Turn POWER switch to ON. Check that the counter displays a minus sign and eleven 7-segment symbols (ξ) with 11 decimal points. This display should last about 2 seconds before switching to 11 zeros with no decimal points.
3. Set FUNCTION switch to FREQ A. The GATE light should be flashing.
4. Set GATE TIME switch as shown in table below, and check for proper display.

GATE TIME	DISPLAY	ANNUNCIATOR
MIN	.1	G Hz
100 ns	.10	G Hz
1 μ s	100.	M Hz
10 μ s	100.0	M Hz
100 μ s	100.00	M Hz
1 ms	100.000	M Hz
10 ms	100.0000	M Hz
100 ms	100.00000	M Hz
1 s	100.000000	M Hz
10 s	100.0000000	M Hz
100 s	100.00000000	M Hz
1000 s	00.000000000	M Hz*

5. Set FUNCTION switch to PERIOD A and then to TIME INT. A to B. Check for proper display, as shown in the table below.

GATE TIME	DISPLAY	ANNUNCIATOR
MIN	10.	n sec
100 ns	10.	n sec
1 μ s	10.0	n sec
10 μ s	10.00	n sec
100 μ s	10.000	n sec
1 ms	10.0000	n sec
10 ms	10.00000	n sec
100 ms	10.000000	n sec
1 s	10.0000000	n sec
10 s	10.00000000	n sec
100 s	10.000000000	n sec
1000 s	0.0000000000	n sec*

6. Set FUNCTION switch to RATIO.
7. Set GATE TIME switch as shown in table below, and check for proper display.

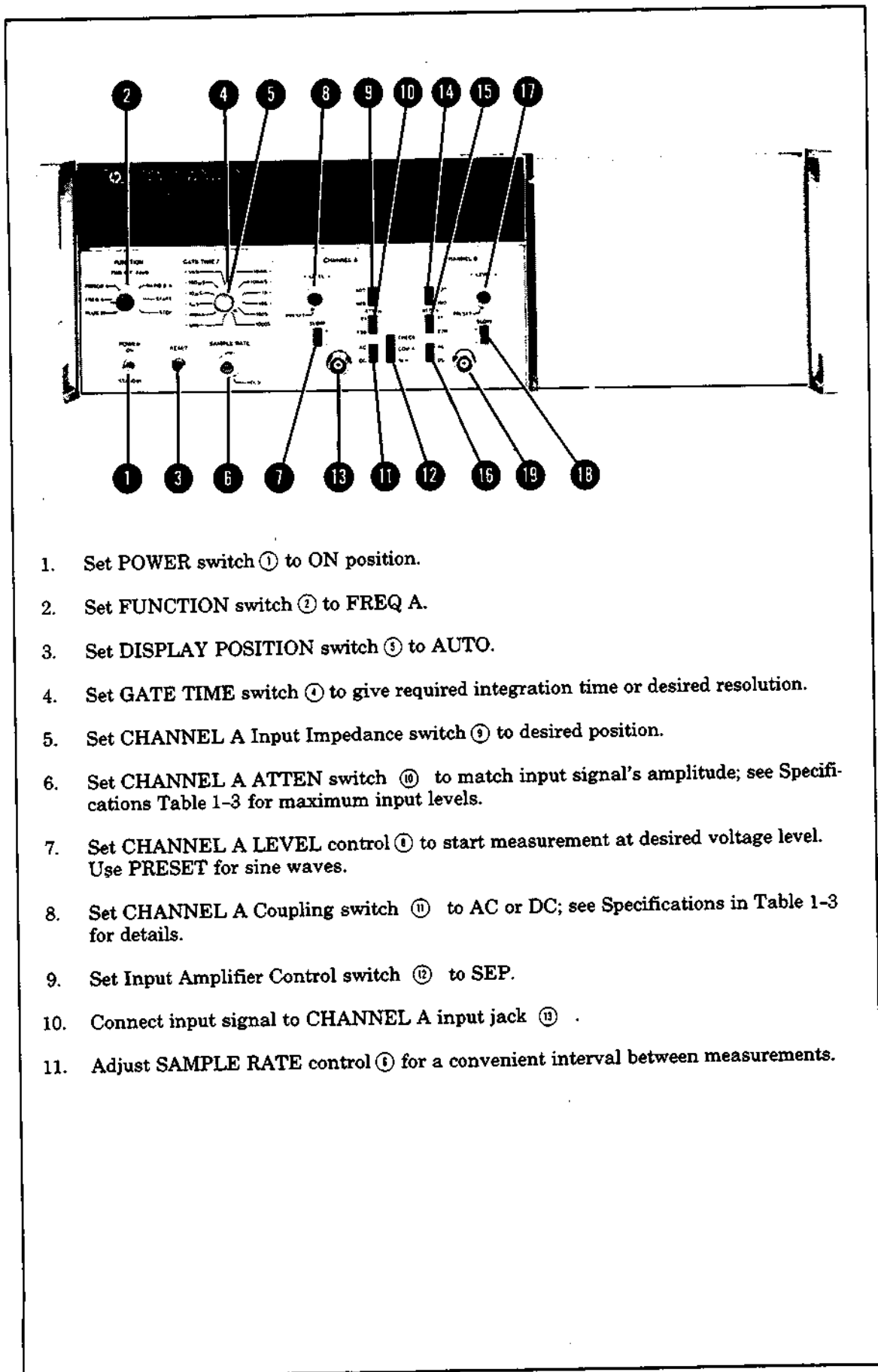
Table 3-2. Self Check (Continued)

GATE TIME	DISPLAY
MIN	1.
100 ns	1.0
1 μs	1.00
10 μs	1.000
100 μs	1.0000
1 ms	1.00000
10 ms	1.000000
100 ms	1.0000000
1 s	1.00000000
10 s	1.000000000
100 s	1.0000000000
1000 s	0000000000 *

8. Set FUNCTION switch to START. Check that counter totalizes and that the GATE light is on.
9. Set FUNCTION switch to STOP. Check that GATE light goes out and the display is held.
10. Set FUNCTION switch to START. The counter should begin totalizing from the previously held number.
11. Set FUNCTION switch to FREQ A and GATE TIME switch to 100 μs. Display is now 100.00 MHz.
12. Turn the DISPLAY POSITION switch (blue knob) through its positions and check for proper display, as shown in the table below.

DISPLAY POSITION	DISPLAY (X = BLANK)	ANNUNCIATOR
AUTO	XXXXXX100.00	M Hz
100 s	XXXXXXXX100.	*M Hz
10 s	XXXXXXXX100.0	*M Hz
1 s	XXXXXX100.00	M Hz
100 ms	XXXXX100.00X	M Hz
10 ms	XXXX100.00XX	M Hz
1 ms	XXX100.00XXX	M Hz
100 μs	XX100.00XXXX	M Hz
10 μs	X100.00XXXXX	M Hz
1 μs	100.00XXXXXX	M Hz
100 ns	00.00XXXXXXX	*M Hz
MIN	0.00XXXXXXXX	*M Hz

13. Push RESET button. Check that counter displays a minus sign and eleven 7-segment symbols ($\frac{9}{8}$) with 11 decimal points.



1. Set POWER switch ① to ON position.
2. Set FUNCTION switch ② to FREQ A.
3. Set DISPLAY POSITION switch ③ to AUTO.
4. Set GATE TIME switch ④ to give required integration time or desired resolution.
5. Set CHANNEL A Input Impedance switch ⑤ to desired position.
6. Set CHANNEL A ATTEN switch ⑥ to match input signal's amplitude; see Specifications Table 1-3 for maximum input levels.
7. Set CHANNEL A LEVEL control ⑦ to start measurement at desired voltage level. Use PRESET for sine waves.
8. Set CHANNEL A Coupling switch ⑧ to AC or DC; see Specifications in Table 1-3 for details.
9. Set Input Amplifier Control switch ⑨ to SEP.
10. Connect input signal to CHANNEL A input jack ⑩ .
11. Adjust SAMPLE RATE control ⑪ for a convenient interval between measurements.

Figure 3-12. Frequency Measurements

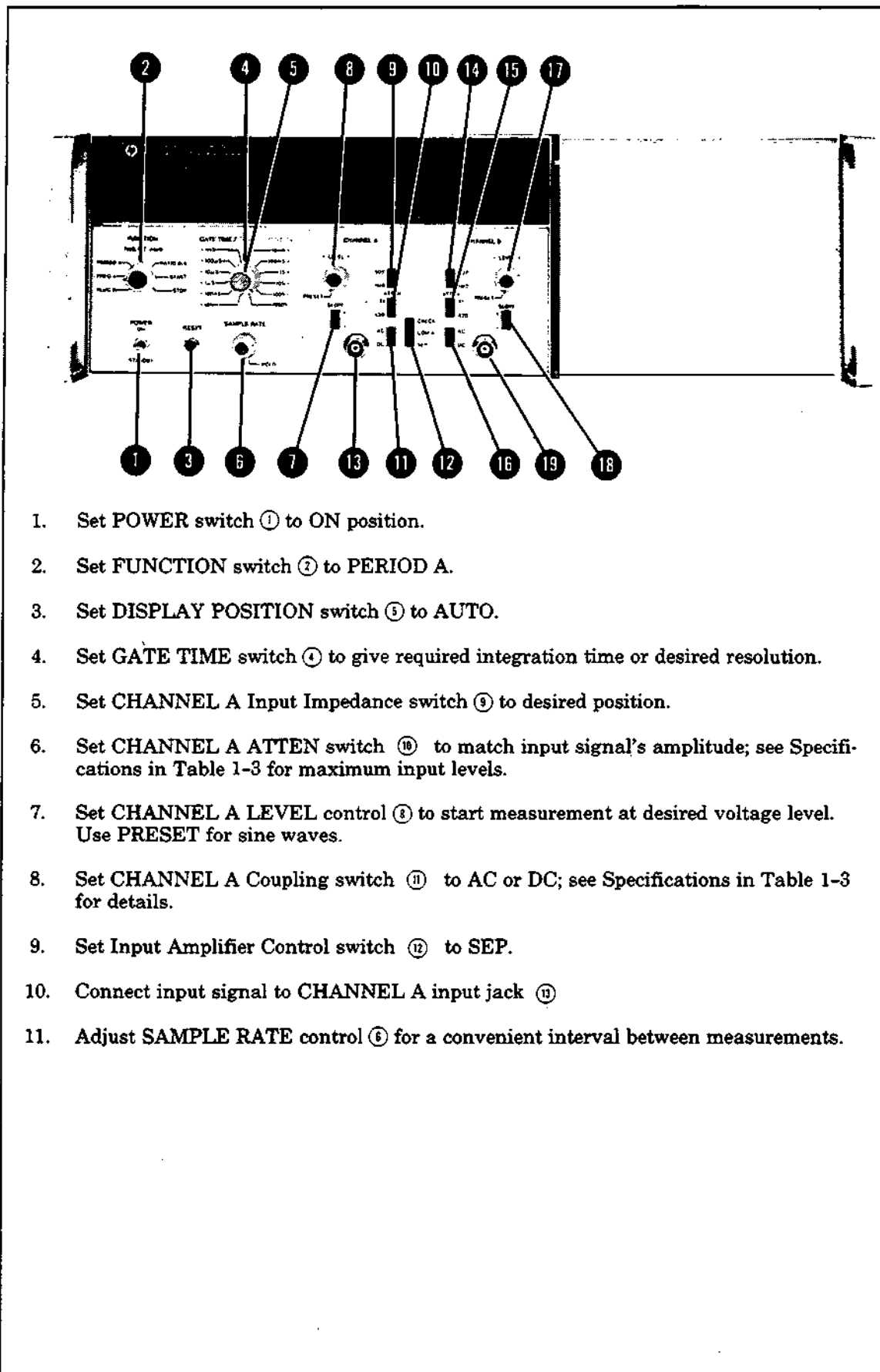
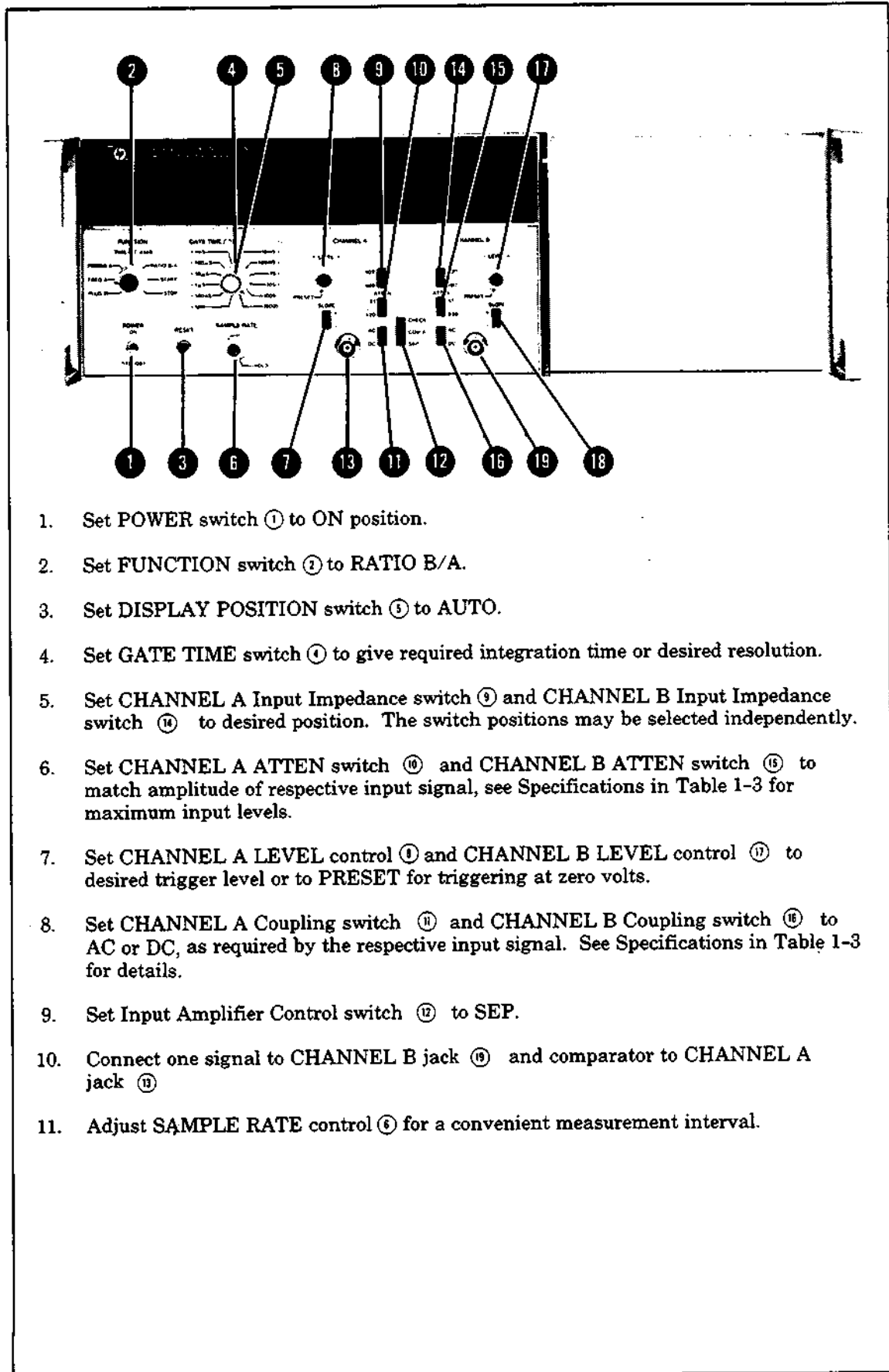
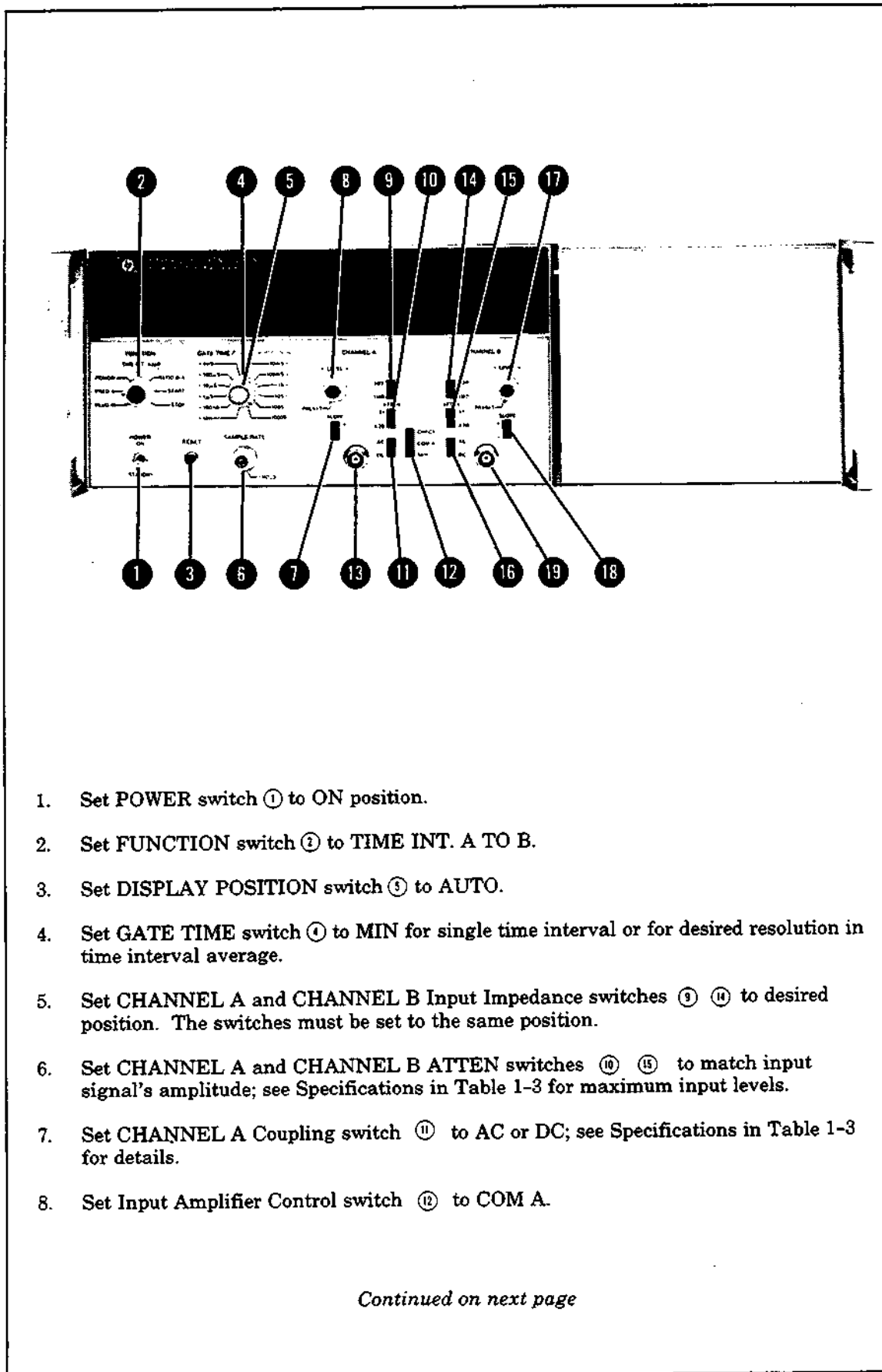


Figure 3-13. Period Measurements



1. Set POWER switch ① to ON position.
2. Set FUNCTION switch ② to RATIO B/A.
3. Set DISPLAY POSITION switch ③ to AUTO.
4. Set GATE TIME switch ④ to give required integration time or desired resolution.
5. Set CHANNEL A Input Impedance switch ⑨ and CHANNEL B Input Impedance switch ⑭ to desired position. The switch positions may be selected independently.
6. Set CHANNEL A ATTEN switch ⑩ and CHANNEL B ATTEN switch ⑮ to match amplitude of respective input signal, see Specifications in Table 1-3 for maximum input levels.
7. Set CHANNEL A LEVEL control ⑦ and CHANNEL B LEVEL control ⑧ to desired trigger level or to PRESET for triggering at zero volts.
8. Set CHANNEL A Coupling switch ⑪ and CHANNEL B Coupling switch ⑫ to AC or DC, as required by the respective input signal. See Specifications in Table 1-3 for details.
9. Set Input Amplifier Control switch ⑬ to SEP.
10. Connect one signal to CHANNEL B jack ⑯ and comparator to CHANNEL A jack ⑰
11. Adjust SAMPLE RATE control ⑥ for a convenient measurement interval.

Figure 3-14. Ratio Measurements



1. Set POWER switch ① to ON position.
2. Set FUNCTION switch ② to TIME INT. A TO B.
3. Set DISPLAY POSITION switch ③ to AUTO.
4. Set GATE TIME switch ④ to MIN for single time interval or for desired resolution in time interval average.
5. Set CHANNEL A and CHANNEL B Input Impedance switches ⑨ ⑩ to desired position. The switches must be set to the same position.
6. Set CHANNEL A and CHANNEL B ATTEN switches ⑬ ⑭ to match input signal's amplitude; see Specifications in Table 1-3 for maximum input levels.
7. Set CHANNEL A Coupling switch ⑪ to AC or DC; see Specifications in Table 1-3 for details.
8. Set Input Amplifier Control switch ⑫ to COM A.

Continued on next page

Figure 3-15. One Source Time Interval Measurements

9. Connect input signal to CHANNEL A jack ⑬
10. Set CHANNEL A SLOPE switch ⑪ to + for triggering on positive slope or - for triggering on negative slope.
11. Set CHANNEL A LEVEL control ⑨ to start measurement at desired voltage level. Use CHAN A TRIG LEVEL output jack on rear panel to display starting point on an oscilloscope (if needed).
12. Set CHANNEL B SLOPE switch ⑫ to + for triggering on positive slope or - for triggering on negative slope.
13. Set CHANNEL B LEVEL control ⑩ to stop measurement at desired voltage level. Use CHAN B TRIG LEVEL output jack on rear panel to display stopping point on an oscilloscope (if needed).
14. Adjust SAMPLE RATE control ⑥ for convenient measurement interval.

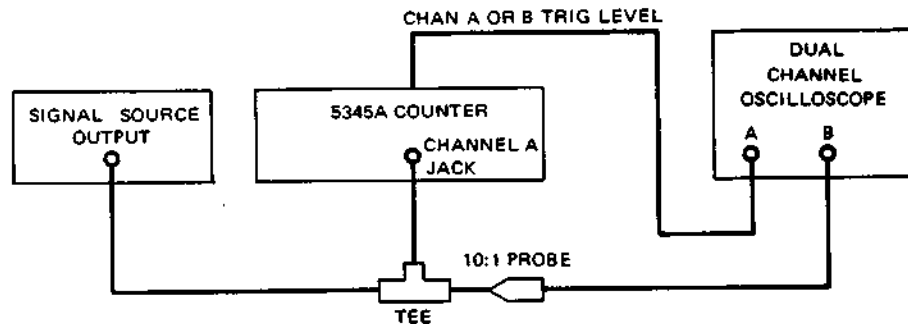
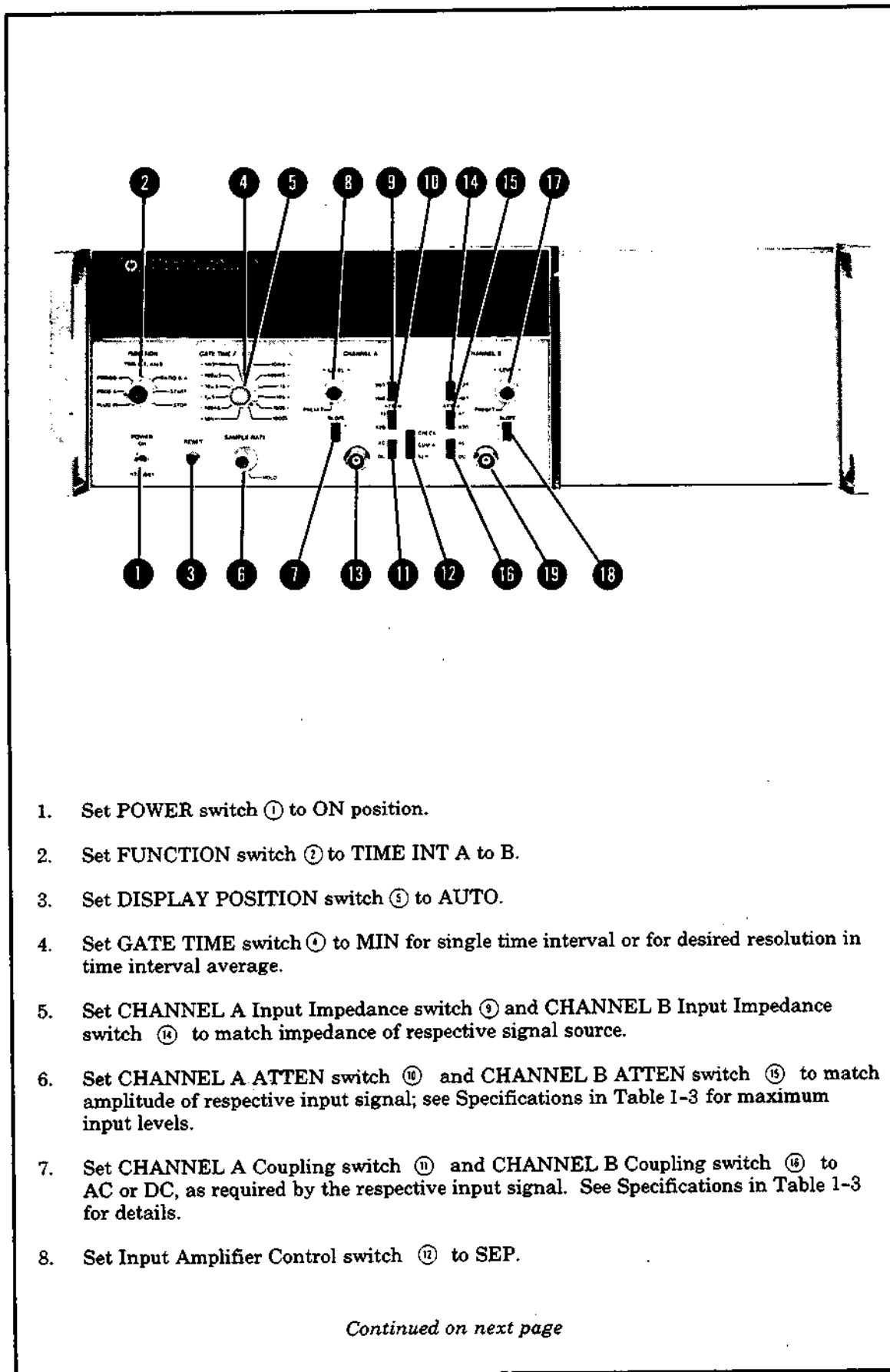


Figure 3-15. One Source Time Interval Measurements (Continued)



1. Set POWER switch ① to ON position.
2. Set FUNCTION switch ② to TIME INT A to B.
3. Set DISPLAY POSITION switch ③ to AUTO.
4. Set GATE TIME switch ④ to MIN for single time interval or for desired resolution in time interval average.
5. Set CHANNEL A Input Impedance switch ⑨ and CHANNEL B Input Impedance switch ⑭ to match impedance of respective signal source.
6. Set CHANNEL A ATTEN switch ⑩ and CHANNEL B ATTEN switch ⑮ to match amplitude of respective input signal; see Specifications in Table 1-3 for maximum input levels.
7. Set CHANNEL A Coupling switch ⑪ and CHANNEL B Coupling switch ⑯ to AC or DC, as required by the respective input signal. See Specifications in Table 1-3 for details.
8. Set Input Amplifier Control switch ⑫ to SEP.

Continued on next page

Figure 3-16. Two Source Time Interval Measurements

9. Connect start signal to CHANNEL A jack ⑮ and stop signal to CHANNEL B jack ⑯.
10. Set CHANNEL A SLOPE switch ⑦ to + for triggering on positive slope or to - for triggering on negative slope.
11. Set CHANNEL A LEVEL control ⑧ to start measurement at desired voltage level. Use CHAN A TRIG LEVEL output jack on rear panel to display starting point on an oscilloscope (if needed).
12. Set CHANNEL B SLOPE switch ⑩ to + for triggering on positive slope or - for triggering on negative slope.
13. Set CHANNEL B LEVEL control ⑪ to stop measurement at desired voltage level. Use CHAN B TRIG LEVEL output jack on rear panel to display stopping point on an oscilloscope (if needed).
14. Adjust SAMPLE RATE control ⑥ for a convenient measurement interval.

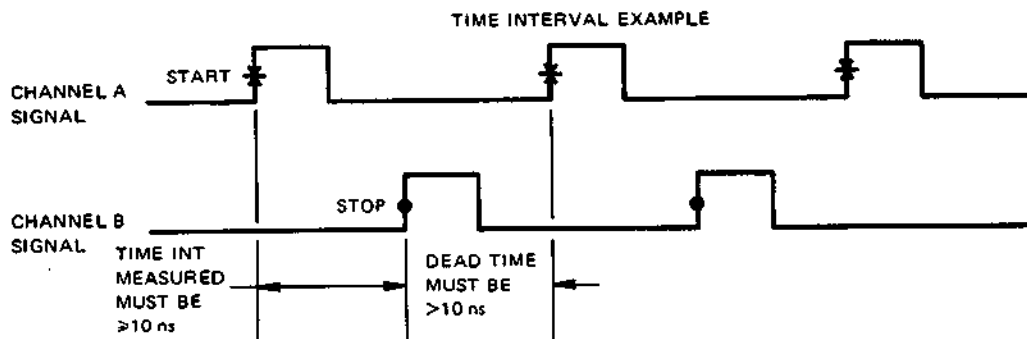
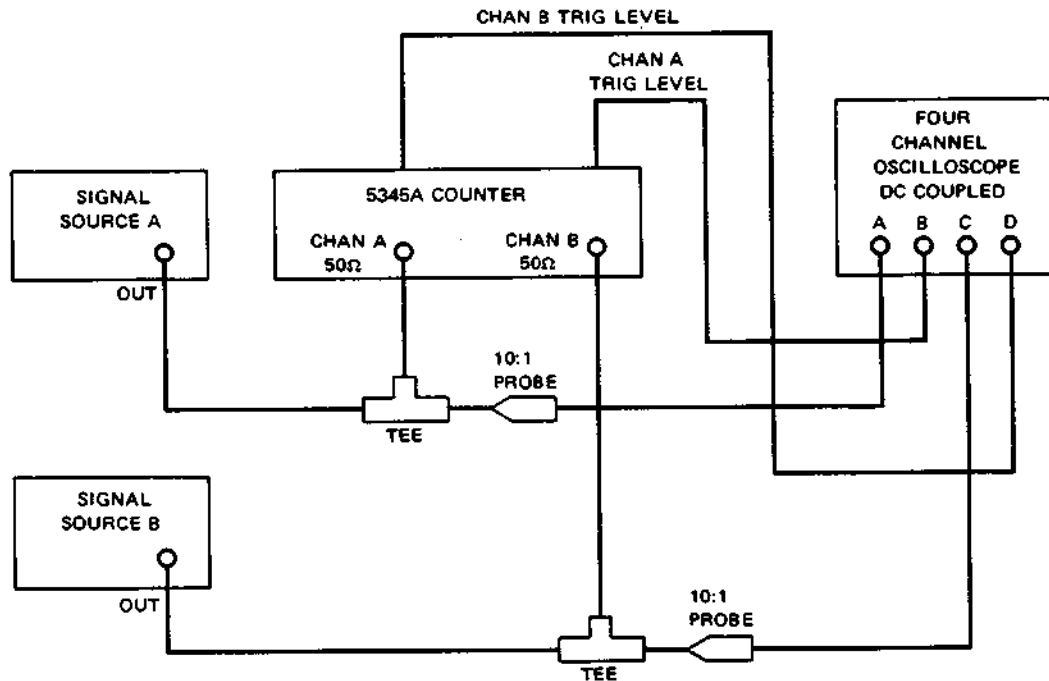
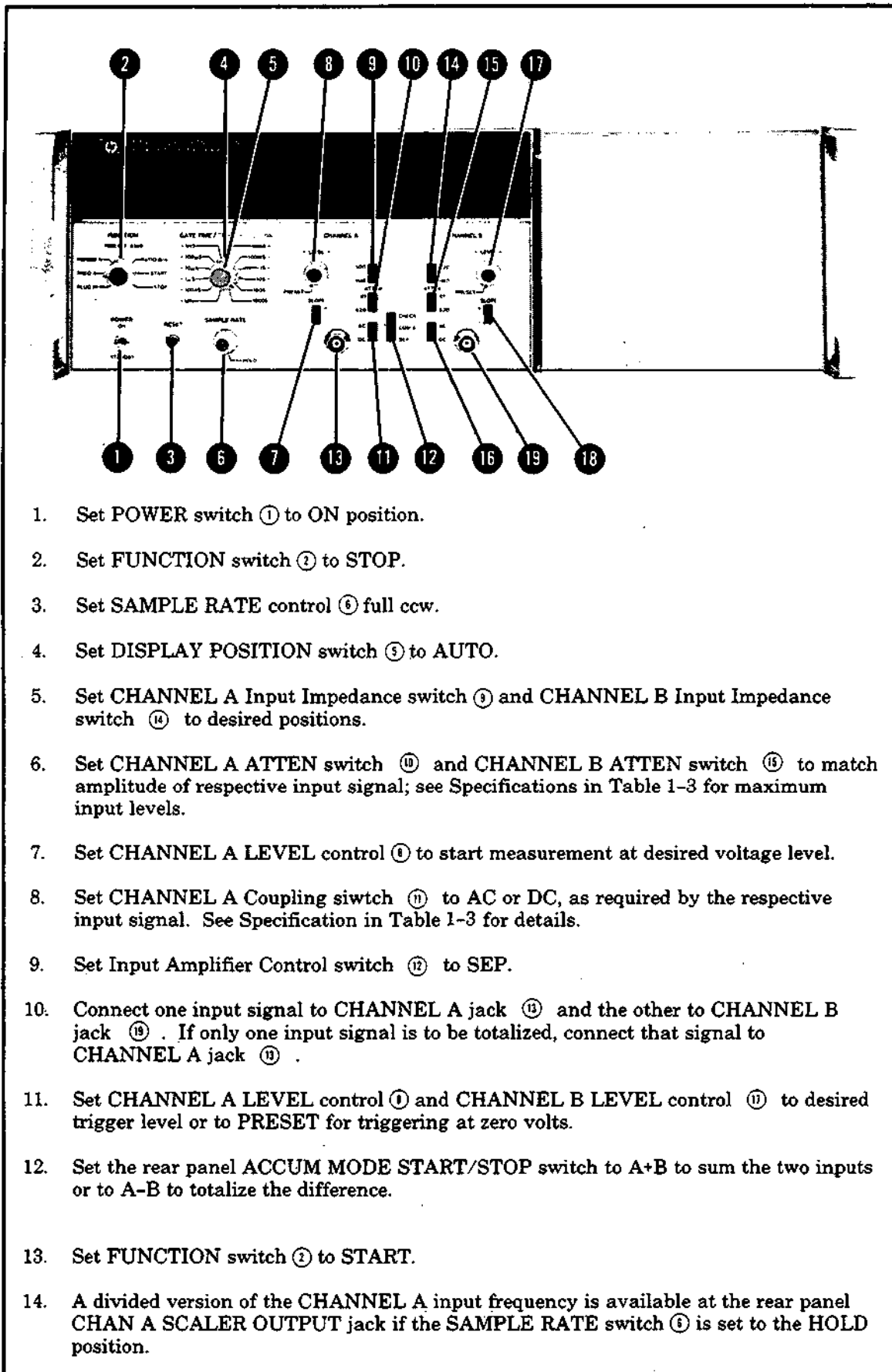


Figure 3-16. Two Source Time Interval Measurements (Continued)



1. Set POWER switch ① to ON position.
2. Set FUNCTION switch ② to STOP.
3. Set SAMPLE RATE control ③ full ccw.
4. Set DISPLAY POSITION switch ④ to AUTO.
5. Set CHANNEL A Input Impedance switch ⑤ and CHANNEL B Input Impedance switch ⑥ to desired positions.
6. Set CHANNEL A ATTEN switch ⑦ and CHANNEL B ATTEN switch ⑧ to match amplitude of respective input signal; see Specifications in Table 1-3 for maximum input levels.
7. Set CHANNEL A LEVEL control ⑨ to start measurement at desired voltage level.
8. Set CHANNEL A Coupling switch ⑩ to AC or DC, as required by the respective input signal. See Specification in Table 1-3 for details.
9. Set Input Amplifier Control switch ⑪ to SEP.
10. Connect one input signal to CHANNEL A jack ⑫ and the other to CHANNEL B jack ⑬. If only one input signal is to be totalized, connect that signal to CHANNEL A jack ⑫.
11. Set CHANNEL A LEVEL control ⑭ and CHANNEL B LEVEL control ⑮ to desired trigger level or to PRESET for triggering at zero volts.
12. Set the rear panel ACCUM MODE START/STOP switch to A+B to sum the two inputs or to A-B to totalize the difference.
13. Set FUNCTION switch ② to START.
14. A divided version of the CHANNEL A input frequency is available at the rear panel CHAN A SCALER OUTPUT jack if the SAMPLE RATE switch ③ is set to the HOLD position.

Figure 3-17. Totalize Measurements

3-70. REMOTE PROGRAMMING VIA THE HEWLETT-PACKARD INTERFACE BUS

3-71. Introduction

3-72. The Hewlett-Packard Interface Bus (HP-IB) is used to transfer data and instrument control instructions between devices. Such devices include measurement instrumentation, programmable signal generators, printers, plotters, and computers to name a few. By connecting these various devices together via the HP-IB, systems ranging from extremely simple to highly complex may be assembled.

3-73. To remotely program the counter efficiently, the operator must be familiar with the selected controller, the configured interface, and the manual operation and functional capabilities of the 5345A. The following HP manuals should provide useful background information:

Hewlett-Packard BASIC 3.0 Interfacing Techniques for HP 9000 Series 200 Computers
Hewlett-Packard Tutorial Description of the Hewlett-Packard Interface Bus

3-74. Interface System Terms

3-75. The following paragraphs define terms and concepts used to describe HB-IB system operations.

- a. **Address:** Each device on the interface is assigned an address. The address is used to specify which device will receive or send information.
- b. **Byte:** A byte is a unit of information consisting of eight binary digits called bits.
- c. **Device:** Any instrument or unit that is HP-IB compatible is called a device.
- d. **Device Independent Command:** A command predefined by the interface standard to have a specified bit pattern, and resulting action.
- e. **Device Dependent Command:** A command that is specific to a particular instrument or family of instruments, which are not predefined by the interface standard. Device dependent commands are usually sent as ASCII strings of characters.
- f. **Polling:** Polling is a process used by a controller to obtain device status information. Polling can be conducted by the controller at any time, however, typically the polling sequence is initiated when a device has requested service. The HP-IB has two types of polling: Parallel Poll and Serial Poll. Parallel Poll is not supported by the 5345A. Serial Poll is only supported by Option 012.
 1. **Parallel Poll:** Parallel Poll is used to simultaneously gather the status of several devices connected to the bus. When the controller executes a Parallel Poll, each device selected sends one bit of (either True or False) status information.
 2. **Serial Poll:** When the controller executes a Serial Poll, the addressed device sends one byte of operational information called a status byte. If the controller has enabled Serial Poll in response to a service request and there is more than one device capable of requesting service, the controller must Serial Poll each device individually to determine which device requested service. When an Option 012 5345A is Serial Polled, its status byte will contain 01000000 (ASCII "I") if it has enabled service request (SRQ), and 00000000 (ASCII "NUL") if it has not enabled SRQ.

Since Option 011 does not respond to Serial Poll, the controller must address each Option 011 counter individually to TALK mode in order to determine which Option 011 5345A requested service. Only the counter with output information will respond. This method may also be used with Option 012.

3-76. HP-IB Description

3-77. The Hewlett-Packard Interface Bus is a high speed parallel interface bus. All devices on the bus are capable of being addressed at one time. However, only one device may respond at a time. The controller is used to address devices, and maintain orderly data flow to and from the devices.

3-78. Each device on the interface may have one or more of the following capabilities: Controller, Talker, or Listener. The controller has the responsibility of controlling interface activity, and must be equipped with

the proper interface module. Controllers transmit all device independent commands to other devices in the interface and usually have Talker and Listener capabilities. Only one device on the interface may be the active controller at any one time. The 5345A Electronic Counter has no controller capabilities.

3-79. The HP-IB system uses a party-line structure (devices share signal lines) on which a maximum of 15 devices (including the controller) may be connected in virtually any configuration desired - as long as there is an uninterrupted path from the controller to every device operating on the bus.

3-80. The bus is made up of 16 signal lines, and 8 ground lines. Of these 16, 8 are data lines, 5 are HP-IB control lines, and 3 are data transfer control lines.

3-81. The eight data lines are used to transfer ASCII data from one instrument to another. These lines are labeled DI01 through D108.

3-82. The five HP-IB control lines are used to maintain an orderly flow of data across the HP-IB. These lines are labeled:

- a. SERVICE REQUEST (SRQ)
- b. REMOTE ENABLE (REN)
- c. INTERFACE CLEAR (IFC)
- d. ATTENTION (ATN)
- e. END OR IDENTIFY (EOI)

3-83. The three transfer control lines are used to transfer each byte of data using what is known as the three-wire handshake. These lines are labeled:

- a. NOT READY FOR DATA (NRFD)
- b. DATA VALID (DAV)
- c. NOT DATA ACCEPTED (NDAC)

3-84. HP-IB Control Lines

- a. SERVICE REQUEST (SRQ)

When a device requires interaction with the controller, it enables the SRQ line which sends a request to the controller for attention. When the controller is ready, it will service the device.

Option 011 and Option 012 enable SRQ if the 5345A output mode is programmed to "WAIT Until Addressed" and a completed measurement is ready for output. Service Request is disabled at all times if the 5345A output mode is programmed to output "ONLY IF Addressed".

- b. REMOTE ENABLE (REN)

- c. The Remote Enable line is used to instruct devices to enter into remote mode and thus, accept data and programming information sent over the HP-IB.

Option 011 responds to the REN signal only if its remote-local storage cell has been properly programmed. The remote-local storage cell has two states: Switch to Local and Switch to Remote. Switch to local is selected by sending the ASCII characters EO. Switch to Remote is selected by sending the ASCII characters E8. The 5345A will enter remote mode if it is programmed for "Switch to Remote" and the REN line is asserted. It will enter local mode (in which the instrument is set by the front panel controls) if the REN line is not asserted or the counter is programmed for "Switch to Local".

Option 012 responds to the REN signal at all times. Thus, if REN is asserted, the 5345A will be in remote mode. If REN is not asserted, the counter will be in local mode.

c. **INTERFACE CLEAR (IFC)**

Only the controller can set the IFC line true. By asserting IFC, all bus activity is unconditionally terminated, and any current talkers and listeners become unaddressed.

Option 011, and Option 012 respond and monitor IFC at all times. When IFC is asserted, the 5345A will immediately stop driving the data and transfer lines. The SRQ line, however, will not be affected by IFC, and thus, will not be cleared if it had previously been asserted by the 5345A.

d. **ATTENTION (ATN)**

The ATN line is used to differentiate between data and bus instructions. If ATN is asserted, information on the data lines should be interpreted as a bus instruction. If ATN is not asserted, information should be interpreted as data.

Option 011, and Option 012 respond and monitor ATN at all times. When ATN is not asserted, the 5345A will output its data if it has been addressed to talk. When ATN is asserted, the 5345A will stop driving the lines and interpret the incoming data as bus commands.

e. **END OR IDENTIFY (EOI)**

Normally, data messages sent over the HP-IB are sent using standard ASCII code and are terminated by the ASCII character LF (line-feed). However, certain devices may wish to send blocks of information that contain data bytes which have the bit pattern of the line-feed character but are actually part of the data message. Thus, no bit pattern can be designated as a terminating character, since it could occur anywhere in the data stream. For this reason, the EOI line is used to mark the end of the data message.

The 5345A does not support the EOI feature.

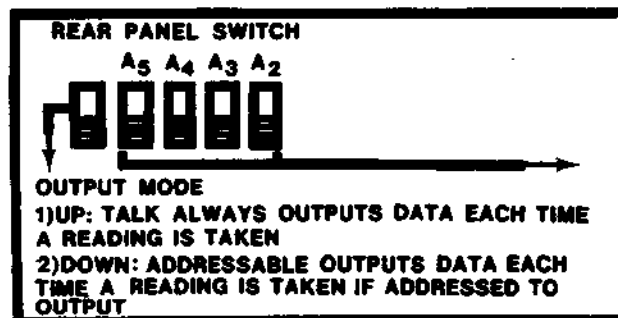
3-85. HP-IB Transfer Control Lines

3-86. The three HP-IB transfer control lines and their interrelationship to each other during the three-wire handshake are as follows.

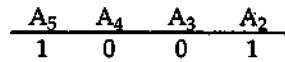
3-87. The transfer of a byte is initiated by the listener. When it is ready to accept data, it sets the Not Ready For Data (NRFD) line false. The talker then senses this condition, places a data byte on the bus, and sets the Data Valid (DAV) line true. When the listener senses DAV is true, it reads the data bus, and sets the Not Data Accepted (NDAC) line false, thus indicating that it has accepted the data byte.

3-88. Address Selection

3-89. Facing the rear panel of the counter, note the five slide switches above the HP-IB connector. The four rightmost switches (A5, A4, A3, A2) determine the counters Listen/Talk address. The far left switch is the Addressable/Talk Only switch. If the 5345A is to be connected to a printer only, with no controller on the bus, then set this switch in the Talk Only (up) position. If the bus has a controller then the 5345A must be able to respond to controller directives, and thus the Addressable/Talk Only switch must be set to the Addressable (down) position.



3-90. Only even addresses may be set on the 5345A, because the A₁ switch is internally wired to the "0" position. However, the address corresponding to the A₁ switch in the "1" position is also used by the 5345A, and thus, to prevent bus conflicts, both even and odd bus addresses must be reserved for the 5345A. The controller is typically set to address 21. Thus, the 5345A cannot be set to address 20, since it also requires address 21, which is already in use by the controller. Addresses 30 and 31 are also not allowed because 31 is reserved for the untalk and unlisten command. The programming examples at the end of this section were written with the counter set to address 18. It is therefore recommended that this address be used. To set the address to 18, position the switches as shown:



3-91. Addressing the 5345A for Talk and Listen

3-92. Addresses are communicated on the data lines. When the controller asserts ATN true, all 5345A's interpret the information on the data lines DI01 through DI05 as an address if during this time, the signal levels on DI07 and DI06 are either "1" and "0", respectively, for a talker; or "0" and "1", respectively, for a listener.

NOTE

When the 5345A is addressed from a listener to a talker or talker to a listener, the appropriate clear codes ("?" or "-") must be issued.

3-93. Output Modes

3-94. The 5345A has two discrete output modes. It has a talk mode and a computer dump mode. The computer dump mode is used when it is desired to output 5345A readings at extremely fast rates or to analyze raw measurement data. The talk mode is used when there is enough time for the 5345A to calculate the measurement, and output the result.

3-95. Computer Dump

3-96. The 5345A will output in computer dump mode if it is addressed to talk, and its talk address is one higher than the address set on the rear panel. Thus, if the rear panel address setting is 18, the computer dump address would be 18+1=19-

3-97. When the 5345A is addressed to output in this mode, it will output the contents of the denominator (events) register and then output the numerator (time) register contents. The processing and display cycles within the 5345A are bypassed with this mode. The sample rate (wait time between measurements) is less than 1 μs in computer dump mode.

NOTE

Computer Dump is not supported when using an Automatic Frequency Converter Plug-In.

3-98. A total of 32 ASCII digits are output in this mode, with no CR (carriage return) or LF (linefeed). Sixteen digits from the denominator (events) register followed by 16 from the numerator (time) are output each time a measurement is taken until the 5345A is unaddressed. The counter outputs from the least to the most significant digits from the denominator, followed with the same order for the numerator. Each count in the time register is equal to 2 ns. For example, three counts in the time register would correspond to 6 ns.

Example:

Denominator Register (events)



Numerator Register (events)



3-99. Talk Output Mode

3-100. When addressed to the Talk output mode, the 5345A sends a space or a minus, up to 11 digits of data, decimal point, the exponent and carriage return linefeed coded in the ASCII format, as shown in Table 3-3.

Table 3-3. Talk Output Format

ORDER OUTPUTTED	CHARACTER	DESCRIPTION
1	() or (-)	Normally a space, minus when B is greater than a in start function
2	0-9	9 to 11 digits may be outputted depending on Gate Time selection, most significant digit first.
3	.	Decimal Point.
4	E	Exponent Multiplier.
5	+ or -	Sign of Exponent Multiplier.
6	0, 3, 6, or 9	Multiplier.
7	CR	Carriage Return.
8	LF	Line Feed (used as a word terminator).

3-101. Programming Commands

3-102. The 5345A has a group of storage cells that are used to store program information. They are used only when a controller has the 5345A operating under remote control. The ASCII characters that can be stored in each cell and their relationship to the 5345A's operation are shown in Table 3-4.

3-103. The program storage cells are loaded with a predetermined set of conditions when either the front panel RESET button is depressed, power is turned on, or the special program code (Remote Program Initialize) I2 is issued. Notice that each time either the RESET pushbutton is depressed, power is turned OFF — then ON, or program code I2 is issued, the 5345A operates according to its front panel controls.

3-104. Program Function Descriptions

- a. Function and Gate — Related directly to the front panel controls. For example, ASCII "F0" and ASCII "G0" select Frequency A function and 1 s gate time, respectively.
- b. Display — The auto position (ASCII "D0") will normally be programmed. This positions the display's least significant digit in the rightmost column with the correct display multiplier automatically selected. Programming the display multiplier is not required in Auto Display. Manual display programming of 0 to 10 digits shifts the decimal point, hence the display, one place left for each programmed code. Manual requires a multiplier suffix to be programmed.
- c. Display Multiplier Suffix — Used only when Manual Display has been programmed. Selects the correct unit of time or frequency.
- d. Reset (I1) — The reset command causes the current measurement cycle to be terminated and a new cycle to begin (i.e., it also acts as a sample trigger). After sending any new programming codes, I1 must terminate the code string to ensure that a measurement cycle has begun using the new codes. If I1 is given when the counter is in the WAIT until addressed mode (E), the counter will immediately go to an output cycle and output all zeros. Only when the output is complete and sample trigger occurs will a new measurement begin. Hence, under these conditions, the first reading into the calculator (consisting of all zeros) must be discarded.

Table 3-4. Program Code Set, Option 011

1. Function	ASCII	7. Output Mode	ASCII		
a. Plug-In	F2	a. ONLY IF Addressed	E2		
b. Frequency A	F0	b. WAIT Until Addressed	E:		
c. Period	F1				
d. Time Interval A to B	F3	8. Display Position			
e. Ratio B/A	F5	(Digits from E in Data String)			
f. Start	F4	(Digit Position Defined from Right to			
g. Stop	F6	Left, Decimal Point on Right Side			
		of Digit)			
2. Accum Mode Start/Stop (If F4 or F6)		a. 0 Digits	D;		
a. A+B	E=	b. 1 Digit	D:		
b. A-B	E5	c. 2 Digits	D9		
		d. 3 Digits	D8		
3. Remote Gating		e. 4 Digits	D?		
a. External Gate	E;	f. 5 Digits	D>		
b. Internal Gate	E3	g. 6 Digits	D=		
		h. 7 Digits	D<		
4. Gate Time		i. 8 Digits	D3		
a. 10000 s	G4	j. 9 Digits	D2		
b. 1000 s	G3	k. 10 Digits	D1		
c. 100 s	G2	l. Auto Position + Auto			
d. 10 s	G1	Suffix Multiplier	D0		
e. 10 s	G0				
f. 100 ms	G?	9. Display Multiplier Suffix			
g. 10 ms	G>	(if other than D0)			
h. 1 ms	G=				
i. 100 μ s	G<				
j. 10 μ s	G;				
k. 1 μ s	G:				
l. 100 ns	G9				
m. Min	G5				
5. Input Amplifier Control		FREQ.	PERIOD		
a. COM A or Separate	E7		TIME		
b. Check	E?		INTERVAL		
			START/		
			RATIO		
			ASCII		
		GHz	ns	G	C7
		MHz	μ s	M	C6
		kHz	ms	k	C5
		Hz	s		C4
		mHz	ks		C3
6. Sample Rate Selection		10. Remote Program	ASCII		
a. Maximum Sample Rate		Initialize	I2		
(~100 ms)	E1E4	Switch to Remote	E8		
b. Minimum Time					
(1-5 ms)	E1E<	11. Local - Remote			
c. HOLD	E9	a. Switch to Local	E0		
		12. Reset Command	I1		
		(End of 100 ms reset pulse			
		initiates measurement cycle)			
		13. Sample Trigger Command			
		(If E9)	J1		

RESET PUSHBUTTON/POWER-UP/I2 PROGRAM conditions are:
F0, G0, D0, E7, E2, E3, E1, E4, E5, E0

- e. Remote Program Initialize Instruction I2 — Sets the remote program storage cells to the initial conditions of instrument power-up or front panel reset. The stored program is F0, G0, E7, E0, E2, E3, E1, E4, E5. They are:

F0 — Frequency A
G0 — 1 s gate time
D0 — Auto display position
E7 — COM A or Separate (depending on front panel position)
E0 — Local operation
E2 — Output only if addressed to talk
E3 — Internal Gate
E1 — Sample rate not hold
E4 — Sample rate = 50 ms time
E5 — A-B Start mode

When taking control of the 5345A it is necessary to change only those storage cells that are different from the above. For example, the 5345A is to be used under remote control for a period measurement at 100 ms gate time it is only necessary to change the ASCII "F0" and "G0" to ASCII "F1" and "G?", respectively.

- f. Input Amplifier Control

1. COM A or Separate (E7) — This programs the position of the COM A and SEP switch on the front panel. Example: If program code E7 is issued and the Input Amplifier Control switch is set to COM A position, COM A will be selected. If, however, the front panel switch was set to SEP, then Separate is selected.
2. Check (E?) — This program selects the front panel check mode. The check mode is always selected regardless of Input Amplifier Control positions.

- g. Local-Remote

1. Local — The 5345A operates according to its front panel controls.
2. Remote — Used in conjunction with the control line REN (Remote Enable) to have the 5345A operate according to the information in its program storage cells.

- h. Output Modes — A 5345A outputs in one of two modes, providing it has been addressed to TALK.

1. ONLY IF addressed (ASCII "E2" stored in the program storage cell). The 5345A will output each measurement if it has been addressed to TALK. If not so addressed, it bypasses the entire output phase of its operating cycle.
2. WAIT until addressed (ASCII "E:" stored in the program storage cell). The 5345A will make a measurement, then wait in the output phase of its operating cycle until it is addressed to TALK. When waiting in the output phase, the 5345A display will be blank. As soon as it is so addressed, it will output and continue according to the information in its program storage cells.

NOTE

The output routine will be bypassed in the WAIT mode (ASCII characters E:) if the bus is in the DATA Mode with no listeners. This is a feature of the 5345A counter which prevents counter hang-up if the HP-IB cable is detached.

Notice that the 5345A ALWAYS outputs when it reaches the output phase of its operating cycle IF it has been addressed to TALK. When programmed ONLY IF, the 5345A continues to go through its operating cycle, bypassing the output phase until addressed to TALK. When programmed to WAIT, the 5345A will stop at its output phase and stay there until addressed to TALK.

- i. Remote Gating
 - 1. External Gate ("E;"), Selects EXT GATE position of Gate Control switch for control of gate circuits.
 - 2. Internal ("E3). Selects INTERNAL position of Gate Control switch, allowing normal operation of the counter.
 - j. Sample Rate Selection — This programmed sample rate determines the "wait time" between measurement. This is the time from the end of processing to the time the counter is armed for the next measurement.
 - 1. Maximum Sample Rate (E1E4). Equivalent to selecting the maximum sample rate with the front panel sample rate control. This results in a wait time of 50 to 100 ms.
 - 2. Minimum Time (E1E<). This results in the fastest repetitive measurement cycles possible since the sample rate portion of the measurement cycle is effectively bypassed. For normal talk mode, the wait time in this mode is $\leq 100 \mu\text{s}$ plus the 1 to 5 ms processing time. For the unprocessed format talk mode (computer dump), the time is $\leq 1 \mu\text{s}$ plus the output time of $107 \mu\text{s}$ into an infinitely fast receiver.
- NOTE**
- In Minimum mode, the counter display will be blank. If E1 has been previously programmed, only E4 or E< must be sent.
- 3. Hold (E9). The counter will wait until a Sample Trigger Command (J1) occurs and then the measurement cycle begins.
- k. ACCUM Mode Start/Stop — Used when totalizing two input signals:
 - 1. A+B (E=). Counts of each channel are added for the total displayed count.
 - 2. A-B (E5). B counts are subtracted from Channel A counts.

3-105. Program Codes and Universal Commands for Option 012

3-106. Tables 3-5 and 3-6 list the universal commands and program codes for Remote Programming of Option 012.

Table 3-5. Universal Command Set, Option 012

ASCII CHARACTER	REMARKS	5345A RESPONSE
SOH	(GTL) Go To Local Included	Causes instrument to return to local if addressed to listen
BS	(GET) Group Execute Trigger	Causes instruments on the bus (that are addressed to listen) to execute their function
DC1	(LLO) (LOCAL Lockout)	Disables the Local pushbutton on the front panel
DC4	(DCL) Device Clear	Causes instrument to reset, same as instruction I1
CAN	(SPE) Serial Poll Enable	Controller places the bus in the serial polling mode
EM	(SPD) Serial Poll Disable	Controls terminates the serial polling mode
?	(UNL) Unlisten	Clears or removes all addressed listeners from the active state of being addressed
— (underscore)	(UNT) Untalk	Underscore is used to clear the addressed talker from the active state of being addressed

Table 3-6. Program Code Set, Option 012

1. Function				ASCII		
a.	Plug-In			F2		
b.	Frequency A			F0		
c.	Period			F1		
d.	Time Interval A to B			F3		
e.	Ratio B/A			F5		
f.	Start			F4		
g.	Stop			F6		
2. Gate Time						
a.	10000 s			G4		
b.	1000 s			G3		
c.	100 s			G2		
d.	10 s			G1		
e.	1 s			G0		
f.	100 ms			G?		
g.	10 ms			G>		
h.	1 ms			G=		
i.	100 μs			G< or G≤*		
j.	10 μs			G;		
k.	1 μs			G:		
l.	100 ns			G9		
m.	Min			G5		
3A. Display Position						
(Digits from E in Data String) (Digit Position Defined from Right to Left, Decimal Point on Right Side of Digit)						
a.	0 Digits			D;		
b.	1 Digit			D:		
c.	2 Digits			D9		
d.	3 Digits			D8		
e.	4 Digits			D?		
f.	5 Digits			D>		
g.	6 Digits			D=		
h.	7 Digits			D<		
i.	8 Digits			D3		
j.	9 Digits			D2		
k.	10 Digits			D1		
l.	Auto Position + Auto Suffix Multiplier			D0		
3B. Display Multiplier Suffix						
FREQ.	PERIOD TIME INTERVAL	START/RATIO	ASCII			
GHz	ns	G	C7			
MHz	μs	M	C6			
kHz	ms	k	C5			
Hz	s		C4			
mHz	ks		C3			
4. Reset						
a.	Machine reset			I1		
b.	Remote Program Initialize			I2		
5. Input Amplifier Control						
a.	COM A or Separate			E7		
b.	Check			E?		
6. Local-Remote				ASCII		
Selects remote upon addressing provided the bus line REN is assertive.						
7. Output Mode						
a.	Output only if addressed to Talk; bypass if not addressed to Talk			E2		
b.	Hold current measurement until addressed to Talk			E:		
NOTE						
The output routine will be bypassed in the wait mode (ASCE:) if the bus is in the DATA Mode with no listeners. This is the result of a 5345A feature which prevents hang-up of the 5345A in the event the HP-IB cable is disconnected.						
8. Remote Gating						
a.	Enable Rear Panel External Gate			E;		
b.	Disable Rear Panel External Gate			E3		
9. Sample Rate						
(Wait Time Between Measurements)						
a.	Not Hold			E1		
1.	Min Time (1-5 ms)			E< or E≤		
2.	~50 ms time (Required for Start Function)			E4		
b.	Hold			E9		
1.	Take a measurement			J1		
10. Accum Mode Start/Stop						
A+B				E=		
A-B				E5		
11. Slope***						
Slope B+				E0**		
Slope B-				E8**		
Slope A+				E6		
Slope A-				E>		
12. Trigger Levels***						
Level A				ADDD		
Level B				BDDD		
D=ASCII Digit 0-9						
NOTE						
On power up, these level are random.						
Trigger Level in Voltage = $\frac{DDD}{250} - 2.000$ for $000 \leq DDD \leq 999$						
AND						
A Chan A:00 = +2.00						
B Chan B:00 = +2.00						
NOTE						
These codes are useful when calibrating the DAC.						
***Codes have different function for Option 011						
***Must be programmed						
RESET PUSHBUTTON/POWER UP/I2 PROGRAM conditions are:						
F0, G0, D0, E7, E2, E3, E1, E4, E5, E0						

3-107. Modes of Operation

3-108. The 5345A has several remote operating modes. They depend on the Sample Rate and Output Modes and the method used to initiate a measurement procedure. This section includes a description of these modes and sample programs.

3-109. The two principal modes of remote operation, based on the Sample Rate Output modes, are described in (a) and (b) below. Modes (c) and (d) are possible by selecting the remaining combinations of the Sample Rate and Output modes.

- a. Sample Rate NOT Hold (E1) and Output ONLY IF E2
 1. If not addressed to talk, the 5345A continuously makes measurements at a rate determined by program codes "E<" or "E4" 1-5 ms or \approx 50 ms, respectively, plus measurement time. It skips the output phase of its operating cycle.
 2. If 5345A is addressed to talk, it no longer skips its output phase. The next and all subsequent measurements are outputted.
- b. Sample Rate Hold (E9) and output mode WAIT until addressed (E:) the 5345A sequence is:
 1. Addressed to LISTEN.
 2. Instructed to make a measurement.
 3. Makes a measurement and stops in its output phase.
 4. Addressed to TALK.
 5. Outputs and stops in its Sample Rate phase.
 6. Addressed to LISTEN.
 7. Instructed to make measurement, then repeats 3 through 6.
- c. Sample Rate NOT Hold (E1) with (E<) or (E4) programmed and WAIT until addressed (E:) the 5345A:
 1. Makes a measurement and stops in its output phase.
 2. Is addressed to TALK.
 3. Outputs, goes through its sample rate and makes another measurement, and if:
 - (a) Still addressed to TALK, it repeats 3.
 - (b) Not addressed to TALK, it stops in its output phase and waits until so addressed, then repeats 3.
- d. Sample Rate Hold (E9) and Output ONLY IF addressed (E2) the 5345A is:
 1. Addressed to LISTEN.
 2. Instructed to make a measurement.
 - (a). Addressed to TALK by the end of the measurement phase, it outputs and stops in the sample rate phase until 1 and 2 are repeated.
 - (b). Not addressed to TALK by the end of the measurement phase, it skips output and stops in the sample rate phase until 1 and 2 are repeated.

3-110. Starting a Measurement Procedure

3-111. When operating the 5345A under remote control, a measurement procedure may be initiated by sending a Reset or Take a Measurement Instruction or by letting the sample rate time run out.

- a. Sample Rate NOT Hold (E1) — a measurement starts at the end of a sample rate time.
- b. Reset Instruction (I1):
 1. Can be given at any time during a 5345A's operating cycle.
 2. Does not change the information in the program storage cells.
 3. Clears the display.
 4. Arms the counter.
 5. Starts measurement phase of the 5345A's operating cycle.
- c. Take a Measurement Instruction (J1):
 1. Can be given only if the 5345A is stopped in the sample rate phase of its operating cycle. If given at any other time it will be ignored by 5345A.
 2. Does not change the information in the program storage cells.
 3. Does not clear the display.
 4. Starts the measurement phase of the 5345A's operating cycle.

3-112. Programming Examples

3-113. The following programming examples are illustrative of HP 5345A programming. The HP 9000 Series 200/300 controller is used and the examples are written in BASIC 5.X.

3-114. Three basic actions must occur to make a measurement and output the results:

- a. The Function (frequency, period, time interval, etc.), gate time, output mode, and other relevant parameters must be specified.
- b. The counter must be triggered to take a measurement. This can be programmed to occur automatically when a signal is present at the input that falls within the trigger level range, or by sending the counter a trigger command.
- c. The measurement data must be removed from the counter and sent to a listening device. In the programming examples that follow, the controller is that device.

3-115. Example Program 1: Triggering a Measurement

3-116. This program demonstrates how to trigger the 5345A to take a frequency measurement when the trigger command "J1" is used and how to output the measurement to the controller.

PROGRAM 1

```
10: OUTPUT 718,"I2E8E9G>I1"  
20: DISP "5345A PROGRAMMED FOR FREQUENCY"  
30: PAUSE  
40: OUTPUT 718;"J1"  
50: DISP "5345A TRIGGERED"  
60: END
```

Program Explanation:

- Line 10: Programs the Counter for power-up conditions: I2 → (Freq A, 1 s Gate, Auto Display, Input Amp to COM A/SEP, switch to Local, output Only if Addressed, Internal Gating, Maximum Sample Rate, Accumulate Mode A-B), E8 → switch to Remote*, E9 → sample rate set to Hold*, G> → 10 ms Gate*, I1 → Reset.
*Overrides condition set by I2.
- Line 20: Displays "5345A PROGRAMMED FOR FREQUENCY".
- Line 30: Suspends program execution until CONTINUE is pressed.
- Line 40: Triggers the 5345A for a measurement.
- Line 50: Displays what occurred in line 40.
- Line 60: Terminates program execution.

Connect a 1 kHz input signal to CHANNEL A of the Counter. Type in Program 1 on the Controller and press RUN.

- a. The 5345A has been programmed for a frequency measurement. The RMT and Hz annunciators will light. The 5345A display will be 0000000000. The controller will display "5345A PROGRAMMED FOR FREQUENCY". Press CONTINUE.
- b. The 5345A GATE lamp will flash on and the display will be approximately 1.000000 kHz (there should be 7 digits displayed). The controller will display "5345A TRIGGERED".

3-117. Example Program 2: Start/Stop Totalize

3-118. After a START command is sent, the HP 5345A can totalize signals applied simultaneously to both Channels A and B. The measured result can be either CHANNEL A plus CHANNEL B (A+B), or CHANNEL A minus CHANNEL B (A-B).

```
                PROGRAM 2
10:  OUTPUT 718,"I2E8E=I1F4"
20:  WAIT 10
30:  OUTPUT 718;"F6"
40:  ENTER 718;X$
50:  PRINT "TOTAL EVENTS A+B=";X$
60:  OUTPUT 718;"E5I1F4"
70:  WAIT 10
80:  OUTPUT 718;"F6"
90:  ENTER 718;Y$
100: PRINT "TOTAL EVENTS A-B=";Y$
110:  END
```

Program Explanation:

- Line 10: Programs the counter for power-up conditions: I2 → described in Program 1 explanation, E8 → switch to Remote, E= → A+B Accumulate Mode, I1 → Reset, F4 → Function set to START, thus opening the gate.
- Line 20: Causes the controller to wait 10 seconds before executing the next program line, and thus allows for a 10-second sample time.
- Line 30: Programs the counter function to STOP, thus closing the gate.
- Line 40: Reads data from the 5345A into the controller into the variable X.
- Line 50: The controller displays the result of the A+B totalize measurement.
- Line 60: Programs the counter for the following conditions: E5 → A-B Accumulate Mode, I1 → Reset, F4 → Function set to START, thus opening the gate.
- Line 70: Causes the controller to wait 10 seconds before executing the next program line, and thus allows for a 10-second sample time.
- Line 80: Programs the Counter function to STOP.
- Line 90: Reads the data from the 5345A into the controller into the variable Y.
- Line 100: The controller displays the results of the totalize measurement.
- Line 110: Terminates program execution.

Connect the signal generator as in Program 1. Type in Program 2 and press RUN.

- a. The Counter will commence totalizing. The GATE and RMT annunciators will light. The counter will display the current event count, and when it exceeds 1000 events, the k annunciator will light. After approximately 10 seconds the counter is programmed to stop and the controller will read the 5345A data and display (A+B) followed by the sum of the events into CHANNEL A plus the events into CHANNEL B which should be in the neighborhood of 20,000 events.
- b. After displaying A+B the controller will continue the program and the 5345A will again start totalizing. After approximately 10 seconds the counter will stop totalizing and the controller will display A-B. Both Channel A and B have the same input signal applied, therefore, A-B should be approximately zero.

The SEP/COM A/CHECK switch can be set to SEP. Under this setting CHANNEL B has no input signal applied, therefore, A+B will be approximately the same as A-B.

3-119. Example Program 3: Frequency Averaging Using External Gate

3-120. Frequency averaging is a measurement technique whereby the input signal is sampled over multiple external gates and an average frequency is computed. The number of samples taken equals the front panel Gate Time divided by the External Gate Time. The advantage of frequency averaging is that the 5345A can provide improved resolution and accuracy in cases where the input signal burst width is so small that very few digits of display would be possible if no averaging were performed. Using the technique may be the difference between obtaining a meaningful or useless frequency measurement.

```

PROGRAM 3
10:  IMAGE 4X,MD.4DE,"Hz"
20:  OUTPUT 718,"I2E8E;I1"
30:  DISP "SAMPLE SIZE = 1 SEC. PER EXT. GATE"
40:  WAIT 3
50:  ENTER 718;D
60:  ENTER 718;A
70:  PRINT "FREQUENCY AVERAGE:"
80:  PRINT USING 10;A
90:  END
    
```

- Line 10: Defines format to be display the frequency measurement on the controller: 4X → 4 Blank Characters, M → Sign Digit, D → specifies 4 Digit Positions Right of the Decimal Point, E → specifies Scientific notation.
- Line 20: Programs the counter for power-up conditions: I2 → described in Program 1 explanation, E8 → switch to Remote, E: → External Gating, I1 → Reset
- Line 30: The controller will display "SAMPLE SIZE = 1 SEC. PER EXT. GATE".
- Line 40: Causes the controller to wait 3 seconds before executing the next program line.
- Line 50: Reads the data from the 5345A buffer register into the variable D (dummy). The reset command (I1) in line 20 clears the 5345A buffer register. Line 50 clears the buffer register for a legitimate reading (Line 60).
- Line 60: Reads the data from the 5345A buffer register into variable A. This variable contains the actual measurement value.
- Line 70: The computer will display "FREQUENCY AVERAGE:"
- Line 80: Programs the CRT to display the measurement (variable A) according to the format specified in Line 10.
- Line 90: Terminate program execution.

With the 1 kHz signal still applied, connect an external gate signal with an amplitude of 0 to -1 volts and a pulse width of 1 ms to the EXT GATE BNC on the rear panel of the 5345A. Set the GATE CONTROL INPUT switch to EXT GATE. Apply the input signal to CHANNEL A of the 5345A. Type in the program and press RUN.

- a. The counter is programmed for a frequency measurement using an external gate. The RMT and GATE annunciators will light and the display will be all zeros until the measurement is made. The controller will display "SAMPLE SIZE = 1 SEC. PER EXT. GATE" for about 3 seconds. For this particular case, sample size is average of 1000 samples.
- b. Upon completion of the measurement by the 5345A, the computer will read the data and display "FREQUENCY AVERAGE: followed by the frequency measurement.

3-121. Example Program 4: Computer Dump Mode

3-122. This program demonstrates the ability of the 5345A to output raw measurement data to the controller for analysis. One advantage of this mode is that most computers can perform the math (normally done by the 5345A) much faster. Another advantage is that the math can be calculated after all of the measurements have been taken, so that minimal time is lost between measurements. This allows an increase in speed over the standard output format.

DENOMINATOR (TIME)		NUMERATOR (EVENT)	
LSD	MSD	LSD	MSD
1600100000000000	0000000000	5030500000000000	0000000000
1st IN		LAST OUT	

The contents of the two 16-digit registers are output in Reverse order as a 32-digit string to the string variable B\$. Thus, the order must be reversed, and the first 16 digits (TIME) must be separated from the second 16 digits (EVENT):

DENOMINATOR (TIME)		NUMERATOR (EVENT)	
LSD	MSD	LSD	MSD
000000000000050305	0000000000	50000000000010016	0000000000
1st IN		LAST OUT	

To calculate a frequency measurement:

$$\frac{(\text{EVENT})}{(\text{TIME}) * (2\text{ns})}$$

2ns time is the time equivalent for each count recorded in the TIME register. That is, the TIME register is incremented every 2 ns. Thus, if the TIME register contained a count of 5, the actual time would be ((5 * 2.E-9) = 10 ns.

```

PROGRAM 4
10: OPTION BASE 1
20: DIM B$(32000)
30: INPUT "HOW MANY MEASUREMENTS?";N
40: OUTPUT 718; "I2G5E8E1E<E11"
50: ENTER 719 USING "#,"&VAL$(N*32)&"A";B$
60: PRINT USING "5X,K,13X,K,11X,K","TIME","EVENTS","FREQ"
70: B$=REV$(B$)
80: FOR I=0 TO N-1
90:   Con=32*I
100:  Num$=B$(Con+1,Con+16)
110:  Den$=B$(Con+17,Con+32)
120:  Time=VAL(Num$)
130:  Event=VAL(Den$)
140:  Freq=Event/(Time*2.E-9)
150:  PRINT USING "16A,X,16A,X,K";Num$,Den$,Freq
160: NEXT I
170: END

```

Program Explanation:

- Line 10: Specifies lower bound of arrays as 1 rather than 0.
- Line 20: Dimensions the string variable B\$ 32,000 characters wide.
- Line 30: Reads into N the number of measurements to be made.
- Line 40: Programs the counter for power-up conditions: I2 → described in program example 1, G5 → Gate Time set to Minimum, E8 → switch to Remote, I1 → Reset.
- Line 50: Reads the measurement into the string variable B\$. Note that address 719 specifies computer dump output from the 5345A.
- Line 60: Displays a title for the measurement table.
- Line 70: Reverses the order of the characters in the string variable B\$.
- Line 80: Sets up a loop for computing the result of each measurement.
- Line 90: Defines the value for the variable Con. Con is used to locate the appropriate substring of B\$.
- Line 100: Copies the first 16 digits of B\$ into Num\$ (numerator).
- Line 110: Copies the last 16 digits of B\$ into Den\$ (denominator).
- Line 120: Converts the string NUM\$ into a numeric quantity and stores it into the variable time.
- Line 130: Converts the string Den\$ into a numeric quantity and stores it into the variable event.
- Line 140: Calculates the measured frequency.
- Line 150: Displays the computer dump data and the calculated frequency.
- Line 160: Returns program control to line 80 to compute the next measurement.
- Line 170: Terminates program execution.

Set the input signal to a desired frequency and press RUN. When the display reads "HOW MANY MEASUREMENTS?" enter the desired number and press ENTER. The measurement values will be displayed.

3-123. Option 012 Remote Programming

3-124. Option 012 provides all the features of Option 011, plus remote programming of the input amplifier's slope and level controls. Option 012 also uses several universal commands, and responds and identifies to serial polling.

3-125. Option 012 has two ^{ADP/A} ~~AD/D~~ converters that permit the reference voltage presented to the input amplifiers to be controlled in 4 mV steps from -2.0V to +2.0V.

NOTE

Trigger level range is linear from -2.0V to +2.0V with 4 mV resolution.

3-126. Features

3-127. The following are special operating features of Option 012:

- a. Slope Control. The slope can be controlled externally.
- b. Trigger Levels. The trigger levels are set sending a channel select code and three bits as:

ADDD
or
BDDD

- 1. The actual trigger level will be:

$$\frac{DDD}{250} - 2.000 \text{ volts}$$

- 2. There is no defined power-up state for the trigger levels.
- 3. Trigger levels stabilize only when the last character is received from the bus.
- 4. Trigger level DAC's can be adjusted according to the procedure outlined in Table 5-6.
- 5. A RESET code command (I1) should be sent to the counter after setting the DAC levels to prevent miscounts.

3-128. Special Programming Considerations (not in Option 011)

3-129. The following programming features must be considered when using Option 012:

- a. SRQ Identified Serially.
- b. Slope Controlled (must be Programmed).
- c. Levels Controlled (must be Programmed).
- d. LLO (Local-Lockout) Universal
- e. GTL (Go to local) Universal Addressed.
- f. DCL (Device Clear) Universal.
- g. GET (Trigger) Universal Addressed.
- h. All other codes are the same, except E0 and E8 which have different functions for Option 011.
- i. Goes to Remote anytime the counter is addressed to listen.
 1. Counter should be RESET with I1 command anytime a program code is sent to the counter. The I1 command should be the last command sent, so as to prevent miscounts.
 2. Slope and Trigger Level codes should be sent to the counter when first programming the counter after a power-up of the counter.
 3. Manual Trigger Level controls should be set to PRESET position when in REMOTE control to prevent interference to the remote levels.

3-130. Examples of Programming (Option 012) only

3-131. The following programming example illustrates the added features and requirements of Option 012.

3-132. Example Program: Time Interval Measurements of Pulse Width

3-133. This program demonstrates the Analysis Capabilities of the 5345A. The counter is programmed to measure the width of the positive-going pulse, then the width of the negative-going pulse. With this data, the Duty Cycle is calculated.

```
PROGRAM 5
10: OUTPUT 718,"I2E6E8A750B750E7G5F3I1"
20: ENTER 718;D
30: ENTER Y18;A
40: OUTPUT 718;"E>E0"
50: ENTER 718;Y
60: PRINT USING"2X,K,10X,K";"POSITIVE","NEGATIVE"
70: PRINT USING "3X,K,13X,K,9X,K";"PULSE","PULSE","DUTY"
80: PRINT USING "3X,K,13X,K,9X,K";"WIDTH","WIDTH","CYCLE"
90: PRINT
100: PRINT USING "MD.4DE,K,4X,MD.4DE,K,3X,MDD.3D,K";A,"S",Y,"S", (A/(A+Y))*100,"%"
110: END
```

Program Explanation:

- Line 10: Programs the Counter for Power-up conditions: I2→ described in Program 1 explanation, E6→ Channel A set to trigger on positive slope, E8→ Channel B set to trigger on negative slope, A750 → Channel A Trigger level set to 1V, B750 → Channel B Trigger level set to 1V, E7→ Input Amp set to COM A/SEP, G5→ Gate Time set to Minimum, F3→ Function set to Time Interval A to B, I1 → Reset.
- Line 20: Reads the data from the 5345A buffer register into the variable D (dummy). The reset command (I1) in line 10 clears the 5345A buffer register. Line 50 clears the 5345A buffer register for a legitimate reading (Line 30).
- Line 30: Reads the positive pulse width measurement into the variable A.
- Line 40: Programs the Counter to measure negative slope: E> → Channel A set to trigger on negative slope, E0 → Channel B set to trigger on positive slope.
- Line 50: Reads the negative pulse width measurement into the variable Y.
- Line 60: Prints the first title line for the measurement table.
- Line 70: Prints the second title line for the measurement table.
- Line 80: Prints the third title line for the measurement table.
- Line 90: Prints a blank line.
- Line 100: Displays the positive and negative pulse widths and the calculated percent duty cycle.
- Line 110: Terminates program execution.

SECTION IV THEORY OF OPERATION

4-1. INTRODUCTION

4-2. This section describes the individual logic elements, overall counter operation, and theory of operation for each printed circuit assembly. The overall counter theory starts in Paragraph 4-44. The theory for each pc board starts in Paragraph 4-71.

4-3. LOGIC ELEMENTS

4-4. Two states exist in the binary system, 1 and 0. HIGH (H) and LOW (L) are used to represent the levels of 1 and 0. HIGH always represents the more positive level, whether it be positive or negative logic. Figure 4-1 shows four pairs of logic symbols that have the same truth tables and can be used interchangeably. The same function is performed by what appears to be two different logic symbols.

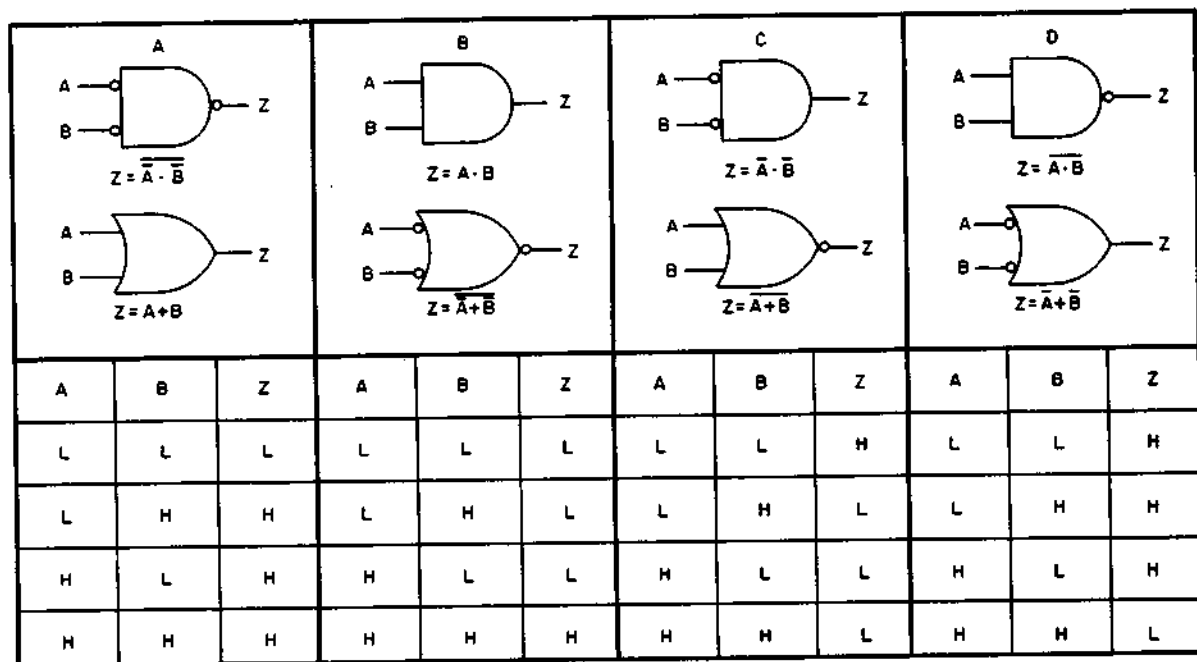


Figure 4-1. Logic Comparison Diagrams

4-5. Logic Levels

4-6. This instrument uses three types of logic. They are:

1. Transistor-Transistor Logic (TTL)
2. Emitter-Coupled Logic (ECL)
3. Emitter-Emitter-Coupled Logic (EECL).

Digital signals have two logic states, referred to as High and Low. The voltage associated with the High or Low state is different for each logic type.

LOGIC STATE	TTL	ECL	EECL
Low	0 to +0.4V	approximately -1.5V	approximately -0.6V
High	2.4 to 5V	approximately -0.8V	approximately 0V

4-7. Wire-OR/Wire-AND Configuration

4-8. The wire-AND configuration applies to TTL type logic. (It may be commonly referred to as wire-OR.) In TTL, the output of an open-collector gate (one having no load resistor) can be paralleled with gates of the same type to perform this function. When the outputs are tied to the same line, any one of the gates can pull the line Low (.7V) without damaging itself. An external pull-up resistor is required.

4-9. The wire-OR configuration applies to ECL type logic. With ECL, an external resistor is not necessarily required. As with TTL, the gate outputs are connected together. In this case, however, any one of the gates can force the line High (-.7V).

4-10. Exclusive OR Gate

4-11. The output of the exclusive OR will be High if one, but not both, of the inputs is High. This can be seen in the truth table in Figure 4-2.

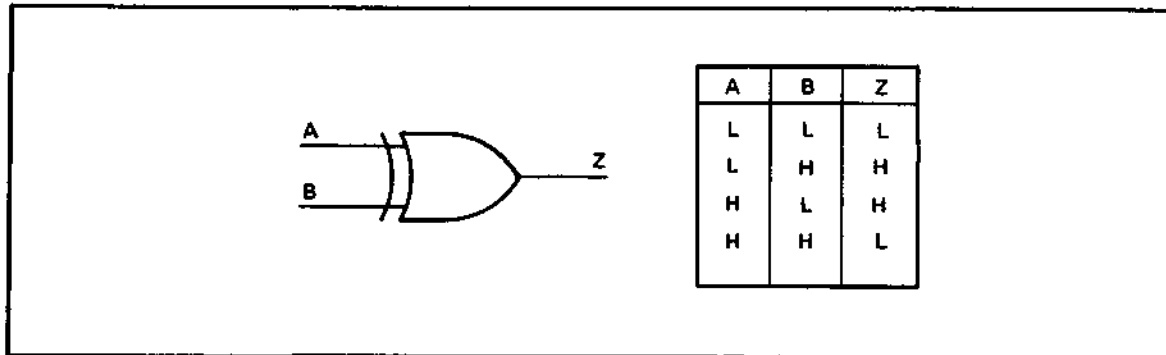


Figure 4-2. Exclusive OR Gate

4-12. INTEGRATED CIRCUITS — THEORY OF OPERATION

4-13. Much of the circuitry used in this instrument is comprised of common logic elements: AND gates, D-Type flip-flops, JK's, etc. Other circuits may use devices that are not as familiar as those mentioned. The following paragraphs briefly describe the operation of these devices. Notice that these devices are shown functionally; i.e., they attempt to best describe the operation of the device and may not reflect the nomenclature used by the manufacturer.

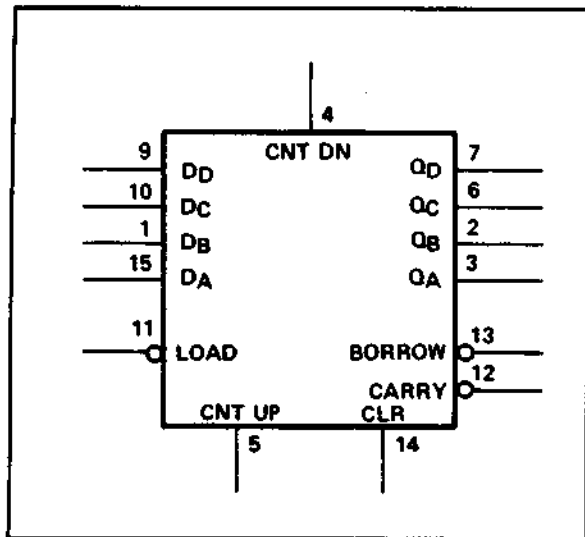


Figure 4-3. Synchronous 4-Bit Up/Down Counter, 1820-0233

4-14. Synchronous 4-Bit Up/Down Counter, 1820-0233

4-15. All four counters are fully programmable; that is, the outputs may be preset to any state by entering the desired data on the data inputs while the LOAD input is Low. The output will change to agree with the data inputs. Once the Load condition is removed, the outputs can count down with each positive pulse on CNT DN or count up with each positive pulse on CNT UP. A High level on the CLR input forces all outputs Low. Borrow goes Low with an underflow condition, while CARRY goes Low with an overflow condition.

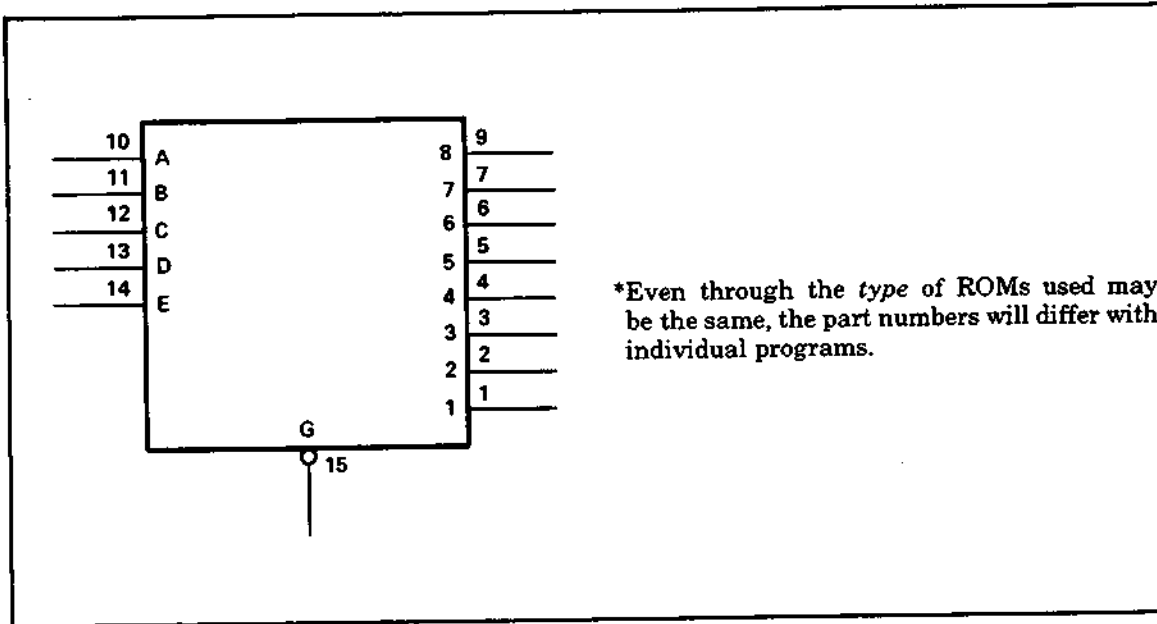


Figure 4-4. Read-Only Memory (ROM) 1820-0254*

4-16. Read-Only Memory (ROM) 1820-0254*

4-17. This device is a programmed, addressable memory. There are 32 storage locations, each of which is capable of storing an 8-bit character. The contents in each location is fixed. The contents of a location are placed on the output lines when the gate (G) is low and the location has been addressed with the proper input code (A,B,C,D,E lines).

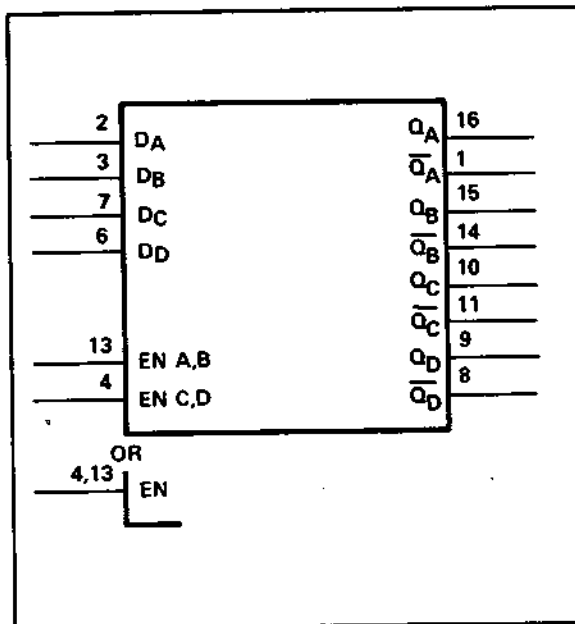


Figure 4-5. 4-Bit Bistable Latch 1820-0301

4-18. 4-Bit Bistable Latch 1820-0301

4-19. Information present at a data (D) input is transferred to the respective Q output when the enable line is High. The Q output will follow the data input as long as the enable line remains High. When the enable line goes Low, the information currently on the D inputs is retained (latched) on the Q output until the enable line returns High.

*Even though the type of ROMs used may be the same, the part numbers will differ with individual programs.

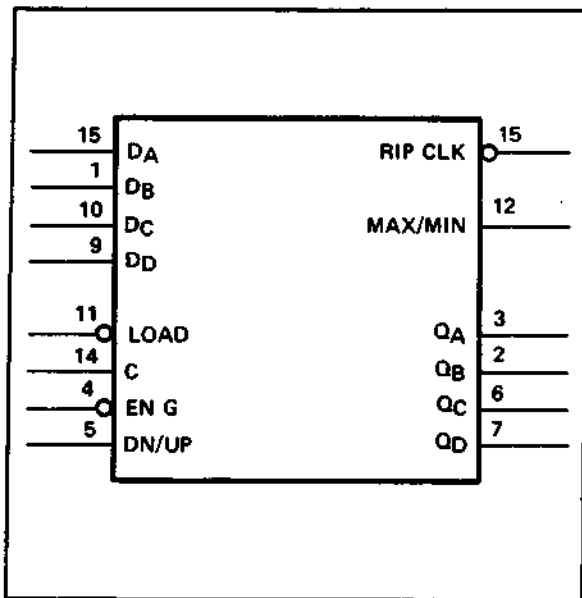


Figure 4-6. Synchronous Up/Down Counter 1820-0545

4-20. Synchronous Up/Down Counter 1820-0545

4-21. A Low on the EN G line enables the operation of this binary counter. While the LOAD input is Low, the counter can be preset to any number from 0 to 15. The Q outputs assume this number, and counting begins from that point. The state of DN/UP determines the direction of counting. If DN/UP is High, the counter counts down, when Low, it counts up. The MAX/MIN output produces a High level output pulse with a duration approximately equal to one complete cycle of the clock when the counter overflows or underflows. The RIP CLK output produces a Low-level pulse equal in width to the low-level portion of the clock input when an overflow or underflow condition exists.

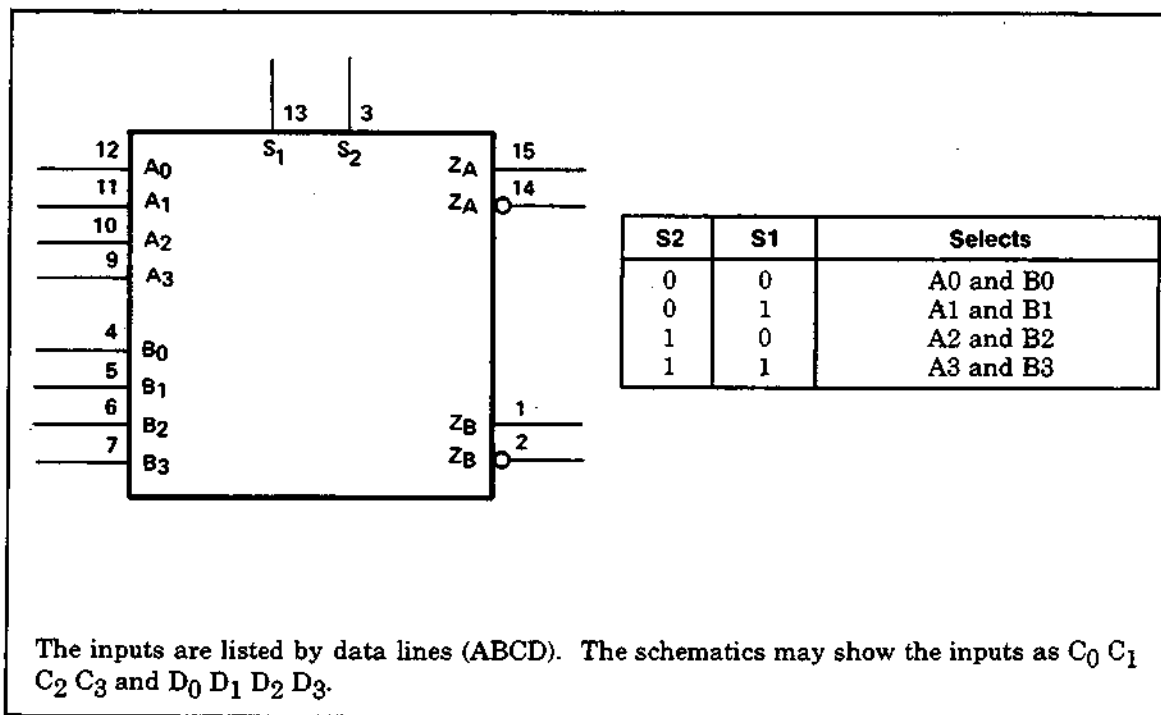


Figure 4-7. Dual Four-Input Multiplexer 1820-0610

4-22. Dual Four-Input Multiplexer 1820-0610

4-23. This multiplexer selects one line from the four A inputs and one line from the four B inputs and transfers that data to the respective Z outputs. Each Z output (A or B) has an inverted and a noninverted line. The inputs to be transferred are selected by the code present on S1 and S2, as shown in the truth table of Figure 4-7.

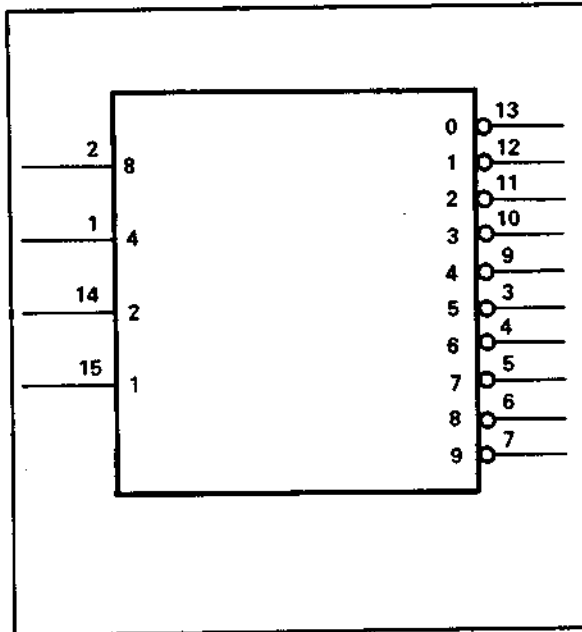


Figure 4-8. One-of-Ten Decoder 1820-0627

4-24. One-of-Ten Decoder 1820-0627

4-25. This IC converts a BCD code to a decimal equivalent. A code on the input lines (8,4,2,1) causes one of the output lines to Low. For example, a code of seven ($\frac{0111}{0111}$) pulls the "7" line Low.

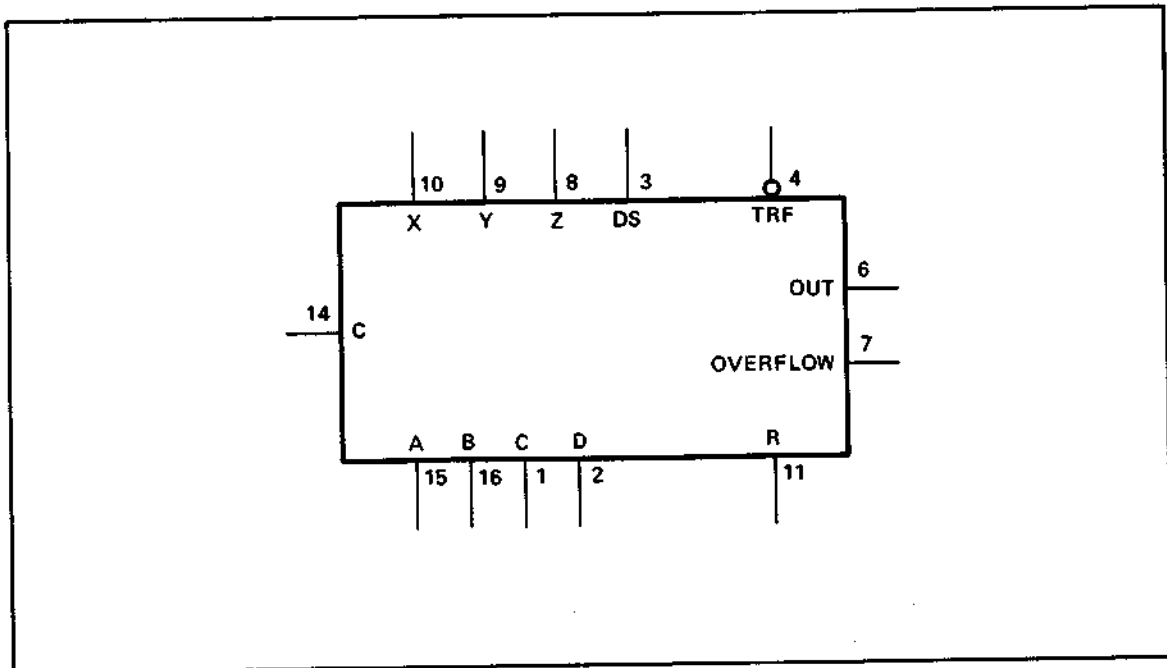


Figure 4-9. MOS Six Decade Counter 1820-0634

4-26. MOS Six Decade Counter 1820-0634

4-27. This is a 6-digit, ripple-through counter with buffer storage outputs for each decade. The circuit has one set of BCD outputs (ABCD) that may be switched from digit to digit, as determined by a decade select code (XYZ). For the counting operation, the device will advance its count on the positive going edge of the clock input (C). While counting is in progress, the decimal count of a selected decade (by means of XYZ lines) is transferred to the BCD outputs when the TRF line is held Low. The decade contents can be "scanned" and transmitted to the BCD outputs by sequentially changing the XYZ code. The High logic level is $>3.4V$ for all inputs.

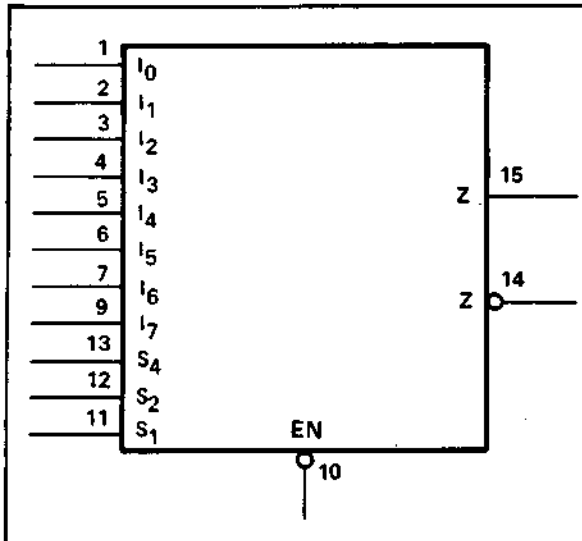


Figure 4-10. Eight-Input Multiplexer 1820-0658

4-28. Eight-Input Multiplexer 1820-0658

4-29. A Low on the EN line enables the operation of this multiplexer. A code on the select lines (S4, S2, S1) selects the corresponding input to transfer its data to the Z outputs. For example, a code of $(\begin{smallmatrix} S4 \\ 0 \\ S2 \\ 1 \\ S1 \\ 1 \end{smallmatrix})$ selects the I3 line, and the Z output (noninverted) assumes the state of I3.

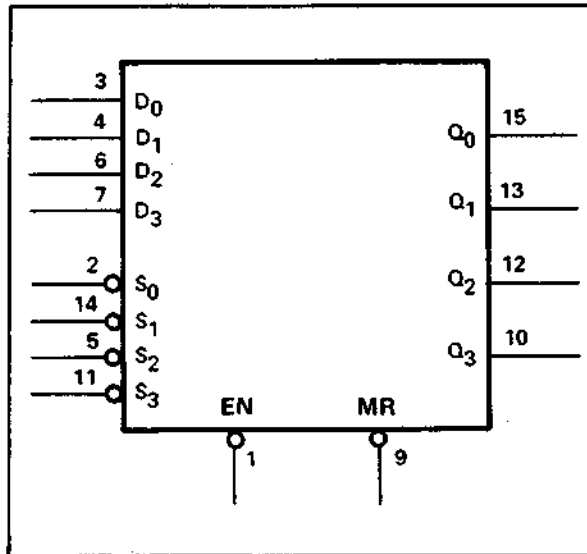


Figure 4-11. Quad Latch 1820-0701

4-30. Quad Latch 1820-0701

4-31. Information present at a data (D) input is transferred to the respective Q output when the enable line is Low and when the respective select (S) line is Low. The Q output will follow the data input as long as EN remains Low. When EN goes High the data currently on the D inputs is retained (latched) on the Q output until EN returns Low or the latch is reset (MR=Low). When the latch is reset, the Q outputs go Low.

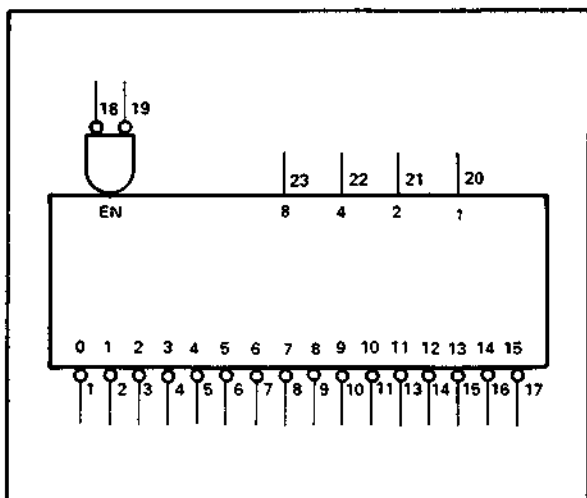


Figure 4-12. One-of-Sixteen Decoder 1820-0702

4-32. One-of-Sixteen Decoder 1820-0702

4-33. This IC converts a binary code to a decimal equivalent. When the device is enabled with two-low levels (pins 18 and 19), a code on the input lines (8,4,2,1) will pull one of the output lines Low. For example, a code of $12(\begin{smallmatrix} 8 \\ 1 \\ 4 \\ 2 \\ 1 \end{smallmatrix})$ pulls the "12" line Low.

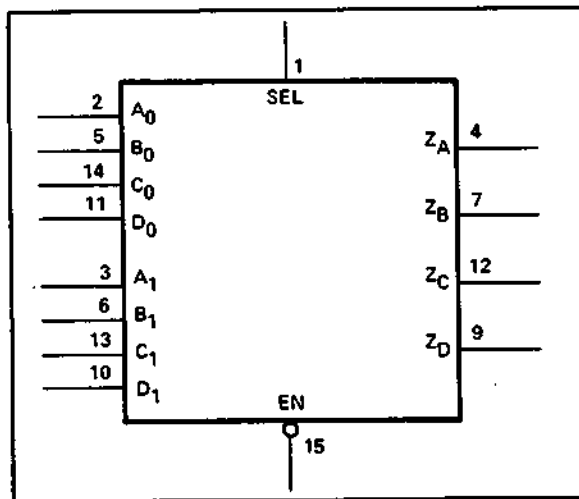


Figure 4-13. Quad Two-Input Multiplexer 1820-0710

4-34. Quad Two-Input Multiplexer 1820-0710

4-35. With the enable (EN) line Low, the multiplexer is enabled to transfer the data inputs (ABCD) directly to the output lines (Z). When SEL is a "0" (Low) the $A_0B_0C_0D_0$ inputs are selected; while the $A_1B_1C_1D_1$ inputs are selected with a "1" (High) on the SEL line.

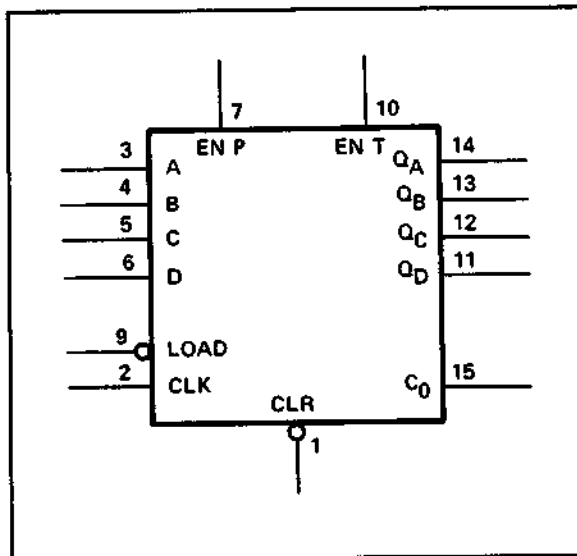


Figure 4-14. Synchronous 4-Bit Counter 1820-0716

4-36. Synchronous 4-Bit Counter 1820-0716

4-37. The two enable lines (EN P and EN T) must be High before the device can count. Each positive edge of the clock pulse advances the binary count on the Q outputs. The carry output (CO) goes High when the output reaches a count of 15 (a total of 16 clock pulses). The count can be preset to start counting from a given number. This is done by pulling the LOAD line Low and entering the desired number on the input lines (A,B,C,D).

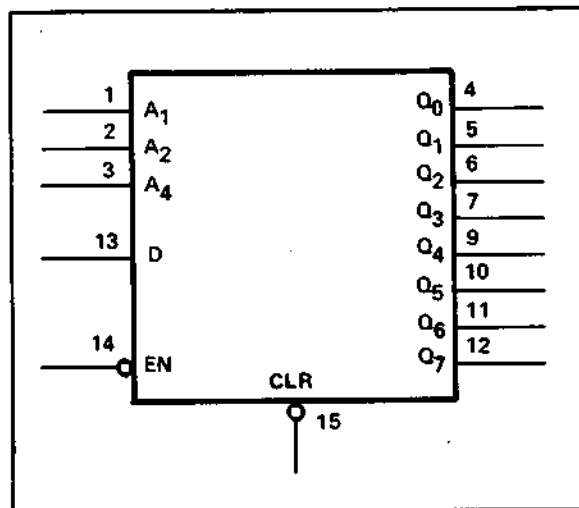


Figure 4-15. 8-Bit Addressable Latch 1820-0833

4-38. 8-Bit Addressable Latch 1820-0833

4-39. When the EN line is Low data (D) is written into the latch and will appear on only the Q that is selected by the address code. For example, an address code of 5 ($\frac{A_4}{1} \frac{A_2}{0} \frac{A_1}{1}$) selects Q5. When EN is High, the latch is in the memory mode; i.e., all latches remain in their previous state and are unaffected by the data or address inputs.

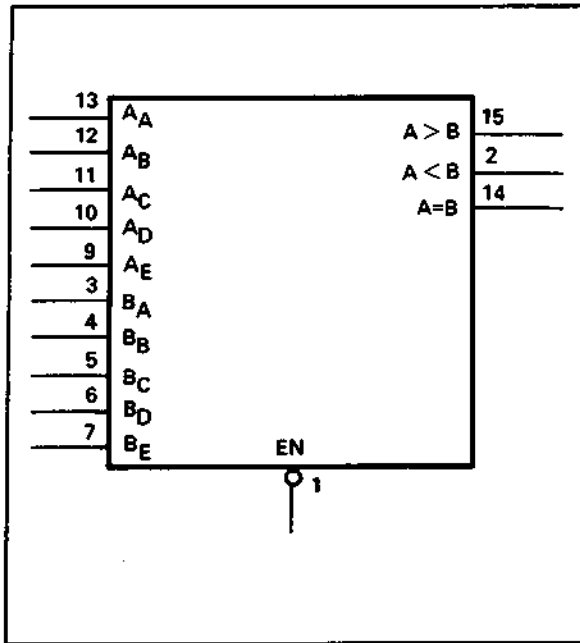


Figure 4-16. 5-Bit Comparator 1820-0904

4-40. 5-Bit Comparator 1820-0904

4-41. This IC performs a comparison between two 5-bit characters and provides three outputs to indicate the result of the comparison: less than, greater than, and equal to. A Low level on EN enables the device, and a High level forces all three outputs Low.

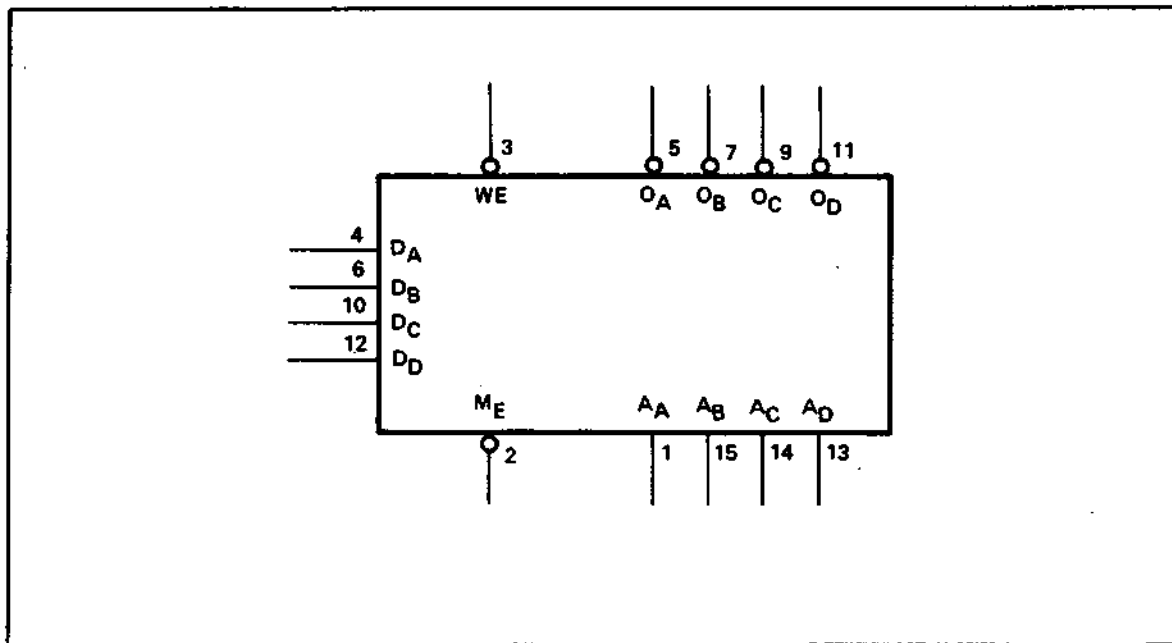


Figure 4-17. 64-Bit Read/Write Memory 1820-1028

4-42. 64-Bit Read/Write Memory 1820-1028

4-43. The memory is capable of storing 16 characters of 4-bits each. Information present at the data (D) inputs is written into the memory by addressing (A lines) the desired memory location and holding both memory enable (ME) and write enable (WE) low. The complement of the information that has been written into the memory is read out at the four output (O) lines. This is done by holding ME low, setting WE high, and addressing the desired location.

4-44. OVERALL THEORY OF OPERATION

4-45. The following paragraphs contain a general description of the counter's operation. A block diagram is provided in Section VIII for reference.

4-46. Input Assembly

4-47. The counter has two input channels, each having a frequency range of dc to 500 MHz. A two-position switch selects either X1 or X20 signal attenuation. The signal is amplified by two amplifiers: one on A3 and the other on A4. The sensitivity of the first amplifier is variable with the LEVEL pot. The second amplifier is a combination amplifier/Schmitt trigger. The outputs of the Schmitt triggers drive the gate board.

4-48. Gate

4-49. The main gate board (A9) uses three separate multiplex switches to select the proper signals for a particular measurement. Two of the switches select inputs from Channel A, Channel B, Plug-in A, Plug-in B, and 100 MHz test. These signals are termed *event counts*, where each pulse represents a count. The third switch selects the internal 500 MHz clock signal, the plug-in clock signal, or the output of the second multiplier for use in the RATIO or START Function. These signals constitute the *time counts*.

4-50. The main gate board also controls the gating of the input signal and clock signal. The main gate circuits are armed by the run down of sample rate or by the reset signal. The arming signal enables the gate to open on the next input cycle. During the time the main gate is open, the event signal and time signal are divided by 20 in the A9 scalars. The signal levels are shifted from EECL to T²L before the signals are sent to the remainder of the scalars on A11.

4-51. Scalers

4-52. The scalars, or dividers, can be considered as a string of 13, individual, divide-by-10 stages. When the main gate opens, the Event Scaler begins accumulating event counts (e.g., Channel A pulses), and the Time Scaler begins accumulating time counts (e.g., internal 500 MHz pulses). Before the decades can output their data, the accumulation of counts must end with the conclusion of the gate time. A method for determining the end of the gate time is, therefore, needed.

4-53. The GATE TIME switch sends the A11 board a different 4-line code for each of its switch positions. The code is passed through a switch to a strobe coder, where it is decoded to a 16-line code. This code addresses one of the Time Scaler decades to output its data. The Time Scaler accumulates 500 MHz clock pulses until a "5" appears on the output of the addressed decade. Any division of 500 MHz by a power of 10 is also a division of 1 second by the same power. Therefore, when a "5" first appears on the output of the addressed decade, the elapsed time (gate time) is the selected multiple of 1 second. For example, if 5×10^8 counts accumulate in 1 second (500 MHz), 1 ms will accumulate 5×10^5 counts. Once a 5 is detected, the main gate closes on the next Channel A input pulse.

4-54. Each decade of the time and events scalars now contains one digit of information, which can be sent to the processor as a 4-line code. This is done by sequentially addressing each decade to output its stored data. The address codes are supplied to the A11 switch by a 16-bit counter: the Denominator Register Counter (DRC) located on the A13 board.

4-55. Arithmetic Processor

4-56. The data from the time and events scalars on A11 are strobed into the A13 board, where the data is manipulated in such a manner as to double the time data. The Adder/Subtractor circuits perform this operation by adding the time data to itself. This, in effect, produces a 1 GHz time base frequency. This results in keeping the measurement in terms of events/nanosecond.

4-57. Once this is accomplished, the DRC again strobes events data into the A13 board. The events data is now located in the Denominator Register and the doubled time data is located in the Numerator Register. This sequence of events occurs in every frequency, period, or time interval measurement.

4-58. The arithmetic process consists of dividing the contents of the Denominator Register into the contents of the Numerator Register $\left(\frac{NR}{DR}\right)$. For mainframe measurements involving a gate time, the process is always a division. The contents of the registers, therefore, may have to be exchanged, depending on the type of measurement being made. For example, in a period measurements, the division needs to be $\frac{\text{time}}{\text{events}}$ ($\frac{1}{T}$ = period); therefore, no exchange is needed, since time data is in NR and events data is in DR. In a frequency measurement, however, the division needs to be $\frac{\text{events}}{\text{time}}$ (cycles/sec = frequency); therefore, the registers must exchange their data to perform the correct division.

4-59. Shifting data from one register to another involves "reading" the data out of each register, storing it in a latch, and then "writing" the data back into the other register. Once both groups of data are positioned in their correct register, the Adder/Subtractor Register accomplishes the division by performing a *series of successive subtractions*. Each time this register completes a successful subtraction, it increments the Quotient Multiplier Counter. Once this counter determines the total number of successful subtractions in a particular digit, it transfers that data into the Quotient Register and continues the subtraction process for the next significant digit. After all subtractions are complete, the Quotient Register shifts the data into the Denominator Register, where it can be distributed to the display or interface bus.

4-60. The Quotient Multiplier Storage circuit is used to determine the unit multiplier (K, M, n, etc.) of the result. The Digit Storage defines the number of significant digits to be computed. The digit counter (DC) is compared with Digit Storage (DS). When DS = DC, the division routine is complete. The Decimal Point Locator for the Result (DPLR) is a counter that keeps track of the decimal point location in the result. The Decimal Point Locator for K is also a counter and is used to keep track of decimal point information from the plug-in.

4-61. State Control Section

4-62. To this point, the counter has been described in terms of signal or data flow. To control the intricacies of the data flow, a hierarchy of commands and controls are needed. Depending on the operating mode being used, the counter uses a particular program which outputs the commands to the various assemblies in the counter. All possible program steps are contained in the ROMs (Read Only Memories), located on A15 (lower left of block diagram). The flow within the program is determined by generating a series of commands and then altering the program flow based on the results.

4-63. The ROMs output two sets of program codes: one set when the MSB address line is High and the other set when MSB is Low. The first set is chosen by address codes, which selects one out of 128 possible ROM address locations. The second set of program codes is chosen from a second set of ROM address locations. Each address location contains a specific program code.

4-64. The first set of program codes is stored in the Word Doubler Storage circuits (A14, A15) until the second set is received. The two sets are then fed to the Combinational Logic circuitry on A15 where the program codes combine to produce about 50 *command lines*. Some of these command lines come directly from the ROMs. As previously mentioned, the command lines control various assemblies to perform particular functions. The results of the function are carried on lines called *qualifier lines*. The A10, A11, A13, A14, and A15 boards contain combinational logic circuits which generate the qualifier signals that are sent to the Qualifier Select Logic. The Qualifier Select Logic examines only one qualifier line. The line it examines is determined by the 6-line output of Word Doubler Storage.

4-65. The Word Doubler Storage circuits provide 6 address lines from the previously addressed program codes. These 6 lines contain a two-digit octal code, which performs two functions: (1) it provides the two most significant digits of a 3-digit code, which will be used to address the ROMs to the next address in the program, and (2) it selects the specific qualifier line that the Qualifier Select Logic will output on the LSB (least significant bit) line. The LSB line is the third digit in the 3-digit ROM address code. Therefore, even though there is a definite arrangement of address codes in a particular program, the program flow can be modified by the state of the LSB line, which is the result of the last set of commands.

4-66. Oscillator Circuits

4-67. The internal time base for the counter is supplied by a 10 MHz, oven-controlled oscillator. The 10 MHz signal feeds through a pulse shaper and buffer to J2 on the rear panel and to the plug-in circuits. It also feeds into a times 50 multiplier circuit (X2, X5, X5). The result is a 500 MHz signal that is used as the counter's time base. Depending on the state of a status line, the 500 MHz clock may be jittered to provide true time interval averaging. A portion of the signal is tapped off after the X10 stage. This 100 MHz signal is used for self-check.

4-68. An external oscillator signal may be applied to J1, EXT FREQ STD INPUT. This signal is sent through a circuit that phase locks the internal oscillator to the external standard.

4-69. Power Supplies

4-70. The power supply circuits are contained on A6 and A7 assemblies. The supplies are short-circuit proof and will automatically shut down if operated at too high a temperature. A sophisticated ground system requires that each supply line be measured to its own return line, e.g., +5V and +5V RET (return).

4-71. CIRCUIT BOARD THEORY

4-72. The following paragraphs describe the operation of each circuit board in the counter. Refer to the appropriate schematic in Section VIII while reading this material. If the reader's purpose is to learn the instrument's operation, rather than a specific part of the counter, it may be helpful to read the material in the suggested order: A3, A4, A9, A11, A10, A13, A15, A14, A1, and A2.

4-73. A1 and A2 Display Assemblies

4-74. Assemblies A1 and A2 combine the circuits necessary to display all measurement data, minus sign, and annunciators. The A1 board contains the digit LEDs, which are placed in sockets, and the annunciators, which are backlighted by incandescent lamps. A2 contains the character generator and its drivers, the decimal point decoder, and the digit enable circuit with its drivers. The annunciator decoding is shared between the two boards.

4-75. STROBING TECHNIQUE. The result of the measurement is displayed by using a strobing technique. That is, only one digit of the displayed number is on at any one time. One digit is displayed and then removed; then the next digit is displayed and removed. This process continues until all digits have been shown. The strobing process occurs at a faster rate than the eye can detect, so the display appears continuously lit. Character generator A2U6 controls the digit (numeric character) to be displayed, while A2U1 controls the placement of the digit in the display.

4-76. CHARACTER GENERATION. The BCD data lines (entitled DR A,B,C,D) carry the digit information from the DR RAM (A13) to the character generator, A2U6. The BCD lines are decoded by A2U6 into segment lines for the LEDs. Each segment line enables an individual segment (or diode) of the LED display; therefore, several of these output lines may be High when displaying a specific digit. Transistors A2Q1 through A2Q7 are used as drivers for the segment lines. A2Q8 drives the decimal point line (described later).

4-77. Since these lines connect to the same segment in each digit, the turn-on of these digits must also be controlled. The same counter codes that address the data from the DR RAM are also sent to A2U1. They are then decoded to turn on each digit, in sequence, from LSB to MSB. Eleven codes are needed to display all possible digits; therefore, the DRC codes are normally stepped from 0 to 10.

4-78. As the DR counter steps through its codes, the data lines (DR) and DRC lines change codes and each digit is displayed. The counter steps through all 11 codes, regardless of the number of digits displayed. A DR code of 15 will blank those columns that have no digits. If the measurement requires a minus sign, the DRC lines provide an additional code of 11. This causes A2U1(13) to go Low. This results in A2Q9 driving the anode of A1DS1 and, at the same time, enables A2U4B and A2Q7 to drive the cathode.

A1 and A2 Continued

4-79. When the LAMP TEST line goes Low, it forces all outputs of A2U1 to go High, which lights all segments of the display. This line also enables A2U4A to light the decimal points. During lamp test, the DRC lines step through all 16 codes (0-15).

4-80. **ENABLE CIRCUITS FOR CHARACTER GENERATION.** Before A2U1 can operate, both G1 and G2 inputs must be Low. Likewise, the RBO line of A2U6 must be High before the device can drive the segments. During the process cycle, the DISP CLK EN line is Low. This resets A2U7A and places a High on the G2 input of A2U1, thereby turning it off. When the display cycle begins, DISP CLK EN goes High and releases the rest position. Also, the DRC code returns to zero. This causes a High-to-Low transition on the DRC D line, which clocks A2U7A, a retriggerable one-shot multivibrator. The "time-out" for this one-shot is longer than the time required to strobe the display. If, for some reason, the DRC codes become inactive, the one-shot will time-out and turn off A2U1 by placing a High on G2.

4-81. A new digit is clock out of the DR RAM with each negative transition of DISP CLK. When this line goes Low, however, it triggers A2U7B, a one-shot multivibrator. This produces a High on the Q output to turn off A2U1 via the G1 line. It also produces a Low on the \bar{Q} output, which blanks A2U6 and forces its output lines Low. This same pulse also shuts off the decimal point by placing a Low on A2U3(3). The duration of these pulses is controlled by R26 and is in the order of about 5 to 50 μ s. This provides enough time for the RAM circuits to settle after selecting another digit. Once the one-shot times out, the Q output of A2U7B returns Low to enable A2U1 and the \bar{Q} output returns High to enable A2U6.

4-82. **DECIMAL POINT GENERATION.** As previously stated, each DRC code represents a specific position in the display. This is also true of the decimal point code, which is transferred on the DP A,B,C,D lines. The position of the decimal point in the display has been determined in the process cycle. The code is placed on the DP lines for the duration of the display cycle. These lines are connected to one side of four exclusive OR gates (A2U2), while the other side of these gates is connected to the DRC lines. When the two codes are equal, all inputs to A2U3B go Low. This enables A2U3A and A2U4A to turn on A2Q8 and light the decimal point.

4-83. **ANNUNCIATOR CIRCUITS.** The multipliers for the measurement (M, K, μ , etc.) are generated by a decoding network, comprised of A2U5A,B, and C, A1U2A and B, and A1U1. Since this counter can make period measurements, in, say, kiloseconds or frequency measurements in terms of Micro Hertz, the decoding circuits must meet these criteria. Because A1U1 is an open-collector 4 to 10 line decoder, its outputs can be wired together or to additional circuitry. A table is provided with the schematic to explain the functional decoding of this circuit. The other annunciators are driven directly or through individual buffers. NAND gate A2U4D ensures that the ARM light is on only when the GATE light is off.

4-84. A3 Input Amplifier

4-85. The Input Amplifier consists of two similar input channels, Channel A and Channel B. The channels are completely separate, and can be selected for common or separate operation. Each channel has ac or dc coupling, selectable 50 Ω or 1 M Ω impedance, an attenuator network, level control, preset control, slope selection, and a high-frequency Schmitt Trigger Amplifier.

4-86. **CHANNEL A.** The circuit theory describes only the Channel A circuit, since the Channel B circuit is similar. The signal entering input connector J3 is sent directly through switch S8 or through coupling capacitor C22, which blocks the signal's dc component. Switch S5 selects SEP or COM mode of operation. Switch S6 selects resistor R25 for 50 Ω input impedance and resistors R28 and R27 for 1 M Ω input impedance. When S5 is in the COM position and S6 is set to 50 Ω s, the two channels are connected together and resistor R26 maintains the 50 Ω input for each channel. In SEP, the inputs are isolated from each other, R26 is bypassed, and the impedance switches can be set separately. Attenuator Switch S7 passes the signal directly in divide-by-1 or attenuates the signal by 10, in divide-by-10, through divider network R28 and R27.

4-87. The conditioned signal is then routed to the Schmitt Trigger Amplifier U2(8) through one of two paths, depending on the frequency. Frequencies below 10 MHz including dc, pass through the source follower FET Q3A. Higher frequencies are bypassed around the FET through capacitor C24. Q3A input is protected at low frequencies by resistor R36, and diodes CR5 and CR6. The amplifier U2 has differential inputs and outputs (only one output line is used) and has a gain of about 3. One input accepts the signal and the other accepts the dc level (-2V to +2V) from the front panel LEVEL/PRESET (pot/switch), or remotely via HP-IB (Option 012). Sensitivity potentiometer R41 enables optimum sensitivity adjustment of Amplifier/Schmitt Trigger U2. Adjusting R41 varies the voltage at the gate of source follower Q3B, thus varying the voltage at Pin 7 (TRIG) of U2. Adjusting R41 also varies the voltage at connector J2(2). FETs Q4A/B are current sources for Q3A/B.

4-88. Manual control of trigger level voltage is accomplished by adjusting LEVEL/PRESET control pot/switch (R38). The trigger level can be PRESET to zero volts, or varied from -2 volts to +2 volts. For Remote control via HP-IB, the trigger LEVEL pot must be set at PRESET (0V) position.

4-89. The counter may be triggered on either slope of the input signal. The SLOPE switch S9 determines this by controlling the output polarity of U2. If S9 is placed to +, a dc voltage of 3.5 volts is present at U2(6) (SLOPE) which enables U2 to trigger on the positive slope of the input signal at U2(8). If placed to -, 0 volts is present at U2(6), and U2 will trigger on the negative slope of the input signal.

4-90. A4 Input Trigger Assembly

4-91. A4 Input Trigger Assembly directly connects the amplified Channel A and Channel B signals from the A3 assembly to the A9 Main Gate assembly. The A4 assembly also provides adjustments for the hysteresis and risetime of A3U1 and U2 outputs, and controls clamp voltages for the input protection diodes on the A3 assembly.

4-92. CHANNEL A. The following circuit theory describes only Channel A, since Channel B is identical. The amplified Channel A signal from A3U2(1) enters at A3P2(6) and goes straight through to the A9 Main Gate assembly via connector P3(2). Analog Adder A4U1 senses the dc trigger level from A3J2(2) and outputs a corresponding set of dc clamp voltages to the input protection diodes A3CR9 and CR10. With a nominal trigger level of 0V at A3U1(3,5), the output is -2V at U1(1) and +2V at U1(7). When the trigger level changes, each output is offset by an amount equal to that change. For example, if the trigger level is +1V, the output at U1(1) is -1V (-2V plus +1V) and the output at U1(7) is +3V (+2V plus +1V).

4-93. A5 Front Panel Interconnect

4-94. This assembly provides an interconnection between the A4 Input Trigger Assembly and the A16 Motherboard Assembly. It also contains two coax cables for transferring the Channel A and Channel B signals to the A9 Main Gate Assembly.

4-95. A6 Switching Regulator

4-96. The A6 assembly provides +5V Display, +5V, and -5.2V for distribution throughout the instrument.

4-97. +5V DISPLAY SUPPLY. Rectifier diodes CR1 and CR2 receive 17V rms from the secondary of T1. C3 filters the resultant 8 Vdc. When the POWER switch is ON, P1B(7) is at ground potential. This causes CR4 to conduct and turn on Q2, which places 8V on U3's input. CR6 also conducts through R5, causing Q3 to turn off. U3 regulates the output voltage at +5V and provides fold back current protection. C7, C11, and C13 filter ac signals from U3. If the POWER switch is set to STANDBY or should S1 open, CR4 no longer conducts and Q2 turns off U3. With CR6 also turned off, Q3 is allowed to turn on through R5. This places a 100Ω load on the 8V unregulated line, which helps keep the high line peak voltage within the voltage rating of C3.

A6 Continued

4-98. **THERMAL AND ELECTRONIC SHUTDOWN.** S1 is a thermal switch that is mounted on U2. P1B(7) connects to the POWER switch and is at ground potential with the switch set to ON. When S1 is closed, there is .7V on the base of Q1, because of CR3. If the switch opens, due to high heat sink temperature, CR3 no longer conducts. This allows Q1 to turn on. Q1's collector voltage drops to a few tenths of a volt, which allows base current to flow in both Q5 and Q6 and causes them to turn on. Q6 turns on Q8. Q5 and Q8 turn on transistors inside U2 and U1, respectively, which turn off their internal current sources and shut off the two regulators. S1 shuts off the +5V DISPLAY supply by turning off CR4 and Q2. These three supplies are also turned off if the POWER switch is placed in STANDBY.

4-99. **+5V REG SUPPLY.** The +5V REG and -5.2V REG supplies receive power from the 22.3V rms secondary of T1. F1 and F2 provide protection for the rectifier circuits, while C1 and C2 prevent internally generated EMI from entering the power cord. CR5 rectifies the ac into +14 Vdc and -14 Vdc supplies. The voltages are filtered by C4-C6. U2 is connected as a switching type voltage regulator, whose output of +5V varies about 30 mV plus and minus at about 18 kHz. Output current is supplied through Q9 current boost.

4-100. When U2 turns on, it draws current through R25. This produces a voltage drop across R25 and turns on Q9. The output of Q9 charges L1 and C16 and increases the voltage on the output. When the output voltage reaches about 30 mV above +5V, it is sensed at U2(5), via the short on the motherboard. U2 shuts off current through R25, thereby shutting off Q9. The field around L1 collapses and causes "catching" diode CR10 to conduct. C16 also discharges until the output voltage drops to about 30 mV below +5V. This voltage is again sensed at U2(5) and Q9 is again turned on. The values of L1 and C16 help determine the switching rate. Q11 limits the output current of U2 during Q9 turn on or should Q9 fail and the regulator attempts to output more current than it is capable of delivering. CR8 and CR9 serve as clamping diodes and prevent the internal circuits of U2 from saturating and causing a slower switching rate.

4-101. **Bi-directional Crowbar.** Should the output voltage become excessive due to a failure in the supply (e.g., Q9 shorted), the crowbar prevents damage to the counter by shorting the output line to common. This is done when the output voltage reaches +6.3V or is shorted to a negative voltage. In either case, CR16 and CR17 conduct and trigger triac CR14. This will probably cause F3 to open.

4-102. **Sense Line Clamp.** The power supply boards should not be removed with the power cord connected. If this occurs, the sense line is disconnected from the +5V output (short on motherboard). Even though the board is removed, power is supplied by the filter capacitors, C4 and C6; and the internal voltage tends to approach +14V, possibly causing damage. To prevent this, diode CR10 conducts and resembles the motherboard short. This regulates the supply at about +5.7V until the stored voltage bleeds off.

4-103. **Current Limit.** Q4 and Q7 form an equivalent SCR. If the output draws too much current ($\approx 6A$), the current sense resistor R7 develops a voltage drop sufficient to turn on Q4. Q4 turns on Q7, which causes Q4 to turn on even harder. The result is that the internal circuits of U2 are deprived of current and shut down the output of U2. Should Q5 turn on (POWER switch to STANDBY or S1 open), it causes the current to flow through Q5 instead of Q4 and Q7. Once this occurs, Q4 and Q7 can be considered "unlatched."

4-104. **-5.2V REG SUPPLY.** This supply is similar in operation to the +5V REG supply. The only differences being that R32 substitutes for Q11 and R34 as a peak current limiter, and CR7 substitutes for Q4 and Q7. As with the other supply, too much current through R12 triggers the SCR. This places -14V on CR7's anode, which draws current out of U2. The result is that U4's output and Q10 turn off. Should Q6 turn on (POWER switch to STANDBY or S1 open), it causes current to flow through Q8 instead of CR7. When the anode current of CR7 goes below its holding current (≈ 5 mA), the SCR unlatches. When Q8 turns off again, the time constant of C10 and R21, 22, and 24 slows the $\frac{dv}{dt}$ on CR7. This prevents the SCR from turning on with a sudden change in anode voltage.

4-105. A7 Linear Regulator

4-106. The A7 assembly provides +12V, +15V, and -15V for distribution throughout the instrument.

4-107. +12V OSCILLATOR SUPPLY. The 12V, 22V, and 11V supplies receive power from the 36V rms secondary of T1. F1 and F2 protect the rectifier circuits, while C1 and C2 prevent internally generated EMI from entering the power cord. CR2 rectifies the ac into +22 Vdc and -22 Vdc supplies. The voltages are filtered by C6-C9, while R6 and R7 serve as bleeder resistors. The +22V unregulated supply is sent out on P1A(10).

4-108. U2 is the 15V regulator whose output is filtered by C18 and C21. R21 and CR8 step the voltage down to +11V regulated and C14 filters the output.

4-109. Regulator U2 uses foldback current limiting and is thermal protected. Should the 12V output short to common, the voltage drops to zero and the current "folds back" to a safe value of current. If, in addition, the IC's temperature increases, the output shuts down completely, turning on again once the chip has cooled down. These actions prevent the supply from short-circuit damage. The +22V supply continues to supply power to the oscillator circuits with the POWER switch set to STANDBY or when the other supplies have shut down due to high temperature.

4-110. THERMAL AND ELECTRONIC SHUTDOWN. S1 is a thermal switch that is mounted on U4. P1B(6) connects to the POWER switch and is at ground potential with the switch set to ON. When S1 is closed, there is .7V on the base of Q3, because of CR3. If the switch opens, due to the high heat sink temperature, CR3 no longer conducts. This allows Q3 to turn on. Q3's collector voltage drops to a few tenths of a volt, which allows base current to flow in Q4 and causes it to turn on. Q4 and CR6 turn on transistors inside U1 and U4, respectively, which turn off their internal current sources and shuts off the two regulators. S1 shuts off the +20V REG supply by turning off Q2. These three supplies are also turned off if the POWER switch is placed in STANDBY.

4-111. +15V SUPPLY. The +22V line supplies input voltage to U1 pin 3. The +15 regulated output voltage is present at P1A(8,8), via Q5 and R28. The motherboard sends this voltage back to P1A(7), where it is sent to U1(5) as the sense voltage.

4-112. Any voltage change on the sense line is compensated for by a subsequent change in output current in a direction necessary to counteract the change in output voltage. Since the regulated output of U1 is unable to supply high current to the +15V load, it is used as base drive for Q5 current boost. As the load increases, the base current increases, and Q5 draws more load current from the +22V supply. Should the load draw too much current, as in the case of a short, Q7 (normally off) conducts via R22. The collector of Q7 sinks current from the internal circuits in U1 that would normally drive Q5. Depriving Q5 of base current drops the output current to some nominal value, hence, foldback.

4-113. Sense Line Clamp. The power supply boards should not be removed with the power cord connected. If this occurs, the sense line is disconnected from the +15V output (short on motherboard). Even though the board is removed, power is supplied by the filter capacitors, C6 and C8; and the internal voltage tends to approach +22V, possibly causing damage. To prevent this, diode CR12 conducts and resembles the motherboard short. This regulates the supply at +15.7V until the stored voltage bleeds off.

4-114. -15V SUPPLY. The -15V supply is similar to the +15V supply; therefore, only the differences will be described. CR6 is used as the shutdown control for U4. With shutdown, U4's output turns off Q6.

4-115. +20V REG SUPPLY. Diode assembly CR1 rectifies the 22V rms voltage into 28 Vdc, which is filtered by C4. U3 is a +15V regulator whose common side is held at +5V. The result is a regulated +20V output. CR10 clamps the common terminal to the output in the event of a short to common. This prevents reverse biasing of circuits internal to U3, preventing damage to the IC.

4-116. A8 PLL Multiplier Noise Generator

4-117. The A8 assembly performs several processes, all of which pertain to the oscillator signal. The main function is to accept the internal 10 MHz oscillator signal and from it produce the 500 MHz time base signal. Other signals derived from the 10 MHz input are the 100 MHz test signal, used for the Check Mode; an amplified 10 MHz signal for the rear panel; and another amplified 10 MHz signal for the plug-in accessories. Another function of the board is to phase lock the internal oscillator signal to an external reference. At appropriate times, the board also places white noise on the time base signal, thereby preventing a harmonic relationship between the time base signal and input signal.

4-118. **INPUT AND MULTIPLIER CIRCUITS.** The 10 MHz oscillator signal enters differential amplifier U3, which serves as an isolation amplifier. This stage prevents changing load currents from affecting the oscillator, itself. One output of the amplifier, pin 6 (TP1), is decoupled by C15 and sets the bias of Q4, 5, and 6 at 8.5 to 9 Vdc. These three transistors form one side of a differential amplifier, while the other side, Q7, accepts the output signal from U3 pin 8 (TP2).

4-119. **Output Amplifiers.** The output of U3 is transferred from the emitter of Q7 to the emitters of the other three transistors, which constitutes a common base configuration for these stages. There are four outputs from these stages. Q7 provides 10 MHz to the rear panel through an impedance matching network, comprised of L7, C30, and C31 (TP5). Zener diode CR14 prevents the output signal from reaching too high of a level when J2 is not loaded with 50 ohms. Another stage, Q6, sends 10 MHz to the plug-in through a similar circuit, consisting of CR15, L8, and C32 (TP6). The remaining two signals are sent to the phase detector circuit and the multiplier circuits.

4-120. **Multiplier Circuits.** The 10 MHz signal from Q5 feeds into a tank circuit, consisting of L9-11, C24, C26, C29, and CR12. This circuit presents two signals, 180 degrees out of phase, to the bases of Q8 and Q9. The transistors form a full-wave rectifier circuit and have the effect of doubling the frequency, while providing current gain. The resultant 20 MHz signal (TP14) is smoothed by L12 and C39, before being amplified in U5. The output signal at U5(6) feeds into the tank circuit of C42, C43, and L13. It is then fed through coupling capacitor C46 (TP15) and into the X5 multiplier of U6B, C50, C52, and L14. The multiplier output is a current square wave, which are high in odd harmonics. Tuning capacitor C52 sets the tank circuit to select the 5th harmonic of the fundamental. The resultant 100 MHz output (TP16) is amplified and filtered by U6A, C56, C57, and L15. The gain of this stage can be varied by R81 (RA). Emitter follower Q17 sends the 100 MHz signal (TP17) off the board for use as a test signal during the check mode.

4-121. The collector of Q17 passes the signal to a phase shifter circuit, comprised of L17, L18, and C68. Adjusting C68 varies the phase relationship between the 100 MHz signal and the 500 MHz signal. The 100 MHz signal can be shifted $\pm 36^\circ$, which is 360° with respect to 500 MHz ($72^\circ \times 5 = 360^\circ$). This means a full period of adjustment for synchronization between the two signals. When in the Check Mode, the adjustment eliminates the ± 2 ns error incurred in a time internal measurement.

4-122. The 100 MHz signal is amplified by U7B, which uses L19 as a load. The signal passes through coupling capacitor C74, before being further amplified in U7A. The gain of U7A is controlled by R99 (RB). The last stage switches current between output transistors and produces square waves of current, which are high in odd harmonics. A quarter wave length transmission line (etched on board) and C67 (CF) tune the 500 MHz output signal (TP18). Further filtering is provided by C65, L16, C60, and C61. The final stages of amplification are provided by Q19 and Q21.

4-123. During totalize, Channel C events, or a ratio measurement, A8 turns off the 500 MHz time base signal. When the 500 MHz OFF line goes low (-2V from +2V), it turns on CR19 and CR20. The diodes sink collector current from Q18 and Q20. This turns off Q19 and Q21, since they no longer receive any base current.

4-124. **NOISE GENERATOR.** No noise is generated when the NOISE CONTROL line is High. At this time, both Q1 and Q2 are turned on. The collector of Q2 places -15V on the cathodes of CR5 and CR6, which results in biasing U8 and U9 out of their operating range.

4-125. Once the NOISE CONTROL line goes Low, it turns on CR1 and places the emitter of Q1 at about 0.7V. This turns off Q1 and Q2 and turns on U9 and U8. The noise generated from Zener diode CR2 is amplified by U9. The noise signal couples to U8 through C12 and C11 and is amplified by U8. The cathode of peak detector CR7 sits at about 2V. The noise, therefore, must be at least -2.7V for the diode to conduct. Any noise greater than this passes through the diode and is filtered into an average dc voltage by C20 (TP12). The higher the noise, the more negative this voltage becomes. An increase of negative voltage tends to turn off Q3, thereby increasing its drain resistance. This results in more of U9's output signal being fed back to its inverting input (pin 2) and causes a corresponding drop in output voltage. The output of U8, then, is constant, due to automatic gain control.

4-126. The output noise of U8 passes through R23, C21, and R41 to the cathode of the voltage variable capacitor, CR12. This capacitor is part of a 10 MHz tank circuit, comprised of C24, C26, C29, and L9-11. As the erratic changes in noise voltage affect CR12's capacitance, the phase of the 10 MHz signal shifts rapidly. The result is a 500 MHz time base signal that is phase modulated so rapidly and erratically that it cannot be harmonically related to any input signal.

4-127. PHASE LOCK LOOP. An external signal applied to the rear panel jack enters the board on J1. Limiting diodes CR3 and CR4 prevent excessive voltages from damaging the input circuits. The first two inverters, U2B and U2A, form a feedback trigger circuit and prevent noise from entering the circuits when no input is present. The output of U2A also feeds U2C and a delay circuit, formed by R21 and C17. The time difference between these two signals produces a positive voltage spike on U2D(15) and a negative voltage spike on U2D(9). These pulses are amplified and inverted in U1.

4-128. The phase detector circuit conducts during the time these pulses are present. During conduction, the circuit passes a small segment of the internal 10 MHz oscillator signal, which charges C33 to the value sampled. Each subsequent sample either adds to the previous charge or subtracts from it. A composite picture of many samples appears as a sine wave of the difference frequency.

4-129. When the difference frequency is too high or when the circuit is phase locked, the ac signal at TP10 is zero. At this time, Q14 and Q15 are turned on and force Q16 off. This places a High on the LAMP TEST line. The current drawn through Q14 turns on Q11, which results in shutting off Q10.

4-130. When the signal at TP10 is at a frequency that can be locked and the circuits are attempting to lock, the signal's amplitude is sufficient to drive the unlocked detector, Q12 and Q13. Diodes CR17 and CR18 pass only the positive going portions of the signal. C81 charges to a more positive level than before, which causes Q14 to turn off. Since no collector current is present, Q15 turns off, allowing Q16 to turn on and pull the LAMP TEST line Low. The gate of Q10 becomes more positive, since Q11 is also off, and allows the FET to pass the signal to the VCO on A18. Using this signal, the internal oscillator adjusts itself until it locks to the external standard.

4-131. Once the circuit locks, it opens FET Q10 and adds low pass filter R55, C45, C49, and R74 to the VCO signal line (TP11). This reduces any noise on the external standard line, connected to the back of the counter, and prevents miscounting. Rear panel switch S9 (FREQUENCY STANDARD INT-EXT) controls whether an external signal applied to the rear panel EXT FREQ STD input is used to control the counter. Q22 prevents the counter from operating off of the internal oscillator when in the EXT STD mode and the external frequency is lost or disconnected. When S9 is set to EXT, a ground is connected to Q22 emitter to enable a detector circuit composed of Q22, C84, CR21, and CR22. As long as the external frequency is present at U2D(15), Q22 is shut off. Loss of the external standard causes Q22 to conduct and initiate a front panel LAMP TEST display.

4-132. A9 Main Gate

4-133. This assembly contains 3 primary blocks: Input Selector, Main Gate, and Scaler. All input signals and reference signals (time base) are presented to the Input Selector circuits, which select only those signals needed to complete a given measurement. The Main Gate circuitry determines the precise moment these signals are passed to the scalers and, in addition, sets the

A9 Continued

timing requirements for a time interval measurement. The scalers count the input pulses of both the input signal (events) and reference signal (time) and, at the end of the gate time, outputs the stored data. Subsequent scalers are located on A11. A fourth block, Turn-off Control, controls the existence of the 500 MHz internal time base signal, as well as the Channel A and Channel B signals.

4-134. FREQUENCY OR PERIOD MEASUREMENT. Assume a frequency measurement is being made from the front panel. (A period measurement is analogous.) The control lines (see Table 4-1) determine the signal path through the Input Selector circuits. With a Low on U14(11 and 12), the MF CH A signal is allowed to pass through U14D and A. If a signal is also connected to CHANNEL B jack, it will pass through the Channel B Multiplexer U15, but will be blocked by U12A and B (pins 6 and 14 are High). The disabled U6A (pin 8 = H) places a Low on U11(11), which enables U11C to pass the input signal to U5(13) and U10(15). At the same time, the Channel C Multiplexer U13 passes the 500 MHz clock signal to the clock input of the Time Gate F-F, U7(13). Now that both signals are present on their respective flip-flops, a set of conditions must be considered. Both gate flip-flops have been set (Q=H) by the GATE RST signal. U7(3) is High from the High outputs of U5(6) and U6B. The disabled U6A has set U5(1) Low, via U1B. The High outputs of U5 and U7 flip-flops prevent U4 and U2 from toggling. The TI+EVT line is Low and allows U10 to pass the input signal to the disabled U4(13).

Table 4-1. A9 Control Lines

Selected Input Signal	Control Lines (EECL)		
	Test	Ext AB	Ext C
100 MHz TEST	H	X	X
MF CH A AND CH B	L	L	X
PI CH A AND CH B	L	H	X
500 MHz CLK	X	X	L
PI CH C	X	X	H
Measurement Mode	Control Lines (EECL)		
	Ratio + ST	TI + EVT (P1B pin 14)	
FREQ OR PERIOD	L	L	
RATIO OR START/STOP	H	L	
TI OR EVENTS	L	H	

4-135. Noting the timing diagram of Figure 4-18, it is seen that once the GATE ARM line goes High (ECL), it places a Low (EECL) on U5(3). This allows the next input signal to toggle the Event Gate flip-flop. This does two things. (1) It places a Low on U4(14), which enables U4 and allows the next input pulse to enter the Event Scaler. (U4 is a binary of the scaler). (2) It places a Low on the D input of U7, which allows the next 500 MHz clock pulse to toggle the flip-flop and enable U2 with a Low on C1. This allows the clock signal to enter the Time Scaler. Binaries U4 and U2 pass their divided (+2) signals to U9 and U3, respectively, where the signals are further divided-by-10. The divide-by-20 input and clock signals are sent to the A11 Scaler board through emitter followers Q15-18.

4-136. The GATE ARM line goes Low once the total number of counts in the time scaler exceeds $\frac{\text{Gate Time}}{2n}$. U5(6) goes High on next input pulse after GATE ARM goes Low. This disables U4 and shuts off the Event Scaler. On the next clock pulse after U7(3) goes High, U2 is disabled by a High on C1, which shuts off the Timer Scaler. Note that only integral (whole) periods are counted in the Event and Time Scalers. This is not true, however, in the totalize (start/stop) mode.

4-137. TOTALIZE MODE. The counter will totalize Channel A pulses for as long as the FUNCTION switch remains in the START position. In this position, the RATIO + ST line is High and causes Q2's collector to go High. This enables U13B and disables U13D from passing the 500 MHz clock signal. The Low on Q1's collector enables U12B to pass the Channel B signal (totalize can be A+B or A-B). The signal passes through U13B to the Time Gate F-F, while the Channel A signal follows the same path that it would in a frequency measurement. The GATE ARM signal is always High in totalize.

4-138. The measurement ends when the FUNCTION switch is placed to STOP. This causes the GATE RST line to go High and set the Event Gate and Time Gate flip-flops. Integral periods are not counted, since the measurement can be interrupted at any time.

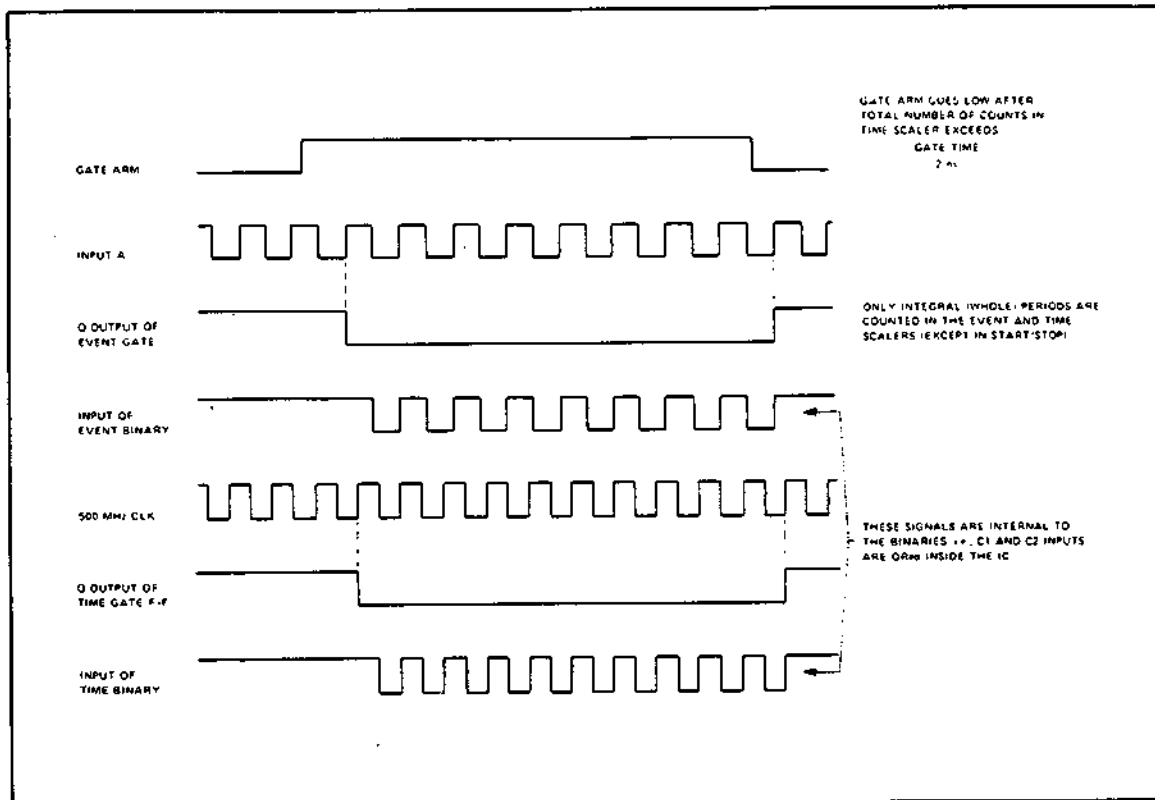


Figure 4-18. A9 Timing Diagram for Frequency, Period, Ratio, and Start/Stop

4-139. **RATIO MODE.** The Ratio mode uses the same signal paths as the Totalize mode. That is, Channel A signal is sent to the Event Scaler and Channel B signal is sent to the Time Scaler. Unlike totalize, the Ratio measurement cycle is based on a selected gate time; therefore, it is dependent on GATE ARM. Since the Channel B signal is a direct replacement of the 500 MHz clock, the lower the frequency of Channel B, the longer the measurement time (see Section III).

4-140. **TIME INTERVAL MODE.** In this mode, the Time Scaler will count 500 MHz clock pulses only during the time between a Channel A pulse and a Channel B pulse. The two input channels regulate the switching of the clock signal by controlling the Event Gate F-F and Time Gate F-F. Refer to Figure 4-19.

4-141. The High on TI+EVT line causes U4(13) to stay Low, thereby enabling the binary to respond to the output of U5, only. Since U5 and U7 have been set (Q=H) by a High GATE RST, U6A is disabled, which results in a Low on U5(1) and causes U11C to be enabled. The first Channel A pulse to arrive after the GATE ARM line goes High clocks U5 and causes its output to go Low. This causes the output of U7 to go Low with the next clock pulse and enables U2 to pass 500 MHz clock pulses to the Time Scaler. The output of U5 also changes the output states of U6A, causing a High at U5(1) and allowing U11B to pass the next incoming Channel B pulse.

4-142. The Channel B pulse clocks the High on U5(1) onto the QA output. This clocks the C2 input of U4 to register that one time interval has occurred. On the next 500 MHz clock pulse, the High on U7(3) is clocked onto U2(13) and disables U2 from registering any more clock pulses.

4-143. **TURN-OFF CONTROL LOGIC.** To prevent possible cross talk of high frequency signals under certain conditions, it is necessary to turn off some of the unused internal signals. For example, the internal 500 MHz clock is turned off when using the external clock from the plug-in or when performing a ratio measurement.

A9 Continued

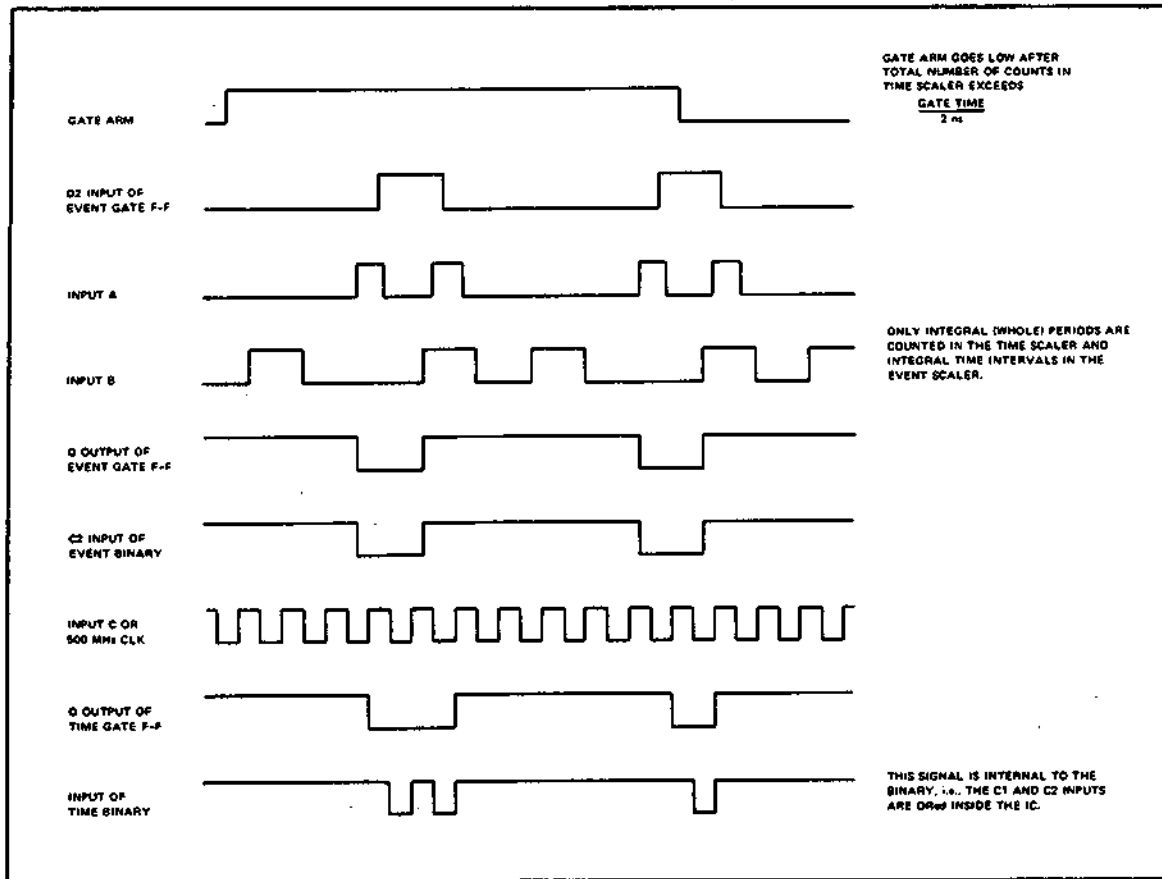


Figure 4-19. A9 Timing Diagram for Time Interval

4-144. When the RATIO + ST line goes High, it turns on Q1 and turns off Q2. The High on Q2's collector turns on Q4, causing its collector to go Low. Q9, CR2, and R43 form an emitter follower, which level shifts the Low on the collector of Q4 to -2V on the 500 MHz control line. The Control line turns off the internal clock (+2V=ON). The same thing applies if the EXT C line goes High.

4-145. If the plug-in Channel A and Channel B signals are being used, the EXT AB line goes High and shuts off the mainframe's input triggers. The High on EXT AB turns on Q3, which saturates Q8 and Q10 and pulls the trigger line High. This turns off the Schmitt triggers on A4. R50 and R51 form a 10-to-1 divider network with two resistors on A4 (A4R22 and 24).

NOTE

Simplified flow diagrams for A9 are given in Figures 5-14 through 5-16.

4-146. A10 Gate Control

4-147. The A10 board is closely related in operation with the A9 Main Gate board. The board controls the various methods of arming the counter. Each of these methods must set the Arm F-F, which remains set throughout the measurement phase. The Resolution circuit detects a 5 code from the scalers and signals the end of the measurement. The board provides signals necessary to terminate the measurement, start the processing cycle, and reset the scalers. The function codes (front panel, remote, or plug-in) are decoded through switching and combinational gating and are sent out as control signals. These lines instruct the counter to perform unique functions for the selected mode.

4-148. CONVENTIONAL ARMING. The sequence of events for a frequency measurement, for example, would be sample rate arm, measure, process, display, and back to sample rate arm. At the end of the processing cycle, the sample rate circuit begins its rundown as the previously taken measurement is being displayed.

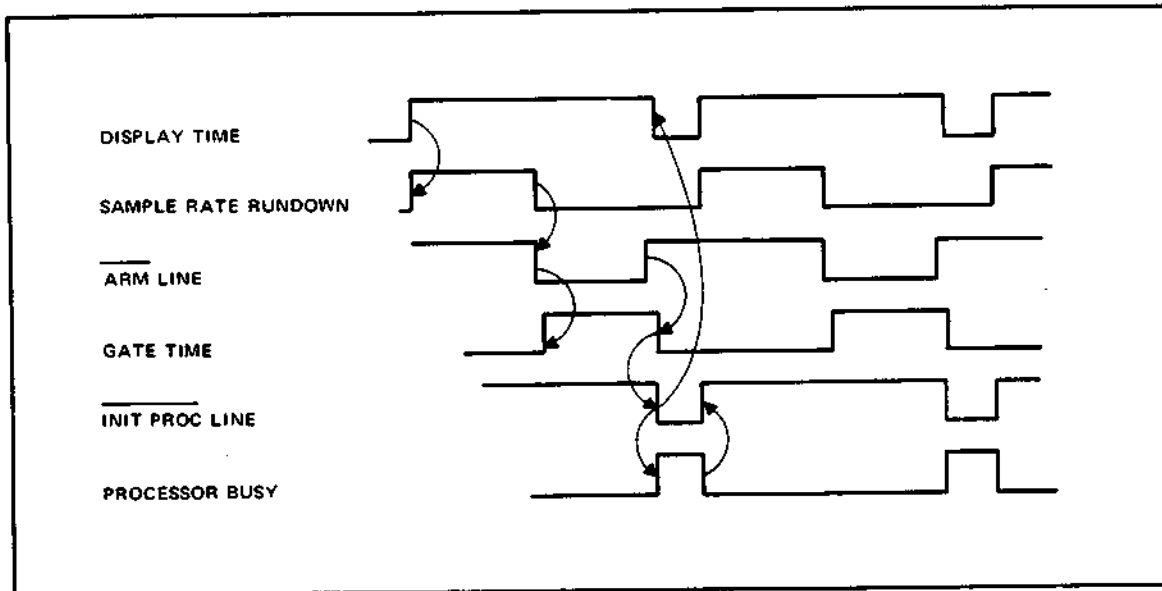


Figure 4-20. Measurement Timing Diagram

4-149. At the end of sample rate, the ARM line goes Low and sets the Arm F-F, U18A and B. If the rear panel GATE CONTROL switch is set to INTERNAL, the resultant ARMED signal turns on U17C, which enables the Event Gate F-F on A9. The complement signal, ARMED, passes through translator U20B and turns on the ARM light on A2. The next Channel A pulse sets the Event Gate F-F (A9) and drives the EVT GATE line low, which turns on the GATE light and turns off the ARM light. The ARMED line also places a High on the cathode of CR1, located in the Resolution circuit. Once the time scaler outputs a 5 code, a High is placed on each cathode of diodes CR1-4. This places a High on the J input of U22A and toggles the Q output High. The ECL High on U11B(4) and the ECL Low on U11C(9) reset the Arm F-F. The cathode of CR1 goes Low again, thereby preventing a 5 from toggling the Resolution F-F during the process phase when data is being read from the scalers. The reset state of the Arm F-F permits the Event Gate F-F on A9 to terminate the measurement on the next Channel A pulse. This is done when the disabled U17C forces the GATE ARM lines to their "false" states.

4-150. MAIN GATE STATUS. After arming, the first Channel A pulse sets the EVT GATE line Low, which causes U22B to set. The MEAS TIME line goes High and enables the Excessive Gate Time F-F on A11. Two nanoseconds later, the TIME GATE line goes Low, but has no effect on the MEAS TIME output until after a 5 code is detected and the Arm F-F resets. The Arm F-F resets U22B. At this time, the TIME GATE line holds the ECL wired-OR High, through U23C and U21C and D, until it also goes Low one time pulse after the Event Gate F-F resets.

4-151. During slow gate times, the GATE light is on for as long as the wired-OR line is High. With fast gate times, a 40 ms one-shot ensures that the GATE light is visible by keeping the GATE LITE line Low for 40 ms after the main gate closes.

4-152. INITIALIZE PROCESSOR CIRCUIT. The processing cycle begins when the measurement cycle is complete and the main gate closes. When the MEAS TIME line goes Low, it allows U12A to clock the Measurement Done F-F, U12B. The Q output goes Low and allows U13B and C to pull the INIT PROC line Low, thereby starting the process cycle. At near completion of the process cycle, the RST FRONT END line goes High and resets U12B via U10F and E.

4-153. ARMING AND PROCESSING IN TOTALIZE. During a totalize measurement, the process cycle is not controlled by the main gate. There is no gate time in an accumulating count and, therefore, no reasons to sample a 5 code. The scalers must be periodically scanned, however, to update the display. This is done by automatically fixing the sample rate at ≈ 80 ms when the FUNCTION switch is set to START and using this signal to control the process cycle. When SAMPLE RATE ARM signal from A11 goes High, it NANDs in U13A with the High output from U13D, caused by the Low ST+STP line. The output of U13A turns on U13B and C and pulls the INIT PROC line Low. The same type of processor start control can be done when using the PI DATA line.

A10 Continued

4-154. In totalize, the ARM F-F sets with the first sample rate rundown and remains set until the RESET button is pushed or the FUNCTION switch is set to some position other than START. With the switch set to STOP, U2C resets the ARM F-F via U5B and also causes the GATE RST line to go High. The ST+STP line also prevents a reset from the Resolution F-F by pulling the cathode of CR2 Low. When the FUNCTION switch is set to STOP, the ARM F-F resets and GATE RST goes High; however, the SCLR RST line does not go High to reset the scalars.

4-155. EXTERNAL ARMING. To externally arm the counter, the rear panel GATE CONTROL switch must be set to EXT ARM and the SAMPLE RATE control must be set to HOLD. This causes Q10, 11, and 12 to turn off and places a Low on U20D(13). The enabled gate can now provide a FORCED ARM signal when the GATE CONTROL jack receives an arm pulse. The FORCED ARM line causes the ARM line to set the Arm F-F. The remainder of the measurement proceeds in the normal manner.

4-156. EXTERNAL GATING. To externally gate the measurement, the rear panel GATE CONTROL switch must be set to EXT GATE. This setting requires both an arm pulse and a gate pulse. The switch position turns on Q10 and Q12 and disables U20D from providing a FORCED ARM signal. The switch also sets U7D(11) High, which places a Low on U17B(10). The first pulse in the GATE CONTROL jack is the arm pulse, assuming the GATE TIME switch is not in MIN. This pulse sets U11D(11) Low for at least 20 ns (depending on the external pulse width) and sets the Arm F-F with a Low on U11B(5). The resultant ARMED signal enables U17B to pass the forthcoming external gate pulse on U17B(9). This enables the Event Gate F-F on A9 with the GATE ARM lines.

4-157. In a time interval measurement, the counter "gates" on the next Channel A pulse after the GATE CONTROL line goes Low. The counter ignores Channel B pulses until the GATE CONTROL line returns High. After the line goes High, the next Channel B pulse toggles the Event Gate F-F (A9) and signals the end of the measurement. This is accomplished as follows.

4-158. With the GATE CONTROL switch set to EXT GATE, the High output of U7D(11) turns off Q7 and keeps the SCH-O line High. This line and the High on the GATE ARM line disable the Event Gate F-F during the time the GATE CONTROL line is Low. In remote operation, the same effect can be brought about by keeping the RMT GATE line High.

4-159. FUNCTION SELECTING AND DECODING. The counter works with a set of conditions given it by various control lines. The states of these lines are selected by the mode of operation being used. The function may originate from the front panel FUNCTION switch, from remote coding, or from the plug-in. The RMT line allows U14 to pass either remote codes or the FUNCTION switch codes. If plug-in is selected, the plug-in code sets U15A(12) Low and enables U8 to pass the plug-in code, rather than remote or function. The table below lists the function codes and the signal lines they activate.

<u>FUNCTION</u>	<u>CODE</u>	<u>ENABLES</u>
	CBA	
PERIOD A	000	SEC LITE, PER+TI, NANO MULT
FREQ A	001	HZ LITE
TIME INT AtoB	010	TI+EVT, TI+EVT, NOISE CONTROL SEC LITE, PER+TI, NANO MULT
PLUG-IN	011	PI SEL
RATIO B/A	100	EVT+RAT+ST+STP, RATIO+ST
START	101	EVT+RAT+ST+STP, RATIO+ST, ST+STP
STOP	111	EVT+RAT+ST+STP, ST+STP

EVENTS

Not selectable from front panel. Can be from plug-in or remote. Intended for 3-channel time interval; i.e., indicate number of inputs on "C" between A and B.

110 TI+EVT, TI+EVT, NOISE CONTROL

A10 Continued

<u>FUNCTION</u>	<u>CODE</u>	
FREQ	001	} Plug-in
FREQ X N	001	
TIME INT	010	
DVM	010	

4-160. **NOISE CONTROL.** A Low on the NOISE CONTROL line allows A8 to generate noise on the internal 500 MHz clock. This line is active when 1) function is time interval and gate time is *not* MIN, 2) in EXT GATE, any function is selected and gate time is *not* MIN, and 3) the GATE CONTROL switch is set to EXT GATE and function is Start or Stop (no time base signal is present, however). The conditions are controlled by gating of U5A and D and U2D. The NOISE CONTROL line is inactive when U2D(11) is Low, since the Noise Control F-F, U6A, clocks the Low to the Q output and disables U5C. The flip-flop examines the state of U2D each time the sample rate circuit pull the ARM line Low.

4-161. **A11 Scaler**

4-162. The scaler board accepts the incoming signal from the front panel and the time base signal and accumulates these counts in addressable decades. Once a 5 is detected in the time scaler, the measurement is stopped. Each decade in the scalers is addressed to output its data to the processor board. The A11 board also contains the sample rate, arming, and reset circuits for the instrument.

4-163. **SCALERS.** Once the Main Gate opens, it allows the Channel A signal and the time base signal to accumulate counts in their respective scalers. The A9 board contains a portion of the scalers, so the signals arriving at A11 have already been divided by 20. The Channel A signal connects to the bases of Q1 and Q2, which along with Q3 level shift it from ECL to TTL. U22A divides the signal by five before passing it to U17 and U16. These two ICs contain decade dividers, whose BCD data outputs are addressable. As the counts accumulate in the scalers, the decades internally store each changing digit, until the counting stops and the data can be addressed out. The time scaler accumulates time base counts in the same fashion.

4-164. The time scaler ends the measurement when a 5 is detected at its addressed output, since a 5 would be a division of 500 MHz and would correspond in time to a setting of the GATE TIME switch. While the count is accumulating, the PROC BUSY line is High. This places a code of "0" on the select lines (S1, S2) of U13 and U9, which allows the multiplexers to pass the BCD code on the FP GT lines to U4. The code from the GATE TIME switch, indicating a specific setting, is decoded in U4 and pulls one of the output lines Low. Output gates U11, 12, 3, and 10 supply a code to the address lines, which select one decade in the time scaler to output its most significant bit. When a 5 is placed on the output lines, it passes through the enabled 4-pole switch U26 to the TIME SCALER A and C lines. When the circuits on the A10 board receive the 5, they turn off the main gate circuit on A9, thereby stopping any further pulses from entering the scalers. The next step is to read the data out of the scalers and into the numerator and denominator registers on A13.

4-165. After the main gate closes, the PROC BUSY line goes Low and places a code of "3" on the S1 and S2 inputs of U13 and U9. This allows the two ICs to pass the states of the DRC A, B, C, D lines. These lines are the binary output of the 16-bit denominator register counter. As the counter steps through its sequence of codes, it addresses each decade (in both scalers) to output its data. The first decades to output are the +20s on the A9 board. The DRC code to U4 is "0000," which pulls pin 1 Low and enables U24 and U28 via U15C. The event code is passed through U23, an ECL to TTL converter, and inverted by U24 before being sent to U25. The time data is passed through converter U27 and inverter U28 and sent to U26. U25 and U26 are enabled by the Low output of U3C and select the "1" inputs because the SEL input is High. The data codes pass through these switches to the registers on A13.

4-166. The second DRC code (0001) causes the 1 line (U4 pin 2) to go Low and forces U25 and U26 to pass the data from U22A and U29A through the "0" outputs. As the DRC codes continue incrementing, each successive output of U4 goes Low and produces a 3-line code. The codes address the decades in U16-19 to output their stored data.

A11 Continued

4-167. When data is accumulating in the time scaler, one decade is always enabled, so that its output lines can send out a "5" to end the measurement. Because of the accumulating speed, the first bit in the first decade of U18 has difficulty outputting its state. A second binary, U29B, is used for this bit, instead. The first decade of U18 is addressed when U4(3) is Low. This disables U20D from passing the "A" bit of U18 and substitutes the output of U29B, instead. The B, C, and D lines of U18 output normally. When any other decade is addressed, U4 pin 3 is high. This enables U20D to pass U18's A bit and disables U20C from passing U29B's A bit.

4-168. EXCESSIVE GATE TIME When making a measurement, if the period is more than ≈ 3.5 times the GATE TIME setting, the counter will reset and flash lamp test on the display. This occurs through the following steps. When an 8 is detected on the input of U26, pin 7 returns High and clocks U22B, causing U3B pin 6 to go Low. With subsequent data entering U26, pin 7 stays High until just prior to three times the GATE TIME setting when it goes Low. When it returns High (at 3.6 times the switch setting), it clocks U22B's output Low and causes U3B(6) to go High. This causes U14A to set and the LAMP TEST line to go Low. U7D causes the $\overline{\text{RST}}$ line to also go Low, via U15A.

4-169. SAMPLE RATE AND ARMING. The sample rate circuit controls the arming of the counter. The counter is armed in one of five ways: 1) with the SAMPLE RATE pot circuit, 2) by the plug-in (P18 pin 19), 3) externally (P18 pin 21) from the rear panel (remote), 4) when in START/STOP, or 5) by resetting the counter.

4-170. When the measurement is ready to be displayed, the DISP CLK EN line goes High and causes the base of Q7 to go Low. This removes Q7's short from C5 and allows C5 to charge through R20 and the SAMPLE RATE pot. The time required for C5 to charge is the display time. When the charge on C5 reaches about 1.4V, it causes Q8 A and B to conduct and triggers a Low output from U2C. This arms the counter by pulling U5A(6) Low, via U5B. When the counter is in remote operation, the SAMPLE RATE line is shorted to +5V, and C5 charges through R20 in about 80 ms. If remote operation requires faster arming, the FORCED ARM lines sets the counter to a maximum sample rate of ≈ 5 ms. This line is also pulled Low through CR8 by the ST + STP line, which is Low during totalize.

4-171. The counter is also armed after a reset by the 1st cycle Arm flip-flop (U20A and B). When a reset is generated from U7D, it sets the output of U20A High. This sets U20B(6) Low, since U20B(5) is also High. U5B turns on and places a High on U5A(4). This does not set U5A's output Low, since U5A (1) is still held Low through CR11. Once the reset signal ends, pin 1 goes High and U5A arms the counter. The flip-flop resets when the PROC BUSY line goes Low.

4-172. Normally, processing the data begins when a 5 is detected in the time scalars. This is not possible for all measurements. During a plug-in measurement or a totalize measurement, U3A is used, instead, to initialize the processor. The SAMPLE RATE ARM lines goes High with the PI ARM line, a reset, or an output from the sample rate circuit. In totalize, the sample rate is about 80 ms. The SAMPLE RATE ARM line is ANDed on A10 with PI DATA or ST + STP to pull the INIT PROC line Low.

4-173. RESET. The counter uses several reset lines, and these are wire-ORed at U1A(1). When the counter is first turned on, C6 conducts rapidly and holds U1A(1) to a low state through CR9. The resultant Low on U7D(13) produces a reset by pulling the $\overline{\text{RST}}$ line Low via U15A. If the counter is not in remote operation, a reset will occur if the FUNCTION, GATE TIME, or DISPLAY POSITION switches change position or if the front panel RESET button is pushed. A reset can also be generated remotely (REM RESET) or from the plug-in (PI RST). Excess gate time also resets the counter.

4-174. A reset signal also resets the Auto Single Cycle flip-flop, U14B. This pulls the $\overline{\text{AUT SC}}$ line Low, which instructs the counter that it should examine the measurement for a new annunciator. This is also done during the processing cycle. When $\overline{\text{LOAD MS}}$ clocks the High level on U14B(12), the annunciator has been selected.

4-175. MIN GATE TIME. This signal is developed on the board to allow a gate time for the duration of only one cycle of the measured frequency. This signal is developed when the GATE TIME switch is set to the "MIN" position. The GTS code of 13 is switched in the same manner as all other GT codes. The 4-to-16 line decoder (U4) decodes the 13 and inverts the output level in

U3C. The high output level is sent from the board via pin P1B(2). This High signal is also tied to the time scaler output switch U26, which disables the switch from passing the 5 code. This allows the MIN GATE signal to maintain full control of the gate.

Paragraphs 4-176 through 4-182 have been deleted.

4-183. A12 Option 011, General Purpose Interface I/O

4-184. Option 011 allows the counter to be externally programmed to make measurements and to output the results of the measurements. The system uses standard ASCII characters for programming. The board can be divided into a few, basic sections. The Bus Communicator section determines the operating mode of the assembly by the use of combinational logic and three flip-flops.

These modes are - talk, computer dump, and listen. When the counter is listening, the controller changes the basic program that is stored in the Data Steering Latch section. When the counter is talking, measurement data is sent to the bus through the Data Encoder ROMs and Bus Drivers.

4-185. When the counter is first turned on, the power up reset circuit of R7, C5, and U12C resets the mode flip-flops (U5A, U5B, and U6B) and the Data Steering Latches via U4D. For full communication with the bus, the rear panel TALK ONLY-ADDRESSABLE switch should be set to the ADDRESSABLE position. The following paragraphs describe the circuits as they might be used in a typical programming sequence.

4-186. ADDRESSING TO LISTEN. The controller sets the ATN line Low, causing U13D(11) to go High and set NDAC Low, via U2B. The NRFD line is High, indicating to the controller that the counter can now accept an ASCII byte. The controller addresses the counter to listen $\begin{pmatrix} D & 7 & 6 & 5 & 4 & 3 & 2 & 1 \\ 1 & 0 & A_2 & A_4 & A_4 & A_2 & 0 \end{pmatrix}$ and, at some time later, pulls the DAV line low, indicating there is valid data on the bus.

4-187. If the 4-line address code equals the code selected by the rear panel ADDRESS switches, the A=B line of U30(14) goes High. The High from U30 and the listen code (DI07 and DI06) are routed through the combinational gating of U23B, U22B, U23E, U9A, U21, and U23D. The result of this gating is a High on the J input of the listen F-F (U6B) and a Low on the K input. The DAV line was set Low when the counter was addressed to listen; however, it was delayed 500 ns by R4, C3, and U12B to allow time for the address code to be gated. The DAV line now produces a 500 ns pulse in U3E, U12A, and U13B. This pulse NANDs in U4B with ATN (still Low) and clocks the three mode flip-flops (U5A, U5B, and U6B). Only the listen F-F toggles. The Low from U12A(3) causes U2B to set the NDAC line High, indicating that the counter has been addressed. When DAV goes High, the NRFD line then goes High and signals the controller that the counter can receive new data.

4-188. CHANGING THE STORED PROGRAM. Once a reset has been generated from either power up reset, IFC, or PB reset, the data steering latches and their associated gates automatically set up a predetermined program. This program electrically sets all measurement controls to one setting, e.g., FUNCTION to frequency, GATE TIME to 1 second, etc. If the program is to be changed, it must be programmed to change. This is accomplished as follows.

4-189. Once the counter has been programmed to listen, the ATN line goes High and the Listen F-F remains set. Assume the function is to be changed from frequency to period (see Table 2-3). This requires an ASCII code of "F1" $\left(F = \begin{matrix} D10 & 7 & 6 & 5 & 4 & 3 & 2 & 1 \\ 1 & 0 & 0 & 0 & 1 & 1 & 0 & 1 \end{matrix} \right)$ shown in Table 2-2. The controller places the ASCII "F" on the bus and also set DAV Low, indicating the data is valid.

4-190. The incoming code is inverted by the Bus Terminators and is used as follows: D107 is not pulled Low; D106 and D105 disable U15B, which places a High on U15C(10); and D104 through D101 are placed on the input lines of U26. When the delayed DAV signal causes U13B to pulse Low, it enables U15C and allows U26 to transfer the data code to its output lines. As with every exchange of data, the transfer lines (NDAC, NRFD) perform their *handshake* operation.

ASCII CHAR	DATA SHEERING LATCH
F	U25
G	U24
D	U32
C	U35
I	U5D, U8C
E	U16
J	U5A

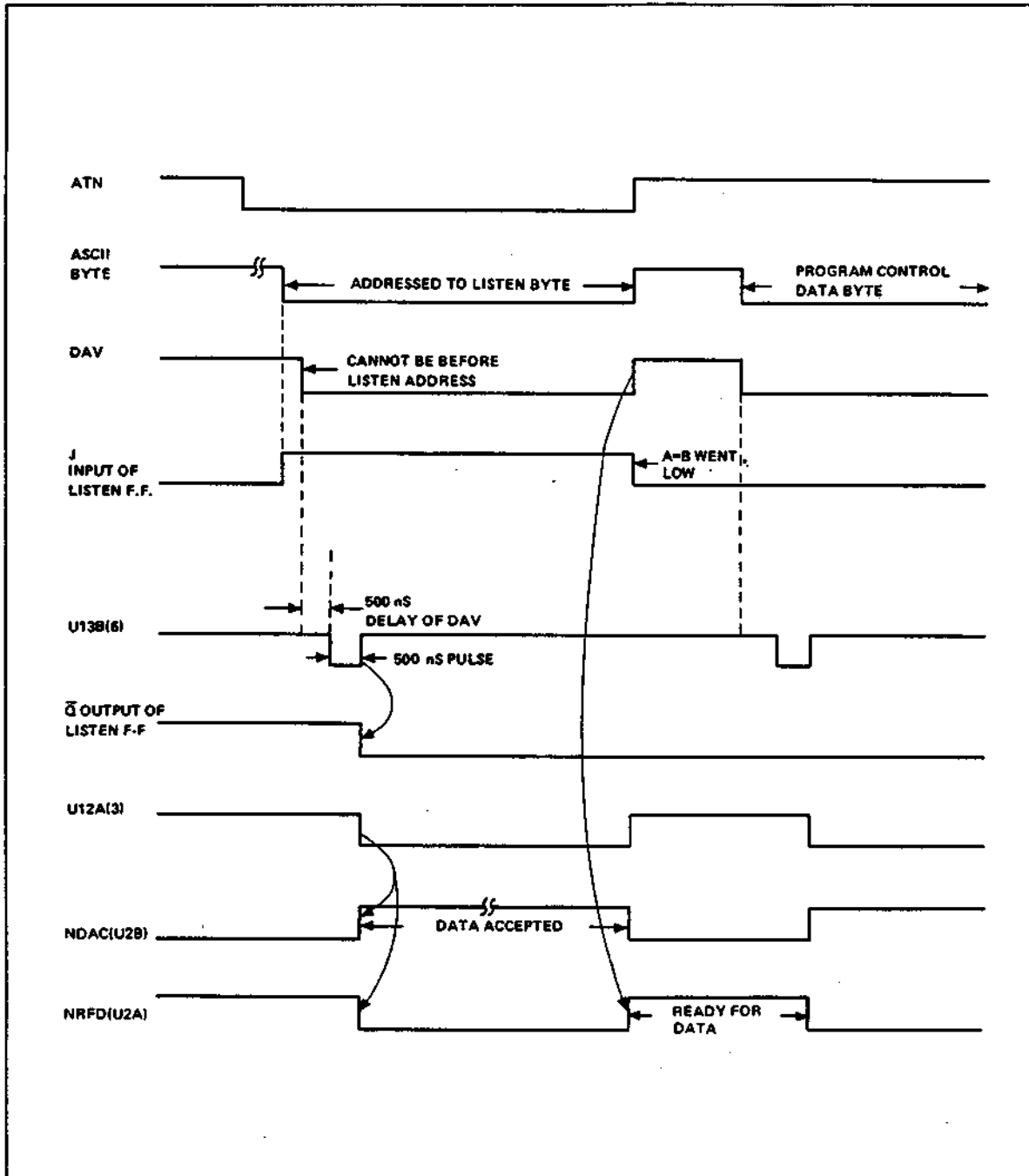


Figure 4-21. Address to Listen Timing Diagram

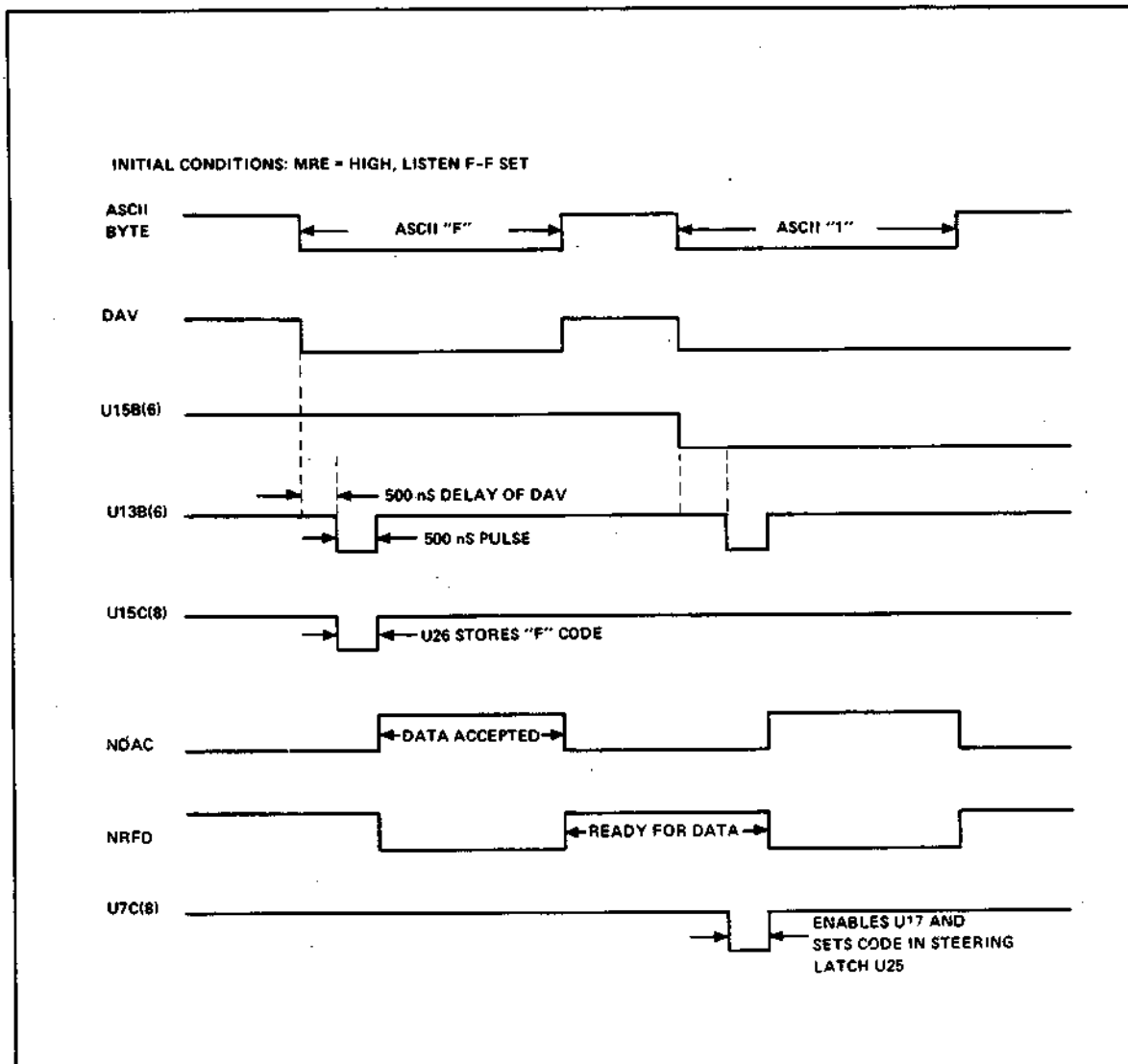


Figure 4-22. Remote Program Timing Diagram

4-191. The controller removes the "F" from the bus, replaces it with an ASCII "1", and pulls DAV Low. This code is used as follows: DI07 is not pulled Use; DI06 and DI05 enable U15B; and DI04 through DI01 are placed on the inputs of the Data Steering Latches. When the delayed DAV signal pulses Low at U13B, it turns on U7C and causes U17 to accept the "F" code that was stored in U26. U17 uses this code to set one of its output lines Low; in this case, it is the 6 line (pin 7) and is used to enable U25 (the function latch). Once enabled, U25 transfers the "1" code to its output lines. Any further changes in the basic program are accomplished in the same manner.

4-192. SWITCHING TO REMOTE. Sometime before the counter makes a measurement, using the newly programmed control settings, it must be switched to remote operation. To do this, the controller sets the REN line Low and sends an ASCII "E8". The "E" enables U16, and the "8" causes U16(4) to go high. This output is Nanded in U8B with the inverted REN signal from U9C. This forces the $\overline{\text{RMT}}$ line Low and sets the counter to follow the remote instructions, instead of the counter's controls. The REN line must remain Low if the counter is to use the functions that were programmed.

4-193. ADDRESSING TO TALK. Before the counter can "talk", it must be cleared from listen. A code of "??" $\left(\begin{array}{c} \text{D10} \ 7 \ 6 \ 5 \ 4 \ 3 \ 2 \ 1 \\ \quad \ 0 \ 1 \ 1 \ 1 \ 1 \ 1 \ 1 \end{array} \right)$ enables U21 and disables U4A. When DAV clocks the three flip-flops, the Listen F-F

A12 Option 11 Continued

(6B) returns to its reset state. The counter can now be addressed to "talk". When the Talk F-F sets, the $\overline{\text{TALK}}$ line causes TALK ONLY to go Low, via the switch circuit on A19. This disables U15D and enables U13C (ATN = HIGH). The Low output from U13C ($\overline{\text{TALK ENABLE}}$), switches the bus terminators from their *third state* (off or high impedance state) to their active state. Measurement data can now be placed on the bus. U2C(8) sets the SRQ line High, indicating to the controller that the counter has data ready.

4-194. The DC SER OUT lines control the order of output data and the state of the ROMs (U29 and U27). Only one ROM is on at any given time. Three of the ROM's outputs (DI07,6, and 5) are sent to the Bus Drivers directly, while the remaining four lines are selected by four-pole switch U28. The ROMs convert the internal data codes to ASCII format. Since the counter is in its out. put routine, the $\overline{\text{EXT OUT EN}}$ line is Low. The FLAG = H line goes High each time a new byte is ready for outputting on the bus. These two lines NAND in U2D to generate a DAV signal. Table 4-2 shows the sequence of data flow to the ROMS, while Tables 4-3 and 4-4 list the ROM codes.

Table 4-2. ROM Sequence

DC SER OUT			DPLR<16	ENABLED ROM	BUS DATA
C	B	A			
0	0	0	L	U29	NONE. Counter is in process of deleting all leading blanks from measurement data before output cycle begins.
0	0	1	L	U29	DIGIT SIGN. ROM examines $\overline{\text{SIGN}}$ line to determine polarity of measurement. No output if polarity is plus (line = H).
0	1	0	L	U29	DENOMINATOR REGISTER OUTPUT. U28 passes measurement digits contained on DR lines. Blank code (DR C & D=H) causes zero code on bus.
0	1	0	H	U29	DECIMAL POINT. DPLR<16 line may go High any time during DR output to insert decimal point in output data.
0	1	1	L	U29	"E". Indicates that forthcoming data will be the exponent for power of 10 of measurement data.
1	0	0	L	U27	EXPONENT SIGN. Outputs minus sign to indicate a number smaller than one; e.g., 6=M, -6= μ .
1	0	1	L	U27	EXPONENT DIGIT. Outputs digit to indicate magnitude of measurement data number.
1	1	0	L	U29	CARRIAGE RETURN. Used with teleprinter. Signals end of output. Provides ASCII code to generate teleprinter carriage return.
1	1	1	L	U29	LINE FEED. Used with teleprinter. Provides ASCII code to advance paper to next line.

4-195. **COMPUTER DUMP.** Computer Dump causes the Denominator Register and Numerator Register to output data directly from the scalars. When addressed to computer dump, U5B sets and forces the $\overline{\text{FORCED ARM}}$ line Low, via U33B. This line bypasses sample rate and forces the counter to make measurements at its fastest possible rate. The $\overline{\text{COMP DUMP}}$ line goes Low and prevents the counter from entering the arithmetic process.

Table 4-3. Rom Outputs , (1816-0254) U29

WORD	INPUTS						OUTPUTS							
	BINARY SELECT					ENABLE	8	7	6	5	4	3	2	1
	E	D	C	B	A	G								
0	L	L	L	L	L	L							L	
1	L	L	L	L	H	L							L	
2	L	L	L	H	L	L							L	
3	L	L	L	H	H	L							L	
4	L	L	H	L	L	L		L			L		L	L
5	L	L	H	L	H	L		L			L		L	L
6	L	L	H	H	L	L	L	L	L	L	L		L	L
7	L	L	H	H	H	L	L	L	L	L	L		L	L
8	L	H	L	L	L	L	L				L		L	L
9	L	H	L	L	H	L					L		L	
10	L	H	L	H	L	L	L				L		L	L
11	L	H	L	H	H	L							L	
12	L	H	H	L	L	L		L		L	L	L		L
13	L	H	H	L	H	L		L		L	L	L		L
14	L	H	H	H	L	L		L		L	L	L		L
15	L	H	H	H	H	L		L		L	L	L		L
16	H	L	L	L	L	L								
17	H	L	L	L	H	L								
18	H	L	L	H	L	L								
19	H	L	L	H	H	L								
20	H	L	H	L	L	L								
21	H	L	H	L	H	L								
22	H	L	H	H	L	L								
23	H	L	H	H	H	L								
24	H	H	L	L	L	L		L			L	L	L	L
25	H	H	L	L	H	L		L			L	L	L	L
26	H	H	L	H	L	L		L			L	L	L	L
27	H	H	L	H	H	L		L			L	L	L	L
28	H	H	H	L	L	L	L		L		L	L	L	L
29	H	H	H	L	H	L	L		L	L	L	L	L	L
30	H	H	H	H	L	L	L		L	L	L	L	L	L
31	H	H	H	H	H	L	L		L	L	L	L	L	L
ALL	X	X	X	X	X	H	H	H	H	H	H	H	H	H

Table 4-4. ROM Outputs, (1816-0255) U27

WORD	INPUTS						OUTPUTS							
	BINARY SELECT					ENABLE	8	7	6	5	4	3	2	1
	E	D	C	B	A	G								
0	L	L	L	L	L	L			L		L		L	L
1	L	L	L	L	H	L			L		L		L	L
2	L	L	L	H	L	L			L		L		L	L
3	L	L	L	H	H	L			L		L		L	L
4	L	L	H	L	L	L		L			L		L	L
5	L	L	H	L	H	L		L			L		L	L
6	L	L	H	H	L	L		L			L		L	L
7	L	L	H	H	H	L					L		L	L
8	L	H	L	L	L	L		L			L		L	L
9	L	H	L	L	H	L		L			L		L	L
10	L	H	L	H	L	L		L			L		L	L
11	L	H	L	H	H	L			L		L		L	L
12	L	H	H	L	L	L			L		L		L	L
13	L	H	H	L	H	L			L		L		L	L
14	L	H	H	H	L	L			L		L		L	L
15	L	H	H	H	H	L					L		L	L
16	H	L	L	L	L	L		L	L				L	L
17	H	L	L	L	H	L	L			L			L	L
18	H	L	L	H	L	L			L	L			L	L
19	H	L	L	H	H	L	L		L	L			L	L
20	H	L	H	L	L	L			L	L			L	L
21	H	L	H	L	H	L	L			L			L	L
22	H	L	H	H	L	L		L	L				L	L
23	H	L	H	H	H	L							L	L
24	H	H	L	L	L	L		L	L				L	L
25	H	H	L	L	H	L	L			L			L	L
26	H	H	L	H	L	L			L	L			L	L
27	H	H	L	H	H	L	L	L		L			L	L
28	H	H	H	L	L	L			L	L			L	L
29	H	H	H	L	H	L	L			L			L	L
30	H	H	H	H	L	L		L	L				L	L
31	H	H	H	H	H	L							L	L
ALL	X	X	X	X	X	H	H	H	H	H	H	H	H	H

4-196. A13 Register, Adder/Subtractor

4-197. The A13 board performs an arithmetic process with the contents of the Event Scaler and Time Scaler. The result of this operation is displayed on the front panel. The board consists of three registers: Numerator, Denominator, and Quotient. Each register contains a Random Access Memory (RAM), having 16 addressable storage locations that are capable of storing 4 bits per location. Data from the Events and Time Scalers are sent to the Numerator and Denominator registers and are then arithmetically manipulated in the Adder/Subtractor circuitry. The Quotient Register (QR) stores the result, while the Quotient Multiplier Counter (QMC) and Multiplier Storage circuitry keep track of the annunciator. The QMC also keeps track of the number of successful subtractions and sends this number to the QR.

4-198. The registers can shift data in the following manner.

Numerator Register

The Numerator register can write data into its RAM from the Time Scaler (A11), Denominator register, or Adder/Subtractor. It can read data out of the RAM into the Adder/Subtractor, Quotient register, or Denominator register.

Denominator Register

The Denominator register can write data into its RAM from the Events Scaler (A11), Quotient register, Numerator register, and Plug-in. It can read data out of the RAM to the plug-in, Adder/Subtractor, Numerator register, display, and output option board, A12.

Quotient Register

The Quotient register can write data into its RAM from the Numerator register, and Quotient Multiplier Counter (QMC). It can read data out of the RAM to the Denominator register, only.

4-199. REGISTER STORAGE OPERATION. The following description concerns an exchange of data between the Numerator Register (NR) and the Denominator Register (DR). The description serves as an explanation for the three registers in general. Each digit of Time Scaler data and Events Scaler data is represented as a 4-bit code. The RAMs are capable of storing 16 of these codes in separate locations (or addresses). The RAM counter that is enabled to count produces a new code with each negative transition of REG CLK. Each new code selects a different RAM location. Once the location is selected, data contained in the location can be read out while REG CLK is Low. If the data source code for the RAM is other than "READ", new data is written into the RAM when REG CLK goes High. Shifting data from one RAM to another requires switches to control the data flow and latches to store data during the write operation. Assuming data has been written into the RAMs from the scalars, a later ROM cycle exchanges data between NR and DR (a frequency measurement). This operation appears as follows.

4-200. The NR EN A and B code changes to "00", and the DR EN A, B, and C code changes to "101". NR CLK EN and DR CLK EN lines are High. This occurs at the start of a new process cycle. REG CLK is Low and data stored at the least-significant-digit (LSD) location appears on the RAM output lines, since the "WE" inputs are High (read mode). The data output of the NR RAM is sent to Latch U20, while the output of the DR RAM is sent to Latch U4 via U1.

4-201. When REG CLK goes High, the data in the latches is locked in, and the outputs of gates U27A and U12B to Low. This last condition forces the RAMs into the "write" mode. The NR RAM writes in the DR data (via U30) that is stored in U4. The DR RAM writes in the NR data (via U17 and U26) that is stored in U20. When REG CLK goes Low again, U22 and U28 are clocked to a new location code. This process continues until all 16 words have been exchanged. The number of clock pulses (REG CLK) for this process was 16.

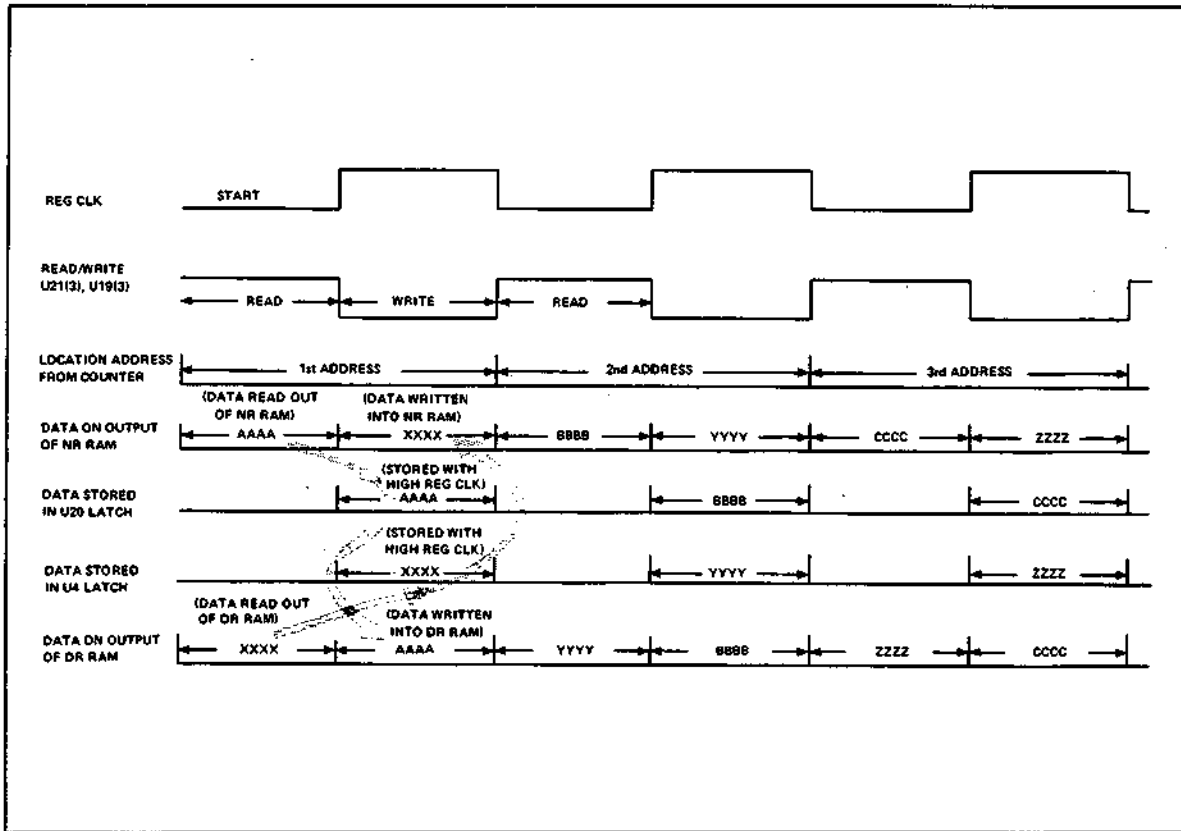


Figure 4-23. An Exchange of NR and DR Data

4-202. All data entering the registers from the scalers is written into the DR and NR with "LOAD EVENT SCR" and "LOAD TIME SCR" codes on the DR EN lines and NR EN lines, respectively. Data is sent to the Adder/Subtractor circuit during the "READ" portion of REG CLK (Low). The result of each digit subtraction is stored in U4 and in the NR during the "WRITE" portion of REG CLK with a "LOAD A/S" code on the NR EN lines.

4-203. **ADD/SUBTRACT CIRCUITRY.** This circuit performs an arithmetic operation between the Events Scaler's contents (E) and the contents of the time Scaler (T). The operation is always a division, i.e., either E for a frequency measurement or $\frac{E}{2XT}$ for a period measurement. The process of division is accomplished by performing a series of subtractions. Under certain conditions this circuit also performs addition (e.g., when the Numerator Register's content is added to itself to double the time count, to recover an overdraft of an unsuccessful subtraction, and during START OR STOP A+B).

4-204. **Addition Mode (NR←NR+DR).** At the beginning of the process cycle, the ADD line is High and WORD DBL CLK pulses High. Together, the two signals reset U6B via U27D. This sets the initial conditions for the addition: U3 does not receive a carry in (U3 pin 13).

4-205. Assume the circuit is to add 25 and 35. In this example, the registers would appear as:

$$\begin{array}{r} \text{NR} \quad + \quad \text{DR} \quad \rightarrow \quad \text{NR} \\ \left[\begin{array}{c} 0000 \dots 25 \\ 16 \end{array} \right] + \left[\begin{array}{c} 0000 \dots 35 \\ 16 \end{array} \right] = \left[\begin{array}{c} 0000 \dots 60 \\ 16 \end{array} \right] \end{array}$$

The 5's are added first. Both 5's are in BCD form and are applied to the A and B inputs of U3 $\left(\begin{array}{c} A_D \ A_C \ A_B \ A_A \\ 0 \ 1 \ 0 \ 1 \end{array} , \begin{array}{c} B_D \ B_C \ B_B \ B_A \\ 0 \ 1 \ 0 \ 1 \end{array} \right)$. The Σ output data is the sum of these two numbers and is expressed in binary $\left(\begin{array}{c} \Sigma_D \ \Sigma_C \ \Sigma_B \ \Sigma_A \\ 1 \ 0 \ 0 \ 0 \end{array} \right)$. Since the counter circuits operate in BCD only, this code must be converted back to BCD. A second adder, U2, adds a zero when the sum is 0 to 9 and adds 6 when the sum is 10 to 18.

A13 Continued

4-206. U5A and B detect when numbers are from 10 to 15, while numbers from 16-18 are indicated by C4 going High (U3). The C4 line is a carry output. Any one of these sources will cause the output of U5C to go High. In the example, the result (10) is a Low output on U5. The High output of U5C applies "6" to the "A" inputs of U2 $\begin{pmatrix} A_D & A_C & A_B & A_A \\ 0 & 1 & 1 & 0 \end{pmatrix}$. It also places a High on the D input of U6B. When the 10 and 6 are added in U2, the result is a '0' and a carry. To this point, the entire addition appears as follows:

$$\begin{array}{r} (5) \ 0101 \\ (5) \ +0101 \\ \hline (10) \ 1010 \end{array} \quad \begin{array}{r} (10) \ 1010 \\ (6) \ +0110 \text{ --conversion number} \\ \hline \ 1 \ 0000 \text{ --BCD} \end{array}$$

↑
Binary

↙ carry in (CO)

4-207. The "0" output of U2 is stored in the Numerator register (with a LOAD A/S code on the NR EN lines), while the carry of 1 (output of U5C) is clocked from the D input of U6B into the CO input of U3. The next addition adds the next two numbers, plus the carry of 1, e.g.,

$$\begin{array}{r} (2) \ 0010 \\ (3) \ +0011 \\ \hline (5) \ 0101 \end{array} \quad \begin{array}{r} (5) \ 0101 \\ (1) \ +0001 \text{ --CO} \\ \hline (6) \ 0110 \end{array}$$

The remaining 14 additions are 0+0 = 0, so that the final answer stored in NR is $\underbrace{(000\dots60)}_{16}$.

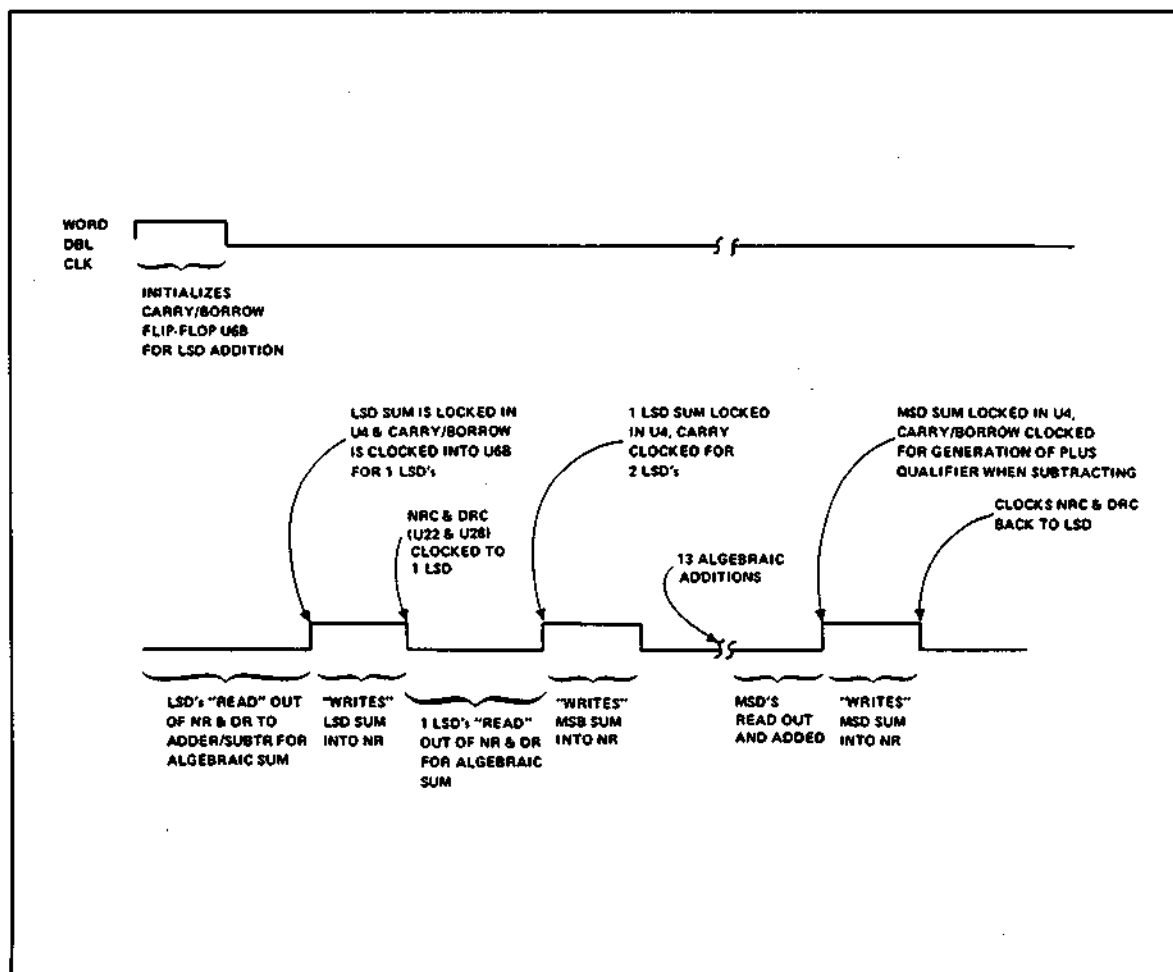


Figure 4-24. Process Cycle Diagram of Addition

A13 Continued

4-208. Subtraction Mode (NR←NR-DR). During 2(subtraction, the ADD line is Low. The state of this line produces four important conditions: 1) It disables U5A and B from detecting numbers from 10-15, 2) It places a possible code of "10" or "0", on the A input of U2 ($\begin{matrix} \text{AAAA} \\ 1001 \end{matrix} + \text{CO of 1 is effectively 10}$ and $\begin{matrix} \text{AAAA} \\ 1111 \end{matrix} + \text{CO of 1 is effectively 0}$ when C4 from U2 is ignored), 3) WORD DBLCLK sets U6B via U27B, which causes a carry 1 in U3, and 4) It enables the exclusive OR gates of U11A, B, C, D. This last condition causes an inversion of the DR outputs and has the effect of taking a negative number and adding 15 to it (actually 16 with CO).

4-209. Assume that two sets of numbers are going to be subtracted: 7 minus 9 followed by 8 minus 5 or, seen differently, 87 minus 59. The exclusive OR gates invert the 9 code (1001) into a code of 6 (0110). This number is added in U3 to the NR number. One of the initial conditions was the setting of U6B. This places a High on the CO input and results in adding a 1 to the other two numbers. To this point, the addition process appears as follows:

$$\begin{array}{r} \text{NR(7) 0111} \\ \text{DR(9) 1001} \text{ -- complement --} \end{array} \begin{array}{r} \text{(7) 0111} \\ \text{(6) +0110} \\ \hline \text{(13) 1101} \end{array} \begin{array}{l} \text{CO --} \\ \text{(13) 1101} \end{array} \begin{array}{r} \text{(1) +0001} \\ \hline \text{(14) 1110} \end{array} \text{ -- binary output of U3}$$

4-210. Since the sum is less than 16, the C4 output of U3 remains Low. The output of U5C is, therefore, Low. U5C and U7A place a code of 9 on the A inputs of U2 and supply a carry input to CO. The result of the addition in U2 is as follows:

$$\begin{array}{r} \text{(14) 1110} \\ \text{(9) +1001} \\ \hline \text{1 0111} \end{array} \begin{array}{r} \text{(7) 0111} \\ \text{(1) +0001} \text{ --(CO), therefore 7-9 = 8.} \\ \hline \text{(8) 1000} \end{array}$$

↑
lost

4-211. When subtracting a larger number from a smaller number, as done here, a digit must be borrowed from the next higher column. This circuit accomplishes borrowing by not adding a 1 to the next set of numbers. When REG CLK goes High it clocks the low on the D input of U6B into the CO input of U3. When REG clock goes Low, it clocks the next set of numbers onto U3's input lines. The next set of numbers in this example is 5 and 8. As before, the 5 is inverted in the exclusive OR gates and added with 8 in U3. This time, however, a 1 is not added in U3: the result of borrowing. The addition appears as follows:

$$\begin{array}{r} \text{NR (8) 1000} \\ \text{DR (5) 0101} \text{ -- complement --} \end{array} \begin{array}{r} \text{(8) 1000} \\ \text{(10) +1010} \\ \hline \text{(18) 1 0010} \end{array} \text{ binary}$$

↑
lost

4-212. Since the sum is greater than 15, the C4 output goes High. This causes a High on the output of U5C, which, along with U7A, produces a code of 15 on U2's A inputs and a High on the carry input, CO. Notice, also, the High on the D input of U6B, which will produce a carry in for U3 on the next positive edge of REG CLK. At the same time, the \bar{Q} of U6B goes low, causing a High output from U27C. This line supplies the plus qualifier to A14A(14). The addition in U2 appears as follows:

$$\begin{array}{r} \text{(2) 0010} \\ \text{(15) +1111} \\ \hline \text{1 0001} \end{array} \begin{array}{r} \text{(1) 0001} \\ \text{(1) +0001} \text{ --CO} \\ \hline \text{(2) 0010} \end{array}$$

↑
lost

For the next 14 digits, the operation is 0-0 = 0. The result of the two subtractions is stored in the Numerator register and appears as $\underbrace{000\dots28}_{16}$ (87 - 59 = 28).

4-213. DIVISION PROCESS, QMC, AND QR. The previous example of subtracting two numbers is only one portion of the arithmetic process. The process is a division, not a subtraction, and is accomplished by performing a *series of successful subtractions*. A successful subtraction is when all 16 digits in the DR have been subtracted (one time only) from all 16 digits in the NR. The two numbers in the previous example will serve to demonstrate the entire division.

4-214. The first subtraction gave a difference of 28, which was stored in the NR. At the end of the subtraction (all 16 digits), the A14 board examines the state of the PLUS line. If this line is High, the QMC CLK line pulses Low and then returns High and causes the QMC (U23) to increment by one, indicating a successful subtraction. Another subtraction can now be attempted; this one, however, is not successful.

After subtraction, the PLUS line is Low, and the QMC does not increment. Instead, a new set of commands is generated from A15. These commands cause the QR to accept the "1" stored in QMC; force the circuit to add

and place the answer in NR; and, once done, cause the NR contents to shift one place to the left. The last operation is done with a 15 pulse cycle. That is, 15 REG CLK pulses are applied to NRC (U22), causing the left most zero in the NR to become the least significant digit. This operation converts

4-215. The QMC is reset and another subtraction process continues, this time with the numbers

The DR contents can be successfully subtracted four times before a negative answer appears. At that time, the 4 is also entered into the QR RAM. The entire process has produced an answer of 1.4.

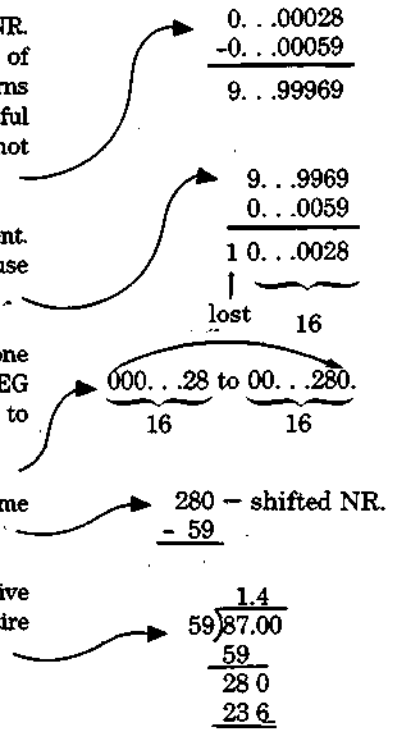
The division process continues until QR has enough resolution.

4-216. Before the answer is sent to the display, the multiplier of the measurement (K, M, μ , etc.) must be determined. The QMC is used in the display formatting routine to keep track of the annunciator code. After formatting, the contents of QMC are read out of U23 and stored in the three D-type flip-flops, U15 A and B and U6A. The stored code is used to light the annunciator.

MULT STORAGE	(NANO MULT=L) ANNUNCIATOR	(NANO MULT=H) ANNUNCIATOR
000	G	N
001	M	μ
010	k	m
011	units	units
100	m	k
101	μ	M
110	n	G
111	not allowed	not allowed

4-217. DISPLAY CYCLE. The DR RAM is used to output measurement readings to the display. When this occurs, the DRC requires 11 pulses to output all of the DR data; but it requires 12 pulses if a minus sign is to be displayed.

4-218. At the start of the display cycle, the DR CLK EN line goes High, and REG GLK begins clocking the DRC (U28). The DR outputs 11 words of data (0 to 10) and then a decision is made whether to light the hard-wired minus sign in the display. At this point the output code of DRC is 10 (1010). This code enables U18B, causing U28(9) to go Low. The DRC loads in the code on the ABCD lines. If the SIGN - line is High, U25A is disabled and places a "0" on the input lines. The next clock pulse returns the DRC count to zero. If SIGN - is Low, U25A is enabled and places an "11" on the DRC lines. This code turns on the hard-wired minus sign in the display. When lamp test is active DRC cycles through all 16 states.



4-219. A14 Qualifier

4-220. The A14 board selects the proper qualifier for each process cycle. It also stores the two most significant digits of the next ROM address code. The heart of the A14 board is U7, the Qualifier Gate Array (QGA), which contains the qualifying circuitry, the DPLR counter and the DPLK counter. A comparison circuit, used to position the decimal point counter, is also included in U7. The internal logic of the QGA is reconfigured each time the 5345A is turned on. The configuration data is stored in EPROM U3 and loaded into the QGA as soon as sensor U12 detects the correct supply voltage. Buffers U4, U8, U9, and U11 protect the data and address lines of U3 during the configuration cycle.

4-221. QUALIFIER CIRCUITS. Of all returning qualifiers that are available for selection, only one is chosen and sent to A15. The selected qualifier is the output P73 (Testpoint C) of the QGA and is sent to A15 as SV7(T). This is the LSD in the octal code for the next ROM address. An example is helpful in understanding the principle of selecting the various ROM addresses.

4-222. Next State Address Storage. Assume the ROMs on A15 have just been addressed to location 211 (see Processor Flow Charts, Section V). The ROMs output a new set of commands. Part of these commands are used to generate the next ROM address; these are the six SV(T+1) lines. Shortly after this code appears on the input lines of U1, the code states are clocked into storage by \sim WORD DBL CLK. In this example, the stored code is 15X, with X being the code's LSD and unknown at this time. Later X will be replaced by the returning qualifier state (1 or 0).

4-223. Qualifier Selection. The clocked in code states SV1(T+1) through SV6(T+1) are used to select the proper qualifier in the QAD. The selected qualifier (P73) is applied to the D input (Pin 17) of U5. When the next ROM cycle begins, \sim ROM CLK clocks all qualifier states, now including SV7(T+1) to the output of U5. The result is the new address code SV1(T) through SV7(T) on the ROM's address lines. In the above example, the qualifier is "1" if \sim PI DATA is "1" and BKPT6 is not selected. The next ROM address is 151. If these conditions are not true, the next ROM address is 150.

4-224. DPLR CIRCUIT. The abbreviation DPLR stands for "decimal point locator for the result". The circuit is a 6 bit UP/DOWN counter located within U7. Before counting begins, the counter is always reset by the \sim DPLR<-1 command. The DPLR code is sent out of A14 via U6 when the P14 line is High. When the P14 line is Low, the DP line direction is reversed to allow a plug-in to load decimal point data into DPLK. P14 is buffered by U9 and available as output signal \sim PI XMT.

4-225. Count Up Mode. In a "count up operation", the flow chart command is $DPLR < DPLR + 1$. The purpose is to shift the decimal point to the left. The command places \sim DPLR UP to a Low and always pulses the \sim DPLR CLK line Low.

4-226. Count Down Mode. In a "count down operation", the flow chart command is $DPLR < DPLR - 1$. The purpose is to shift the decimal point one place to the right. The command places \sim DPLR UP to a High state and pulses the \sim DPLR CLK line Low.

4-227. Relating DPLR Code to D.P. Position. Each code of the DPLR relates to a specific placement of the decimal point in the display. Figure 4-25 shows the decimal point in the display and outside of the display. The ranges outside the display are possibly used during computation. Generally, the positive range codes are used in giga-unit arithmetic and negative range in the nano-unit arithmetic.

4-228. DPLK CIRCUIT. The abbreviation DPLK stands for "decimal point locator for K". The K refers to K data from the plug-in. The counter is located within QGA and is used in several operations. Briefly, it is used in computer dump to determine when all characters in the DR and NR have been strobed out; it recognizes when all 16 characters in NR have been examined for purposes of determining resolution; it stores the decimal point code for K data; it is used in the serial out routine to determine when all 16 characters have been examined; and, in general, it is the source of qualifier signals.

4-229. Resetting and Counting. The DPLK counter is always reset prior to use. Reset occurs when the DPLK < -1 line goes Low. Count downs are accomplished with the \sim DPLK CLK line. Each clock pulse decrements the count by one.

A14 Continued

4-230. Loading Plug-In Decimal Point Data. When using K data from the plug-in, the \sim DPLK < DPLK PI command line goes Low to enter the decimal point code into DPLK storage. Prior to loading, a \sim DPLK < -1 command is generated.

4-231. Generating Display Clock. The DISP CLK line is used to strobe the display at a much slower rate than REG CLK can normally provide. The DISP CLK line is a result of dividing the \sim DPLK CLK signal by 64.

4-232. COMPARATOR CIRCUITRY. The comparator circuit, which is also included in the QGA, compares the 6-bit DPLR code to one of four data sources. These data sources are: DPLK lines (6 bit), PI DISP POS lines (4 bits), RMT DISP POS (4 BITS), FP DISP POS (4 bits). The result of comparison is a \sim DPLR = qualifier or a DPLR > qualifier. These qualifiers are available at testpoint E and testpoint G respectively.

Paragraphs 4-229 through 4-240 have been deleted.

4-241. A15 ROM

4-242. The A15 board contains four ROMS, used for generating the command lines. These lines control the counter's internal operation in accordance with the flowchart. Also present is the Multivibrator Clock: the source of all clock signals used in timing or in the shifting of data. Associated with this is the Processor Timing circuit which produces MSB, ROM CLOCK, SINGLE PULSE and WORD DBL CLK pulses after a given number of REG CLK pulses. The remaining circuits are used in determining the resolution, decimal point placement in AUTO, and the status of the asterisk light.

4-243. ROMS AND COMMAND GENERATION. Each of the four ROMs on A15 are addressed by the eight lines entering the lower left of the schematic. As shown in the example below, seven of the input lines comprise an octal code; these codes are the *state address* numbers found throughout the flowchart. The remaining line is MSB. The ROMs output two sets of program codes: one set when MSB=1 and a second set when MSB=0. Each ROM contains 256 separate locations that store a 4-bit program code; an address from 128 to 255 is selected when MSB=1, while an address from 0-127 is selected when MSB=0. Example:

Octal State Address (261)	Binary Code	Signal Lines	ROM Inputs	ROM Address
	1	MSB	128	128
2	0	SV1(T)	64	
	1	SV2(T)	32	32
6	0	SV3(T)	16	
	1	SV4(T)	8	8
1	1	SV5(T)	4	4
	0	SV6(T)	2	
	1	SV7(T)	1	+1
				173

When MSB goes to 0, the ROM address becomes $32+8+4+1 = 45$.

4-244. ROM CIRCUITS. The *program codes* (located in the ROMs) generate a group of commands by means of combinational logic and decoding devices or by simply using the lines as they appear at the ROM. Since both sets of program codes must generate commands, the first set of program codes are stored until the second set is generated. They are then converted to commands and sent out at the same time.

4-245. The first set of codes (MSB=1) is stored in U1 and U25A and in U17 on the negative transition to WORD DBL CLK. A14 stores the SV (T+1) codes on the positive transition of WORD DBL CLK. (These two transitions occur at the same time.) U18 decodes the output of U17 into separate command lines. The MSB line also goes Low at this time, and the ROMs output the second set of program codes. After a 350 ns delay, the SINGLE PUSLE line pulses Low. This line pulses the D inputs and U9 and U33 and allows the two ICs to decode the ROM outputs. The new data on the outputs of U9 and U33 generate command lines but only for the duration of SINGLE PUSLE. When SINGLE PUSLE is High, U9 and U33 are effectively inhibited since they are 4 to 10 line decoders and a High on the D line (weighted 8) selects the upper eight codes (8 and 9 not used). With the D line low, the remaining lines (A,B,C = 1,2,4) can select one of the output lines (0 to 7). Zero output is selected as a "do nothing" command. SINGLE PUSLE and its inverse are also used to gate other commands (see "P" commands in Table 5-4).

4-246. NEW ADDRESS GENERATION. The address code for the next ROM cycle is a product of the current ROM cycle. While MSB equals 1, a portion of the ROM outputs (the SV(T+1) lines) are stored in A14. These lines are clocked into storage with the positive transition of WORD DBL CLK. See Figure 4-26. The lines then appear on the output of the first storage device. When the next ROM CLK, pulses Low to High, these codes are shifted to the output of the second storage device; they are then used as the address code for the next ROM cycle.

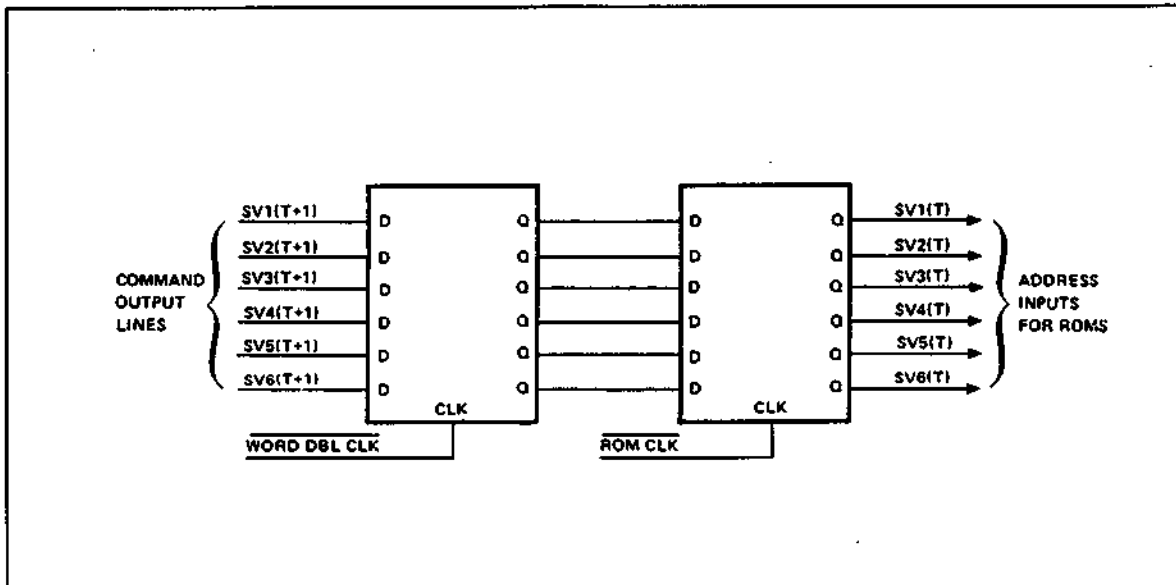


Figure 4-26. A14 ROM Address Storage

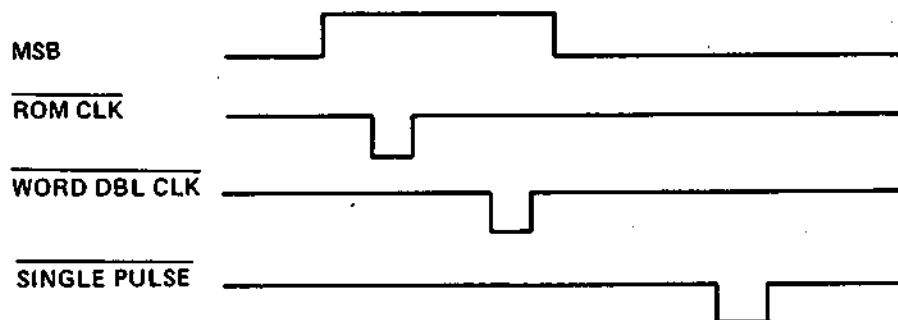
4-247. PROCESS TIMING CIRCUITS. The Multivibrator Clock circuit (U5A and B) generates a 4 MHz rectangular wave that produces all of the clock signals used in instrument timing. These signals include ROM CLK, WORD DBL CLK, REG CLK, PI CLK, MSB, and SINGLE PUSLE. The signals are generated during one process cycle, which is defined as the time between two ROM CLK pulses.

4-248. The Processor timing circuit operates in three basic modes by generating 1, 15, or 16 REG CLK pulses, according to the following chart. 1 PULSE COUNT, and 15 PULSE COUNT are ROM generated commands. These three modes are explained in more detail under Examples 1, 2, and 3 below. Examples 4 and 5 explain the effect on 15 and 16 pulse cycles during display and when loading the registers from the scalars.

Table 4-5. Commands for Processor Timing Modes

1 PULSE COUNT	15 PULSE COUNT	# of REG CLK PULSES GENERATED
1	—	1
H	H	15
H	L	16

4-249. The following timing diagram segment applies to this circuit, regardless of the circuit's operating mode.



4-250. *Example 1:* Assume the A13's NR and DR are to exchange all 16 characters of data. This requires 16 pulses of REG CLK between the two ROM CLK pulses. The description is related to the timing diagram, Figure 4-27 and the A15 schematic. The numbered circles in the text relate to those found in the timing diagram and on the schematics.

4-251. The output of MV CLK (TP8) clocks in the High on U39A(2). The resultant High on the Q output enables U31A to pass MV CLK (inverted through U6C) to the clock input of U23A ② (a divide by two). U22D changes the duty cycle of ③ by extracting every other Low-going pulse from ② and inverting it at ④. U22D is enabled to pass a pulse whenever ③ is Low. U14B inverts ④ to clock U15 with signal ⑤. The first time U15 is clocked, the carry output (CO) goes Low. When U15 has been clocked 16 times, the CO line ⑥ goes High. Each time U15 is clocked, a REG CLK pulse is also generated through U13E, U4C, and D, and U13F to clock the registers on A13.

4-252. The High from CO is inverted in U13D and disables U31C and D. The Low to High transition of U31D(6) clocks U39B, causing its Q output ⑦ to go High. This line is MSB. One clock pulse later (U38C pin 11), U38C is enabled and sets ROM CLK Low.

4-253. The output pulse of U22D ④ that occurs between the sixteenth pulse and the first pulse of the next process cycle performs two operations: 1) While the pulse is positive, it enables U14A to output WORD DBL CLK ⑧. 2) On its negative-going transition, it disables U31B and D to clock U39B back to its original reset state; and it disables U14A, both of which turn off WORD DBL CLK. Notice that the clock pulse ⑤ normally generated by U22D is inhibited by U14B during this time. When U39B is clocked back to its original state, MSB ⑦ goes low, and a new timing cycle can begin.

4-254. *Example 2:* Assume an unsuccessful subtraction has occurred on A13. The NR contents must shift one place to the left. To do this, the contents are rotated 15 places to the right. Again, refer to Figure 4-27.

4-255. When MSB goes low, a new set of commands are generated from the ROM circuits. One of the ROM lines, 15 PULSE COUNT, controls the number of clock pulses that U15 will accept before the CO lines goes High. The High of 15 PULSE COUNT enables U38B, which pulls the LOAD input of U15 Low. This inputs the High on U15(3), which has the effect of presetting the counter to a code of one with the first clock pulse ⑤. This pulse also causes CO ⑥ to go Low and disable U18B. When 15 clock pulses have occurred, the CO line returns High.

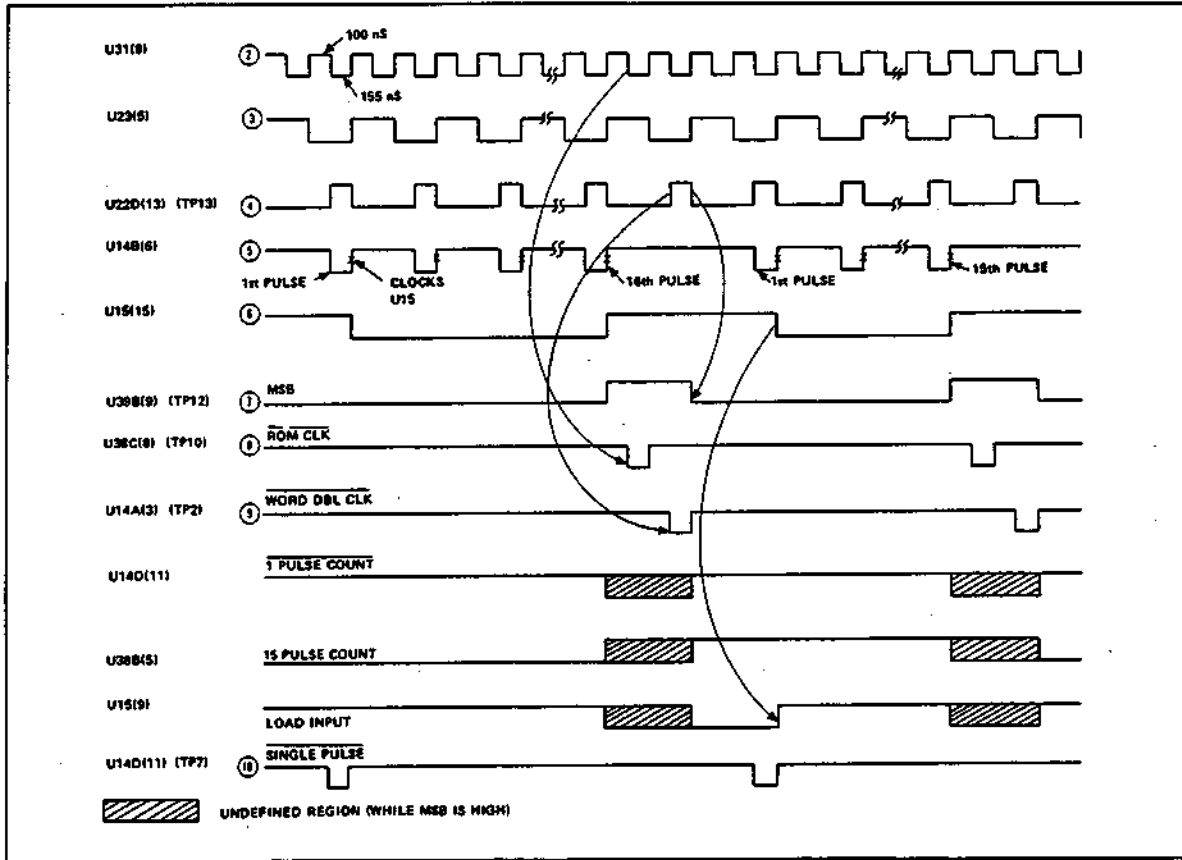


Figure 4-27. 16 and 15 Pulse Cycles

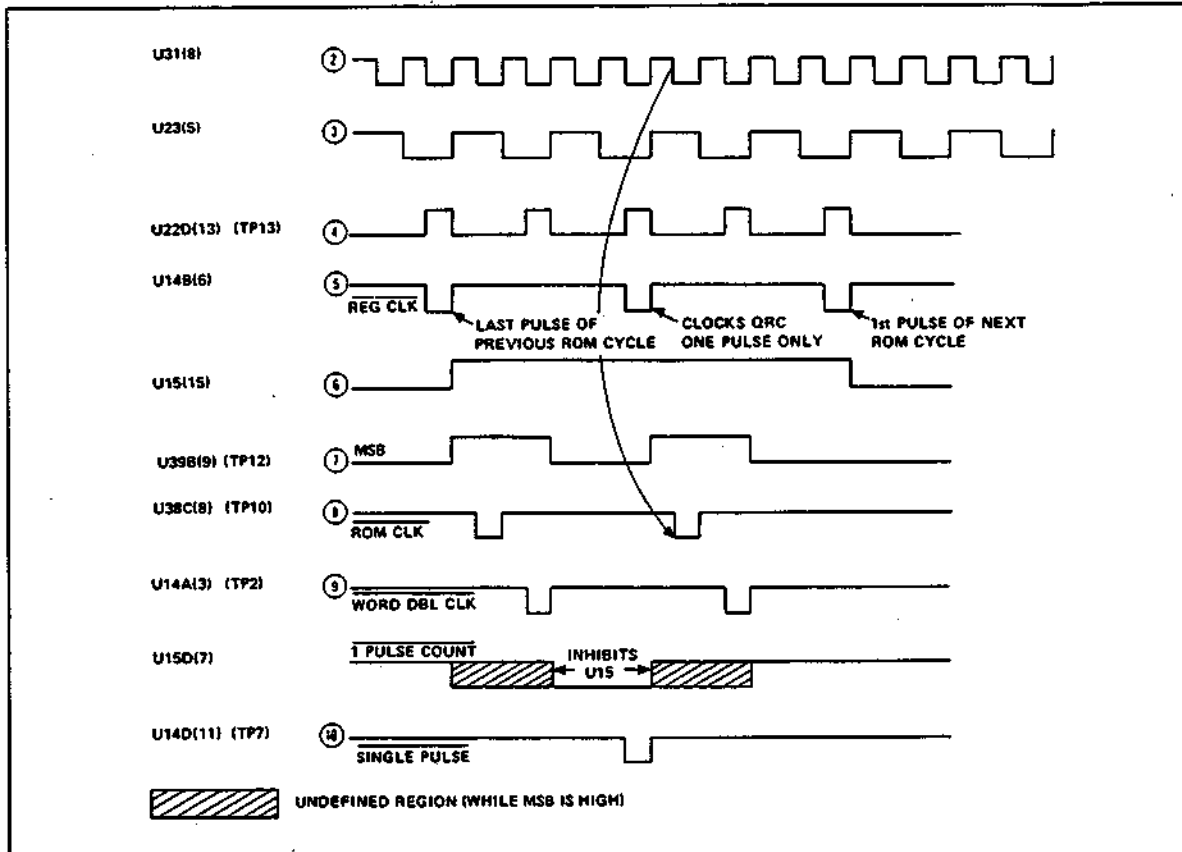


Figure 4-28. 1 Pulse Cycle

4-256. *Example 3:* Assume the QRC needs to be incremented by one ($QRC \leftarrow QRC + 1$). For the execution of this command, only one REG CLK pulse is sent to A13 while QRC CLK EN is active. The internal command that assures a process cycle of one REG CLK is 1 PULSE COUNT. Refer to Figure 4-28.

4-257. When MSB goes Low ($MSB=0$), ROM U24 generates $\overline{1 \text{ PULSE COUNT}}$. This line inhibits U15 from operating by removing the enable signal (U15 Pin 7). While MSB remains Low, U14B is enabled by U39B. This allows U14B to pass one clock pulse ⑤ through U13E, U4C and D, and U13F. Once the pulse clocks QRC, the purpose of this ROM cycle is complete. What remains is to complete the rest of the timing cycle before continuing to the next.

4-258. The Low of $\overline{1 \text{ PULSE COUNT}}$ causes the output of U7B to go High. Since this enables U31B, the Low-to-High transition of U15(15) is not needed to clock U39B. When the output of U22D ④ goes High and then low, it causes a positive transition at U31(6). This clocks U39B(9) ⑦ High. The High on U39B's Q output combines with signals ② and ③ to produce a ROM CLK pulse ⑧ from U38C(8). This same ④ pulse that clocks U39B also produces REG CLK through U14B, U13E, U4C and D, and U13F. The ROM CLK signal and $\overline{WORD \text{ DBL CLK}}$ initiate the process of generating a new set of commands for the next process cycle.

4-259. *Example 4:* Data is strobed from the Time or Events Scaler (A11) by the 4-bit binary output of DRC (A13). This counter is clocked by REG CLK; however, the clock signal's duty cycle is about 2 MHz, which is too fast for the scalers. Since no more than 13 decades of the scalers are ever used (a 10,000 second gate time), the A15 board divides the clock by two (1 MHz) for the first 13 places, then returns to its normal 2 MHz rate for the remaining three places. Refer to Figure 4-29.

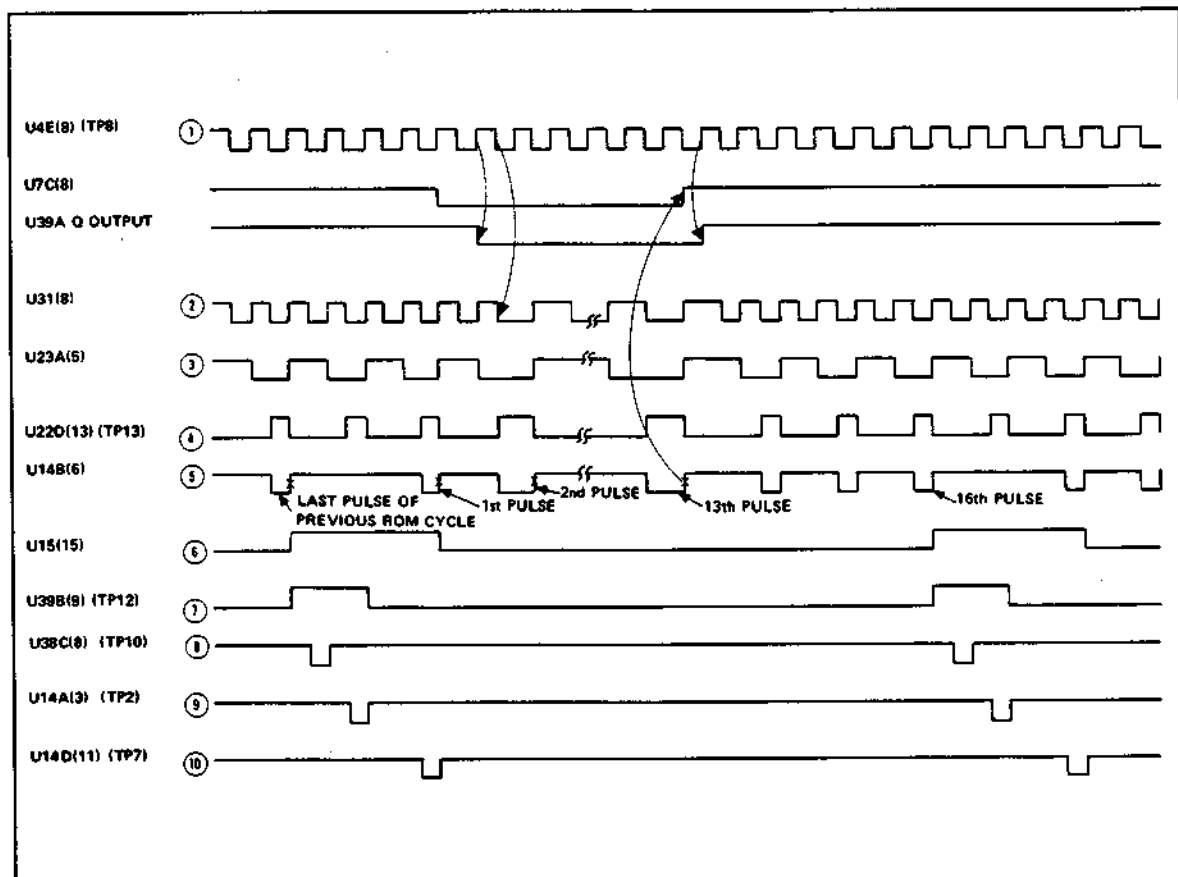


Figure 4-29. Timing for Scaler Strobing

4-260. The output of U7 A1 is High when scaler data is being read into the DR (U3C and U11A) or into the NR (U7D). This High NANDs in U7C with the Low output of U14C. After the first REG CLK pulse, the output of U14C goes High. The next positive transition of MV CLK (TP8) ① clocks the Low on the D input of U39A to the Q output. This enables U22C to pass the Low pulses of MV CLK, which clock U23B (a +2 stage). The

toggling of U39 also disables U31A and enables U31F, so that the output of U23B (the +2) is enabled to $\text{\textcircled{2}}$. As long as this condition exists, REG CLK will also be divided by two. Once U15 has been clocked 13 times, the QC and QD outputs of U15 go High (code of 12). This enables U14C and disables U7C. The next positive transition of MV CLK toggles U39A and allows the remaining pulses to go through U6C and U31A, thereby bypassing U23B.

4-261. *Example 5:* Assume that data is to be displayed. Strobing data into the display requires a much slower clock rate than REG CLK normally provides. During the display cycle, U20C(10) is commanded High. (On the schematic, U20C is located to the near left of the large cutout.) For every process cycle, the SINGLE PULSE line (U20C pin 9) goes High, once. The resultant Low output pulse is sent to A14 as $\overline{\text{DPLK CLK}}$. The A14 board divides these pulses by 64 and sends the A15 board a $\overline{\text{DPLK CLK}}$ pulse. Therefore, for every ROM cycle there occurs one SINGLE PULSE, causing one pulse; for every 64 $\overline{\text{DPLK CLK}}$ pulses there occurs one $\overline{\text{DPLK CLK}}$ pulse. (On the schematic, $\overline{\text{DPLK CLK}}$ is located in the lower right portion of the cutout.) Since DISP CLK EN is commanded High at this time, the slower $\overline{\text{DPLK CLK}}$ signal is sent through U4B and D and U13F and leaves the A15 board as REG CLK.

4-262. DIGIT COUNTER, DIGIT STORAGE, AND ASSOCIATED CIRCUITS. Digit counter, U35, is a 4-bit binary counter. The counter's main function is to keep track of the number of digits that are resolved in a measurement. This is done by, first, counting the number of digits in the time scaler. In a frequency measurement having a 1-second gate time, for example, there will *always* be 9 digits in the time scaler. After the digits are counted, the ROMs issue a command ($\text{DS} \leftarrow \text{DC}$) to store this count in Digit Storage (U34).

4-263. During the process cycle, Digit Counter increments by one each time the Quotient Register stores a calculated digit. When this count equals the count in Digit Storage, the division process has resolved enough digits for the particular gate time used.

4-264. The exclusive OR gates (U36A, B, C,D) compare the code in DC to the code in DS. U36C compares the "D" lines of the two codes; if equal, its output goes Low. Likewise, U36D(11) goes Low when the "B" lines are equal. The two gates combine to enable U29A. Since U36A and U36B are tied to the \bar{Q} outputs of DS, their outputs will be High when the "A" lines are equal (U36A) and "C" lines are equal (U36B). When the two codes are equal, the output of U37A goes Low. This activates the qualifier line $\text{DC} = \text{DS}$, which signals A14 that no further divisions are needed in the measurement.

4-265. In AUTO, the counter positions the decimal point behind one of the three most significant digits in the display. To do this, the code used to indicate the number of digits (DS) is subtracted from the code used to position the decimal point (DP lines). When DP minus DS gives a difference of -1 to -3, the decimal point is properly aligned. The \bar{Q} outputs of DS provide the inverted code (for subtraction) to be added in U28 to the DP codes, along with a carry in of one (CO input). When the sum code equals 13 to 15 and C4 is Low, the decimal point is considered to be properly aligned. The output of U28 will then enable U21A, which, in turn, activates the $\overline{\text{AUT DP ALN}}$ line via U21B. Example: CHECK, FREQ A, 100 ms, AUTO. Measurement yields .1000000 GHz immediately after computation, At this point, DP=9 and DS=8. In Giga unit arithmetic, the DP is decremented by three each time DP-DS is out of the "aligned" range. Therefore, decrementing by three yields 100.00000 MHz. DP=6 and DS=8. DP-DS=-2, signifying that alignment has been achieved.

4-266. There are instances when the decimal point is not placed behind one of the first three digits, but the decimal point should, nevertheless, be considered aligned. For example, in a totalize measurement, the decimal point is continuously updated as the display accumulates counts. The display overflows when the number of digits exceeds 11.

$\begin{array}{ccccccc} & & \text{G} & & \text{M} & & \\ & & \downarrow & & \downarrow & & \\ (\text{1X} : & \text{X} & \text{X} & \text{XX} & \text{X} & \text{XXXXXX} &) \end{array}$

The decimal point must remain fixed for the display to read in gigaunits (G is the highest annunciator). For 12 or greater numbers of resolved digits, the Q outputs of U34A and U34D go High when the display overflows. This enables U11B, U29C ($\overline{\text{ST} + \text{STP}}$ line is Low), and U21B, causing the decimal point to remain fixed (corresponding to G-units).

4-267. The decimal point is also considered aligned if U21B is enabled by U29D. This occurs when the number to be displayed is ≥ 10 G and contains less than 3 digits. In this case, the decimal point is initially positioned out of viewable range (DPLR=+ is Low). For example: $\overline{\text{XX.X1}}$ 2.G would satisfy the conditions to enable U29D. The display and decimal point would shift left one place and a fictitious zero would be inserted in place of the 2 $\overline{\text{XX.X10}}$ G. The insertion of a fictitious zero would also light the asterisk.

4-268. The $\overline{\text{QMC=6}}$ line goes Low after the QMC has stepped through all possible annunciator codes in an attempt to select the correct multiplier for the measurement's result. Each time the DP codes increment (or decrement) by three, the QMC is also incremented by one to change the multiplier code. The subtraction of DP and DS occurs in an attempt to satisfy the output of U21A (DPLR-DS= -1 to -3). When six attempts have been made to align the decimal point with the proper multiplier, the QMC has selected all available multipliers. The last annunciator is then used, regardless of the decimal point's position. The $\overline{\text{QMC=6}}$ line goes Low to enable U12B, which activates the $\overline{\text{AUT DP ALN}}$ line via U21B.

4-269. The last gate to control $\overline{\text{AUT DP ALN}}$ is U38A. Should a plug-in make time interval measurements in the sub-nanosecond range, U38A forces the decimal point alignment in terms of nanoseconds.

4-270. **ASTERISK HARDWARE.** The $\overline{\text{LOAD*S}}$ command clocks U25B. A High on the Q output causes the front panel asterisk lamp to light. The D input U25B(12) is High when the * Flip-Flop is "ON" (U10B(6) is Low making U37B(6) High) or when the DS contents are 0, 1, 2, 3, or 4 (U20A(3) or U37C(8) is Low). The asterisk lights under the following conditions:

- Factitious zero - asterisk flip-flop is on.
- Underflow - DS = 0
- Overflow - DS = 0, 1, 2, 3, or 4

4-271. A16 Motherboard

4-272. The A16 assembly is the counter's largest interconnection board. It provides the main source of signal interconnection between the other board assemblies. It contains no electrical parts but does provide connection for several wiring harnesses plus a pressure connector that connects to A17. See motherboard wiring in Section VIII.

4-273. A17 Plug-in Interconnection

4-274. The A17 board is located behind the sheet metal at the rear of the plug-in compartment. The board connects to A16 by means of a pressure connector (P1) and to the plug-in via A17J1 (visible at rear of plug-in compartment).

4-275. A18 10 MHz Oscillator (Oven)

4-276. This unit is a 10 MHz crystal oscillator whose frequency stability is temperature regulated by an internal oven. The unit incorporates an AGC circuit and is also capable of phase locking to an external standard. Before phase locking can occur, however, the two signals must be within one cycle of each other. The specifications are listed in Table 1-3.

4-277. A18 Option 001 Oscillator

4-278. Option 001 is a voltage controlled 10 MHz oscillator. A separate power supply consisting of CR1, Q1, and associated components, provides a "cleaner" source of power. This helps to isolate the oscillator from the switching currents associated with other supplies.

4-279. U1A operates like an amplifier with positive feedback. The positive feedback path is from the noninverted output of U1A(6) through C9, C8, CR2, C4-C6, and crystal Y1. Negative feedback establishes the input bias for U1A. This path is through R5 and R2. The trimmer capacitors C4 and C5 provide frequency adjustment of the oscillator. Diode CR2 is a voltage variable capacitor. When this oscillator is phase locked to a external standard, a voltage from A8 assembly changes automatically to vary the capacitance of this diode. This change of value affects the feedback loop's phase and, therefore, the crystal's exact frequency.

4-280. The inverted output of U1A(5) is fed to buffer U1B(10). The buffer provides isolation between the oscillator and the output stage, Q2. The outputs of U1B(8) and (9) switch from about 4.0 to 4.75 volts. When one output is 4.0V, the other is 4.75V. Level shifter Q2 converts the output of U1B to an approximate TTL level.

4-281. A19, Option 010, 011, Interface Panel

4-282. The A19 assembly provides the interconnection between A12 (optional) and the interface bus. The A2 through A5 switches select the address code for the instrument. The remaining switch selects TALK ALWAYS or ADDRESSABLE.

SECTION V MAINTENANCE AND SERVICE

5-1. INTRODUCTION

5-2. This section contains maintenance and service information. Included is a table of assemblies, a table of recommended test equipment, overall troubleshooting information and troubleshooting charts, processor flowcharts, an in-cabinet performance check, and adjustment procedures.

5-3. ASSEMBLY DESIGNATIONS

5-4. Table 5-1 lists the designations nomenclature, and Hewlett-Packard part number of assemblies used in the 5345A.

Table 5-1. Assembly Designations

REFERENCE DESIGNATION	DESCRIPTION	HP PART NO.
A1	Cathode Driver Display	05345-60001
A2	Anode Driver Display	05345-60027
A3	Input Attenuator	05345-60238
A3	Input Attenuator (Option 012)	05345-60239
A4	Input Trigger	05345-60124
A5	Interconnect	05345-60005
A6	Switching Regulator	05345-60006
A7	Linear Regulator	05345-60007
A8	PLL Multiplier Noise Generator	05345-60031
A9	Main Gate	05345-60099
A10	Gate Control	05345-60050
A11	Scaler	05345-60011
A12	General Purpose Interface I/O (Option 011)	05345-60018
A12	HP-IB I/O (Option 012)	05345-60121
A13	Adder/Subtractor	05345-60013
A14	Qualifier	05345-60144
A15	ROM	05345-60045
A16	Motherboard	05346-60016
A17	Plug-In Interconnection	05345-60017
A18	10 MHz Oscillator (Oven)	10811-60111
A19	Interface Panel (Option 011)	05345-60019
A19	Interface Panel (Option 012)	05345-60022
A20	Filter (Option 012)	05345-60130

5-5. TEST EQUIPMENT

5-6. Table 5-2 lists test equipment recommended for maintaining the counter, and for checking its performance. Test equipment having equivalent characteristics may be substituted for the equipment listed.

Table 5-2. Recommended Test Equipment

INSTRUMENT	REQUIRED CHARACTERISTICS	RECOMMENDED TYPE
Oscilloscope	60 MHz Bandwidth	HP 54501A
Vertical Plug-in	50 mV/div Sensitivity	HP 54501A
Time Base Plug-in	50 MHz Bandwidth	HP 54501A
Sampler	10 μ s/div	HP 54501A
Test Oscillator	10 Hz to 10 MHz Accuracy: \pm 4%	HP 3325B
Single Generator	10 MHz to 5600 MHz Accuracy: \pm 2%	HP 8644A or 8657A*
Pulse Generator	10 ns pulse width, manual trigger	HP 8161A
DVM	0V to 25V Accuracy: \pm 0.3%	HP 3466A
AC VTCM	20 Hz to 1 MHz Accuracy: \pm 3%	HP 3466A
Logic Probe	Logic State Test	HP 545A
Logic Pulser	State Activator	HP 546A
Logic Comparator	IC Test	HP 10529A
Extender Board Kit		HP 10595A

*See NOTE in Table 5-5, step 1.

5-7. ADJUSTMENTS AND IN-CABINET PERFORMANCE CHECK

5-8. Table 5-6 contains adjustment procedures for the 5345A. Adjustments should be made when necessity is established by the performance test or when components are replaced that change the circuit's operating characteristics.

5-9. PERIODIC MAINTENANCE

NOTE

Instruments with serial number 1708A02576 or higher are supplied less the air filters. Hewlett-Packard recommends removing the filters from all previous units. If desired, to retain filter protect, follow the step-by-step instructions in paragraph 3-69.

5-10. Instrument cooling is accomplished by a fan that intakes air through two air filters. These filters *must* be periodically inspected and cleaned when dust buildup is apparent. This procedure is described in Section II under *Air Filter Cleaning*.

5-11. OVERALL TROUBLESHOOTING

5-12. There are two methods of troubleshooting the 5345A to board level. The fastest and most efficient means of isolating problems is to use the board replacement kit. If this kit is not available, the trouble isolation method is recommended. This procedure makes use of troubleshooting charts and associated information. Both methods are described in the following paragraphs. In addition, see paragraph entitled *Troubleshooting Aids*.

CAUTION

**BE SURE TO REMOVE POWER CORDS BEFORE REMOVING THE
POWER SUPPLY BOARDS.**

5-13. Trouble Isolation Method

5-14. The 5345A Overall Troubleshooting flowcharts are intended to reveal any basic machine malfunctions. The tests verify the measurement and processor cycles; however, the input amplifiers are not tested. The internal 100 MHz test bypasses the amplifiers. Any suspected input amplifier problems should be tested separately.

5-15. The tests begin when the FUNCTION switch is set to START. This mode checks most of the basic operations during the measurement cycle. Much of the processing cycle is also verified in this mode. Upon successful completion of the Start mode, the Frequency mode is set up. This test performs further and more complete testing of the processor.

5-16. Troubleshooting the instrument should be approached as described below. Refer back to this listing when progressing through the troubleshooting procedures.

- a. Perform the operations that are outlined in the *Overall Troubleshooting Flowchart*, Figure 5-1. The troubleshooting charts will isolate the problem to a specific board assembly or to a problem in the processor. When the problem is found to be on a board, consult the board theory in Section IV and the signal line mnemonics in Section VII.
- b. When the problem is in the processor, set up the available test equipment, as outlined in Figure 5-6 or Figure 5-7. Perform the described test while verifying results in Table 5-3, Processor Flow Test Results.
- c. When an incorrect ROM address is detected, consult *Processor Troubleshooting Symptoms*, Figure 5-8, to determine the troubleshooting approach for the particular symptom.

5-17. TROUBLESHOOTING AIDS

5-18. In addition to the previously described troubleshooting methods, there are some devices unique to the 5345A that can aid in troubleshooting. These units are the 5345A Special Test Board, and the Extender Board Kit. These units are described in the following paragraphs.

Paragraphs 5-19 and 5-20 have been deleted.

5-21. Extended Board Kit (10595A)

5-22. This kit is required for servicing the 5345A Electronic Counter. It allows circuit boards and circuit assemblies to be extended from their plug-in connectors for monitoring signals with the appropriate test equipment. The kit includes the following extender assemblies:

- a. 05345-60201 Extender boards for the A6, A7 power supplies, and A8 multiplier assembly.
05345-60202
- b. 05345-60203 Extender board for the A9 Main Gate assembly only.
- c. 05345-60204 Extender boards for the A10, A11, A12, A13, A14, and A15 assemblies.
- d. 05345-60205 Front Panel Extender cable which allows troubleshooting for the A1, A2 Display assemblies and A3, A4 Input Amplifier assemblies.
- e. 1250-0831 Special adapter for BNC-to-subminiature connector. Used in calibrating the input amplifier assemblies.
- f. 05345-60200 This is a special test board. See separate description.

5-23. Special Test Board (05345-60200)

5-24. Although included in the Extender Board Kit, this board provides some unique troubleshooting aids. The operations it can perform and methods for using it are outlined below.

FUNCTIONS PROVIDED

- a. Extender board for A10, A11, A12, A13, A14, and A15 board assemblies.
- b. Processor Tester. Transfers BCD data from the GATE TIME switch directly into the arithmetic processor. This provides known good data to the processor, thereby isolating problems between the processor assemblies and data circuits on assemblies within the front end. Specific front end assemblies are A3, A4, A8, A9 and A11.
- c. Front End Tester. This enables circuit tests to be made while the instrument is in the measurement phase. The processing phase is inhibited with the test board.

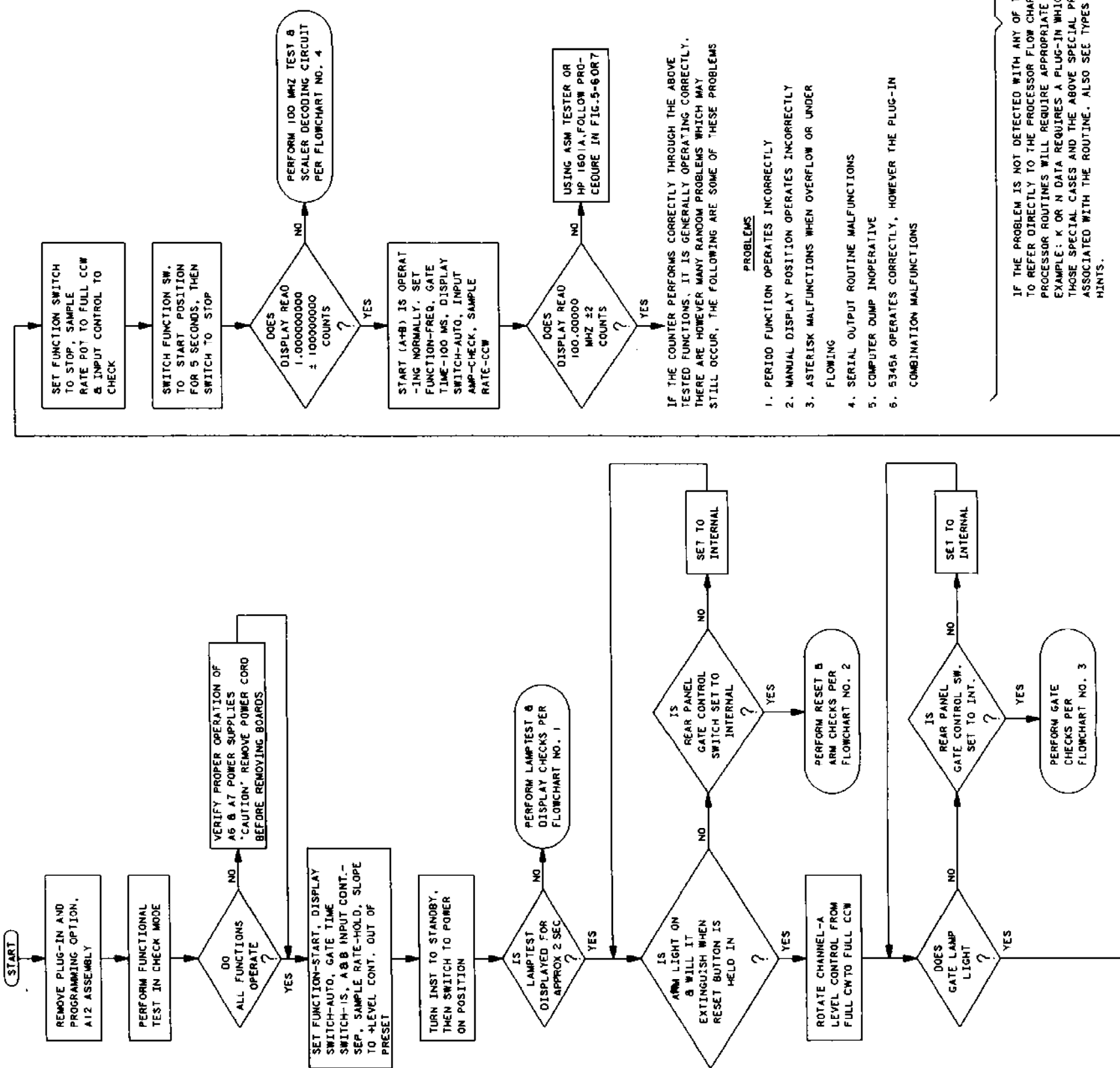
USING THE 05345-60200 TEST BOARD

- a. When using as an extender board, install extender board with the two CINCH connectors up and install board to be tested.
- b. When using the board to test the processor, follow the procedure below:
 1. Remote the A11 Scaler assembly.
 2. Install the test board with the connectors marked XA11(A) and XA11(B) into the A11 position of the 5345A motherboard.
 3. Set the 5345A switches as described on the test board under Front Panel Functions.
 4. Set switches as outlined under A14 Switches. The BKPT-1, 2, and 7 refer to the test switches located on the top of the A14 board.

NOTE

BKPT-7 must be set and remain set while all tests are performed. Also, note the position of the SAMPLE RATE control when tests are performed.

- c. When using the board to troubleshoot the Front End, use the following procedure:
 1. Remove the A15 RAM assembly.
 2. Install the test board with the connectors marked XA15(A) and XA15(B) into the A15 position of the 5345A motherboard.
 3. Troubleshoot circuits associated with the measurement phase. The processor will remain inhibited during this time.



NOTE:
WHEN CHECKING FOR CORRECT ROM STATES OR COMMANDS AND QUALIFIERS, SET UP ASM TESTER OR HP 1601 AS OUTLINED IN PROCEDURE FIG. 5-6 OR 5-7

- TEST**
1. ENSURE THAT THE PERIOD + TI QUALIFIER SELECTS STATE 531. ALSO THAT STATE 670 IS SELECTED IN THE DIVIDE ROUTINE
 2. THIS ROUTINE BEGINS AT STATE 510; CHECK COMMANDS AND QUALIFIERS IN THIS ROUTINE
 3. THIS ROUTINE BEGINS AT STATE 650; CHECK COMMANDS & QUALIFIERS THROUGH THIS ROUTINE
 4. SWITCH REAR PANEL ASCII CODE SWITCHES TO THE 'TALK ALWAYS' POSITION; MONITOR STATES BEGINNING AT STATE 730.
 5. THIS ROUTINE BEGINS AT STATE 210; CHECK COMMANDS AND QUALIFIERS
 6. CHECK ROUTINES BEGINNING AT STATES 150, 170, 050 & 521

- PROBLEMS**
1. PERIOD FUNCTION OPERATES INCORRECTLY
 2. MANUAL DISPLAY POSITION OPERATES INCORRECTLY
 3. ASTERISK MALFUNCTIONS WHEN OVERFLOW OR UNDER FLOWING
 4. SERIAL OUTPUT ROUTINE MALFUNCTIONS
 5. COMPUTER DUMP INOPERATIVE
 6. 5345A OPERATES CORRECTLY, HOWEVER THE PLUG-IN COMBINATION MALFUNCTIONS

IF THE PROBLEM IS NOT DETECTED WITH ANY OF THE ROUTINES, IT WILL BE NECESSARY TO REFER DIRECTLY TO THE PROCESSOR FLOW CHARTS. (FIGURE 5-10) SOME OF THE PROCESSOR ROUTINES WILL REQUIRE APPROPRIATE PLUG-INS TO GET INTO THE ROUTINES. EXAMPLE: K OR N DATA REQUIRES A PLUG-IN WHICH CAN PROVIDE K AND N DATA. FOR THOSE SPECIAL CASES AND THE ABOVE SPECIAL PROBLEMS, READ THE FLOWCHART THEORY ASSOCIATED WITH THE ROUTINE. ALSO SEE TYPES OF SYMPTOMS, UNDER TROUBLESHOOTING HINTS.

5345-D-20

Figure 5-1. Overall Troubleshooting Flowchart
5-5

Figure 5-1
OVERALL TROUBLESHOOTING FLOWCHART

(See Page 5-5)

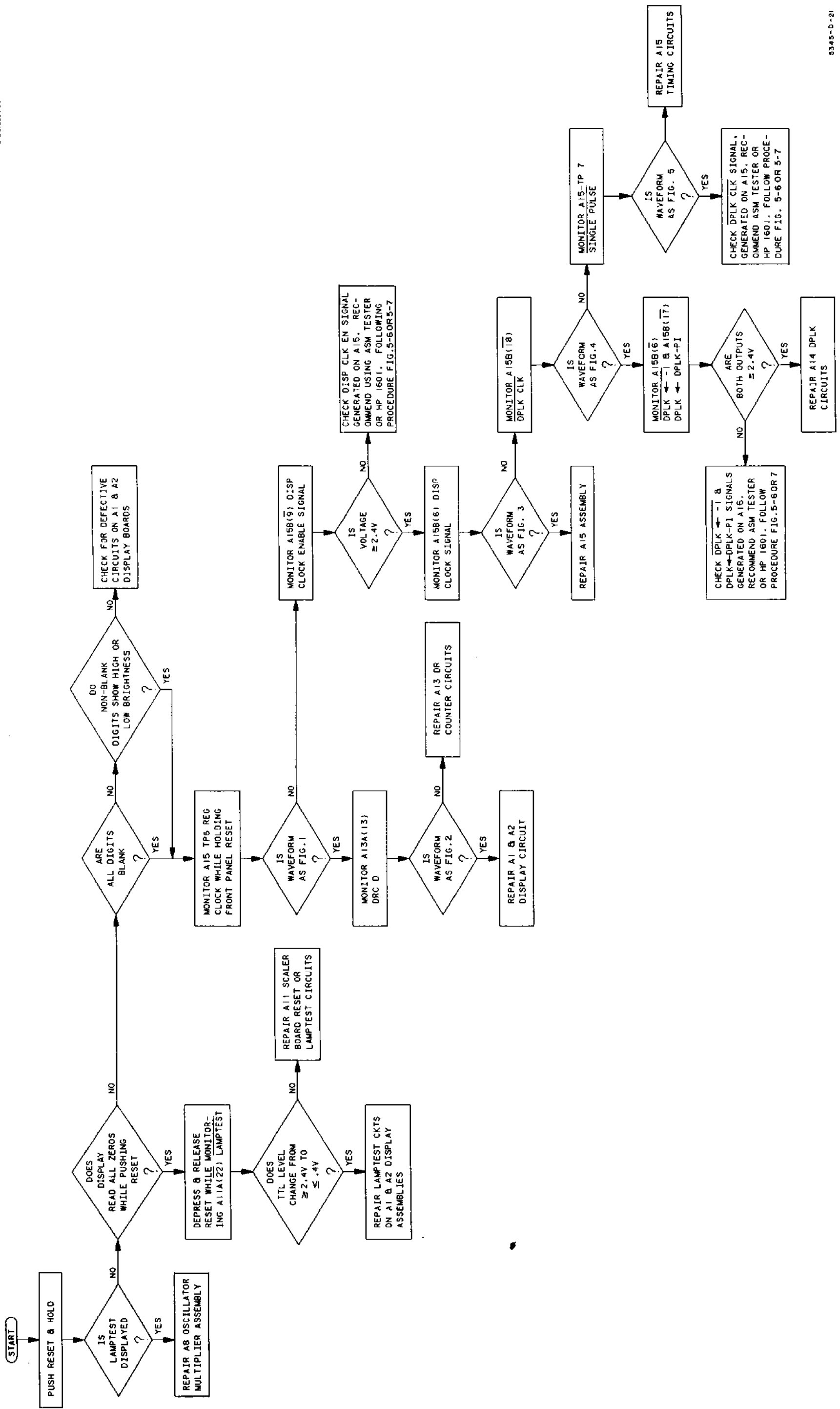


Figure 5-2. Troubleshooting Flowchart #1

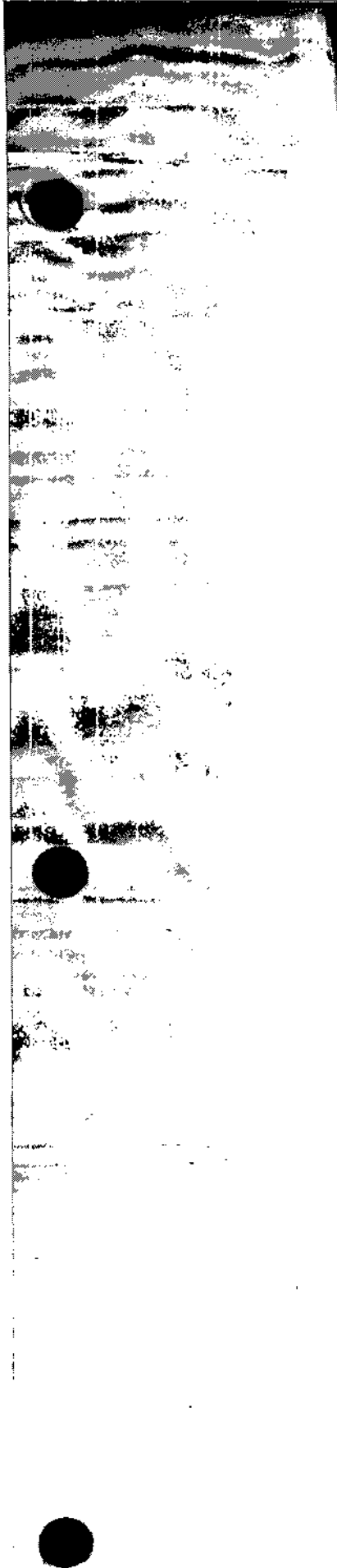
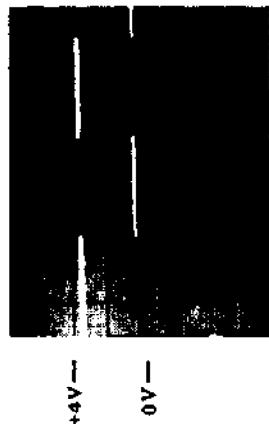


Figure 5-2
TROUBLESHOOTING FLOWCHART # 1

(See Page 5-7)

Equipment: 180A with 1801A/1821A and 100048 10:1 Probe

Figure 1. (REG CLK)



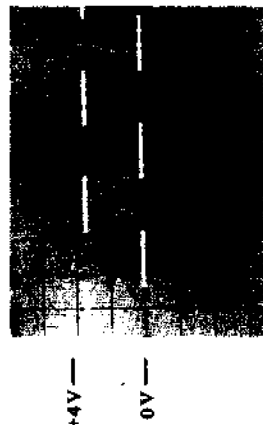
.2V/DIV, 20 μS/DIV,
+SLOPE, DC INPUT

Figure 2. (DRC D)



.2V/DIV, 1 mS/DIV,
+SLOPE, DC INPUT

Figure 3. (DISP CLK)



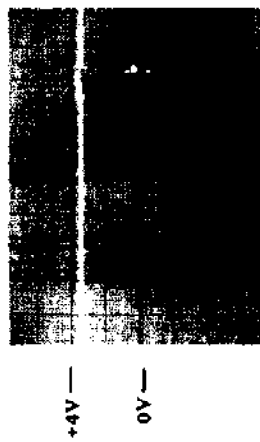
.2V/DIV, 20 μS/DIV,
+SLOPE, DC INPUT

Figure 4. (DPLK CLK)



.2V/DIV, 2 μS/DIV,
-SLOPE, DC INPUT

Figure 5. (SINGLE PULSE)



.2V/DIV, 1 μS/DIV,
-SLOPE, DC INPUT

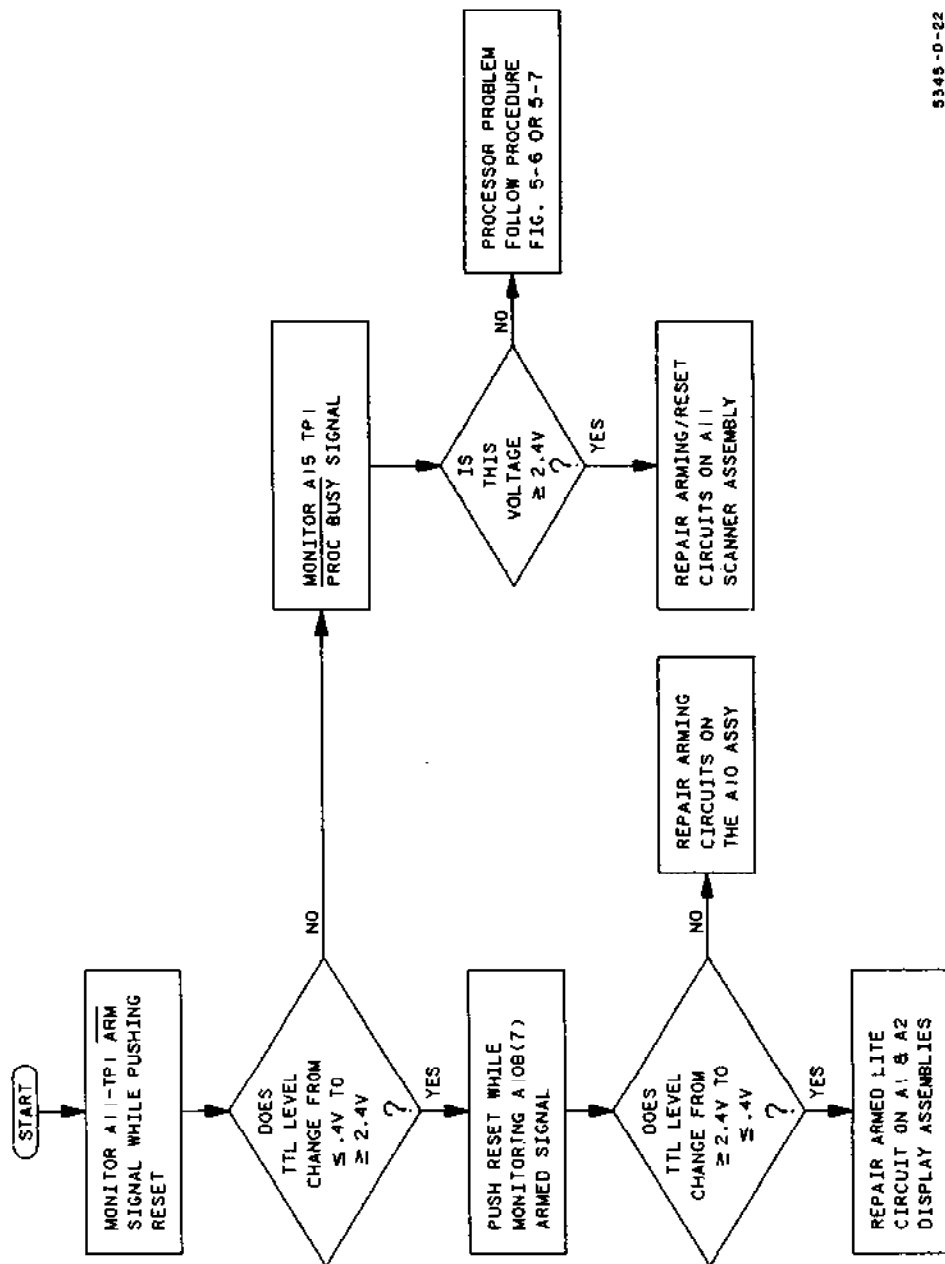
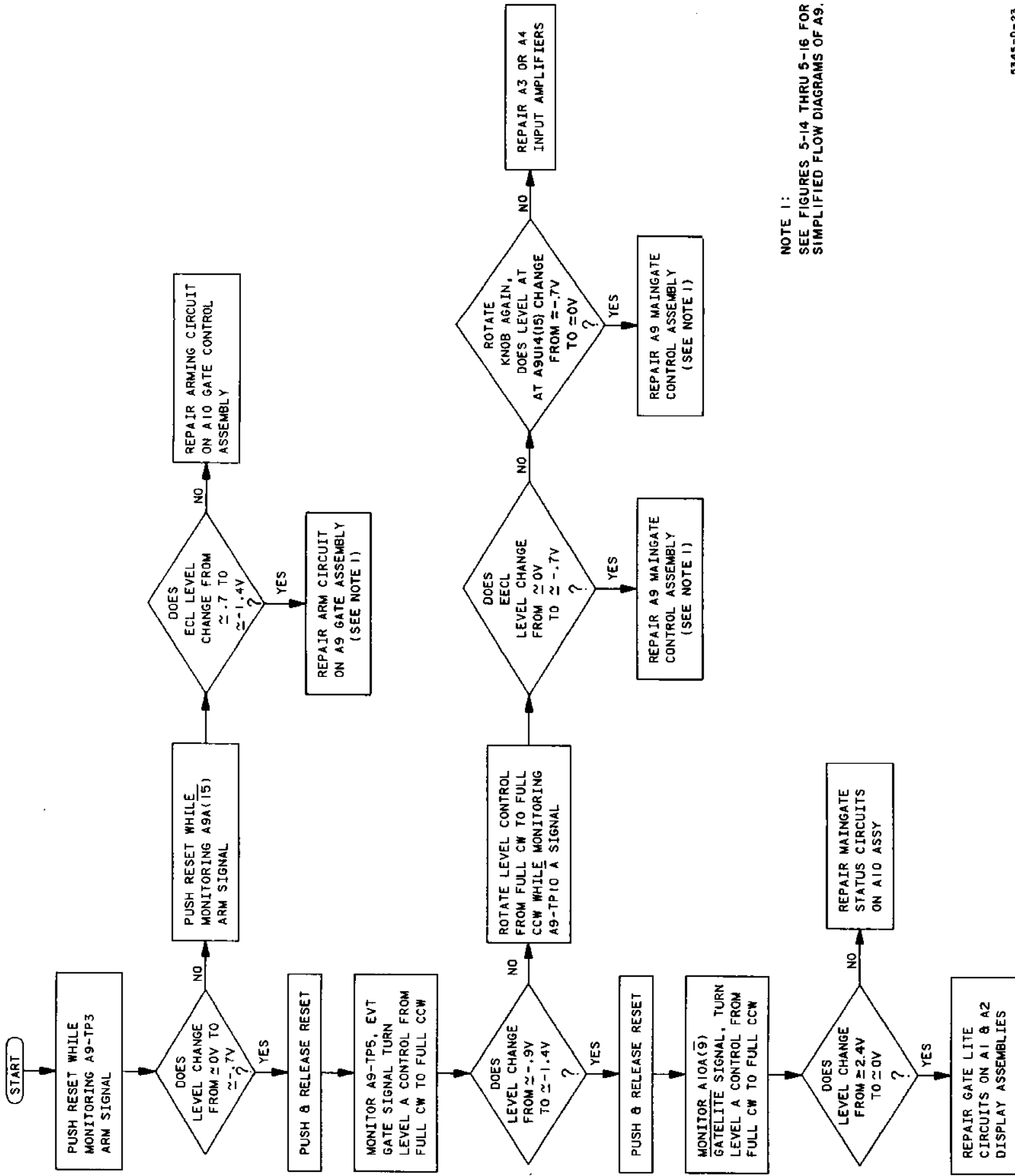


Figure 5-3
TROUBLESHOOTING FLOWCHART # 2

(See Page 5-9)



NOTE 1:
SEE FIGURES 5-14 THRU 5-16 FOR SIMPLIFIED FLOW DIAGRAMS OF A9.

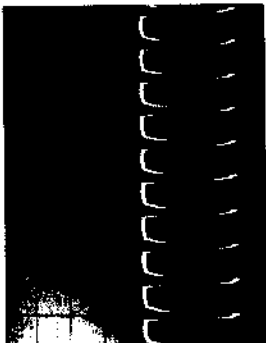
5345-0-23

Figure 5-4
TROUBLESHOOTING FLOWCHART # 3

(See Page 5-11)

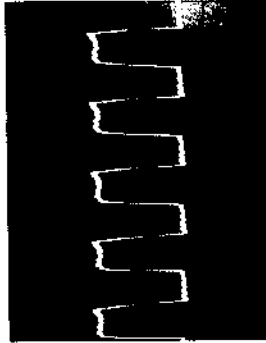
Equipment: 180A with 1801A/1821A and 100048 10:1 Probe

Figure 6.
(E/10 and T/10 Signal)



.02V/DIV, 1 μS/DIV,
+ SLOPE, DC INPUT

Figure 7.
(EVT SCLR and TIME SCLR AI)



.02V/DIV, 1 μS/DIV,
+ SLOPE, AC INPUT

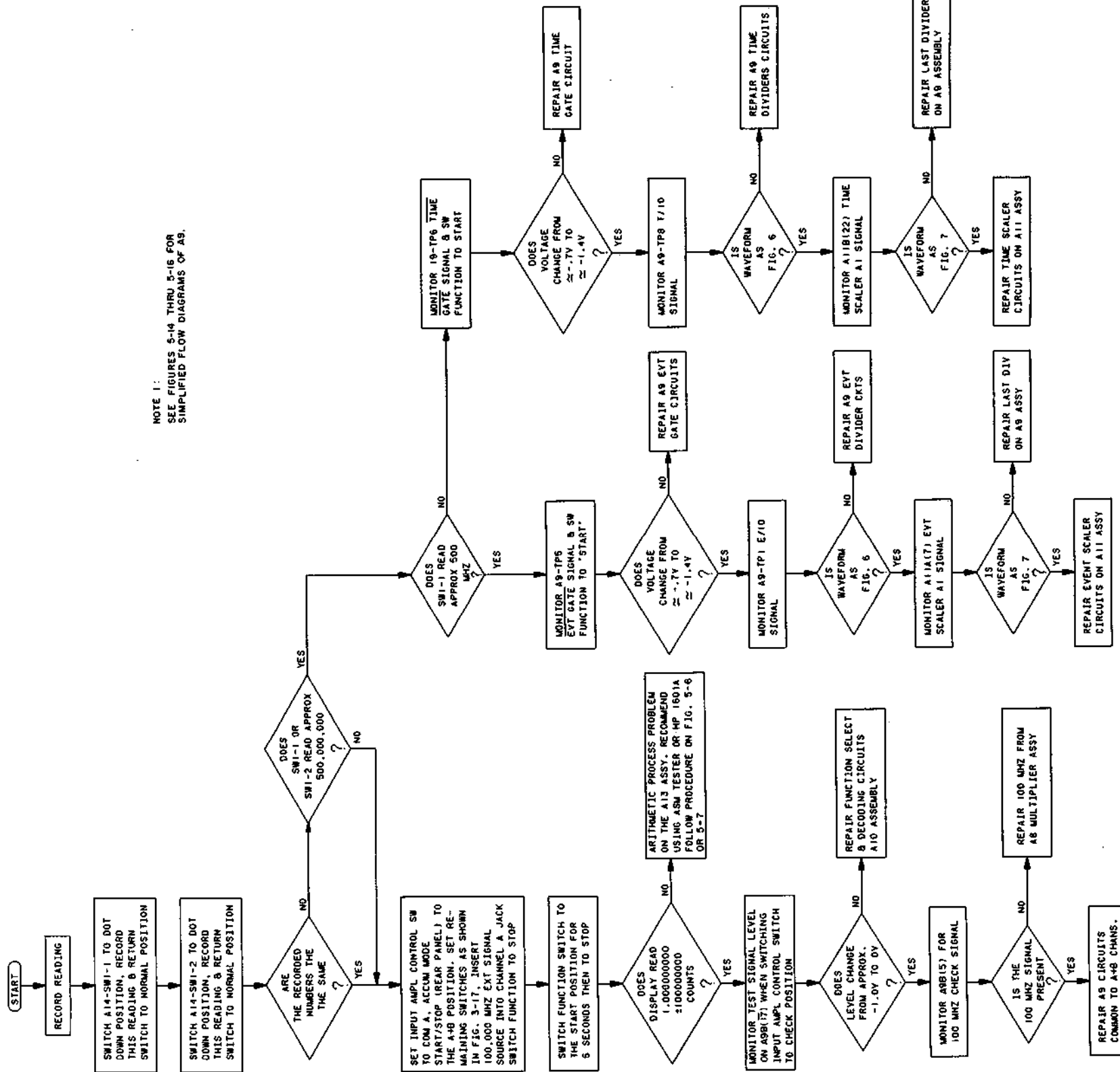
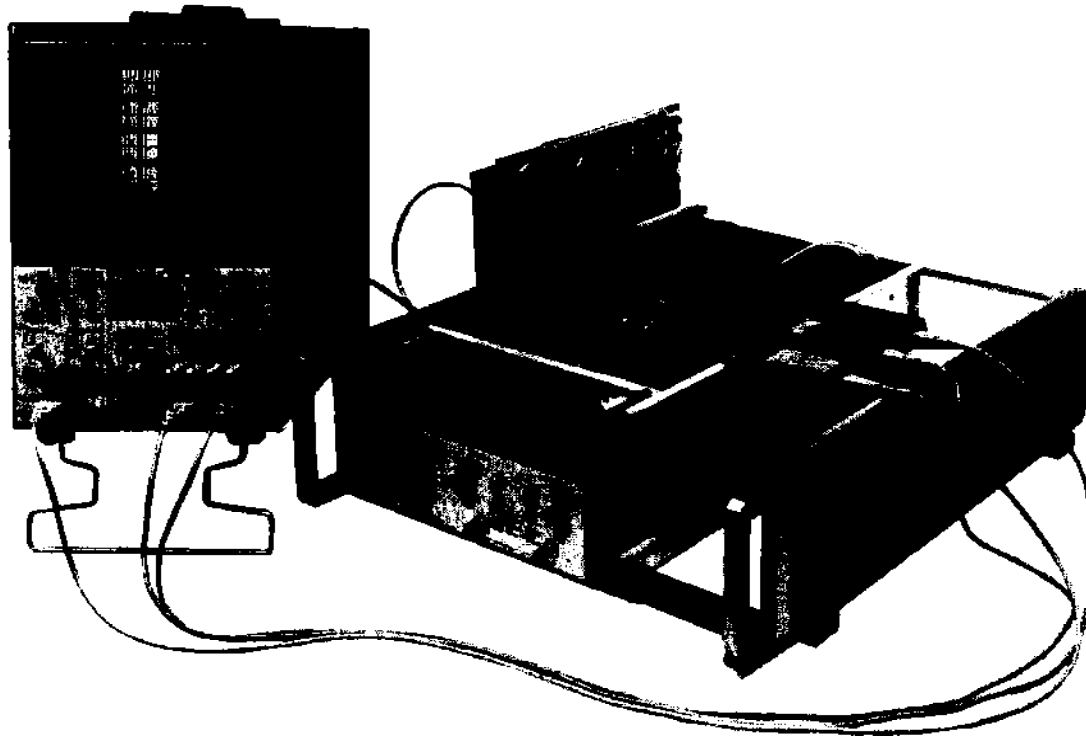


Figure 5-5. Troubleshooting Flowchart #4



EQUIPMENT REQUIRED:

- A. 180 Oscilloscope.
- B. 1601A Logic State Analyzer.

EQUIPMENT SETUP:

- 1. Remove 5345A Top Cover.
- 2. Place A15 on extender card (05345-60204 or 05345-60200).
- 3. Connect 10230A Clock Probe to A15 TP7 and common to A15 TP4.
- 4. Connect the 10231A Six Bit Probes to A15 as follows:

- Bit 0 – U24(5)
- Bit 1 – U24(6)
- Bit 2 – U24(7)
- Bit 3 – U24(4)
- Bit 4 – U24(3)
- Bit 5 – U24(2)
- Bit 6 – U24(1)

Figure 5-6. Verifying Processor Flow With HP 1601A

Figure 5-5
TROUBLESHOOTING FLOWCHART # 4

(See Page 5-13)

EQUIPMENT SETTINGS:

5345A

FUNCTION FREQ A
 GATE TIME 100MS
 Input Control CHECK
 SAMPLE RATE HOLD

180/w 1601A

DISPLAY PLUS, MARK-ON, BYTE BCD
 (this gives best pattern display)
 CLOCK POS
 THRESHOLD TTL
 SAMPLE MODE SINGLE
 TRIGGER MODE START DELAY
 COLUMN BLANKING To display seven bits
 DISPLAY RATE In single, it has no influence
 TRIGGER WORD Set to 570
 NOTE: Set all unused switches to OFF POSITION
 DELAY SET 00000

OPERATING PROCEDURE:

1. Push SAMPLE MODE RESET button on the 1601A.
2. Push 5345A RESET.

COMMENTS:

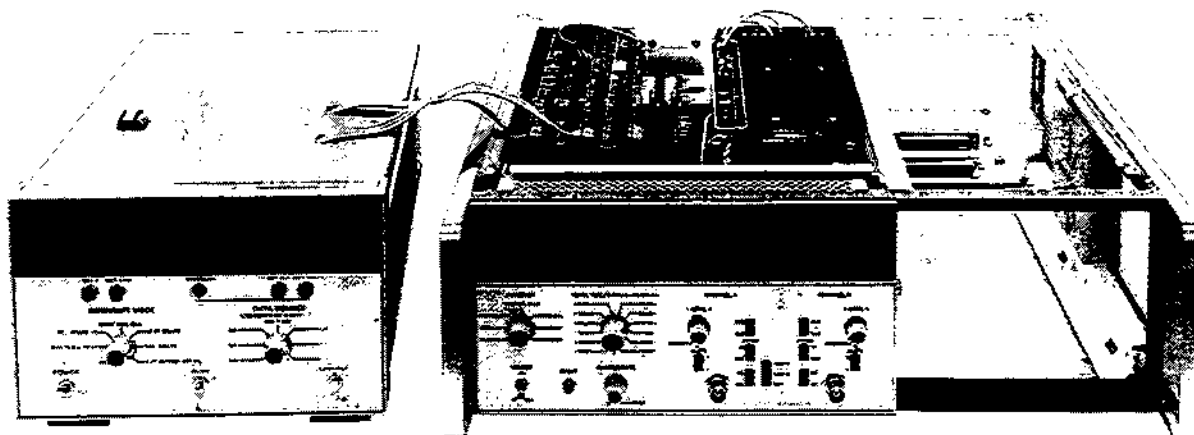
After the 5345A RESET is depressed and released, the ROM address of 570 should be displayed on the first word of the 1601A.

$$\begin{array}{r} 7654\ 321\ 0 \\ 101111\ 0 \\ \hline 5\ 7\ 0 \end{array}$$

Table 5-3 shows the address which will be selected as the DELAY SET switch is incremented from the 570 trigger point. These addresses are correct only for the 5345A equipment settings above.

When verifying the selection of correct states, refer to *Processor Flow Test Results*, Table 5-3. ROM addresses can be quickly verified by setting the delay switches to mid points in the table. Any delayed states differing from those in the table indicate a failure. Also, all states *following* the incorrect state will usually differ from those in the table. When an incorrect state is found, refer to Figure 5-8, *Processor Symptoms and Troubleshooting*.

Figure 5-6. Verifying Processor Flow With HP 1601A (Continued)



EQUIPMENT REQUIRED:

1. K13-59992A 5345A ASM Tester.

EQUIPMENT SETUP:

1. Set 5345A POWER switch to STANDBY position.
2. Remove 5345A Top Cover.
3. Connect 5345A ASM Tester as follows:
 - a. Test cable to A15 test socket J1. ((Note pin 1 placement.)
 - b. Data cable to A13 test socket J1. (Note pin 1 placement.)

EQUIPMENT SETTINGS:

1. Set the 5345A the same as when using the HP 1601A.
2. Set the 5345A ASM Tester as follows:
 - a. Switch the 5345A and ASM TESTER POWER switch to ON.
 - b. Set the INTERRUPT MODE switch to the SEL STATE position.
 - c. Set the SET 0-7 and SET 00-71 switches to 570 state address. The address will be displayed as the REF CODE.
 - d. Set the INTERRUPT CTR to the number of times that the selected state is desired to match the REF CODE, before the 5345A is interrupted. The INTERRUPT CTR is normally set to 1.
 - e. Push and HOLD RESET on the 5345A.
 - f. Push and release CONTINUE. (Lamp test should be displayed on the 5345A and the TEST CODE will display state 001.)

Figure 5-7. Verifying Processor Flow With 5345A ASM Tester

- g. Release RESET on the 5345A. The REF CODE and TEST CODE should now display the selected state address.

NOTE

If there is a problem in the 5345A processor the TEST CODE may not be selected. In this case a new address should be tried. Check the PROCESSOR FLOW CHARTS to determine prior addresses.

- h. Set INTERRUPT MODE switch to NEXT STATE.

OPERATING PROCEDURE:

Push CONTINUE. This will step the processor to the next ROM address, as listed in Table 5-3. This new address will be displayed as the Test Code. As CONTINUE is pushed, each sequential address that is listed in the table should be displayed as the Test Code. When an incorrect state is found, refer to Figure 5-8, *Processor Symptoms and Troubleshooting*.

NOTE

The A13J1 connection enables the data to be monitored at selected states. For operating procedure, see *ASM TESTER* manual.

Figure 5-7. Verifying Processor Flow With 5345A ASM Tester (Continued)

Table 5-3. Process Flow Test Results

Delay Switch	ROM Address	Processor Operation	Comment
00000	570	Initiate Processor	yes
00001	211	Computer dump	no
00002	151	PI Data	no
00003	361	Display TC	no
00004	440	DPLK=-17	no
00005	600	NR=0, 1st zero digit	yes
00006	440	DPLK=-17	no
00007	600	NR=0, 2nd zero digit	yes
00008	440	DPLK=-17	no
00009	600	NO=0, 3rd zero digit	yes
00010	440	DPLK=-17	no
00011	600	NR=0, 4th zero digit	yes
00012	440	DPLK=-17	no
00013	600	NR=0, 5th zero digit	yes
00014	440	DPLK=-17	no
00015	600	NR=0, 6th zero digit	yes
00016	440	DPLK=-17	no
00017	600	NR=1, 7th zero digit	yes
00018	440	DPLK=-17	no
00019	600	NR=0, 8th zero digit	yes
00020	440	DPLK=-17	no
00021	601	NR=0, 1st nonzero digit	no
00022	400	Prepare to count 1st digit	yes
00023	440	DPLK=-17	no
00024	601	NR=0, 2nd nonzero digit	no
00025	400	Prepare to count 2nd digit	yes
00026	440	DPLK=-17	no
00027	601	NR=0, 3rd nonzero digit	no
00028	400	Prepare to count 3rd digit	yes
00029	440	DPLK=-17	no
00030	601	NR=0, 4th nonzero digit	no
00031	400	Prepare to count 4th digit	yes
00032	440	DPLK=-17	no
00033	601	NR=0, 5th nonzero digit	no
00034	400	Prepare to count 5th digit	yes
00035	440	DPLK=-17	no
00036	601	NR=0, 6th nonzero digit	no
00037	400	Prepare to count 6th digit	yes
00038	440	DPLK=-17	no
00039	601	NR=0, 7th nonzero digit	no
00040	400	Prepare to count 7th digit	yes
00041	440	DPLK=-17	no
00042	601	NR=0, 8th nonzero digit	no
00043	400	Prepare to count 8th digit	yes
00044	441	DPLK=-17	yes
00045	221	Period or TI	no

Table 5-3. Process Flow Test Results (Continued)

Delay Switch	ROM Address	Processor Operation	Comment
00046	451	Flag=H	yes
00047	051	Plug-in	no
00048	420	Events, Ratio and Start or Stop	no
00049	530	Period or TI	no
00050	201	Start or Stop	no
00051	071	N Data	no
00052	671	Divide Routine	
00053	030	Divide Routine	
00054	310	Divide Routine	
00055	460	Divide Routine	MSB = 1
00056	540	Divide Routine	
00057	671	Divide Routine	
00058	031	Divide Routine	
00059	540	Divide Routine	
00060	671	Divide Routine	
00061	030	Divide Routine	
00062	311	Divide Routine	
00063	460	Divide Routine	1st Remainder
00064	540	Divide Routine	
00065	671	Divide Routine	
00066	030	Divide Routine	
00067	311	Divide Routine	
00068	460	Divide Routine	2nd Remainder
00069	540	Divide Routine	
00070	671	Divide Routine	
00071	030	Divide Routine	
00072	311	Divide Routine	
00073	460	Divide Routine	3rd Remainder
00074	540	Divide Routine	
00075	671	Divide Routine	
00076	030	Divide Routine	
00077	311	Divide Routine	
00078	460	Divide Routine	4th Remainder
00079	540	Divide Routine	
00080	671	Divide Routine	
00081	030	Divide Routine	
00082	311	Divide Routine	
00083	460	Divide Routine	5th Remainder
00084	540	Divide Routine	
00085	671	Divide Routine	
00086	030	Divide Routine	
00087	311	Divide Routine	
00088	460	Divide Routine	6th Remainder
00089	540	Divide Routine	
00090	671	Divide Routine	
00091	030	Divide Routine	

Table 5-3. Process Flow Test Results (Continued)

Delay Switch	ROM Address	Processor Operation	Comment
00092	311	Divide Routine	
00093	460	Divide Routine	7th Remainder
00094	540	Divide Routine	
00095	671	Divide Routine	
00096	030	Divide Routine	
00097	311	Divide Routine	
00098	461	End Divider Routine	yes
00099	121	FLAG=H, LOAD RESULT to DR	no
00100	520	K Data	no
00101	551	Start and Stop	
00102	341	Breakpoint 2	no
00103	440	States 440 through 441 are repeated for a second time after the arithmetic routine. The purpose of the processor operations will vary during these operations. Consult flowchart theory 2A (440), if needed.	
00104	600		
00105	440		
00106	600		
00107	440		
00108	600		
00109	440		
00110	600		
00111	440		
00112	600		
00113	440		
00114	600		
00115	440		
00116	600		
00117	440		
00118	600		
00119	440		
00120	601		
00121	400		
00122	440		
00123	601		
00124	400		
00125	440		
00126	601		
00127	400		
00128	440		
00129	601		
00130	400		
00131	440		
00132	601		
00133	400		
00134	440		
00135	601		
00136	400		
00137	440		

Table 5-3. Process Flow Test Results (Continued)

Delay Switch	ROM Address	Processor Operation	Comment
00138	601		
00139	400		
00140	440		
00141	601		
00142	400		
00143	441	↓ End of Count Digits	
00144	221	Period or TI	no
00145	450	FLAG=H	no
00146	561	Display Storage	no
00147	510	DC=0	no
00148	500	Determine Auto Multiplier	
00149	270	Determine Auto Multiplier	
00150	711	Determine Auto Multiplier	
00151	741	Determine Auto Multiplier	
00152	770	Determine Auto Multiplier	
00153	741	Determine Auto Multiplier	
00154	770	Determine Auto Multiplier	
00155	741	Determine Auto Multiplier	
00156	770	Determine Auto Multiplier	
00157	740	Determine Auto Multiplier	
00158	500	Determine Auto Multiplier	
00159	270	Determine Auto Multiplier	
00160	710	-1 ≥ DPLR-DS ≥ 3	Mult. Selected
00161	640	Left justify result	
00162	651	Left justify result	
00163	660	Left justify result	
00164	640	Left justify result	
00165	651	Left justify result	
00166	660	Left justify result	
00167	640	Left justify result	
00168	651	Left justify result	
00169	660	Left justify result	
00170	640	Left justify result	
00171	651	Left justify result	
00172	660	Left justify result	
00173	640	Left justify result	
00174	651	Left justify result	
00175	660	Left justify result	
00176	640	Left justify result	
00177	651	Left justify result	
00178	660	Left justify result	
00179	640	Left justify result	
00180	651	Left justify result	
00181	660	Left justify result	
00182	640	Left justify result	
00183	651	Left justify result	

Table 5-3. Process Flow Test Results (Continued)

Delay Switch	ROM Address	Processor Operation	Comment
00184	660	Left justify result	
00185	640	Left justify result	
00186	650	Left justify result	
00187	621	End of Left justify	
00188	260	Auto Right justify	
00189	610	Auto Right justify	
00190	011	Auto Right justify	
00191	621	Auto Right justify	
00192	260	Auto Right justify	
00193	610	Auto Right justify	
00194	011	Auto Right justify	
00195	621	Auto Right justify	
00196	260	Auto Right justify	
00197	610	Auto Right justify	
00198	011	Auto Right justify	
00199	621	Auto Right justify	
00200	260	Auto Right justify	
00201	610	Auto Right justify	
00202	011	Auto Right justify	
00203	621	Auto Right justify	
00204	260	Auto Right justify	
00205	610	Auto Right justify	
00206	011	Auto Right justify	
00207	621	Auto Right justify	
00208	260	Auto Right justify	
00209	610	Auto Right justify	
00210	011	Auto Right justify	
00211	621	Auto Right justify	
00212	260	Auto Right justify	
00213	610	Auto Right justify	
00214	011	Auto Right justify	
00215	621	Auto Right justify	
00216	260	Auto Right justify	
00217	610	Auto Right justify	
00218	011	Auto Right justify	
00219	620	Auto Right justify	
00220	731	Serial Output	no
00221	571	End of Test	

5-25. 5345A OPERATIONAL VERIFICATION

5-26. The Operational Verification can be performed to give a high degree of confidence that the 5345A is operating properly without performing the complete In-Cabinet Performance Check listed in Table 5-5 of the 5345A Operating and Service Manual.

SELF-CHECK

Set 5345A function switch to **FREQ A**, **GATE TIME** to 1 ms, **Input Amplifier Control** switch to **CHECK** and **Display Position** to **AUTO**. Counter should display 100.00 ±1 MHz with Gate Light flashing.

Change Gate Time to **MIN**, counter should display .1 GHz with Gate Light flashing.

Record results on Operational Verification Record.

CHANNEL A INPUT SENSITIVITY

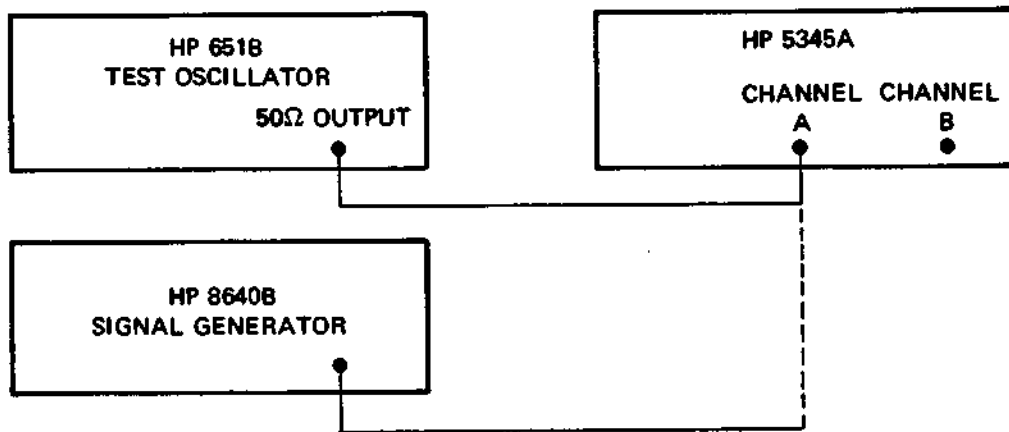
Specification (Channel A and B):

Range: DC coupled, 0 to 500 MHz

Sensitivity: X1 25 mV rms sine wave.

Description: A signal at the minimum level is applied to the 5345A Channel A input and varied over the specified frequency range.

Setup:



Set 5345A controls as follows:

FUNCTION	FREQ A
GATE TIME	100 ms
DISPLAY POSITION	AUTO
SAMPLE RATE	Full CCW
LEVEL A	PRESET
ATTEN	X1
INPUT IMPEDANCE	50Ω
INPUT AMPLIFIER CONTROL	SEP
INPUT COUPLING	DC

Connect signal source to Channel A of the 5345A. Set the input signal to 20 Hz at 25 mV rms, 100 kHz at 25 mV rms, 300 MHz at 25 mV rms, and 500 MHz at 25 mV rms. Counter should display the correct frequency at all points with Gate Light flashing. Record results on Operational Verification Record.

CHANNEL B INPUT SENSITIVITY AND COMMON INPUT TEST

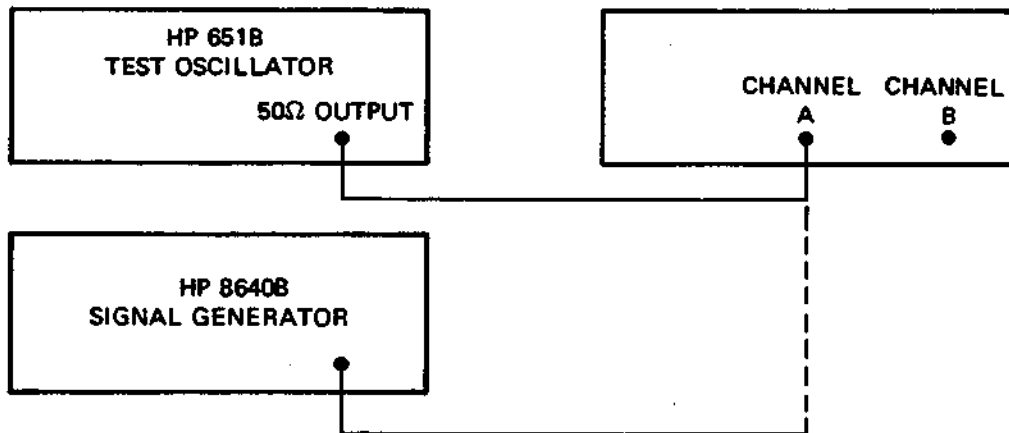
Specification (Common Input):

Range: DC coupled, 0 400 MHz

Sensitivity: X1 50 mV rms sine wave

Description: A signal at the minimum level is applied to the 5345A Channel A input and varied over the specified frequency range. The 5345A is set to Common Input and Ratio B/A. The counter should display approximately "one" over the frequency range.

Setup:



Set 5345A controls as follows:

FUNCTION	RATIO B/A
GATE TIME	100 ns
DISPLAY POSITION	AUTO
SAMPLE RATE	Full CCW
LEVEL (A&B)	PRESET
ATTEN (CHAN A)	X1
INPUT IMPEDANCE (A&B)	50Ω
INPUT AMPLIFIER CONTROL	COM
INPUT COUPLING (A&B)	DC

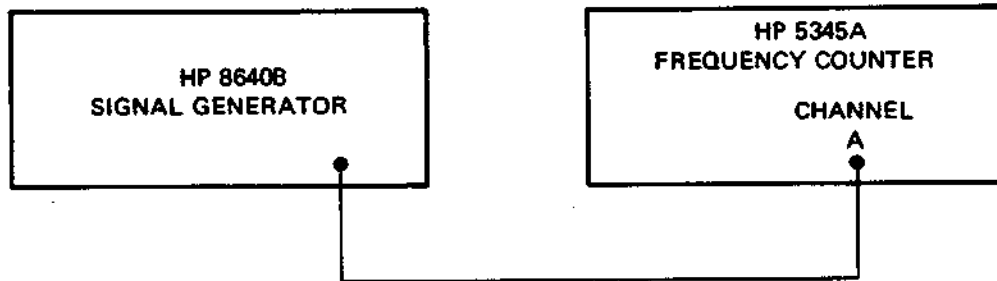
Connect signal source to Channel A of the 5345A. Set the input to 20 Hz at 50 mV rms, 100 kHz at 50 mV rms, 300 MHz at 50 mV rms, and 400 MHz at 50 mV rms. Counter should display a ratio of approximately "one" throughout the frequency range and Gate Light should be flashing. Record results on Operation Verification Record.

PERIOD

Specification:
Range: 2 ns

Description: A 2 ns period signal (500 MHz) is applied to the 5345A Channel A input in order to verify the counter's period specifications.

Setup:



Set 5345A controls as follows:

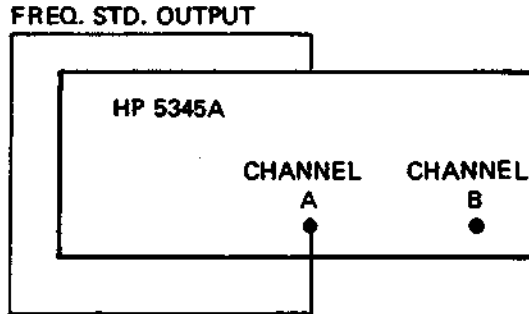
FUNCTION	PERIOD A
GATE TIME	100 ms
DISPLAY POSITION	AUTO
SAMPLE RATE	Full CCW
LEVEL A	PRESET
ATTEN	X1
INPUT IMPEDANCE	50 Ω
INPUT AMPLIFIER CONTROL	SEP
INPUT COUPLING	DC

Connect signal source to Channel A of the 5345A. Set the input signal to 500 MHz at 200 mV rms. Counter should display approximately 2 ns and Gate Light should be flashing. Record results on Operation Verification Record.

TIME INTERVAL

Description: The 10 MHz FREQ STD OUTPUT from the rear panel of the 5345A is applied to Channel A in order to make a Time Interval measurement.

Setup:



Set 5345A controls as follows:

- FUNCTION TIME INT A to B
- GATE TIME 1 ms
- DISPLAY POSITION AUTO
- SAMPLE RATE Full CCW
- LEVEL (A&B) PRESET
- ATTEN (A&B) X1
- INPUT IMPEDANCE (A&B) 50Ω
- INPUT AMPLIFIER CONTROL COM A
- INPUT COUPLING DC
- SLOPE (CHAN A) (+)
- SLOPE (CHAN B) (-)

The counter should display approximately 50.XXXX ns with Gate Light flashing.

Set Channel A SLOPE switch to (-). Counter should display approximately 100.XXX ns with Gate Light flashing.

Record results on Operational Verification Record.

START/STOP

Description: The counter's 100 MHz Check signal is totalized for approximately 10 s in order to verify operation of the START/STOP function of the counter.

Set 5345A control as follows:

- FUNCTION STOP
- GATE TIME MIN
- DISPLAY POSITION AUTO
- SAMPLE RATE Full CCW

Press 5345A RESET switch. Set the FUNCTION switch to START and allow the counter to totalize for approximately 10 s.

Counter should display approximately $2 \times (10^9)$ counts (A+B Mode).

Record results on Operational Verification Record.

OPERATIONAL VERIFICATION RECORD

HEWLETT-PACKARD MODEL 5345A
ELECTRONIC COUNTER

Test Performed by _____

SERIAL NO. _____

Date _____

TEST	RESULTS	
	PASS	FAIL
Self Check:		
100.000 ± MHz	_____	_____
.1 GHz	_____	_____
Channel A Input Sensitivity:		
20.XXXXXX Hz	_____	_____
100.XXXXXX kHz	_____	_____
300.XXXXXX MHz	_____	_____
500.XXXXXX MHz	_____	_____
CHANNEL B INPUT SENSITIVITY AND COMMON INPUT TEST:		
20 Hz, 50 mV rms - 1.0 ±1	_____	_____
100 kHz, 50 mV rms - 1.0 ±1	_____	_____
300 MHz, 50 mV rms - 1.0 ±1	_____	_____
400 MHz, 50 mV rms - 1.0 ±1	_____	_____
Period		
2.XXXXXXX ns	_____	_____
Time Interval		
50.XXXX ns	_____	_____
100.XXX ns	_____	_____
Start/Stop		
2.XXXXXXXXXX GHz	_____	_____

PROCESSOR SYMPTOMS AND TROUBLESHOOTING

- A. The state address is off by one count in the LSD; e.g., Address 450 may be selected instead of 451.
- B. The state address is off by several addresses; e.g., Address 440 follows 211 instead of 151.

HP 1601A EQUIPMENT SETUP

When using the HP 1601A Logic State analyzer, the equipment should be set up as shown in Figure 5-6. The additional Probe Bits can be used to monitor any of the commands or DC levels which make up the qualifiers. Note that many of these commands are active low outputs and will be displayed on the 1601A as zeros.

5345A ASM TESTER SETUP AND OPERATING PROCEDURE

When using the ASM Tester, the equipment should be set up as shown in Figure 5-7. For checking output command states, the ASM Tester should be operated as follows:

1. Set the REF CODE to the last correct state.
2. Set the INTERRUPT MODE switch to SEL STATE.
3. Push CONTINUE. (Ref and test codes should now equal.)
4. Set the INTERRUPT MODE switch to NEXT STATE.
5. Using the 10525A Logic Probe, monitor the desired command.
6. Push CONTINUE. Note: When CONTINUE is pushed, the logic probe will display the active state of the selected command.

PROCESSOR PROBLEM A

Symptom A is the result of a qualifier problem. Several things can cause this to occur.

1. Incorrect ROM command generation.
2. Associated circuits of the qualifier.
3. Defective circuits within the process arithmetic section.

TROUBLESHOOTING METHOD FOR A TYPE PROBLEMS

Troubleshooting for A type problems should be done in the following manner.

1. First, locate the defective state on the flow charts. Refer to the command listings in Table 5-4. Find the letter code adjacent to the defective ROM address. Then, locate this letter code on the flow charts.
2. Determine which qualifier or part of the qualifier is responsible for selecting the correct ROM state. The particular qualifier may be obvious in some cases; however, familiarization with the flow charts will be required for detecting others. See flow chart theory.
3. Using the octal MSB digits of the defective state, locate the A14 qualifier switch and verify the proper closure of the switch. Must set TRIGGER WORD on 1601 to last correct state address while checking for proper switch closure. Refer to the A14 theory for a description of qualifier selection.
4. If the switch is operating properly, trace the qualifier signal back to its source. If it is a multiple qualifier, verify that the remaining qualifiers are inactive.
5. When the source of the qualifier has been identified, check previous ROM states in the flow charts and determine which ROM address executed the command or commands to satisfy the qualifier.
6. Monitor this new address and check the commands to ensure they are generated. If the commands are found to be defective, troubleshoot and repair the circuits. Some qualifiers will be generated by the result of a counter, comparator, or adder. For these qualifiers, the input commands should be checked first. If these commands are correct, the appropriate circuits should then be checked. An example of this type of qualifier is DPLK = -17. The input commands to this qualifier are DPLK = -1 (Reset) and DPLK CLK (DPLK = DPLK -1).

PROCESSOR PROBLEM B

The problem which caused symptom B will generally be a defective ROM or the next state storage circuits (T+1) on the A14 qualifier assembly.

TROUBLESHOOTING METHOD FOR B TYPE PROBLEMS

NOTE

Connect 10230A Clock Probe to A15TP12 while monitoring SV1(T+1) -SV6(T+1).

Troubleshooting this problem should be done as follows:

1. Locate the defective state on the flow charts. Refer to the command listing table. Find the letter code adjacent to the defective ROM address. Then locate the letter code on the flow chart.
2. With the ASM Tester, step the processor to the last correct address. Use the operating procedure outlined in Figure 5-7. With the HP 1601A, trigger on the last correct address.
3. While at this address, check SV1(T+1) - SV6(T+1) states, located at pins 2, 7, 5, 10, 12, and 15, respectively, on the A14 Qualifier Assembly. Pins 2, 7, and 5 equal the Octal MSB, and pins 10, 12, and 15 equal the next MSB.
4. The output levels of these pins should reflect the octal address of the next state to be selected. If it is incorrect, tract the line back to its source and troubleshoot those circuits.

Figure 5-8. Processor Symptoms and Troubleshooting

Table 5-4. Command Source Listing

COMMAND SOURCE		A15-U10-6	A15-U10-3	A15-U10-1	A15-U10-5	A15-U10-2	A15-U10-14	A15-U10-8	A15-U10-11	A15-U10-7	A15-U10-16	A15-U10-12	A15-U10-13	A15-U10-4	A15-U10-5	A15-U10-1	A15-U10-9	A15-U10-17	A15-U10-10	A15-U10-15	A15-U10-3	A15-U10-13-2	A15-U10-13-7	A15-U10-13-5	A15-U10-13-12	A15-U10-13-15	A15-U10-13	A15-U10-2	
MSB	PULSED COMMAND	P	P	P	P	P	P	P	P	P	P	P	P	P	P	P	P	P	P	P	P	P	P	P	P	P	P	P	
LETTER CODES	ADDRESS	COMMAND SOURCE																											
		ON	OFF	PULSE CNT.	IS PULSE CNT.	ADD	DC-4	DC CLK	DRP CLK EN	DRK CLK	DRK CLK	DRK CLK	DRK CLK	DRK CLK	DRK CLK	DRK CLK	DRK CLK	DRK CLK	DRK CLK	DRK CLK	DRK CLK	DRK CLK	DRK CLK	DRK CLK	DRK CLK	DRK CLK	DRK CLK	DRK CLK	DRK CLK
SHT 3P	000	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H
RESET	001	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H
SHT 2B0	010	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H
SHT 2B1	011	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H
SHT 3B	020	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H
SHT 3B	021	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H
SHT 3D	030	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H
SHT 3D	031	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H
SHT 4	040	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H
SHT 4	041	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H
SHT 2	050	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H
SHT 2	051	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H
SHT 4H	060	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H
SHT 4H	061	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H
SHT 3A	070	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H
SHT 3A	071	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H
SHT 3K	100	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H
SHT 3A	101	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H
SHT 4	110	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H
SHT 4	111	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H
SHT 3G	120	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H
SHT 3G	121	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H
SHT 3N	130	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H
SHT 3N	131	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H
SHT 4E	140	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H
SHT 4E	141	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H
SHT 1H	150	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H
SHT 1H	151	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H
SHT 4D	160	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H
SHT 4D	161	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H
SHT 1L	170	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H
SHT 1L	171	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H
SHT 2K	200	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H
SHT 2K	201	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H
SHT 1D	210	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H
SHT 1D	211	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H
SHT 2D	220	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H
SHT 2D	221	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H
SHT 1K	230	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H
SHT 1K	231	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H
SHT 2H	240	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H
SHT 2H	241	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H
SHT 3J	250	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H
SHT 3J	251	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H
SHT 2Z	260	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H
SHT 2Z	261	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H
SHT 2R	270	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H
SHT 2R	271	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H
SHT 1D	300	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H
SHT 1D	301	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H
SHT 3E	310	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H
SHT 3E	311	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H
SHT 1D	320	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H
SHT 1D	321	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H
SHT 1G	330	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H
SHT 1G	331	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H
SHT 3R	340	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H
SHT 3R	341	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H
SHT 4C	350	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H
SHT 4C	351	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H
SHT 1J	360	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H
SHT 1J	361	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H
SHT 4C	370	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H
SHT 4C	371	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H	H

NOTE:
* NORMALLY H, L WITH "N" DATA ROUTINE.
BLANK LOCATIONS = DON'T CARE STATES.
BOLD LETTERS = ACTIVE STATES.

Figure 5-8
PROCESSOR SYMPTOMS AND TROUBLESHOOTING

(See Page 5-27)

Table 5-4. Command Source Listing (Continued)

COMMAND SOURCE	MSB		PULSED COMMANDS		LETTER CODES		ADDRESSES		COMMANDS	
	0	1	0	1	0	1	0	1	0	1
SHT 2C	400	H	H	L	H	L	H	L	H	L
SHT 2C	401	H	H	L	H	L	H	L	H	L
SHT 2Q	410	H	H	L	H	L	H	L	H	L
SHT 2Q	411	H	H	L	H	L	H	L	H	L
SHT 2G	420	H	H	L	H	L	H	L	H	L
SHT 2C	421	H	H	L	H	L	H	L	H	L
SHT 2M	430	H	H	L	H	L	H	L	H	L
SHT 2M	431	H	H	L	H	L	H	L	H	L
SHT 2A	440	H	H	L	H	L	H	L	H	L
SHT 2A	441	H	H	L	H	L	H	L	H	L
SHT 2E	450	H	H	L	H	L	H	L	H	L
SHT 2E	451	H	H	L	H	L	H	L	H	L
SHT 2F	460	H	H	L	H	L	H	L	H	L
SHT 2F	461	H	H	L	H	L	H	L	H	L
SHT 2L	470	H	H	L	H	L	H	L	H	L
SHT 2L	471	H	H	L	H	L	H	L	H	L
SHT 2P	500	H	H	L	H	L	H	L	H	L
SHT 2P	501	H	H	L	H	L	H	L	H	L
SHT 2N	510	H	H	L	H	L	H	L	H	L
SHT 2N	511	H	H	L	H	L	H	L	H	L
SHT 3H	520	H	H	L	H	L	H	L	H	L
SHT 3H	521	H	H	L	H	L	H	L	H	L
SHT 2H	530	H	H	L	H	L	H	L	H	L
SHT 2H	531	H	H	L	H	L	H	L	H	L
SHT 3S	540	H	H	L	H	L	H	L	H	L
SHT 3S	541	H	H	L	H	L	H	L	H	L
SHT 3Q	550	H	H	L	H	L	H	L	H	L
SHT 3Q	551	H	H	L	H	L	H	L	H	L
SHT 2L	560	H	H	L	H	L	H	L	H	L
SHT 2L	561	H	H	L	H	L	H	L	H	L
SHT 1C	570	H	H	L	H	L	H	L	H	L
SHT 1C	571	H	H	L	H	L	H	L	H	L
SHT 2B	600	H	H	L	H	L	H	L	H	L
SHT 2B	601	H	H	L	H	L	H	L	H	L
SHT 2AA	610	H	H	L	H	L	H	L	H	L
SHT 2AA	611	H	H	L	H	L	H	L	H	L
SHT 2Y	620	H	H	L	H	L	H	L	H	L
SHT 2Y	621	H	H	L	H	L	H	L	H	L
SHT 4A	630	H	H	L	H	L	H	L	H	L
SHT 4A	631	H	H	L	H	L	H	L	H	L
SHT 2T	640	H	H	L	H	L	H	L	H	L
SHT 2T	641	H	H	L	H	L	H	L	H	L
SHT 2W	650	H	H	L	H	L	H	L	H	L
SHT 2W	651	H	H	L	H	L	H	L	H	L
SHT 2X	660	H	H	L	H	L	H	L	H	L
SHT 2X	661	H	H	L	H	L	H	L	H	L
SHT 2C	670	H	H	L	H	L	H	L	H	L
SHT 2C	671	H	H	L	H	L	H	L	H	L
SHT 1E	700	H	H	L	H	L	H	L	H	L
SHT 1E	701	H	H	L	H	L	H	L	H	L
SHT 2S	710	H	H	L	H	L	H	L	H	L
SHT 2S	711	H	H	L	H	L	H	L	H	L
SHT 4B	720	H	H	L	H	L	H	L	H	L
SHT 4B	721	H	H	L	H	L	H	L	H	L
SHT 1B	730	H	H	L	H	L	H	L	H	L
SHT 1B	731	H	H	L	H	L	H	L	H	L
SHT 2U	740	H	H	L	H	L	H	L	H	L
SHT 2U	741	H	H	L	H	L	H	L	H	L
SHT 1F	750	H	H	L	H	L	H	L	H	L
SHT 1F	751	H	H	L	H	L	H	L	H	L
SHT 4K	760	H	H	L	H	L	H	L	H	L
SHT 4K	761	H	H	L	H	L	H	L	H	L
SHT 2V	770	H	H	L	H	L	H	L	H	L
SHT 2V	771	H	H	L	H	L	H	L	H	L

NOTE:
* NORMALLY H, L WITH "N" DATA ROUTINE.
BLANK LOCATIONS = DONT CARE STATES.
BOLD LETTERS = ACTIVE STATES.

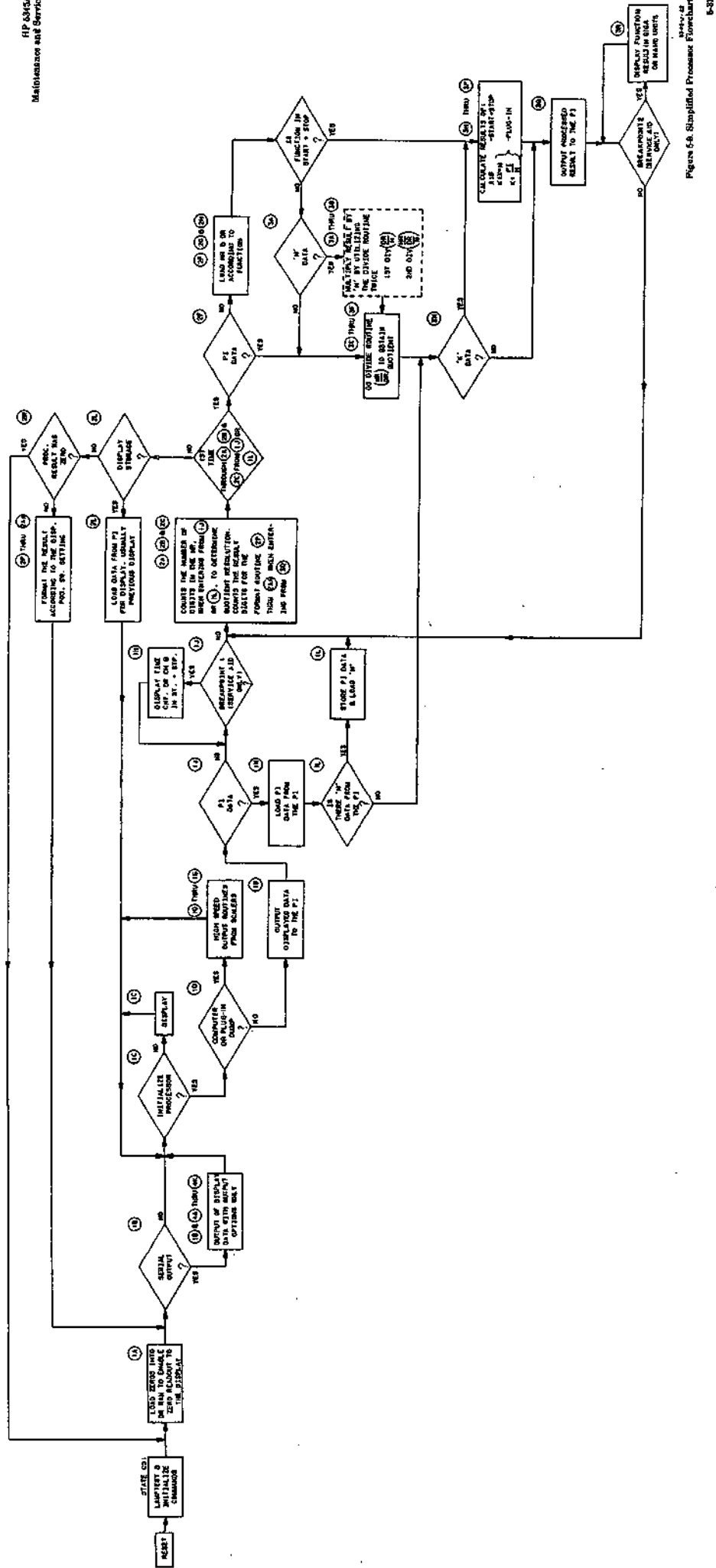


Figure 6-8. Simplified Process Flowchart

SYMBOLOLOGY

- reads "assign," e.g., DPLR--1 reads "DPLR assign minus one."
- + reads "or" (will occasionally read "plus," e.g., DCR--DRC+1).
- reads "and."
- reads "not," e.g., qualifier 1E reads: "yes, the counter is ready for data and DPLK is not equal to minus 33."
- b reads "blanks," e.g., QR-b reads "QR assign blanks."
- reads "minus."

This state sets up the conditions prior to lamp test and the display of zeros. Lamp test is accomplished by the RESET and DISPCLK EN signals. The DPLK-DPLK-1 command clocks the DPLK counter. The DPLK output is then used as the display clock for the LED display. The RESET FRONT END command resets the scalars to zero.

Lamp test is displayed when enabled by DRC--DRC+1. The reset circuit enables the DRC--DRC+1 command repeatedly so the Denominator Register Counter is circulated through all 16 locations of the Denominator RAM. This causes lamp test display for approximately 50 msec during reset.

The decimal point is also positioned out of the visual range of the display by DPLR--1. Plug-in data is inhibited by PI XMT BUS. The FLAG--H and DC--0 qualifiers are used later. PROC BUSY is inhibited until the end of the measurement phase.

The DIGIT COUNTER has just been set to 0, so command State 101 is selected.

This state sets the sign in the display to plus, continues to RESET FRONT END and inhibit PROC BUSY. Zeros are again loaded into the DR and also in the QR by DRC--DRC+16 and QRC--QRC+16. The decimal point is also shifted by the command DPLR--DPLR-1 for the serial output routine.

The SERIAL OUTPUT qualifier determines if the TALK ALWAYS switch is set or the serial output routine has been remotely programmed.

The command state resets the DPLK counter and digit counter. The DR and QR RAMs, which contain the data to be outputted, are shifted one RAM location by DRC--DRC+15 leading digits in the QR RAM. Digit counter is used by the programming option A12 to indicate the type of data to be outputted. See Table 4-2 A12 ROM sequence. After execution of this state, the DR and QR counters address the MSD in the RAM. The PROC BUSY is inhibited during the output routine.

This state continues to RESET FRONT END and inhibit PROC BUSY.

The INIT PROC qualifier remains false (N) until completion of the next measurement phase. Upon completion of TIME and EVENTS loaded into the scalars, the last measurement is displayed at State 571.

This state reads the DR contents to the display with commands DR--DR, DRC--DRC+1. If the display time is 12 µsec or more, the DRC will go through 11 states for a positive display of 11 digits; 12 states for a negative display of 11 digits and the -polarity sign. The display clock is generated by command DPLK--DPLK-1. The PI XMT BUS command inhibits PI DATA while DR data is read to the display. PROC BUSY is also inhibited until measurement phase is completed.

This state signifies the beginning of the process cycle. The DRC, DC, and DPLK counters are reset at this state.

1D QUALIFIER

STATE 210

The COMPUTER DUMP+PI DUMP qualifier remains false unless activated by the remote programming unit or the plug-in unit. This state loads the TIME and EVENT counts into the NR and DR, respectively. The EVENT counts are transmitted through the DR to the plug-in unit. The number of digits (α) transferred out of the TIME AND EVENT scalars is 16 (α = 16) for COMPUTER DUMP operation. For PI DUMP operation α is a variable from 1 to 16 (α = 1 - 16). Refer to "Theory of Operation" in applicable manual for plug-in unit.

STATE 211

This command state enables the DR contents to be read to the plug-in when requested and also loads the time count from the A11 time scaler into the NR. The asterisk is also turned off. The following commands provide these operations.

DR--DR } Rotate the contents of the DR onto the bus.
DRC--DRC+16 }

PI CLK EN } Enables 16 register clock pulses to the PI for data loading.

NR--TC } Control the writing of the time count into
NRC--NRC+16 } the NR.

QR--b } Loads blank (b) into the WR.
QRC--QRC+16 }

PI XMT BUS } Inhibits plug-in data from being placed on the bus.

FLAG--L } This is a qualifier director used for the plug-in data routine.

*--OFF } Turns off the asterisk in the display block.

The PI DUMP qualifier is determined by the plug-in unit when PI DUMP data is requested, otherwise the qualifier is false and COMPUTER DUMP data is assumed.

This state transfers TIME counts from NR through DR to the plug-in. The numbers of digits transferred (α) is determined by PI DUMP. See "Theory of Operation" in plug-in manual for added details. PI CLK EN provides clock pulses to the plug-in unit for data loading. RES FRONT END resets all scalars, and PI XMT BUS enables data input to the plug-in unit.

Blanks are loaded into the WR by QR-b and QRC--QRC+16 commands to blank the display when COMPUTER DUMP is requested. The EXT OUT EN signal to A12 enables data outputting on the general purpose interface bus (HP-IB).

This qualifier is true unconditionally and selects state 320.

Scalars in A11 reset by RES FRONT END command while PROC BUSY signals processing cycle is complete. Decimal point is set out of visual range for next display cycle by DPLR--1 command.

This state occurs only if a qualifier malfunction occurs. State 321 is programmed identical to state 320 so counter operation is not affected.

The READY FOR DATA • DPLK--33 qualifier performs two main functions.

1. It causes the process to go into a wait loop (State 700 and State 750) until the READY for DATA (RFD) signal is received from the output recording device.
2. Causes the output to be terminated after all 32 characters have been outputted.

The EXT OUT EN signal is used to enable placing data on the general purpose interface bus. RES FRONT END resets the A11 scalars.

STATE 701

The EXT OUT EN signal is used to enable placing data on the general purpose interface bus (signal to A12). The FLAG--H causes the A12 DAV line to go Low, indicating the data is on the bus. PI DATA is inhibited from the A13 bidirectional bus and DPLK is decremented, indicating a character has been outputted.

1F QUALIFIER

The DPLK--33 qualifier determines when all the characters have been outputted from the DR and NR RAMs. It is initialized to minus one at State 570 and each time a character is outputted, State 701 decrements the counter.

STATE 750

This state inhibits the plug-in from placing any data on A13A(7, 5, 6, and 8) bidirectional bus. The EXT OUT EN signal is used to enable placing data on the general purpose interface bus.

STATE 751

This state loads blanks into the DR for the display, sets the decimal point out of visual range by DPLR--1, resets front end for next measurement, and disables the processor. The sign is also set to + for the display. This completes the computer dump routine.

1G QUALIFIER

The DATA ACCEPTED is a qualifier which originates from the recording device via the A12 assembly. If the data has not been accepted by the output device, State 330 is selected.

STATE 330

This state is a wait state which enables the data to be held on the output lines until the data is received by the recording device. PI XMT BUS is held inactive, thereby inhibiting PI DATA. EXT OUT EN allows the data to be held on the general purpose interface bus.

STATE 331

Once the data is accepted, the next character can now be readied for outputting. This is done by shifting the DR and NR RAMs by one place (DR--NR, DRC--DRC+1 and NR--NR, NRC--NRC+1). The EXT OUT EN remains enabled, however, the FLAG--L causes the DAC line on A12 to go High which indicates the data on the bus is no longer valid. PI XMT BUS remains inactive, inhibiting PI DATA.

- 1H QUALIFIER** The PI DATA or BREAKPOINT 6 qualifier checks for PI DATA or the service switch setting A14S1-6. The 5345A uses this qualifier when sending its band frequency to the 5345A.
- STATE 150** This state sets the sign to "+" and loads PI DATA to the DR RAM. The PI decimal point is also transferred to the DPLK counter. The PI XMT BUS enables the PI to transmit its data onto the A13 bidirectional data bus.
- STATE 151** This state sets the sign to "+" and loads the time count from the NR to the DR in preparation for State 360. All data transferred to the display must be done via the DR RAM. The flag is also set High for future qualifiers 2C, 2D, and 2E.
- 1J QUALIFIER** The BREAKPOINT 1 qualifier is generally used when servicing the 5345A. When it is enabled by switching A14S1-1, the contents of the NR is displayed via the DR RAM.
- STATE 360** This state reads data from the DR RAM (time count) and into the display. The DPLK counter generates the DISP CLK. The DISP CLK EN enables the display and also causes the DRC on A13 to select a count 11 mode. DPLR is decremented, so its correct operation can be verified easily. This state also inhibits any PI DATA. The QR is also rotated with the DR RAM; however, this is done for purposes of servicing only.
- STATE 361** This state reinitializes the DPLK, DPLR, QMC, and DRC counters. This is normally done after display states.
- 1K QUALIFIER** The DPLR=DPLK qualifier essentially causes the contents of the DPLK counter to be loaded into the DPLR. The DPLR counter increments at State 231 until it equals the DPLK count. The flag must be low at this state to enable the comparison (see A14 Theory). The flag was set low at prior State 211.
- STATE 231** This state causes DPLR to increment, so it can be equated with DPLK at the 1K qualifier.
- STATE 230** This state resets DPLK; this can be done now because the contents were equated at the DPLK=DPLR qualifier. QMC is also reset for future use, and DPLR is decremented in the event "N" data is selected. "N" data causes the divide routine to be selected; where the result of the routine is accumulated in the QMC, therefore, the decimal point must be offset by one.
- 1L QUALIFIER** The N DATA • $\overline{\text{BREAKPOINT 4}}$ (QMC=0) qualifier is active when N data is available from the PI. Many of the 5245 plug-ins send N data to the 5345A. Breakpoint 4 is a switch used to inhibit N data. This can be helpful when troubleshooting a mainframe that includes a plug-in with N data available.
- STATE 171** With no N DATA, State 171 recovers the previous decimal point shift at State 230 with command DPLR=DPLR+1. The digit counter is incremented by DC-DC+1 in case the K DATA routine is selected. DC cannot be set to zero for K DATA.

NOTE

PI and K DATA must be in Giga or Nano units from the plug-in.

- STATE 170** This state sets the processor to divide PI DATA by N DATA. The previously loaded PI DATA is transferred from the DR RAM to the NR RAM by commands NR-DR, NRC-NRC+16, DRC-DRC+16. N DATA can now be loaded from the plug-in via the bi-directional bus to the A13 DR RAM. This is done with command DR-PI, PI CLK EN, and PI XMT BUS. The FLAG-H is used as a qualifier director to ensure State 2E (451) will be selected.

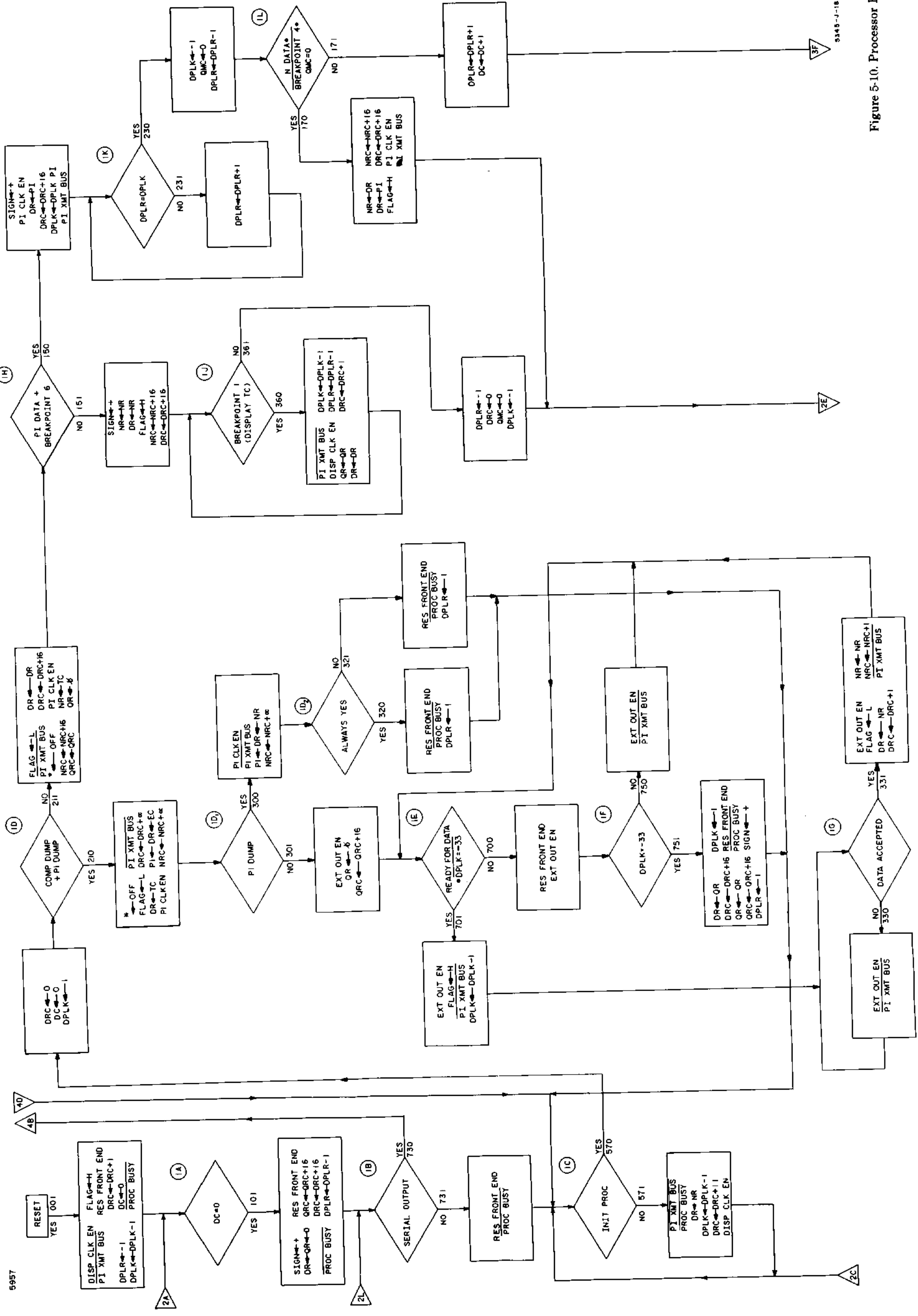


Figure 5-10. Processor Flowchart, Sheet 1

2A QUALIFIER The $DPLK=-17$ qualifier is a routine consisting of commands and qualifiers 2A, 2B, and 2C. The commands and qualifiers in the loop are used to determine the number of significant digits desired in the algorithm. This loop looks at time data in the NR, beginning with the most significant digit, to determine the first nonzero digit. The NR is rotated until a nonzero is detected; then, the remaining digits in the RAM are counted.

STATE 441 This state resets QMC. This must be done because the 2A, 2B, and 2C routine could leave the counter at any value.

STATE 440 This state rotates the time data in the NR by one position with $NR-NR$ and $NRC-NRC+15$ commands. DPLK is used as a loop counter and is decremented by $DPLK-DPLK-1$ each time it passes this state. The counter will be decremented until all 16 digits have been rotated through the RAM. The QR is also rotated by one position to allow loading of the next digit at State 2B(601) by $QRC-QRC+15$. This is required when the processor again enters this loop after the arithmetic routines. It maintains the alignment of the result and ensures that blanks remain in leading locations of QR. This must be done because QR is used as the working RAM during the format routine.

2B QUALIFIER The $NR=0 \cdot QMC=0$ qualifier compares the NR MSD character with QMC. As long as they are both zero, State 600 is selected. When the first nonzero digit appears in the NR, a "noncompare" occurs and State 601 is selected.

STATE 600 This state causes the $DPLK=-17$ qualifier to be selected. The processor will continue to select State 440 and 600, rotating the NR and QR and decrementing DPLK until $NR=0$ is not zero at qualifier 2B.

STATE 601 This state loads the contents of the NR into the QR. Because the QR contents were all blanks prior to this state, the MSD zero digits in the NR will result as blank digits in the QR. The operation is not required when entering the 2A, 2B, and 2C loop from State 1J(361) or 1L(170). It is required, however, after the arithmetic routines when entering from State 3R(541) in preparation for the formatting routine.

2C QUALIFIER This qualifier is required to maintain the accuracy specification in MIN gate time when entering the qualifier from 1J(361) or 1L(170). MIN gate is the only gate position where this is required. During this first time through, State 400 is selected if the leading MSD is a 5 or greater. If it is less than 5, State 401 will be selected and the leading digit will not be counted. Events, Ratio, Start or Stop, and MIN always cause State 400 to be selected. The $QMC=0$ ensures that for the remaining times through this loop State 2C(400) will be selected instead of 2C(401). $FLAG=H$ causes State 2C(400) to always be selected when entering the 2A, 2B, and 2C loop from State 3R(541) instead of 1J(361) or 1L(170).

STATE 401 This state ensures two actions:

1. That State 601 will be selected for the remaining times through the loop, instead of State 600. This ensures that any remaining zero digits in the NR will be counted.
2. Causes the $QMC=0$ to be true, thereby always forcing State 400 to be selected during the remaining times through the loop. This causes Digit Counter to count the remaining digits at State 2C(400).

STATE 400 If the 2C qualifier caused this state to be selected on the first pass through the loop, then $QMC-QMC+1$ performs the same action it did at State 401. $DC-DC+1$ is incremented and loaded into Digit Storage by $DS-DC$ each time this state is encountered. This causes the digits in the NR to be counted by DC and stored in DS.

2D QUALIFIER This qualifier is also used to maintain the accuracy specification, as was qualifier 2C. When the 2D qualifier conditions are met, the result in the divide routine calculates one extra quotient digit. It does this because DS is incremented at State 220. The $FLAG=H$ in this qualifier is true the first time this state is encountered because of State 1J(361). It will be false after the 2A, 2B, and 2C routine is encountered the second time from State 3R(541). In this case, it was set low after the divide routine at State 3G(121). This causes State 220 to be bypassed. The accuracy specification is checked only when the state is encountered for the first time.

STATE 220 Increments DC by one and places this into DS. This causes the quotient result in the divide routine to calculate one more digit when in MIN gate.

STATE 221 Causes State 220 to be bypassed.

Sheet **1**

Figure 5-10
PROCESSOR FLOWCHART, SHEET 1

(See Page 5-33)

- 2E QUALIFIER** The first time this qualifier is encountered from 2A, 2B, and 2C, the flag will be high from 1L(170) or 1J(361); therefore, State 451 will be selected. The second time through this loop from 2A, 2B, and 2C, the flag is low and DPLK=-17 is false, so State 450 is selected. The DPLK=-17 is active when entering this state from sheet 3K after the result has been multiplied by "N". This was done in routine 3A through 3G. Selection of State 451 causes the divide routine to be repeated.
- STATE 450 The DPLK counter is reset at this state.
- STATE 451 Because the contents of DC are now stored in DS for divide routine, the counter is reset by command DC-0.
- 2F QUALIFIER** This qualifier checks for PI DATA or BREAKPOINT 6. BREAKPOINT 6 is a service switch, located on A14S1-5, which enables State 050 to be selected.
- STATE 050 This state is selected for the division of PI DATA by "N". The QR is loaded with zeros in preparation for the divide routines 3C through 3F.
- STATE 051 Time count from the scalers is loaded into the NR and also rotates into the DR. This is in preparation for doubling the time count to place reading in terms of Giga or Nano units.
- 2G QUALIFIER** This qualifier determines if the time count must be doubled. It is not doubled for C Channel Events + Ratio + Start + Stop.
- STATE 421 When the time count is not doubled, the event count is loaded into the DR. DR-EC and DRC-DRC+16 perform this operation.
- STATE 420 The NR and DR RAMs are rotated and the contents are added, thereby yielding the result of twice the time count. NR-NR+DR and DRC-DRC+16 and NRC-NRC+16 perform this. As the DR RAM is rotated, the event count is loaded into it.
- 2H QUALIFIER** This qualifier determines if the NR and DR contents must be rotated to yield the reciprocal. This operation must be done for a frequency measurement.
- STATE 530 Rotates the NR and DR contents to enable calculation for frequency measurement.
- STATE 531 No change in NR and DR contents is required. Causes qualifier 2J to be selected.
- 2K QUALIFIER** State 200 is selected when the counter's function is START or STOP.
- STATE 200 This state sets the DC to one and also increments DPLR by one. DC is used as a qualifier director at State 000 (3P). It must not equal zero when going through this state. The decimal point for start or stop must be right justified in the display. The DPLR value prior to 2K was equal to -1; so by incrementing DPLR by one, it will now be equal to zero. This positions the decimal point to the extreme right in the display.
- STATE 201 This state causes qualifier 3A to be selected.

- 2L QUALIFIER** Some plug-ins have the capability of storing the old, or previously displayed data. When the plug-in requests a transfer of the old displayed data, the data is transferred from a plug-in RAM. When this occurs, State 560 is selected.
- STATE 560 This state loads the old display contents into the DR RAM. This is done by DR-PIS, DRC-DRC+16, PI CLK EN, and by enabling the PI XMT BUS line. The decimal point data is transferred to the DPLK counter by DPLK-DPLK-PI. DPLR is reset in preparation for State 2M. Any data that was stored by the PI is assumed to be "+", so the sign is assigned "+". The plug-in can make data "-" by activating PI INV SIGN. The RES FRONT END command is provided in preparation for the next measurement.
- STATE 561 The FLAG-H command is required for the Auto/Manual routine (2P through 2AA).
- 2M QUALIFIER** This qualifier looks for equality between DPLK and DPLR. When this occurs, their contents are the same. This means that, in effect, the contents of DPLK was loaded into DPLR.
- STATE 241 When DPLK does not equal DPLR, the DPLR counter is incremented by 1 (DPLR-DPLR+1) and then rechecked for equality. This continues until they equal.
- STATE 240 When equality occurs in the qualifier (2M), the DPLK counter is reset (DPLK--1). This can be done because the DPLR counter now contains the same count as DPLK. The PROC BUSY line is disabled, so a new measurement cycle can occur. RES FRONT END also occurs in preparation for the new measurement cycle.
- 2N QUALIFIER** Qualifier 2N checks if the DC equals zero. It will be zero if during the previous 2A, 2B, and 2C routine the NR contained all zeros. When this occurs, the Auto/Manual routine (2P through 2AA) is bypassed and the processor goes into the display routine to display or output zeros. Normally, the DC has something other than zero, so State 510(2P) is selected.
- STATE 510 This state selects the Auto/Manual routine (2P).
- STATE 511 The DPLR counter is set to -1, which sets the decimal point out of the viewable range of the display. RES FRONT END is done in preparation for a new measurement cycle.
- 2P QUALIFIER** This qualifier determines if the front panel DISPLAY POSITION is set to AUTO or the DISPLAY POSITION has been set to a manual position for the first time (AUTO SC • LOCAL MUL) and RESET has been pressed.
- STATE 501 This state selects the local multiplier qualifier (2Q).
- STATE 500 This state selects the DS<3 qualifier (2R).
- 2Q QUALIFIER** This qualifier determines if the multiplier is local or if it is programmed remotely. If it is being programmed remotely, then State 411 is selected and the remote multiplier is loaded into MS. If the multiplier is local, then MS contains what was loaded at State 710(2S) during the last AUTO processing cycle.
- STATE 410 This state selects qualifier 2T.
- STATE 411 This state loads the remote multiplier into MS.
- 2R QUALIFIER** DS<3 digit qualifier is required when less than three digits are displayed; for example, MIN and CHECK display .1 GHz. In this case, the display remains unchanged. It does not shift the decimal point or change the multiplier and display to 1XX. MHz (XX equaling factitious zeros). To maintain the current decimal point location and multiplier when there is less than three digits, DC is incremented and stored in DS until the count equals three. It does this in the 271(2R) State. In the case of MIN and CHECK, qualifier 2S performs the DPLR(+1)-DS(+3) function. This qualifier is then satisfied because the difference between DPLR and DS is now -2. This causes State 710 to be selected.
- STATE 271 This state increments Digit Counter and stores its contents into Digit Storage until the Digit Storage equals three.
- STATE 270 The comparing of DPLR and DS at qualifier 2S requires that the DPLR data be placed on the bidirectional bus. This state, therefore, inhibits any plug-in data from the bus.

2S QUALIFIER This qualifier performs the comparison to determine if the result of the subtraction (DPLR-DS) is between -1 and -3. For example, assume a frequency measurement of the internal check signal is on 1 sec gate time mode. After the division routine at 3C through 3F, a reading of .100000000 GHz results. The AUTO decimal point position will cause a reading with the decimal point realigned to display 100.000000 MHz. This is accomplished as follows:

With .100000000 GHz, DPLR equals +9

With 1 sec gate time, there will be nine digits, so DS=+9. The qualifier compares DPLR with DS; the result is zero, so the -1 to -3 criterion is not met. State 711 is therefore selected. The next requirement is to shift the decimal point in increments of three and check for the -1 to -3 criterion each time. In frequency this causes the multiplier to shift from GHz to MHz to kHz, etc. This operation begins at State 711.

QMC is used to store the multiplier. It will count from 0 to 6, with each number representing a different multiplier. If QMC reaches 6, it is necessary to ensure it is not incremented any further; therefore, the QMC=6 part of the qualifier causes the 2P, 2R, 2S, 2U, and 2V loop to be exited at State 710(2S). Another instance when this occurs is when a plug-in enables the processor to measure in the pico sec range. This case would cause nano sec to be selected; however, the criterion of DPLR and DS between -1 and -3 is not met. This would attempt to cause micro seconds to be selected and would only worsen the situation. The solution is to retain the nano multiplier. This is done by the qualifier DPLR-DS= + and nano. As an example, for .00XXXXX nano sec., DPLR would be 6 and DS=4. The difference provides a + with nano, so the qualifier is now satisfied. State 710 will now be selected, and the nano multiplier and the decimal point position remain unchanged. A zero difference between DPLR and DS will also yield a + result. Another case occurs with an excessively large number in start or stop, such as 999 GHz. This case is covered by the qualifier Start + Stop • DS>12. 999 GHz would be 12 digits, again forcing the processor to 710 leaving the decimal point and annunciator unchanged. The last case occurs with large numbers caused by the Plug-in's multiply-by-N routine. This could cause DPLR to end up in the minus region. When this occurs, the processor again must leave the multiplier and decimal point unchanged. This is provided by the qualifier $\overline{\text{nan0}} \bullet \overline{\text{DPLR+}}$.

STATE 710 This state loads the annunciator code from the QMC into the multiplier storage (MS).

STATE 711 This state selects the qualifier 2U.

2T QUALIFIER When entering from 2Q, this qualifier determines if the remote programmed or internal multiplier (MS) is equal to QMC. If not, State 641 will be selected. States 2U and 2V will change QMC and the decimal point until QMC equals MS. When this occurs, the correct multiplier has been selected and State 640 is selected. When entering from 710(2S) or 660(2X), State 640 is always selected.

STATE 641 Causes qualifier 2U to be selected.

STATE 640 This state moves the contents of the QR one location, so the most significant character (digit or blank) is in position for the next qualifier, 2W.

2U QUALIFIER The DPLK counter ensures that qualifier and States 2V are entered three times. DPLK is set to -1 prior to this state.

STATE 740 This state resets DPLK, since States 2V have been entered three times. QMC is also incremented, which represents the multiplier change.

STATE 741 This state causes the DPLK counter to be clocked, decrementing its value by one. This will continue each time this state is encountered until DPLK=-4.

- 2V QUALIFIER** The nano qualifier determines if the measurement is Nano or Giga.
- STATE 770 When State 770 is selected, the measurement unit was Giga. The multiplier change requires the decimal point be shifted three places to the display's right. Each shift is accomplished with DPLR-DPLR-1.
- STATE 771 When State 771 is selected, the measurement unit was nano. The multiplier change requires the decimal point be shifted three places to the display's left due to 2U and 2V. Each shift is accomplished with DPLR-DPLR+1.
- 2W QUALIFIER** This qualifier is the start of the 2W, 2X, and 2T loop, which is used to position the QR content to its most significant locations. The loop checks the decimal point location. When the decimal point is in the positive region, blanks are loaded in the LSD locations of the QR until there are no MSD blanks. When the decimal point is in the negative region, the QR is rotated one location, and the LSD position is loaded with a factitious zero at 640(2T). This qualifier continues to enter the 2W, 2X, and 2T loop, until the decimal point becomes positive and MSD location of the QR is not a blank.
- STATE 650 This state resets digit counter (DC-0). This is required for future State 2AA. The RES FRONT END is activated in preparation for the next measurement. The QR is also repositioned one location. This was required because of previous State 2T(640). The one location change enables the least significant character of QR to be addressed for qualifier 2Y.
- STATE 651 This state selects the 2X qualifier.
- 2X QUALIFIER** This qualifier determines if the decimal point counter is in the positive or negative region. State 660 is selected when it is plus.
- STATE 660 The blank at the QR location is preserved here with QR-b; this character will be in the least significant location after execution of 640(2T). When the contents are rotated at State 2T(640), the decimal point must also be moved. This is done at this state with DPLR-DPLR+1.
- STATE 661 Because the decimal point is in the negative region, factitious zeros must be loaded into the least significant location of the QR RAM (QR-0). Because factitious zeros are loaded into the QR, the command *-ON enables the asterisk to be turned on. The QR contents were rotated at State 2T(640), so the decimal point must also remain aligned. This state performs this by incrementing the decimal point code (DPLR-DPLR+1).
- 2Y QUALIFIER** This qualifier determines if the DISPLAY POSITION switch is in the AUTO or manual position; and if in manual, it checks the decimal point position relative to the manual DISPLAY POSITION switch setting. If the decimal point is not equal to the selected display position code, alignment is necessary, so State 621 is selected. Alignment is accomplished by shifting the result and decimal point position right or left until the decimal point code matches the display position code. If AUTO is selected, the result (QR) and decimal point are shifted right until no blanks are located in the right most location. State 621 is also selected for this.
- STATE 621 This state changes the QRC code to address the most significant character in the QR. This is necessary in case State 2Z(261) is selected where blanks will be placed in the MSD position.
- STATE 620 State 2Y(620) occurs under the two following conditions:
1. In Manual display, alignment is attained.
 2. In Auto, the most right-justified digit is no longer a blank.
- State 2Y(620) now loads the formatted result into the DR RAM in preparation for the display. The status of the asterisk is determined at this time. DS is loaded with the DC. The asterisk is displayed only if DS is less than five or if an *-ON command occurred. The RES FRONT END and disabling PROC BUSY is in preparation for the next measurement.

2Z QUALIFIER This qualifier determines if the AUTO or manual front panel display has been selected. If the DISPLAY POSITION switch is in manual, it checks if the decimal point position is greater than or equal to the value of the switch setting. If it is not, the MSD of the QR must be loaded with a blank code. The blank is loaded at State 261.

STATE 261 This state completes the "shift the result to the left" operation that was started at 621(2Y). The QR location, which now represents the least significant character of the display, is blanked and decimal point is shifted left one position. Execution of 261 means that an overflow occurs and the asterisk will be displayed, due to DC set to zero at State 650(2W). RES FRONT END is activated in preparation for the next measurement.

STATE 260 This state positions the QRC to address the LSD of the QR RAM (QR-QR and QRC-QRC+1) by cancelling 621(2Y). The decimal point is decremented in anticipation of a shift result (QR) right at 2BB.

2AA QUALIFIER This qualifier examines the LSD of the QR to determine if it is a blank. The QR will be shifted right one location at States 2BB. If the QR location (which will become the most significant character after 2BB) is a blank, DC will count it as a valid right shift (no underflow). If the QR location has a digit, then an underflow will occur (LSD(s)) will be lost. DC is reset to zero, so the asterisk will be displayed. At least five valid shifts are required to prevent an overflow condition. Less than five shifts will also display the asterisk (see A15 Theory).

STATE 610 This state increments DC by one each time the 2AA qualifier encounters a blank in the LSD position.

STATE 611 This state resets digit counter if a blank is not encountered at State 2AA. The state may be encountered only when the DISPLAY POSITION switch is set to manual.

2BB QUALIFIER Qualifier 2BB determines if the decimal point is away from the MSD in the result. If it is, then zeros must be inserted between the digits and the decimal point. When all the zeros have been inserted or if none were needed to begin with and further shift rights are required, blanks are inserted to cancel any possible underflowed digits.

Example: .000DDDDDDDD, 11 digit display with zeros. If the decimal point is less than 16, blanks are loaded in MSD locations.

Example: BBD.DDDDDDDDD, the two MSDs are blank.

STATE 011 This state places blank codes in the LSD position of the QR RAM. QRC-QRC+1 positions the blank to the MSD position. RES FRONT END is used in preparation for the next measurement.

STATE 010 This state places zeros in the LSD position of the QR RAM. QRC-QRC+1 positions the blank to the MSD position. RES FRONT END is used in preparation for the next measurement.

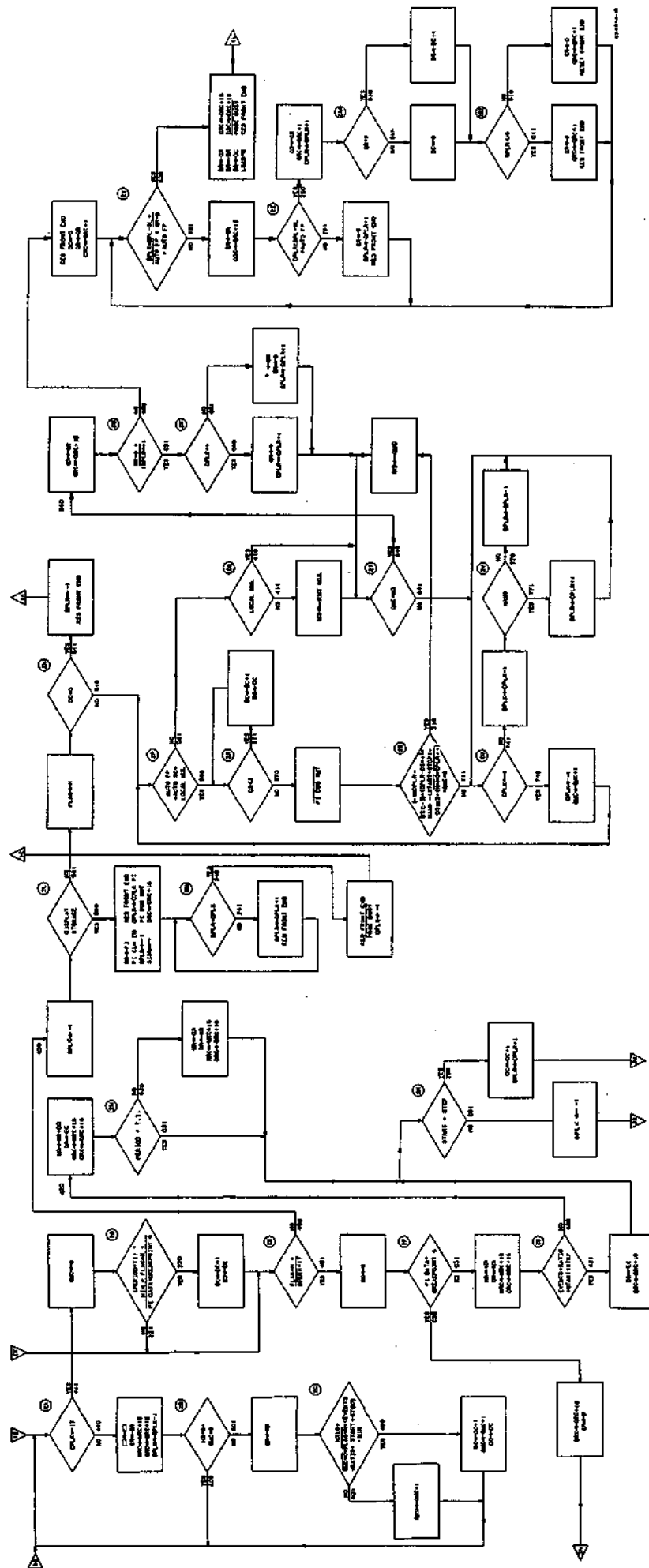


Figure 5-11. Processor Floortest, Sheet 2

3A QUALIFIER	This qualifier is active if there is an "N" value from the Plug-in. Many of the 5245 plug-ins supply "N". The operation that will be performed is the result times "N". The multiplication is performed by dividing the DR by "N" on the first time through the divide routine (3C through 3F). The second time through the divide routine (3C through 3F) the NR is divided by the first quotient. BREAKPOINT 4 of this qualifier will cause the 3A and 3B "N" routine to be bypassed even when there is "N" data. This is helpful when troubleshooting. QMC=0 is true the first time this qualifier is encountered.	3G QUALIFIER	This qualifier determines if a second division is required. When it is required, State 120 is selected. Without "N" data, State 121 will always be selected. A second division occurs with a plug-in which supplies "N" data.
STATE 070	This command increments QMC to one. This ensures that the 3A qualifier will be false after State 3E(021) is selected. This causes State 3A(071) selection.	STATE 120	This state reloads time count into the NR and adjusts the decimal point position by incrementing DPLR. This state is required in anticipation of the second division where the NR will have measurement data and the DR, the quotient of the first division.
STATE 071	This state resets QMC and loads zeros into the QR. The QR must contain zeros prior to the divide routine (3C through 3F), since it will be used to store the quotient. QMC was reset in case the "N" data routine was selected. Its value would have been set to one at State 3A(070).	STATE 121	This state loads the result of the division routine from the QR to the DR. The flag is set Low for qualifier 3J and 3L. The digit counter is set to one for qualifiers 3F and 3P.
3B QUALIFIER	With "N" data, this qualifier is addressed twice, once for each division. The first time the flag will be high from State 1H(151) and State 021 will be executed. State 021 will set the flag low which causes 020 to be addressed the second time.	3H QUALIFIER	This qualifier determines if the division result is to be added or subtracted from "K" data. State 521 can be selected only when there is a plug-in that can supply "K" data. BREAKPOINT 5, which is located on A14, can inhibit the "K" data routine even when the plug-in requests it.
STATE 021	This state is selected in preparation of entering the divide routine (3C through 3F) for the first time. It loads the DR contents into the NR and the "N" data from the plug-in into the DR. The plug-in data transfer requires PI CLK EN and PI XMT BUS enable signals. The flag is set low for "reversed" decimal point shifts during the first division and selection of State 3G(120). State 120 will cause the divide routine to be selected a second time.	STATE 520	This state loads the DR contents into the NR. This is done in preparation for future States 2A, 2B, and 2C. These states use the NR as the working RAM. Digit counter is also reset for the 2A, 2B, and 2C loop.
STATE 020	This state is selected prior to the second time through the divide routine. This state transfers the result of first divide routine (DR/"N") from the QR into the DR. The next time through the divide routine this result will be divided into the NR. These two divisions result in NR/(DR/"N"). This effectively multiplies a result times "N". The flag is assigned High to ensure State 3G(121) is selected. The flag set high also causes normal decimal point shifts during the second division.	STATE 521	When the 3H qualifier has been entered from 1F, this state loads PI DATA from the DR into the NR. When the 3H qualifier has been entered from 121(3G) the division result in the DR is loaded into the NR. In either case, "K" data is loaded into the DR. This state also transfers the decimal point code for "K" data from the plug-in to the DPLK counter. PI CLK EN signal enables the transfer of data from the plug-in to the DR RAM. The RES FRONT END command resets the time and event scalars. The scalars will now be a source of zeros for "K" data States 250 and 251(3J). PI XMT BUS enables the plug-in on the bidirectional bus.
3C QUALIFIER	This qualifier is the beginning of the divide routine. A division is performed in the divide routine by a series of subtractions. The subtractions are accumulated in the quotient multiplier counter (A13). Each time a successful subtraction occurs, QMC is incremented by one. If the NR is 10 times greater than the DR, the quotient multiplier counter will reach 10. When this occurs State 3C(670) is selected.		
STATE 671	This state effectively performs the division. This is done by subtracting the DR contents from the NR (NR-NR-DR). The DR contents remain the same and the result of the subtraction is placed into the NR.		
STATE 670	QMC equaling 10 at qualifier 3C indicated that the NR is 10 times greater than the DR. This command state decrements the DPLR counter to indicate this is the case. The DR is multiplied by 10 with a shift left. The new value of the DR has been successfully subtracted from the NR once. Therefore, before starting the next set of subtractions QMC must be initialized to one. This is accomplished by setting QMC		
STATE 030	This state loads the subtraction result from QMC into the QR. This requires DPLR to be incremented (DPLR-DPLR+1), so the decimal point remains properly aligned with the data shift. The decimal point shift with "N" data will be decremented (DPLR-DPLR-1). This state also recovers the contents that were contained in the NR prior to the last unsuccessful subtraction. This is done by adding the unsuccessful result in the NR with the DR content. This yields the prior NR contents which are restored to the NR. Commands used for this operation are NR-NR+DR, NRC-NRC+16, DR-DR, and DRC-DRC+16. The MSD is now in the QR. Recovering and restoring the NR and DR are done in preparation of calculating the remaining digits.		
STATE 031	This state increments the QMC each time a successful subtraction occurs at State 3C(671). It also increments QMC when a forced add from State 3C(670) occurs.		
3E QUALIFIER	This qualifier will cause State 311 to be bypassed until the first quotient digit has been calculated in the QMC. State 310 occurs as long as the NR magnitude is smaller than the DR.		
STATE 310	This state causes qualifier 3F to be selected.		
STATE 311	This state increments DC each time a digit is calculated. This will continue each time this state is encountered until all significant digits have been calculated. QMC is reset in preparation of calculating the next significant digit.		
3F QUALIFIER	This $DC=DS \cdot \overline{DISP\ STOR} + FLAG=H$ part of the qualifier is used by the divide routine in determining if all significant digits have been calculated. State 460 is selected each time there is another significant digit to calculate. DS determines the number of digits in the result to resolve. When all the digits have been resolved, State 461 will be selected. The $(DISP\ STOR + FLAG=H) \cdot DC=14$ is used with some plug-in routines. When the flag is Low, as it will be when "N" data from the plug-in occurs, the intermediate result will be calculated to 14 digits. This is accomplished by this qualifier so no truncation error will occur when the final result is calculated. The $DISP\ STOR \cdot DC=14$ portion of the qualifier performs essentially the same operation as the $FLAG=H$ part and is used when the plug-in enables DISP STOR. This could be done again when calculating the intermediate portion of the result.		
STATE 460	This state positions the NR and QR contents one place to the left. The QR is shifted left in anticipation of the next quotient digit to be loaded at State 3D(030). The NR is shifted left to multiply it by 10 so the next quotient digit can be calculated.		
STATE 461	This state reinitializes digit counter, DRC, and DPLK by resetting them. This is required for future states.		

- 3J QUALIFIER** This qualifier determines whether DPLR is greater or smaller than DPLK. The possibility of DPLR equaling DPLK was eliminated by qualifier 3L.
- STATE 251 This state decrements DPLR while shifting the result to the right. This causes the result's LSD to shift into the MSD position. The scaler, which contains zeros, now loads a zero in the MSD position. This action will continue until the decimal points are aligned.
- STATE 250 This state decrements DPLK while shifting "K" data to the right. This causes the "K" data LSD to shift into the MSD position. The scalers, which contain zeros, now load a zero into the MSD position. This action will continue to occur until the decimal points are aligned.
- 3K QUALIFIER** When entering this qualifier, digit counts should never be zero. This causes State 100 to be selected which selects qualifier 3L.
- STATE 100 This state provides a delay from State 3J to qualifier 3L.
- 3L QUALIFIER** This qualifier is selected when the START or STOP function is selected or when a plug-in supplies "K" data. For K data the DPLR=DPLK portion of the qualifier is active. The DPLR and DPLK counters, which contain decimal point codes for the result and "K" data, must be aligned prior to the addition or subtraction to "K" data. When the decimal point codes are not equal, State 470 is selected. The 3J and 3K states are selected until alignment is attained. When alignment occurs, State 471 is selected. The addition or subtraction will be performed in the START or STOP routine (3L, 3M, 3N, and 3P). When the START or STOP FUNCTION is selected, the (START + STOP) • PI DATA + BREAKPOINT 6 part of the qualifier is used. In this case, only State 471 will be selected.
- STATE 470 This state causes the 3J qualifier to be selected.
- STATE 471 This state exchanges the contents of the NR and DR RAMs. In START + STOP this places A channel into the NR and B channel into the DR. With "K" data it places the result in the NR and "K" data in the DR. This is done in preparation for the A-B or A+B operation, in both cases at States 430(3M) and 431(3M) respectively. The flag is set Low for future State 550(3Q) and qualifier 2C. This causes the DPLR counter at State 550 to count up (+); and, at qualifier 2C, it always causes State 400(2C) to be selected. PI XMT BUS is also enabled. This is required so that the plug-in can transmit the sign status on the SIGN- line used in qualifier 3M. SIGN- determines whether the result is added or subtracted from "K".
- 3M QUALIFIER** This is a three part qualifier. The first portion of the qualifier is PI • SIGN "-". This part is active when a result is added or subtracted to "K" data. If the sign is minus, the result will be subtracted from "K" data in State 430(3M); otherwise, it will be added at State 431(3M). The second part of the qualifier is PI • CHECK. This is used when in START + STOP and input control is in CHECK position. In this case, A+B is always performed, regardless of the switch setting of the ACCUM MODE START/STOP switch. This causes selection of State 431(3M). The third and final portion of the qualifier is PI • A-B SW. When in START + STOP and not plug-in and the A-B switch is not in A-B position, the A+B State 431 is selected. When the ACCUM MODE START/STOP switch is set to A-B, State 430 is selected.
- STATE 430 This state subtracts the contents of the DR from the contents of the NR and places the result in the NR. The DR maintains its original contents prior to the subtraction A-B or "K" data minus result.
- STATE 431 This state adds the contents of the NR to the contents of the DR and places the result in the NR. A+B or result + "K" data is performed in this state.
- 3N QUALIFIER** This qualifier checks the result of the NR+DR or NR-DR operations. When NR+DR was performed at State 431(3M), the qualifier always selects State 131 because the result will always equal plus. When NR-DR is performed at State 430(3M) a position or negative result will occur. When the NR was larger than the DR, a positive result occurs and State 131 is always selected. When the NR is smaller than the DR a negative result occurs. In this case, State 130(3N) is selected where it adds the negative result in the NR with B or "K" data in the DR. This recovers the original NR and DR contents prior to the subtraction at State 430(3M). The sign is also set to minus to indicate the final result will be negative. Upon completion of this operation, State 471 is again selected. This state again causes the NR and DR contents to be exchanged. When this occurs, the NR will now be larger than the

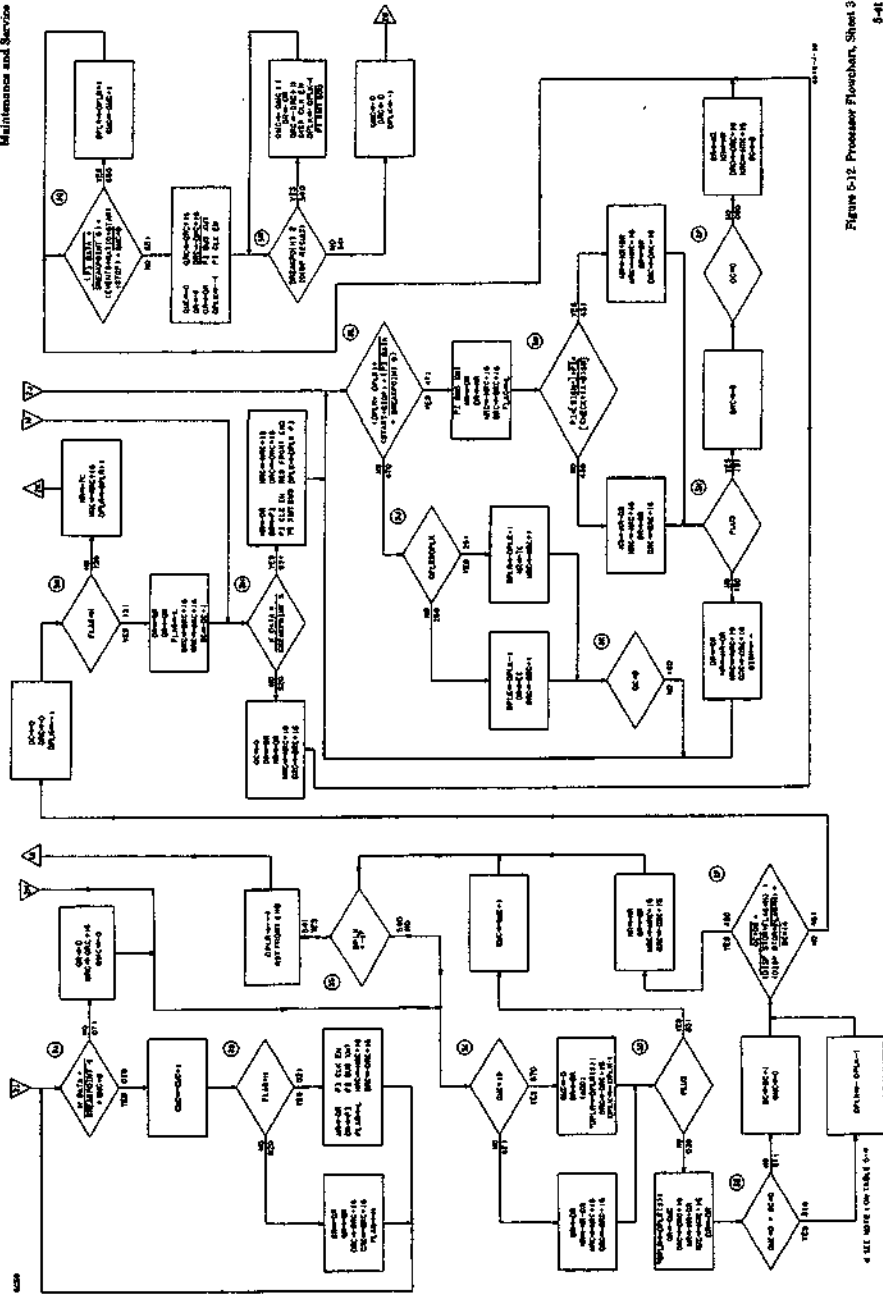


Figure 5-12 Processor Flowchart, Sheet 3
5-41

DR State 400000 is now selected and it will hold a positive mask with the sign set to minus. This causes State 131 selection thereby completing A-B to STATE 310P or "E" data across the test.

This state recovers the original DR and DR consists prior to the A-B operation at State 430. This state is selected only when the 2F qualifier provided a negative subaddress. The sign set to minus, which indicates the final NDC/DJ result will be minus.

This state indicates the denominator register counter to zero and causes the 2F qualifier to be selected.

DR counter is always set at 1 when entering this qualifier. This causes State 600 to be selected.

This state positions the test from the OFFSET, STOP, and DR. This is done in the next 10, 40, and 80 states. The mask with BREAKPOINT 3 at State 560DR DR is also reset to zero (or 2A, 2B, and 2C jump).

This qualifier is required to position the decimal point as it represents the result of Round Back, Start, or Round On. This is accomplished by State 600. QAC is now counted until it equals zero, each time the decimal point is shifted left. When the decimal point is shifted nine places (representing Digit) the qualifier is satisfied and State 601 is selected. This state causes the test to be selected and the test to be selected. The PI DATA at this point will already have the decimal point location selected according to Qns wans.

This state increments DPLB and increments QAC until the 5Q qualifier is satisfied.

This state performs the following functions:
1. Load mask into the 0R. This is required for the 2A, 2B, and 2C loop on the RAM location prior to the ASD will contain mask codes.

2. The DR is established with PI XDRY BUS is selected and PI CLK DR is established. The DR is established with PI XDRY BUS is selected. The QAC and DPLA counter are also reset at this state for future state.

BREAKPOINT 3 is used for troubleshooting. It is based on the A13 qualifier assembly. The DR is established with PI XDRY BUS is selected. The QAC and DPLA counter are also reset at this state for future state. The display is put in the AUTO manual modes as the display result will not be formatted.

This state enables the DR counter to be tested to the next state display. The DR is established with PI XDRY BUS is selected. The QAC and DPLA counter are also reset at this state for future state. The display is put in the AUTO manual modes as the display result will not be formatted. The DR counters are set to the A1 and A2 assembly. The A13 indicator has no PI is inhibited from sending any data with PI XDRY BUS bus.

This state resets the DRC and DPLA counters. This reset is done to cause the display data at 541 was set by BREAKPOINT 2.

This qualifier directs when the search for the most significant digit in the division routine has been completed. This is accomplished by subtracting one from the DPLB counter for each time through the search.

This state enables a branch to qualifier 2.

This state will only be selected when the search for the first digit has been performed. The DPLB counter contains are zero, and therefore a branch count by per formed. It will then the first and as that a new measurement can be taken and set DPLB to -1 so that no decimal point will be displayed.

- 4A QUALIFIER** This state enables the decimal point with DPLA, DPLA*, DPLA*, and DPLA* codes. The DPLA*-17, DPLA*-17, and DPLA*-17 codes ensure that the processor does not attempt to correct State 40 if all locations contain valid data.
- STATE 480** This state enables the decimal point with DPLA, DPLA*, DPLA*, and DPLA* codes. The DPLA*-17, DPLA*-17, and DPLA*-17 codes ensure that the processor does not attempt to correct State 40 if all locations contain valid data.
- STATE 481** This state enables the sign digit of the display to output (see output coding table). The PI XMT BUS is inhibited. The data is set low, allowing the A12 assembly that a character is ready to output. PROC BUSY remains inactive.
- 4B QUALIFIER** This qualifier is generated by the device receiving the output data. When the output device enables the A12 output assembly (RD), the PI XMT BUS is inhibited, but the PI XMT BUS remains inactive.
- STATE 700** This state occurs as a valid key with the NBDP line from the output device is activated. This state continues to inhibit any PI DATA and PROC BUSY. The EXT OUT EN signal enables the A12 board to output. This signal and the Flag are active until the output device is inhibited. This state is entered.
- STATE 701** This state continues to inhibit PI DATA and PROC BUSY. The EXT OUT EN signal and Flag assigned high (FLAD-H) are active until the output device is inhibited. This state is entered.
- 4C QUALIFIER** This qualifier is generated by the device receiving the output data. When the output device enables the A12 output assembly (RD), the PI XMT BUS is inhibited, but the PI XMT BUS remains inactive.
- STATE 720** This state occurs as a valid key with the NBDP line from the output device is activated. This state continues to inhibit any PI DATA and PROC BUSY. The EXT OUT EN signal enables the A12 board to output. This signal and the Flag are active until the output device is inhibited. This state is entered.
- STATE 721** This state continues to inhibit PI DATA and PROC BUSY. The EXT OUT EN signal and Flag assigned high (FLAD-H) are active until the output device is inhibited. This state is entered.
- 4D QUALIFIER** This qualifier is generated by the device receiving the output data. When the output device enables the A12 output assembly (RD), the PI XMT BUS is inhibited, but the PI XMT BUS remains inactive.
- STATE 740** This state occurs as a valid key with the NBDP line from the output device is activated. This state continues to inhibit any PI DATA and PROC BUSY. The EXT OUT EN signal enables the A12 board to output. This signal and the Flag are active until the output device is inhibited. This state is entered.
- STATE 741** This state continues to inhibit PI DATA and PROC BUSY. The EXT OUT EN signal and Flag assigned high (FLAD-H) are active until the output device is inhibited. This state is entered.
- 4E QUALIFIER** This qualifier is generated by the device receiving the output data. When the output device enables the A12 output assembly (RD), the PI XMT BUS is inhibited, but the PI XMT BUS remains inactive.
- STATE 760** This state occurs as a valid key with the NBDP line from the output device is activated. This state continues to inhibit any PI DATA and PROC BUSY. The EXT OUT EN signal enables the A12 board to output. This signal and the Flag are active until the output device is inhibited. This state is entered.
- STATE 761** This state continues to inhibit PI DATA and PROC BUSY. The EXT OUT EN signal and Flag assigned high (FLAD-H) are active until the output device is inhibited. This state is entered.
- 4F QUALIFIER** This qualifier is generated by the device receiving the output data. When the output device enables the A12 output assembly (RD), the PI XMT BUS is inhibited, but the PI XMT BUS remains inactive.
- STATE 110** This state occurs as a valid key with the NBDP line from the output device is activated. This state continues to inhibit any PI DATA and PROC BUSY. The EXT OUT EN signal enables the A12 board to output. This signal and the Flag are active until the output device is inhibited. This state is entered.
- STATE 111** This state continues to inhibit PI DATA and PROC BUSY. The EXT OUT EN signal and Flag assigned high (FLAD-H) are active until the output device is inhibited. This state is entered.
- 4G QUALIFIER** This qualifier is generated by the device receiving the output data. When the output device enables the A12 output assembly (RD), the PI XMT BUS is inhibited, but the PI XMT BUS remains inactive.
- STATE 801** This state occurs as a valid key with the NBDP line from the output device is activated. This state continues to inhibit any PI DATA and PROC BUSY. The EXT OUT EN signal enables the A12 board to output. This signal and the Flag are active until the output device is inhibited. This state is entered.
- STATE 800** This state continues to inhibit PI DATA and PROC BUSY. The EXT OUT EN signal and Flag assigned high (FLAD-H) are active until the output device is inhibited. This state is entered.
- 4H QUALIFIER** This qualifier is generated by the device receiving the output data. When the output device enables the A12 output assembly (RD), the PI XMT BUS is inhibited, but the PI XMT BUS remains inactive.
- STATE 000** This state occurs as a valid key with the NBDP line from the output device is activated. This state continues to inhibit any PI DATA and PROC BUSY. The EXT OUT EN signal enables the A12 board to output. This signal and the Flag are active until the output device is inhibited. This state is entered.
- STATE 001** This state continues to inhibit PI DATA and PROC BUSY. The EXT OUT EN signal and Flag assigned high (FLAD-H) are active until the output device is inhibited. This state is entered.
- 4I QUALIFIER** This qualifier is generated by the device receiving the output data. When the output device enables the A12 output assembly (RD), the PI XMT BUS is inhibited, but the PI XMT BUS remains inactive.
- STATE 240** This state occurs as a valid key with the NBDP line from the output device is activated. This state continues to inhibit any PI DATA and PROC BUSY. The EXT OUT EN signal enables the A12 board to output. This signal and the Flag are active until the output device is inhibited. This state is entered.
- STATE 241** This state continues to inhibit PI DATA and PROC BUSY. The EXT OUT EN signal and Flag assigned high (FLAD-H) are active until the output device is inhibited. This state is entered.
- 4J QUALIFIER** This qualifier is generated by the device receiving the output data. When the output device enables the A12 output assembly (RD), the PI XMT BUS is inhibited, but the PI XMT BUS remains inactive.
- STATE 780** This state occurs as a valid key with the NBDP line from the output device is activated. This state continues to inhibit any PI DATA and PROC BUSY. The EXT OUT EN signal enables the A12 board to output. This signal and the Flag are active until the output device is inhibited. This state is entered.
- STATE 781** This state continues to inhibit PI DATA and PROC BUSY. The EXT OUT EN signal and Flag assigned high (FLAD-H) are active until the output device is inhibited. This state is entered.

3

Sheet

FIGURE 1-12
PROCESSOR FLOWCHART, SHEET 3
(See Page 5-11)

* MEASUREMENT STARTS AT 730 IF SAMPLE RATE IS BYPASSED.
IF MEASUREMENT TERMINATES BEFORE COMPLETION OF OUTPUT ROUTINE, THEN THE DISPLAY (STATE 571) WILL BE BYPASSED.

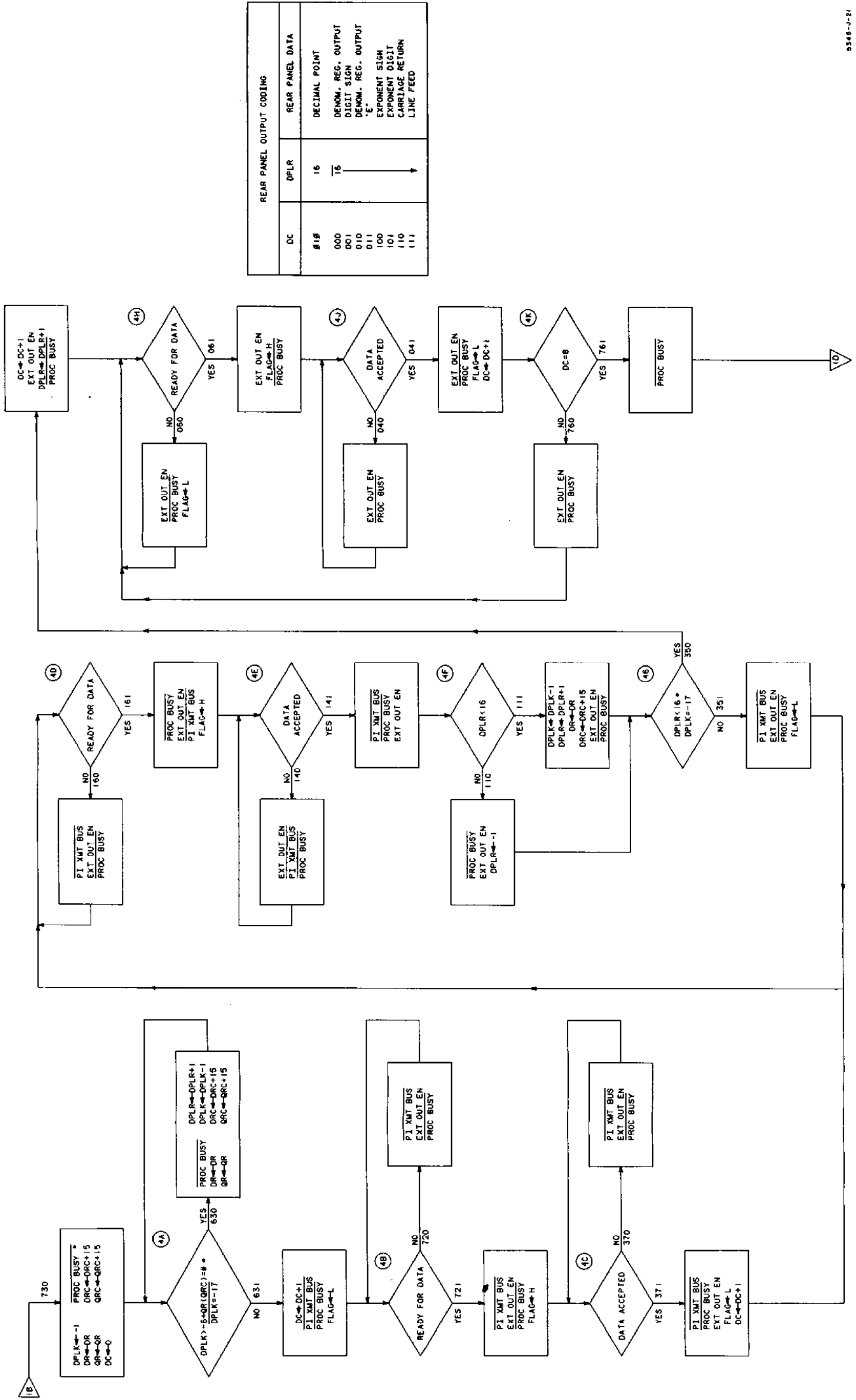


Figure 5-13. Processor Flowchart, Sheet 4

5345-0-21

Table 5-5. In-Cabinet Performance Check

- A. Set POWER switch to ON.
- B. Push RESET. All segments of display, including decimal points should light.
- C. Perform Self-Check, Table 3-2.

1. CHANNEL A FREQUENCY AND SENSITIVITY

Specifications:

Range: 20 Hz to 500 MHz
Sensitivity: 25 mV rms

Equipment:

Signal generators listed in Table 5-2.

NOTE

A very wide band source such as the HP Model 8660A/B Synthesizer with 86602A plug-in is not a recommended substitute for the fundamental oscillator type 8640B Signal Generator. With such a wideband source applied to the wideband counter, any instantaneous random event from the synthesizer broadband noise floor will be measured as a count if above the counter triggering threshold. If an 8660A/B is used to check the counter, the Synthesizer output level should be low (=25 mV rms) so the noise floor will be below the counter trigger threshold.

- a. Set counter controls as follows:

FUNCTION	FREQ A
GATE TIME	100 ms
DISPLAY POSITION	AUTO
SAMPLE RATE	full ccw
LEVEL	PRESET
ATTEN	X1
Input Impedance	50Ω
Input Amplifier Control	SEP
Input Coupling	DC

- b. Adjust signal generator from 20 Hz to 500 MHz, maintaining 25 mV rms input amplitude. Counter should properly display all frequencies within this range. Record on test card.

Sheet 4

**Figure 5-13
PROCESSOR FLOWCHART, SHEET 4**

(See Page 5-43)

Table 5-5. In-Cabinet Performance Check (Continued)

2. CHANNEL A ATTEN CONTROL

Specifications: ATTEN (sensitivity): 300 mV rms in X10

Equipment: Signal Generator: HP 651A

a. Set counter controls as follows:

FUNCTION	FREQ A
GATE TIME	100 ms
DISPLAY POSITION	AUTO
SAMPLE RATE	full ccw
LEVEL	PRESET
ATTEN	X10
Input Impedance	50Ω
Input Amplifier Control	SEP
Input Coupling	DC

b. Connect signal generator output to 5345A Channel A input. Set signal generator to 10 kHz at 0V rms.

c. Increase amplitude of input signal until counter display a stable count to 10 kHz. Output level meter should read 300 mV or less. Record on test card.

3. TIME INTERVAL CHECK

Specifications:

10 ns single pulse time interval
150 mV p-p sensitivity

Equipment:

Pulse Generator: HP 8007B
Sampling Oscilloscope: HP 180A with HP 1810A
Attenuator: HP 355D

a. Set counter controls as follows:

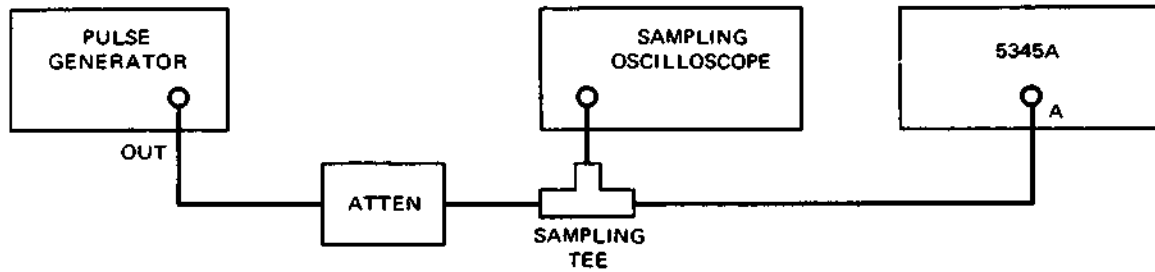
FUNCTION	TIME INT. A to B
GATE TIME	1 ms
DISPLAY POSITION	AUTO
SAMPLE RATE	full ccw
LEVEL (A&B)	PRESET
ATTEN (A&B)	X1
Input Impedance (A&B)	50Ω
Input Amplifier Control	COM A
Input Coupling	DC
SLOPE (Chan A)	+
SLOPE (Chan B)	-

b. Set pulse generator as follows:

TRANSITION TIME (s)	0.1μ - 2.5n; VERNIER full ccw
RATE (Hz)	10k - .3M; VERNIER Midrange
PULSE WIDTH (s)	5n - 50n; VERNIER Midrange
AMPLITUDE (V)	0.2 - 0.5; VERNIER ccw
PULSE POLARITY	+

c. Set output of pulse generator to give 10 ns pulses at 150 mV,p-p, using external attenuator.

Table 5-5. In-Cabinet Performance Check (Continued)



- d. Adjust CHANNEL A LEVEL control clockwise well into a region where the GATE light flashes.
- e. Adjust CHANNEL B LEVEL control clockwise until the display becomes steady.
- f. Adjust PULSE WIDTH control until display reads 10 ns or slightly below. Record on test card.
- g. Set RATE (Hz) switch on pulse generator to MAN.
- h. Set counter's GATE TIME switch to MIN.
- i. Manually trigger the pulse generator, once.
- j. The counter should display 10 ns \pm 2 ns. Record on test card.

4. CHANNEL B FREQUENCY AND SENSITIVITY

Specifications:

Range: 20 Hz to 400 MHz
Sensitivity: 25 mV rms

Equipment:

Signal generators listed in Table 5-2. NOTE: See NOTE in Table 5-5, step 1.

- a. Set counter controls as follows:

FUNCTION	RATIO
GATE TIME	MIN
DISPLAY POSITION	AUTO
SAMPLE RATE	full ccw
LEVEL (A&B)	PRESET
ATTEN (Chan B)	X1
Input Impedance (A&B)	50 Ω
Input Amplifier Control	COM
Input Coupling (A&B)	DC
SLOPE (Chan A&B)	-

- b. Set signal generator to 20 Hz at 50 mV and connect signal to counter's CHANNEL A jack.
- c. Adjust signal generator from 20 Hz to 400 MHz, maintaining 50 mV rms input amplitude. Counter should display a ratio of one throughout frequency range. As frequency is increased, adjust GATE TIME for more resolution. Record on test card.

Table 5-5. In-Cabinet Performance Check (Continued)

5. CHANNEL B ATTEN CONTROL

Specifications:

ATTEN (sensitivity): 300 mV rms in X10

Equipment:

Signal Generator: HP 651A

a. Set counter controls as follows:

FUNCTION	START
GATE TIME	1 ms
DISPLAY POSITION	AUTO
SAMPLE RATE	full ccw
LEVEL (A&B)	PRESET
ATTEN (Chan B)	X10
Input Impedance (Chan B)	50Ω
Input Amplifier Control	SEP
SLOPE (Chan A)	-

- b. Connect signal generator output to 5345A CHANNEL B input. Set signal generator to 10 kHz at 300 mV rms.
- c. Turn CHANNEL A LEVEL control full clockwise. Counter should begin totalizing. Record on test card.

6. INPUT COUPLING, TOTALIZE MODE, AND SLOPE

Equipment:

Pulse Generator: HP 8007B

Oscilloscope: HP 180A with HP 1801A and HP 1820A

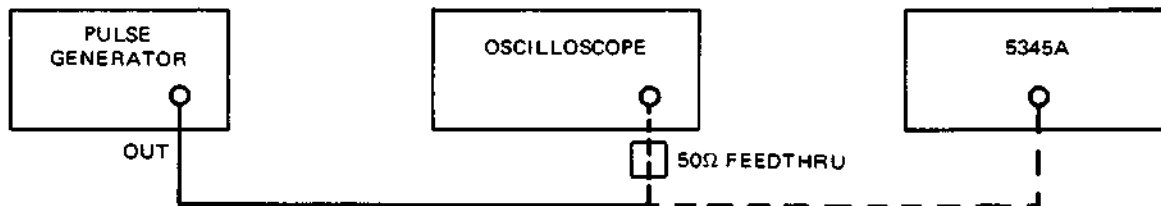
a. Set counter controls as follows:

FUNCTION	START
GATE TIME	MIN
DISPLAY POSITON	AUTO
SAMPLE RATE	full ccw
LEVEL (A&B)	=10° ccw to -LEVEL
ATTEN (A&B)	X1
Input Impedance (A&B)	50Ω
Input Amplifier Control	SEP
Input Coupling	DC
SLOPE (A&B)	+
ACCUM MODE START/STOP	A+B

Table 5-5. In-Cabinet Performance Check (Continued)

b. Set pulse generator as follows:

TRANSITION TIME (s) $0.1\mu - 2.5n$; VERNIER full ccw
RATE (Hz) 3k - 10k; VERNIER ccw
PULSE WIDTH (s) $50\mu - 1.5m$; VERNIER ccw
AMPLITUDE (V) 0.5 - 1
PULSE POLARITY +



- c. Connect pulse generator to oscilloscope, using 50 Ω feedthrough. Connect pulse generator trigger output to oscilloscope external trigger input. Adjust pulse generator to 10 kHz square wave at 1V peak from zero volts.
- d. Connect pulse generator to CHANNEL A jack, directly.
- e. Set CHANNEL A Input Coupling switch to AC; counter should begin totalizing. Record on test card. Set SLOPE switch to -; counter should continue totalizing.
- f. Remove cable from CHANNEL A jack and connect to CHANNEL B jack. Counter should not totalize.
- g. Set CHANNEL B Input Coupling switch to AC; counter should begin totalizing. Record on test card. Set SLOPE switch to -; counter should continue totalizing. Record on test card.
- h. Set ACCUM MODE START/STOP switch (rear panel) to A-B and push RESET.
- i. Turn CHANNEL A LEVEL control full clockwise. Counter should begin totalizing and minus light should be on. Record on test card.

7. GATE OUTPUT, SAMPLE RATE, AND FREQUENCY STANDARD OUTPUT

Specifications:

Gate Output: 0 to >1V into 50 Ω

Sample Rate: Continuously variable from <0.1 sec to >5 sec., also will hold display.

Frequency Standard Output: 10 MHz sine wave, >1V rms into 50 Ω

Table 5-5. In-Cabinet Performance Check (Continued)

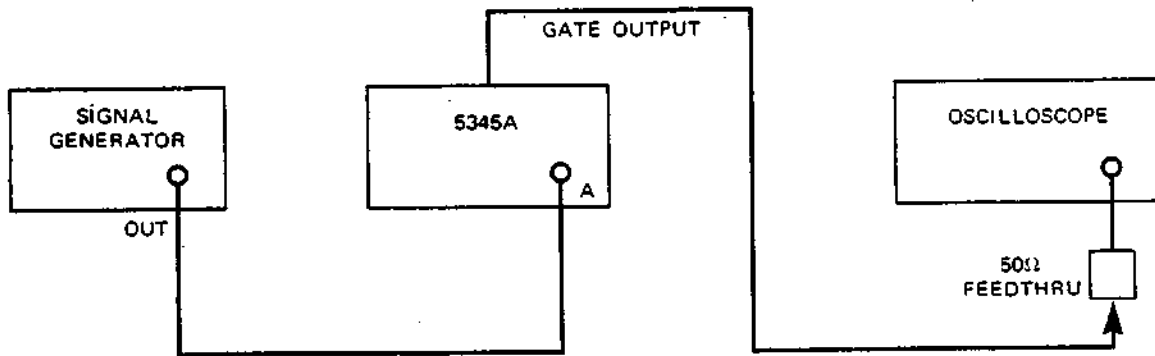
Equipment:

Signal Generator: HP 651A
Oscilloscope: HP 180A with HP 1801A and HP 1820A

- a. Set counter controls as follows:

FUNCTION	FREQ A
GATE TIME	10 ms
DISPLAY POSITION	AUTO
SAMPLE RATE	full ccw
LEVEL	PRESET
ATTEN	X1
Input Impedance	50Ω
Input Amplifier Control	SEP
Input Coupling	AC

- b. Set signal generator to 1 MHz at 25 mV rms.
c. Set oscilloscope's sweep time to 10 msec.



- d. The positive pulses (about 10 ms wide) should be 0 to >1V. Record on test card.
e. The time between positive pulses should be <0.1 sec. Record on test card.
f. Slowly turn SAMPLE RATE control clockwise and observe increase in time between flashes of counter's GATE light.
g. At full clockwise position (not in HOLD) time between flashes should be >5 seconds. Record on test card.
h. Set SAMPLE RATE switch to HOLD. GATE light should *not* flash again. Record on test card.

FREQUENCY STANDARD OUTPUT

- i. Remove cable from GATE OUTPUT jack and connect to FREQ STD OUTPUT jack. Oscilloscope should display a 10 MHz sine wave at >1V rms (>2.83V p-p). Record on test card.

8. EXTERNAL FREQUENCY STANDARD INPUT (Standard or Option 001)

Specification:

Counter must phase lock to external standard ($\pm 5 \times 10^{-9}$ for standard oscillator, $\pm 5 \times 10^{-6}$ for Option 001).

Equipment:

Signal Generator: HP 651A

Table 5-5. In-Cabinet Performance Check (Continued)

a. Set counter controls as follows:

FUNCTION	FREQ A
GATE TIME	10 ms
DISPLAY POSITION	AUTO
SAMPLE RATE	full ccw
Input Amplifier Control	CHECK

- b. Connect external standard to rear panel EXT FREQ STD INPUT jack. Set rear panel INT STD-EXT STD switch to EXT STD. Counter should display lamp test for about 2 seconds before again display 100 MHz. The internal time base is now phase locked to the external standard. Record on test card.
- c. Set signal generator to approximately 10 MHz at 1V rms and connect to EXT FREQ STD
- d. Counter should continuously display lamp test, indicating that counter will *not* phase lock to external standard. Record on test card.

9. GATE CONTROL INPUT

Specification:

To ensure proper operation of Gate Control Input.

Equipment:

- Pulse Generator: HP 8007B
- Signal Generator: HP 651A
- Oscilloscope: HP 180A with HP 1801A and HP 1820A

EXTERNAL ARM

a. Set counter controls as follows:

FUNCTION	FREQ A
GATE TIME	1 μ s
DISPLAY POSITION	AUTO
SAMPLE RATE	HOLD
LEVEL	PRESET
ATTEN	X1
Input Impedance	50 Ω
Input Amplifier Control	SEP
Input Coupling	DC
Gate Control (rear panel)	EXT ARM

b. Set pulse generator controls as follows:

RATE (Hz)	10K - .3M; VERNIER ccw
WIDTH (s)	1.5 μ - 50 μ
PULSE POLARITY	-
AMPLITUDE (V)	0.5 - 1

- c. Connect pulse generator to oscilloscope using 50 Ω termination. Adjust pulse generator for 2.0 μ s pulses at -1V peak. Disconnect setup.
- d. Connect pulse generator to counter's GATE CONTROL INPUT jack.
- e. Set pulse generator's RATE switch to MAN.
- f. Set signal generator to 2 MHz to 25 mV rms and connect to counter's CHANNEL A jack. Counter should make measurement and display 2.00 MHz. Record on test card.

PERFORMANCE CHECK TEST CARD

HEWLETT-PACKARD MODEL 5345A
ELECTRONIC COUNTER

Test Performed by _____

SERIAL NO. _____

Date _____

DESCRIPTION	CHECK
1. CHANNEL A FREQUENCY AND SENSITIVITY	_____
2. CHANNEL A LEVEL AND ATTEN CONTROLS	_____
Attenuator Sensitivity: 300 mV	_____
3. TIME INTERVAL	_____
Time Interval: 10 ns at 150 mV p-p	_____
Single Shot Time Interval: 10 ns at 150 mV p-p	_____
4. CHANNEL B FREQUENCY AND SENSITIVITY	_____
5. CHANNEL B LEVEL AND ATTEN CONTROLS	_____
Attenuator Sensitivity: 300 mV	_____
6. INPUT COUPLING, TOTALIZE MODE, AND SLOPE	_____
Channel B Totalizes	_____
Channel B Totalizes	_____
A-B Mode Totalizes	_____
+ and - Slope	_____
7. GATE OUTPUT, SAMPLE RATE, AND FREQUENCY STANDARD OUTPUT	_____
Gate Output: 0 to >1V	_____
Minimum Sample Rate: <0.1 s	_____
Maximum Sample Rate: >5 s	_____
Frequency Standard Output: 10 MHz at >1V rms	_____
8. EXTERNAL FREQUENCY STANDARD INPUT	_____
Phase Locks	_____
9. GATE CONTROL INPUT	_____
External Arm	_____
External Gate:	_____
Arm Light	_____
Gate Light	_____
10. CHANNEL A SCALER OUTPUT	_____

PERFORMANCE CHECK TEST CARD

HEWLETT-PACKARD MODEL 5345A
ELECTRONIC COUNTER

Test Performed by _____

SERIAL NO. _____

Date _____

DESCRIPTION	CHECK
1. CHANNEL A FREQUENCY AND SENSITIVITY	_____
2. CHANNEL A LEVEL AND ATTEN CONTROLS	_____
Attenuator Sensitivity: 300 mV	_____
3. TIME INTERVAL	_____
Time Interval: 10 ns at 150 mV p-p	_____
Single Shot Time Interval: 10 ns at 150 mV p-p	_____
4. CHANNEL B FREQUENCY AND SENSITIVITY	_____
5. CHANNEL B LEVEL AND ATTEN CONTROLS	_____
Attenuator Sensitivity: 300 mV	_____
6. INPUT COUPLING, TOTALIZE MODE, AND SLOPE	_____
Channel B Totalizes	_____
Channel B Totalizes	_____
A-B Mode Totalizes	_____
+ and - Slope	_____
7. GATE OUTPUT, SAMPLE RATE, AND FREQUENCY STANDARD OUTPUT	_____
Gate Output: 0 to >1V	_____
Minimum Sample Rate: <0.1 s	_____
Maximum Sample Rate: >5 s	_____
Frequency Standard Output: 10 MHz at >1V rms	_____
8. EXTERNAL FREQUENCY STANDARD INPUT	_____
Phase Locks	_____
9. GATE CONTROL INPUT	_____
External Arm	_____
External Gate:	_____
Arm Light	_____
Gate Light	_____
10. CHANNEL A SCALER OUTPUT	_____

Table 5-5. In-Cabinet Performance Check (Continued)

EXTERNAL GATE

- g. Set counter's GATE CONTROL switch (rear panel) to EXT GATE and SAMPLE RATE knob full ccw.
- h. Set signal generator to 2.5 MHz and push counter's RESET button.
- i. Push pulse generator's MAN button once; counter's ARM light should turn on. Record on test card.
- j. Push MAN button once; ARM light should turn off, GATE light should flash on, and display should read 2.50 MHz. Record on test card.

10. CHANNEL A SCALER OUTPUT

Specification:

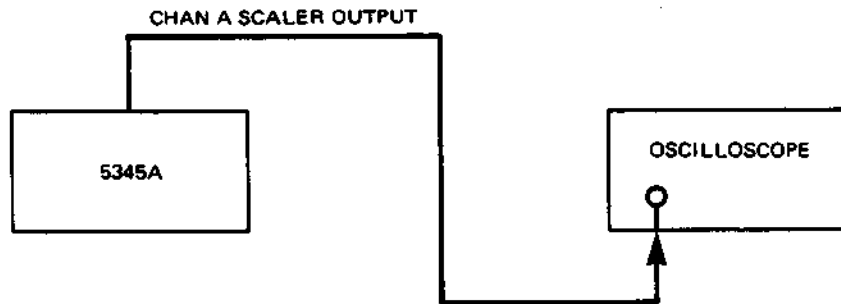
Divides Channel A frequencies by powers of 10.

Equipment:

Oscilloscope: HP 180A with HP 1801A and HP 1820A

- a. Set counter controls as follows:

FUNCTION	START
GATE TIME	100 ns
DISPLAY POSITION	AUTO
SAMPLE RATE	HOLD
Input Amplifier Control	CHECK



- b. Oscilloscope's display should be 80% duty cycle rectangular waveform, which is a divided version of the input signal. Record on test card.

Table 5-6. Adjustment Procedures

A2 ANODE DRIVER DISPLAY

Equipment:

HP 180A Oscilloscope with 1801A and 1820A. Adjustment A2R6 controls the width of the blanking pulses that are generated from A2U7B. These pulses are in the order of approximately 5 to 50 μ s. The purpose of the pulses is to turn off the display when addressing a new digit. It also has the effect of controlling the intensity.

A3 AND A4 INPUT ASSEMBLIES

NOTE

The A3 and A4 assemblies must be tested together as a unit.

Equipment:

- HP 182C Mainframe Oscilloscope
- HP 1810A 1 GHz Sampling Plug-In
- HP 3435A DMM
- HP 8660C Synthesized Signal Generator
- HP 10503-6001 BNC Cables (4 each)
- HP 05062-60186 Female SMC to Female BNC Cable (2 each)

Accessories:

Ceramic Tuning Wand

Setup:

NOTE

Setup adjustment performed with no signal input.

- a. Set CHANNEL A and CHANNEL B LEVEL control to PRESET, and SLOPE switches to \int .
- b. Adjust all potentiometers (R3, R11, R12, and R8) on the A4 board to center position.

Duty Cycle Adjustment to Attain 25 mV Sensitivity:

NOTE

Allow a half hour warmup before performing the following adjustment procedure.

- a. Set the 3435A DMM controls as follows:

FUNCTION	Vdc
RANGE	200 mV

- b. Connect 3435A DMM positive lead to Pin 8 of A3U2 (Channel A Hybrid) and connect negative lead to Pin 11 (∇) of A3U2. If the dc voltage reading is less than 100 mV, continue to Step c. If the dc voltage reading is greater than 100 mV select R44 until dc voltage at Pin 8 reads less than 100 mV.

NOTE

Increasing R44 value causes offset voltage at Pin 8 of A3U2 to increase; whereas, decreasing R44 value causes the offset voltage to decrease.

- c. Connect 3435A DMM positive lead to Pin 7 of A3U1 (Channel B Hybrid) and connect negative lead to Pin 11 (∇) of A3U1. If the dc voltage reading is less than 100 mV, continued to Channel A Sensitivity Adjustment (next step). If the dc voltage reading is greater than 100 mV select R7 until dc voltage at Pin 8 reads less than 100 mV.

NOTE

Increasing R7 value causes offset voltage at Pin 7 of A3U1 to increase; whereas, decreasing R7 value causes the offset voltage to decrease.

Table 5-6. Adjustment Procedures (Continued)

Channel A Sensitivity Adjustment:

- a. Connect a BNC cable from the 8660C RF OUTPUT to the 5345A Channel A Input.
- b. Connect a BNC cable from 8660C EXT TIMEBASE (rear panel) to the 5345A 10 MHz FREQ STD OUTPUT (rear panel) to lock the 8660C with the 5345A timebase.
- c. Set the 8660C frequency to 100 MHz and amplitude to 25 mV.
- d. Set the 182C/1810A Oscilloscope controls as follows:

MODE A
 POLARITY A TRIG
 GAIN +UP (both channels)
 TIME DIV 20 mV/cm (both channels)
 EXPANDED
 2 ns/cm
 TRIGGER NORM
 +SLOPE
 EXT
 SCAN SWEEP

*10503A
A FT BNC 7 cables
double from panel
1250 - 0080
250 - 0851
BNC / SMC adapter*

- e. Set the 5345A input controls (both channels) as follows:

CHECK/SEP/COM A SEP
 IMPEDANCE 50Ω
 COUPLING DC
 LEVEL PRESET
 ATTEN X1
 SLOPE

- f. Connect a SMC cable (~~05060-60186~~) from Channel A input of the 1810A plug-in to A9J1. (Connect a BNC-to-male SMC RF connector to one side of the SMC cable to enable connection to the oscilloscope.)
- g. Observe that the 5345A counter is triggering and waveform appears on 182C Oscilloscope screen.

NOTE

Triggering may not occur and the waveform may not be present. A3R41 may be too far out of adjustment; if this is the case do adjustment in Step h. If waveform is present skip to Step i.

- h. Adjust A3R41 until waveform appears on 182C display.
- i. Continue to adjust A3R41 until waveform is symmetrical.
- j. Toggle CHANNEL A SLOPE switch up and down; observe that waveform maintain its symmetrical form. If waveform doesn't maintain its symmetrical form, then replace the Hybrid (U2); and, repeat steps f through j.
- k. The 5345A Channel A is now calibrated for 25 mV sensitivity.

Channel B Sensitivity Adjustment:

- a. Set 1810A plug-in to Channel B, TRIG B, INT TRIG.
- b. Connect a SMC cable (~~05060-60186~~) from Channel B input of the 1810A plug-in to A9J2. (Connect a BNC-to-male SMC RF connector to one side of the SMC cable to enable connection to the oscilloscope.)
- c. Observe that the 5345A Counter is triggering and waveform appears on 182A Oscilloscope screen.

NOTE

Triggering may not occur and the waveform may not be present. A3R3 may be too far out of adjustment; if this is the case, do adjustment in Step d. If waveform is present skip to Step e.

- d. Adjust A3R3 until waveform appears on 182A screen.
- e. Continue to adjust A3R3 until waveform is symmetrical.
- f. Toggle CHANNEL B SLOPE switch up and down; observe that waveform maintains its symmetrical form. If waveform does not maintain its symmetrical form, then replace the Hybrid (U1); and, repeat steps b through f.
- g. The 5345A Channel B is now calibrated for 25 mV sensitivity.

Table 5-6. Adjustment Procedures (Continued)

A6 AND A7 POWER SUPPLIES

CAUTION

BEFORE REMOVING A POWER SUPPLY BOARD, ALWAYS DISCONNECT THE POWER CABLE AT REAR OF INSTRUMENT. TURNING THE POWER SWITCH TO STANDBY IS NOT SUFFICIENT TO PREVENT POSSIBLE COUNTER DAMAGE.

Adjust power supplies only when necessary. Use a quality DVM and place power supply boards on extender boards during adjustment.

+5V and -5.2V Adjustment:

- a. Place A6 assembly (05345-60006) on extender boards.
- b. Connect plus side of DVM to TP6 on board. Connect common side of DVM to "+5V RET" (+5V return) pin on board.
- c. Adjust R19 until DVM reads $+5V \pm 20$ mV.
- d. Connect plus side of DVM to TP3 on board. Connect common side of DVM to "-5.2V RET" pin on board.
- e. Adjust R29 until DVM reads $-5.2V \pm 20$ mV. Return A6 to its connector.

+15 and -15V Adjustment:

- a. Place A7 assembly (05345-60007) on extender boards.
- b. Connect plus side of DVM to TP2 on board. Connect common side of DVM to "+15V RET" pin on board.
- c. Adjust R18 until DVM reads $+15V \pm 20$ mV.
- d. Connect plus side of DVM to TP7 on board. Connect common side of DVM to "-15V RET" pin on board.
- e. Adjust R24 until DVM reads $-15V \pm 20$ mV.

A8 PPL MULTIPLIER NOISE GENERATOR

Equipment:

HP 180A with 1810A Sampler
HP 10020A Resistive Divider Kit

NOTE

TP15 through TP20 are probe sockets. A common socket is located next to each A8 test point for the probes common side. A good ground is essential for TP16 through TP20, otherwise signal amplitude will vary.

- a. Set counter's FUNCTION switch to FREQ A.
- b. Set oscilloscope controls as shown under appropriate waveforms next to A8 schematic.
- c. Connect the 20:1 probe divider from the 10020A kit to the oscilloscope probe.
- d. Connect BNC cable from counter's FREQ STD OUTPUT 10 MHz jack (rear panel) to oscilloscope's EXT INPUT.
- e. Place A8 on extender boards (05345-60201 and 05345-60202).
- f. Connect oscilloscope probe to TP14. Adjust C29 (labeled CA on the board) for maximum signal. The waveform is a full wave rectified 10 MHz yielding a 20 MHz period. Amplitude should be .75V to 2.0V p-p.
- g. Connect oscilloscope probe to TP15. Adjust C43 (labeled CB on the board) 20 MHz signal for maximum. Amplitude should be 2V to 3V p-p.

Table 5-6. Adjustment Procedures (Continued)

A8 PPL MULTIPLIER NOISE GENERATOR (Continued)

- h. Connect oscilloscope probe to TP16. Adjust C52 (labeled CC on the board) 100 MHz signal for maximum. Amplitude should be .075V to .125V p-p.
- i. Connect oscilloscope probe to TP17. Adjust C57 (labeled CD on the board) 100 MHz signal for maximum. Adjust R81 (labeled RA on the board) for signal level of .6V to .7V p-p.
- j. Connect oscilloscope probe to TP18. Adjust C67 (labeled CF on the board) for maximum 500 MHz signal. Amplitude should be .4V to .6V p-p.
- k. Connect oscilloscope probe to TP19. Adjust C67 (labeled CF on the board) and C61 (labeled CG on the board) for maximum signal. Amplitude should be .3V to .5V p-p.
- l. Connect oscilloscope probe to TP20. Adjust R99 (labeled RB on the board) for signal on \approx .85V. Check that 100 MHz modulation ripple on the top of waveform is <40 mV p-p.
- m. Remove A8 from extender boards and reinstall A8 in motherboard. Set counter's FUNCTION switch to TIME INT A to B. Switch Input Control switch to CHECK position. Set GATE TIME switch to 100 ms position. Turn C68 (labeled CE on the board) phase adjust ccw until a stable 10 ns reading is displayed on the 5345A display. Switch FUNCTION from PERIOD to TIME INT A to B position to ensure reliable reading. NOTE: Adjustment should be turned 360° before setting is selected.

A9 MAIN GATE

The A9 adjustments were completed at the factory in accordance with the selected bias resistors for the particular ICs used. No attempt at adjustment should be made on this board. See further description adjacent to the A9 schematic.

A15 ROM

Equipment:

10048 10:1 Probe

- a. Set counter controls as follows:

FUNCTION	TIME INT A TO B
GATE TIME	10 μ s
DISPLAY POSITION	AUTO
LEVEL (A&B)	PRESET
SLOPE, CH A	-
SLOPE, CH B	+
Input Coupling (A&B)	AC
Input Impedance (A&B)	1 M Ω
Input Amplifier Control	COM A

- b. Connect oscilloscope probe to A15TP8 and BNC end of probe to CHANNEL A jack. The A15 board need not be placed on an extender board.

NOTE

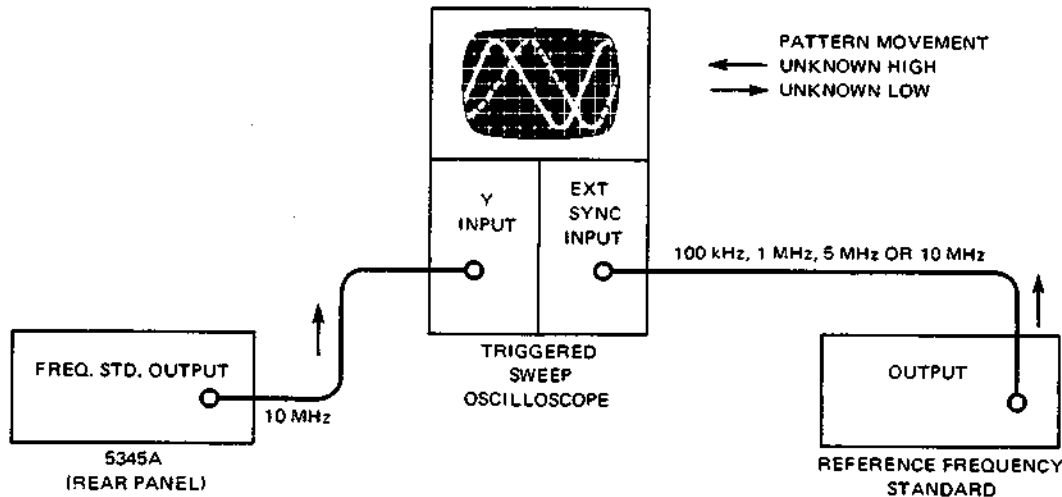
If the 5345A is suspected faulty, connect BNC of probe to a separate counter (e.g., 5326A).

- c. Adjust R5 (located between U4 and U5) to 155 ns.
- d. Set FUNCTION switch to PERIOD A.
- e. Adjust R4 to 255 ns.
- f. Set FUNCTION switch back to TIME INT A to B and do step c through e until both readings are correct.

Table 5-6. Adjustment Procedure (Continued)

A18 OSCILLATOR (STANDARD OR OPTION 001)

Every few months, the oscillator should be checked to a house standard. When adjustment is required, use the oscilloscope method shown below. Using the appropriate sweep speed, adjust the oscillator until the movement of the pattern is stopped or nearly stopped.



CALIBRATION

MOVEMENT	SWEEP SPEED			NOTES
	1 μ SEC/CM	0.1 μ SEC/CM	0.01 μ SEC/CM	
1 CM/SEC	1 X 10 ⁻⁶	1 X 10 ⁻⁷	1 X 10 ⁻⁸	TIME SCOPE TRACE MOVEMENT WITH SECOND HAND OF WATCH OR CLOCK
1 CM/10 SEC	1 X 10 ⁻⁷	1 X 10 ⁻⁸	1 X 10 ⁻⁹	
1 CM/100 SEC	1 X 10 ⁻⁸	1 X 10 ⁻⁹	1 X 10 ⁻¹⁰	

Option 001 Special Adjustment Procedure:

Under normal conditions, the oscillator can be adjusted by using the above procedure. Should the fine-tuning capacitor (accessible through hole in top of oscillator cover) fail to bring the oscillator frequency within range, a coarse adjustment must be made using A18C5. This adjustment is made at the factory to compensate for component value variances. The procedure is outline as follows:

- a. Remove rear panel power cord and remove oscillator from other board connector.
- b. Remove metal cover from board by removing the four holding screws.
- c. Turn adjustment screw of the 18-turn trimmer capacitor A18C4 (see component locator of A18 Option 001, Section VIII) full clockwise. The slot screw itself will not move in or out.
- d. Turn C4 adjustment screw 7 turns ccw. This is the electrical center of the adjustment.
- e. Place oscillator on extender board and insert extender board into the oscillator connector on 5345A motherboard.
- f. Replace power cord, set FUNCTION to FREQ A, and GATE TIME to 100 ms.
- g. Connect a 10 MHz frequency standard to CHANNEL A input.
- h. Adjust A18C5 for a display of 10.000 018 MHz to 10.000 022 MHz. The 20 Hz offset compensates for cover capacity and warm-up in the counter.
- i. Turn power off, mount metal cover to oscillator board, and insert oscillator board into instrument. Replace top cover and allow instrument to warm-up for 1/2-hour before performing oscillator adjustment using oscilloscope method outlined above.

Table 5-6. Adjustment Procedure (Continued)

A12 INTERFACE I/O (OPTION 012) CALIBRATION PROCEDURE

- a. Allow instrument warmup of at least 30 minutes.
- b. Connect DVM to rear panel jacks for Channels A and B trigger levels.
- c. Set Trigger Level manual controls to Preset position for Channels A and B.
- d. Program Channel A to -2.000 volts (A000).
- e. Adjust pot A (R69) to -2.0000 volts \pm .0005 volt.
- f. Program Channel A to +2.000 volts (A:00).
- g. Adjust pot B (R74) to +2.0000 volts \pm .0005 volt.
- h. Program Channel B to -2.000 volts (B000).
- i. Adjust pot D (R86) to -2.0000 volts \pm .0005 volt.
- j. Program Channel B to +2.000 volts (B:00).
- k. Adjust pot C (R82) to +2.0000 volts \pm .0005 volt.
- l. Repeat steps d through k until DAC is within specified setting.

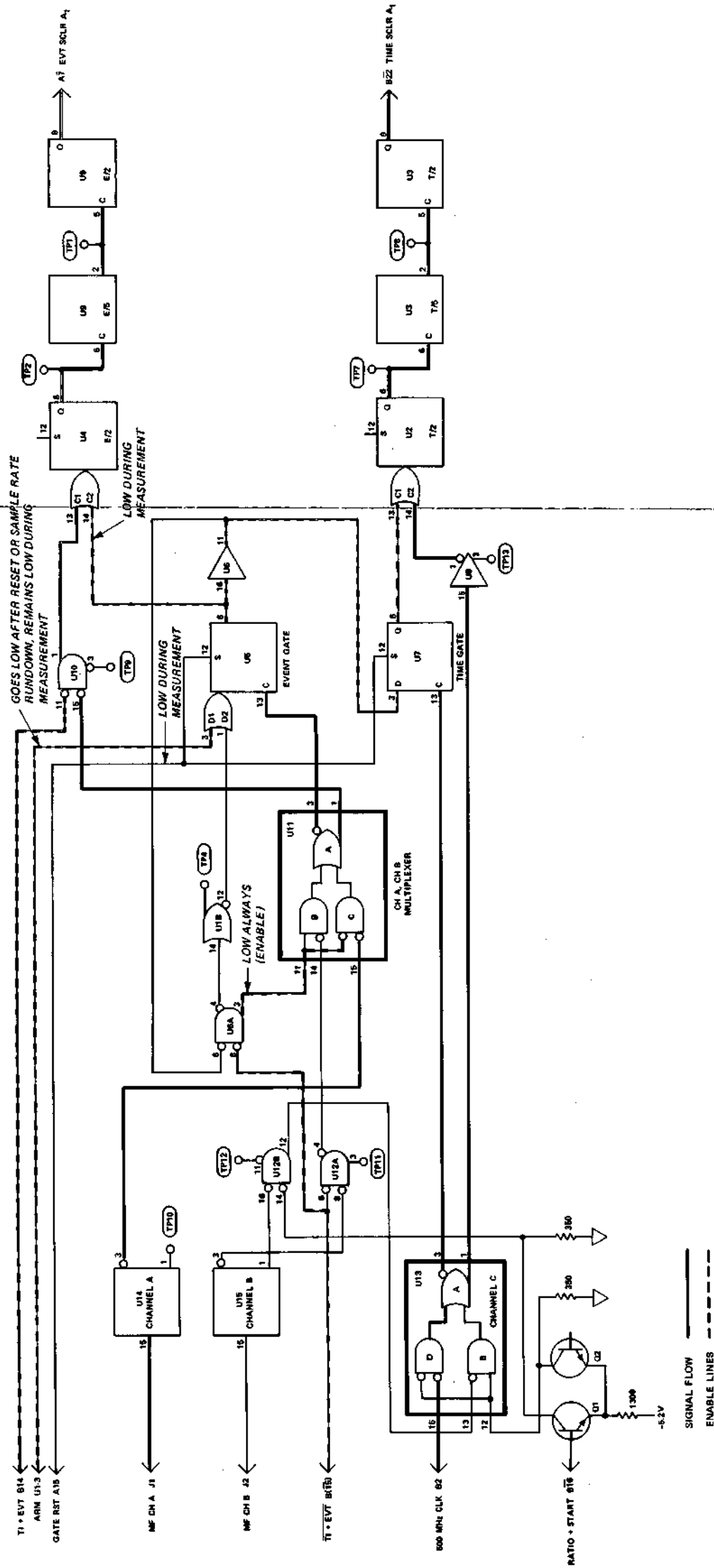


Figure 5-14. A9 Main Gate Assembly.
Simplified Signal Flowchart for Frequency/Period
5-69

Figure 5-14
A9 MAIN GATE ASSEMBLY, SIMPLIFIED SIGNAL
FLOWCHART FOR FREQUENCY/PERIOD

(See Page 5-59)

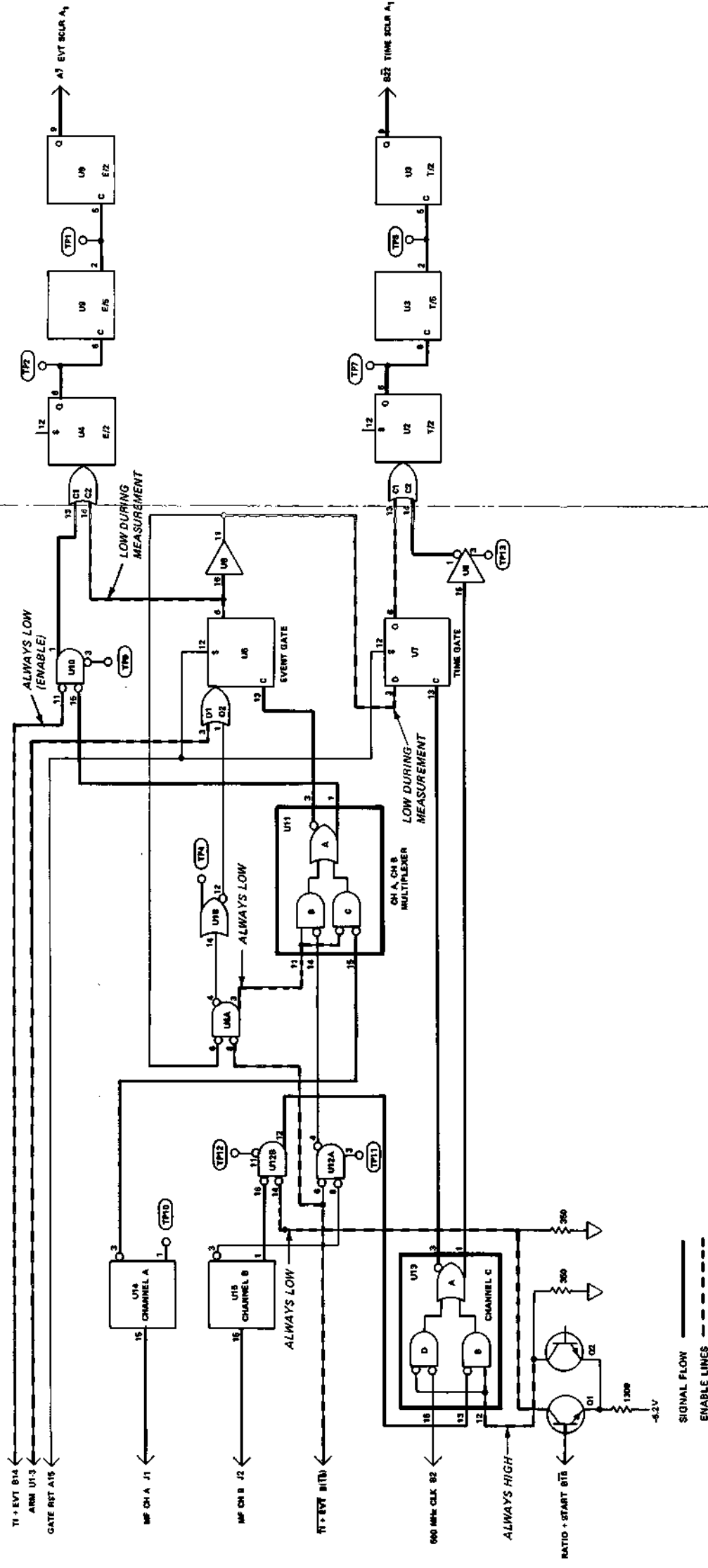


Figure 5-15. A9 Main Gate Assembly.
Simplified Signal Flowchart for Ratio or Start/Stop

Figure 5-15
A9 MAIN GATE ASSEMBLY, SIMPLIFIED SIGNAL
FLOWCHART FOR RATIO OR START/STOP

(See Page 5-61)

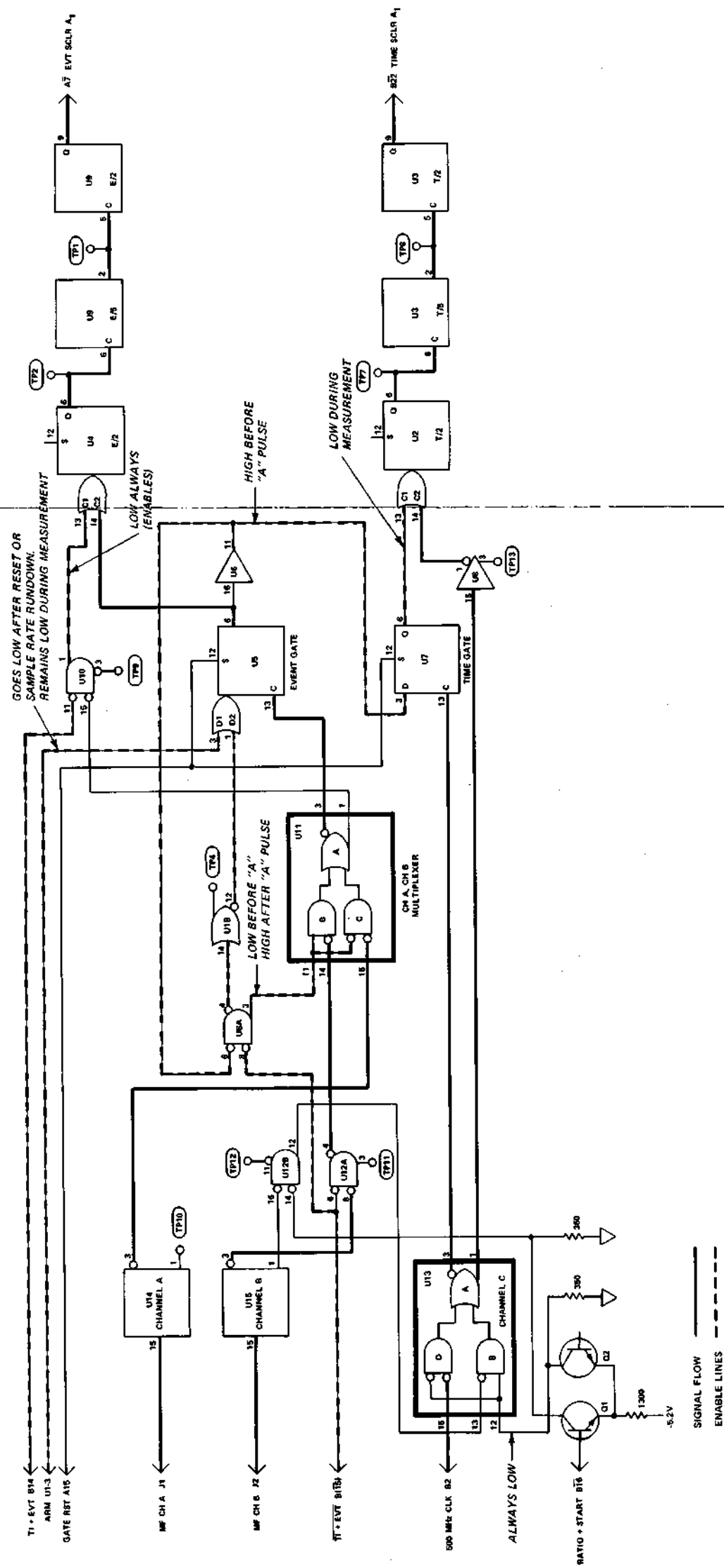


Figure 5-16. A9 Main Gate Assembly.
Simplified Signal Flowchart for Time Interval.

Figure 5-16
A9 MAIN GATE ASSEMBLY, SIMPLIFIED SIGNAL
FLOWCHART FOR TIME INTERVAL

(See Page 5-63)

SECTION VI REPLACEABLE PARTS

6-1. INTRODUCTION

6-2. This chapter contains information for ordering parts. The following replaceable parts lists are included.

Table 6-1	Reference Designations and Abbreviations
Table 6-2	Replaceable Parts
Table 6-3	Miscellaneous Parts
Table 6-4	Replaceable Parts for Options
Table 6-5	Manufacturers Code List

6-3. REFERENCE DESIGNATIONS

6-4. Tables 6-1 through 6-4 list the abbreviations and reference designations used in the parts lists, block diagrams, and throughout the manual.

6-5. REPLACEABLE PARTS

6-6. Tables 6-2 through 6-4 list the replaceable parts and are organized as follows:

1. Electrical assemblies in alphanumerical order by reference designation.
2. Chassis-mounted electrical parts in alphanumerical order by reference designation.
3. Chassis-mounted mechanical parts in alphanumerical order by reference designation.

6-7. The information given for each part consists of the following:

1. Reference Designation
2. Hewlett-Packard part number.
3. Part number check digit (CD).
4. Total quantity (QTY) in instrument. The total quantity is given once and at the first appearance of the part number in the list.
5. Description of the part.
6. Typical manufacturer's part number for the part.

6-8. HOW TO ORDER A PART

6-9. Hewlett-Packard wants to keep your parts ordering process as simple and efficient as possible. Think of the process as having the following steps:

- Identifying the part and the quantity that you want.
- Determining the ordering method to be used and contacting Hewlett-Packard.

6-10. Parts Identification

6-11. To identify the part(s) you want, first refer to the replaceable parts lists (Tables 6-2 and 6-3) in this chapter.

6-12. When ordering from Hewlett-Packard, the important numbers to note from the Parts List are the HP Part Number and part-number check digit (in the "CD" column), and the quantity of the part you want.

6-13. If the part you want is NOT identified in the manual, you can call on Hewlett-Packard for help (see the following section ("Contacting Hewlett-Packard"). Please have the following information at hand when you contact HP for help:

- Instrument Model Number (example "HP 5345A").
- Complete instrument Serial Number (example "1234A56789"). Information about where to find the serial number is given in the preface of this manual in the "HOW TO USE THIS MANUAL" section.
- Description of the part and its use.
- Quantity of the part required.

6-14. Contacting Hewlett-Packard

6-15. Depending on where you are in the world, there are one or more ways in which you can get parts or parts information from Hewlett-Packard.

- Outside the United States, contact your local HP sales office. HP sales offices are listed at the back of this manual.
- Within the United States, we encourage you to order replacement parts or request parts information directly by telephone or mail from the HP Support Materials Organization, using the telephone numbers or address listed below. (You can also contact your local HP sales office. HP sales offices are listed at the back of this manual.)

6-16. By telephone:

- a. For Parts Ordering, use our toll-free number (800) 227-8164, Monday through Friday (except Holidays), 6 am to 5 pm (Pacific Time).
- b. If you need a part in a hurry, an extra-cost Hotline phone ordering service is available, 24 hours a day. Use the toll free number above at the times indicated; at other times, use (916) 785-8460.
- c. For Parts Identification Assistance, call us at (916) 783-0804. Our Parts Identification hours are from Monday through Friday, 6 am to 5 pm (Pacific Time).

6-17. For mail correspondence, use the address below:

Hewlett-Packard
Support Materials Roseville
P.O. Box 1145
Roseville, CA 95661-1145

6-18. CABINET PARTS AND HARDWARE:

6-19. To locate and identify miscellaneous cabinet parts, refer to *Figure 6-1*. This figure provides an exploded view of the cabinet, with the parts identified by reference designations; the reference designations correspond with the ones in *Table 6-3*.

Table 6-1. Reference Designations and Abbreviations

REFERENCE DESIGNATIONS			
A	= assembly	DL	= delay line
AT	= attenuator, isolator termination	DS	= annunciator, signaling device (audible or visual); lamp; LED
B	= fan; motor	E	= miscellaneous electrical part
BT	= battery	F	= fuse
C	= capacitor	FL	= filter
CP	= coupler	H	= hardware
CR	= diode, diode thyristor varactor	HY	= circulator
DC	= directional coupler	J	= electrical connector; (stationary portion); jack
K	= relay	L	= coil, inductor
L	= coil, inductor	M	= metre
M	= metre	MP	= miscellaneous mechanical part
MP	= miscellaneous mechanical part	P	= electrical connector (movable portion); plug
Q	= transistor; SCR; triode thyristor	R	= resistor
R	= resistor	RT	= thermistor
RT	= thermistor	S	= switch
S	= switch	T	= transformer
T	= transformer	TB	= terminal board
TB	= terminal board	TC	= thermocouple
TC	= thermocouple	TP	= test point
TP	= test point	U	= integrated circuit; microcircuit
U	= integrated circuit; microcircuit	V	= electron tube
V	= electron tube	VR	= voltage regulator; breakdown diode
VR	= voltage regulator; breakdown diode	W	= cable; transmission path; wire
W	= cable; transmission path; wire	X	= socket
X	= socket	Y	= crystal unit; piezo-electric
Y	= crystal unit; piezo-electric	Z	= tuned cavity; tuned circuit
Z	= tuned cavity; tuned circuit		

ABBREVIATIONS			
A	= ampere	HD	= head
ac	= alternating current	HDW	= hardware
ACCESS	= accessory	HF	= high frequency
AD	= analog-to-digital	HI	= high
AF	= audio frequency	HP	= Hewlett-Packard
AFC	= automatic frequency control	HPF	= high pass filter
AGC	= automatic gain control	HR	= hour (used in parts list)
AL	= aluminum	HV	= high voltage
ALC	= automatic level control	HZ	= hertz
AM	= amplitude modulation	IC	= integrated circuit
AMPL	= amplifier	ID	= inside diameter
APC	= automatic phase control	IF	= intermediate frequency
ASSY	= assembly	IMP	= impregnated
AUX	= auxiliary	IN	= inch
AVG	= average	INCD	= incandescent
AWG	= American wire gage	INCL	= include(s)
BAL	= balance	INP	= input
BCD	= binary coded decimal	INS	= insulation
BD	= board	INT	= internal
BE CU	= beryllium copper	KG	= kilogram
BFO	= beat frequency oscillator	KHZ	= kilohertz
BH	= binder head	KV	= kilovolt
BKDM	= breakdown	L	= pound
BP	= bandpass	LC	= inductance-capacitance
BPF	= bandpass filter	LED	= light-emitting diode
BRS	= brass	LG	= low frequency
BWO	= backward-wave oscillator	LH	= long
CAL	= calibrate	LI	= left hand
ccw	= counterclockwise	LIM	= limit
CER	= ceramic	LN	= linear taper (used in parts list)
CHAN	= channel	LN	= linear
cm	= centimeter	LK WASH	= lockwasher
CMO	= coaxial	LO	= low; local oscillator
COEF	= coefficient	LOG	= logarithmic taper (used in parts list)
COM	= common	LOG	= logarithmic (ic)
COMP	= composition	LFF	= low pass filter
CONPL	= complete	LV	= low voltage
CONN	= connector	m	= metre (distance)
CP	= cadmium plate	mA	= milliampere
CRT	= cathode-ray tube	MAX	= maximum
CTL	= complementary transistor logic	MO	= megohm
CW	= continuous wave	MEG FLM	= meg (10 ⁶) (used in parts list)
cw	= clockwise	MET FLM	= metal film
D/A	= digital-to-analog	MET OX	= metal oxide
dB	= decibel	MF	= medium frequency; microfarad (used in parts list)
dBm	= decibel referred to 1mW	MFR	= manufacturer
dc	= direct current	mg	= milligram
deg	= degree (temperature interval (or difference))	MHZ	= megahertz
°C	= degree Celsius (centigrade)	mH	= millihenry
°F	= degree Fahrenheit	mho	= conductance
GK	= degree Kelvin	MIN	= minimum
DEPC	= deposited carbon	min	= minute (time)
DET	= detector	MINAT	= minute (plane angle)
diam	= diameter	mm	= millimetre
DIA	= diameter (used in parts list)	MOD	= modulator
DIFF AMPL	= differential amplifier	MOM	= momentary
dv	= division	MOS	= metal-oxide semiconductor
DPDT	= double-pole, double-throw	ms	= millisecond
DR	= drive	MTG	= mounting
DSS	= double sideband	MTR	= meter (indicating device)
DTL	= diode transistor logic	mV	= millivolt
DVM	= digital voltmeter	mV ac	= millivolt, ac
ECL	= emitter coupled logic	mV dc	= millivolt, dc
EMF	= electromotive force	mVpk	= millivolt, peak
EDP	= electronic data processing	mVp-p	= millivolt, peak-to-peak
ELECT	= electrolytic	mVrms	= millivolt, rms
ENCAP	= encapsulated	mW	= milliwatt
EXT	= external	MUX	= multiplex
F	= farad	MY	= mylar
FET	= field-effect transistor	µA	= microampere
F/F	= flip-flop	µF	= microfarad
FH	= flat head	µH	= microhenry
FOL H	= filter head	µmho	= micromho
FM	= frequency modulation	µs	= microsecond
FP	= front panel	µV	= microvolt
FREQ	= frequency	µV ac	= microvolt, ac
FXD	= fixed	µV dc	= microvolt, dc
g	= gram	µVpk	= microvolt, peak
GE	= germanium	µVp-p	= microvolt, peak-to-peak
GHz	= gigahertz	µVrms	= microvolt, rms
GL	= glass	µW	= microwatt
GND	= ground(ed)	µW ac	= microwatt, ac
H	= henry	µW dc	= microwatt, dc
h	= hour	µWpk	= microwatt, peak
HET	= heterodyne	µA	= microampere
HEX	= hexagonal	NC	= no connection
		NC	= normally closed

ABBREVIATIONS (continued)			
NE	= neon	SPST	= single-pole, single-throw
NEG	= negative	SSB	= single sideband
nF	= nanofarad	SST	= stainless steel
N/O	= normally open	SO	= square
NOM	= nominal	SWR	= standing-wave ratio
NORM	= normal	SYNC	= synchronize
NPN	= negative-positive-negative	T	= timed (slow-blow fuse)
NPO	= negative-positive zero (zero temperature coefficient)	TA	= tantalum
NRFR	= not recommended for field replacement	TC	= temperature compensating
ns	= nanosecond	TD	= time delay
NSR	= not separately replaceable	TERM	= terminal
nW	= nanowatt	TFT	= thin-film transistor
OB	= order by description	TGL	= toggle
OD	= outside diameter	THD	= thread
OH	= oval head	THRU	= through
OP AMPL	= operational amplifier	TI	= titanium
OPT	= option	TOL	= tolerance
CSC	= oscillator	TRIM	= trimmer
OX	= oxide	TSTR	= transistor
oz	= ounce	TTL	= transistor-transistor logic
Ω	= ohm	TV	= television
Ω (used in parts list)	= ohm (used in parts list)	TVI	= television interference
PAM	= pulse-amplitude modulation	TWT	= traveling wave tube
PC	= printed circuit	U	= micro (10 ⁻⁶ used in parts list)
PCM	= pulse code modulation	UF	= microfarad (used in parts list)
PDM	= pulse-duration modulation	UHF	= ultrahigh frequency
PH BRZ	= phosphor bronze	UNREG	= unregulated
PHL	= Phillips	V	= volt
PIN	= positive-intrinsic-negative	VA	= voltampere
PIV	= peak inverse voltage	Vac	= volts ac
pk	= peak	VAR	= variable
PL	= phase lock	VCO	= voltage-controlled oscillator
PLO	= phase lock oscillator	Vdc	= volts dc
PM	= phase modulation	VDCW	= volts, dc, working (used in parts list)
PNP	= positive-negative-positive	V(F)	= volts, filtered
P/O	= part of	VFO	= variable-frequency oscillator
POLY	= polystyrene	VHF	= very-high frequency
PORC	= porcelain	Vpk	= volts peak
POS	= positive; position(s) used in parts list	Vp-p	= volts peak-to-peak
POSN	= position	Vrms	= volts rms
POT	= potentiometer	VSWR	= voltage standing wave ratio
pp	= peak-to-peak	VTO	= voltage-tuned oscillator
pp-p	= peak-to-peak (used in parts list)	VTVM	= vacuum-tube voltmeter
PPM	= pulse-position modulation	V(X)	= volts, switched
PREF	= preamplifier	W	= watt
PRR	= pulse repetition rate	W/V	= working inverse voltage
ps	= picosecond	W/W	= wirewound
PT	= point	W/O	= without
PTM	= pulse-time modulation	YG	= yttrium-iron-garnet
PWM	= pulse-width modulation	Zo	= characteristic impedance
PWV	= peak working voltage		
RC	= resistance capacitance		
RECT	= rectifier		
REF	= reference		
REG	= regulated		
REPL	= replaceable		
RF	= radio frequency		
RFI	= radio frequency interference		
RH	= round head; right hand		
RLC	= resistance-inductance-capacitance		
RMO	= rack mount only		
rms	= root-mean-square		
ROM	= read-only memory		
R&P	= rack and panel		
RWV	= reverse working voltage		
S	= scattering parameter		
S	= second (time)		
S-D	= slow-blow fuse (used in parts list)		
SCR	= silicon controlled rectifier; screw		
SE	= selenium		
SECT	= sections		
SEMICON	= semiconductor		
SHF	= superhigh frequency		
SI	= silicon		
SIL	= silver		
SL	= slide		
SNR	= signal-to-noise ratio		
SPDT	= single-pole, double-throw		
SPG	= spring		
SR	= split ring		

MULTIPLIERS			
Abbreviation	Prefix	Multiple	
T	tera	10 ¹²	
G	giga	10 ⁹	
M	mega	10 ⁶	
k	kilo	10 ³	
da	deka	10	
d	deci	10 ⁻¹	
c	centi	10 ⁻²	
m	milli	10 ⁻³	
µ	micro	10 ⁻⁶	
n	nano	10 ⁻⁹	
p	pico	10 ⁻¹²	
f	femto	10 ⁻¹⁵	
a	atto	10 ⁻¹⁸	

NOTE
All abbreviations in the parts list will be in upper case.

Table 6-2. Replaceable Parts for Standard Instrument without Options

Reference Designation	HP Part Number	C D	Qty	Description	Mfr Code	Mfr Part Number
A1	05345-60001	9	1	CATHODE DISPLAY DRIVER ASSEMBLY	28480	05345-60001
A1DS1 - DS12	1990-0437	7	12	DISPLAY-NUM SEG 1-CHAR .43-H	28480	5082-7751
A1DS13 - DS24	2140-0221	7	12	LAMP-INCAND 683 5VDC 60MA T-1-BULB	00115	683-AS15
A1J1	1251-1365	6	1	CONNECTOR-PC EDGE 22-CONT/ROW 2-ROWS	28480	1251-1365
A1R1	1810-0041	9	2	NETWORK RESISTOR 9-SIP 2.7K OHM X 8	28480	1810-0041
A1R2	1810-0041	9		NETWORK RESISTOR 9-SIP 2.7K OHM X 8	28480	1810-0041
A1R3	0683-1315	0	1	RESISTOR 130 5% .25W FC		
A1U1	1820-0491	4	1	IC DCDR TTL BCD-TO-DE 4-TO-10-LINE	01295	SN74145N
A1U2	1820-0668	7	1	IC BFR TTL NON-INV HEX 1-1NP	01295	SN7407N
A1XDS1	1200-0496	5	12	SOCKET-IC 14-PIN	28480	1200-0496
	0520-0278	8	4	SCREW-MACH 2-56 .875-IN-LG 82-DEG	00000	ORDER BY DESCRIPTION
	0590-0106	8	4	NUT-HEX PLASTIC LKG 2-56-THD .143-IN-THK	00000	ORDER BY DESCRIPTION
	3050-0098	6	4	WASHER-FL MTLIC NO. 2 .094-IN-ID	00000	ORDER BY DESCRIPTION
	05345-40004	0	2	BLOCK-ANNUNCIATOR	28480	05345-40004
	05345-40007	3	1	ANNUNCIATOR	28480	05345-40007
A2	05345-60027	9	1	ANODE DISPLAY DRIVER ASSEMBLY (SERIES 2134)	28480	05345-60027
A2C1	0160-0300	3	1	CAPACITOR-FXD 2700PF ±10% 200VDC POLYE	28480	0160-0300
A2C2	0180-4130	8	1	CAPACITOR FXD 2.2UF ±10% WVDC 20TA	28480	0180-44130
A2C3	0180-1714	7	1	CAPACITOR-FXD 330UF ±10% 6VDC TA	56289	150D337X900652
A2CR1	1901-0519	9	1	DIODE SWITCHING 200V 50NS DO-35	28480	1901-0519
A2Q1 - Q8	1854-0246	8	8	TRANSISTOR NPN SI PD=350W FT=250MHZ	04713	5PS 233
A2Q9 - Q20	1853-0326	3	12	TRANSISTOR PNP SI PD=1W FT=50MHZ	04713	MPS-U51
A2R1 - R8	0683-1005	5	8	RESISTOR 10 5% .25W FC TC=-400/+500	01121	CB1005
A2R9	0683-1035	1	3	RESISTOR 10K 5% .25W FC TC=-400/+700	01121	CB-1035
A2R10	0683-1035	1		RESISTOR 10K 5% .25W FC TC=-400/+700	01121	CB-1035
A2R11	1810-0041	9	2	NETWORK RESISTOR 9-SIP 2.7K OHM X 8	28480	1810-0041
A2R12	1810-0041	9		NETWORK RESISTOR 9-SIP 2.7K OHM X 8	28480	1810-0041
A2R13 - R24	0683-1815	5	12	RESISTOR 180 5% .25W FC TC=-400/+800	01121	CB1815
A2R25	0757-0941	3	1	RESISTOR 5.1K 2% .125W F TC=0±100	24546	C4-1/8-TO-5101G
A2R26	2100-2031	7	1	RESISTOR-TRMR 50K 10% C TOP-ADJ 1-TRN	73138	82PR50K
A2R27	0683-1035	1		RESISTOR 10K 5% .25W FC TC=-400/+700	01121	CB1035
A2U1	1820-0496	8	1	IC DCDR TTL 4-TO-16-LINE 4-INP	01295	SN74154N
A2U2	1820-1211	8	1	IC GATE TTL LS EXCL-OR QUAD 2-INP	01295	SN74LS88N
A2U3	1820-0655	2	1	IC GATE TTL OR DUAL 4-INP	01295	SN7425N
A2U4	1820-0349	1	1	IC GATE DTL NAND QUAD 2-INP	01295	SN15849N
A2U5	1820-1202	7	1	IC GATE TTL LS NAND TPL 3-INP	01295	SN74LS10N
A2U6	1820-1644	1	1	IC DCDR TTL 4-TO-16-LINE 4-INP	01295	SN74154N
A2U7	1820-0515	3	1	IC MV TTL MONOSTBL RETRIG-RESET DUAL	04713	MC8602P
	0360-0124	3	2	CONNECTOR-SGL CONT PIN .04-IN-BSC-SZ RND	28480	0360-0124
	0360-1762	7	3	CONNECTOR-SGL CONT SKT .025-IN-BSC-SZ SQ	28480	0360-1762

See Introduction To This Section For Ordering Information
*Indicates Factory Selected Value

Table 6-2. Replaceable Parts for Standard Instrument without Options (Continued)

Reference Designation	HP Part Number	C D	Qty	Description	Mfr Code	Mfr Part Number
A3	05345-60238	4	1	INPUT ATTENUATOR ASSEMBLY - STANDARD	28480	05345-60238
A3	05345-60239	4	1	INPUT ATTENUATOR ASSEMBLY - OPTION 012 (See Table 6-4. Option Assembly Replaceable Parts)	28480	5082-7751
A3C1 - C8	0160-3879	7	32	CAPACITOR-FXD .01UF ±20% 100VDC CER	28480	0160-3879
A3C9				NOT ASSIGNED		
A3C10	0150-0072	5	2	CAPACITOR-FXD 200PF ±5% 1KVDC CER	72982	838-X5E-201J-1KV
A3C11 - C15	0160-3879	7		CAPACITOR-FXD .01UF ±20% 100VDC CER	28480	0160-3879
A3C16	0160-0552	7	2	CAPACITOR-FXD 100PF ±5% 400VDC CER	28480	0160-0552
A3C17	0160-0551	6	2	CAPACITOR-FXD .01UF +100-0% 500VDC CER	28480	0160-0551
A3C18	0160-5978	1	4	CAPACITOR-FXD 2.2PF ±.25PF 50VDC CER	28480	0160-5978
A3C19				NOT USED		
A3C20	0160-3879	7		CAPACITOR-FXD .01UF ±20% 100VDC CER	28480	0160-3879
A3C21				NOT USED		
A3C22	0160-0551	6		CAPACITOR-FXD .01UF +100-0% 500VDC CER	28480	0160-0551
A3C23	0160-5978	1		CAPACITOR-FXD 2.2PF ±.25PF 50VDC CER	28480	0160-5978
A3C24	0160-0552	7		CAPACITOR-FXD 100PF ±5% 400VDC CER	28480	0160-0552
A3C25 - C33	0160-3879	7		CAPACITOR-FXD .01UF ±20% 100VDC CER	28480	0160-3879
A3C34	0150-0072	5		CAPACITOR-FXD 200PF ±5% 1KVDC CER	72982	838-X5E-201J-1KV
A3C35	0160-3879	7		CAPACITOR-FXD .01UF ±20% 100VDC CER	28480	0160-3879
A3C36 - C44	0160-3879	7		CAPACITOR-FXD .01UF ±20% 100VDC CER	28480	0160-3879
A3C45	0160-5978	1		CAPACITOR-FXD 2.2PF ±.25PF 50VDC CER	28480	0160-5978
A3C46	0160-5978	1		CAPACITOR-FXD 2.2PF ±.25PF 50VDC CER	28480	0160-5978
A3CR1	1901-0050	3	8	DIODE-SWITCHING 80V 200MA 2NS DO-35	28480	1901-0050
A3CR2	1901-0050	3		DIODE-SWITCHING 80V 200MA 2NS DO-35	28480	1901-0050
A3CR3	1901-0579	1	4	DIODE-SWITCHING 40V 20MA 300NS DO-7	28480	1901-0579
A3CR4	1901-0579	1		DIODE-SWITCHING 40V 20MA 300NS DO-7	28480	1901-0579
A3CR5	1901-0579	1		DIODE-SWITCHING 40V 20MA 300NS DO-7	28480	1901-0579
A3CR6	1901-0579	1		DIODE-SWITCHING 40V 20MA 300NS DO-7	28480	1901-0579
A3CR7 - CR12	1901-0050	3		DIODE-SWITCHING 80V 200MA 2NS DO-35	28480	1901-0050
A3CR13				NOT ASSIGNED		
A3CR14	1902-0025	4	2	DIODE-ZNR 10V 5% DO-35 PD= .4W TC=+.06%	28480	1902-0025
A3CR15	1902-0025	4		DIODE-ZNR 10V 5% DO-35 PD=.4W TC=+.06%	28480	1902-0025
H1, H2	0380-0519	2	2	SPACER-RND .125-IN-LG .259-IN-ID	28480	0380-0519
A3J1	1250-1163	0	2	CONNECTOR-RF BNC FEM SGL-HOLE-RR 50-OHM	28480	1250-1163
A3J2	1251-2034	8	2	CONNECTOR-PC EDGE 10-CONT/ROW 2-ROWS	28480	1251-2034
A3J3	1250-1163	0		CONNECTOR-PC BNC FEM SGL-HOLE-RR 50-OHM	28480	1250-1163
A3J4	1251-2034	8		CONNECTOR-PC EDGE 10-CONT/ROW 2-ROWS	28480	1251-2034
MP1	5020-3440	7	1	SPRING-DETENT	28480	5020-3440
MP2 - MP7	1460-0603	6	6	SPRING-DETENT	28480	1460-0603
MP8 - MP11	05345-40002	8	4	GUIDE	28480	05345-40002
MP13 - MP14	05345-20113	0	2	NUT-HEXAGONAL	28480	053454-20113
A3Q1	1855-0225	5	4	TRANSISTOR-JFET DUAL N-CHAN D-MODE SI	28480	1855-0225
A3R1	0698-7224	3	2	RESISTOR 316 1% .05W F TC=0±100	24546	C3-1/8-TO-316R-F
A3R2	0698-7239	0	2	RESISTOR 1.33K 1% .05W F TC=0±100	24546	C3-1/8-TO-1331-F
A3R3	2100-4127	6	2	RESISTOR-TRMR 10K 5% WW SIDE-ADJ 11-TRN	28480	2100-4127
A3R4	0698-8824	1	2	RESISTOR 562K 1% .125W F TC=0±100	28480	0698-8824
A3R5	0698-7243	6	2	RESISTOR 1.98K 1% .05W F TC=0±100	24546	C34-1/8-TO-1961-F
A3R6	0698-7233	4	12	RESISTOR 750 1% .05W F TC=0±100	24546	C3-1/8-TO-750R-F
A3R7	0698-7233	4		RESISTOR 750 1% .05W F TC=0±100	24546	C3-1/8-TO-750R-F
A3R8	0698-7253	8	4	RESISTOR 5.11K 1% .05W F TC=0±100	24546	C3-1/8-TO-51111-F
A3R9	0757-0442	9	2	RESISTOR 10K 1% .125W F TC=0±100	24546	C4-1/8-T-1002-F
A3R10*	0698-7260	7	2	RESISTOR 10K 1% .05W F TC=0±100	24546	C3-1/8-TO-1002-F
A3R11	0698-7253	8		RESISTOR 5.11K 1% .05W F TC=0±100	24546	C3-1/8-TO-51111-F
A3R12	2100-3616	6	2	RESISTOR-VAR W/SW 5K 20% LIN SPST-NO	01121	GS1N112S502MZ
A3R13				NOT USED		
A3R14	0698-3969	5	1	RESISTOR 51 2% .125W F TC=0±100	28480	0698-3969
A3R15	0698-7233	4		RESISTOR 750 1% .05W F TC=0±100	24546	C3-1/8-TO-750R-F

See Introduction To This Section For Ordering Information
* Indicates Factory-Selected Value

Table 6-2. Replaceable Parts for Standard Instrument without Options (Continued)

Reference Designation	HP Part Number	C D	Qty	Description	Mfr Code	Mfr Part Number
A3R16	0757-0059	4	2	RESISTOR 1M 1% .5W F TC=0±100	28480	0757-0059
A3R17	0698-7233	4		RESISTOR 750 1% .05W F TC=0±100	24546	C3-1/8-TO-750R-F
A3R18	0698-7233	4		RESISTOR 750 1% .05W F TC=0±100	24546	C3-1/8-TO-750R-F
A3R19	0698-7229	8	2	RESISTOR 511 1% .05W F TC=0±100	24546	C3-1/8-TO-511R-F
A3R20	0698-7233	4		RESISTOR 750 1% .05W F TC=0±100	24546	C3-1/8-TO-750R-F
A3R21	0698-8381	5	2	RESISTOR 50 5% .1W C TC=0±200	28480	0698-8381
A3R22	0698-8881	0	2	RESISTOR 900K 5% .3W C TC=0±200	28480	0698-8881
A3R23	0698-8880	9	2	RESISTOR 100K 5% .15W C TC=0±150	28480	0698-8880
A3R24	0757-0072	1	2	RESISTOR 49.9 1% .5W F TC=0±100	28480	0757-0072
A3R25	0757-0072	1		RESISTOR 49.9 1% .5W F TC=0±100	28480	0757-0072
A3R26	0698-8382	6	1	RESISTOR 25 5% .25W C TC=0±150	28480	0698-8382
A3R27	0698-8880	9		RESISTOR 100K 5% .15W C TC=0±150	28480	0698-8880
A3R28	0698-8881	0		RESISTOR 900K 5% .3W C TC=0±200	28480	0698-8881
A3R29	0698-8381	5		RESISTOR 50 5% .1W C TC=0±200	28480	0698-8381
A3R30	0698-7205	0	1	RESISTOR 51.1 1% .05W F TC=0±100	24546	C3-1/8-TO-511R1-F
A3R31	0698-7233	4		RESISTOR 750 1% .05W F TC=0±100	24546	C3-1/8-TO-750R-F
A3R32	0698-7233	4		RESISTOR 750 1% .05W F TC=0±100	24546	C3-1/8-TO-750R-F
A3R33	0698-7229	8		RESISTOR 511 1% .05W F TC=0±100	24546	C3-1/8-TO-511R-F
A3R34	0698-7233	4		RESISTOR 750 1% .05W F TC=0±100	24546	C3-1/8-TO-750R-F
A3R35	0698-7233	4		RESISTOR 750 1% .05W F TC=0±100	24546	C3-1/8-TO-750R-F
A3R36	0757-0059	4		RESISTOR 1M 1% .5W F TC=0±100	28480	0757-0059
A3R37				NOT USED		
A3R38	2100-3616	6		RESISTOR-VAR W/SW 5K 20% LIN SPST-NO	01121	GS1N112S502MZ
A3R39	0698-7253	8		RESISTOR 5.11K 1% .05W F TC=0±100	24546	C3-1/8-TO-5111-F
A3R40	0757-0442	9		RESISTOR 10K 1% .125W F TC=0±100	24546	C4-1/8-TO-1002-F
A3R41	2100-4127	6		RESISTOR-TRMR 10K 5% WW SIDE-ADJ 11-TRN	28480	2100-4127
A3R42	0698-7260	7		RESISTOR 10K 1% .05W F TC=0±100	24546	C3-1/8-TO-1002-F
A3R43	0698-7233	4		RESISTOR 750 1% .05W F TC=0±100	24546	C3-1/8-TO-750R-F
A3R44	0698-7233	4		RESISTOR 750 1% .05W F TC=0±100	24546	C3-1/8-TO-750R-F
A3R45	0698-8824	1		RESISTOR 562K 1% .125W F TC=0±100	28480	0698-8824
A3R46	0698-7253	8		RESISTOR 5.11K 1% .05W F TC=0±100	24546	C3-1/8-TO-5111-F
A3R47	0698-7239	0		RESISTOR 1.33K 1% .05W F TC=0±100	24546	C3-1/8-TO-1331-F
A3R48	0698-7243	6		RESISTOR 1.96K 1% .05W F TC=0±100	24546	C3-1/8-TO-1961-F
A3R49	0698-7224	3		RESISTOR 316 1% .05W F TC=0±100	24546	C3-1/8-TO-316R-F
A3R50	0698-7219	6	2	RESISTOR 196 1% .05W F TC=0±100	24546	C3-1/8-TO-196R-F
A3R51	0698-7219	6		RESISTOR 196 1% .05W F TC=0±100	24546	C3-1/8-TO-196R-F
A3R52	0698-8827	4	2	RESISTOR 1M 1% .125W F TC=0±100	28480	0698-8827
A3R53	0698-8827	4		RESISTOR 1M 1% .125W F TC=0±100	28480	0698-8827
A3R54, R55				NOT USED		
A3R56, R57	0698-8912	8	2	RESISTOR 10 10% .075W C TC=0±300	14193	CR1-AA-10-K
A3S1	3101-2334	6	2	SWITCH-SLIDE DPDT SUBMIN .5A 125VAC/DC PC	28480	3101-2334
A3S2 - S4	05345-60100	9	6	LEVER-SLIDE ASSEMBLY	28480	05345-60100
A3S5	05345-60101	0	1	SLIDE ASSEMBLY, PC SWITCH	28480	05345-60101
A3S6 - S8	05345-60100	9		LEVER-SLIDE ASSEMBLY	28480	05345-60100
A3S9	3101-2334	6		SWITCH-SLIDE DPDT SUBMIN .5A 125VAC/DC PC	28480	3101-2334
A3U1	5088-7061	8	1	AMP-HYBRID CH A	28480	5088-7061
A3U2	5088-7062	9	1	AMP-HYBRID CH B		
	4330-0145	9	2	INSULATOR-BEAD GLASS	28480	4330-0145
	01801-22301	7	2	HEATSINK	28480	01801-22301
	0340-0060	4	4	TERMINAL-STUD SPCL-FDTHRU PRESS-MTG	98291	011-6809 000 209
	1200-0475	0	28	CONNECTOR-SCL CONT SKT .017-IN-BSC-SZ	28480	1200-0475
	1251-2229	3	4	CONNECTOR-SGL CONT SKT .033-IN-BSC-SZ	28480	1251-2229

See Introduction To This Section For Ordering Information
* Indicates Factory-Selected Value

Table 6-2. Replaceable Parts for Standard Instruments without Options (continued)

Reference Designation	HP Part Number	C D	Qty	Description	Mfr Code	Mfr Part Number
A4	05345-60124	7	1	INPUT TRIGGER ASSEMBLY	28480	05345-60124
A4C1	0180-0098	8	4	CAP-FXD 100UF ±20% 20VDC TA	56289	150D107X0020S2
A4C2	0180-2816	2	4	CAP-FXD 68UF ±20% 10VDC TA	28480	0180-2816
A4C3	0180-0098	8		CAP-FXD 100UF ±20% 20VDC TA	56289	150D107X0020S2
A4C4	0180-2816	2		CAP-FXD 68UF ±20% 10VDC TA	28480	0180-2816
A4C5	0180-2816	2		CAP-FXD 68UF ±20% 10VDC TA	28480	0180-2816
A4C6	0180-2816	2		CAP-FXD 68UF ±20% 10VDC TA	28480	0180-2816
A4C7	0180-0098	8		CAP-FXD 100UF ±20% 20VDC TA	56289	150D107X0020S2
A4C8	0180-0098	8		CAP-FXD 100UF ±20% 20VDC TA	56289	150D107X0020S2
A4C9	0160-3879	7	4	CAP-FXD .01UF ±20% 100VDC CER	28480	0160-3879
A4C10	0160-3879	7		CAP-FXD .01UF ±20% 100VDC CER	28480	0160-3879
A4C11	0160-3879	7		CAP-FXD .01UF ±20% 100VDC CER	28480	0160-3879
A4C12	0160-3879	7		CAP-FXD .01UF ±20% 100VDC CER	28480	0160-3879
A4CR1 - CR4	1901-0460	8	4	DIODE-STABISTOR 30V 150MA DO-7	28480	1901-0460
A4L1	9100-3060	1	2	INDUCTOR 260UH 15%	28480	9100-3060
A4L2	9100-3060	1		INDUCTOR RF-CH-MLD 100UH 10%	28480	9100-3060
A4L3	9100-1788	6	4	CORE-FERRITE CHOKE-WIDEBAND; IMP;>680	28480	9100-1788
A4L4	9100-1788	6		CORE-FERRITE CHOKE-WIDEBAND; IMP;>680	28480	9100-1788
A4L5	9100-1788	6		CORE-FERRITE CHOKE-WIDEBAND; IMP;>680	28480	9100-1788
A4L6	9100-1788	6		CORE-FERRITE CHOKE-WIDEBAND; IMP;>680	28480	9100-1788
A4L7	9100-2562	6	2	INDUCTOR RF-CH-MLD 100UH 10%	28480	9100-2562
A4L8	9100-2562	6		INDUCTOR RF-CH-MLD 100UH 10%	28480	9100-2562
A4R1	0757-0446	3	4	RESISTOR 15K 1% .125W F TC=0±100	24546	C4-1/8-TO-1502-F
A4R2	0698-7263	0	2	RESISTOR 13.3K 1% .05W F TC=0±100	24546	C3-1/8-TO-1332-F
A4R3	2100-1738	9	2	RESISTOR-TRMR 10K 10% C TOP-ADJ 1-TRN	73138	82PR10K
A4R4	0698-7255	0	2	RESISTOR 6.19K 1% .05W F TC=0±100	24546	C3-1/8-TO-6191-F
A4R5	0757-0446	3		RESISTOR 15K 1% .125W F TC=0±100	24546	C4-1/8-TO-1502-F
A4R6	0698-7263	0		RESISTOR 13.3K 1% .05W F TC=0±100	24546	C3-1/8-TO-1332-F
A4R7	0698-7255	0		RESISTOR 6.19K 1% .05W F TC=0±100	24546	C3-1/8-TO-6191-F
A4R8	2100-1738	9		RESISTOR-TRMR 10K 10% C TOP-ADJ 1-TRN	73138	82PR10K
A4R9	0757-0446	3		RESISTOR 15K 1% .125W F TC=0±100	24546	C4-1/8-TO-1502-F
A4R10	0757-0446	3		RESISTOR 15K 1% .125W F TC=0±100	24546	C4-1/8-TO-1502-F
A4R11	2100-1984	7	2	RESISTOR-TRMR 100 10% TOP ADJ 1-TRN TC=0±100	28480	2100-1984
A4R12	2100-1984	7		RESISTOR-TRMR 100 10% TOP ADJ 1-TRN TC=0±100	28480	2100-1984
A5	05345-60005	3	1	INTERCONNECT ASSEMBLY	28480	05345-60005
A5J1	1251-2134	9	1	CONNECTOR-PC EDGE 18-CONT/ROW 2-ROWS	28480	1251-2134
ASW1	05345-60076	8	1	CABLE ASSEMBLY-CHANNEL "A" (A5 TO A9)	28480	05345-60076
ASW2	05345-60077	9	1	CABLE ASSEMBLY, CHANNEL "B" (A5 TO A9)	28480	05345-60077
	0380-0059	5	1	SPACER, RVT-ON .25-IN-LG	28480	0380-0059
	0520-0173		4	SCREW-MACH 2-56 0.188-IN-LG PAN-HD POZI W/LKWR	00000	ORDER BY DESCRIPTION

See Introduction To This Section For Ordering Information
* Indicates Factory-Selected Value

Table 6-2. Replaceable Parts for Standard Instruments without Options (Continued)

Reference Designation	HP Part Number	C D	Qty	Description	Mfr Code	Mfr Part Number
A6	05345-60006	9	1	SWITCHING REGULATOR ASSEMBLY (SERIES 1744)	28480	05361-60001
A6C1	0160-0174	9	2	CAPACITOR-FXD .47UF +80-20% 25VDC CER	28480	0160-0174
A6C2	0160-0174	9		CAPACITOR-FXD .47UF +80-20% 25VDC CER	28480	0160-0174
A6C3	0180-0459	5	1	CAPACITOR-FXD 9100UF +75-10% 12VDC AL	28480	0180-0459
A6C4	0180-2473	7	3	CAPACITOR-FXD 5600UF +75-10% 20VDC AL	56289	601D568G020JS4
A6C5	0180-2473	7		CAPACITOR-FXD 5600UF +75-10% 20VDC AL	56289	601D568G020JS4
A6C6	0180-2473	7		CAPACITOR-FXD 5600UF +75-10% 20VDC AL	56289	601D568G020JS4
A6C7	0160-3060	8	5	CAPACITOR-FXD .1UF ±20% 25VDC CER	28480	0160-3060
A6C8	0180-0210	6	2	CAPACITOR-FXD 3.3UF ±20% 15VDC TA	56289	150D335X0015A2
A6C9	0160-3060	8		CAPACITOR-FXD .1UF ±20% 25VDC CER	28480	0160-3060
A6C10	0160-3060	8		CAPACITOR-FXD .1UF ±20% 25VDC CER	28480	0160-3060
A6C11	0160-3060	8		CAPACITOR-FXD .1UF ±20% 25VDC CER	28480	0160-3060
A6C12	0160-3060	8		CAPACITOR-FXD .1UF ±20% 25VDC CER	28480	0160-3060
A6C13	0180-1714	7	1	CAPACITOR-FXD 330UF ±10% 6VDC TA	56289	150D337X9006S2
A6C14	0160-3878	6	2	CAPACITOR-FXD 1000PF ±20% 100VDC CER	28480	0160-3878
A6C15	0160-3878	6		CAPACITOR-FXD 1000PF ±20% 100VDC CER	28480	0160-3878
A6C16	0180-2746	7	3	CAPACITOR-FXD 330UF +100-10% 20VDC AL	00853	301EM331U020B
A6C17	0180-2746	7		CAPACITOR-FXD 330UF +100-10% 20VDC AL	00853	301EM331U020B
A6C18	0180-2746	7		CAPACITOR-FXD 330UF +100-10% 20VDC AL	00853	301EM331U020B
A6C19	0180-0210	6	2	CAPACITOR-FXD 3.3UF ±20% 15VDC TA	56289	150D335X0015A2
A6CR1	1901-1081	2	2	DIODE-PWR RECT 100V 3A	04713	MR501
A6CR2	1901-1081	2		DIODE-PWR RECT 100V 3A	04713	MR501
A6CR3	1901-0519	9	7	DIODE-SWITCHING 200V 50NS DO-34	28480	1901-0519
A6CR4	1901-0519	9		DIODE-SWITCHING 200V 50NS DO-34	28480	1901-0519
A6CR5	1906-0343	7	1	DIODE- FW BRIDGE 100V 6A VF	28480	1906-0343
A6CR6	1901-0519	9		DIODE-SWITCHING 200V 50NS DO-34	28480	1901-0519
A6CR7	1884-0201	8	1	THYRISTOR-SCR TO-92 VRRM=60	04713	2N5061
A6CR8	1901-0519	9		DIODE-SWITCHING 200V 50NS DO-34	28480	1901-0519
A6CR9	1901-0519	9		DIODE-SWITCHING 200V 50NS DO-34	28480	1901-0519
A6CR10	1901-0676	9	2	DIODE-SCHOTTKY 20V 5A	28480	1901-0676
A6CR11	1901-0676	9		DIODE-SCHOTTKY 20V 5A	28480	1901-0676
A6CR12	1901-0519	9		DIODE-SWITCHING 200V 50NS DO-34	28480	1901-0519
A6CR13	1901-0519	9		DIODE-SWITCHING 200V 50NS DO-34	28480	1901-0519
A6CR14	1884-0330	4	2	DIODE THYRISTOR TRIAC TO-220AB	28480	1884-0330
A6CR15	1884-0330	4		DIODE- THYRISTOR TRIAC TO 220AB	28480	1884-0330
A6CR16	1902-3035	3	3	DIODE-ZNR 3.16V 5% DO-7 PD=R2 TC=-.064%	28480	1902-3035
A6CR17	1902-3035	3		DIODE-ZNR 3.16V 5% DO-7 PD=R2 TC=-.064%	28480	1902-3035
A6CR18	1902-3035	3		DIODE-ZNR 3.16V 5% DO-7 PD=R2 TC=-.064%	28480	1902-3035
A6CR19	1902-0074	3	1	DIODE-ZNR 7.15V 5% DO-35 PD=.4W	28480	1902-0074
A6F1 - F4	2110-0446	5	4	FUSE 10A 125V NTD .281X.093	28480	2110-0446
A6L1 - L2	9110-3017	8	2	300MH AT 5 AMP DC	28480	9100-3017
A6MP1	0340-0797	4	4	INSULATOR-TRANSISTOR TO-220 ALUM	28480	0340-0797
A6MP2	0360-0124	3	13	CONNECTOR-SGL CONT	28480	0360-0124
A6Q1	1854-0574	5	2	TRANSISTOR NPN SI PD=500MW FT=125MHZ	28480	1854-0574
A6Q2	1853-0364	9	1	TRANSISTOR PNP SI PD=40W FT=1MHZ	04713	MUE-701
A6Q3	1854-0574	5		TRANSISTOR NPN SI PD=500MW FT=125MHZ	28480	1854-0574
A6Q4	1853-0336	5	3	TRANSISTOR PNP SI PD=625MW FT=50MHZ	04713	MPSA92
A6Q5	1853-0336	5		TRANSISTOR PNP SI PD=625MW FT=50MHZ	04713	MPSA92
A6Q6	1853-0336	5		TRANSISTOR PNP SI PD=625MW FT=50MHZ	04713	MPSA92
A6Q7	1854-0071	7	3	TRANSISTOR NPN SI PD=300MW FT=200MHZ	28480	1854-0071
A6Q8	1854-0071	7		TRANSISTOR NPN SI PD=300MW FT=200MHZ	28480	1854-0071
A6Q9	1853-0722	3	1	TRANSISTOR PNP SI TO-220AB PD=75W	28480	1853-0722
A6Q10	1853-1262	0	1	TRANSISTOR NPN SI TO-220AB PD=75W	28480	1854-1262
A6Q11	1854-0071	7		TRANSISTOR NPN SI PD=300MW FT=200MHZ	28480	1854-0071
A6R1	0683-5135	0	1	RESISTOR 51K 5% .25W FC TC=-400/+800	01121	CB5135
A6R2				NOT ASSIGNED		
A6R3	0683-5115	6	1	RESISTOR 510 5% .25W FC TC=-400/+700	01121	CB-5115
A6R4	0683-1125	0	1	RESISTOR 1.1K 5% .25W FC TC=-400/+700	01121	CB-1125
A6R5	0683-2025	1	1	RESISTOR 2K 5% .25W FC TC=-400/+700	01121	CB2025

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Table 6-2. Replaceable Parts for Standard Instruments without Options (Continued)

Reference Designation	HP Part Number	C D	Qty	Description	Mfr Code	Mfr Part Number
A6R6	0683-1025	9	4	RESISTOR 1K 5% .25W FC TC=-400/+600	01121	CB1025
A6R7	0811-1827	2	2	RESISTOR .1 10% 3W PW TC=0±90	28480	0811-1827
A6R8	0613-0050	5	1	RESISTOR 100 5% 3W PW TC=0±20	91637	CW2B1-3W-62-101-J
A6R9	0683-1035	1	3	RESISTOR 10K 5% .25W		
A6R10	0683-2035	3	1	RESISTOR 20K 5% .25W FC TC=-400/+800	01121	CB2035
A6R11	0683-1025	9		RESISTOR 1K 5% .25W FC TC=-400/+600	01121	CB1025
A6R12	0811-1827	2		RESISTOR .1 10% 3W PW TC=0±90	28480	0811-1827
A6R13	0683-1035	1		RESISTOR 10K 5% .25W		
A6R14	0683-1035	1		RESISTOR 10K 5% .25W		
A6R15	0683-1025	9		RESISTOR 1K 5% .25W FC TC=-400/+600	01121	CB1025
A6R16	0683-3015	1	2	RESISTOR 300 5% .25W FC TC=-400/+600	01121	CB3015
A6R17	0757-0917	3	1	RESISTOR 510 2% .125W F TC=0±100	24546	C4-1/8-TO-511-G
A6R18	0757-0439	4	2	RESISTOR 6.81K 1% .125W F TC=0±100	24546	C4-1/8-TO-6811-F
A6R19	2100-2497	9	2	RESISTOR-TRMR 2K 10% C TOP-ADJ 1-TRN	73138	82PR2K
A6R20	0757-0933	3	1	RESISTOR 2.4K 2% .125W F TC=0±100	24546	C4-1/8-TO-2401-G
A6R21	0683-1025	9		RESISTOR 1K 5% .25W FC TC=-400/+600	01121	CB1025
A6R22	0683-5105	4	1	RESISTOR 510 2% .25W FC TC=-400/+500	01121	CB5105
A6R23	0811-1732	8	1	RESISTOR 1 5% 3W PW TC=0±50	28480	0811-1732
A6R24	0683-3015	1		RESISTOR 300 5% .25W FC TC=-400/+600	01121	CB3015
A6R25	0683-3305	2	2	RESISTOR 33 5% .25W FC TC=-400/+500	01121	CB3305
A6R26	0683-1005	5	2	RESISTOR 10 5% .25W FC TC=-400/+500	01121	CB1005
A6R27	0757-0954	8	1	RESISTOR 18K 2% .125W F TC=0±100	24546	C4-1/8-TO-1802-G
A6R28	0757-0439	4		RESISTOR 6.81K 1% .125W F TC=0±100	24546	C4-1/8-TO-6811-F
A6R29	2100-2497	9		RESISTOR-TRMR 2K 10% C TOP-ADJ 1-TRN	73138	82PR2K
A6R30	0757-0934	4	1	RESISTOR 2.7K 2% .125W F TC=0±100	24546	C4-1/8-TO-2701-G
A6R31	0683-3305	2		RESISTOR 33 5% .25W FC TC=-400/+500	01121	CB3305
A6R32	0683-0275	9	1	RESISTOR 2.7 5% .25W FC TC=-400/+500	01121	CB27G5
A6R33	0757-0969	5	1	RESISTOR 75K 2% .125W F TC=0±100	24546	C4-1/8-TO-7502-G
A6R34	0811-1831	8	1	RESISTOR 2.5% 3W PW TC=0±50	28480	0811-1831
A6R35	0683-7525	6	1	RESISTOR 7.5K 5% .25W FC TC=-400/+700	01121	CB7525
A6R36	0757-0346	2	1	RESISTOR 10 1% .125W F TC=0±100	24546	C4-1/8-TO-10R0-F
A6R37	0683-1005	5		RESISTOR 10 5% .25W FC TC=-400/+500	01121	CB1005
A6S1	3103-0032	1	1	SWITCH-THRM FXD +194F 3A OPN-ON-RISE	28480	3103-0032
A6U1	1826-0032	1	1	IC 1463 V RGLTR TO-66	04713	MC1463R
A6U2	1826-0024	1	1	IC V RGLTR TO-66	04713	MC1469R
A6U3	1826-0122	0	1	IC 7805 V RGLTR TO-220	07263	7805UC
	3050-0100	1	1	WASHER, FL MTL NO. 6 .147-IN-ID	00000	ORDER BY DESCRIPTION

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* Indicates Factory-Selected Value

Table 6-2. Replaceable Parts for Standard Instruments without Options (Continued)

Reference Designation	HP Part Number	C D	Qty	Description	Mfr Code	Mfr Part Number
A7	05345-60007	5	1	LINEAR REGULATOR ASSEMBLY	28480	05345-60007
A7C1	0150-0012	3	2	CAP-FXD .01UF ±20% 1KVDC CER	56289	C023A102J103MS38
A7C2	0150-0012	3	2	CAP-FXD .01UF ±20% 1KVDC CER	56289	C023A102J103MS38
A7C3	0150-0084	9	2	CAP-FXD .1UF +80-20% 100VDC CER	28480	0150-0084
A7C4	0180-2472	6	1	CAPACITOR-FXD 1450UF +75-10% 35VDC AL	28480	0180-2472
A7C5	0160-0164	7	1	CAPACITOR-FXD .039UF ±10% 200VDC POLYE	28480	0160-0164
A7C6	0180-2470	4	4	CAPACITOR-FXD 2200UF +75-10% 30VDC AL	56289	601D228G030GS4
A7C7	0180-2470	4	4	CAPACITOR-FXD 2200UF +75-10% 30VDC AL	56289	601D228G030GS4
A7C8	0180-2470	4	4	CAPACITOR-FXD 2200UF +75-10% 30VDC AL	56289	601D228G030GS4
A7C9	0180-2470	4	4	CAPACITOR-FXD 2200UF +75-10% 30VDC AL	56289	601D228G030GS4
A7C10	0180-0155	8	1	CAPACITOR-FXD 2.2UF ±20% 20VDC TA	56289	150D225X0020A2
A7C11	0150-0050	9	2	CAPACITOR-FXD 1000PF +80-20% 1KVDC CER	28480	0150-0050
A7C12	0150-0050	9	2	CAPACITOR-FXD 1000PF +80-20% 1KVDC CER	28480	0150-0050
A7C13	0160-3878	6	2	CAPACITOR-FXD 1000PF ±20% 100VDC CER	28480	0160-3878
A7C14	0160-0161	4	1	CAPACITOR-FXD 0.01UF ±10% 200V POLYE-FL	56289	708D1CC103PK201AX
A7C15	0150-0084	9	2	CAP-FXD .1UF +80-20% 100VDC CER	28480	0150-0084
A7C16	0160-3878	6		CAPACITOR-FXD 1000PF ±20% 100VDC CER	28480	0160-3878
A7C17				NOT ASSIGNED		
A7C18	0160-3060	8	5	CAPACITOR-FXD .1UF ±20% 25VDC CER	28480	0160-3060
A7C19	0160-3060	8	5	CAPACITOR-FXD .1UF ±20% 25VDC CER	28480	0160-3060
A7C20	0180-0098	8	2	CAPACITOR-FXD 100UF ±20% 20VDC TA	56289	150D107X0020S2
A7C21	0180-4134	6	1	CAPACITOR-FXD 22UF ±10% 15VDC TA	56289	150D226X9015B2
A7C22	0180-0098	8		CAPACITOR-FXD 100UF ±20% 20VDC TA	56289	150D107X0020S2
A7C23	0160-3060	8		CAPACITOR-FXD .1UF ±20% 25VDC CER	28480	0160-3060
A7C24	0160-3060	8		CAPACITOR-FXD .1UF ±20% 25VDC CER	28480	0160-3060
A7C25	0180-0160	5	1	CAPACITOR-FXD 22UF ±20% 35VDC TA	56289	150D226X003R2
A7C26	0160-3060	8		CAPACITOR-FXD .1UF ±20% 25VDC CER	28480	0160-3060
A7C27 - C30				NOT ASSIGNED		
A7C31	0160-0161	4	1	CAPACITOR-FXD .01UF ±10% 200VDC POLYE	28480	0160-0161
A7CR1	1906-0096	7	1	DIODE-FW BRIDGE 200V 2A	04713	MDA202
A7CR2	1901-0638	3	1	DIODE-W BRIDGE 100V 4A	04713	MDA-970-2
A7CR3	1901-0050	3	7	DIODE-SWITCHING 80V 200MA 2NS DO-35	28480	1901-0050
A7CR4	1901-0050	3	7	DIODE-SWITCHING 80V 200MA 2NS DO-35	28480	1901-0050
A7CR5	1901-0050	3	7	DIODE-SWITCHING 80V 200MA 2NS DO-35	28480	1901-0050
A7CR6	1901-0050	3		DIODE-SWITCHING 80V 200MA 2NS DO-35	28480	1901-0050
A7CR7	1901-0028	5	1	DIODE-PWR RECT 400V 750MA DO-29	28480	1901-0028
A7CR8	1902-3171	7	1	DIODE-ZNR 11V 5% DO-35 PD= .4W TC=+.062%	28480	1902-3171
A7CR9	1902-0041	4	1	DIODE-ZNR 5.11V 5% DO-35 PD=.4W	28480	1902-0041
A7CR10	1901-0050	3		DIODE-SWITCHING 80V 200MA 2NS DO-35	28480	1901-0050
A7CR11	1901-0050	3		DIODE-SWITCHING 80V 200MA 2NS DO-35	28480	1901-0050
A7CR12	1901-0050	3		DIODE-SWITCHING 80V 200MA 2NS DO-35	28480	1901-0050
A7CR13	1901-0734	0	1	DIODE-PWR RECT 1N581830V 1A	04713	2N5818
A7F1 - F2	2110-0446	5	2	FUSE 10A 125V NTD .281X.093	28480	2110-0446
A7MP1	0340-0797	4	4	INSULATOR-TRANSISTOR, ALUMINUM	28480	0340-0797
A7MP2	0360-0124	3	4	CONNECTOR-SGL CONT PIN .04-IN-BSC-SZ RND	28480	0360-0124
A7MP3	0570-0025	8	2	SCREW-MACH 6-32 .5-IN-LG RD-HD SLT	00000	ORDER BY DESCRIPTION
A7MP5	0570-0130	6	4	SCREW-MACH 6-32 .375-IN-LG BDG-HD-SLT	00000	ORDER BY DESCRIPTION
A7MP6	05345-20103	8	1	HEAT SINK	28480	05345-20103
A7Q1	1854-0574	5	1	TRANSISTOR NPN SI PD=500MW FT=125MHZ	28480	1854-0574
A7Q2	1853-0364	9	1	TRANSISTOR PNP SI PE=40W FT=1MHZ	04713	MJE-701
A7Q3	1854-0071	7	3	TRANSISTOR NPN SI PD=300MW FT=200MHZ	28480	1854-0071
A7Q4	1854-0071	7	3	TRANSISTOR NPN SI PD=300MW FT=200MHZ	28480	1854-0071
A7Q5	1854-1262	0	1	TRANSISTOR NPN SI TO-220AB PD=75W	28480	1854-1262
A7Q6	1853-0365	0	1	TRANSISTOR PNP SI TO-220AB PD=90W	04713	MJE2901K
A7Q7	1854-0071	7		TRANSISTOR NPN SI PD=300MW FT=200MHZ	28480	1854-0071
A7Q8	1853-0314	9	1	TRANSISTOR PNP 2N2905A SI TO-39 PD=600MW	04713	2N2905A
A7R1	0683-3635	1	1	RESISTOR 36K 5% .25W FC TC=-400/+800	01121	CB3635
A7R2	0683-5125	8	2	RESISTOR 5.1K 5% .25W FC TC=-400/+700	01121	CB5125
A7R3	0583-3335	8	2	RESISTOR 33K 5% .25W FC TC=-400/+800	01121	CB3335
A7R4	0683-4715	0	1	RESISTOR 470 5% .25W FC TC=-400/+800	01121	CB-4715
A7R5	0683-5125	8	2	RESISTOR 5.1K 5% .25W FC TC=-400/+700	01121	CB5125

See Introduction To This Section For Ordering Information
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Table 6-2. Replaceable Parts for Standard Instruments without Options (Continued)

Reference Designation	HP Part Number	C D	Qty	Description	Mfr Code	Mfr Part Number
A7R6	0583-3035	5	2	RESISTOR 30K 5% .25W FC TC=-400/+800	01121	CB3035
A7R7	0583-3035	5		RESISTOR 30K 5% .25W FC TC=-400/+800	01121	CB3035
A7R8	0683-2425	5	2	RESISTOR 2.4K 5% .25W FC TC=-400/+700	01121	CB2425
A7R9	0683-2425	5		RESISTOR 2.4K 5% .25W FC TC=-400/+700	01121	CB2425
A7R10	0683-4725	2	1	RESISTOR 4.7K 5% .25W FC TC=-400/+700	01121	CB4725
A7R11	0683-6225	1	1	RESISTOR 6.2K 5% .25W FC TC=-400/+700	01121	CB6225
A7R12	0683-1535	6	1	RESISTOR 15K 5% .25W FC TC=-400/+800	01121	CB1535
A7R13	0683-2035	3	1	RESISTOR 20K 5% .25W FC TC=-400/+800	01121	CB-2035
A7R14	0747-0439	4	2	RESISTOR 6.81K 1% .125W F TC=0±100	24546	C4-1/8-TO-6811-F
A7R15	0747-0439	4		RESISTOR 6.81K 1% .125W F TC=0±100	24546	C4-1/8-TO-6811-F
A7R16	2100-2497	9	2	RESISTOR-TRMR 2K 10% C TOP-ADJ 1-TRN	73138	82PR2K
A7R17	2100-2497	9		RESISTOR-TRMR 2K 10% C TOP-ADJ 1-TRN	73138	82PR2K
A7R18	0698-5838	1	1	RESISTOR 5.6 5% .5W CC TC=0±412	01121	DB56G5
A7R19	0757-0956	0	2	RESISTOR 22K 2% .125W F TC=0±100	24546	C4-1/8-TO-2202-G
A7R20	0757-0956	0		RESISTOR 22K 2% .125W F TC=0±100	24546	C4-1/8-TO-2202-G
A7R21	0761-0057	1	1	RESISTOR 560 5% 1W MO TC=0±200	28480	0761-0057
A7R22	0683-1025	9	2	RESISTOR 1K 5% .25W FC TC=-400/+600	01121	CB1025
A7R23	0683-1025	9		RESISTOR 1K 5% .25W FC TC=-400/+600	01121	CB1025
A7R24	0757-0916	2	1	RESISTOR 470 2% .125W F TC=-400/+600	01121	CB1025
A7R25	0757-0941	3	1	RESISTOR 5.1K 2% .125W F TC=0±100	24546	C4-1/8-TO-5101-G
A7R26	0757-0899	0	1	RESISTOR 91 2% .125W F TC=0±100	24546	C4-1/8-TO-91R0-G
A7R27	0757-0924	2	1	RESISTOR 1K 2% .125W F TC=0±100	24546	C4-1/8-TO-1001-G
A7R28	0811-1849	8	2	RESISTOR .75 10% 5W PW TC=0±90	28480	0811-1849
A7R29	0811-1849	8		RESISTOR .75 10% 5W PW TC=0±90	28480	0811-1849
A7R30	0683-3335	8		RESISTOR 33K 5% .25W FC TC=-400/+800	01121	CB3335
A7R31	0683-2025	1	2	RESISTOR 2K 5% .25W FC TC=-400/+700	01121	CB2025
A7R32	0683-2025	1		RESISTOR 2K 5% .25W FC TC=-400/+700	01121	CB2025
A7S1	3103-0032	1	1	SWITCH-TRM FXD +194F 3A OPEN-ON-RISE	28480	3103-0032
A7U1	1826-0024	1	1	IC V REGULATOR TO-66	04713	MC1469R
A7U2	1826-0147	9	1	IC 7812V RGLTR TO-220	04713	MC7812CP
A7U3	1826-0147	9		IC 7812V RGLTR TO-220	04713	MC7812CP
A7U4	1826-0032	1	1	IC 1463 C RGLTR TO-66	04713	MC1463R
	0380-0019	7	2	SPACER RND. .116-ID	28480	0380-0019
	0380-0885	5	4	STANDOFF-RIVET-ON .156-IN-LG 4-40 THD	00000	ORDER BY DESCRIPTION
	1400-0482	3	2	CABLE TIE	28480	1400-0482
	2190-0005	0	2	WASHER-LOCK EXT 7. NO. 4 .116-ID	00000	ORDER BY DESCRIPTION
	2200-0109	8	2	SCREW-MACH 4-40 .438-IN-LG PAN-HD POZI	00000	ORDER BY DESCRIPTION
	2200-0113	4	2	SCREW-MACH 4-40 .625-IN-LG PAN-HD POZI	00000	ORDER BY DESCRIPTION
	2360-0203	1	1	SCREW 6-32 .625-IN-LG PAN-HD POZI	00000	ORDER BY DESCRIPTION
	2420-0001	5	1	NUT-HEX 6-32 .625-IN-LG PAN-HD POZI	00000	ORDER BY DESCRIPTION
	3050-0100	1	1	WASHER, FL MTLC NO. 6 .147-IN-ID	00000	ORDER BY DESCRIPTION

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Table 6-2. Replaceable Parts for Standard Instruments without Options (Continued)

Reference Designation	HP Part Number	C D	Qty	Description	Mfr Code	Mfr Part Number
A8	05345-60031	5	1	PLL MULTIPLE NOISE GENERATOR (SERIES 1744)	28480	05345-60031
A8C1	0160-3879	7	13	CAPACITOR-FXD .01UF ±20% 100VDC CER	28480	0160-3879
A8C2	0160-2929	9	7	CAPACITOR-FXD 68UF 10% 10V TA	72136	DM152D686X9010B2
A8C3	0140-0223	7	4	CAPACITOR-FXD 260PF ±1% 300VDC MICA	72136	DM15F261F0300WV1C
A8C4	0160-0945	2	5	CAPACITOR-FXD 910PF ±5% 100VDC MICA	28480	0160-0945
A8C5	0180-3074	5	3	CAPACITOR-FXD 15UF 20% 30V TA	72136	DM152D156X0030B2
A8C6				NOT ASSIGNED		
A8C7	0180-3074	5		CAPACITOR-FXD 15UF 20% 30V TA	72136	DM152D156X0030B2
A8C8	0180-1743	2	4	CAPACITOR-FXD .1UF ±10% 35VDC TA	56289	150D104X9035A2
A8C9	0160-3879	7		CAPACITOR-FXD .01UF ±20% 100VDC CER	28480	0160-3879
A8C10	0160-2199	2	3	CAPACITOR-FXD 30-F ±5% 300VDC MICA	28480	0160-2199
ABC11	0180-1743	2		CAPACITOR-FXD .1UF ±10% 35VDC TA	56289	150D104X9035A2
ABC12	0180-1743	2		CAPACITOR-FXD .1UF ±10% 35VDC TA	56289	150D104X9035A2
ABC13	0140-0202	2	4	CAPACITOR-FXD 15PF ±5% 500VDC MICA	72136	DM15C150J0500WV1CR
ABC14	0160-3879	7		CAPACITOR-FXD .01UF ±20% 100VDC CER	28480	0160-3879
ABC15	0160-3879	7		CAPACITOR-FXD .01UF ±20% 100VDC CER	28480	0160-3879
A8C16	0160-3879	7		CAPACITOR-FXD .01UF ±20% 100VDC CER	28480	0160-3879
A8C17	0140-0202	2		CAPACITOR-FXD 15PF ±5% 500VDC MICA	72136	DM15C150J0500WV1CR
A8C18	0160-2199	2		CAPACITOR-FXD 30-F ±5% 300VDC MICA	28480	0160-2199
A8C19	0160-0945	2		CAPACITOR-FXD 910PF ±5% 100VDC MICA	28480	0160-0945
A8C20	0180-1745	4	2	CAPACITOR-FXD 1.5UF ±10% 20VDC TA	56289	150D155X9020A2
A8C21	0180-0210	6	1	CAPACITOR-FXD 3.3UF ±20% 15VDC TA	56289	150D335X0015A2
A8C22	0160-3875	3	2	CAPACITOR-FXD 22PF ±5% 200VDC CER 0±30	28480	0160-3875
A8C23	0160-3875	3		CAPACITOR-FXD 22PF ±5% 200VDC CER 0±30	28480	0160-3875
A8C24	0180-0335	4	2	CAPACITOR-FXD 91PF ±1% 300VDC MICA 0+70	28480	0160-0335
A8C25	0140-0193	0	1	CAPACITOR-FXD 82PF ±5% 300VDC MICA	72136	DM15E820J0300WV1CR
A8C26	0160-0335	4		CAPACITOR-FXD 91PF ±1% 300VDC MICA 0+70	28480	0160-0335
A8C27	0160-3879	7		CAPACITOR-FXD .01UF ±20% 100VDC CER	28480	0160-3879
A8C28	0160-3879	7		CAPACITOR-FXD .01UF ±20% 100VDC CER	28480	0160-3879
A8C29	0121-0180	5	2	CAPACITOR-V TRMR CER 15-60PF 200V PC-MTG	52763	304324 15/60-F N1500
A8C30	0160-0362	7	2	CAPACITOR-FXD 510PF ±5% 300VDC MICA	28480	0160-0362
A8C31	0160-0362	7		CAPACITOR-FXD 510PF ±5% 300VDC MICA	28480	0160-0362
A8C32	0160-3879	7		CAPACITOR-FXD .01UF ±20% 100VDC CER	28480	0160-3879
A8C33	0140-0223	7		CAPACITOR-FXD 260PF ±1% 300VDC MICA	72136	DM15F261F0300WV1C
A8C34	0140-0223	7		CAPACITOR-FXD 260PF ±1% 300VDC MICA	72136	DM15F261F0300WV1C
A8C35	0160-3879	7		CAPACITOR-FXD .01UF ±20% 100VDC CER	28480	0160-3879
A8C36	0140-0223	7		CAPACITOR-FXD 260PF ±1% 300VDC MICA	72136	DM15F261F0300WV1C
A8C37	0140-0202	2		CAPACITOR-FXD 15PF ±5% 500VDC MICA	72136	DM15C150J0500WV1CR
A8C38	0160-3879	7		CAPACITOR-FXD .01UF ±20% 100VDC CER	28480	0160-3879
A8C39	0140-0214	6	1	CAPACITOR-FXD 60PF ±5% 300VDC MICA	72136	DM15E600J0300WV1CR
A8C40	0180-1745	4		CAPACITOR-FXD 1.5UF ±10% 20VDC TA	56289	150D155X9020A2
A8C41	0180-3074	5		CAPACITOR-FXD 15UF 20% 30V TA	72136	DM152D156X0030B2
A8C42	0160-2199	2		CAPACITOR-FXD 30PF ±5% 300VDC MICA	28480	0160-2199
A8C43	0121-0105	4	1	CAPACITOR-VTRMR CER 9-35PF 200V PC MTG	52763	304324 9/35PF N650
A8C44	0160-3879	7		CAPACITOR-FXD .01UF ±20% 100VDC CER	28480	0160-3879
A8C45	0180-0106	9	3	CAPACITOR-FXD 60UF ±20% 6VDC TA	56289	150D606X0006B2
A8C46	0140-0145	2	1	CAPACITOR-FXD 22PF ±5% 500VDC MICA	72136	DM15C220J0500WV1CR
A8C47	0160-3878	6	18	CAPACITOR-FXD 1000PF ±20% 100VDC CER	28480	0160-3878
A8C48	0180-1743	2		CAPACITOR-FXD .1UF ±10% 35VDC TA	56289	150D104X9035A2
A8C49	0180-0106	9		CAPACITOR-FXD 60UF ±20% 6VDC TA	56289	150D606X0006B2
A8C50	0160-2198	1	1	CAPACITOR-FXD 20PF ±5% 300VDC MICA	28480	0160-2198
A8C51	0180-0106	9		CAPACITOR-FXD 60UF ±20% 6VDC TA	56289	150D606X0006B2
A8C52	0121-0059	7	2	CAPACITOR-V TRMR CER 2-8PF 350V PC-MTG	52763	304324 2/8PF NPO
A8C53	0160-3878	6		CAPACITOR-FXD 1000PF ±20% 100VDC CER	28480	0160-3878
A8C54	0140-0209	9	1	CAPACITOR-FXD 5PF ±10% 500VDC MICA	72136	DM15C050K0800WV1CR
A8C55	0160-3878	6		CAPACITOR-FXD 1000PF ±20% 100VDC CER	28480	0160-3878
A8C56*	0140-0202	2		CAPACITOR-FXD 15PF ±5% 500VDC MICA	72136	DM15C150J0500WV1CR
A8C57	0121-0059	7		CAPACITOR-V TRMR CER 2-8PF 350V PC-MTG	52763	304324 2/8PF NPO
A8C58	0160-3878	6		CAPACITOR-FXD 1000PF ±20% 100VDC CER	28480	0160-3878
A8C59	0160-2241	5	2	CAPACITOR-FXD 2.2PF ±.25PF 500VDC CER	28480	0160-2241
A8C60	0160-2241	5		CAPACITOR-FXD 2.2PF ±.25PF 500VDC CER	28480	0160-2241

See Introduction To This Section For Ordering Information
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Table 6-2. Replaceable Parts for Standard Instruments without Options (Continued)

Reference Designation	HP Part Number	C D	Qty	Description	Mfr Code	Mfr Part Number
A8C61	0132-0007	8	2	CAPACITOR-V TRMR PSTN .7-3PF 350V	72982	535-033-4R
A8C62	0160-0945	2		CAPACITOR-FXD 910PF ±5% 100VDC MICA	28480	0160-0945
A8C63	0160-0945	2		CAPACITOR-FXD 910PF ±5% 100VDC MICA	28480	0160-0945
A8C64	0160-3878	6		CAPACITOR-FXD 1000PF ±20% 100VDC CER	28480	0160-3878
A8C65	0160-2235	7	1	CAPACITOR-FXD .75PF ±25PF 500VDC CER	28480	0160-2235
A8C66	0160-3872	3		CAPACITOR- 2.2PF ±10% 200VDC CER	28480	0160-3875
A8C67	0132-0007	8		CAPACITOR-FXD V TRMR PSTN .7-3PF 350V	72982	535-033-4R
A8C68	0121-0180	5		CAPACITOR-V TRMR PSTN 15-60PF 200V PC-MTG	52763	304324 15/60PF N1500
A8C69	0160-3879	7		CAPACITOR-FXD .01UF ±20% 100VDC CER	28480	0160-3879
A8C70	0160-3878	6		CAPACITOR-FXD 1000PF ±20% 100VDC CER	28480	0160-3878
A8C71 - C73	0160-3878	6		CAPACITOR-FXD 1000PF ±20% 100VDC CER	28480	0160-3878
A8C74	0160-0945	2		CAPACITOR-FXD 910PF ±5% 100VDC MICA	28480	0160-0945
A8C75	0160-3878	6		CAPACITOR-FXD 1000PF ±20% 100VDC CER	28480	0160-3878
A8C76 - C84	0160-3879	7		CAPACITOR-FXD .01UF ±20% 100VDC CER	28480	0160-3879
A8CR1	1901-0040	1	17	DIODE-SWITCHING 30V 50MA 2NS DO-35	28480	1901-0040
A8CR2	1902-3139	7	1	DIODE-ZNR 8.25V 5% DO-35 PD= .4W	28480	1901-3139
A8CR3	1901-0999	9	2	DIODE-SCHOTTKY 20V 10NS DO-35	28480	1901-0999
A8CR4	1901-0999	9		DIODE-SCHOTTKY 20V 10NS DO-35	28480	1901-0999
A8CR5 - CR11	1901-0040	1		DIODE-SWITCHING 30V 50MA 2NS DO-35	28480	1901-0040
A8CR12	0122-0221	7	1	DIODE-VVC 100PF 10% CR/C25-MIN=2 BVR=30V	28480	0122-0221
A8CR13	1901-0040	1		DIODE-SWITCHING 30V 50MA 2NS DO-35	28480	1901-0040
A8CR14	1902-0041	4	1	DIODE-ZNR 5.11V 5% DO-35 PD=.4W	28480	1902-0041
A8CR15-CR22	1901-0040	1		DIODE-SWITCHING 30V 50MA 2NS DO-35	28480	1901-0040
A8J1 - J3	1250-0836	2	3	CONNECTOR-RF SMC M PC 50-OHM	28480	1250-0836
A8L1 - L4	9100-1641	0	4	INDUCTOR-RF CH-MLD 240UH 5% .168DX.365LG	28480	9100-1641
A8L5	9100-2265	6	3	INDUCTOR-RF-CH-MLD 10UH 10% .105DX.26LG	28480	9100-2265
A8L6	9100-2261	2	1	INDUCTOR RF-CH-MLD 2.7UH 10% .105DX.26LG	28480	9100-2261
A8L7	9140-0158	6	5	INDUCTOR RF-CH-MLD 1UH 10% .105DX.26LG	28480	9140-0158
A8L8	9100-2265	6		INDUCTOR RF-CH-MLD 10UH 10% .105DX.26LG	28480	9100-2265
A8L9	9140-0158	6	5	INDUCTOR RF-CH-MLD 1UH 10% .105DX.26LG	28480	9140-0158
A8L10, L11	9100-2255	4	2	INDUCTOR RF-CH-MLD 4709NH 10% .105DX.26LG	28480	9100-2255
A8L12, L13	9140-0158	6		INDUCTOR RF-CH-MLD 1UH 10% .105DX.26LG	28480	9140-0158
A8L14, L15	9100-2247	4	2	INDUCTOR-RF-CH-MLD 100NH 10% .105DX.26LG	28480	9100-2247
A8L16 - L17				ETCHED ON PC BOARD		
A8L18	9100-0346	0	1	INDUCTOR RF-CH-MLD 50NH 20% .105DX .26LG	28480	9100-0346
A8L19	9140-0158	5		INDUCTOR RF-CH-MLD 1UH 10% .105DX.26LG	28480	9140-0158
A8L20	9100-2251	0	2	INDUCTOR RF-CH-MLD 220NH 10% .105DX.26LG	28480	9100-2251
A8L21				ETCHED ON PC BOARD		
A8L22	9100-2251	6		INDUCTOR RF-CH-MLD 1UH 10% .105DX.26LG	28480	9140-0158
A8L23				ETCHED ON PC BOARD		
A8L24	9100-2265	6		INDUCTOR RF-CH-MLD 10UH 10% .105DX.26LG	28480	9100-2265
A8MP1	1205-0011	0	1	HEAT SINK TO-5/TO-35-CS	28480	1205-0011
A8MP2	1205-0037	0	1	HEAT SINK TO-18-CS	28480	1205-0037
A8MP3				NOT ASSIGNED		
A8MP4, MP5	1480-0116	8	2	PIN-GRV .062-9N-DIA .25-IN-LG STL	28480	1480-0116
A8MP6 - MP9				NOT ASSIGNED		
A8MP10, MP11	5040-1464	3	2	EXTRACTOR, CARD	28480	5040-1464
A8Q1	1853-0036	2	7	TRANSISTOR PNP SI PD=310MW FT=250MHZ	28480	1853-0036
A8Q2	1854-0071	7	2	TRANSISTOR NPN SI PD=300MW FT=200MHZ	28480	1854-0071
A8Q3	1855-0062	8	1	TRANSISTOR J-FET N-CHAN D-MODE SI	28480	1855-0062
A8Q4 - Q6	1853-0036	2		TRANSISTOR PNP SI PD=310MW FT=250MHZ	28480	1853-0036
A8Q7	1853-0007	1		TRANSISTOR PNP SI TO-18 PD=360MW	28480	1853-0034
A8Q8, Q9	1854-0215	1	5	TRANSISTOR NPN SI PD=350MW FT=300MHZ	04713	2N3904
A8Q10	1855-0020	8	1	TRANSISTOR J-FET N-CHAN D-MODE TO-18 SI	28480	1855-0020
A8Q11	1854-0215	1		TRANSISTOR NPN SI PD=350MW FT=300MHZ	04713	2N3904
A8Q12 - Q14	1853-0036	2		TRANSISTOR PNP SI PD=310MW FT=250MHZ	28480	1853-0036
A8Q15	1854-0215	1		TRANSISTOR NPN SI PD=350MW FT=300MHZ	04713	2N3904
A8Q16	1854-0215	1		TRANSISTOR NPN SI PD=350MW FT=300MHZ	04713	2N3904
A8Q17	1854-0345	8	3	TRANSISTOR NPN 2N5179 SI TO-72 PD=200MW	04713	SN5179
A8Q18	1853-0020	4	2	TRANSISTOR PNP SI PD=300MW FT=150MHZ	28480	1853-0020
A8Q19	1854-0345	8		TRANSISTOR NPN 2N5179 SI TO-72 PD=200MW	04713	SN5179
A8Q20	1853-0020	4		TRANSISTOR PNP SI PD=300MW FT=150MHZ	28480	1853-0020

See Introduction To This Section For Ordering Information
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Table 6-2. Replaceable Parts for Standard Instruments without Options (Continued)

Reference Designation	HP Part Number	C D	Qty	Description	Mfr Code	Mfr Part Number
A8Q21	1854-0345	8		TRANSISTOR NPN 2N5179 SI TO-72 PD=200MW	04713	SN5179
A8Q22	1854-0071	7		TRANSISTOR NPN SI PD=300MW FT=200MHZ	28480	1854-0071
A8R1	0757-0924	2	18	RESISTOR 1K 2% .125W F TC=0±100	24546	C4-1/8-TO-1001-G
A8R2	0757-0924	2		RESISTOR 1K 2% .125W F TC=0±100	24546	C4-1/8-TO-1001-G
A8R3	0757-1065	4	1	RESISTOR 280 1% .5W TF TC=0±100	28480	0757-1065
A8R4	0757-0972	0	9	RESISTOR 100K 2% .125W F TC=0±100	24546	C4-1/8-TO-1002-G
A8R5	0757-0950	4	10	RESISTOR 12K 2% .125W F TC=0±10	24546	C4-1/8-TO-1202-G
A8R6	0767-0952	6	2	RESISTOR 15K 2% .125W F TC=0±100	24546	C4-1/8-TO-1502-G
A8R7	0757-0931	1	11	RESISTOR 2K 2% .125W F TC=0±100	24546	C4-1/8-TO-2001-G
A8R8*	0757-0948	0	4	RESISTOR 10K 2% .125W F TC=0±100	24546	CR-1/8-TO-1002-G
A8R9	0757-0924	2		RESISTOR 1K 2% .125W F TC=0±100	24546	C4-1/8-TO-1001-G
A8R10	0683-2045	5	2	RESISTOR 200K 5% .25W FC TC=800/+900	01121	CB2045
A8R11	0757-0924	2		RESISTOR 1K 2% .125W F TC=0±100	24546	C4-1/8-TO-1001-G
A8R12	0757-0924	2		RESISTOR 1K 2% .125W F TC=0±100	24546	C4-1/8-TO-1001-G
A8R13	0757-0972	0		RESISTOR 100K 2% .125W F TC=0±100	24546	C4-1/8-TO-1002-G
A8R14	0757-0964	0	3	RESISTOR 47K 2% .125W F TC=0±100	24546	C4-1/8-TO-4702-G
A8R15	0757-0941	3	6	RESISTOR 5.1K 2% .125W F TC=0±100	24546	C4-1/8L-TO-5101G
A8R16	0757-0941	3		RESISTOR 5.1K 2% .125W F TC=0±100	24546	C4-1/8L-TO-5101G
A8R17	1810-0030	6	1	NETWORK RESISTOR 8L-SIP 1.0K OHM X 7	28480	1810-0030
A8R18	0757-0964	0		RESISTOR 47K 2% .125W F TC=0±100	2446	C4-1/8-TO-4702-G
A8R19	0757-0972	0		RESISTOR 100K 2% .125W F TC=0±100	24546	C4-1/8-TO-1002-G
A8R20	0757-0924	2		RESISTOR 1K 2% .125W F TC=0±100	24546	C4-1/8-TO-1001-G
A8R21	0757-0924	2		RESISTOR 1K 2% .125W F TC=0±100	24546	C4-1/8-TO-1001-G
A8R22	0757-0900	4	6	RESISTOR 100 2% .125W F TC=0±100	24546	C4-1/8-TO-101-G
A8R23	0757-0948	0		RESISTOR 10K 2% .125W F TC=0±100	24546	CR-1/8-TO-1002-G
A8R24	0757-0972	0		RESISTOR 100K 2% .125W F TC=0±100	24546	C4-1/8-TO-1002-G
A8R25	0757-0924	2		RESISTOR 1K 2% .125W F TC=0±100	24546	C4-1/8-TO-1001-G
A8R26	0757-0924	2		RESISTOR 1K 2% .125W F TC=0±100	24546	C4-1/8-TO-1001-G
A8R27	0683-2745	2	1	RESISTOR 270K 5% .25W FC TC=800/+900	01121	CB2745
A8R28	0683-1655	1	3	RESISTOR 1.6M 5% .25W FC TC=900/+1100	01121	CB1655
A8R29	0757-0924	2		RESISTOR 1K 2% .125W F TC=0±100	24546	C4-1/8-TO-1001-G
A8R30	0757-0924	2		RESISTOR 1K 2% .125W F TC=0±100	24546	C4-1/8-TO-1001-G
A8R31	0757-0900	4		RESISTOR 100 2% .125W F TC=0±100	24546	C4-1/8-TO-101-G
A8R32	0757-0948	0		RESISTOR 10K 2% .125W F TC=0±100	24546	CR-1/8-TO-1002-G
A8R33	0683-1055	1		RESISTOR 10M 5% .25W FC TC=900/+1100	01121	CB1055
A8R34	0757-0900	4		RESISTOR 100 2% .125W F TC=0±100	24546	C4-1/8-TO-101-G
A8R35	0767-0952	6		RESISTOR 15K 2% .125W F TC=0±100	24546	C4-1/8-TO-1502-G
A8R36	0757-0935	5	3	RESISTOR 3K 2% .125W F TC=0±100	24546	C4-1/8-TO-3001-G
A8R37	0757-0968	4	2	RESISTOR 68K 2% .125W F TC=0±100	24546	C4-1/8-TO-6802-G
A8R38	0683-2045	5		RESISTOR 200K 5% .25W FC TC=800/+900	01121	CB2045
A8R39	0757-0893	4	2	RESISTOR 51 2% .125W F TC=0±100	24546	C4-1/8-TO-51R0-G
A8R40	0757-0972	0		RESISTOR 100K 2% .125W F TC=0±100	24546	C4-1/8-TO-1002-G
A8R41	0757-0965	1	5	RESISTOR 51K 2% .125W F TC=0±100	24546	C4-1/8-TO-5102-G
A8R42	0757-0924	2		RESISTOR 1K 2% .125W F TC=0±100	24546	C4-1/8-TO-1001-G
A8R43	0757-0924	2		RESISTOR 1K 2% .125W F TC=0±100	24546	C4-1/8-TO-1001-G
A8R44	0757-0972	0		RESISTOR 100K 2% .125W F TC=0±100	24546	C4-1/8-TO-1002-G
A8R45	0757-0948	0		RESISTOR 10K 2% .125W F TC=0±100	24546	CR-1/8-TO-1002-G
A8R46	0757-0931	1		RESISTOR 2K 2% .125W F TC=0±100	24546	C4-1/8-TO-2001-G
A8R47	0757-0909	3	3	RESISTOR 240 2% .125W F TC=0±100	24546	C4-1/8-TO-241-G
A8R48	0757-0909	3		RESISTOR 240 2% .125W F TC=0±100	24546	C4-1/8-TO-241-G
A8R49	0757-0972	0		RESISTOR 100K 2% .125W F TC=0±100	24546	C4-1/8-TO-1002-G
A8R50	0757-0965	1		RESISTOR 51K 2% .125W F TC=0±100	24546	C4-1/8-TO-5102-G
A8R51	0757-0941	3		RESISTOR 5.1K 2% .125W F TC=0±100	24546	C4-1/8-TO-5101-G
A8R52	0757-0941	3		RESISTOR 5.1K 2% .125W F TC=0±100	24546	C4-1/8-TO-5101-G
A8R53	0757-0941	3		RESISTOR 5.1K 2% .125W F TC=0±100	24546	C4-1/8-TO-5101-G
A8R54	0757-0970	8	1	RESISTOR 82K 2% .125W F TC=0±100	24546	C4-1/8L-TO-8202-G
A8R55	0683-1655	1		RESISTOR 1.6M 5% .25W FC TC=900/+1100	01121	CB1655
A8R56	0683-1655	1		RESISTOR 1.6M 5% .25W FC TC=900/+1100	01121	CB1655
A8R57	0757-0972	0		RESISTOR 100K 2% .125W F TC=0±100	24546	C4-1/8-TO-1002-G
A8R58	0757-0950	4		RESISTOR 12K 2% .125W F TC=0±10	24546	C4-1/8-TO-1202-G
A8R59	0757-0950	4		RESISTOR 12K 2% .125W F TC=0±10	24546	C4-1/8-TO-1202-G
A8R60	0757-0950	4		RESISTOR 12K 2% .125W F TC=0±10	24546	C4-1/8-TO-1202-G

See Introduction To This Section For Ordering Information
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Table 6-2. Replaceable Parts for Standard Instruments without Options (Continued)

Reference Designation	HP Part Number	C D	Qty	Description	Mfr Code	Mfr Part Number
A8R61	0683-2735	0	1	RESISTOR 27K 5% .125W FC TC=+400/+800	01121	CB2735
A8R62	0757-0931	1		RESISTOR 2K 2% .125W F TC=0±100	24546	C4-1/8-TO-2001-G
A8R63	0757-0950	4		RESISTOR 12K 2% .125W F TC=0±10	24546	C4-1/8-TO-1202-G
A8R64	0757-0914	0	3	RESISTOR 390 2% .125W F TC=0±100	24546	C4-1/8-TO-391-G
A8R65	0757-0950	4		RESISTOR 12K 2% .125W F TC=0±10	24546	C4-1/8-TO-1202-G
A8R66	0757-0972	0		RESISTOR 100K 2% .125W F TC=0±100	24546	C4-1/8-TO-1002-G
A8R67	0757-0900	4		RESISTOR 100 2% .125W F TC=0±100	24546	C4-1/8-TO-101-G
A8R68	0757-0950	4		RESISTOR 12K 2% .125W F TC=0±10	24546	C4-1/8-TO-1202-G
A8R69	0757-0950	4		RESISTOR 12K 2% .125W F TC=0±10	24546	C4-1/8-TO-1202-G
A8R70	0757-0931	1		RESISTOR 2K 2% .125W F TC=0±100	24546	C4-1/8-TO-2001-G
A8R71	0757-0924	2		RESISTOR 1K 2% .125W F TC=0±100	24546	C4-1/8-TO-1001-G
A8R72	0757-0950	4		RESISTOR 12K 2% .125W F TC=0±10	24546	C4-1/8-TO-1202-G
A8R73	0757-0964	0		RESISTOR 47K 2% .125W F TC=0±100	2446	C4-1/8-TO-4702-G
A8R74	0757-0924	2		RESISTOR 1K 2% .125W F TC=0±100	24546	C4-1/8-TO-1001-G
A8R75	0757-0900	4		RESISTOR 100 2% .125W F TC=0±100	24546	C4-1/8-TO-101-G
A8R76	0757-0941	3		RESISTOR 5.1K 2% .125W F TC=0±100	24546	C4-1/8-TO-5101-G
A8R77	0757-0965	1		RESISTOR 51K 2% .125W F TC=0±100	24546	C4-1/8-TO-5102-G
A8R78	0757-0950	4		RESISTOR 12K 2% .125W F TC=0±10	24546	C4-1/8-TO-1202-G
A8R79	0757-0931	1		RESISTOR 2K 2% .125W F TC=0±100	24546	C4-1/8-TO-2001-G
A8R80	0757-0924	2		RESISTOR 1K 2% .125W F TC=0±100	24546	C4-1/8-TO-1001-G
A8R81	2100-2521	0	2	RESISTOR-TRMR 2K 10% C SIDE-ADJ 1-TRN	30983	ET50X202
A8R82	0757-0916	2	2	RESISTOR 470 2% .125W F TC=0±100	24546	C4-1/8-TO-471-G
A8R83	0757-0893	4		RESISTOR 51 2% .125W F TC=0±100	24546	CR-1/8-TO-51R0-G
A8R84	0757-0935	5		RESISTOR 3K 2% .125W F TC=0±100	24546	C4-1/8-TO-3001-G
A8R85	0757-0931	1		RESISTOR 2K 2% .125W F TC=0±100	24546	C4-1/8-TO-2001-G
A8R86	0757-0916	2		RESISTOR 470 2% .125W F TC=0±100	24546	C4-1/8-TO-471-G
A8R87	0757-0941	3		RESISTOR 5.1K 2% .125W F TC=0±100	24546	C4-1/8-TO-5101-G
A8R88	0757-0968	4		RESISTOR 68K 2% .125W F TC=0±100	2446	C4-1/8-TO-6802-G
A8R89	0757-0924	2		RESISTOR 1K 2% .125W F TC=0±100	24546	C4-1/8-TO-1001-G
A8R90	0757-0900	4		RESISTOR 100 2% .125W F TC=0±100	24546	C4-1/8-TO-101-G
A8R91	0757-0904	8	2	RESISTOR 150 2% .125W F TC=0±100	24546	C4-1/8-TO-151-G
A8R92	0757-0931	1		RESISTOR 2K 2% .125W F TC=0±100	24546	C4-1/8-TO-2001-G
A8R93	0757-0909	3		RESISTOR 240 2% .125W F TC=0±100	24546	C4-1/8-TO-241-G
A8R94	0757-0935	5		RESISTOR 3K 2% .125W F TC=0±100	24546	C4-1/8-TO-3001-G
A8R95	0757-0914	0		RESISTOR 390 2% .125W F TC=0±100	24546	C4-1/8-TO-391-G
A8R96	0757-0941	3		RESISTOR 5.1K 2% .125W F TC=0±100	24546	C4-1/8-TO-5101-G
A8R97	0757-0965	1		RESISTOR 51K 2% .125W F TC=0±100	24546	C4-1/8-TO-5102-G
A8R98	0757-0931	1		RESISTOR 2K 2% .125W F TC=0±100	24546	C4-1/8-TO-2001-G
A8R99	2100-2521	0		RESISTOR-TRMR 2K 10% C SIDE-ADJ 1-TRN	30983	ET50X202
A8R100	0757-0924	2		RESISTOR 1K 2% .125W F TC=0±100	24546	C4-1/8-TO-1001-G
A8R101	0757-0911	7	1	RESISTOR 300 2% .125W F TC=0±100	24546	C4-1/8-TO-301-G
A8R102	0757-0914	0		RESISTOR 390 2% .125W F TC=0±100	24546	C4-1/8-TO-391-G
A8R103	0757-0904	8		RESISTOR 150 2% .125W F TC=0±100	24546	C4-1/8-TO-151-G
A8R104	0757-0931	1		RESISTOR 2K 2% .125W F TC=0±100	24546	C4-1/8-TO-2001-G
A8R105	0757-0931	1		RESISTOR 2K 2% .125W F TC=0±100	24546	C4-1/8-TO-2001-G
A8R106	0757-0931	1		RESISTOR 2K 2% .125W F TC=0±100	24546	C4-1/8-TO-2001-G
A8R107	0757-0965	1		RESISTOR 51K 2% .125W F TC=0±100	24546	C4-1/8-TO-5102-G
A8TP1 - TP16	0360-1682	0	15	TERMINAL-STUD SGL-TUR PRESS-MTG	28480	0360-1682
A8TP16 - TP20	1251-2259	9	11	CONNECTOR, PC EDGE 18-CONT/ROW 2-ROWS	28480	1251-2259
A8U1	1820-0306	0	3	IC DIFF AMPL TO-99 PKG	DL585	CA3028A
A8U2	1820-0802	1	1	IC GATE ECL NOR QUAD 2-INP	04713	MC10102-
A8U3	1820-0306	0		IC DIFF AMPL TO-99 -KG	3L585	CA3028A
A8U4	1820-0477	6	3	IC OP AMP GP 8-DIP-P PKG	20545	UPC301AC
A8U5	1820-0306	0		IC DIFF AMPL TO-99 PKG	DL585	CA3028A
A8U6, U7	1858-0004	4	2	TRANSISTOR ARRAY 12-PIN MET TO-101	3L585	CA3049
A8U8	1820-0477	6		IC OP AMP GP 8-DIP-P PKG	20545	UPC301AC
A8U9	1820-0477	6		IC OP AMP GP 8-DIP-P PKG	20545	UPC301AC
	0380-1489		1	SPACER, SNAP-IN .375-LG .280-OD NYLON	00000	ORDER BY DESCRIPTION

See Introduction To This Section For Ordering Information
* Indicates Factory-Selected Value

Table 6-2. Replaceable Parts for Standard Instruments without Options (Continued)

Reference Designation	HP Part Number	C D	Qty	Description	Mfr Code	Mfr Part Number
A9	05345-60099	5	1	MAIN GATE ASSEMBLY	28480	05345-60099
A9C1	0160-3060	8	1	CAPACITOR-FXD .1UF ±20% 25VDC CER	28480	0160-3060
A9C2	0180-1714	7	1	CAPACITOR-FXD 330UF ±10% 6VDC TA	56289	150D337X9006S2
A9C3	0180-1702	3	1	CAPACITOR-FXD 180UF ±20% 6VDC TA	56289	150D187X0006R2
A9C4	0160-3875	3	1	CAPACITOR-FXD 22PF ±5% 200VDC CER 0±30	28480	0160-3875
A9C5	0160-3879	7	22	CAPACITOR-FXD .01UF ±20% 100VDC CER	28480	0160-3879
A9C6	0160-3879	7		CAPACITOR-FXD .01UF ±20% 100VDC CER	28480	0160-3879
A9C7	0160-3879	7		CAPACITOR-FXD .01UF ±20% 100VDC CER	28480	0160-3879
A9C8	0160-3879	7		CAPACITOR-FXD .01UF ±20% 100VDC CER	28480	0160-3879
A9C9	0150-0050	9	9	CAPACITOR-FXD 1000PF +80-20% 1KVDC CER	28480	0150-0050
A9C10	0150-0050	9		CAPACITOR-FXD 1000PF +80-20% 1KVDC CER	28480	0150-0050
A9C11	0150-0050	9		CAPACITOR-FXD 1000PF +80-20% 1KVDC CER	28480	0150-0050
A9C12	0160-3879	7		CAPACITOR-FXD .01UF ±20% 100VDC CER	28480	0160-3879
A9C13	0160-3879	7		CAPACITOR-FXD .01UF ±20% 100VDC CER	28480	0160-3879
A9C14	0160-3879	7		CAPACITOR-FXD .01UF ±20% 100VDC CER	28480	0160-3879
A9C15	0150-0050	9		CAPACITOR-FXD 1000PF +80-20% 1KVDC CER	28480	0150-0050
A9C16	0150-0050	9		CAPACITOR-FXD 1000PF +80-20% 1KVDC CER	28480	0150-0050
A9C17 - C20	0160-3879	7		CAPACITOR-FXD .01UF ±20% 100VDC CER	28480	0160-3879
A9C22	0150-0050	9		CAPACITOR-FXD 1000PF +80-20% 1KVDC CER	28480	0150-0050
A9C23	0160-3879	7		CAPACITOR-FXD .01UF ±20% 100VDC CER	28480	0160-3879
A9C24	0160-3879	7		CAPACITOR-FXD .01UF ±20% 100VDC CER	28480	0160-3879
A9C25*	0160-3874	2	1	CAPACITOR-FXD 10UF ±5% 200WVDC	28480	0160-3874
A9C26				NOT ASSIGNED		
A9C27	0150-0050	9		CAPACITOR-FXD 1000PF +80-20% 1KVDC CER	28480	0150-0050
A9C28	0160-3879	7		CAPACITOR-FXD .01UF ±20% 100VDC CER	28480	0160-3879
A9C29	0160-3879	7		CAPACITOR-FXD .01UF ±20% 100VDC CER	28480	0160-3879
A9C30	0160-3879	7		CAPACITOR-FXD .01UF ±20% 100VDC CER	28480	0160-3879
A9C31	0160-3879	7		CAPACITOR-FXD .01UF ±20% 100VDC CER	28480	0160-3879
A9C32	0160-3879	7		CAPACITOR-FXD .01UF ±20% 100VDC CER	28480	0160-3879
A9C33				NOT ASSIGNED		
A9C34	0160-3879	7		CAPACITOR-FXD .01UF ±20% 100VDC CER	28480	0160-3879
A9C35	0160-3879	7		CAPACITOR-FXD .01UF ±20% 100VDC CER	28480	0160-3879
A9C36	0150-0050	9		CAPACITOR-FXD 1000PF +80-20% 1KVDC CER	28480	0150-0050
A9C37	0160-3879	7		CAPACITOR-FXD .01UF ±20% 100VDC CER	28480	0160-3879
A9C38	0160-3879	7		CAPACITOR-FXD .01UF ±20% 100VDC CER	28480	0160-3879
A9CR1	1901-0040	1	4	DIODE-SWITCHING 30V 50MA 2NS DO-35	28480	1901-0040
A9CR2	1902-3002	3	1	DIODE-ZNR 2.37V 5% DO-7 PD=4W TC=-0.74%	28480	1902-3002
A9CR3	1901-0040	1		DIODE-SWITCHING 30V 50MA 2NS DO-35	28480	1901-0040
A9CR4	1901-0040	1		DIODE-SWITCHING 30V 50MA 2NS DO-35	28480	1901-0040
A9CR5	1901-0040	1		DIODE-SWITCHING 30V 50MA 2NS DO-35	28480	1901-0040
A9L1	9100-1636	3	1	INDUCTOR RF-CH-MLD 110UH 5% .166DX .385LG	28480	9100-1636
A9L2	9100-0346	0		INDUCTOR RF-CH-MOD 50NHX 20% .105DX.26LG	28480	9100-0346
A9L3	9100-1788	6	1	CHOKE-WIDEBAND IMP>680 OHMS	28480	9100-1788
A9Q1 - Q7	1854-0071	7	12	TRANSISTOR NPN SI PD=300MW FT=200MHZ	28480	1854-0071
A9Q8	1853-0020	4	2	TRANSISTOR PNP SI PD=300MW FT=150MHZ	28480	1853-0020
A9Q9	1854-0071	7		TRANSISTOR NPN SI PD=300MW FT=200MHZ	28480	1854-0071
A9Q10	1853-0020	4		TRANSISTOR PNP SI PD=300MW FT=150MHZ	28480	1853-0020
A9Q11 - Q12	1854-0345	8	2	TRANSISTOR NPN SN5179 SI TO-72 PD=200MW	04713	2N5179
A9Q13 - Q14	1854-0092	2	2	TRANSISTOR NPN SI PD=200MW FT=600MHZ	28480	1854-0092
A9Q15-- Q18	1854-0071	7		TRANSISTOR NPN SI PD=300MW FT=200MHZ	28480	1854-0071
A9R1, R2				NOT ASSIGNED		
A9R3	0757-0931			RESISTOR 2K 2% .125W F TC=0±100	24546	C4-1/8-TO-2001-G
A9R4	0757-0922	0	2	RESISTOR 820 2% .125W F TC=0±100	24546	C4-1/8-TO-821-G
A9R5				NOT ASSIGNED		
A9R6	0757-0931			RESISTOR 2K 2% .125W F TC=0±100	24546	C4-1/8-TO-2001-G
A9R7				NOT ASSIGNED		
A9R8	0757-0922	0		RESISTOR 820 2% .125W F TC=0±100	24546	C4-1/8-TO-821-G
A9R9 - R14	0698-3969	5	22	RESISTOR 51 2% .125W F TC=0±100	28480	0698-3969
A9R15 - R19	0698-7205	0	9	RESISTOR 51.1 1% .05W F TC=0±100	24546	C3-1/8-TO-51R1-F
A9R20	0698-3969	5		RESISTOR 51 2% .125W F TC=0±100	28480	0698-3969

See Introduction To This Section For Ordering Information
* Indicates Factory-Selected Value

Table 6-2. Replaceable Parts for Standard Instruments without Options (Continued)

Reference Designation	HP Part Number	C D	Qty	Description	Mfr Code	Mfr Part Number
A9R21	0683-1015	7	5	RESISTOR 100 5% .25W FC TC=-400/+500	01121	CB1015
A9R22	0683-1015	7		RESISTOR 100 5% .25W FC TC=-400/+500	01121	CB1015
A9R23	0757-0394	0	12	RESISTOR 51.1 1% .125W F TC=0±100	24546	C4-1/8-TO-51R1-F
A9R24	0757-0394	0		RESISTOR 51.1 1% .125W F TC=0±100	24546	C4-1/8-TO-51R1-F
A9R25	0757-0394	0		RESISTOR 51.1 1% .125W F TC=0±100	24546	C4-1/8-TO-51R1-F
A9R26	0698-3969	5		RESISTOR 51 2% .125W F TC=0±100	28480	0698-3969
A9R27	0757-0912	8	4	RESISTOR 330 2% .125W F TC=0±100	24546	C4-1/8-TO-331-G
A9R28	0757-0927	5	2	RESISTOR 1.3K 2% .125W F TC=0±100	24546	4-1/8-TO-1301-G
A9R29, R30				NOT ASSIGNED		
A9R31	0698-3969	5		RESISTOR 51 2% .125W F TC=0±100	28480	0698-3969
A9R32	0698-3969	5		RESISTOR 51 2% .125W F TC=0±100	28480	0698-3969
A9R33	0757-0912	8		RESISTOR 330 2% .125W F TC=0±100	24546	C4-1/8-TO-331-G
A9R34	0698-3969	5		RESISTOR 51 2% .125W F TC=0±100	28480	0698-3969
A9R35	0698-3969	5		RESISTOR 51 2% .125W F TC=0±100	28480	0698-3969
A9R36	0757-0919	5	3	RESISTOR 620 2% .125W F TC=0±100	24546	C4-1/8-TO-621-G
A9R37	0757-1094	9	3	RESISTOR 1.47K 1% .125W F TC=0±100	24546	C4-1/8-TO-1471-F
A9R38	0757-0927	5		RESISTOR 1.3K 2% .125W F TC=0±100	24546	4-1/8-TO-1301-G
A9R39	0683-1025	9	6	RESISTOR 1K 5% .25W FC TC=-400/+600	01121	CB1025
A9R40	0757-1094	9		RESISTOR 1.47K 1% .125W F TC=0±100	24546	C4-1/8-TO-1471-F
A9R41	0698-3969	5		RESISTOR 51 2% .125W F TC=0±100	28480	0698-3969
A9R42	0683-1015	7		RESISTOR 100 5% .25W FC TC=-400/+500	01121	CB1015
A9R43	0757-0917	3	1	RESISTOR 510 2% .125W F TC=0±100	24546	C4-1/8-TO-511-G
A9R44	0698-3969	5		RESISTOR 51 2% .125W F TC=0±100	28480	0698-3969
A9R45	0757-0912	8		RESISTOR 330 2% .125W F TC=0±100	24546	C4-1/8-TO-331-G
A9R46	0683-1025	9		RESISTOR 1K 5% .25W FC TC=-400/+600	01121	CB1025
A9R47	0757-0903	7	2	RESISTOR 130 2% .125W F TC=0±100	24546	C4-1/8-TO-131-G
A9R48	0757-1094	9		RESISTOR 1.47K 1% .125W F TC=0±100	24546	C4-1/8-TO-1471-F
A9R49	0757-0394	0		RESISTOR 51.1 1% .125W F TC=0±100	24546	C4-1/8-TO-51R1-F
A9R50	0757-0823	0	2	RESISTOR 1.82K 1% .5W F TC=0±100	28480	0757-0823
A9R51	0757-0823	0		RESISTOR 1.82K 1% .5W F TC=0±100	28480	0757-0823
A9R52	0757-0903	7		RESISTOR 130 2% .125W F TC=0±100	24546	C4-1/8-TO-131-G
A9R53	0698-3969	5		RESISTOR 51 2% .125W F TC=0±100	28480	0698-3969
A9R54 - R55				NOT ASSIGNED		
A9R56 - R57				NOT ASSIGNED		
A9R58	0757-0394	0		RESISTOR 51.1 1% .125W F TC=0±100	24546	C4-1/8-TO-51R1-F
A9R59	0757-0912	8		RESISTOR 330 2% .125W F TC=0±100	24546	C4-1/8-TO-331-G
A9R60	0698-3969	5		RESISTOR 51 2% .125W F TC=0±100	28480	0698-3969
A9R61	0698-3969	5		RESISTOR 51 2% .125W F TC=0±100	28480	0698-3969
A9R62	0757-0898	9	1	RESISTOR 82 2% .125W F TC=0±100	24546	C4-1/8-TO-82R0-G
A9R63	0757-0394	0		RESISTOR 51.1 1% .125W F TC=0±100	24546	C4-1/8-TO-51R1-F
A9R64	0698-3969	5		RESISTOR 51 2% .125W F TC=0±100	28480	0698-3969
A9R65	0757-0394	0		RESISTOR 51.1 1% .125W F TC=0±100	24546	C4-1/8-TO-51R1-F
A9R66	0757-0394	0		RESISTOR 51.1 1% .125W F TC=0±100	24546	C4-1/8-TO-51R1-F
A9R67				NOT ASSIGNED		
A9R68	0698-3969	5		RESISTOR 51 2% .125W F TC=0±100	28480	0698-3969
A9R69	0757-0394	0		RESISTOR 51.1 1% .125W F TC=0±100	24546	C4-1/8-TO-51R1-F
A9R70				NOT ASSIGNED		
A9R71	0698-3378	0	20	RESISTOR 51 5% .125W CC TC=-270/+540	01121	BB5105
A9R72				NOT ASSIGNED		
A9R73	0698-3969	5		RESISTOR 51 2% .125W F TC=0±100	28480	0698-3969
A9R74	0698-3969	5		RESISTOR 51 2% .125W F TC=0±100	28480	0698-3969
A9R75	0698-3378	0		RESISTOR 51 5% .125W CC TC=-270/+540	01121	BB5105
A9R76	0683-5115	6		RESISTOR 510 5% .25W FC TC=-400/+600	01121	CB5115
A9R77	0683-1505	0	2	RESISTOR 15 5% .25W FC TC=-400/+500	01121	CB1505
A9R78	0757-0919	5		RESISTOR 620 2% .125W F TC=0±100	24546	C4-1/8L-TO-621-G
A9R79	0757-0394	0		RESISTOR 51.1 1% .125W F TC=0±100	24546	C4-1/8-TO-51R1-F
A9R80				NOT ASSIGNED		
A9R81	0683-5115	6		RESISTOR 510 5% .25W FC TC=-400/+600	01121	CB5115
A9R82	0757-0394	0		RESISTOR 51.1 1% .125W F TC=0±100	24546	C4-1/8-TO-51R1-F
A9R83	0757-0394	0		RESISTOR 51.1 1% .125W F TC=0±100	24546	C4-1/8-TO-51R1-F
A9R84	0683-1505	0		RESISTOR 15 5% .25W FC TC=-400/+500	01121	CB1505
A9R85	0757-0919	5		RESISTOR 620 2% .125W F TC=0±100	24546	C4-1/8L-TO-621-G

See Introduction To This Section For Ordering Information
* Indicates Factory-Selected Value

Table 6-2. Replaceable Parts for Standard Instruments without Options (Continued)

Reference Designation	HP Part Number	C D	Qty	Description	Mfr Code	Mfr Part Number
A9R86	0683-2015	9	3	RESISTOR 200 5% .25W FC TC=-400/+600	01121	CB2015
A9R87	0683-2015	9		RESISTOR 200 5% .25W FC TC=-400/+600	01121	CB2015
A9R88 - R92	0683-5115	6		RESISTOR 510 5% .25W FC TC=-400/+600	01121	CB5115
A9R93	0698-3378	0		RESISTOR 51 5% .125W CC TC=-470/+540	01121	BB5105
A9R94	0683-5115	6		RESISTOR 510 5% .25W FC TC=-400/+600	01121	CB5115
A9R95	0683-5115	6		RESISTOR 510 5% .25W FC TC=-400/+600	01121	CB5115
A9R96	0683-5115	6		RESISTOR 510 5% .25W FC TC=-400/+600	01121	CB5115
A9R97	0683-2015	9		RESISTOR 200 5% .25W FC TC=-400/+600	01121	CB2015
A9R98	0757-0900	4	2	RESISTOR 100 2% .125W F TC=0±100	24546	C4-1/8-TO-101-G
A9R99	0757-0900	4		RESISTOR 100 2% .125W F TC=0±100	24546	C4-1/8-TO-101-G
A9R100	0683-1015	7		RESISTOR 100 5% .25W FC TC=-400/+500	01121	CB1015
A9R101	0683-1015	7		RESISTOR 100 5% .25W FC TC=-400/+500	01121	CB1015
A9R102 - R105	0683-1025	9		RESISTOR 1K 5% .25W FC TC=-400/+600	01121	CB1025
A9R106 - R109	0698-7205	0		RESISTOR 51.1 1% .05W F TC=0±100	24546	C3-1/8-TO-51R1-F
A9R110	0698-3378	0		RESISTOR 51 5% .125W CC TC=-470/+540	01121	BB5105
A9R111 - R115	0698-3378	0		RESISTOR 51 5% .125W CC TC=-470/+540	01121	BB5105
A9R116	0698-3378	0		RESISTOR 51 5% .125W CC TC=-470/+540	01121	BB5105
A9R117 - R119				NOT ASSIGNED		
A9R120	0698-3378	0		RESISTOR 51 5% .125W CC TC=-470/+540	01121	BB5105
A9R121	0757-0394	0	1	RESISTOR 51.1 1% .125W TC=0±100	28480	0757-0394
A9R122 - R124				NOT ASSIGNED		
A9R125	0698-3969	5		RESISTOR 51 2% .125W F TC=0±100	28480	0698-3969
A9R126	0698-3378	0		RESISTOR 51 5% .125W CC TC=-470/+540	01121	BB5105
A9R127	0698-3969	5		RESISTOR 51 2% .125W F TC=0±100	28480	0698-3969
A9R128	0698-3378	0		RESISTOR 51 5% .125W CC TC=-470/+540	01121	BB5105
A9R129	0698-3378	0		RESISTOR 51 5% .125W CC TC=-470/+540	01121	BB5105
A9R130	0698-3378	0		RESISTOR 51 5% .125W CC TC=-470/+540	01121	BB5105
A9R131	0698-3378	0		RESISTOR 51 5% .125W CC TC=-470/+540	01121	BB5105
A9R132	0698-3378	0		RESISTOR 51 5% .125W CC TC=-470/+540	01121	BB5105
A9R133	0698-6000	1	3	RESISTOR 2.7K 5% .125W CC TC=-350/+857	01121	BB2725
A9R134	0698-6000	1		RESISTOR 2.7K 5% .125W CC TC=-350/+857	01121	BB2725
A9R135	0698-6000	1		RESISTOR 2.7K 5% .125W CC TC=-350/+857	01121	BB2725
A9R136	0757-0994	4		RESISTOR 2.7K 2% .125W F TC=0±100	24546	C4-1/8-TO-2701-G
A9U1	5088-7082	3	7	IC EECC D3-1 GATE	28480	5088-7082
A9U2	5088-7081	2	4	IC EECL 3-IN MUX	28480	5088-7081
A9U3	1DC9-0001	9	2	IC-DIGITAL BI-QUIN ECL COUNTER	28480	1DC9-0001
A9U4	5088-7081	2		IC EECL 3-IN MUX	28480	5088-7081
A9U5	5088-7081	2		IC EECL 3-IN MUX	28480	5088-7081
A9U6	5088-7082	3		IC EECC D3-1 GATE	28480	5088-7082
A9U7	5088-7081	2		IC EECL 3-IN MUX	28480	5088-7081
A9U8	5088-7080	1	5	IC B196D-0100 FF	28480	5088-7080
A9U9	1DC9-0001	9	2	IC-DIGITAL BI-QUIN ECL COUNTER	28480	1DC9-0001
A9U10	5088-7080	1		IC B196D-0100 FF	28480	5088-7080
A9U11	5088-7080	1		IC B196D-0100 FF	28480	5088-7080
A9U12	5088-7082	3		IC EECC D3-1 GATE	28480	5088-7082
A9U13	5088-7080	1		IC B196D-0100 FF	28480	5088-7080
A9U14	5088-7080	1		IC B196D-0100 FF	28480	5088-7080
A9U15	5088-7080	1		IC B196D-0100 FF	28480	5088-7080
A9Z1	9100-1788	6		CORE-FERRITE CHOKE-WIDEBAND; IMP;>680	28480	9100-1788
	5000-9043	6	1	PIN, PC BOARD EXTRACTOR	28480	5000-9043
	5040-6843	2	1	EXTRACTOR, PC BOARD	28480	5043-6843
	0360-0124	3	18	CONNECTOR, SGL CONT PIN .04-IN-BSC-SZ RND	28480	0360-0124
	0380-0306	5	1	STANDOFF RIVET-ON .562-IN-LG .152-IN ID	00000	ORDER BY DESCRIPTION
	1250-0836	2	2	CONNECTOR-RF SMC M PC 50-OHM	28480	1250-0836

See Introduction To This Section For Ordering Information
* Indicates Factory-Selected Value

Table 6-2. Replaceable Parts for Standard Instruments without Options (Continued)

Reference Designation	HP Part Number	C D	Qty	Description	Mfr Code	Mfr Part Number
A10	05345-60050	8	1	GATE CONTROL ASSEMBLY	28480	05345-60050
A10C1 - C3	0160-3879	7	5	CAPACITOR-FXD .01UF ±20% 100VDC CER	28480	0160-3879
A10C4	0160-3878	6	2	CAPACITOR-FXD 1000PF ±20% 100VDC CER	28480	0160-3878
A10C5	0150-0122	6	1	CAPACITOR-FXD 2000PF ±20% 500VDC CER	28480	0150-0122
A10C6	0160-3878	6		CAPACITOR-FXD 1000PF ±20% 100VDC CER	28480	0160-3878
A10C7	0160-2198	1	1	CAPACITOR-FXD 20PF ±5% 300VDC MICA	28480	0160-2198
A10C8	0160-0945	2	1	CAPACITOR-FXD 910PF ±5% 100VDC MICA	28480	0160-0945
A10C9	0160-3876	4	1	CAPACITOR-FXD 47PF ±20% 200VDC CER	28480	0160-3876
A10C10	0180-3074	1	1	CAPACITOR-FXD 15UF ±20% 30VDC TA	56289	1500156X9020B2
A10C11 - C12	0160-3879	7	1	CAPACITOR-FXD .01UF ±20% 100VDC CER	28480	0160-3879
A1C13	0160-3789	8	1	CAPACITOR-FXD .01UF ±20% 50VDC CER	28480	0160-3789
A10CR1 - CR4	1901-0040	1	4	DIODE-SWITCHING 30V 50MA 2NS DO-35	28480	1901-0040
A10CR5	1901-0535	9	12	DIODE-SM SIG SCHOTTKY	28480	1901-0535
A10CR6	1901-0028	5		DIODE-PWR RECT 400V 750MA DO-29	28480	1901-0028
A10CR7, CR8	1901-0535	9		DIODE-SM SIG SCHOTTKY	28480	1901-0535
A10Q1 - Q6	1854-0071	7	10	TRANSISTOR NPN SI PD=300MW FT=200MHZ	28480	1854-0071
A10Q7	1853-0015	7	7	TRANSISTOR PNP SI PD=200MW FT=500MHZ	28480	1853-0015
A10Q8 - Q11	1854-0071	7		TRANSISTOR NPN SI PD=300MW FT=200MHZ	28480	1854-0071
A10Q12	1853-0015	7		TRANSISTOR PNP SI PD=200MW FT=500MHZ	28480	1853-0015
A10Q13	1854-0092	2		TRANSISTOR NPN SI PD=200MW FT=600MHZ	28480	1854-0092
A10Q14	1854-0092	2		TRANSISTOR NPN SI PD=200MW FT=600MHZ	28480	1854-0092
A10Q15 - Q19	1853-0015	7		TRANSISTOR PNP SI PD=200MW FT=500MHZ	28480	1853-0015
A10Q20	1854-0009	1	1	TRANSISTOR NPN SI PD=300MW FT=600MHZ	04713	2N709
A10R1	1810-0041	9	1	NETWORK RESISTOR 9-SIP 2.7K OHM X 8	28480	1810-0041
A10R2	0683-1035	1	15	RESISTOR 10K 5% .25W FC TC=-400/+700	01121	CB1035
A10R3	0683-1035	1		RESISTOR 10K 5% .25W FC TC=-400/+700	01121	CB1035
A10R4	0683-1025	9		RESISTOR 1K 5% .25W FC TC=-400/+600	01121	CB-1025
A10R5	0683-1025	9	2	RESISTOR 1K 5% .25W FC TC=-400/+600	01121	CB-1025
A10R6	0683-1035	1		RESISTOR 10K 5% .25W FC TC=-400/+700	01121	CB1035
A10R7	0683-1035	1		RESISTOR 10K 5% .25W FC TC=-400/+700	01121	CB1035
A10R8	0757-0407	6	5	RESISTOR 200 1% .125W F TC=0±100	24546	C4-1/8-TO-2-1-F
A10R9	0683-1035	1		RESISTOR 10K 5% .25W FC TC=-400/+700	01121	CB1035
A10R10	0757-0407	6		RESISTOR 200 1% .125W F TC=0±100	24546	C4-1/8-TO-2-1-F
A10R11 - R14	0683-1035	1		RESISTOR 10K 5% .25W FC TC=-400/+700	01121	CB1035
A10R15	0757-0420	3	2	RESISTOR 750 1% .125W F TC=0±100	24546	C4-1/8-TO-751-F
A10R16	0757-0420	3		RESISTOR 750 1% .125W F TC=0±100	24546	C4-1/8-TO-751-F
A10R17	0757-0417	8	2	RESISTOR 562 1% .125W F TC=0±100	24546	C4-1/8-TO-562R-F
A10R18	0757-0407	6		RESISTOR 200 1% .125W F TC=0±100	24546	C4-1/8-TO-2-1-F
A10R19	0757-0279	0	1	RESISTOR 3.16K 1% .125W F TC=0±100	24546	C4-1A-TO-3161-F
A10R20	0683-1035	1		RESISTOR 10K 5% .25W FC TC=-400/+700	01121	CB1035
A10R21	0757-0283	6	1	RESISTOR 2K 1% .125W F TC=0±100	24546	C4-1/8-TO-2001-F
A10R22	0683-5105	4	6	RESISTOR 51 5% .25W FC TC=-400/+500	01121	CB5105
A10R23	0683-1035	1		RESISTOR 10K 5% .25W FC TC=-400/+700	01121	CB1035
A10R24	0683-5115	6	1	RESISTOR 510 5% .25W FC TC=-400/+600	01121	CB5115
A10R25	0683-9115	4	1	RESISTOR 910 5% .25W FC TC=-400/+600	01121	CB9115
A10R26	0683-1225	1	1	RESISTOR 1.2K 5% .25W FC TC=-400/+700	01121	CB1225
A10R27	0757-0403	2	3	RESISTOR 121 1% .125W F	28480	0757-0403
A10R28	0683-4715	0		RESISTOR 470 5% .25W FC TC=-400/+600	01121	CB4715
A10R29	0757-0407	6		RESISTOR 200 1% .125W F TC=0±100	24546	C4-1/8-TO-2-1-F
A10R30	0757-0407	6		RESISTOR 200 1% .125W F TC=0±100	24546	C4-1/8-TO-2-1-F
A10R31	0683-1035	1		RESISTOR 10K 5% .25W FC TC=-400/+700	01121	CB1035
A10R32	0757-0417	8		RESISTOR 562 1% .125W F TC=0±100	24546	C4-1/8-TO-562R-F
A10R33	0683-2025	1	4	RESISTOR 2K 5% .25W FC TC=-400/+700	01121	CB2025
A10R34	0683-2025	1		RESISTOR 2K 5% .25W FC TC=-400/+700	01121	CB2025
A10R35	0683-1035	1		RESISTOR 10K 5% .25W FC TC=-400/+700	01121	CB1035
A10R36	0698-3446	3	3	RESISTOR 383 1% .125W F TC=0±100	24546	C4-1/8-TO-383R-F
A10R37	0698-3446	3		RESISTOR 383 1% .125W F TC=0±100	24546	C4-1/8-TO-383R-F
A10R38	0683-1035	1		RESISTOR 10K 5% .25W FC TC=-400/+700	01121	CB1035
A10R39	0757-0400	9	1	RESISTOR 80.9 1% .125W F TC=0±100	24546	C4-1/8-TO-90R9-F
A10R40	0683-2025	1		RESISTOR 2K 5% .25W FC TC=-400/+700	01121	CB2025

See Introduction To This Section For Ordering Information
*Indicates Factory Selected Value

Model 5345A
Replaceable Parts

Table 6-2. Replaceable Parts for Standard Instruments without Options (Continued)

Reference Designation	HP Part Number	C D	Qty	Description	Mfr Code	Mfr Part Number
A10R41	0683-2225	3	1	RESISTOR 2.2K 5% .25W FC TC=-400/+700	01121	CB2225
A10R42	0698-0083	8	1	RESISTOR 1.96K 1% .125W F TC=0±100	24546	C4-1/8-TO-1961-F
A10R43	0757-0440	7	1	RESISTOR 7.5K 1% .125W F TC=0±100	24546	C4-1/8-TO-7501-F
A10R44	0698-3151	7	1	RESISTOR 2.87K 1% .125W F TC=0±100	24546	C4-1/8-TO-2871-F
A10R45	0757-0427	0	1	RESISTOR 1.5K 1% .125W F TC=0±100	24546	C4-1/8-TO-1501-F
A10R46	0757-0918	4	1	RESISTOR 560 2% .125W F TC=0±100	24546	C4-1/8-TO-561-G
A10R47	0683-5105	4		RESISTOR 51 5% .25W FC TC=-400/+500	01121	CB5105
A10R48	0683-5105	4		RESISTOR 51 5% .25W FC TC=-400/+500	01121	CB5105
A10R49	0757-0955	9	1	RESISTOR 20K 2% .125W F TC=0±100	24546	C4-1/8-TO-2002-G
A10R50	0757-0946	8	1	RESISTOR 8.2K 2% .125W F TC=0±100	24546	C4-1/8-TO-8201-G
A10R51	0683-2025	1		RESISTOR 2K 5% .25W FC TC=-400/+700	01121	CB2025
A10R52	0698-3442	9	1	RESISTOR 237 1% .125W F TC=0±100	24546	C4-1/8-TO-237R-F
A10R53	0683-4715	0	5	RESISTOR 470 5% .25W FC TC=-400/+600	01121	CB4715
A10R54	0683-4715	0		RESISTOR 470 5% .25W FC TC=-400/+600	01121	CB4715
A10R55	0683-4715	0		RESISTOR 470 5% .25W FC TC=-400/+600	01121	CB4715
A10R56	0698-3444	1	1	RESISTOR 316 1% .125W F TC=0±100	24546	CR-1/8-TO-316R-F
A10R57	0698-3441	8	1	RESISTOR 215 1% .125W F TC=0±100	24546	C4-1/8-TO-215R-F
A10R58	0698-3446	3		RESISTOR 383 1% .125W F TC=0±100	24546	C4-1/8-TO-383R-F
A10R59	0683-4715	0		RESISTOR 470 5% .25W FC TC=-400/+600	01121	CB4715
A10R60	0683-4715	0		RESISTOR 470 5% .25W FC TC=-400/+600	01121	CB4715
A10R61	0757-0403	2		RESISTOR 121 1% .125W F	28480	0757-0403
A10R62	0683-5105	4		RESISTOR 51 5% .25W FC TC=-400/+500	01121	CB5105
A10R63	0683-5105	4		RESISTOR 51 5% .25W FC TC=-400/+500	01121	CB5105
A10R64	0683-4715	0		RESISTOR 470 5% .25W FC TC=-400/+600	01121	CB4715
A10R65	0683-4715	0		RESISTOR 470 5% .25W FC TC=-400/+600	01121	CB4715
A10R66	0683-4715	0		RESISTOR 470 5% .25W FC TC=-400/+600	01121	CB4715
A10R67	0683-5105	4		RESISTOR 51 5% .25W FC TC=-400/+500	01121	CB5105
A10R68	1810-0318	3	2	NETWORK RESISTOR 6-SIP 1.0K OHM X 5	01121	206A102
A10R69	1810-0318	3		NETWORK RESISTOR 6-SIP 1.0K OHM X 5	01121	206A102
A10R70	1810-0204	6	1	NETWORK RESISTOR 8-SIP 1.0K OHM X 7	01121	208A102
A10R71	1810-0203	5	1	NETWORK RESISTOR 8-SIP 470.0 OHM X 7	01121	208A471
A10R72	0683-1525	4	1	RESISTOR 1.5K 5% .25W FC TC=-400/+700	01121	CB1525
A10R73 - R80				NOT ASSIGNED		
A10R81	0683-1035	1		RESISTOR 10K 5% .25W FC TC=-400/+700	01121	CB1035
A10U1	1820-0054	5	1	IC GATE TTL NAND QUAD 2-INP	01295	SN7400N
A10U2	1820-1197	9	2	IC GATE TTL LS NAND QUAD 2-INP	01295	SN74LS00N
A10U3	1820-3124	1	3	IC XLTR ECL TTL-TO-ECL QUAD 2-INP	04713	MC10124P
A10U4	1820-0174	0	1	IC INV TTL HEX	01295	SN7404N
A10U5	1820-0094	3	2	IC GATE DTL NAND QUAD 2-INP	01295	SN145846N
A10U6	1820-0077	2	2	IC FF TTL D-TYPE POS-EDGE-TRIG CLEAR	01295	SN7474N
A10U7	1820-0094	3		IC GATE DTL NAND QUAD 2-INP	01295	SN145846N
A10U8	1820-1470	1	2	IC MUXR/DATA-SEL TTL LS 2-TO-1 LINE QUAD	01295	SN74LS157N
A10U9	1820-1199	1	2	IC DM74LS04N	27014	SN7404
A10U10	1820-1210	7	1	IC GATE TTL LS AND-OR-INV DUAL 2-INP	01295	SN74LS51N
A10U11	1820-0802	1	3	IC GATE ECL NOR QUAD 2-INP	04713	MC10102P
A10U12	1820-0077	2		IC FF TTL D-TYPE POS-EDGE-TRIG CLEAR	01295	SN7474N
A10U13	1820-1197	9		IC GATE TTL LS NAND QUAD 2-INP	01295	SN74LS00N
A10U14	1820-1470	1		IC MUXR/DATA-SEL TTL LS 2-TO-1 LINE QUAD	01295	SN74LS157N
A10U15	1820-0068	1	1	IC-GATE TTL NAND TPL 3-INP	01295	SN7410N
A10U16	1820-1199	1		IC INV TTL LS HEX 1-INP	01295	SN74LS04N
A10U17	1820-0803	2	1	IC GATE ECL OR-NOR TPL	04713	MC10105P
A10U18	1820-0806	5	1	IC GATE ECL OR-NOR DUAL 4-5-INP	04713	MC10109P
A10U19	1820-3124	1		IC XLTR ECL TTL-TO-ECL QUAD 2-INP	04713	MC10124P
A10U20	1820-3125	7	1	IC XLTR ECL ECL-TO-TTL QUAD 2-INP	04713	MC10125P
A10U21	1820-0802	1		IC GATE ECL NOR QUAD 2-INP	04713	MC10102P
A10U22	1820-0817	8	1	IC FF ECL D-M/S DUAL	04713	MC10131P
A10U23	1820-0802	1		IC GATE ECL NOR QUAD 2-INP	04713	MC10102P
A10U24	1820-1173	1		IC XLTR ECL TTL-TO-ECL QUAD 2-INP	04713	MC10124NL
MP1	5000-9043	6	1	PIN, PC BOARD EXTRACTOR	28480	5000-9043
MP2	5040-6843	2	1	EXTRACTOR PC BOARD 28480	28480	5040-6843

See Introduction To This Section For Ordering Information
*Indicates Factory Selected Value

Table 6-2. Replaceable Parts for Standard Instruments without Options (Continued)

Reference Designation	HP Part Number	C D	Qty	Description	Mfr Code	Mfr Part Number
A11	05345-60011	1	1	SCALER ASSEMBLY	28480	05345-60011
A11C1	0160-3879	7	4	CAPACITOR-FXD .01UF ±20% 100VDC CER	28480	0160-3879
A11C2	0160-3879	7		CAPACITOR-FXD .01UF ±20% 100VDC CER	28480	0160-3879
A11C3	0180-2929	7	2	CAPACITOR-FXD 68UF +10% WVDC	28480	0180-2929
A11C4	0160-3879	7		CAPACITOR-FXD .01UF ±20% 100VDC CER	28480	0160-3879
A11C5	0180-0354	9	1	CAPACITOR-FXD 40UF +5% 10VDC TA	56289	150D406X5010B2
A11C6	0180-2929	7		CAPACITOR-FXD 68UF +10% WVDC	28480	0180-2929
A11C7	0180-1701	2	1	CAPACITOR-FXD 6.8UF +20% 6VDC TA	56289	150D68X0006A2
A11C8	0160-3879	7		CAPACITOR-FXD .01UF ±20% 100VDC CER	28480	0160-3879
A11C8	0160-38					
A11CR1 - CR4	1901-0535	9	8	DIODE-SM SIG SCHOTTKY NOT ASSIGNED	28480	1901-0535
A11CR5						
A11CR6	1901-0028	5	2	DIODE-PWR RECT 400V 750MA DO-29	28480	1901-0028
A11CR7	1901-0028	5		DIODE-PWR RECT 400V 750MA DO-29	28480	1901-0028
A11CR8	1901-0535	9		DIODE-SM SIG SCHOTTKY	28480	1901-0535
A11CR9	1901-0535	9		DIODE-SM SIG SCHOTTKY	28480	1901-0535
A11CR10	1901-0040	1	2	DIODE-SWITCHING 30V 50MA 2NS DO-35	28480	1901-0040
A11CR11	1901-0535	9		DIODE-SM SIG SCHOTTKY	28480	1901-0535
A11CR12	1901-0040	1		DIODE-SWITCHING 30V 50MA 2NS DO-35	28480	1901-0040
A11CR13	1901-0535	9		DIODE-SM SIG SCHOTTKY	28480	1901-0535
A11MP1	5000-9043	6	1	PIN-PC BOARD EXTRACTOR	28480	5000-9043
A11MP2	5040-6843	2	1	EXTRACTOR, PC BOARD	28480	5040-6843
A11Q1	1854-0092	2	4	TRANSISTOR NPN SI PD=200MW FT=600MHZ	28480	1854-0092
A11Q2	1854-0092	2		TRANSISTOR NPN SI PD=200MW FT=600MHZ	28480	1854-0092
A11Q3	1854-0809	9	2	TRANSISTOR NPN SI PD=300MW FT=600MHZ	04713	SN709
A11Q4	1854-0092	2		TRANSISTOR NPN SI PD=200MW FT=600MHZ	28480	1854-0092
A11Q5	1854-0092	2		TRANSISTOR NPN SI PD=200MW FT=600MHZ	28480	1854-0092
A11Q6	1854-0809	9		TRANSISTOR NPN SI PD=300MW FT=600MHZ	04713	SN709
A11Q7	1854-0071	7	1	TRANSISTOR NPN SI PD=300MW FT=200MHZ	28480	1854-0071
A11Q8	1854-0560	9	1	TRANSISTOR NPN SI DARL PD=310MW	04713	MPSA12
A11R1	0683-1315	0	2	RESISTOR 130 5% .25W FC TC=-400/+600	01121	CB1315
A11R2	0683-2715	6	2	RESISTOR 270 5% .25W FC TC=-400/+600	01121	CB2715
A11R3	1810-0055	5	3	NETWORK RESISTOR 9-SIP 10.0K 0HM X 8	28480	1810-0055
A11R4	0683-1315	0		RESISTOR 130 5% .25W FC TC=-400/+600	01121	CB1315
A11R5	0683-1035	1	6	RESISTOR 10K 5% .25W FC TC=-400/+700	01121	CB1035
A11R6	1810-0055	5		NETWORK RESISTOR 9-SIP 10.0K 0HM X 8	28480	1810-0055
A11R7	0683-2715	6		RESISTOR 270 5% .25W FC TC=-400/+600	01121	CB2715
A11R8	0683-6815	5	2	RESISTOR 680 5% .25W FC TC=-400/+600	01121	CB6815
A11R9	0683-6815	5		RESISTOR 680 5% .25W FC TC=-400/+600	01121	CB6815
A11R10	0683-4715	0	2	RESISTOR 470 5% .25W FC TC=-400/+600	01121	CB4715
A11R11	0683-4715	0		RESISTOR 470 5% .25W FC TC=-400/+600	01121	CB4715
A11R12	0683-1035	1		RESISTOR 10K 5% .25W FC TC=-400/+700	01121	CB1035
A11R13	0683-1035	1		RESISTOR 10K 5% .25W FC TC=-400/+700	01121	CB1035
A11R14	1810-0041	9	1	NETWORK RESISTOR 9-SIP 2.7K 0HM X 8	28480	1810-0041
A11R15	0683-3925	2	1	RESISTOR 3.9K 5% .25W FC TC=-400/+700	01121	CB3925
A11R16				NOT ASSIGNED		
A11R17	0683-2015	9	1	RESISTOR 200 5% .25W FC TC=-400/+600	01121	CB2015
A11R18	1810-0055	5		NETWORK RESISTOR 9-SIP 10.0K 0HM X 8	28480	1810-0055
A11R19				NOT ASSIGNED		
A11R20	0698-3150	6	1	RESISTOR 2.37K 1% .125W F TC=0/+100	24546	C4-1/8-TO-2371-F
A11R21	0683-1035	1		RESISTOR 10K 5% .25W FC TC=-400/+700	01121	CB1035
A11R22	0683-3315	4	1	RESISTOR 330 5% .25W FC TC=-400/+600	01121	CB3315
A11R23	0683-1035	1		RESISTOR 10K 5% .25W FC TC=-400/+700	01121	CB1035
A11R24	0683-1035	1		RESISTOR 10K 5% .25W FC TC=-400/+700	01121	CB1035
A11R25	0683-2435	7	1	RESISTOR 24K 5% .25W FC TC=-400/+800	01121	CB2435
A11R26	0683-1035	1		RESISTOR 10K 5% .25W FC TC=-400/+700	01121	CB1035
A11R27	0683-1035	1		RESISTOR 10K 5% .25W FC TC=-400/+700	01121	CB1035
A11R28	0683-1025	9	2	RESISTOR 1K 5% .25W FC TC=-400/+600	01121	CB1025
A11R29	0683-1025	9		RESISTOR 1K 5% .25W FC TC=-400/+600	01121	CB1025

See Introduction To This Section For Ordering Information
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Table 6-2. Replaceable Parts for Standard Instruments without Options (Continued)

Reference Designation	HP Part Number	C D	Qty	Description	Mfr Code	Mfr Part Number
A11U1	1820-0307	1	1	IC INV TTL HEX	01295	SN15386N
A11U2	1820-1425	6	1	IC-SCHMITT-TRIG TTL LS NAND QUAD 2-INP	01295	SN74LS132N
A11U3	1820-1202	7	1	IC TAGE TTL LS NAND TPL 3-INP	01295	SN74LS10N
A11U4	1820-0495	8	1	IC DCDR TTL 4-TO-16-LINE 4-INP	01295	SN74154N
A11U5	1820-1204	9	3	IC GATE TTL LS NAND DUAL 4-INP	01295	SN74LS20N
A11U6	1820-0094	3	2	IC GATE DTL NAND QUAD 2-INP	01295	SN14848N
A11U7	1820-0094	3		IC GATE DTL NAND QUAD 2-INP	01295	SN14848N
A11U8	1820-0207	0	1	IC MV TTL MONOSTBL RETRIG-RESET	04713	MC8601P
A11U9	1820-0610	9	2	IC MUXR/DATA-SEL TTL 4-TO-1 LINE DUAL	04713	MC8309P
A11U10	1820-1199	1	1	IC INV TTL LS HEX 1-INP	01295	SN74LS04N
A11U11	1820-1204	9		IC GATE TTL LS NAND DUAL 4-INP	01295	SN74LS20N
A11U12	1820-1204	9		IC GATE TTL LS NAND DUAL 4-INP	01295	SN74LS20N
A11U13	1820-0610	9		IC MUXR/DATA-SEL TTL 4-TO-1 LINE DUAL	04713	MC8309P
A11U14	1820-0077	2	1	IC FF TTL D-TYPE POS-EDGE-TRIG CLEAR	01295	SN7474N
A11U15	1820-0174	0	2	IC INV TTL HEX	01295	SN7404N
A11U16	1820-2316	6	4	IC CNTR TTL DECD HEX	28480	1820-2316
A11U17	1820-2316	6		IC CNTR TTL DECD HEX	28480	1820-2316
A11U18	1820-2316	6		IC CNTR TTL DECD HEX	28480	1820-2316
A11U19	1820-2316	6		IC CNTR TTL DECD HEX	28480	1820-2316
A11U20	1820-1198	0	3	IC GATE TTL LS NAND QUAD 2-INP	01295	SN74LS03N
A11U21	1820-0174	0		IC INV TTL HEX	01295	SN7404N
A11U22	1820-1869	2	2	IC DIGITAL TTL 74S196CTR	01295	SN74S196N
A11U23	1820-3125	7	2	IC XLTR ECL ECL-TO-TTL QUAD 2-INP	04713	MC10125P
A11U24	1820-1198	0		IC GATE TTL LS NAND QUAD 2-INP	01295	SN74LS03N
A11U25	1820-1470	1	1	IC MUXR/DATA SEL TTL LS 2-TO-1 LINE QUAD	01295	SN74LS157N
A11U26	1820-1015	0	1	IC MUXR/DATA SEL TTL S 2-TO-1 LINE QUAD	01295	SN74S158N
A11U27	1820-3125	7		IC XLTR ECL ECL-TO-TTL QUAD 2-INP	04713	MC10125P
A11U28	1820-1198	0		IC GATE TTL LS NAND QUAD 2-INP	01295	SN74LS03N
A11U29	1820-1869	2		IC DIGITAL TTL 74S196CTR	01295	SN74S196N
A11W1 - W2	8159-0005	0	2	RESISTOR, ZERO OHM	28480	8159-0005
	0360-0124	3	7	CONNECTOR-SGL CONT PIN .04-IN BSC SZ RND	28480	0360-0124

See Introduction To This Section For Ordering Information
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Table 6-2. Replaceable Parts for Standard Instruments without Options (Continued)

Reference Designation	HP Part Number	C D	Qty	Description	Mfr Code	Mfr Part Number
A12	05345-60018	8	1	I/O INTERFACE ASSEMBLY (OPTION 011) (See Table 6-4. Option Assembly Replaceable Parts)	28480	05345-60018
A12	05345-60121	4	1	HP-IB INTERFACE ASSEMBLY (OPTION 012) (See Table 6-4. Option Assembly Replaceable Parts)	28480	05345-60121
A13	05345-60013	3	1	ADDER/SUBTRACTER ASSEMBLY	28480	05345-60013
A13C1	0180-0210	6	1	CAPACITOR-FXD 3.3UF ±20% 15VDC TA	56289	150D335X0015A2
A13C2, C3	0160-3879	7	2	CAPACITOR-FXD .01UF ±20% 100VDC CER	28480	0160-3879
A13J1	1200-0487	4	1	SOCKET-IC 16CONT DIP DIP-SLDR	28480	1200-0487
A13MP1	5000-9043	6	1	PIN, PC BOARD EXTRACTOR	28480	5000-9043
A13MP2	5040-6843	2	1	EXTRACTOR, PC BOARD	28480	5040-6843
A13R1 - R4	1810-0156	7	4	NETWORK RESISTOR 6-SIP 1.3K OHM X 5	91637	CSP06F07-132J
A13U1	1820-0616	5	2	IC MUXR/DATA-SEL TTL 2-TO-1-LINE QUAD	07263	9322PC
A13U2	1820-0910	2	2	IC ADDR TTL LS BIN FULL ADDR 4-BIT	01295	SN74LS83AN
A13U3	1820-0910	2	2	IC ADDR TTL LS BIN FULL ADDR 4-BIT	01295	SN74LS83AN
A13U4	1820-1411	0	2	IC LCH TTL LS D-TYPE 4-BIT	01295	SN74LS75N
A13U5	1820-1202	7	2	IC GATE TTL LS NAND TPL 3-INP	01295	SN74LS10N
A13U6	1820-0077	2	1	IC FF TTL D-TYPE POS-EDGE-TRIG CLEAR	01295	SN7474N
A13U7	1820-0734	0	1	IC TTL/LS SCHMITT-TRIG HEX INV	01295	SN74LS14N
A13U8	1820-1028	5	3	IC TTL 64-BIT STAT RAM 33-NS OC	01295	SN7489N
A13U9	1820-0274	1	1	IC GATE DTL OR QUAD 2-INP	04713	MC1808P
A13U10	1820-1430	3	4	IC CNTR TTL LS BIN SYNCHRO POS-EDGE-TRIG	01295	SN74LS161AN
A13U11	1820-1211	8	2	IC GATE TTL LS EXCL-OR QUAD 2-INP	01295	SN74LS86N
A13U12	1820-1425	6	3	IC SCHMITT-TRIG TTL LS NAND QUAD 2-INP	01295	SN74LS132N
A13U13	1820-0655	2	1	IC GATE TTL NOR DUAL 4-INP	01295	SN7425N
A13U14	1820-1144	6	2	IC GATE TTL LS NOR QUAD 2-INP	01295	SN74LS02N
A13U15	1820-1112	8	1	IC FF TTL LS D-TYPE POS-EDGE-TRIG	01295	SN74LS74AN
A13U16	1820-1425	6		IC SCHMITT-TRIG TTL LS NAND QUAD 2-INP	01295	SN74LS132N
A13U17	1820-0610	9	2	IC MUXR/DATA-SEL TTL 4-TO-1 LINE DUAL	04713	MC8309P
A13U18	1820-1204	9	1	IC GATE TTL LS NAND DUAL 4-INP	01295	SN74LS20N
A13U19	1820-1028	5		IC TTL 64-BIT STAT RAM 33-NS OC	01295	SN7489N
A13U20	1820-1411	0		IC LCH TTL LS D-TYPE 4-BIT	01295	SN74LS75N
A13U21	1820-1028	5		IC TTL 64-BIT STAT RAM 33-NS OC	01295	SN7489N
A13U22	1820-1430	3		IC CNTR TTL LS BIN SYNCHRO POS-EDGE-TRIG	01295	SN74LS161AN
A13U23	1820-1430	3		IC CNTR TTL LS BIN SYNCHRO POS-EDGE-TRIG	01295	SN74LS161AN
A13U24	1820-1211	8		IC GATE TTL LS EXCL-OR QUAD 2-INP	01295	SN74LS86N
A13U25	1820-1144	6		IC GATE TTL LS NOR QUAD 2-INP	01295	SN74LS02N
A13U26	1820-0610	9		IC MUXR/DATA-SEL TTL 4-TO-1 LINE DUAL	04713	MC8309P
A13U27	1820-1425	6		IC SCHMITT-TRIG TTL LS NAND QUAD 2-INP	01295	SN74LS132N
A13U28	1820-1430	3		IC CNTR TTL LS BIN SYNCHRO POS-EDGE-TRIG	01295	SN74LS161AN
A13U29	1820-1197	9	1	IC GATE TTL LS NAND QUAD 2-INP	01295	SN74LS00N
A13U30	1820-0616	5		IC MUXR/DATA-SEL TTL 2-TO-1-LINE QUAD	07263	9322PC
A13U31	1820-1470	1	2	IC MUXR/DATA-SEL TTL LS 2-TO-1-LINE QUAD	01295	SN74LS157N
A13U32	1820-1470	1		IC MUXR/DATA-SEL TTL LS 2-TO-1-LINE QUAD	01295	SN74LS157N
A13U33	1820-1202	7		IC GATE TTL LS NAND TPL 3-INP	01295	SN74LS10N

See introduction to this section for ordering information
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Table 6-2. Replaceable Parts for Standard Instruments without Options (Continued)

Reference Designation	HP Part Number	C D	Qty	Description	Mfr Code	Mfr Part Number
A14	05345-60144	1	1	QUALIFIER ASSEMBLY (SERIES 3103A)	28480	05345-60144
C1	0160-0576	5	11	CAPACITOR-FXD 0.1UF +20% 50V CER	04222	S4205C104MAAH
C2	0160-0576	5		CAPACITOR-FXD 0.1UF +20% 50V CER	04222	S4205C104MAAH
C3	0180-3845	9	1	CAPACITOR-FXD 4.7UF +10% 35V TA	56289	299D475X9035CB1
C4	0160-0576	5		CAPACITOR-FXD 0.1UF +20% 50V CER	04222	S4205C104MAAH
C5	0160-0576	5		CAPACITOR-FXD 0.1UF +20% 50V CER	04222	S4205C104MAAH
C6	0160-0576	5		CAPACITOR-FXD 0.1UF +20% 50V CER	04222	S4205C104MAAH
C7				NOT ASSIGNED		
C8	0160-0576	5		CAPACITOR-FXD 0.1UF +20% 50V CER	04222	S4205C104MAAH
C9	0160-0576	5		CAPACITOR-FXD 0.1UF +20% 50V CER	04222	S4205C104MAAH
C10				NOT ASSIGNED		
C11	0160-0576	5		CAPACITOR-FXD 0.1UF +20% 50V CER	04222	S4205C104MAAH
C12	0160-0576	5		CAPACITOR-FXD 0.1UF +20% 50V CER	04222	S4205C104MAAH
C13				NOT ASSIGNED		
C14	0160-0576	5		CAPACITOR-FXD 0.1UF +20% 50V CER	04222	S4205C104MAAH
C15	0160-0576	5		CAPACITOR-FXD 0.1UF +20% 50V CER	04222	S4205C104MAAH
MP1	5000-9043	6	1	PIN- EXTRACTOR	28480	5000-9043
MP2	5040-6843	2	1	EXTRACTOR- BLACK	28480	5040-6843
R1	1810-0278	4	1	NETWORK RESISTOR 10-SIP 3.3K OHM X 9	91637	MSP10A01
R2	1810-0206	8	2	NETWORK RESISTOR 8-SIP 10.0K OHM X 7	11236	750-81
R3	1810-0206	8		NETWORK RESISTOR 8-SIP 10.0K OHM X 7	11236	750-81
U1	1820-3294	1	1	IC FF TTL/ALS D-TYPE POS-EDGE TRIG	01295	SN74ALS374N
U2	1820-2739	7	2	IC-GATE TTL/ALS NOR QUAD 2-INP	28480	1820-2739
U3	05345-80030	5	1	EPROM- CMOS 65536 (64K) 300NS 3-S	28480	05345-80030
U4	1820-3145	1	4	IC-DRVR TTL/ALS BUS OCTL	01295	SN74ALS244BN
U5	1820-3318	0	1	IC-FF TTL/ALS D-TYPE POS-EDGE TRIG	28480	1820-3318
U6	1820-3308	8	1	IC-TRANSCIEVER TTL/ALS BUS OCTL	01295	SN74ALS5639AN
U7	1820-6539	3	1	IC-CMOS PROGRAMMABLE LGC	28480	1820-6539
U8	1820-3145	1		IC-DRVR TTL/ALS BUS OCTL	01295	SN74ALS244BN
U9	1820-3145	1		IC-DRVR TTL/ALS BUS OCTL	01295	SN74ALS244BN
U10	1820-2739	7		IC-GATE TTL/ALS NOR QUAD 2-INP	28480	1820-2739
U11	1820-3145	1		IC-DRVR TTL/ALS BUS OCTL	01295	SN74ALS244BN
U12	1826-1338	2	1	IC-VOLTAGE SUPP	28480	1826-1338
XU7	1200-1343	3	1	SOCKET-CHIP CARRIER 84-CONT SQUARE	00779	821573-1

See Introduction To This Section For Ordering Information
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Table 6-2. Replaceable Parts for Standard Instruments without Options (Continued)

Reference Designation	HP Part Number	C D	Qty	Description	Mfr Code	Mfr Part Number
A15	05345-60045	1	1	ROM ASSEMBLY	28480	05345-60045
A15C1	0180-2204	2	1	CAPACITOR-FXD 10UF ±20% 10VDC TA	28480	0180-2204
A15C2, C3	0160-3879	7	2	CAPACITOR-FXD .01UF ±20% 100VDC CER	28480	0160-3879
A15C4, C5	0160-3878	6	2	CAPACITOR-FXD 1000PF ±20% 100VDC CER	28480	0160-3878
A15C6	0140-0190	7	1	CAPACITOR-FXD 39PF ±5% 300VDC MICA	72136	DM15E390J0300WV1CR
A15C7	0140-0145	2	1	CAPACITOR-FXD 22PF ±5% 500VDC MICA	72136	DM15C220J0500WV1CR
A15J1	1200-0487	4	1	SOCKET-IC 16-CONT DIP DIP-SLDR	28480	1200-0487
A15MP1	5000-9043	6	1	PIN, PC BOARD EXTRACTOR	28480	5000-9043
A15MP2	5040-6843	2	1	EXTRACTOR, PC BOARD	28480	5040-6843
A15R1, R2	0683-1035	1	3	RESISTOR 10K 5% .25W FC TC=-400/+700	01121	CB1035
A15R3	0757-0440	7	2	RESISTOR 7.5K 1% .125W F TC=0±100	24546	C4-1/8-TO-7501-F
A15R4, R5	2100-2489	9	2	RESISTOR-TRMR 5K 10% C SIDE-ADJ 1-TRN	30983	ET50X502
A15R6	0757-0440	7	2	RESISTOR 7.5K 1% .125W F TC=0±100	24546	C4-1/8-TO-7501-F
A15R7	0683-1035	1	1	RESISTOR 10K 5% .25W FC TC=-400/+700	01121	CB1035
A15R8, R9	8159-0005	0	2	RESISTOR ZERO OHMS 22AWG LEAD DIA	28480	8159-0005
A15U1	1820-0788	2	1	IC FF TTL D-TYPE POS-EDGE-TRIG CLEAR HEX	01295	SN74174N
A15U2	1820-0349	1	1	IC GATE DTL NAND QUAD 2-INP	01295	SN15849N
A15U3	1820-1211	8	2	IC GATE TTL LS EXCL-OR QUAD 2-INP	01295	SN74LS86N
A15U4	1820-0377	5	1	IC GATE TTL H AND-OR-INV DUAL 2-INP	01295	SN74H50N
A15U5	1820-0515	3	1	IC MV TTL MONOSTBL RETRIG/RESET DUAL	04713	MC8602P
A15U6	1820-1199	1	2	IC INV TTL LS HEX 1-INP	01295	SN74LS04N
A15U7	1820-1197	9	1	IC GATE TTL LS NAND QUAD 2-INP	01295	SN74LS00N
A15U8	05345-80020	4	1	ROM-PROGRAMMED	28480	05345-80020
A15U9	1820-1418	7	2	IC DCDR TTL LS BCD-TO-DEC 4-TO-10-LINE	01295	SN74LS542N
A15U10	1820-1197	9	1	IC GATE TTL LS NAND QUAD 2-INP	01295	SN74LS00N
A15U11	1820-1202	7	2	IC GATE TTL LS NAND TPL 3-INP	01295	SN74LS10N
A15U12	1820-0084	3	1	IC GATE DTL NAND QUAD 2-INP	01295	SN15848N
A15U13	1820-0683	6	1	IC INV TTL S HEX 1-INP	01295	SN74S04N
A15U14	1820-0681	4	1	IC GATE TTL S NAND QUAD 2-INP	01295	SN74S00N
A15U15	1820-1430	3	1	IC CNTR TTL LS BIN SYNCHRO POS-EDGE-TRIG	01295	SN74LS161AN
A15U16	05345-80021	5	1	ROM-PROGRAMMED	28480	05345-80021
A15U17	1820-1411	0	2	IC LCH TTL LS D-TYPE 4-BIT	01295	SN74LS75N
A15U18	1820-1418	7	1	IC DCDR TTL LS BCD-TO-DEC 4-TO-10-LINE	01295	SN74LS542N
A15U19	1820-1199	1	1	IC INV TTL LS HEX 1-INP	01295	SN74LS04N
A15U20	1820-1197	9	1	IC GATE TTL LS NAND QUAD 2-INP	01295	SN74LS00N
A15U21	1820-0655	2	2	IC GATE TTL NOR DUAL 4-INP	01295	SN7425N
A15U22	1820-1144	6	1	IC GATE TTL LS NOR QUAD 2-INP	01295	SN74LS02N
A15U23	1820-1112	8	1	IC FF TTL LS 3-TYPE POS-EDGE-TRIG	01295	SN74LS74AN
A15U24	05345-80022	6	1	ROM-PROGRAMMED	28480	05345-80022
A15U25	1820-0077	2	2	IC FF TTL D-TYPE POS-EDGE-TRIG CLEAR	01295	SN7474N
A15U26	1820-1197	9	1	IC GATE TTL LS NAND QUAD 2-INP	01295	SN74LS00N
A15U27	1820-0655	2	1	IC GATE TTL NOR DUAL 4-INP	01295	SN7425N
A15U28	1820-0910	2	1	IC ADDR TTL LS BIN FULL ADDR 4-BIT	01295	SN74LS83AN
A15U29	1820-1144	6	1	IC GATE TTL LS NOR QUAD 2-INP	01295	SN74LS02N
A15U30	1820-0782	6	1	IC GATE TTL NOR TPL 3-INP	01295	SN7427N
A15U31	1820-0072	7	1	IC GATE TTL AND-OR-INV DUAL 2-INP	01295	SN7450N
A15U32	05345-80004	4	1	ROM-PROGRAMMED	28480	05345-80004
A15U33	1820-0214	9	1	IC DCDR TTL BCD-TO-DEC 4-TO-10 LINE	01295	SN7442AN
A15U34	1820-1411	0	1	IC LCH TTL LS D-TYPE 4-BIT	01295	SN74LS75N
A15U35	1820-0089	8	1	IC CNTR TTL BIN ASYNCHRO NEG-EDGE-TRIG	01295	SN7493N
A15U36	1820-1211	8	1	IC GATE TTL LS EXCL-OR-QUAD 2-INP	01295	SN74LS86N
A15U37	1820-1202	7	1	IC GATE TTL LS NAND TPL 3-INP	01295	SN74LS10N
A15U38	1820-0068	1	1	IC GATE TTL NAND TPL 3-INP	01295	SN7410N
A15U39	1820-0077	2	1	IC FF TTL D-TYPE POS-EDGE-TRIG CLEAR	01295	SN7474N
A15XU8	1200-0473	8	4	SOCKET-IC 16-CONT DIP DIP-SLDR	28480	1200-0473
A15XU16	1200-0473	8	1	SOCKET-IC 16-CONT DIP DIP-SLDR	28480	1200-0473
A15XU24	1200-0473	8	1	SOCKET-IC 16-CONT DIP DIP-SLDR	28480	1200-0473
A15XU36	1200-0473	8	1	SOCKET-IC 16-CONT DIP DIP-SLDR	28480	1200-0473
	0360-0124	3	13	CONNECTOR-SGL CONT PIN .04-IN BSC SZ RND	28480	0360-0124

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Table 6-2. Replaceable Parts for Standard Instruments without Options (Continued)

Reference Designation	HP Part Number	C D	Qty	Description	Mfr Code	Mfr Part Number
A16	05345-60016	6	1	MOTHERBOARD ASSEMBLY	28480	05345-60016
A16XA5	1251-2026	8	1	CONNECTOR-PC EDGE 18-CONT/ROW 2-ROWS	28480	1251-2026
A16XA6A	1251-2034	8	6	CONNECTOR-PC EDGE 10-CONT/ROW 2-ROWS	28480	1251-2034
A16XA6B	1251-2034	8		CONNECTOR-PC EDGE 10-CONT/ROW 2-ROWS	28480	1251-2034
A16XA7A	1251-2034	8		CONNECTOR-PC EDGE 10-CONT/ROW 2-ROWS	28480	1251-2034
A16XA7B	1251-2034	8		CONNECTOR-PC EDGE 10-CONT/ROW 2-ROWS	28480	1251-2034
A16XA8A	1251-2034	8		CONNECTOR-PC EDGE 10-CONT/ROW 2-ROWS	28480	1251-2034
A16XA8B	1251-2034	8		CONNECTOR-PC EDGE 10-CONT/ROW 2-ROWS	28480	1251-2034
A16XA9A	1251-1365	6	14	CONNECTOR-PC EDGE 22-CONT/ROW 2-ROWS	28480	1251-1365
A16XA9B	1251-1365	6		CONNECTOR-PC EDGE 22-CONT/ROW 2-ROWS	28480	1251-1365
A16XA10A	1251-1365	6		CONNECTOR-PC EDGE 22-CONT/ROW 2-ROWS	28480	1251-1365
A16XA10B	1251-1365	6		CONNECTOR-PC EDGE 22-CONT/ROW 2-ROWS	28480	1251-1365
A16XA11A	1251-1365	6		CONNECTOR-PC EDGE 22-CONT/ROW 2-ROWS	28480	1251-1365
A16XA11BA	1251-1365	6		CONNECTOR-PC EDGE 22-CONT/ROW 2-ROWS	28480	1251-1365
A16XA12A	1251-1365	6		CONNECTOR-PC EDGE 22-CONT/ROW 2-ROWS	28480	1251-1365
A16XA12B	1251-1365	6		CONNECTOR-PC EDGE 22-CONT/ROW 2-ROWS	28480	1251-1365
A16XA13A	1251-1365	6		CONNECTOR-PC EDGE 22-CONT/ROW 2-ROWS	28480	1251-1365
A16XA13B	1251-1365	6		CONNECTOR-PC EDGE 22-CONT/ROW 2-ROWS	28480	1251-1365
A16XA14A	1251-1365	6		CONNECTOR-PC EDGE 22-CONT/ROW 2-ROWS	28480	1251-1365
A16XA14B	1251-1365	6		CONNECTOR-PC EDGE 22-CONT/ROW 2-ROWS	28480	1251-1365
A16XA15A	1251-1365	6		CONNECTOR-PC EDGE 22-CONT/ROW 2-ROWS	28480	1251-1365
A16XA15B	1251-1365	6		CONNECTOR-PC EDGE 22-CONT/ROW 2-ROWS	28480	1251-1365
A16XA18	1251-2035	9	1	CONNECTOR-PC EDGE 15-CONT/ROW 2-ROWS	28480	1251-2035
A16MP1,2	1251-2205	5	2	POLARIZING KEY, PC EDGE CONNECTOR	28480	1251-2205
A16MP3	0380-0923	2	3	STANDOFF, RVT-ON .25-IN-LG 6-32 THD	00000	ORDER BY DESCRIPTION
A16MP4	0380-0077	7	5	SPACER, RVT-ON 1.88-IN-LG .162-IN ID	28480	ORDER BY DESCRIPTION
A16MP5	0380-0765	0	1	STANDOFF, RVT-ON .25-IN-LG 6-32 THD	00000	ORDER BY DESCRIPTION
	1251-3288	6	1	CONNECTOR, 64-PIN PRESSURE TYPE	28480	1251-3288
	2200-0757	2	2	SCREW -MACH 4-40 .688-IN-LG PAN-HD POZI	00000	ORDER BY DESCRIPTION
	2260-0009	3	2	NUT-HEX W/LKWR 4-40-THD .094-THK	00000	ORDER BY DESCRIPTION
	2360-0117	6	1	SCREW-MACH 6-32 .375-LG PAN-HD POZI W/LKWR	00000	ORDER BY DESCRIPTION
	3050-0082	8	2	WASHER FL NM NO. 4 .116-IN-HD	00000	ORDER BY DESCRIPTION
	05345-60071		1	CABLE ASSY, DISPLAY INTERFACE (A16 To A2)	28480	05345-60071
	05345-60073		1	CABLE ASSY, REAR PANEL	28480	05345-60073
	05345-60090		1	CABLE ASSY, TRANSFORMER	28480	05345-60090
A17	05345-60017	7	1	PLUG-IN INTERCONNECT ASSEMBLY	28480	053345-60017
A17J1	1251-0101	6	1	CONNECTOR 50-PIN F MICRO-RIBBON	28480	1251-0101
A18	10811-60111	8	1	OSCILLATOR-OVEN - STANDARD	28480	10811-60111
A19	05345-60019	9	1	INTERFACE PANEL - OPTION 011 (See Table 6-4. Option Assembly Replaceable Parts)	28480	05345-60016
A19	05345-60022	4	1	INTERFACE PANEL - OPTION 012 (See Table 6-4. Option Assembly Replaceable Parts)	28480	05345-60022
A20	05345-60130	4	1	FILTER ASSEMBLY - OPTION 012 (See Table 6-4. Option Assembly Replaceable Parts)	28480	05345-60130

See Introduction To This Section For Ordering Information
*Indicates Factory-Selected Value

Table 6-3. Miscellaneous Parts

Reference Designation	HP Part Number	C D	Qty	Description	Mfr Code	Mfr Part Number
MISCELLANEOUS - ELECTRICAL						
B1	3160-0378	6	1	FAN-TBAX 120-CMF 115V 50/60-HZ	28480	3160-0378
C1	0180-4801	7	3	CAPACITOR-FXD 100PF ±5% 100VDC CER	28480	0160-4801
C2	0160-4801	7		CAPACITOR-FXD 100PF ±5% 100VDC CER	28480	0160-4801
C3	0160-4439	7	2	CAPACITOR-FXD 4700PF ±20% 250VAC (RMS)	28480	0160-4439
C4	0160-4439	7		CAPACITOR-FXD 4700PF ±20% 250VAC (RMS)	28480	0160-4439
C5	0180-0161	6	1	CAPACITOR-FXD 3.3UF ±10% 35VDC TA	00904	T110B335K035AS
C6	0160-4801	7		CAPACITOR-FXD 100PF ±5% 100VDC CER	28480	0160-4801
	0180-0230	0	1	CAPACITOR-FXD 1UF ±20% 50V TA	28480	0180-0230
F1	2110-0015	4	1	FUSE 2.5A 250V TD FE	28480	2110-0015
F1	2110-0305	5	2	FUSE 1.25A 250V TD 1.25X.25 UL	75915	3131.25
FL1	0960-0444	2	1	LINE MODULE - UNFILTERED	28480	0960-0444
J1 - J8	1250-0083	1	8	CONNECTOR-RF BNC FEM SGL-HOLE-FR 50-OHM	28480	1250-0083
Q1	1854-1262	8	1	TRANSISTOR NPN 10A 90W	28480	1854-1262
R1	2100-3297	9	1	RESISTOR-VAR W/SWITCH 250K 10% 10CW SPST-NO	28480	2100-3297
R2	0683-1235	3	1	RESISTOR 12K 5% .25W FC TC=+400/+800	01121	CB1235
S1	3100-2929	3	1	SWITCH-ROTARY 0.812 STRUT CTR SPCG; 7	28480	3100-2929
S3	3101-0052	1	1	SWITCH, PB SPST NO MOM .25A 30VAC BLK-BTN	82389	961
S4/S5	3100-2930	6	2	SWITCH, ROTARY 0.812 STRUT CTR SPCG (DUAL SWITCH)	28480	3100-2930
S6	2100-3297	9	2	RESISTOR-VAR W/SWITCH 250K 10% 10CW SPST-NO	28480	2100-3297
S7	3101-2479	0	1	SWITCH-TOGGLE SUBMIN 4PDT 5A 120VAC	28480	3101-2479
S8, S9	3101-0957	5	2	SWITCH-TOGGLE SUBMIN DPDT 5A 115VAC	28480	3101-0957
T1	9100-3043	0	1	TRANSFORMER, POWER, PRI: 100/120/220/240	28480	9100-3043
A2Q1	1854-1262	1	1	TRANSISTOR NPN 10A 90W	28480	1854-1262
MISCELLANEOUS - CABLE ASSEMBLIES						
A3W1	05345-60191	8	1	CABLE ASSY, FILTER (OPT 012)	28480	05345-60191
A3W2	05345-60192	9	1	CABLE ASSY, FILTER (OPT 012)	28480	05345-60192
W2	05345-60072	4	1	FAN CABLE-STD (Fan/Transformer to Power Switch Cbl W11)	28480	05345-60210
W2 (OPT 012)	05345-60210	1	1	FAN CABLE - OPT 012 (A12 / Fan / Transformer to Power Switch Cable W11)	28480	05345-60210
W4	05345-60089	3	1	MAIN POWER CABLE (From Power Module to Transformer)	28480	05345-60089
W5	05345-60093	9	1	FREQ CONVERTER PLUG-IN CABLE (From W5J1 to A16)	28480	05345-60093
W8	05345-60078	0	1	EXTERNAL FREQ. STD INPUT CABLE (Rear Panel- S9 to A8)	28480	05345-60078
W9	05345-60079	1	1	FREQ. STD OUTPUT CABLE (From Rear Panel -J2 to A8)	28480	05345-60079
W10	05345-60070	2	1	FRONT PANEL CABLE (From Front Panel Switches to A4)	28480	05345-60070
W11	05345-60060	0	1	POWER SWITCH CABLE (Power Switch S2 to Fan Cable, W2)	28480	05345-60060
W11 (OPT 012)	05345-60211	1	1	POWER SWITCH CABLE (A2 / Power Switch S2 to Fan Cbl W2)	28480	05345-60068
W12	05345-60082	6	1	GATE OUTPUT CABLE (From Rear Panel J3 to A16J5)	28480	05345-60082
W13	05345-60083	7	1	GATE INPUT CABLE (From Rear Panel J4 to A16J4)	28480	05345-60083
W15	8120-1378	1	1	POWER CORD, LINE	28480	8120-1378
MISCELLANEOUS						
A8MP8, MP9	3050-0001	2	2	WASHER, FL (for Mounting T1)		
A18MP6	05345-00021	7	1	PLATE PATCH #1 (SEE OPT 010, 011 012 PARTS LISTS)	28480	05345-00021
MP1	1490-0030	6	1	TILT STAND 3-IN-W 13.75-IN-OA-LG SST	28480	1490-0030
MP2	5000-0051	8	2	TRIM STRIP, FLUTED	28480	5000-0051
MP3	5000-8527	9	1	COVER, PERFORATED SIDE (REAR)	28480	5000-8527
MP4	5000-8531	5	1	COVER, SIDE (REAR)	28480	5000-8531
MP5	5000-8529	1	2	COVER, SIDE (FRONT)	28480	5000-8529
MP6				NOT ASSIGNED		
MP7	5060-0222	1	2	HANDLE ASSEMBLY 5TH SIDE	28480	5060-0222
MP8	5060-0767	9	5	FOOT ASSEMBLY, FM	28480	5060-0767
MP9	5060-8740	4	1	KIT- RACK MOUNT	28480	5060-8740
MP10	05345-00034	2	1	PANEL, REAR	28480	05345-00034
MP11	05345-00005	7	1	BRACKET, FAN CONNECTOR (SEE OPT 012 PARTS)	28480	05345-00005
MP12	05345-00006	8	1	BRACKET, BNC	28480	05345-00006
MP13	05345-00007	9	1	COVER, DISPLAY HOUSING	28480	05345-00007
MP15	05345-00013	7	1	COVER, P1 CONNECTOR	28480	05345-00013

SAMPLE
NOTE

See introduction to this section for ordering information
* Indicates factory-selected value

Table 6-3. Miscellaneous Parts (Continued)

Reference Designation	HP Part Number	C D	Qty	Description	Mfr Code	Mfr Part Number
MP16	05345-00014	8	1	BRACKET, P1 CONNECTOR	28480	05345-00014
MP17	05345-00015	9	1	HOUSING, P1 CONNECTOR	28480	05345-00015
MP18	05345-00016	0	1	COVER ASSEMBLY, BOTTOM	28480	05345-00016
MP19	05345-00017	1	1	COVER ASSEMBLY, TOP	28480	05345-00017
MP20	05345-00033	1	1	PANEL, FRONT	28480	05345-00033
MP21	05345-40008	4	1	WINDOW	28480	05345-40008
MP22	05345-20100	5	1	PANEL, FRONT SUB	28480	05345-20100
MP23	05345-40005	1	1	GUIDE, #1 BOARD	28480	05345-40005
MP24	05345-40006	2	1	GUIDE, #2 BOARD	28480	05345-40006
MP25				NOT ASSIGNED		
MP26	05345-20104	9	2	FRAME ASSEMBLY, SIDE	28480	05345-20104
MP27	05345-00002	4	1	BULKHEAD, FAN	28480	05345-00002
MP28	05345-20105	0	1	FRAME PANEL FRONT	28480	05345-20105
MP29	05345-20102	7	1	HOUSING, POWER SUPPLY	28480	05345-20102
MP30	05345-00003	5	1	BULKHEAD, MAIN	28480	05345-00003
MP31	05345-00009	1	1	RAIL	28480	05345-00009
MP32	05345-20101	6		HOUSING, DISPLAY	28480	05345-20101
MP33	05345-00018			CLIP, SPRING (Part of MP46)	28480	05345-00018
MP34	05345-20107	2	1	PANEL, CAST ALUMINUM (Part of MP46)	28480	05345-20107
MP35	05345-00028	4	1	PANEL, PAINTED INSERT (Part of MP46)	28480	05345-00028
MP36	05345-00011	5	1	BRACKET, MB#2	28480	05345-00011
MP37				NOT ASSIGNED		
MP38A	3030-0518	3	2	SCREW-SHLDR 6-32 .57-IN-LG SST	28480	3030-0518
MP39	05345-00010	4	1	BRACKET, MB#1	28480	05345-00010
MP40	05345-00020			COVER, OSCILLATOR (OPTION 001)	28480	05345-00020
MP41	05345-00027	3	1	BRACKET, TRANSISTOR	28480	05345-00027
MP42	5040-0274			FOOT	28480	5040-0274
MP43	5060-8737	9	2	HANDLE, RETAINER	28480	5060-8737
MP44				NOT ASSIGNED		
MP45				NOT ASSIGNED		
MP46	05345-60033	7	1	COVER, PLUG-IN	28480	05345-60033
	0340-0620	2	1	INSULATOR, TRANSISTOR TO-220	28480	0340-0620
	0340-0797	4	1	INSULATOR, XSTR ALUMINUM (Part of Q1)	28480	0340-0797
	0360-0040	2	2	TERMINAL-SLDR LUG LK-MTG FOR #1/4 SCREW	28480	0360-0040
	0360-1632	0	8	TERMINAL SLDR LUG LK-MTG FOR #3/8 SCR	28480	0360-1632
	0370-1005	2	3	KNOB-BASE PTR 3/8 JGK (Level A, B, Sample Rate)	28480	0370-1005
	0370-1099	4	1	KNOB-BASE PTR 1/2 JGK (Function)	28480	0370-1099
	0370-1100	8	1	KNOB-BASE PTR 1/2 JGK (Gate Time)	28480	0370-1100
	0370-1882	3	1	KNOB-CONC-PTR 1/2 JGK .125-IN-ID	28480	0370-1882
	0380-0007	3	2	SPACER RND .438-LG .18-ID (OPT 012)	28480	0380-0007
	0380-0093	7	4	STANDOFF-HEX .5-IN-LG 6-32-THD	28480	0380-0093
	0400-0002	2	1	GROMMET, RND .187-ID RUBBER (OPT 001)	28480	0400-0002
	0460-0800	2	1	TAPE, INDL 5-IN-W (Top Cover)	28480	0460-0800
	0510-0075	2	1	FASTENER CLIPS (Side Frame to Top Cover)	28480	0510-0075
	0520-0130	1	2	SCREW-MACH 2-56 .375-IN-LG PAN-HD POZI	00000	ORDER BY DESCRIPTION
	0520-0173	2	5	SCREW-MACH 2-56 .188-IN-LG PAN-HD-POZI	00000	ORDER BY DESCRIPTION
	0520-0246	0	10	SCREW-MACH 2-56 .25-IN-LG PAN-HD POZI	00000	ORDER BY DESCRIPTION
	0550-0051	8	2	SCREW-MACH 3-48 .375-IN-LG PAN-HD POZI	00000	ORDER BY DESCRIPTION
	0570-0130	6	1	SCREW-MACH 6-32 .375-IN-LG BDG HD SLT	00000	ORDER BY DESCRIPTION
	0590-0005	6	1	NUT-SHTMET-J-TP 6-32 THD .31-WD STL	28480	0590-0005
	0590-0025	0	5	NUT-HEX PLASTIC LKG 6-32-THD .172-IN-THK	28480	0590-0025
	0590-0053	4	8	NUT-SHTMET-J-TP 6-32-THD .5-WD STL	28480	0590-0053
	0590-0106	8	2	NUT-HEX PLASTIC LKG 2-56 THD .143-IN-THK	00000	ORDER BY DESCRIPTION
	1410-1035	5	2	BUSHING-PANEL .136-ID 1/4-32-THD .342 LG	28480	1410-1035
	1480-0377	3	2	PIN-ALIGNMENT .187-IN-DIA .875-IN-LG SST	28480	1400-0377
	2190-0016	3	2	WASHER-LK HLCL NO. 8 .377-IN-ID	28480	2190-0016
	2190-0017	4	4	WASHER-LK HLCL NO. 8 .168-IN-ID (for mounting T1)	28480	2190-0017
	2190-0046	9	5	WASHER-LK HLCL NO. 6 .141-IN-ID	28480	2190-0046
	2190-0060	7	1	WASHER-LK INTL T 1/4-IN .256-IN-ID	28480	2190-0060
	2190-0124	4	1	WASHER-LK INTL T NO. 10 .195-IN-ID	28480	2190-0124
	2200-0103	2	8	SCREW-MACH 4-40 .25-IN-LG PAN-HD-POZI	28480	2200-0103

See introduction to this section for ordering information
* Indicates factory-selected value

Table 6-3. Miscellaneous Parts (Continued)

Reference Designation	HP Part Number	C D	Qty	Description	Mfr Code	Mfr Part Number
	2260-0009	3	2	NUT-HEX WALKWR 4-40-THD .094-IN-THK	00000	ORDER BY DESCRIPTION
	2360-0115	4	36	SCREW-MACH 6-32 .312-IN-LG PAN-HD POZI	00000	ORDER BY DESCRIPTION
	2360-0117	6	2	SCREW-MACH 6-32 .375-IN-LG PAN-HD-POZI	00000	ORDER BY DESCRIPTION
	2360-0118	7	4	SCREW-MACH 6-32 .375-IN-LG 82 DEG	00000	ORDER BY DESCRIPTION
	2360-0123	4	8	SCREW-MACH 6-32 .625-IN-LG PAN-HD POZI	00000	ORDER BY DESCRIPTION
	2360-0125	6	3	SCREW-MACH 6-32 .75-IN-LG PAN-HD POZI	00000	ORDER BY DESCRIPTION
	2360-0200	8	8	SCREW-MACH 6-32 .5-IN-LG 100 DEG	00000	ORDER BY DESCRIPTION
	2360-0220	2	5	SCREW-MACH 6-32 2.25-IN-LG PAN-HD POZI	00000	ORDER BY DESCRIPTION
	2360-0242	8	1	SCREW-MACH 6-32 .125-IN-LG PAN-HD POZI	00000	ORDER BY DESCRIPTION
	2360-0331	6	2	SCREW-MACH 6-32 .25-IN-LG PAN-HD POZI	00000	ORDER BY DESCRIPTION
	2360-0333		33	SCREW-(Top Cover)	28480	2360-0333
	2420-0001	5	6	NUT-HEX WALKWR 6-32-THD .109-THK	00000	ORDER BY DESCRIPTION
	2510-0046	9	19	SCREW-MACH 8-32 .375-IN-LG 82-DEG	00000	ORDER BY DESCRIPTION
	2510-0136	8	4	SCREW-MACH 8-32 2.5-IN-LG PAN-HD-POZI (for mounting T1)	00000	ORDER BY DESCRIPTION
	2950-0001	8	8	NUT-HEX DBL-CHAM 3/8-32-THD .094-IN-THK	00000	ORDER BY DESCRIPTION
	2950-0035	8	2	NUT-HEX DBL-CHAM 15/32-32 THD	00000	ORDER BY DESCRIPTION
	2950-0043	8	3	NUT-HEX DBL-CHAM 3/8-32-THD .094-IN-THK	00000	ORDER BY DESCRIPTION
	2950-0052	9	2	NUT-HEX DBL-CHAM 1/4-40-THD .062-IN-THK	00000	ORDER BY DESCRIPTION
	2950-0072	3	2	NUT-HEX DBL-CHAM 1/4-32-THD .062-IN-THK	00000	ORDER BY DESCRIPTION
	2950-0078	9	1	NUT-HEX DBL-CHAM 10-32-THD .067-IN-THK	28480	2950-0078
	3050-0001		15	WASHER, FL (for Mounting T1)		
	3050-0017	9	2	WASHER-FL MTLT 1/4-IN- .26-IN-ID	28480	3050-0017
	3050-0105	6	2	WASHER-FL MTLT NO. 4 .125-IN-ID	28480	3050-0105
	3050-0619	7	1	WASHER-FL MTLT NO. 6 .142-IN-ID	28480	3050-0619
	4324-0202	6	0.5	PAD, FM ANTI-STAT	28480	4324-0202
	7120-4006	7	1	LABEL, FUSE WARNING	28480	7120-4006
	7120-4301	5	1	LABEL, LINE VOLTAGE	28480	7120-4301
	7120-8732	4	1	LABEL, SHOCK WARNING	28480	7120-8732
	7124-0891	3	1	LABEL, HP LOGO	28480	7124-0891
	05345-00012	6	1	PLATE, PATCH #1	28480	05345-00012
	05345-00036		1	INSULATOR-TRANSFORMER (T1)	28480	05345-00036
	05345-00037	5	1	SHIELD, INPUT AMP	28480	05345-00037
	05345-00038	6	1	BRACKET- 12 CKD CONNECTOR (OPT 012)	28480	05345-00038
	08620-20061	7	1	BUSHING-SCREW	28480	08620-20061

See introduction to this section for ordering information
* Indicates factory-selected value

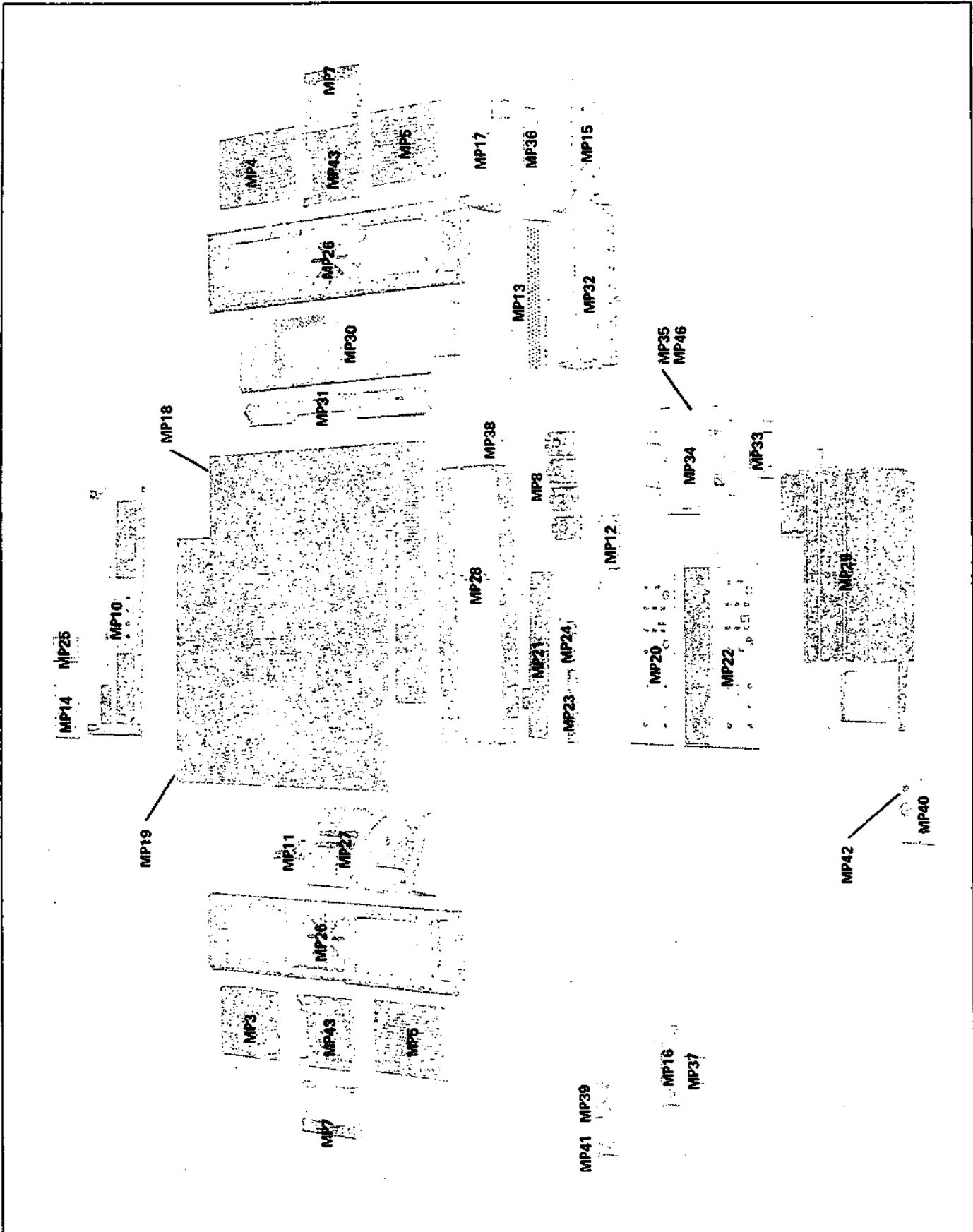


Figure 6-1. Mechanical Parts

Table 6-4 Replaceable Parts for Options

Reference Designation	HP Part Number	C D	Qty	Description	Mfr Code	Mfr Part Number
A12	05345-60018	8	1	I/O INTERFACE ASSEMBLY - OPTION 011	28480	05345-60018
A12C1	0180-2929	8	2	CAPACITOR-FXD 68UF ±10% 10V TA	28480	0180-2929
A12C2	0160-3879	7	2	CAPACITOR FXD .01UF ±20% 100VDC CER	28480	0160-3879
A12C3	0180-2929	1	3	CAPACITOR-FXD 220UF ±20% 10V TA	28480	0180-0158
A12C4	0160-0158	9	3	CAPACITOR-FXD 5600PF ±10% 200VDC POLYE	28480	0160-0158
A12C5	0160-0158	9		CAPACITOR-FXD 5600PF ±10% 200VDC POLYE	28480	0160-0158
A12C6	0160-0158	9		CAPACITOR-FXD 5600PF ±10% 200VDC POLYE	28480	0160-0158
A12C99	0160-3879	7		CAPACITOR FXD .01UF ±20% 100VDC CER	28480	0160-3879
A12CR1	1901-1068	5	1	DIODE-SM SIG SCHOTTKY	28480	1901-1068
A12CR2 - CR5	1901-0040	1	5	DIODE-SWITCHING 30V 50MA 2NS DO-35	28480	1901-0040
A12CR99	1901-0040	1		DIODE-SWITCHING 30V 50MA 2NS DO-35	28480	1901-0040
A12J1	1200-0541	1	1	SOCKET-IC DIP 24-PIN DIP-SLDR	28480	1200-0541
A12MP1	5000-9043	6	1	PIN, PC BOARD EXTRACTOR	28480	5000-9043
A12MP2	5040-6843	2	1	EXTRACTOR, PC BOARD	28480	5040-6843
A12Q1	1854-0574	5	1	TRANSISTOR NPN SI PD=500MW FT=125MHZ	28480	1854-0574
A12Q2	1854-0071	7	1	TRANSISTOR NPN SI PD=300MW FT=200MHZ	28480	1854-0071
A12Q3	1853-0058	3	1	TRANSISTOR PNP SI PD=300MW FT=200MHZ	07263	S32248
A12R1	1810-0136	3	2	NETWORK RESISTOR 10-SIP MULTI-VALUE	28480	1810-0136
A12R2	1810-0136	3		NETWORK RESISTOR 10-SIP MULTI-VALUE	28480	1810-0136
A12R3	1810-0041	9	1	NETWORK RESISTOR 9-SIP 2.7K OHM X 8	28480	1810-0041
A12R4	0683-1215	9	4	RESISTOR 120 5% .25W FC TC=-400/+600	01121	CB1215
A12R5	0683-1215	9		RESISTOR 120 5% .25W FC TC=-400/+600	01121	CB1215
A12R6	0683-1025	9	1	RESISTOR 1K 5% .25W FC TC=-400/+600	01121	CB1025
A12R7	0683-2725	8	2	RESISTOR 2.7K 5% .25W FC TC=-400/+700	01121	CB2725
A12R8	0683-4725	2	3	RESISTOR 4.7K 5% .25W FC TC=-400/+700	01121	CB4725
A12R9	0683-1215	9		RESISTOR 120 5% .25W FC TC=-400/+600	01121	CB1215
A12R10	0683-2725	8		RESISTOR 2.7K 5% .25W FC TC=-400/+700	01121	CB2725
A12R11	0683-8225	5	2	RESISTOR 8.2K 5% .25W FC TC=-400/+700	01121	CB8225
A12R12	0683-3035	5	1	RESISTOR 30K 5% .25W FC TC=-400/+800	01121	CB3035
A12R13	0683-8225	5		RESISTOR 8.2K 5% .25W FC TC=-400/+700	01121	CB8225
A12R14	0683-1035	1	1	RESISTOR 10K 5% .25W FC TC=-400/+700	01121	CB1035
A12R15	0683-4725	2		RESISTOR 4.7K 5% .25W FC TC=-400/+700	01121	CB4725
A12R16	0683-4725	2		RESISTOR 4.7K 5% .25W FC TC=-400/+700	01121	CB4725
A12R17	0696-7253	8	1	RESISTOR 5.1K 1% .05W F TC=0±100	24546	C3-1/8-TQ-5111-F
A12R99	0683-1215	9		RESISTOR 120 5% .25W FC TC=-400/+600	01121	CB1215
A12U1	1820-1197	9	3	IC GATE TTL LS NAND QUAD 2-INP	01295	SN74LS00N
A12U2	1820-0621	2	1	IC BFR TTL NAND QUAD 2-INP	01295	SN7438N
A12U3	1820-0174	0	4	IC INV TTL HEX	01295	SN7404N
A12U4	1820-1144	6	3	IC GATE TTL LS NOR QUAD 2-INP	01295	SN74LS02N
A12U5	1820-0075	0	2	IC FF TTL J-K PULSE CLEAR DUAL	01295	SN7473N
A12U6	1820-0075	0		IC FF TTL J-K PULSE CLEAR DUAL	01295	SN7473N
A12U7	1820-1414	3	2	IC GATE TTL LS NAND TPL 3-INP	01295	SN74LS12N
A12U8	1820-0094	3	1	IC GATE DTL NAND QUAD 2-INP	01295	SN15846N
A12U9	1820-0174	0		IC INV TTL HEX	01295	SN7404N
A12U10	1820-1144	6		IC GATE TTL LS NOR QUAD 2-INP	01295	SN74LS02N
A12U11	1820-0174	0		IC INV TTL HEX	01295	SN7404N
A12U12	1820-1056	9	1	IC SCHMITT-TRIG TTL NAND QUAD 2-INP	01295	SN74132N
A12U13	1820-0054	5	1	IC GATE TTL NAND QUAD 2-INP	01295	SN7400N
A12U14	1820-1144	6		IC GATE TTL LS NOR QUAD 2-INP	01295	SN74LS02N
A12U15	1820-1197	9		IC GATE TTL LS NAND QUAD 2-INP	01295	SN74LS00N
A12U16	1820-0833	8	1	IC LCH TTL COM CLEAR 8-BIT	07263	933RPC
A12U17	1820-2053	8	1	IC DCDR TTL LS BCD 4-TO-16-LINE	18324	74LS154N
A12U18	1820-1084	3	2	IC DRVR TTL BUS DRVR QUAD 1-INP	18324	N8TO9N
A12U19	1820-1084	3		IC DRVR TTL BUS DRVR QUAD 1-INP	18324	N8TO9N
A12U20	1820-1199	1	2	IC INV TTL LS HEX 1-INP	01295	SN74LS04N

See introduction to this section for ordering information
* Indicates factory-selected value

Table 6-4 Replaceable Parts for Options

Reference Designation	HP Part Number	C D	Qty	Description	Mfr Code	Mfr Part Number
A12U21	1820-1207	2	1	IC GATE TTL LS NAND 8-INP	01295	SN74LS30N
A12U22	1820-1197	9		IC GATE TTL LS NAND QUAD 2-INP	01295	SN74LS00N
A12U23	1820-1199	1		IC INV TTL LS HEX 1-INP	01295	SN74LS04N*
A12U24	1820-0626	7	5	IC LCH TTL 4-BIT	04713	MC831RP
A12U25	1820-0626	7		IC LCH TTL 4-BIT	04713	MC831RP
A12U26	1820-0626	7		IC LCH TTL 4-BIT	04713	MC831RP
A12U27	05345-80006	6	1	ROM-PROGRAMMED	28480	05345-80006
A12U28	1820-1470	1	1	IC MUXR/DATA-SEL TTL LS 2-TO-1 LINE QUAD	01295	SN74LS157N
A12U29	05345-80005	5	1	ROM-PROGRAMMED	28480	05345-80005
A12U30	1820-0706	4	1	IC COMPUTER TTL MAGTD 5-BIT	07263	9324PC
A12U31	1820-0907	7	1	IC GATE TTL NAND TPL 3-INP	01295	SN7412N
A12U32	1820-0626	7		IC LCH TTL 4-BIT	04713	MC831RP
A12U33	1820-0174	0		IC INV TTL HEX	01295	SN7404N
A12U34	1820-0175	1	1	IC INV TTL HEX 1-INP	01295	SN7405N
A12U35	1820-0626	7		IC LCH TTL 4-BIT	04713	MC831RP
A12U99	1820-1425	6	1	IC SCHMITT-TRIG TTL LS NAND QUAD 2-INP	01295	SN74LS132N
	0360-0124	3	5	CONNECTOR-SGL CONT PIN .04-IN-BSC-SZ RND	28480	0360-0124
	8159-0005	0	1	RESISTOR-ZERO OHMS 22 AWG LEAD DIA	28480	8159-0005
A19	05345-60019	9	1	INTERFACE PANEL - OPTION 011	28480	05345-60019
	0380-0643	3	5	STANDOFF-HEX .255-IN-LG 6-32-THD	00000	ORDER BY DESCRIPTION
	0510-0002	5	1	THREADED INSERT NUT 6-32 .062-IN-LG STL	28480	0510-0002
	1251-3283		1	CONNECTOR- MICRORIBBON 24-CKT, 24-CONT	28480	1251-3283
	1530-1098	4	1	CLEVIS 0.070-IN W SLT 0.454-IN PIN CTR	00000	ORDER BY DESCRIPTION
	2190-0017	4	2	WASHER-LK HLCL NO. 8 .168-IN-ID	28480	2190-0017
	8120-0664	6	1	CABLE ASSEMBLY, 26AWG 24-COND	28480	8120-0664

See introduction to this section for ordering information
* Indicates factory-selected value

Table 6-4 Replaceable Parts for Options (Continued)

Reference Designation	HP Part Number	C D	Qty	Description	Mfr Code	Mfr Part Number
A3	05345-60239	4	1	INPUT ATTENUATOR ASSEMBLY - OPTION 012 NOTE: A3 - Option 012 consists of a standard A3 assembly (05345-60238) plus the following parts:	28480	05345-60239
A3W1	05345-60191	8	1	WIRE ASSEMBLY - WHITE (FROM A3 TO A20)	28480	05345-60191
A3W2	05345-60192	9	1	WIRE ASSEMBLY - VIOLET (FROM A3 TO A20)	28480	05345-60192
A12	05345-60121	4	1	HP-IB INTERFACE ASSEMBLY - OPTION 012	28480	05345-60121
A12C1	0160-0194	3	1	CAPACITOR-FXD .015UF +10% 200VDC POLYE	28480	0160-0194
A12C2, C3	0160-0158	9	3	CAPACITOR-FXD 5600PF +10% 200VDC POLYE	28480	0160-0158
A12C4	0160-2929	8	1	CAPACITOR-FXD 686K 10V AX TA	28480	0160-2929
A12C5	0160-0158	9	1	CAPACITOR-FXD 5600PF +10% 200VDC POLYE	28480	0160-0158
A12C6, C7	0160-3879	7	2	CAPACITOR FXD .01UF +20% 100VDC CER	28480	0160-3879
A12C8 - C11				NOT ASSIGNED		
A12C12	0160-4822	2	1	CAPACITOR-FXD 1000PF +5% 100VDC CER	28480	0160-4822
A12C99	0160-3879	7	1	CAPACITOR FXD .01UF +20% 100VDC CER	28480	0160-3879
A12CR1				NOT ASSIGNED		
A12CR2 - CR4	1901-0040	1	5	DIODE-SWITCHING 30V 50MA 2NS DO-35	28480	1901-0040
A12CR5 - CR7	1901-0535	9	3	DIODE-SM SIG SCHOTTKY	28480	1901-0535
A12CR8	1901-1068	5	1	DIODE-SM SIG SCHOTTKY	28480	1901-1068
A12CR9	1901-0040	1	1	DIODE-SWITCHING 30V 50MA 2NS DO-35	28480	1901-0040
A12CR10	1901-0071	0	1	DIODE-ZNR 9V 5% DO-14 PD= .4W TC=+.001%	28480	1902-0071
A12CR99	1901-0040	1	1	DIODE-SWITCHING 30V 50MA 2NS DO-35	28480	1901-0040
A12J1	1200-0485	2	1	SOCKET-IC 14-CONT DIP DIP-SLDR	28480	1200-0485
A12J2	1200-0541	1	1	SOCKET-IC 24-CONT	28480	1200-0541
A12MP1	5000-9043	6	1	PIN, PC BOARD EXTRACTOR	28480	5000-9043
A12MP2	5040-6843	2	1	EXTRACTOR, PC BOARD	28480	5040-6843
A12Q1	1853-0058	3	1	TRANSISTOR PNP SI PD=300MW FT=200MHZ	07263	S32248
A12R1	1810-0041	9	1	NETWORK RESISTOR 9-SIP 2.7K OHM X 8	28480	1810-0041
A12R2	0757-0924	2	1	RESISTOR 1K 2% .125W F TC=0+100	24546	C4-1/8-TO-1001-G
A12R3	0683-1025	9	2	RESISTOR 1K 5% .25W FC TC=400+600	01121	CB1025
A12R4	0683-4735	4	7	RESISTOR 47K 5% .25W FC TC=400+600	01121	CB4735
A12R5	0683-1035	1	1	RESISTOR 10K 5% .25W FC TC=400+700	01121	CB1035
A12R6	0683-4735	4	1	RESISTOR 47K 5% .25W FC TC=400+600	01121	CB4735
A12R7 - R9	0683-1215	9	5	RESISTOR 120 5% .25W FC TC=400+600	01121	CB1215
A12R10	0683-1025	9	1	RESISTOR 1K 5% .25W FC TC=400+600	01121	CB1025
A12R11 - R13	0683-4735	4	1	RESISTOR 47K 5% .25W FC TC=400+600	01121	CB4735
A12R14	0683-1215	9	1	RESISTOR 120 5% .25W FC TC=400+600	01121	CB1215
A12R15 - R16	0683-4735	4	1	RESISTOR 47K 5% .25W FC TC=400+600	01121	CB4735
A12R17	1810-0136	3	2	NETWORK RESISTOR 10-SIP MULTI-VALUE	28480	1810-0136
A12R18	0698-4009	6	6	RESISTOR 50K 1% .125W F TC=0+100	24546	C4-1/8-TO-5002-F
A12R19	0698-4009	6	1	RESISTOR 50K 1% .125W F TC=0+100	24546	C4-1/8-TO-5002-F
A12R20	0757-0465	6	10	RESISTOR 100K 1% .125W F TC=0+100	24546	C4-1/8-TO-1003-F
A12R21	0698-4009	6	1	RESISTOR 50K 1% .125W F TC=0+100	24546	C4-1/8-TO-5002-F
A12R22	0757-0465	6	1	RESISTOR 100K 1% .125W F TC=0+100	24546	C4-1/8-TO-1003-F
A12R23	0698-4009	6	1	RESISTOR 50K 1% .125W F TC=0+100	24546	C4-1/8-TO-5002-F
A12R24	0757-0465	6	1	RESISTOR 100K 1% .125W F TC=0+100	24546	C4-1/8-TO-1003-F
A12R25	0698-4009	6	1	RESISTOR 50K 1% .125W F TC=0+100	24546	C4-1/8-TO-5002-F
A12R26 - R28	0757-0465	6	1	RESISTOR 100K 1% .125W F TC=0+100	24546	C4-1/8-TO-1003-F
A12R29	0698-4009	6	1	RESISTOR 50K 1% .125W F TC=0+100	24546	C4-1/8-TO-5002-F
A12R30	0757-0465	6	1	RESISTOR 100K 1% .125W F TC=0+100	24546	C4-1/8-TO-1003-F
A12R31	1810-0055	5	1	NETWORK RESISTOR 9-SIP 10.0K OHM X 8	28480	1810-0055
A12R32 - R34	0757-0465	6	1	RESISTOR 100K 1% .125W F TC=0+100	24546	C4-1/8-TO-1003-F
A12R35	1810-0136	3	1	NETWORK RESISTOR 10-SIP MULTI-VALUE	28480	1810-0136
A12R36, R37	0811-0640	5	10	RESISTOR 100K .01% .125W PWW TC=0+10	28480	0811-0640
A12R38	0698-3157	3	2	RESISTOR 19.6K 1% .125W F TC=0+100	24546	C4-1/8-TO-1962-F
A12R39	0611-0640	5	1	RESISTOR 100K .01% .125W PWW TC=0+10	28480	0611-0640
A12R40	0811-0848	3	6	RESISTOR 50K .01% .125W PWW TC=0+10	28480	0811-0848
A12R41	0757-0459	8	2	RESISTOR 56.2K 1% .125W F TC=0+100	24546	C4-1/8-TO-5622-F
A12R42				JUMPER		
A12R43, R44	0811-0640	5	1	RESISTOR 100K .01% .125W PWW TC=0+10	28480	0811-0640
A12R45	0811-0696	1	3	RESISTOR 91K 1% .125W PWW TC=0+5	28480	0811-0696

See introduction to this section for ordering information
*Indicates factory-selected value

Table 6-4 Replaceable Parts for Options (Continued)

Reference Designation	HP Part Number	C D	Qty	Description	Mfr Code	Mfr Part Number	
A12R46	0811-0640	5	10	RESISTOR 100K .01% .125W PWW TC=0+10	28480	0811-0640	
A12R47, R48	0811-0618	7		RESISTOR 100K .1% .125W PWW TC=0+10	28480	0811-0618	
A12R49	0811-0648	3		RESISTOR 50K .01% .125W PWW TC=0+10	28480	0811-0648	
A12R50	0698-3157	3		RESISTOR 19.6K 1% .125W F TC=0+100	24546	C4-1/8-TC-1962-F	
A12R51	0811-0648	3	5	RESISTOR 50K .01% .125W PWW TC=0+10	28480	0811-0648	
A12R52, R53	0811-0618	7		RESISTOR 100K .1% .125W PWW TC=0+10	28480	0811-0618	
A12R54	0811-0640	5		RESISTOR 100K .01% .125W PWW TC=0+10	28480	0811-0640	
A12R55				JUMPER			
A12R56	0811-0648	3	5	RESISTOR 50K .01% .125W PWW TC=0+10	28480	0811-0648	
A12R57, R58	0811-0618	7		RESISTOR 100K .1% .125W PWW TC=0+10	28480	0811-0618	
A12R59, R60	0811-0640	5		RESISTOR 100K .01% .125W PWW TC=0+10	28480	0811-0640	
A12R61	0811-0645	0	2	RESISTOR 409.09K .01% .125W PWW TC=0+100	28480	0811-0465	
A12R62, R63	0811-0618	7		RESISTOR 100K .1% .125W PWW TC=0+10	28480	0811-0618	
A12R64	0757-0459	8		RESISTOR 56.2K 1% .125W F TC=0+100	24546	C4-1/8-TC-5622-F	
A12R65	0811-0618	7		RESISTOR 100K .1% .125W PWW TC=0+10	28480	0811-0618	
A12R66	0811-0647	2	6	RESISTOR 50K .1% .125W PWW TC=0+10	28480	0811-0647	
A12R67	0811-0618	7		RESISTOR 100K .1% .125W PWW TC=0+10	28480	0811-0618	
A12R68	0811-0648	3		RESISTOR 50K .01% .125W PWW TC=0+10	28480	0811-0648	
A12R69	2100-2503	8		RESISTOR-TRMR 20K 10% C SIDE-ADJ 17-TRN	32997	3009P-1-203	
A12R70	0811-0696	1		RESISTOR 81K 1% .125W PWW TC=0+5	28480	0811-0696	
A12R71, R72	0811-0647	2		RESISTOR 50K .1% .125W PWW TC=0+10	28480	0811-0647	
A12R73	0811-0640	5		RESISTOR 100K .01% .125W PWW TC=0+10	28480	0811-0640	
A12R74	2100-2706	3	2	RESISTOR-TRMR 10K 10% C-SIDE ADJ 17-TRN	32997	3009P-1-103	
A12R75*	0811-2592	0		1	RESISTOR 11K 1% .125W PWW TC=0+10	28480	0811-2592
A12R76	0757-0418	9	1	RESISTOR 619 1% .125W F TC=0+100	24546	C4-1/8-TC-619R-F	
A12R77, R78	0811-0647	2		RESISTOR 50K .1% .125W PWW TC=0+10	28480	0811-0647	
A12R79	0811-0648	3		RESISTOR 50K .01% .125W PWW TC=0+10	28480	0811-0648	
A12R80	0811-0647	2		RESISTOR 50K .1% .125W PWW TC=0+10	28480	0811-0647	
A12R81	0811-0640	5		RESISTOR 100K .01% .125W PWW TC=0+10	28480	0811-0640	
A12R82	2100-2706	3	2	RESISTOR-TRMR 10K 10% C-SIDE ADJ 17-TRN	32997	3009P-1-103	
A12R83, R84	0811-0644	9		RESISTOR 450K .01% .125W PWW TC=0+10	28480	0811-0644	
A12R85	0811-0645	0		RESISTOR 409.09K .01% .125W PWW TC=0+100	28480	0811-0465	
A12R86	2100-2503	8		RESISTOR-TRMR 20K 10% C SIDE-ADJ 17-TRN	32997	3009P-1-203	
A12R87	0698-3437	2	1	RESISTOR 133 1% .125W F TC=0+100	24546	C4-1/8-TC-133R-F	
A12R89	0683-1215	9		RESISTOR 120 5% .25W FC TC=400/4600	01121	CB1215	
A12U1	1820-1202	7		3	IC GATE TTL LS NAND TPL 3-INP	01295	SN74LS10N
A12U2 - U3	1820-1418	7	2	IC DDDR TTL LS BCD-TO-DEC 4-TO-10-LINE	01295	SN74LS42N	
A12U4	05345-80011	3		1	ROM-PROGRAMMED	28480	05345-80011
A12U5	0490-1063	6	1	RELAY-REED 2A 500MA 50VDC 5VDC-COIL 10VA	28480	0490-1063	
A12U6 - U7	1820-0493	6		3	IC OP AMP GP 8-DIP-P PKG	27014	LM307N
A12U8					NOT ASSIGNED		
A12U9	1820-0077	2	2	IC FF TTL D-TYPE POS-EDGE-TRIG CLEAR	01295	SN7474N	
A12U10	1820-1197	9		5	IC GATE TTL LS NAND QUAD 2-INP	01295	SN74LS00N
A12U11	1820-1056	9	1	IC SCHMITT-TRIG TTL LS INV HEX 2-INP	01295	SN74132N	
A12U12	1820-1199	1		4	IC INV TTL LS HEX 1-INP	01295	SN74LS04N
A12U13	1820-0174	0	1	IC INV TTL HEX	01295	SN7404N	
A12U14	1820-0708	4		1	IC COMPUTER TTL MAGTD 5-BIT	07263	9324PC
A12U15 - U16	1813-0054	0	2	IC SWITCH ANALOG DUAL 14-DIP-C PKG	27014	AH0154D	
A12U17	1820-1416	5		1	IC SCHMITT-TRIG TTL LS INV HEX 1-INP	01295	SN74LS14N
A12U18	1820-1144	6	2	IC GATE TTL LS NOR QUAD 2-INP	01295	SN74LS02N	
A12U19	1820-1200	5		2	IC INV TTL LS HEX	01295	SN74LS05N
A12U20 - U21	1820-0075	0	2	IC FF TTL J-K PULSE CLEAR DUAL	01295	SN7473N	
A12U22	1820-1202	7		7	IC GATE TTL LS NAND TPL 3-INP	01295	SN74LS10N
A12U23	1820-0493	6	0	IC OP AMP GP 8-DIP-P PKG	27014	LM307N	
A12U24	1813-0054	0		IC SWITCH ANALOG DUAL 14-DIP-C PKG	27014	AH0154D	
A12U25	1820-0077	2	1	IC FF TTL D-TYPE POS-EDGE-TRIG CLEAR	01295	SN7474N	
A12U26	1820-1204	9		1	IC GATE TTL LS NAND DUAL 4-INP	01295	SN74LS20N
A12U27	1820-0621	2	2	IC BFR TTL NAND QUAD 2-INP	01295	SN7438N	
A12U28	1820-0094	3		1	IC GATE DTL NAND QUAD 2-INP	01295	SN15846N
A12U29	1820-1144	6		IC GATE TTL LS NOR QUAD 2-INP	01295	SN74LS02N	

See introduction to this section for ordering information
*Indicates factory-selected value

Table 6-4 Replaceable Parts for Options (Continued)

Reference Designation	HP Part Number	C D	Qty	Description	Mfr Code	Mfr Part Number
A12U30 - U31	1820-1197	9		IC GATE TTL LS NAND QUAD 2-INP	01295	SN74LS00N
A12U32	1820-0976	0	4	IC SHF-RGTR CMOS D-TYPE SERIAL-IN	3L585	CD4015BE
A12U33	1820-0928	2	4	IC BFR CMOS QUAD	3L585	CD4041A3
A12U34	1820-1084	3	2	IC DRVR TTL BUS DRVR QUAD 1-INP	18324	N8TO9N
A12U35	1820-1199	1		IC INV TTL LS HEX 1-INP	01295	SN74LS04N
A12U36	1820-1197	9		IC GATE TTL LS NAND QUAD 2-INP	01295	SN74LS00N
A12U37	1820-0626	7	5	IC LCH TTL 4-BIT	04713	MC8314P
A12U38	1820-0633	8	1	IC LCH TTL COM CLEAR 8-BIT	07263	9334PC
A12U39	1820-0907	7	1	IC GATE TTL NAND TL 3-INP	01295	SN7412N
A12U40	1820-1199	1		IC INV TTL LS HEX 1-INP	01295	SN74LS04N
A12U41	1820-0621	2		IC BFR TTL NAND QUAD 2-INP	01295	SN7438N
A12U42	1820-0976	0		IC SHF RGTR CMOS D-TYPE SERIAL-IN	3L585	CD4015BE
A12U43	1820-0928	2		IC BFR CMOS QUAD	3L585	CD4041A3
A12U44	05345-80005	5	1	ROM-PROGRAMMED	28480	05345-80005
A12U45	1820-1084	3		IC DRVR TTL BUS DRVR QUAD 1-INP	18324	N8TO9N
A12U46	1820-1202	7		IC GATE TTL LS NAND TPL 3-INP	01295	SN74LS10N
A12U47 - U49	1820-0626	7		IC LCH TTL 4-BIT	04713	MC8314P
A12U50	1820-0668	7	1	IC BFR TTL NON-INV HEX 1-INP	01295	SN7407N
A12U51	1820-0928	2		IC BFR CMOS QUAD	3L585	CD4041A3
A12U52	05345-80006	6	1	ROM-PROGRAMMED	28480	05345-80006
A12U53	1820-1470	1	1	IC MUXR/DATA-SEL TTL LS 2-TO-1-LINE QUAD	01295	SN74LS157N
A12U54	1820-1197	9		IC GATE TTL LS NAND QUAD 2-INP	01295	SN74LS00N
A12U55	1820-2053	8	1	IC DCDR TTL LS BCD 4-TO-16-LINE	18324	74LS154N
A12U56	1820-0626	7		IC LCH TTL 4-BIT	04713	MC8314P
A12U57	1820-1199	1		IC INV TTL LS HEX 1-INP	01295	SN74LS04N
A12U58	1820-1200	5		IC INV TTL LS HEX	01295	SN74LS05N
A12U59 - U60	1820-0976	0		IC SHF RGTR CMOS D-TYPE SERIAL-IN	3L585	CD4015BE
A12U61	1820-0928	2		IC BFR CMOS QUAD	3L585	CD4041A3
A12U99	1820-1426	6	1	IC SCHMITT-TRIG TTL LS NAND QUAD 2-INP	01295	SN74LS132N
A12XU4	1200-0473	8	1	SOCKET-IC 16-CONT DIP DIP-SLDR	28480	1200-0473
	0360-0065	1	2	TERMINAL-STUD FKD-TUR SWGFRM-MTG	28480	0360-0065
	0360-0124	3	4	CONNECTOR-SGL CONT PIN .04-IN-BSC-SZ RND	28480	0360-0124
A12ZA5	8159-0005	0	2	RESISTOR-ZERO OHMS 22AWG LEAD DIA	28480	8159-0005
A19	05345-60022	4	1	INTERFACE PANEL - OPTION 012	28480	05345-60022
A19W1	8120-0664	6	1	CABLE ASSEMBLY 26AWG 24-CNDCT	28480	8120-0664
	05345-00022	1	1	PLATE, REAR PANEL PATCH		
	0380-0643	3	2	STANDOFF-HEX .255-IN-LG 6-32-THD	00000	ORDER BY DESCRIPTION
	0510-0002	5	1	THREADED INSERT-NUT 6-32 .062-IN-LG STL	28480	0510-0002
	1251-3283	1	1	CONNECTOR-RECT MICRORIBBON 24-CKT 24-CONT	28480	1251-3283
	1530-1098	4	1	CLEAVIS 0.070-IN W SLT: 0.454-IN-PIN CTR	00000	ORDER BY DESCRIPTION
	2190-0017	4	2	WASHER-LK HLCL NO. 8 .168-IN-ID	28480	2190-0017
A20	06345-60130	4	1	FILTER ASSEMBLY - OPTION 012	28480	05345-60130
A20C1-C4				NOT ASSIGNED		
A20C5	0180-1701	2	2	CAPACITOR-FXD 6.8UF +20% 5VDC TA	56289	150D685X0006A2
A20C6 - C7				NOT ASSIGNED		
A20C8	0180-1701	2		CAPACITOR-FXD 6.8UF +20% 5VDC TA	56289	150D685X0006A2
A20R1 - R4				NOT ASSIGNED		
A20R5	0683-1015	7	2	RESISTOR 100 5% .25W FC TC=-400/+500	01121	CB1015
A20R6 - R7				NOT ASSIGNED		
A20R8	0683-1015	7		RESISTOR 100 5% .25W FC TC=-400/+500	01121	CB1015
	1251-0600	0	2	CONNECTOR-SGL CONTACT	28480	1251-0600

See introduction to this section for ordering information.
*Indicates factory-selected value

Table 6-5. Manufacturers Code List

MFR. NO.	MANUFACTURER NAME	ADDRESS	ZIP CODE
00000	Any Satisfactory Supplier		
S0545	Nippon Electric Co.	Tokyo, Japan	
00115	Ace Glass Inc	Vineland, NJ	
00853	Westin Incorporated	Norcross, GA	30071
00904	Denver Plastic Inc	Lakewood, CO	80214
01121	Allen Bradley Company	Milwaukee, WI	79935
01295	Texas Instr. Semicond. Cmpnt Div.	Dallas, TX	75265
04713	Motorola Incorporated	Roselle, IL	04713
07263	Fairchild Semiconductor Corporation	Cupertino, CA	95014
14193	Cal-R Inc	Santa Monica, CA	90404
18324	Signetics Corp	Sunnyvale, CA	94086
19701	Mepco/Electra Corporation	Mineral Wells, TX	76067
24046	Transitron Electronic Corporation	Wakefield, MA	01880
24546	Corning Glass Works (Bradford)	Corning, NY	14830
27014	National Semiconductor Corporation	Santa Clara, CA	95052
28480	Hewlett-Packard Co. Corporate Hq	Palo Alto, CA	94304
3L585	RCA Corporation	New York, NY	10112
32997	Boums Inc. Trimpot Prod Division	Riverside, CA	92507
52763	Stettner Electronics Incorporated	Lauf, Germany	D-856
56289	Sprague Electric Co	Lexington, MA	01273
72136	Electro Motive Corporation	Florence, SC	06226
72982	Erie Technological Products Inc	Erie, PA	16512
73138	Beckman Instruments, Inc Helipot Div.	Fullerton, CA	92635
73899	J.F.D. Electronics Corporation	Brooklyn NY	11219
74970	Johnson E.F. Co	Waseca, MN	56093
75915	Littlefuse Incorporated	Des Plaines, IL	60016
82389	Switchcraft Inc	Chicago II	60630
84411	TRW Capacitor Division	Camden, NJ	08103
91637	Dale Electronics, Inc.	Columbus, NE	68601
98291	Sealectro Corporation	Portsmouth, England	

SECTION VII OPTIONS AND MANUAL CHANGES

7-1. INTRODUCTION

7-2. This section contains information necessary to adapt this manual to older instruments. Also included is information for available options. Refer to Section III for remote programming information.

7-3. OPTIONS

7-4. The following is a list of available options. Option 011, General Purpose Interface I/O (provides digital output and input control over all functions except input amplifier). Option 012 is similar to Option 011 but includes level and slope control. Correction of faults in Option 012 (05345-60121) board are accomplished under HP Exchange program by board replacement. Order HP Part No. 05345-60621 assembly from nearest HP Sales Service Office. (See Section II for full description and programming details.)

7-5. FIELD INSTALLATION OF OPTIONS

7-6. All options are field installable.

7-7. Option 011 is installed by removing the rightmost patch panel on the counter's rear panel and substituting the A19 Interface Panel. Install the A12 board into the motherboard connectors marked XA12, and connect the A19 ribbon cable to the socket on A12. Note the position of pin one when performing this connection.

Option 011	A12 05345-60018	} May be ordered under a single number 05345-60209
	A19 05345-60019	

7-8. MANUAL CHANGES

7-9. This manual applies directly to HP 5345A Electronic Counters with Serial Prefix 3103A. Refer to paragraph 1-4 for a description of the serial prefix effectively.

7-10. Newer Instruments

7-11. As changes are made, newer instruments may have serial prefixes that are not listed in this manual. The manual for these instruments is supplied with a manual change sheet which contains the required updating information. If this sheet is missing, contact the nearest Hewlett-Packard Sales Office listed at the back of this manual.

7-12. Older Instruments

7-13. To adapt this manual to instruments having a serial prefix prior to 3103A, perform the backdating that applies to your instrument's serial prefix as listed in Table 7-1.

Table 7-1. Manual Backdating

If Your Instrument Has Serial Prefix	Make the following Changes to Your Manual
3103A (A3, Date Code below 91094)	1
Fan Bracket	1,2
A14 Qualifier Assembly, Series 2928	1,2,3
Serial 2928A13419 and below with Option 010, Oscillator	1 thru 4
Serial 2928A13380 and below w/Opt 001, 10 MHz Voltage Controlled Oscillator- <i>ON 2/11/02</i>	1 thru 5
2816A	1 thru 6
2740A A9 Main Gate Assembly	1 thru 7
2648A, A10 Gate Control Assembly	1 thru 8
2648A A9 Main Gate Assembly	1 thru 9
2426A, A9	1 thru 10
2420A (Option 011 & 012 only)	1 thru 11
2346A	1 thru 12
2134A09291 and above	1 thru 13
2134A08181 and above	1 thru 14
2134A08081 and above	1 thru 15
2134A	1 thru 16
2130A	1 thru 17
2128A	1 thru 18
2120A	1 thru 19
2116A	1 thru 20
2112A	1 thru 21
2104A	1 thru 22
2040A	1 thru 23

If Your Instrument Has Serial Prefix	Make the following Changes to Your Manual
2016A	1 thru 24
2012A	1 thru 25
2008A	1 thru 26
2006A	1 thru 27
2004A	1 thru 28
1944A	1 thru 29
1932A	1 thru 30
1912A	1 thru 31
1904A	1 thru 32
1820A	1 thru 33
1808A	1 thru 34
1744A	1 thru 35
1708A	1 thru 36
1644A	1 thru 37
1624A	1 thru 38
1612A	1 thru 39
1604A	1 thru 40
1528A	1 thru 41
1520A	1 thru 42
1516A	1 thru 43
1512A	1 thru 44
1440A	1 thru 45
1438A	1 thru 46
1436A	1 thru 47
1428A	1 thru 48
1424A	1 thru 49
1412A	1 thru 50
1352A	1 thru 51
1340A	1 thru 52

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Co./Dept.		Co.	
Phone #		Phone #	408 553 2243
Fax #	805 734 2154	Fax #	

CHANGE 1

To backdate the A3 Input Attenuator Assembly from Date Code 91094, make the following changes:

Table 6-2. A3 Input Attenuator Assembly Replaceable Parts:

Delete A3C45 and C46 0160-5978 CAPACITOR-FXD 2.2PF +22.73% 50V.

Page 8-31, Figure 8-8. A3 Input Attenuator Assembly (05345-60238):

Delete A3C45 and C46 in parallel with R22 and R28 on schematic diagram and component locator.

CHANGE 2

Table 6-3. Miscellaneous Parts:

Change W2, Power Cable for Option 012, from 05345-60210 to 05345-60087.

Change W11, Power Cable for Option 012, from 05345-60211 to 05345-60068.

Change Fan Bracket part number from 05345-00038 to 05345-00029.

Change connector p/n 1251-5337 to 1251-3803 on cable p/n 05345-60088, and mating connector on 5345A to 1251-3804.

CHANGE 3

To backdate from Series 3103A to 2928A, make the following changes:

4-36-4-37
Pages ~~4-37/4-40~~. Theory Of Operation - A14 Qualifier:

Replace paragraphs 4-217 thru 4-228 with Table 7-2 (paragraphs 4-219 thru 4-240).

6-24
Page ~~6-26~~, Table 6-2. A14 Qualifier Assembly Replaceable Parts:

Replace A14 (05345-60144) Replaceable Parts List with Table 7-3 (05345-60044).

Pages 8-52/8-53, Fig 8-18. A14 Qualifier Assembly Component Locator/Schematic Diagram:

Replace A14 (05345-60144) component locator/schematic with Figure 7-1 A14, (05345-60044).

CHANGE 4

For instruments with Option 010, General Purpose Interface Output, make the following changes:

Page 3-26, Operation and Programming:

Add the following to paragraph 3-84 (a):

Option 010 has SRQ permanently disabled, and thus cannot request service.

Add the following to paragraph 3-84 (b):

Option 010 does not respond to the REN line.

Add "Option 010," to the beginning of the second paragraph of 3-84 (c), and (d):

Page 4-25, Add Table 7-4 (paragraphs 4-176 thru 4-182).

Paragraph 4-281.

Change paragraph heading to read "A19, Option 010, 011, Interface Panel".

Add Table 7-5, A12 Option 010 output Interface Assembly Replaceable Parts.

g-22 Figure ~~8-23~~. A19 Options 011 and 012 Interface Panel Assembly:

Change figure title to read "A19 Options 010, 011, and 012 Interface Assembly".

Add (Option 010, 05345-60024) to figure heading..

CHANGE 5

For instruments with Option 001, 10 MHz Voltage Controlled Oscillator, make the following changes:

Table 1-3, HP 5345A Specifications:

Add the following Option 001 Specifications:

OPTION 001: 10 MHz (crystal frequency) oscillator.

Stability:

Aging Rate: $<3 \times 10^{-7}$ per month for oscillator off-time less than 24 hours. Final value is defined as frequency 24 hours after turn-on.

Short Term: $<2 \times 10^{-9}$ for 1 s average

Temperature: $<2 \times 10^{-6}$, 25°C to 35°C

Line Voltage: $<1 \times 10^{-8}$, $\pm 10\%$ nominal.

External Frequency Standard Input: 1, 2, 2.5, 5, or 10 MHz $\pm 5 \times 10^{-5}$, with input voltage $>1V$ rms into 1K Ω .

Table 5-6. Adjustment Procedure (Continued):

Add "(STANDARD OR OPTION 001)" to A18 OSCILLATOR heading.

Add Table 7-6. A18 Option 001 Oscillator Assembly Replaceable parts.

Add Figure 7-2. A18 Option 001 10 MHz Oscillator Assembly Schematic Diagram.

CHANGE 6

To backdate from Series Prefix 2928A to 2816A, make the following changes:

Page 6-29, Table 6-3. Miscellaneous Electrical Parts:

Change C5 from 0180-0230 (1UF) to 0180-0161 CAPACITOR-FXD 3.3UF -20 +20TAO OHM.

CHANGE 7

To backdate the 5345A from Series 2740A to 2648A, make the following changes:

Pages 6-18/6-21, Table 6-2. A9 Main Gate Assembly Replaceable Parts:

See schematic changes (Page 8-41).

Page 8-41, Figure 8-12. A9 Main Gate Assembly Schematic/Component Locator:

Change the A9 (05345-60099) schematic to show the following pins are not tied together:

A9U1, PINS 14, 15	A9U7, PINS 2,3
A9U2, PINS 2,3	A9U7, PINS 13, 14
A9U4, PINS 2,3	

Instruments with Serial Numbers above 2648A12169 also include changes for Series 2740A.

CHANGE 8

To backdate the A10 Gate Control Assembly from Series 2648 to Series 2104, make the following changes:

Pages 6-21/6-23, Table 6-2. A10 Gate Control Assembly Replaceable Parts:

Change A10 (05345-60050) from Series 2648 to 2104.

Change A10R27, A60, A61 from 0683-0403 (121 ohms) to 0757-0415 RESISTOR 470 1% .12 W F.

Add A10R28, R54, R55, 0683-4715, RESISTOR FXD 470 1% .12W F.

Page 8-43, Figure 8-13. A10 Gate Control Assembly Schematic/Component Locator:

Change A10 (05345-60050) Series from 2648 to 2104.

Change A10R27, R60, R61 values from 121 ohms to 470 ohms.

Schematic Diagram:

Add A10R28 from the emitter of Q7 to +5V.

Add A10R55 from the emitter of Q19 to +5V.

Add A10R54 from the emitter of Q18 to +5V.

Component Locator:

Add A10R28 between R27 and R64.

Add A10R54 between R47 and R60.

Add R55 between R61 and R45.

CHANGE 9

To backdate the 5345A from Series 2740A to 2648A, make the following changes:

Pages 6-18/6-21, Table 6-2. A9 Main Gate Assembly Replaceable Parts:

- Delete the asterisk (*) from A9C25 indicating a factory-selected value.
- Add A9R3 and R6, 0757-0931, RESISTOR 2K 2% .125WF TC=0+-100.

NOTE: A9 (05345-60099) may or may not have A9R3, R6.

Page 8-41, Figure 8-12. A9 Main Gate Assembly Schematic/Component Locator:

- Add A9R3 and R6, 2K ohms, in upper left of schematic.
- Add A9R3 below R10, and R6 between C15 to the right of U15, above R12.

NOTE: A9 (05345-60099) may or may not have A9R3, R6.

CHANGE 10 (2426A)

Page 6-18, Table 6-2. Standard Assembly Replaceable Parts:

- Change A9C25 from 0160-3879 to "NOT USED".

Page 8-41, Figure 8-12. A9 Main Gate Assembly:

- Delete C25 (connected to U1B Pin 14 and R64).

NOTE

Instruments with serial number 2426A10881 and above may or may not have C25 (22 pF) installed.

CHANGE 11 (2420A for Option 011 and 012 Only)

OPTION 011 ONLY:

Page 6-36, Table 6-4. Option Assembly Replaceable Parts:

- Change A12 (05345-60018) SERIES from 2420 to 2134.
- Delete A12C99, A12CR99, A12R99, and A12U99.

Page 8-49, Figure 8-16. A12 Option 011 I/O Interface Assembly:

- Change A12 (05345-60018) SERIES from 2426 to 2134.
- Change "TALK HANDSHAKE" circuit as shown in Figure 7-3. (Delete C99, CR99, R99, and U99).

OPTION 012 ONLY:

Page 6-38, Table 6-4. Option Assembly Replaceable Parts:

- Change A12 (05345-60121) SERIES from 2426 to 2420.
- Delete A12C12, A12C99, A12R99, A12CR99, and A12U99.

Page 8-49A, Figure 8-16A. A12 Option 012 HP-IB Interface Assembly:

- Replace A12 Option 012 Schematic Diagram with Figure 7-4A/B.
- Change A12 (05345-60121) SERIES from 2426 to 2420.

CHANGE 12 (2346A)

Pages 1-3/1-4, Table 1-3. HP 5345A Specifications:

- Replace Table 1-3 with Table 7-5.

Pages 4-12/4-13, Theory of Operation:

- Replace paragraphs 4-84 through 4-92 with Table 7-6.

Pages 5-52/5-53, Table 5-6. Adjustment Procedure:

- Replace A3 and A4 Adjustment Procedure with Table 7-7.

Pages 6-6/6-9, Table 6-2. Standard Assembly Replaceable Parts:

- Replace A3/A4 Parts List with Table 7-8.

Page 6-25, Table 6-2. Standard Assembly Replaceable Parts:

- Change A12 (05345-60121) part number to 05345-60021.

Page 6-32, Table 6-3. Miscellaneous Replaceable Parts:

- Delete 05345-00037, 2360-0242, 3050-0066.

CHANGE 12 (2346A) (Continued)

OPTION 012 ONLY:

Page 6-38, Table 6-4. Option Assembly Replaceable Parts:

- Change A3 (05345-60239) part number to 05345-60039.
- Delete A3W1 05345-60191 and A3W2 05345-60192.

Pages 6-38/6-40, Table 6-4. Option Assembly Replaceable Parts:

- Change A12 (05345-60121) part number to 05345-60021.
- Change A12CR1 from "NOT USED" to 1902-0057 DIODE: BRKDOWN 6.49V.
- Change A12R2 from 0757-0924 to 0683-4725 R:FXD 4700 OHM 5%.25W.
- Add A12XU17 1200-0474 SOCKET:IC 14 PIN
- Add A12XU22 05345-80003 SOCKET:IC 14 PIN LESS PIN 11.

Page 6-41, Table 6-4. Option Assembly Replaceable Parts:

- Change A20 (05345-60130) part number to 05345-60030.
- Add A20C1, A20C2, A20C3, A20C4, A20C6, A20C7 0180-1701 C:FXD 6.8 uF.
- Add A20R1, A20R2, A20R3, A20R4, A20R6, A20R7 R:FXD 100 OHM .25W.

Pages 8-30/8-31, Figure 8-8. A3/A4 Input Assemblies:

- Replace A3/A4 Component/Adjustment Locator and Schematic Diagram with Figures 7-5, 7-6.

CHANGE 13 (2134A09291 and above)

Page 6-29, Table 6-3. Miscellaneous Replaceable Parts:

- Delete 05345-00036 INSULATOR-TRANSFORMER.

CHANGE 14 (2134A08181 and above)

Page 6-30, Table 6-3. Miscellaneous Replaceable Parts:

- Delete W2 (OPTION 012) 05345-60087

CHANGE 15 (2134A08081 and above)

Page 6-28, Table 6-2. Standard Assembly Replaceable Parts:

- Change A18 (10811-60111) to 10544-60011. The oscillators are directly interchangeable.

CHANGE 16 (2134A)

Table 7-8. Standard Assembly Replaceable Parts:

- Change A4R27 and A4R29 from 0757-0276 to 0683-5105 R:FXD 51 OHM 5%.25W.

Figure 7-6. A3/A4 Input Assemblies:

- Change A4R27 and A4R29 to 51 ohms.

CHANGE 17 (2130A)

Pages 6-5/6-6, Table 6-2. Standard Assembly Replaceable Parts:

- Change A2 (05345-60027) SERIES from 2134 to 1352.
- Change A2U2 from 1820-1211 to 1820-0598 IC DM74L86N.
- Change A2U5 from 1820-1202 to 1820-0587 IC DM74L10N.
- Change A2U6 from 1820-1644 to 1820-0914 IC DECODER.

Pages 6-23/6-24, Table 6-2. Standard Assembly Replaceable Parts:

- Change A11 (05345-60011) SERIES from 2134 to 2104.
- Change A11U16,U17,U18,U19 from 1820-2316 to 1820-0634 IC COUNTER.
- Add A11CR5,CR10 1901-0040 DIODE-SWITCHING 2NS 30V 50MA.
- Add A11CR9 1901-0535 DIODE-SCHOTTKY.

Page 6-27, Table 6-2. Standard Assembly Replaceable Parts:

- Change A15 (05345-60045) SERIES from 2134 to 2104.
- Change A15U3,U36 from 1820-1211 to 1820-0598 IC DM74L86N.

Page 6-36, Table 6-4. Option Assembly Replaceable Parts:

- Change A12 (05345-60018) SERIES from 2134 to 2104.
- Delete A12R15,R16,R17.
- Change A12U7 from 1820-1414 to 1820-0587 IC DM74L10N.
- Change A12U30 from 1820-0706 to 1820-0904 IC COMPARATOR.
- Change A12U24, U25, U26, U32, U35 from 1820-0626 to 1820-0701 IC LATCH.

Page 8-29, Figure 8-7. Anode Driver Display Assembly:

- Change A2 (05345-60027) SERIES from 2134 to 1352.

CHANGE 17 (2130A) (Continued)

A2U6 Truth Table, Input Condition "H X H H L H L":

Change "c" in output condition from H to L. Page 8-45, Figure 8-14. A11 Scaler Assembly:

Change A11 (05345-60011) SERIES to 2104.

Add A11R5.

Page 8-49, Figure 8-16. A12 Option 011 I/O Interface:

Change A12 (05345-60018) SERIES from 2134 to 2104.

Delete A12R15,R16,R17.

Page 8-55, Figure 8-19. A15 ROM Assembly:

Change A15 (05345-60045) SERIES from 2134 to 1820.

CHANGE 18 (2128A)

Page 6-26, Table 6-2. A14 Qualifier Assembly:

Change A14 (05345-60044) SERIES from 2130 to 1644.

Change A14U14 from 1820-1112 to 1820-0596 IC DM7474N.

Change A14U24 from 1820-0111 to 1820-0627 IC DECODER.

Change A14U27 from 1820-0610 to 1820-0708 IC MULTIPLEXER.

Change A14U28 from 1820-0706 to 1820-0904 IC COMPARATOR.

Change A14U37 from 1820-1211 to 1820-0598 IC DM74L86N.

Change A14U38 from 1820-0075 to 1820-0595 IC DM74L73N.

Change A14U2,U3,U7,U8,U11,U15 from 1820-0615 to 1820-0658 IC MULTIPLEXER.

Page 8-53, Figure 8-18. A14 Qualifier Assembly:

Change A14 (05345-60044) SERIES from 2130 to 2104.

Change pin numbers on U37B and U37C.

Interchange pins 6 and 4 on U37B and pins 8 and 10 on U37C.

CHANGE 19 (2120A)

Table 7-4. Standard Assembly Replaceable Parts:

Change A3 (05345-60038 & 05345-60039) SERIES from 2420 to 2116.

Change A3R10, R12 from 0757-0283 to 0683-2025 2K 5% .25W.

Change A3R22, R25 from 0698-7233 to 0698-6241 750 5% .125W.

Change A3R27, R50 from 0757-0424 to 0683-1125 1.1K 5%.25W.

Change A3R30, R49 from 0698-7188 to 0698-6283 10 5%.125W.

Change A3R31 from 0757-0427 to 0683-1525 1.5K 5% .25W.

Change A3R32 from 0698-7240 to 0698-5178 1.5K 5%.125W.

Change A3R33, R35, R41, R42 from 0698-7243 to 0698-3113 100 5% .125W.

Change A3R37, R39, R55, R57 from 0698-7205 to 0698-3378 51 5% .125W

Change A3R38, R40 from 0757-0280 to 0683-1025 1K 5%.25W.

Change A3R43, R46 from 0698-7228 to 0698-6984 470 5% .125W.

Change A3R48 from 0698-7221 to 0698-5564 240 5%.125W.

Change A3R51,R52,R53,R54 from 0757-0424 to 0683-1125 51 5% .125W.

Change A3R59,R60,R61,R62, from 0698-7214 to 0683-5105 51 5% .25W.

CHANGE 20 (2116A)

Page 6-25, Table 6-2. Standard Assembly Replaceable Parts:

Change A13 (05345-60013) SERIES from 2120 to 2004.

Change A13U24 from 1820-1211 to 1820-0598 IC DM74L86N

Page 8-51, Figure 8-17. Adder/Subtractor Assembly:

Change A13 (05345-60013) SERIES from 2120 to 2004.

Change A13U24B pin number 4 to pin number 6, and pin number 6 to pin number 4.

CHANGE 21 (2112A)

Page 6-14, Table 6-2. Standard Assembly Replaceable Parts:

Change A8C56 from 0140-0202 to 0160-2198 15pF 5% 500VDC.

Page 8-39, Figure 8-11. PLL Multiple Noise Generator Assembly:

Change A3C56 to 15 pF.

CHANGE 22 (2104A)

Page 6-25, Table 6-2. Standard Assembly Replaceable Parts:

- Change A13 (05345-60013) SERIES from 2120 to 2004.
- Change A13U14, U26 from 1820-0610 to 1820-0584 IC DM74L02N
- Change A13U24 from 1820-1211 to 1820-0598 IC DM74L86N

Page 6-29, Table 6-3. Miscellaneous Replaceable Parts:

- Change S7 from 3101-2479 to 3101-0529 SWITCH-SL DP3T-NS 1A 125VAC.
- Change S8 and S9 from 3101-0957 to 3101-1541 SWITCH-SL SPST-NS 1A 125VAC.

Page 6-31, Table 6-3. Miscellaneous Replaceable Parts:

- Change MP10 from 05345-00034 to 05345-60004 PANEL, REAR

WRONG

CHANGE 23 (2040A)

Pages 6-21/6-23, Table 6-2. Standard Assembly Replaceable Parts:

- Change A10 (05345-60050) SERIES from 2104 to 2016.
- Change A10U2, U13 from 1820-1197 to 1820-0583 IC DM74L00N.
- Change A10U8, U14 from 1820-1470 to 1820-0710 IC MULTIPLEXER.
- Change A10U9 from 1820-1199 to 1820-0586 IC DM74L04N
- Change A10U10 from 1820-1210 to 1820-0590 IC DM74L51N.
- Change A10U6, U12 from 1820-0077 to 1820-0596 IC DM74L74N.

Pages 6-23/6-24, Table 6-2. Standard Assembly Replaceable Parts:

- Change A11 (05345-60011) SERIES from 2104 to 2006.
- Change A11U5 from 1820-1204 to 1820-0588 IC DM74L20N.
- Change A11U20, U24, U28 from 1820-1198 to 1820-0585 IC DM74L03N
- Change A11U25 from 1820-1470 to 1820-0710 IC MULTIPLEXER.

Page 6-25, Table 6-2. Standard Assembly Replaceable Parts:

- Change A13U14, U25 from 1820-1144 to 1820-0328 IC SN7402N
- Change A13U31, U32 from 1820-1470 to 1820-0710 IC MULTIPLEXER.

Page 6-26, Table 6-2. Standard Assembly Replaceable Parts:

- Change A14 (05345-60044) SERIES from 2104 to 1904.
- Change A14U5, U17, U21 from 1820-1199 to 1820-0586 IC DM74L04N.
- Change A14U6, U9, U10, U16, U22 from 1820-1197 to 1820-0583 IC DM74L00N.
- Change A14U12 from 1820-1144 to 1820-0584 IC DM74L02N.
- Change A14U18, U36 from 1820-1210 to 1820-0590 IC DM74L51N.
- Change A14U33, U34 from 1820-1202 to 1820-0587 IC DM74L10N.
- Change A15 (05345-60045) SERIES from 2104 to 1820.
- Change A15U7, U10, U20 from 1820-1197 to 1820-0583 IC DM74L00N.
- Change A15U11, U37 from 1820-1202 to 1820-0587 IC DM74L10N.
- Change A15U19 from 1820-1199 to 1820-0586 IC DM74L04N
- Change A15U26, U29 from 1820-1144 to 1820-0584 IC DM74L02N

Page 6-36, Table 6-4. Option Assembly Replaceable Parts:

- Change A12, Option 011 (05345-60018) SERIES from 2104 to 1612.
- Change A12U1, U15, U22 from 1820-1197 to 1820-0583 IC DM74L00N.
- Change A12U4, U10, U14 from 1820-110-0584 IC DM74L02N.
- Change A12U17 from 1820-2053 to 1820-0702 IC DECODER.
- Change A12U20, U23 from 1820-1199 to 1820-0584 IC DM74L04N.
- Change A12U21 from 1820-1207 to 1820-0589 IC DM74L30N.

Pages 6-38/6-40, Table 6-4, Option Assembly Replaceable Parts:

- Change A12, Option 012 (05345-60021) SERIES from 2104 to 2012.
- Change A12U1, U22, U46 from 1820-1202 to 1820-0587 IC DM74L10N.
- Change A12U2, U3 from 1820-1418 to 1820-1047 IC TTL 74L42A.
- Change A12U10, U30, U36, U54 from 1820-1197 to 1820-0583 IC DM74L00N.
- Change A12U12, U35, U40, U57 from 1820-1199 to 1820-0586 IC DM74L04N.
- Change A12U18 from 1820-1144 to 1820-0584 IC DM 74L02N.
- Change A12U26 from 1820-1204 to 1820-0588 IC DM74L20N.
- Change A12U53 from 1820-1470 to 1820-0710 IC MULTIPLEXER.
- Change A12U55 from 1820-2053 to 1820-0702 IC TTL 93L11.

CHANGE 24 (2016A)

Page 6-17, Table 6-2. Standard Assembly Replaceable Parts:

Replace A9 assembly parts list with Table 7-9.

Page 8-41, Figure 8-12, A9 Main Gate Assembly:

Replace A9 Main Gate Assembly schematic and component locator with Figure 7-7

Delete A9C25.

05345 60009 = 020
60099 = 020

CHANGE 25 (2012A)

Page 6-21, Table 6-2. Standard Assembly Replaceable Parts:

Change A10 (05345-60050) SERIES from 2016 to 2008.

Delete A10CR8, R81.

Page 8-43, Figure 8-13. Gate Control Assembly:

Change A10 (05345-60050) SERIES from 2016 to 2008.

Delete A10CR8, R81.

CHANGE 26 (2008A)

Table 7-4. Standard Assembly Replaceable Parts:

Change A9U5 from 1820-2000 to 1820-0566 IC DIGITAL.

Page 6-23, Table 6-2. Standard Assembly Replaceable Parts:

Change A10U6 from 1820-1179 to 1820-0596 IC DM74L74N.

Page 6-29, Table 6-3, Miscellaneous Replaceable Parts:

Change S2 from 3101-2269 to 3101-1694 SWITCH-TGL SUBMIN DPNT NS 2A 250VAC.

Page 6-31, Table 6-3. Miscellaneous Replaceable Parts:

Change MP20 from 05345-00033 to 05345-00032.

Page 6-38, Table 6-4. Option Assembly Replaceable Parts:

Change A12 (05345-60021) SERIES from 2012 to 1912.

Delete A12C7.

Pages 8-49A/8-49B, Figure 8-16. A12 Option 012 Schematic:

Change A12 SERIES from 2012 to 1912.

Delete A12C7.

CHANGE 27 (2006A)

Pages 6-21/6-23, Table 6-2. Standard Assembly Replaceable Parts:

Change A10C10 from 0180-1746 to 0180-0210 CAPACITOR-FXD 3.3UF ±20% 15VDC TA.

Delete A10C13.

Change A10R41 from 0683-2225 to 0757-0283 RESISTOR-2K 1%.125W.

Change A10R46 from 0757-0918 to 0757-0416 RESISTOR-511 1%.125W.

Change A10R49 from 0757-0955 to 0757-0462 RESISTOR-75K 1%.125W.

Change A10R50 from 0757-0946 to 0698-3449 RESISTOR-28.7K 1%.125W.

Change A10U3, U10, U24 from 1820-1173 to 1820-0146 IC MC1017P.

Change A10U11, U21, U23 from 1820-0802 to 1820-0145 IC MC1010P.

Change A10U16 from 1820-1199 to 1820-0174 IC SN7404N.

Change A10U18 from 1820-0806 to 1820-0142 IC MC1004P.

Change A10U20 from 1820-1052 to 1820-0275 IC MC1039P.

Change A10U22 from 1820-0817 to 1820-0581 IC MC1032P.

Page 6-34, Table 6-4. Option Assembly Replaceable Parts:

Change A18 (05345-60069) SERIES from 2008 to 1340.

Delete A18R8, R9, R10, R11.

Change A18U1 from 1820-0806 to 1820-0142 IC MC1004P.

Page 8-43, Figure 8-13. A10 Gate Control Assembly:

Replace A10 (05345-60050) Component Locator and Schematic with Figure 7-8.

Page 8-61, Figure 8-22. A18 Option 001 10 MHz Oscillator:

Change A18 SERIES from 2008 to 1340. Delete A18R8, R9, R10, R11.

CHANGE 28 (2004A)

Page 6-24, Table 6-2. Standard Assembly Replaceable Parts:

Change A11 (05345-60011) SERIES from 2006 to 1820.

Delete A11R28, R29.

Change A11U23, U27 from 1820-1052 to 1820-0275 IC MC1039P.

Page 8-45, Figure 8-14. A11 Scaler Assembly:

Change A11 SERIES from 2006 to 1820.

Change connections for A11CR1, CR4, delete A11R28, R29 and change connections to A11U23, U27 as shown in Figure 7-9.

CHANGE 29 (1944A)

Page 6-25, Table 6-2. Standard Assembly Replaceable Parts:

Change A13 (05345-60013) SERIES from 2004 to 1912.

Add A13C4 0160-3877 CAPACITOR -FXD 100PF 20% 200WVDC CER

Change A13U6 from 1820-0077 to 1820-1112 IC 74LS74.

Page 8-51, Figure 8-17. A13 Adder/Subtractor Assembly:

Add A13C4 (100 pF) between REG CLK line (to A13U6B pin 11) and circuit board common.

CHANGE 30 (1932A)

Page 6-29, Table 6-3. Miscellaneous Replaceable Parts:

Change C3, C4 from 0160-4439 to 0160-3333 CAPACITOR-FXD 5000 pF $\pm 20\%$ 250WVAC CER.

Page 8-65, Figure 8-24. Wiring, Power Transformer, A17J1, W5J1:

Change C3, C4 from .0047 to .0005 UF.

CHANGE 31 (1912A)

Pages 6-18/6-20, Table 6-2. Standard Assembly Replaceable Parts:

Change A9 (05345-60009) SERIES from 1932 to 1516.

Change A9R9 thru R14, R20, R25, R26, R31 thru R35, R41, R44, R49, R53, R58, R60, R61, R66, R68 thru R71, R73, R74, R82 and R83 from 0698-3969 to 0757-0893 RESISTOR 51 2% .125W F TC=0 \pm 100.

Page 8-41, Figure 8-12. A9 Main Gate Assembly:

Change A9 (05345-60009) SERIES from 1932 to 1516.

CHANGE 32 (1904A)

Page 6-25, Table 6-2. Standard Assembly Replaceable Parts:

Change A13 (05345-60013) SERIES from 1912 to 1820.

Delete A13C4.

Pages 6-39/6-40, Table 6-4. Option Assembly Replaceable Parts:

Change A12 (05345-60021) SERIES from 1912 to 1644.

Change A12R69, R86 from 2100-2503 to 2100-2706 RESISTOR-VAR 10K 10%.

Change A12U9, U25, U37, U47 from 1820-0077 to 1820-0174 IC SN7404N.

Change A12U48, U49, U56 from 1820-0626 to 1820-0701 IC TTL 93L14.

Change A12U14 from 1820-0706 to 1820-0584 IC DM74L02N.

Pages 8-49A/8-49B, Figure 8-16A. A12 Option 012 Interface Assembly:

Change A12 (05345-60021) SERIES from 1912 to 1644.

Change A12R69, R86 from 20K to 10K.

Page 8-51, Figure 8-17. A13 Adder/Subtractor Assembly:

Change A13 (05345-60013) SERIES from 1912 to 1820.

Delete A13C4.

CHANGE 33 (1820A)

Page 6-26, Table 6-2. Standard Assembly Replaceable Parts:

Change A14 (05345-60044) SERIES from 1904 to 1820.

Change A14R3 from 0698-6001 to 0683-1035 RESISTOR-10K 5%.25W FC TC=-400 \pm 700.

Delete A14R4.

Page 8-53, Figure 8-18. A14 Qualifier Assembly:

Delete R4.

CHANGE 34 (1808A)

Page 6-24, Table 6-2. Standard Assembly Replaceable Parts:

- Change A11 (05345-60011) SERIES from 1820 to 1352.
- Change A11U2 from 1820-1425 to 1820-1056 IC SN74132N.
- Change A11U3 from 1820-1202 to 1820-0068 IN SN7410N.
- Change A11U10 from 1820-1199 to 1820-0174 IC SN7404N.
- Change A11U11, U12 from 1820-1204 to 1820-0069 IC SN7420N.

Page 6-25, Table 6-2. Standard Assembly Replaceable Parts:

- Change A13 (05345-60013) SERIES from 1820 to 1340.
- Change A13U2, U3 from 1820-0910 to 1820-0305 IC SN7483N.
- Change A13U4, U20 from 1820-1411 to 1820-0301 IC SN7475N.
- Change A13U5, U33 from 1820-1202 to 1820-0068 IC SN7410N.
- Change A13U6 from 1820-1112 to 1820-0077 IC SN7474N.
- Change A13U7 from 1820-1416 to 1820-0174 IC SN7404N.
- Change A13U10, U22, U23, U28 from 1820-1430 to 1820-0716 IC SN74161N.
- Change A13U11 from 1820-1211 to 1820-0282 IC SN7486N.
- Change A13U12, U16, U27 from 1820-1425 to 1820-0054 IC SN7400N.
- Change A13U15 from 1820-1112 to 1820-0596 IC DM74L74N.
- Change A13U18 from 1820-1204 to 1820-0069 IC SN7420N.
- Change A13U25 from 1820-1144 to 1820-0328 IC SN7402N.
- Change A13U29 from 1820-1197 to 1820-0054 IC SN7400N.

Page 6-26, Table 6-2. Standard Assembly Replaceable Parts:

- Change A14 (05345-60044) SERIES from 1820 to 1708.
- Change A14U1 from 1820-1207 to 1820-0070 IC SN7430N.
- Change A14U13 from 1820-1194 to 1820-0233 IC SN74193N.
- Change A14U23, U31 from 1820-1196 to 1820-0788 IC SN74174N.
- Change A14U26 from 1820-1144 to 1820-0328 IC SN7402N.
- Change A14U29 from 1820-1278 to 1820-0545 IC SN74191N.
- Change A14U32 from 1820-1112 to 1820-0077 IC SN7474N.

Page 6-28, Table 6-2. Standard Assembly Replaceable Parts:

- Change A15 (05345-60045) SERIES from 1820 to 1708.
- Change A15U9, U18 from 180-1418 to 1820-0214 IC SN7442N.
- Change A15U15 from 1820-1430 to 1820-0716 IC SN74161N.
- Change A15U17, U34 from 1820-1411 to 1820-0301 IC SN7475N.
- Change A15U22 from 1820-1144 to 1820-0328 IC SN7402N.
- Change A15U23 from 1820-1112 to 1820-0077 IC SN74074N.
- Change A15U28 from 1820-0910 to 1820-0305 IC SN7483N.

Figure 7-7. A10 Gate Control Assembly:

- Change A10 (05345-60010) SERIES from 1820 to 1436.

Page 8-45, Figure 8-14. A11 Scaler Assembly:

- Change A11 (05345-60011) SERIES from 1820 to 1352.

Page 8-51, Figure 8-17. A13 Adder/Subtractor Assembly:

- Change A13 (05345-60013) SERIES from 1820 to 1340.

Page 8-53, Figure 8-18. A14 Qualifier Assembly:

- Change A14 (05345-60044) SERIES from 1820 to 1708.

Page 8-55, Figure 8-19. A15 ROM Assembly:

- Change A15 (05345-60045) SERIES from 1820 to 1708

CHANGE 35 (1744A)

Page 6-12, Table 6-2. Standard Assembly Replaceable Parts:

- Delete A7CR13.

Page 8-35, Figure 8-10. A7 Linear Regulator Assembly:

- Change A7 (05345-60007) SERIES from 1808 to 1440.
- Delete A7CR13.

CHANGE 36 (1708A)

Page 6-9, Table 6-2. Standard Assembly Replaceable Parts:

Change A4 (05345-60004) SERIES from 1744 to 1612.

Change A4R15, R18 from 0757-0334 to 07570-0913 RESISTOR-360 2%.125W F TC=0±100

Delete A4C26,C27.

Page 6-10, Table 6-2. Standard Assembly Replaceable Parts:

Change A6 (05345-60006) SERIES from 1744 to 1424.

Change A6C16, C17, C18 from 1080-2746 to 0180-1714 CAPACITOR 330UF±10%6VDCTA-SOLID.

Page 6-12, Table 6-2. Standard Assembly Replaceable Parts:

Change A7 (05345-60007) SERIES from 1808 to 1440.

Change A7CR1 from 1906-0096 to 1906-0028 DIODE MULT FULL WAVE BRIDGE RECTIFIER.

Pages 6-14/6-15, Table 6-2. Standard Assembly Replaceable Parts:

Change A8 (05345-60031) SERIES from 1744 to 1604.

Change A8C56 from 0160-2198 to 0140-0202 CAPACITOR-FXD 15PF ±5% 500WVDC MICA

Change A8R8 from 0757-0948 to 0757-0950 RESISTOR-12K 2%.125W F TC=0±100

Page 8-33, Figure 8-9. A6 Switching Regulator Assembly:

Change A6 (05345-60006) SERIES from 1744 to 1424.

Page 8-39, Figure 8-11 PLL Multiple Noise Generator Assembly:

Change A8 (05345-60031) SERIES from 1744 to 1604.

Change A8C56 from 20 pF to 15 pF.

Change A8R8 from 12K to 10K.

CHANGE 37 (1644A)

Page 6-26, Table 6-2. Standard Assembly Replaceable Parts:

Change Part Number of A14 from 05345-60044 to 05345-60034.

Change SERIES from 1708 to 1624.

Page 6-27, Table 6-2. Standard Assembly Replaceable Parts:

Change Part Number of A15 from 05345-60045 to 05345-60035.

Change SERIES from 1708 to 1624.

Change A15U8 from 1816-1018 to 1816-0824.

Change A15U16 from 1816-1019 to 1816-0825.

Change A15U24 from 1816-1020 to 1816-0826.

Change A15U32 from 1816-1021 to 1816-0827.

Page 8-53, Figure 8-18. A14 Qualifier Assembly:

Change schematic to delete jumper and terminals A,B,C near U2 and U7. The point that was terminal A connects directly to U7 pin 5. Delete jumper and terminals D,E,F near U15. The terminals D and E are replaced with a straight through connection so that U15(1) connects to U25A(3), R3, and P1A(F6-).

Page 5-4, Paragraph 5-24 (using the 05345-60200 Test Board) Step b(4):

Change second sentence to read "The BKPT 1, 2, 3, and 7 refers to test switches located on top of the A14 board."

Page 5-18, Table 5-3. Processor Flow Test Results:

Replace part of Table 5-3 (starting with Delay Switch 00039 - ending with 00220) with Table 7-10).

Page 5-28, Table 5-4. Command Source Listing:

Replace Table 5-4 with Table 7-11.

Page 5-29, Table 5-4. Command Source Listing:

Replace Table 5-4 with Table 7-12.

Page 5-31, Figure 5-9. Simplified Processor Flowchart:

Change flowchart as indicated in partial diagram in Figure 7-10. In block 2A, 2B, and 2C, change last sentence to "when entering from 3R."

Page 5-31, Figure 5-9. Simplified Processor Flowchart:

Change flowchart as shown in Figure 7-12.

Page 5-39, Figure 5-11. Processor Flowchart, Sheet 2:

Near the center of the flowchart, delete the DPLK← -1 block between the START+STOP block and the 31 symbols.

Page 5-39, Figure 5-11. Processor Flowchart, Sheet 2:

Change flowchart as shown in Figure 7-13, add accompanying 2J QUALIFIER test to page 5-32.

CHANGE 37 (1644A) (Continued)

Page 5-41, Figure 5-12. Processor Flowchart, Sheet 3:

Replace Figure 5-12 with Figure 7-14.

Page 5-41, Figure 5-12. Processor Flowchart, Sheet 3:

Delete 3S QUALIFIER and change 3R QUALIFIER as follows:

- | | |
|---------------------|---|
| 3R QUALIFIER | BREAKPOINT 3 is used for troubleshooting. It is located on the A14 Qualifier assembly. When it is enabled, it allows the DR result to be displayed. This display is prior to the AUTO manual routine so the display result will not be formatted. |
| STATE 540 | This state enables the DR contents to be read to the front panel display. The DPLK counter provides display clock and the DISP CLK EN signal enables the A1 and A2 display assembly. The DR contents are sent to the A1 and A2 assembly via the A13 bi-directional bus so the P1 is inhibited from sending any data with P1 XMT BUS line. |
| STATE 541 | This state resets the DRC and DPLK counters. This must be done in case the display state at 541 was activated by BREAKPOINT 3. |

CHANGE 38 (1624A)

This change backdates the manual to cover instruments with CHANNEL A and CHANNEL B ATTEN controls with attenuations of X20 instead of X10.

Page 1-3, Table 1-3. Specifications:

Change first footnote to read "**Trigger error for sine waves is $<[\pm 0.3\%$ of one period +number of periods average] for signals with 40 dB or better signal-to-noise ratio."

Under INPUT CHANNELS A AND B SEPARATE INPUTS change as follows:

X1	(Same)		
X20	400mV rms sine wave 1.2V p-p pulse		
Dynamic Range (preset)			
50 Ω	20 mV to 400 mV rms sine wave	1 M Ω X1	20 mV to 400 mV rms sine wave
X1	60 mV to 1.2V p-p pulse		60 mV to 1.2V p-p pulse
X20	400 mV to 7V rms sine wave 1.2V to 7V p-p pulse	X20	400 mV to 8V rms sine wave 1.2V to 24V p-p pulse

Page 1-4, Table 1-3. Specifications:

Change as follows:

Under Maximum Input, change X10 to X20.

Change last spec in Maximum Input to 70V rms above 5 MHz.

Under COMMON INPUTS, change Sensitivity (preset) as follows:

Sensitivity: (preset)

50 Ω X1 (same)

50 Ω X20 800 mV rms sine wave, 2.4V p-p pulse.

Dynamic Range (preset)

50 Ω 40mV to 800 mV rms sine wave

X1

120 mV to 2.4V p-p pulse

X20 .8 to 5V rms sine wave 2.4 to 5V p-p pulse

Page 5-1, Table 5-1. A3 Assembly:

Change A3 part number from 05345-60038 to 05345-60003.

CHANGE 38 (1624A) (Continued)

Page 6-6, Table 6-2. Replaceable Parts for Standard Instruments:

Change A3 part number from 05345-60038 to 05345-60003 SERIES 1520.

Change A3C4 and A3C7 from 0160-4531 to 0160-0550, Capacitor-Fxd 10 pF $\pm 5\%$ 50WVDC CER, 28480, 0160-0550.

Change A3R4 and A3R7 from 0698-8881 to 0698-8383, Resistor 950K 5% .25W C TC=0 \pm 150, 28480, 0698-8383.

Change A3R5 and A3R8 from 0698-8880 to 0698-8384, Resistor 50K 5%.15W C TC--0 \pm 150, 28480, 0698-8384. Page 6-31, Table 6-3. Mechanical Parts:

Change HP and Mfr Part Number for Front Panel MP20 from 05345-00032 to 05345-00025.

Page 8-31, Figure 8-8. A3 Input Attenuator Schematic Diagram:

Change A3 Part Number and Series Number at top of Diagram from 05345-60038 SERIES 1644 to 05345-60003 SERIES 1520A.

Change A3C4 and A3C7 from 2.2 pF to 10 pF.

Change A3R4 and A3R7 from 900K to 950K.

Change A3R5 and A3R8 from 100K to 50K.

Change "X10" markings for A3S5 and A3S7 attenuators to "X20".

CHANGE 39 (1612A)

Pages 5-28 and 5-29, Table 5-4. Command Source Listing:

Replace Table 5-4 with Tables 7-13 and 7-14.

Page 5-31, Figure 5-9. Simplified Flowchart:

Change qualifier ID from "COMPUTER OR PLUG-IN DUMP" to "COMPUTER DUMP."

Page 5-32, Flowchart States:

Change START 001 as follows:

RESET:	This state sets up the conditions prior to lamp test and display of zeros. Lamp test is accomplished by the RESET and the DISP CLK EN signals. The DPLK \rightarrow DPLK-1
STATE 001	command clock the DPLK counter. The DPLK output is then used as the display clock for the LED display. The RESET FRONT END command resets the scalars to zero. This is in preparation for loading zero data into the DR by commands DR \leftarrow EC and DRC \leftarrow DRC+16. The decimal point is also positioned out of the visual range of the display by DPLR \leftarrow -1. PI XMT BUS inhibits plug-in data. FLAG \leftarrow H and DC \leftarrow 0 are qualifiers which are used later. PROC BUSY is inhibited until the end of the measurement phase.

Page 5-32, Flowchart States:

Change STATE 571 as follows:

STATE 571	This state reads the DR contents to the display with commands DR \leftarrow DR, DRC \leftarrow DRC+L I and DISP CLK EN. The display clock is generated by command DPLK \leftarrow DPLK-1. PI XMT BUS inhibits any PI DATA while the DR-data is read to the display. PROC BUSY is also inhibited until completion of the measurement phase.
------------------	--

Change STATE 570 under IC QUALIFIER as follows:

STATE 570	This state signifies the beginning of the process cycle. Blanks are loaded into the QR by command QR \leftarrow b and QRC \leftarrow QRC+16. This is done to blank the display when COMPUTER DUMP is requested. The DRC, DC, and DPLK counters are reset at this state.
------------------	---

CHANGE 39 (1612A) (Continued)

Change ID QUALIFIER AND STATES 210 and 211 to the following:

ID QUALIFIER	The COMPUTER DUMP qualifier remains false unless the remote programming unit requests that computer dump be outputted.
STATE 210	This state loads the TIME and EVENT counts into the NR and DR, respectively. The flag is set low, alerting the programming output option that the first digit is ready to output. The PI XMT BUS is inactive to ensure that no PI DATA can get onto the bus. The asterisk is also turned off during the blanked display.
STATE 211	This command state enables the DR contents to be read to the plug-in when requested and also loads the time count from the A11 time scaler into the NR. The asterisk is also turned off. The following commands provide these operations.
DR←DR	Rotate the contents of the DR onto the bus.
DRC←DRC+16	
PI CLK EN	Enables 16 register clock pulses to the PI for data loading.
NR←TC	Control the writing of the time count into the NR.
NRC←NRC+16	
$\overline{\text{PI XMT BUS}}$	Inhibits plug-in data from being placed on the bus.
FLAG←1	This is a qualifier director used for the plug-in data routine.
*←OFF	Turns off the asterisk in the display block.

Page 5-33, Flowchart States:

Delete QUALIFIER 1D₁, STATES 300 and 301, QUALIFIER 1D₂ and STATES 310 and 321.

Page 5-33, Figure 5-10. Processor Flowchart, Sheet 1:

Replace flowchart with Figure 7-15.

Page 5-39, Figure 5-11. Processor Flowchart, Sheet 2:

In STATE 340, change the second line to "DRC←DCR+11."

Page 5-40, Flowchart States:

In STATE 540 change second line to DRC-DRC+11.

Page 6-26, Table 6-2. A14 Replaceable Parts:

Change A14 from 05345-60034 to 05345-60014 in HP Part Number and Mfr Part Number columns.

Change A14 from SERIES 1624 to SERIES 1612.

Page 6-27, Table 6-2. A15 Replaceable Parts:

Change A15 from 05345-60035 to 05345-60015 in HP Part Number and Mfr Part Number columns.

Change A15 from SERIES 1624 to SERIES 1612.

Change A15U8 from 1816-0824 to 1816-0344, IC Digital, Memory, 50364, H620IN-5835.

Change A15U16 from 1816-0825 to 1816-0345, IC Digital, Memory, 050364, H620IN-5836.

Change A15U24 from 1816-0826 to 1816-0346, IC Digital, Memory, 50364, H620IN-5837.

Change A15U32 from 1816-0827 to 1816-0347, IC Digital, Memory, 28480, 1816-0347.

Page 8-53, Figure 8-18. A14 Schematic Diagram:

Change the schematic diagram as shown in the partial diagram in Figure 7-11. The 05345-60034 and 05345-60014 circuit boards are **not** directly interchangeable.

CHANGE 40 (1604A)

Page 6-9, Table 6-2. A4 (05345-60004) Replaceable Parts:

Change SERIES 1612 to 1512.

Delete A4CR3 and A4CR4.

Page 6-26, Table 6-2. A14 (05345-60014) Replaceable Parts:

Change SERIES 1612 to 1340.

Delete A14R3.

Page 6-27, Table 6-2. A15 (05345-60015) Replaceable Parts:

Change SERIES 1612 to 1352.

Change A15U6 from 1820-1199 to 1820-0586, IC DM74L04N, 27014, DM74L04N.

Delete A15R7.

Page 6-30, Table 6-3. Replaceable Parts:

Change W5 Part Number from 05345-60093 to 05345-60092 in HP and Mfr Part Number columns.

Page 6-36, Table 6-4. A12 Option 011 Replaceable Parts:

Change A12 circuit board 05345-60018 from SERIES 1604 to 1340.

Change A12Q1 from 1854-0574 to 1854-0246.

Change A12R12 from 0683-3035 to 0683-8225 Resistor 8.2K, 5%,.25W, FCTC=400/+700,01121, CB8225.

Page 8-31, Figure 8-8. A4 (05345-60004) Schematic Diagram:

Change series number at the top of A4 schematic from SERIES 1612 to 1512.

Delete diodes A4CR4 and A4CR3. Replace with straight through connections. Also delete A4CR3 and A4CR4 from REFERENCE DESIGNATIONS.

Page 8-49, Figure 8-16. A12 Option 011 Schematic:

Change SERIES 1604 to 1340.

Change diagram for A12Q1 to an NPN transistor.

Change A12R12 from 30K to 8200 ohms.

Page 8-51, Figure 8-17. A13 (05345-60013) Schematic Diagram:

Change signal input to B13 (left side of diagram) from $NRC \leftarrow 0$ to INIT AUTEST.

Page 8-53, Figure 8-18. A14 (05345-60014) Schematic Diagram:

Change series number at top of schematic from 1612 to 1340.

Change schematic diagram as shown in Figures 7-16 and 7-17.

Page 8-55, Figure 8-19. A15 (05345-60015) Schematic Diagram:

Change SERIES number on top of schematic from 1612 to 1532.

Change A15 schematic as shown in Figure 7-18.

Page 8-65, Figure 8-24. W5J1 Wiring Diagram:

Delete brown wire connection to pin 1 of W4J1.

Delete red wire connection to pin 2 of W4J1.

CHANGE 41 (1528A)

Make note that a rack mount kit HP Part Number 5060-8740 was supplied with instruments serial prefixed 1528A and below.

Page 6-13, Table 6-2. A8 Replaceable Parts:

Change A8 circuit board from SERIES 1604 to 1424.

Page 6-41, Table 6-3. A19 for Options 010, 011, and 012:

Change HP and Mfr Part Number for M/FEM HEX STANDOFF from 0380-0643 to 0380-1036.

Page 8-5, Figure 8-24. Power Wiring Diagram:

Change POWER MODULE from part number 0960-0444 to 5060-9422.

Page 8-63, Figure 8-23. A19 for Option 010, 011, and 012:

Change SERIES number from 1604 to 1340.

NOTE

Heat sink 1205-0011 from A8U7 was not supplied for instruments prefixed 1528 and below, but is recommended for all instruments.

CHANGE 42 (1520A)

Page 6-30, Table 6-2. Replaceable Parts for Standard Instruments without Options:

Change W5 part number from 05345-60092 to 05345-60075 in HP and Mfr Part Number columns.

Page 6-31, Table 6-3. Mechanical Parts:

Delete MP47*, this was not supplied for instruments prefixed 1520 and below.

Page 8-65, Figure 8-24. W5J1 Wiring Diagram:

On W5J1, delete yellow wire from pin 4.

On W5J1, delete blue wire from pin 6.

CHANGE 43 (1516A)

Page 6-17, Table 6-2. A9 Parts List:

Change series number of A9 to 1516A.

Page 6-20, Table 6-2. A9 Parts List:

Delete A9R114, A9R115, and A9R116.

Page 8-12, A9 Schematic Diagram:

Change series number at top of schematic to 1516A.

On component locator, delete A9R114, A9R115, and A9R116.

On schematic, replace A9R114, A9R115, and A9R116 with straight-through connections.

CHANGE 44 (1512A)

Page 6-7, Table 6-2. A3 Parts List:

Change A3C9 and A3C11 to 0160-4058, Capacitor-Fxd 39 pF $\pm 5\%$ 400WVDC CER, 28480, 0160-4058.

Add A3C27 to 0160-3879, Capacitor-Fxd 0.01 MF $\pm 20\%$ 100WVDC CER, 28480, 0160-3879.

Change A3Q1 and A3Q2 to 1855-0050 in HP and Mfr Part Number columns.

Change A3R38 and A3R40 from 0683-1635 (16 K Ω) to 0683-1025, Resistor-Fxd 100 ohm, 5% .25W FCTC=-400/+600, 01121, CB1025.

Change board series number to 1512A.

CHANGE 45 (1440A)

If the serial number of your instrument is between 1428A00451 and 1440A00950 and is not equipped with Option 001 make the changes in Table 7-15.

If your instrument is equipped with Option 001 and has a serial number between 1428A00451 and 1428A00950, make the changes given in Table 7-16.

Page 6-7, Table 6-2. A3 Parts List:

Change A3R14 and A3R16 to 0698-5174, Resistor 200 OHM 5% 1/8W CC Tubular, 01121, BB2015.

Change A3R19, A3R20, A3R28, and A3R29 to 0698-7064, Resistor 100K 5% 1/8W CC Tubular, 01121, BB1045.

Change A3R38 and A3R40 to 0757-0911, Resistor 300 OHM 2% 1/8W Tubular, 24546, C4-1/8-TO-301-G. Change A3R43, A3R46, and A3R48 to 0675-1021, Resistor 1K 10% 1/8W CC Tubular, 01121, BB1021. Change A4R45 to 0683-1025, Resistor 1K 5% 1/4W CC Tubular, 01121 CB1025.

Page 8-31, Figure 8-8. A3 Schematic Diagram:

Change the following resistor values:

A3R14, R16 to 200 ohms.

A3R19, R20, R28, R29 to 100K.

A3R33, R40 to 300 ohms.

A3R43, R45, R46, R48 to 1000 ohms.

Change A3 series number at top of schematic to 1428A.

Page 6-9, Table 6-2. A4 Parts List:

Change A4R12, R14 to 0698-7178, Resistor-Fxd 2M ohm 5% 1/8W CC Tubular, 01121, BB2055.

Change A4R11, R13 to 2100-1738, Resistor-Var Trimmer 10K ohm 10% C, 19701, ET50W103.

Change A4R2, R5 to 2100-2061, Resistor-Var 200 ohm 10% C, 30983, ET50W201.

Page 8-31, Figure 8-8. A4 Schematic Diagram:

Change A4R2, R5 to 200 ohms.

Change A4R12, R14 to 2M ohms.

Change Series Number at top of Schematic to 1440A.

CHANGE 46 (1438A)

Page 2-1:

Delete illustration for pc board selector. Instruments with Series Prefix 1438A and below have a screwdriver-operated line voltage selector. Fuses are 2.5A for 115V operation or 1.25A for 230V operation. Page 6-9, Table 6-2. A4 Parts List:

Change A4U1, U2 to 1826-0151.

Change Series number of board to 1340A.

Page 6-11, Table 6-2. A7 Parts List:

Change A7C5 to 0160-0161, C:Fxd 0.01A $\pm 10\%$ 20WVDC Polyester, 56289, 292P10392.

Change series number of board to 1436A.

Page 6-29, Table 6-3. Miscellaneous Chassis Parts:

Change FL1 to 5060-1189.

Change T1 to 9100-3037.

Change C3 to 0160-3043, Dual 5000 pF $\pm 20\%$, 28480, 0160-3043.

Delete C4.

Change W4 to 05345-60074.

Change W14 to 05345-60084.

Page 8-65, Figure 8-24. Wiring Power Transformer:

Replace Power Wiring with Figure 7-22.

CHANGE 47 (1436A)

Page 6-20, Table 6-2. A9 Parts List:

Delete A9R112 and A9R113.

Change board series number to 1428A.

Page 8-41, Figure 8-12. A9 Schematic Diagram:

Delete A9R112 and A9R113.

CHANGE 48 (1428A)

Page 6-11, Table 6-2. A7 Parts List:

Replace A7 parts list with Table 7-17.

Page 6-22, Table 6-2. A10 Parts List:

Change A10R45 and A10R46 to 0757-0440, Resistor 7.5K 1% 1/8W F T, 24546, C4-1/8-TO-7501-F.

Page 8-35, Figure 8-10. A7 Schematic Diagram:

Replace A7 Schematic Diagram with Figure 7-22.

Replace A7 Component Locator with Figure 7-24.

Page 8-43, Figure 8-13. A10 Schematic Diagram:

Change A10R45 to 7500 ohms.

Change A10R46 to 2610 ohms.

CHANGE 49 (1424A)

Page 1-4, Table 1-3. Specifications:

Change specifications under INPUT CHANNELS A AND B

Sensitivity: X1, 10 mV rms sine wave and 30 mV peak-to-peak pulse. X20, 200 mV rms and 600 mV peak-to-peak pulse.

Dynamic Range: 30 dB

50 Ω : X1, 10 mV to 350 mV rms sine wave and 30 mV to 1.0V peak-to-peak pulse.

X20, 0.2 to 7.0V rms sine wave and 0.6V to 14V peak-to-peak pulse.

1 M Ω : X1, 10 mV to 350 mV rms sine wave and 30 mV to 1.0V peak-to-peak pulse.

X20, 0.2 to 7.0V rms sine wave and 0.6V to 20V peak-to-peak pulse.

Delete linear operating range specification.

Trigger Level: Continuously adjustable to more than cover the DYNAMIC RANGE ($\pm 0.5V_{dc}$ times the attenuator setting). Adjustment is nonlinear with more settability in the more sensitive region.

CHANGE 49 (1424A) (Continued)

Page 1-5, Table 1-3. Specifications:

Change specifications under INPUT CHANNELS A AND B.

Output: CHAN A and B trigger voltage (X ATTEN) is accurate to within ± 15 mV (X ATTEN) of actual trigger point. Rear panel BNC connectors.

Under COMMON INPUT

Change to Sensitivity: (Preset) 50 Ω : X1, 20 mV rms sine wave and 60 mV peak-to-peak pulse, X20, 400 mV rms sine wave and 1.2V peak-to-peak pulse.

Trigger Level: Continuously adjustable over the range of ± 1 Vdc in 50 Ω and 1 M Ω multiplied by the attenuator setting.

Page 3-1, Paragraph 3-8:

In first sentence, "change minimum level of 20 mV rms" to 10 mV rms sine wave.

Page 3-4, Paragraph 3-35:

In first sentence, change triggering range to -0.5V to +0.5V.

Page 3-13, Item 8:

Change level range in X1 setting to ± 0.5 V.

Change level range in X20 setting to ± 10 V Page 3-14, Item 3 and Item 4:

Change level control output to ± 0.5 V.

Page 4-12, paragraph 4-87:

In sixth sentence (6th line) change to read "accepts to dc level (± 0.5 V)"

Page 5-44, Step 1, Specifications:

Change sensitivity to 10 mV rms.

Page 5-44, Step 1b:

Change to read, "Adjust signal generator from 20 Hz to 500 MHz", maintaining 10 mV rms input amplitude. Page 5-45, Step 2, Specifications:

Change Level Range to ± 0.5 V.

Change ATTEN (Sensitivity): to 200 mV rms in X20.

Page 5-45, Step 2b:

Change to read "set signal generator to 10 kHz at 1V rms."

Page 5-45, Step 2c:

Change 2nd sentence to read "OUTPUT level meter should read 200 mV or less".

Page 5-45, Step 3, Specifications:

Change sensitivity spec to 60 mV p-p.

Page 5-45, Step 3c:

Change pulse generator output to "10 ns pulses at 60 mV p-p"

Page 5-46, Step 4, Specifications:

Change sensitivity spec to 10 mV rms.

Page 5-46, Step 4b:

Change to read "set signal generator to 20 Hz at 20 mV"

Page 5-46, Step 4c:

In first sentence, change 40 mV to 20 mV.

Page 5-47, Step 5, Specifications:

Change Level Range to ± 0.5 V.

Change ATTEN (sensitivity) to 200 mV rms in X20.

Page 5-47, Step 5b:

Change 1V rms to 1.5V rms.

Page 5-47, Step 5d:

Change -1.3 to +1.3V to -5V to +.5V.

Page 5-47, Step 5g:

Change second sentence to read "output level meter should read 200 mV or less". Page 5-50a.

Performance Test Card:

Change Channel A and Channel B level spec to ± 0.5 V.

Change Channel A and Channel B Atten Sensitivity spec to 200 mV.

Change time interval single shot time interval spec to 10 ns at 60 mV p-p.

Page 6-7, Table 6-2. A3 Parts List:

Change A3R10 and A3R12 to 0683-5625, Resistor-Fxd 5.6K 5% 1/4W CC Tubular, 01121, CB2025.

Change A3 series number to 1340A.

Page 6-20, Table 6-2. A9 Parts List:

Delete A9R111.

CHANGE 49 (1424A) (Continued)

- Page 8-31, Figure 8-8. A3 Schematic Diagram:
Change A3R10 and A3R12 to 5600 ohms.
Change A3 series number to 1340A.
Page 8-41, Figure 8-12. A9 Schematic Diagram:
Delete A9R111.
Change A9 series number to 1412A.

CHANGE 50 (1412A)

- Page 6-9, Table 6-2. A6 Parts List:
Change A6CR19 to 1902-3036.
Change series number to 1412A.
Page 8-33, Figure 8-9. A6 Schematic Diagram:
Change A6CR19 to 3.16V.

CHANGE 51 (1352A)

- Page 6-5, Table 6-2. A1 Parts List:
Change A1DS1-12 to 1990-0452.
Change board series number to 1352A.
Page 6-10, Table 6-2. A6 Parts List:
Change A6R4 to 0683-2035, Resistor-Fxd 20K 5% 1/4W CC Tubular, 01121, CB2035.
Page 6-20, Table 6-2. A9 Parts List:
Delete A9R110.
Change A9R106 through A9R109 to 0698-3378, Resistor-Fxd 50 ohms 5% 1/4W, 01121, BB5105.
Change board series to 1352A.
Page 6-22, Table 6-2. A10 Parts List:
Change A10R51 to 0683-4715, Resistor-Fxd 470 ohm 5% 1/4W CC Tubular, 01121, CB4715.
Change board series to 1340A.
Page 6-29, Table 6-3. Miscellaneous Chassis Parts:
Delete R2 12K resistor.
Page 8-33, Figure 8-9. A6 Schematic Diagram:
Change A6R4 to 20K ohms.
Change board series to 1352A.
Page 8-27, Figure 8-6. Chassis Parts:
Delete R2.
Page 8-35, Figure 8-10. A7 Schematic Diagram:
Delete top lead connection of A7R16 and connect it to junction of A7L1 and A7C9.
Change board series to 1340A.
Page 8-41, Figure 8-12. A9 Schematic Diagram:
Delete A9R110.
Change A9R106 through R109 to 51 ohms.
Change board series to 1352A.
Replace component locator with Figure 7-25.
Page 8-43, Figure 8-13. A10 Schematic Diagram:
Change A10R51 to 470 ohms.
Change board series number to 1340A.

CHANGE 52 (1340A)

- Page 6-5, Table 6-2. A1 Parts List:
Change A1R3 to 0683-1515, Resistor-Fxd 150 ohm 5% 1/4W CC Tubular, 01121, CB1515.
Change board series number to 1340A.
Page 6-5, Table 6-2 and Figure 8-7. A2 Parts List and Schematic Diagram:
Change part number of A2 to 05345-60002, Series 1340A.
Page 6-10, Table 6-2. A6 Parts List:
Change A6Q2 to 1853-0326.
Change A2 series number to 1340A.
Page 6-20, Table 6-2 and Page 8-41, Figure 8-12. A9 Parts Lists and Schematic Diagram:
Delete A9R106 through A9R109.
Change A9 series number to 1340A.

CHANGE 52 (1340A) (Continued)

Page 6-23, Table 6-2 and Page 8-45, Figure 8-14. A11 Parts List and Schematic Diagram:

Delete A11Q9, Q10, R26, R27.

On schematic, indicate a direct connection from U17 pin 6 to U16 pin 14. Also indicate a direct connection from U18 pin 6 to U19 pin 4.

Change A11 board series number to 1340A.

Page 8-27, Table 6-2 and Page 8-55, Figure 8-19 A15 Parts List and Schematic Diagram:

Add A15R7,0683-1325,1300 ohm 5% 1/4W CC Tubular, 01121, CB1325.

On schematic, indicate resistor R7 in place of jumper A.

Change A2 Assembly number to 1340A.

Page 8-29, Table 6-3 and Page 8-27, Figure 8-6. Miscellaneous Chassis Parts and Front Panel Switch Wiring:

Delete C4, insulator 0340-0797 and screw 9570-0130.

Page 8-29, Figure 8-7. A1 Schematic Diagram:

Change A1R3 to 150 ohms and board series number to 1340A.

Table 7-2. A14 Qualifier Theory of Operation

4-219. A14 Qualifier

4-220. The A14 board selects the proper qualifier for each process cycle. It also stores the two most significant digits of the next ROM address code. Located on this board is the DPLR counter and DPLK counter. A comparison circuit is used to position the decimal point under certain conditions.

4-221. QUALIFIER CIRCUITS. Of all the returning qualifiers that are available for selection, only one is chosen and sent to A15. The selected qualifier is the output of U1 (far right of schematic) and is sent to A15 as SV7(T). This is the LSD in the octal code for the next ROM address. An example is helpful in understanding the principle of selecting the various ROM addresses. (A summary is included at the end of this description.)

4-222. Next State Address Storage. Assume the ROMs on A15 have just been addressed to location 211 (see Processor Flow Charts, Section V). The ROMs output a new set of commands. Part of these commands are used to generate the next ROM address; these are the six SV(T+1) lines (see smaller cutout in schematic). Shortly after this code appears on the input lines of U23, the code states are clocked into storage by WORD DBL CLK. In this example, the stored code is 15X, with X being the code's LSD and unknown at this time. Later, X will be replaced by the returning qualifier state (1 or 0).

4-223. Qualifier Selection. As the counter performs the operations asked for by the ROM commands, qualifiers are sent to A14, giving information on the result of these operations. However, at this ROM state, the counter is interested in only two qualifiers: PI Data and BKPT 6. These qualifiers are selected for examination, using the code stored in U23. The Q1, Q2, and Q3 outputs of U23 comprise the MSD of the stored next-state ROM address (001 is the 1 of 15X). These 3 lines are decoded in U24 to pull the "1" output Low (pin 12). This allows U16C and U17F to enable qualifier switch U8. The next most significant digit is on the Q4, Q5, and Q6 outputs of U23. This coded digit is 5 (101 is the 5 of 15X). These lines connect to the select lines (S1, S2, S4) of each qualifier switch; however, these lines affect only the enabled switch, U8. This code selects input I5. Tracing the source of input I5 reveals that this input connects to the PI DATA line and the S1-6 switch (BKPT-6): the two qualifiers shown in the flow chart. The qualifier state is inverted on the Z output and again in U1. It is then applied to the D input of U32A. When the next ROM cycle begins, ROM CLK clocks the qualifier to the Q output as SV7(T). The other SV(T) states are also clocked out of U31 with ROM CLK. If there is not plug-in data and break point 6 is not selected, the qualifier is "1" and the next ROM address is 151. If one of these qualifiers is true, the next ROM address is 150. The result of the qualifier, then, determines the direction of program flow, as shown in the flow charts.

4-224. Summary. The two most significant octal digits of the next ROM address are clocked into storage (U23) with WORD DBL CLK. U24 decodes the MSD to enable a qualifier switch. The enabled qualifier switch shares the same number as the value of the MSD in SV(T+1). The second most significant digit stored in U23 selects an input of the enabled qualifier switch. The switch passes the qualifier on that input to the inverted output, through U1, and onto U32A. The next ROM CLK pulse clocks U31 and U32A and places the address code onto the ROM's address lines. The input to the qualifier switch may be the result of combinational logic for several qualifiers.

Table 7-2. A14 Qualifier Theory of Operation (Continued)

4-225. DPLR CIRCUIT. The abbreviation DPLR stands for "decimal point locator for the result." The circuit is a 6-bit counter comprised of up/down counter U29 and flip-flops U38A and U38B. The direction of counting is determined by the commands listed in the flow chart. Before counting begins, the circuits are *always* reset by the DPLR- - 1 command. This line resets U38A and B and loads a code of 15 into U29 (D inputs held High). The DPLR code is sent out of A14 via U20A, B, C, and D and U30A and B when the PI XMT line is High. When the PI XMT line is Low, the DP lines are high impedance to allow a plug-in to load decimal point data into DPLK.

4-226. Count Up Mode. In a "count up" operation, the flow chart command is DPLR - DPLR+1. The purpose is to shift the decimal point one place to the left. The command places DPLR UP to a Low and pulses the DPLR CLK line Low. If the output code of U29 is 15 (as it is initially), a pulse is *always* produced at RIP CLK that will toggle flip-flop U38A through inverter U37B. The actual clocking occurs on the rising edge of RIP CLK when the code changes from 15 to 0. Flip-flop U38B will toggle at this same time *only* if U38A(13) is High (as it is initially), since this causes U37C(10) to be High.

4-227. Count Down Mode. In a "count down" operation, the flow chart command is DPLR-DPLR -1. The purpose is to shift the decimal point one place to the right. The command places DPLR UP to a High state and pulses the DPLR CLK line Low. This causes U29 to decrement its count by one. If the output code of U29 is zero, a pulse is *always* produced at RIP CLK that will toggle flip-flop U38A through inverter U37B. The actual clocking occurs on the rising edge of RIP CLK when the code changes from 0 to 15. Flip-flop U38B will toggle at this same time *only* if U38A(13) is Low, since this causes U37C(10) to be High.

4-228. Relating DPLR Code to D.P. Position. Each code of the DPLR relates to a specific placement of the decimal point in the display. Figure 4-25 shows the decimal point in the display and outside of the display. The ranges outside the display are possibly used during computation. Generally, the positive range codes are used in giga-unit arithmetic and negative range in nano-unit arithmetic. To determine the negative code, take the 2's complement of the positive code. For example, a code of -1 appears as follows:

DPLR: -/+	E	D	C	B	A	
+1 code:	0	0	0	0	0	1
Take complement:	1	1	1	1	1	0
add one:	1	1	1	1	1	1 = -1 code
(2's complement)						

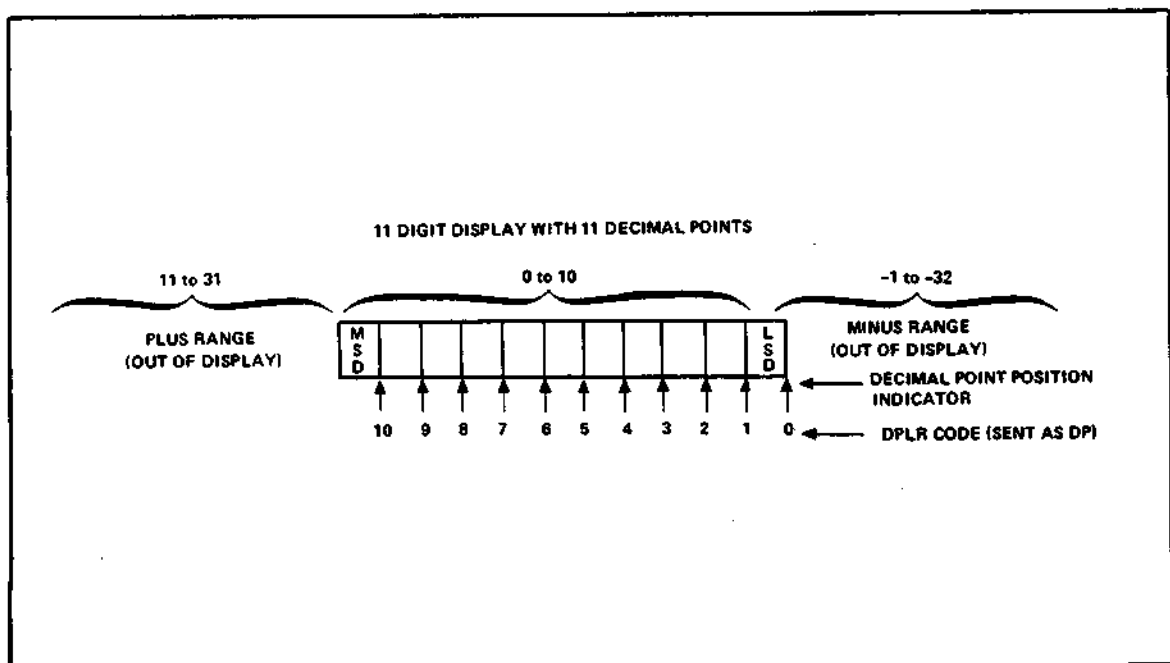


Figure 4-25. Relation of D.P. Codes to Display Position

Table 7-2. A14 Qualifier Theory of Operation (Continued)

4-229. **DPLK CIRCUIT.** The abbreviation DPLK stands for "decimal point locator for K". The K refers to K data from the plug-in. The counter is used in several operations. Briefly, it is used in computer dump to determine when all characters in the DR and NR have been strobed out; it recognizes when all 16 characters in NR have been examined for purposes of determining resolution; it stores the decimal point code for K data; it is used in the serial out routine to determine when all 16 characters have been examined; and, in general, it is the source of qualifier signals.

4-230. **Resetting and Counting.** The DPLK counter is *always* reset prior to use. Reset occurs when the $\overline{\text{DPLK}}\text{-}\overline{\text{I}}$ line goes Low. This clears the 4-bit counter U13 via U5D and resets flip-flops U14A and U14B. This results in High output levels from U12B and D, U5B and C, and the Q outputs of U14A and B. These points are considered the output lines of the DPLK counter.

4-231. Even though U13 is connected for a count-up mode, using the inverters on the output lines and the Q outputs of U14A and B constitutes a count-down mode by forming the complement of the code. The reset code is equivalent to the first count-down from zero; therefore, all High output levels constitute a count of -1

$$\begin{pmatrix} -/+ & E & D & C & B & A \\ 1 & 1 & 1 & 1 & 1 & 1 \end{pmatrix}$$

Future count downs are accomplished with the $\overline{\text{DPLK}}\text{CLK}$ line. Each clock pulse decrements the counter by one count; for example, the next clock pulse sets the counter to -2

$$\begin{pmatrix} -/+ & E & D & C & B & C \\ 1 & 1 & 1 & 1 & 1 & 0 \end{pmatrix}$$

4-232. **Loading Plug-In Decimal Point Data.** When using K data from the plug-in, the $\overline{\text{DPLK}}\text{-}\overline{\text{DPLKPI}}$ command line goes Low to enter the decimal point code into DPLK storage. The LOAD input of U13 goes Low and allows the DP C, D, E, and F code to be entered into U13 storage. Entering the DP A and DP B states into U14A and B requires a different approach. Prior to loading from the plug-in, a $\overline{\text{DPLK}}\text{-}\overline{\text{I}}$ command is generated. The Q outputs of U14A and B, therefore, are initially High. If DP A is Low, U21D, U21F, and U22D will cause U14A to set with the $\overline{\text{DPLK}}\text{-}\overline{\text{DPLKPI}}$ pulse. If DP B is low, U21B, U21F, and U22C will cause U14B to set with the $\overline{\text{DPLK}}\text{-}\overline{\text{DPLKPI}}$ pulse. If neither of these conditions exists, the flip-flop will remain reset.

4-233. **Generating Display Clock.** The DISP CLK line is used to strobe the display at a much slower rate than REG CLK can normally provide. The DISP CLK line is a result of dividing the $\overline{\text{DPLK}}\text{CLK}$ signal by 64. This line continuously pulses Low during display. On the 32nd Low-to-High transition of $\overline{\text{DPLK}}\text{CLK}$, the QD output of U13 goes High and on the 64th pulse it goes Low. The High-to-Low transition causes a new digit to be addressed and strobed and generates a blanking pulse for the display.

4-234. **COMPARATOR DESCRIPTION.** The comparator circuit compares the 6-bit DPLR code to one of four possible data sources. Selection of a data source is shown on the A14 schematic (table in large cutout). The result of comparison is a $\overline{\text{DPLR}}\text{=}$ qualifier or a $\text{DPLR}>$ qualifier.

4-235. Switches U27 and U35 select the appropriate data code (ABCD) for comparison to the DPLR code. When a comparison is made to the DPLK code, two additional lines are compared. These are -/+ (from U12B) and E (from U12D). For any comparison other than DPLK, the FLAG=H line is High, forcing the outputs of U12B and U12D Low. The remaining 4 bits are provided by the display position A, B, C, D code.

4-236. **Equality Comparison.** When comparing DPLR to DPLK, the five code lines (A,B,C,D,E) are compared in U28, yielding a High output from A=B when the codes are same. The sign (-/+) bits are compared in exclusive OR gate U37A, which yields a Low with equality. U37D inverts the sign comparison; therefore, when the A through E codes are equal, U30D output drives the $\overline{\text{DPLR}}\text{=}$ qualifier Low.

4-237. **Magnitude Comparison.** Switch U36B, C, and D determines whether DPLR is greater than the data being compared. The switch is controlled by U37A and inverter U37D. If the sign bits are *not* equal, U36B, C, and D passes the sign of the DPLR (from U38 pin 8). If the sign is positive (Low), then

Table 7-2. A14 Qualifier Theory of Operation (Continued)

DPLR is greater, since the other sign had to be negative. This sets the $\overline{\text{DPLR}} >$ qualifier High through U36D. Conversely, a negative (High) sign set U36(6) Low, indicating that DPLR is smaller. When the Signs are equal, the U36B, C, D switch is capable of passing the $\text{A} < \text{B}$ output of U28. If $\text{A} < \text{B}$ is Low, the DPLR code is greater than the comparator's code and the output of U36D is High.

4-238. Example of Comparison: When the counter is operating out of the AUTO mode, the decimal point position on the display is fixed and the measured number is positioned around it. The DISPLAY POSITION switch controls the decimal point placement from the front panel. The placement can also be controlled remotely or from the plug-in. Since the code that positions the decimal point is derived from the DPLR, the DPLR must be made to agree with the display position code.

4-239. The states of $\overline{\text{RMT}}$ and $\overline{\text{PI DISP POS/GT SEL}}$ lines determine which display position code is used (from panel, remote, or plug-in). The $\text{FLAG} = \text{H}$ line is High when comparing for display position. Gates U22B, U6D, and U6C control the selection of input lines for U27 and U35. The selected outputs are sent to the B inputs of U28 where they are compared to the DPLR code on the A inputs.

4-240. If the DPLR code equals the display position code, the $\overline{\text{DPLR}} =$ qualifier will be Low. In this case, the measurement data is properly aligned around the selected decimal point position and no further action is required. When the two codes do not equal, the state of the $\text{DPLR} >$ determines whether DPLR should be incremented or decremented, i.e., should the displayed digits be shifted to the left or to the right. This process ends when $\overline{\text{DPLR}} =$ becomes active.

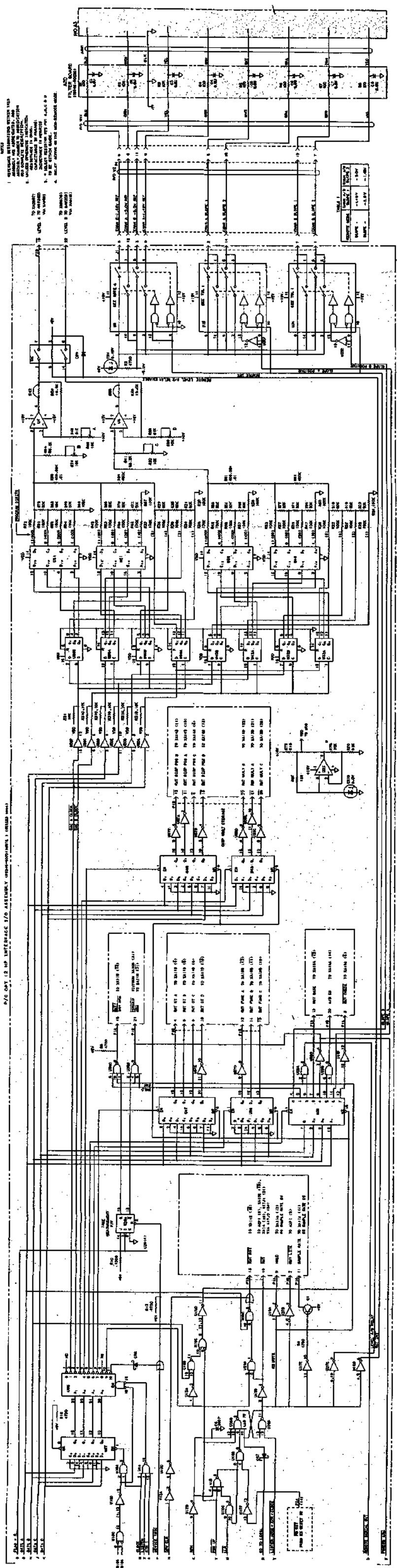


Figure 7-4B. A12 Option 012 I/O Assembly (Sheet 1 of 2)

Figure 7-4B
A12 OPTION 012 HP INTERFACE I/O ASSEMBLY
(Sheet 2 of 2)

(See page 7-39)

Table 7-5. Table of Specifications

FREQUENCY/FREQUENCY AVERAGE

PERIOD/PERIOD AVERAGE MEASUREMENTS

Both frequency and period are measured by measuring the total elapsed time T, for an integral number of cycles, N, of the input waveform. Computation, involving the quantities of N and T, provides direct readout of either frequency or period.

Range: 50 μ Hz to 500 MHz; 2 nsec to 20,000 seconds

Measurement Time: Consists of GATE TIME plus the time required to reach the next STOP trigger level. When in MIN the GATE TIME is less than 50 nanoseconds. When in a decade step, the counter will reset if a stop trigger level is not reached within approximately 3.4 times the GATE TIME setting. Decade GATE TIME ranges from 100 nsec to 1000 sec.

When using EXT GATE the measurement time consists of the GATE TIME divided by the duty cycle of the EXT GATE signal plus the time required to reach the next STOP trigger level after the end of the last EXT GATE pulse.

Accuracy: Resolution is nine digits per second of measurement time. With DISPLAY POSITION switch in AUTO the least significant digit error is ± 1 count if the most significant digit is 1 through 4, and ± 2 counts if the most significant digit is 5 through 9. Accuracy is \pm least significant digit (LSD) counts \pm time base accuracy \pm trigger error.*

TIME INTERVAL/TIME INTERVAL AVERAGE

Range: 10 nsec to 20,000 sec

Minimum Time Between Trigger Points: 10 nsec

Trigger Pulse Width: 1 nsec minimum width input at minimum voltage input.

Accuracy:

Time Interval: \pm trigger error** \pm 2 ns \pm time base accuracy

Time Interval Averaging:

$\pm \frac{\text{trigger error}^{**} \pm 2 \text{ nsec}}{\sqrt{\text{intervals averaged}}} \pm .7 \text{ nsec} \pm \text{time base accuracy}$

Not affected by harmonics of clock frequency.

Resolution:

Time Interval: 2 nsec

Time Interval Average:

$\pm \frac{2 \text{ nsec}}{\sqrt{\text{intervals averaged}}} \pm 2 \text{ picoseconds}$

Measurement Time: For single time interval measurements the GATE TIME switch should be in MIN. Measurement time will be the displayed time interval.

When a decade GATE TIME is selected, the counter will be in the TIME INTERVAL AVERAGE mode. The GATE TIME selected should be greater than the displayed time interval. The measurement time is now the GATE TIME divided by the duty cycle of the time interval waveform plus the time required to reach the next trigger stop level after the total GATE TIME has been accumulated.

*Trigger error for sine waves of 40 dB signal-to-noise amplitude ratio is $< (\pm 0.3\% \text{ of one period} + \text{number of periods averaged})$. If peak noise amplitude is greater than 10 millivolts, additional miscounting may occur (this situation can arise when measuring high-level outputs of broadband synthesized signal sources).

**For any wave shape, trigger error is less than

$$\pm \frac{0.0025}{\text{signal slope in } V/\mu\text{s}} \mu\text{s (with 40 dB S/N) or}$$

$$\pm \frac{2 \times \text{peak noise voltage}}{\text{signal slope in } V/\mu\text{s}} \mu\text{s}$$

RATIO B/A

Range: Both channels accept dc to 500 MHz

Accuracy: \pm LSD \pm trigger error* (applies only to channel A).

LSD is as described under FREQUENCY ACCURACY.

Measurement Time: Measurement time is equal to the GATE TIME selected times 500 MHz/frequency of Channel B input.

START/STOP

Range: Both inputs may have repetition rates from dc to 500 MHz.

Modes: A, A+B, and A-B is determined by a rear panel switch.

Resolution: Not affected by GATE TIME setting. Resolution is one count up to eleven digits.

Accuracy: Coincident pulses may be applied to both inputs. One count is required to initiate each input, i.e., in Mode A add one count to display, in Mode A+B add two counts to display, in Mode A-B add no counts to display.

SCALING

Range: dc to 500 MHz

Scaling Factor: Selectable by GATE TIME setting. As GATE TIME is varied from the 100 ns position to the 1000 s position, scaling factor increases from 10^2 to 10^{12} . Actual scaling factor equals GATE TIME setting $\times 10^{-9}$ seconds.

Input: Input signal through Channel A.

Output: Output frequency equals input frequency divided by scaling factor. Rear panel BNC supplies 80% duty cycle TTL compatible pulses.

INPUT CHANNELS A AND B

SEPARATE INPUTS

Range: DC coupled, 0 to 500 MHz

AC coupled, 1 M Ω 200 Hz to 500 MHz
50 Ω 4 MHz to 500 MHz

Impedance: Switch selectable, 1 M Ω shunted by less than 30 pF or 50 Ω nominal

Sensitivity: (preset)

X1 20 mV rms sine wave, 60 mV p-p pulse

X10 200 mV rms sine wave, 600 mV p-p pulse

Dynamic Range: (preset)

50 Ω X1 20 mV to 250 mV rms sine wave
60 mV to 750 mV p-p pulse

X10 200 mV to 2.5V rms sine wave
600 mV to 7V p-p pulse

1 M Ω X1 20 mV to 250 mV rms sine wave
60 mV to 750 mV p-p pulse

X10 200 mV to 2.5V rms sine wave
600 mV to 7.5V p-p pulse

Linear Operating Range: -2.0 to +0.5 Vdc

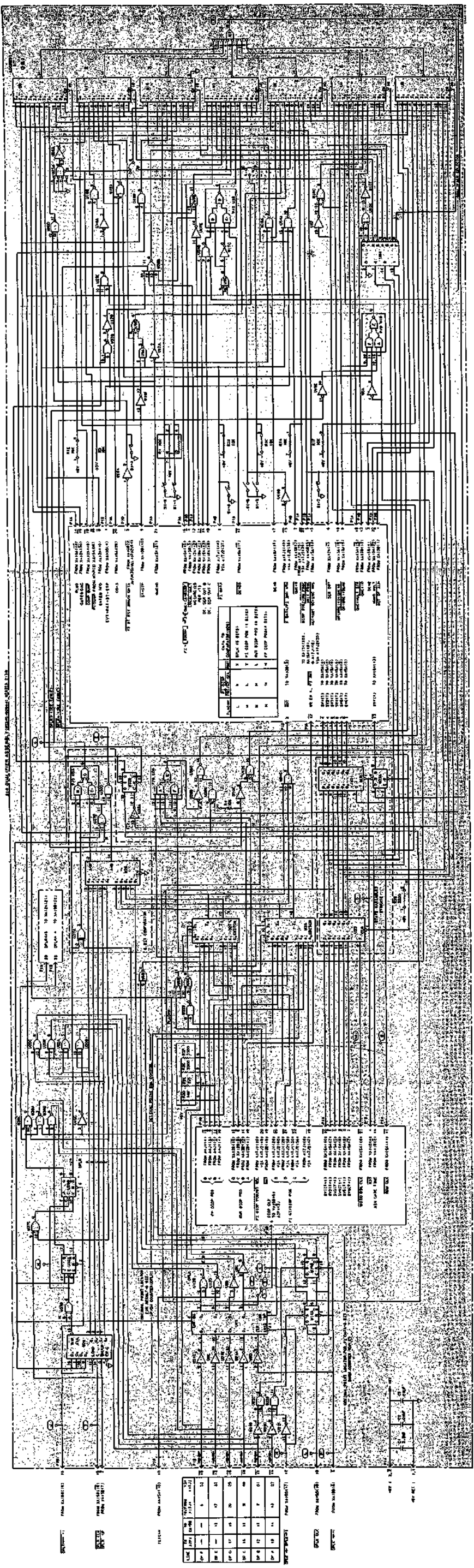
Trigger Level: Continuously adjustable over ± 1.3 Vdc. Adjustment is nonlinear with more settability around zero volts.

Preset: Centers trigger level about dc at 25 $^{\circ}$ C

Drift: ± 10 mV dc max., 0 $^{\circ}$ C to 55 $^{\circ}$ C

Output: CHAN A and CHAN B output trigger voltage (X ATTEN) is accurate to within ± 15 mV (X ATTEN) of actual trigger point hysteresis center. Rear BNC connectors.

Slope: Independent selection of positive or negative slope.



NOTES
 1. REVISIONS TO THIS DRAWING ARE INDICATED BY A REVISION NUMBER TO THE RIGHT OF THE DRAWING.
 2. UNLESS OTHERWISE SPECIFIED, ALL DIMENSIONS ARE IN INCHES.
 3. DIMENSIONS IN PARENTHESES ARE FOR INFORMATION ONLY.

REFERENCE DESIGNATIONS

A14
C1-3
P1
S1
U1-8

SERVICE NOTES

The A14 assembly has seven servicing switches (S1-7), some of which are related to the plug-in. These switches perform the following actions when selected:

- S1-1 (Close to the display) displays time and/or measurement contents.
- S1-2 Displays the complete arithmetic result in 8 bits or 16-bit bank.
- S1-3 Has the effect of nullifying the **DATA** register from the plug-in. Useful for observing S1-2 arithmetic result without an N.
- S1-4 Has the effect of nullifying the **DATA** register from the plug-in. Useful for observing S1-2 arithmetic result without a K.
- S1-5 Activates **PI DATA** without regard to plug-in status. Useful for observing the contents of the **PI DATA** register.
- S1-6 Forces an **INITIALIZE PROCESSOR** qualifier. Useful for observing the **START**, **STOP**, or **PI DATA** registers. Useful for viewing the processor's behavior with an oscilloscope.
- S1-7 (Close to the display) displays the cycle time of the processor once every 50 nsec. The cycle time with S1-7 is about once every 5 nsec.

Figure 7-1. A14 Qualifier Assembly

**Table 7-4. A12 Option 010, General Purpose Interface Output
Theory of Operation**

4-176. A12 Option 010, General Purpose Interface Output

4-177. Option 010 allows the counter to make measurements in accordance with the front panel controls and to output the results of the measurements by means of a bus system. The system uses standard ASCII characters to communicate its data. There are two modes of operation: the address to talk mode for outputting data and the TALK ONLY mode. The circuits can be cleared from talking by supplying a Interface Clear (IFC) signal.

4-178. ADDRESSING TO TALK. The controller sets the ATN line Low, causing a High on U5A(1) and U5B(4) and a Low on U4B(5). At this time, the NRFD line from U5B is High, indicating to the controller that the counter can now accept an ASCII byte. The controller addresses the counter to talk $\begin{pmatrix} \text{DIO} & 7 & 6 & 5 & 4 & 3 & 2 & 1 \\ & 1 & 0 & A_5 & A_4 & A_3 & A_2 & 0 \end{pmatrix}$ and, at some time later, pulls the DAV line Low, indicating there is valid data on the bus.

4-179. If the 4-line address code equals the code selected by the rear panel ADDRESS switches, the A=B line of U7(14) goes High. The address code also allows U3D to enable U4C and D. The result of this gating is a High on the J input of the Talk F-F (U6) and a Low on the K input. The DAV line was set Low when the counter was addressed to talk; however, it was delayed 500 ns by R7, C4, and U1A to allow time for the address code to be gated. The delayed DAV line now produces a 500 ns pulse in U2C, U1C, and U3A. This pulse NANDs in U4B with ATN (still Low) and clocks the Talk F-F. Once the flip-flop is set, the controller causes ATN to return High, since it has accepted a high NDAC.

4-180. OUTPUT ROUTINE. The High output of the Talk F-F is sent to A19 and returns on the TALK ONLY line when the rear panel switch is set to ADDRESSABLE. The line is continuously High when the switch is set to TALK ONLY. This signal is inverted in U9C and becomes $\overline{\text{SER OUT}}$, which starts the output routine. TALK ONLY and the High of ATN also cause the output of U5D to go Low. This Low level switches the bus terminators from their *third state* (off or high impedance state) to their active state. Measurement data can now be placed on the bus.

4-181. Once data is placed on the bus, the counter waits until the listener requests information by sending NRFD High. This results in a GATED RFD signal from U10A, U10C, and U14A. The counter responds by setting the FLAG = H line High. Since the $\overline{\text{EXT OUT EN}}$ line is Low during the output routine, U8A and U5C cause the DAV line to go Low, indicating the valid data is on the line. Once the listener accepts the data, it responds with a high NDAC signal. This produces a GATE DAC signal to place new data on the bus and repeat the process. Gate U10A causes GATED DAC and GATED RFD to go High if the bus is disconnected. This causes the processor section of the counter to exit the serial output routine.

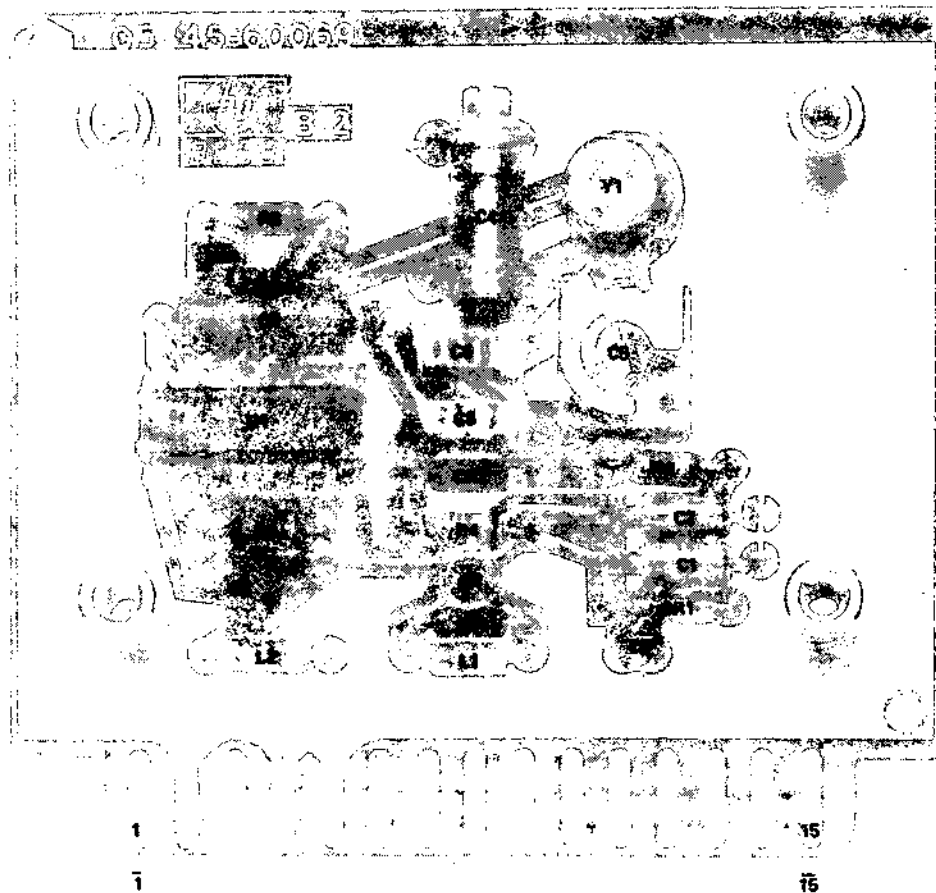
4-182. DATA TRANSFER. The DC SER OUT lines control the order of output data and the state of the ROMs (U16 and U17). Only one ROM is on at any given time. Three of the ROM's outputs (DIO7, 6, and 5) are sent to the Bus Drivers directly, while the remaining four lines are selected by four-pole switch U15. The ROMs convert the internal data codes to ASCII format. Since the counter is in its output routine, the $\overline{\text{EXT OUT EN}}$ line is Low. The FLAG = H lines goes High each time a new byte is ready for outputting on the bus. Table 4-2 shows the sequence of data flow to the ROMs, while Tables 4-3 and 4-4 list the ROM codes.

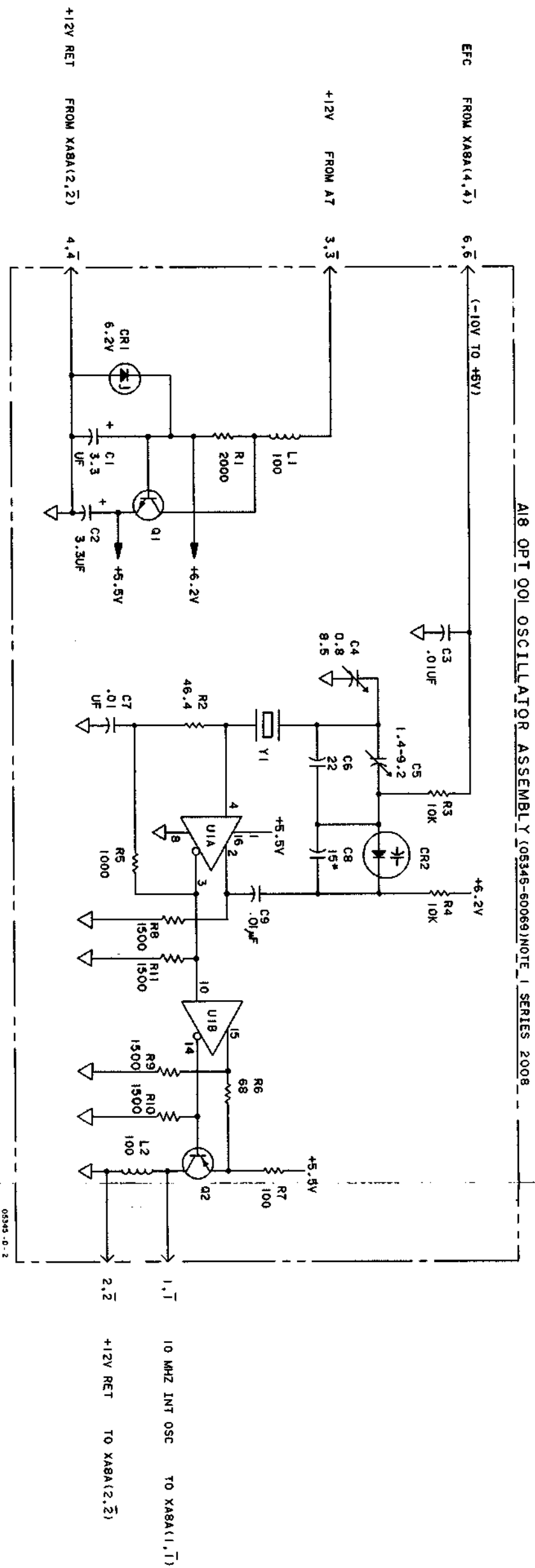
Table 7-5. A12 (Option 010) Replaceable Parts

Reference Designation	HP Part Number	C D	Qty	Description	Mfr Code	Mfr Part Number
A12	05345-60023	5	1	OUTPUT INTERFACE ASSEMBLY - OPTION 010	28480	05345-60023
A12C1	0160-3879	7	1	CAPACITOR FXD .01UF ±20% 100VDC CER	28480	0160-3879
A12C2	0180-2929	8	2	CAPACITOR-FXD 68UF ±10% 10V TA	28480	0180-2929
A12C3	0180-2929	8		CAPACITOR-FXD 68UF ±10% 10V TA	28480	0180-2929
A12C4	0160-0158	9	3	CAPACITOR-FXD 5600PF ±10% 200VDC POLYE	28480	0160-0158
A12C5	0160-0158	9		CAPACITOR-FXD 5600PF ±10% 200VDC POLYE	28480	0160-0158
A12C6	0160-0158	9		CAPACITOR-FXD 5600PF ±10% 200VDC POLYE	28480	0160-0158
A12CR1	1901-1068	5	2	DIODE-SM SIG SCHOTTKY	28480	1901-1068
A12CR2	1901-1068	5		DIODE-SM SIG SCHOTTKY	28480	1901-1068
A12CR3	1901-0040	1	2	DIODE-SWITCHING 30V 50MA 2NS DO-35	28480	1901-0040
A12CR4	1901-0040	1		DIODE-SWITCHING 30V 50MA 2NS DO-35	28480	1901-0040
A12J1	1200-0541	0	1	SOCKET-IC 24-CONT	28480	1200-0433
A12MP1	5000-9043	6	1	PIN, PC BOARD EXTRACTOR	28480	5000-9043
A12MP2	5040-8843	2	1	EXTRACTOR, PC BOARD	28480	5040-8843
A12R1	0683-4725	2	1	RESISTOR 4.7K 5% .25W FC TC=-400/+700	01121	CB4725
A12R2	0683-1035	1	1	RESISTOR 10K 5% .25W FC TC=-400/+700	01121	CB1035
A12R3	1810-0041	9	2	NETWORK RESISTOR 9-SIP 2.7K OHM X 8	28480	1810-0041
A12R4	1810-0136	3	2	NETWORK RESISTOR 10-SIP MULTI-VALUE	28480	1810-0136
A12R5	1810-0136	3		NETWORK RESISTOR 10-SIP MULTI-VALUE	28480	1810-0136
A12R6	1810-0041	9		NETWORK RESISTOR 9-SIP 2.7K OHM X 8	28480	1810-0041
A12R7	0683-1215	9	3	RESISTOR 120 5% .25W FC TC=-400/+600	01121	CB1215
A12R8	0683-1215	9		RESISTOR 120 5% .25W FC TC=-400/+600	01121	CB1215
A12R9	0683-1215	9		RESISTOR 120 5% .25W FC TC=-400/+600	01121	CB1215
A12U1	1820-1056	9	1	IC SCHMITT-TRIG TTL NAND QUAD 2-INP	01295	SN74132N
A12U2	1820-1199	1	3	IC INV TTL LS HEX 1-INP	01295	SN74LS04N
A12U3	1820-1197	9	2	IC GATE TTL LS NAND QUAD 2-INP	01295	SN74LS00N
A12U4	1820-1144	6	2	IC GATE TTL LS NOR QUAD 2-INP	01295	SN74LS02N
A12U5	1820-0621	2	1	IC BFR TTL NAND QUAD 2-INP	01295	SN7438N
A12U6	1820-0075	0	1	IC FF TTL J-K PULSE CLEAR DUAL	01295	SN7473N
A12U7	1820-0706	4	1	IC COMPUTER TTL MAGTD 5-BIT	07263	9324PC
A12U8	1820-1144	6		IC GATE TTL LS NOR QUAD 2-INP	01295	SN74LS02N
A12U9	1820-1199	1		IC INV TTL LS HEX 1-INP	01295	SN74LS04N
A12U10	1820-1197	9		IC GATE TTL LS NAND QUAD 2-INP	01295	SN74LS00N
A12U11	1820-1084	3	2	IC DRVR TTL BUS DRVR QUAD 1-INP	18324	N8T09N
A12U12	1820-1199	1		IC INV TTL LS HEX 1-INP	01295	SN74LS04N
A12U13	1820-1084	3		IC DRVR TTL BUS DRVR QUAD 1-INP	18324	N8T09N
A12U14	1820-1202	7	1	IC GATE TTL LS NAND TPL 3-INP	01295	SN74LS10N
A12U15	1820-1470	1	1	IC MUXR/DATA-SEL TTL LS 2-TO-1 LINE QUAD	01295	SN74LS157N
A12U16	05345-80006	6	1	ROM-PROGRAMMED	28480	05345-80006
A12U17	05345-80005	5	1	ROM-PROGRAMMED	28480	05345-80005
	1200-0473	8	2	SOCKET 16-DIP	28480	1200-0473
	8159-0005	0	1	RESISTOR-ZERO OHMS 22 AWG LEAD DIA	28480	8159-0005
A19	05345-60024	6	1	INTERFACE PANEL - OPTION 010	28480	05345-60024
	0380-0643	3	2	STANDOFF-HEX .255-IN-LG 6-32-THD	00000	ORDER BY DESCRIPTION
	0510-0002	5	1	THREADED INSERT NUT 6-32 .062-IN-LG STL	28480	0510-0002
	1251-3283	1	1	CONNECTOR- MICRORIBBON 24-CKT, 24-CONT	28480	1251-3283
	1530-1098	4	1	CLEVIS 0.070-IN W SLT 0.454-IN PIN CTR	00000	ORDER BY DESCRIPTION
	2190-0017	4	2	WASHER-LK HLCL NO. 8 .168-IN-ID	28480	2190-0017
	8120-0664	6	1	CABLE ASSEMBLY, 28AWG 24-COND	28480	8120-0664
	05345-00022	1	1	PLATE, REAR PANEL PATCH	28480	05345-00022

Table 7-6. A18 (Option 001) Replaceable

REFERENCE DESIGNATION	HP PART NUMBER	C D	QTY	DESCRIPTION	MFR CODE	MFR PART NUMBER
A18	05345-00069	9	1	OSCILLATOR ASSEMBLY - OPTION 001	28480	05345-00069
A18C1	0180-0210	6	2	CAPACITOR-FXD 3.3UF +-20% 15VDC TA	56289	150D335X0015A2
A18C2	0180-0210	6		CAPACITOR-FXD 3.3UF +-20% 15VDC TA	56289	150D335X0015A2
A18C3	0160-3879	7	2	CAPACITOR-FXD .01UF +-20% 100VDC CER	28480	0160-3879
A18C4	0121-0048	4	1	CAPACITOR-V TRMR PSTN .8-6.5PF 750V	73899	VC9G2
A18C5	0121-0128	1	1	CAPACITOR-V TRMR-AIR 1.9-10.8PF 350V	74970	189-0503-028
A18C6	0160-2265	3	1	CAPACITOR-FXD 22PF +-5% 500VDC CER 0+-30	28480	0160-2265
A18C7	0160-3879	7		CAPACITOR-FXD .01UF +-20% 100VDC CER	28480	0160-3879
A18C8	0160-2261	9	1	CAPACITOR-FXD 15PF +-5% 500VDC CER 0+-30	28480	0160-2261
A18C9	0160-0161	4	1	CAPACITOR-FXD .01UF +-10% 200VDC POLYE	28480	0160-0161
A18CR1	1902-0033	4	1	DIODE-ZNR 1N823 6.2V 5% DO-7 PD=4W	24046	1N823
A18CR2	0122-0221	7	1	DIODE-VVC 100PF 10% C4/C25-MIN=2 BVR=30V	28480	0122-0221
A18L1	9100-2276	9	2	INDUCTOR RF-CH-MLD 100UH 10% .105DX.26LG	28480	9100-2276
A18L2	9100-2276	9		INDUCTOR RF-CH-MLD 100UH 10% .105DX.26LG	28480	9100-2276
A18Q1	1854-0210	6	1	TRANSISTOR NPN 2N2222SI TO-18 PD=500MW	04713	2N2222
A18Q2	1853-0015	7	1	TRANSISTOR PNP SI PD=200MW FT=500MHZ	28480	1853-0015
A18R1	0757-0931	1	1	RESISTOR 2K 2% .125W F TC=0+-100	24546	C4-1/8L-TO-2001-G
A18R2	0698-4037	0	1	RESISTOR 46.4 1% .125W F TC=0+-100	24546	C4-1/8-TO-46R4-F
A18R3	0757-0948	0	2	RESISTOR 10K 2% .125W F TC=0+-100	24546	C4-1/8-TO-1002-G
A18R4	0757-0948	0		RESISTOR 10 2% .125W F TC=0+-100	24546	C4-1/8-TO-1002-G
A18R5	0757-0924	2	1	RESISTOR 1K 2% .125W F TC=0+-100	24546	C4-1/8-TO-1001-G
A18R6	0757-0896	7	1	RESISTOR 68 2% .125W F TC=0+-100	24546	C4-1/8-TO-68R0-G
A18R7	0757-0900	4	1	RESISTOR 100 2% .125W F TC=0+-100	24546	C4-1/8-TO-101-G
A18R8	0683-1525	4	4	RESISTOR 1.5K 5% .25W FC TC-400/+700	01121	CB1525
A18R9	0683-1525	4		RESISTOR 1.5K 5% .25W FC TC-400/+700	01121	CB1525
A18R10	0683-1525	4		RESISTOR 1.5K 5% .25W FC TC-400/+700	01121	CB1525
A18R11	0683-1525	4		RESISTOR 1.5K 5% .25W FC TC-400/+700	01121	CB1525
A18U1	1820-0806	5	1	IC GATE ECL OR-NOR DUAL 4-5-INP	04713	MC10109P
A18Y1	0410-0553	9	1	CRYSTAL-QUARTZ 10.000 MHZ	28480	0410-0553
	0380-0311	2	4	STANDOFF-RVT-ON .5-IN-LG 6-32-THD	00000	ORDER BY DESCRIPTION
	2360-0113	2	4	SCREW-MACH 6-32 .25-IN-LG PAN-HD POZI	00000	ORDER BY DESCRIPTION
	0400-0002	2	1	GROMMET-RND .188-IN-ID .312-IN-GRV-OD	28480	0400-0002
	05345-00021	7	1	COVER, METAL	28480	05345-00021





NOTES

1. REFERENCE DESIGNATIONS WITHIN THIS ASSEMBLY ARE ABBREVIATED. ADD ASSEMBLY NUMBER TO ABBREVIATION FOR COMPLETE DESCRIPTION.
2. UNLESS OTHERWISE INDICATED:
RESISTANCE IN OHMS;
CAPACITANCE IN PICOFARADS;
INDUCTANCE IN MICROHENRIES

REFERENCE DESIGNATIONS	A18
C1-8	
CR1,2	
L1,2	
Q1,2	
R1-7	
U1	
Y1	

Figure 7-2. A18 Option 001 10 MHz Oscillator Assembly

Figure 7-2
A18 OPTION 001 10 MHZ OSCILLATOR ASSEMBLY

(See page 7-33)

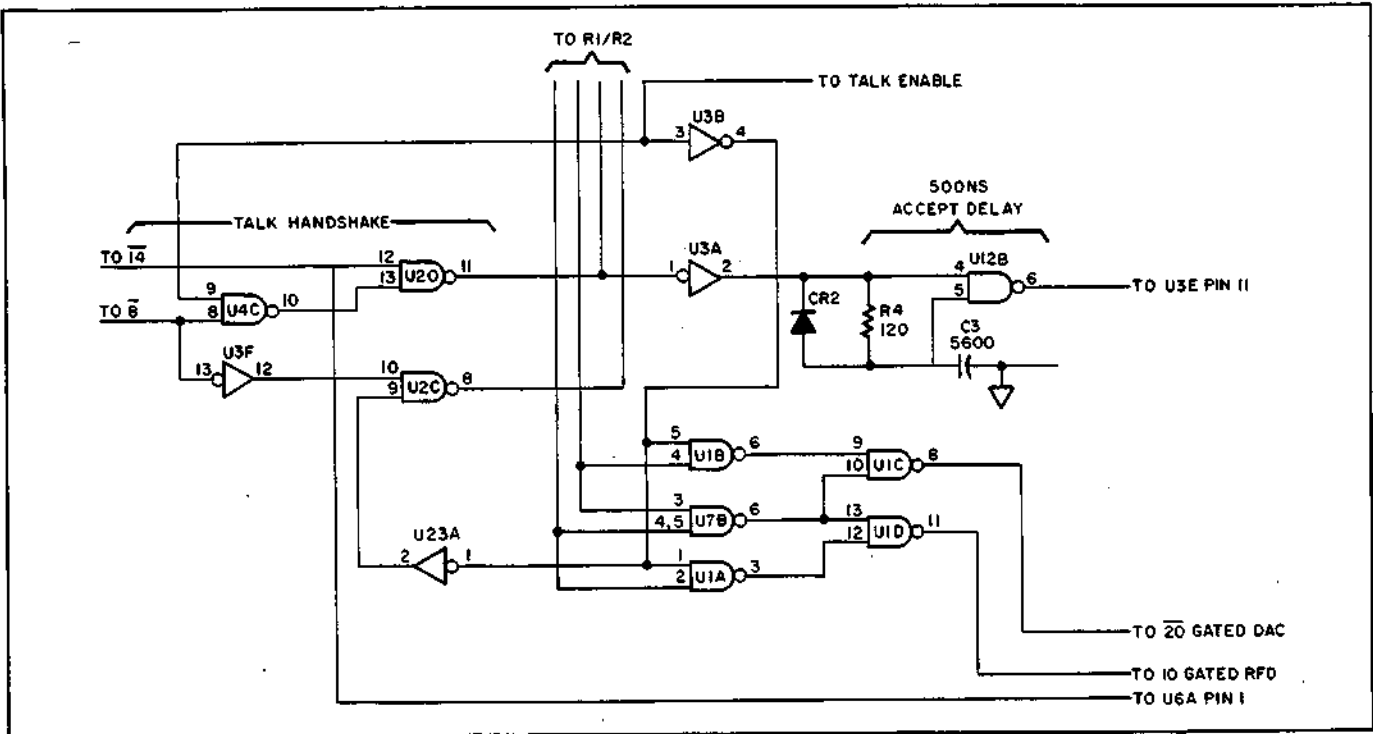


Figure 7-3. A12 Option 011 Partial Schematic Diagram

NOTES
1. REFERENCE DESIGNATIONS WITHIN THIS ASSEMBLY ARE TO BE INTERPRETED AS SHOWN FOR COMPLETE IDENTIFICATION.
2. WAVEFORMS, LOGIC DIAGRAMS, AND/OR CONNECTIONS IN THIS ASSEMBLY ARE TO BE INTERPRETED AS SHOWN FOR COMPLETE IDENTIFICATION.

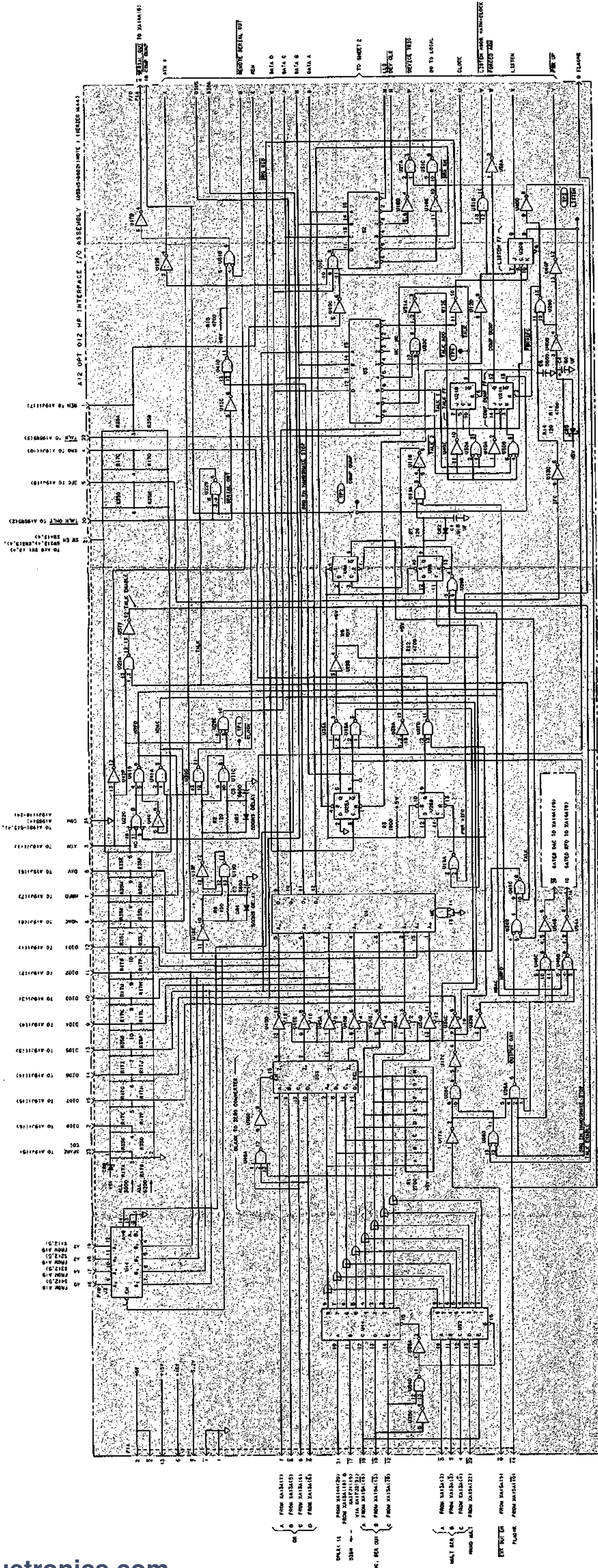


Figure 7-4A. A12 Opt 012 HP Interface I/O Assembly (Sheet 1 of 2)

Figure 7-4A
A12 OPTION 012 HP INTERFACE I/O ASSEMBLY
(Sheet 1 of 2)

(See page 7-37)

Table 7-5. Table of Specifications (Continued)

Maximum Input: Damage may occur beyond specified level. For larger inputs voltage divider probes 10020A for 50 Ω and 10004B for 1 M Ω are recommended.

50 Ω X1	$\pm 7V$ dc 7V rms below 5 MHz 3.5V rms (+24 dBm) above 5 MHz
X10	$\pm 7V$ dc, 7V rms (+30 dBm)
1 M Ω X1	$\pm 350V$ dc 250V rms to 20 kHz 3.5V rms to above 5 MHz
X10	$\pm 350V$ dc 250V rms to 20 kHz 35V rms above 5 MHz

Cross Talk: No effects if inputs to Channel A and B are both above or below 100 MHz. With one signal above 100 MHz and the other below, there are no effects if the lower frequency signal has a slew rate of $\geq 10V/\mu s$.

COMMON INPUT

In this mode the signal is applied to Channel A through a power splitter which equalizes impedances and delays to the input amplifiers. Channel B input is disabled. Both input impedance switches should be in the same position. All specifications are the same as for separate operation with the following differences.

Range: DC coupled, 0 to 400 MHz
AC coupled, 1 M Ω 300 Hz to 400 MHz
50 Ω 4 MHz to 400 MHz
Impedance: 1 M Ω becomes 500 k Ω shunted by < 50 pF
50 Ω no change

Sensitivity: (preset)

50 Ω X1	40 mV rms sine wave, 120 mV p-p pulse
X10	400 mV rms sine wave, 1.2V p-p pulse
1 M Ω	no change

Dynamic Range: (preset)

50 Ω X1	40 mV to 500 mV rms sine wave 120 mV to 1.5V p-p pulse
X10	400 mV to 5V rms sine wave, 1.2 to 5V p-p pulse
1 M Ω	no change

Maximum Input:

50 Ω	$\pm 5.0V$ dc and 5V rms
1 M Ω	no change

Trigger Level: Continuously adjustable over the range of ± 2.6 Vdc in 50 Ω or $\pm 1.3V$ dc in 1 M Ω multiplied by the attenuator setting.

Output: Rear BNC Connector

50 Ω	Output voltage X2 (X ATTN) is accurate to within ± 15 mV X2 (X ATTN) of actual trigger point.
1 M Ω	Same as in SEPARATE.

GENERAL

Display: 11 digit LED display and sign. Annunciator displays ksec to nsec, k to n, μ Hz to GHz. Decimal point is positioned with DISPLAY POSITION control or positioned after the first, second, or third most significant digit if DISPLAY POSITION is in AUTO. Leading zeros are suppressed.

Overflow: Asterisk is illuminated when display is overflowed or underflowed.

Sample Rate: Continuously variable from < 0.1 sec to > 5 sec with front panel control. In HOLD position the last reading is maintained until the counter is manually reset or an EXTERNAL ARM signal is applied. Number of readings per second will generally be limited by the output

device, i.e., 5150A Printer or 9830A Calculator. In COMPUTER DUMP mode the counter can take up to several thousand readings per second.

External Arm Input: Arming will be initiated by $-1.0V$ (-5.0 V max) into 50 Ω rear BNC input for greater than 500 ns. Minimum time between EXT ARM and acceptance of start pulse is < 1 μs .

External Gate Input: EXT GATE feature will respond to a 0.0V to $-1.0V$ pulse into 50 Ω with 50 ns or faster rise and fall time pulse edges. Maximum pulse height (damage level) is $-5V$. Minimum pulse width is 20 ns. Time delay of the leading edge of EXT GATE to the acceptance of input signal is less than 20 ns.

Gate Output: > 1 volt into 50 Ω .

Reset: Counter resets at initial turn on. Can be reset at any time with front panel pushbutton or through HP Interface Bus.

TIMEBASE

Standard High Stability Timebase: Crystal Frequency, 10 MHz Oven Oscillator (10544A). (See separate data sheet).

Stability:

Aging Rate: $< 5 \times 10^{-10}$ per day
Short Term: $< 1 \times 10^{-11}$ for 1 s average
Temperature: $< 7 \times 10^{-9}$, 0 $^{\circ}C$ to 55 $^{\circ}C$
Line Voltage: $< 1 \times 10^{-10}$, $\pm 10\%$ from nominal

External Frequency Standard Input: 1, 2, 2.5, 5, or 10 MHz $\pm 5 \times 10^{-6}$. Input voltage ≥ 1 V rms into 1 k Ω .

*For Oscillator off time less than 24 hours.

**15 minutes after change.

Option 001: Crystal Frequency, 10 MHz

Stability:

Aging Rate: $< 3 \times 10^{-7}$ per month
Short Term: $< 2 \times 10^{-9}$ rms for 1 s average
Temperature: $< 2 \times 10^{-6}$, 25 $^{\circ}C$ to 35 $^{\circ}C$
 $< 5 \times 10^{-6}$, 0 $^{\circ}C$ to 55 $^{\circ}C$

Line Voltage: $< 1 \times 10^{-8}$, $\pm 10\%$ from nominal

External Frequency Standard Input: 1, 2, 2.5, 5, or 10 MHz $\pm 5 \times 10^{-6}$. Input voltage ≥ 1 Vrms into 1 k Ω .

Frequency Standard Output: 10 MHz 1 Vrms high purity sine wave from 50 Ω source.

Operating Temperature: 0 $^{\circ}C$ to 55 $^{\circ}C$

Power Requirements: 100/120/220/240 Vrms $\pm 5\%$ -10% , 48 to 66 Hz, maximum power 250 VA.

Weight: 37 lbs (17 kg) net

OPTIONS

Option 001: Room temperature time base (room temperature crystal).

Option 010: Digital Output only. HP Interface Bus format, useful with 5150A Printer or 59301A with 5050B Printer.

Option 011: Digital Input/Output. Full compatibility with HP Interface Bus. Provides digital output as well as input for control over all functions except input amplifier.

Option 012: Similar to Option 011 but includes slope and level control. Recommended for computer or dedicated calculator applications. Programming codes differ slightly from Option 011. See 5345A Option 012 Technical Data Sheet for full specifications.

Option 908: Rack Mounting Kit

Table 7-5. Table of Specifications (Continued)

SELF-TEST

A 100 MHz is internally applied for testing all functions. Pushing RESET illuminates all segments of display digits. Seven internal diagnostic switches are provided for verifying the operation of the input amplifiers, digital front-end, processor, and plug-ins.

ACCESSORIES AVAILABLE

K13-59992A ASM Tester: Useful for troubleshooting Algorithmic State Machine processor

10595A Board Extender Kit: Useful for troubleshooting plug-in boards while in operation.

10590A Plug-In Adapter: Increases usefulness of 5345A by providing interface to 5245L plug-ins. Except as noted, the plug-ins listed below operate in a manner as they do in the 5245L. Measurements taken with the plug-in adapter combination yield similar accuracy, and greater speed and resolution than is associated with the 5245 series counters. Compatible plug-ins: 5251A, 5252A (lower frequency limit 1 MHz), 5253B, 5254C, 5255A, 5256A, 5257A, 5258A, 5261A (lower frequency limit 1 MHz), 5262A, 5265A, 5257A.

10004B: 50Ω Probe Kit

10020A: 10 MΩ Probe Kit

K15-59992A STANDBY POWER UNIT

Plug-in to maintain oscillator operation for prolonged periods without line voltage.

WEIGHT: 7.2 kg (3 lbs. 4 oz.) net

DIMENSIONS:

- NOTES:
DIMENSIONS IN INCHES AND (MILLIMETERS)
A EIA RACK HEIGHT (INCLUDING FILLER STRIP). FOR CABINET HEIGHT (INCLUDING FEET) ADD $\frac{3}{16}$ (B) TO EIA RACK HEIGHT
B REAR APRON RECESS

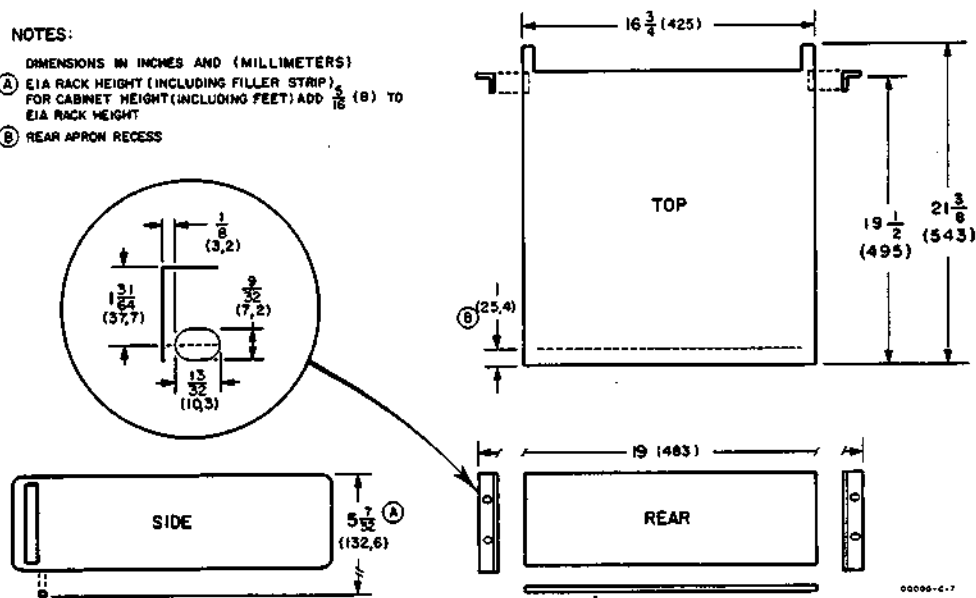


Table 7-6. Paragraphs 4-84 through 4-92

4-84. A3 Input Attenuator

4-85. The Input Attenuator consists of two input channels. The channels are completely separate with each input having ac or dc coupling, an attenuator network, selectable 50Ω or 1MΩ impedance, level control, slope selection, and high frequency amplifier.

4-86. **CIRCUIT THEORY.** The circuit theory describes only channel A, since Channel B is analogous. The signal entering J2 is sent directly through S1 or through coupling capacitor C1, which blocks the signal's dc component. S4 selects R3 for 50 ohm input impedance and R4 and R5 for 1M ohm input impedance. When S3 is in the COM A position and S4 is set to 50Ω, the two channels are connected together and R1 helps maintain the 50 ohm input for each channel. In SEP, the inputs are isolated from each other, R1 is bypassed, and the impedance switches can be set separately. S5 ATTEN switch passes the signal directly in X1 or when in X10, attenuates the signal by 10, through divider network R4 and R5.

4-87. The signal is then routed to the amplifier through one of two paths, depending on the frequency. Frequencies below 10 MHz, including dc, pass through the FET impedance converter (source follower). Higher frequencies are bypassed around the FET through C9. The FET's input is protected at low frequencies by R1, CR1, and CR2. The amplifier U2 has differential inputs and outputs and has a gain (single ended) of about 3. One input accepts the signal and the other accepts the dc level (+1.3V) from the LEVEL pot (via A4U4). The amplifier is biased by 5 current sources: Q3, Q4, R51, and R56. R44 adjusts the amplifier bias (-70 mV at pin 15).

4-88. The counter may trigger on either slope of the input signal. The SLOPE switch, S8, determines this by controlling the output polarities of U2. If S8 is placed to +, the outputs of U2 will be 180° out of phase with their respective inputs. When S8 is placed to -, the outputs of U2 will be in phase with their respective inputs.

4-89. A4 Input Trigger

4-90. The Input Trigger assembly provides additional amplification of the input signals before they are sent to the counting circuits. The differential output of A3 enters the board on pin P1A(4) and P1A(7) and goes to the inputs of U2. R2 adjusts the trigger output of U2 for 50% duty cycle with a sine wave input. The amplifier has a gain of about 3.5 and contains a Schmitt trigger, which shapes the lower frequencies into fast rise time square waves. R15, 21, 20, 25, 28, 31, and 32 are current source resistors for U2, while R16 adjusts the bias.

4-91. The trigger output of U2(13) is a negative pulse about -0.7V in amplitude. Pulse width depends on the input signal and on the setting of R2. Pulse amplitude is controlled by the trigger current source at pin 14.

4-92. U4 is a buffer amplifier, which accepts dc levels from the front panel LEVEL control or the rear panel level inputs. R11 corrects for offset voltages in A3U2 when the SLOPE switch position is changed. The output of U4 also connects to U2's current source and turns off the amplifier when the signal level exceeds +3.5 Vdc.

Table 7-7. Adjustment Procedures

A3 INPUT ATTENUATOR

Equipment:

- HP 3480A/3482A DVM
- Extender Cable 05345-60205
- HP 180A Oscilloscope with 1810A Sampler
- HP 8640B Signal Generator

Setup:

1. Set LEVEL controls to PRESET.
2. Connect DVM between common and the cathode of diode A4CR1. Adjust A4R11 for an indication of 0 volts ± 50 millivolts. Connect DVM between common and cathode of diode A4CR2. Adjust A4R13 for 0 volts ± 50 millivolts.

NOTE

Allow a 5-minute warmup before performing adjustment procedure.

Bias Adjustment

1. Remove front panel display assembly, as outlined in Section III. Connect display assembly to counter, using extender cable. Place side of cable with "CINCH" on side of board with part number (05345-60004).
2. Connect DVM to U2 pin 15 (Channel B, U1 pin 15).
3. Adjust bias pot A4R44 (Channel B, A3R47) for a reading of 1.00V ± 50 mV.

The following adjustments are done with the bottom cover and bottom air filter removed. The front panel display assembly is installed in the instrument.

Sensitivity Adjustment:

1. Set 5345A controls as follows:

Input Impedance	50 Ω
ATTEN (A&B)	X1
Input Coupling	DC
Input Amplifier Control	SEP
SLOPE (A&B)	+
LEVEL Control	PRESET

2. Set 8640B Signal Generator output to 100 MHz at 100 mV rms into 50 Ω .
3. Set 180A Oscilloscope controls as follows:

AC/DC	DC
MAGNIFIER	X1
DISPLAY	INT

Table 7-7. Adjustment Procedures (Continued)

4. Set 1810A Sampler controls as follows:

DISPLAY	FILTERED
MODE	A
POLARITY	+ UP
mV/DIV	200
TIME/DIV (outer knob)	10 nSEC
TIME/DIV (inner knob)	2 nSEC
CW SLOPE	+
SCAN	SWEEP
DIRECT/EXPANDED	EXPANDED
SCAN knob	almost fully cw

5. Disconnect the two white cables connected to the A9 board. Channel A output cable is the longer of the two. Connect these cables through an adapter connector (HP part number 1250-0831) to the oscilloscope's inputs.
6. Adjust A4R2 and A4R11 (Channel B, A4R5 and A4R13) for a signal on oscilloscope.
7. Adjust A4R11 (Channel B, A4R13) for no change in signal when SLOPE switch changes position.
8. Adjust A4R2 (Channel B, A4R45) for 50% duty cycle.
9. Set 8640B output to 20 mV rms.
10. Adjust A4R11 (Channel B, A4R13) for no change in signal when SLOPE switch changes position. Readjust A4R2 (Channel B, A4R5) for 50% duty cycle if required.

A4 INPUT TRIGGER

Equipment:

HP 3480A/3482A DVM
HP 180A Oscilloscope with 1810A Sampler
HP 8640B Signal Generator

NOTE

Allow a 5-minute warmup before performing adjustment procedure.

The following adjustments are done with the bottom cover and bottom air filter removed. The front panel display assembly is installed in the instrument. See Section III for removal of air filter.

Bias Adjustment:

1. Adjust A4R2 (Channel B, A4R5) offset pot to midpoint.
2. Connect 412A to A4U2 pin 3 (Channel B, A4U1 pin 3).
3. Adjust A4R16 (Channel B, A4R19) bias pot for a reading of +800 mV \pm 50 mV.

NOTE

NOTE — If A4U2 (Channel A) or A4U1 (Channel B) are replaced, the value of A4R15 (Channel A) or A4R18 (Channel B) may have to be increased in value to meet the 800 mV \pm 50 mV specifications. An increase of approximately 10 Ω increases adjustment range of A4R16 or A4R19 approximately 100 mV.

Sensitivity Adjustment:

1. Set 5345A controls as follows:

Input Impedance	50 Ω
ATTEN (A&B)	X1
Input Coupling	DC
Input Amplifier Control	SEP
SLOPE (A&B)	+
LEVEL Control	PRESET

Table 7-7. Adjustment Procedures (Continued)

2. Set 8640B Signal Generator output to 100 MHz at 100 mV rms into 50Ω.

3. Set 180A Oscilloscope controls as follows:

AC/DC	DC
MAGNIFIER	X1
DISPLAY	INT

4. Set 1810 Sampler controls as follows:

DISPLAY	FILTERED
MODE	A
POLARITY	+ UP
mV/DIV	200
TIME/DIV (outer knob)	10 nSEC
TIME/DIV (inner knob)	2 nSEC
CW SLOPE	+
SCAN	SWEEP
DIRECT/EXPANDED	EXPANDED
SCAN knob	almost fully cw

5. Disconnect the two white cables connected to the A9 board. Channel A output cable is the longer of the two. Connect these cables through an adapter connector (HP part number 1250-0831) to the oscilloscope's inputs.

6. Adjust A4R2 (Channel B, A4R5) for a signal on oscilloscope.

7. Adjust A4R11 (Channel B, A4R13) for no change in signal when SLOPE switch changes position.

8. Set 8640B output to 10 mV rms.

9. Adjust A4R2 (Channel B, A4R5) for 50% duty cycle.

10. Adjust A4R11 (Channel B, A4R13) for no change in signal when SLOPE switch changes position. Readjust A4R2 (Channel B, A4R5) for 50% duty cycle if required.

Table 7-8. A3/A4 Replaceable Parts

Reference Designation	HP Part Number	Qty	Description	Mfr Code	Mfr Part Number
A3	05345-60039	1	INPUT ATTENUATOR (OPTION 012)	28480	05345-60039
A3	05345-60038	1	INPUT ATTENUATOR ASSY (SERIES 1644)	28480	05345-60038
A3C1	0160-0551	2	CAPACITOR-FXD .01UF +100-0% 400WVDC CER	28480	0160-0551
A3C2	0160-0531	2	CAPACITOR-FXD .01UF +100-0% 400WVDC CER	28480	0160-0531
A3C3			STRAY CAPACITANCE		
A3C4	0160-4531	2	CAPACITOR-FXD 2.2±.25PF 50WVDC CER CHIP	28480	0160-4531
A3C5			NOT ASSIGNED		
A3C6			STRAY CAPACITANCE		
A3C7	0160-4531	2	CAPACITOR-FXD 2.2±.25PF 50WVDC CER CHIP	28480	0160-4531
A3C8			NOT ASSIGNED		
A3C9	0160-0552	2	CAPACITOR-FXD 100PF +-5% 400WVDC CER	28480	0160-0552
A3C10	0150-0072	2	CAPACITOR-FXD 200PF +-5% 1000WVDC CER	28480	0150-0072
A3C11	0160-0552		CAPACITOR-FXD 100PF +-5% 400WVDC CER	28480	0160-0552
A3C12	0150-0072		CAPACITOR-FXD 200PF +-5% 1000WVDC CER	28480	0150-0072
A3C13	0160-3879	55	CAPACITOR-FXD .01UF +-20% 100WVDC CER	28480	0160-3879
A3C14	0160-3879		CAPACITOR-FXD .01UF +-20% 100WVDC CER	28480	0160-3879
A3C15	0160-3879		CAPACITOR-FXD .01UF +-20% 100WVDC CER	28480	0160-3879
A3C16	0160-3879		CAPACITOR-FXD .01UF +-20% 100WVDC CER	28480	0160-3879
A3C17			NOT ASSIGNED		
A3C18			NOT ASSIGNED		
A3C19	0160-3876	11	CAPACITOR-FXD 47PF +-20% 200WVDC CER	28480	0160-3876
A3C20	0160-3878	41	CAPACITOR-FXD 1000PF +-20% 100WVDC CER	28480	0160-3878
A3C21	0160-3876		CAPACITOR-FXD 47PF +-20% 200WVDC CER	28480	0160-3876
A3C22	0160-3878		CAPACITOR-FXD 1000PF +-20% 100WVDC CER	28480	0160-3878
A3C23	0160-3878		CAPACITOR-FXD 1000PF +-20% 100WVDC CER	28480	0160-3878
A3C24	0160-3878		CAPACITOR-FXD 1000PF +-20% 100WVDC CER	28480	0160-3878
A3C25	0160-3878		CAPACITOR-FXD 1000PF +-20% 100WVDC CER	28480	0160-3878
A3C26	0160-3878		CAPACITOR-FXD 1000PF +-20% 100WVDC CER	28480	0160-3878
A3C27	0160-3879		CAPACITOR-FXD 0.01UF +-20% 100WVDC CER	28480	0160-3879
A3CR1	1901-0376	4	DIODE-GEN PRP 35V 50MA	28480	1901-0376
A3CR2	1901-0376		DIODE-GEN PRP 35V 50MA	28480	1901-0376
A3CR3	1901-0376		DIODE-GEN PRP 35V 50MA	28480	1901-0376
A3CR4	1901-0376		DIODE-GEN PRP 35V 50MA	28480	1901-0376
A3CR5	1901-0040	32	DIODE-SWITCHING 2NS 30V 50MA	28480	1901-0040
A3CR6	1901-0040		DIODE-SWITCHING 2NS 30V 50MA	28480	1901-0040
A3CR7	1901-0040		DIODE-SWITCHING 2NS 30V 50MA	28480	1901-0040
A3CR8	1901-0040		DIODE-SWITCHING 2NS 30V 50MA	28480	1901-0040
A3J1A	1251-2034	8	CONNECTOR: PC EDGE; 10-CONT; DIP SOLDER	71785	252-10-30-300
A3J1B	1251-2034		CONNECTOR: PC EDGE; 10-CONT; DIP SOLDER	71785	252-10-30-300
A3J2	1250-1163	2	CONNECTOR-RF BNC FEM SGL HDLE RR	28480	1250-1163
A3J3	1250-1163		CONNECTOR-RF BNC FEM SGL HDLE RR	28480	1250-1163
A3Q1	1855-0225	2	TRANSISTOR JFET, OVAL N-CHAN D-MODE SI	28480	1855-0225
A3Q2	1855-0225		TRANSISTOR JFET, OVAL N-CHAN D-MODE SI	28480	1855-0225
A3Q3	1854-0215	9	TRANSISTOR NPN SI PD=310MW FT=300MHZ	04713	SPS 3611
A3Q4	1854-0215		TRANSISTOR NPN SI PD=310MW FT=300MHZ	04713	SPS 3611
A3Q5	1854-0215		TRANSISTOR NPN SI PD=310MW FT=300MHZ	04713	SPS 3611
A3Q6	1854-0215		TRANSISTOR NPN SI PD=310MW FT=300MHZ	04713	SPS 3611
A3R1	0698-8382	1	RESISTOR 25 5% .25W C TC=0+-150	28480	0698-8382
A3R2			NOT ASSIGNED		
A3R3	0757-0072	2	RESISTOR 49.9 1% .5W F TC=0+-100	19701	MF7C1/2-T0-49R9-F
(FOR R3)	1251-2229	2	CONNECTOR: 1-CONT SKT .033 DIA	00779	1-331677-3
A3R4	0698-8881	2	RESISTOR 800K 5% .25W C TC=0+-150	28480	0698-8881
A3R5	0698-8880	2	RESISTOR 100K 5% .15W C TC=0+-150	28480	0698-8880
A3R6	0757-0072	19701	RESISTOR 49.9 1% .5W F TC=0+-100	19701	MF7C1/2-T0-49R9-F
(FOR R6)	1251-2229	00779	CONNECTOR: 1-CONT SKT .033 DIA	00779	1-331677-3
A3R7	0698-8881	28480	RESISTOR 800K 5% .25W C TC=0+-150	28480	0698-8881
A3R8	0698-8880	28480	RESISTOR 100K 5% .15W C TC=0+-150	28480	0698-8880
A3R9	2100-0597	2	RESISTOR-VAR W/SW 100K 20% CC SPST-SW	28480	2100-0597
A3R10	0683-2025	9	RESISTOR 2K 5% .25W FC TC=-400/+700	01121	CB2025
A3R11	2100-0597		RESISTOR-VAR W/SW 100K 20% CC SPST-SW	28480	2100-0597
A3R12	0683-2025		RESISTOR 2K 5% .25W FC TC=-400/+700	01121	CB2025
A3R13	0698-8381	2	RESISTOR 50 5% .15W C TC=0+-150	28480	0698-8381
A3R14	0683-5115	14	RESISTOR 510 5% .25W FC TC=-400/+600	01121	CB5115
A3R15	0698-8381		RESISTOR 50 5% .15W C TC=0+-150	28480	0698-8381
A3R16	0683-5115		RESISTOR 510 5% .25W FC TC=-400/+600	01121	CB5115
A3R17	0683-1055	2	RESISTOR 1M 5% .25W FC TC=-800/+900	01121	CB1055
A3R18	0683-1055		RESISTOR 1M 5% .25W FC TC=-800/+900	01121	CB1055
A3R19	0698-8615	4	RESISTOR 75K 1% 1/20W	28480	0698-8615
A3R20	0698-8615		RESISTOR 75K 1% 1/20W	28480	0698-8615
A3R21	0757-0420	6	RESISTOR 750 1% .125W F TC=0+-100	24546	C4-1/R-T0-751-F
A3R22	0698-6241	2	RESISTOR 750 5% .125W CC TC=0+-882	01121	BB7515
A3R23	0757-0420		RESISTOR 750 1% .125W F TC=0+-100	24546	C4-1/R-T0-751-F
A3R24	0757-0420		RESISTOR 750 1% .125W F TC=0+-100	24546	C4-1/R-T0-751-F
A3R25	0698-6241		RESISTOR 750 5% .125W CC TC=0+-882	01121	BB7515
A3R26	0757-0420		RESISTOR 750 1% .125W F TC=0+-100	24546	C4-1/R-T0-751-F
A3R27	0683-1125		RESISTOR 1.1K 5% .25W FC TC=-400/+700	01121	CB1125
A3R28	0698-8615		RESISTOR 75K 1% 1/20W	28480	0698-8615

▶ NOT IN OPTION 012.

See introduction to this section for ordering information

Table 7-8. A3/A4 Replaceable Parts (Continued)

Reference Designation	HP Part Number	Qty	Description	Mfr Code	Mfr Part Number	
A3R29	0698-8615	2	RESISTOR 75K 1% 1/20W	28480	0698-8615	
A3R30	0698-6283		RESISTOR 10 5% .125W CC TC=0+588	01121	891005	
A3R31	0683-1525		1	RESISTOR 1.5K 5% .25W FC TC=-400/+700	01121	C81525
A3R32	0698-5178		5	RESISTOR 1.5K 5% .125W CC TC=0+882	01121	B81525
A3R33	0698-3113		4	RESISTOR 100 5% .125W CC TC=0+588	01121	B81015
A3R34	0757-0802	2	RESISTOR 162 1% .5W F TC=0+-100	19701	MF7C-1/2-TO-162R-F	
A3R35	0698-3113		RESISTOR 100 5% .125W CC TC=0+588	01121	B81015	
A3R36	0757-0802		RESISTOR 162 1% .5W F TC=0+-100	19701	MF7C-1/2-TO-162R-F	
A3R37	0698-3378		17	RESISTOR 51 5% .125W CC TC=0+588	01121	B85105
A3R38	0683-1025		2	RESISTOR 1000 .5% .25W CC TC=-400/+800	01121	CB1025
A3R39	0698-3378	2	RESISTOR 51 5% .25W CC TC=-400/+800	01121	B85105	
A3R40	0683-1025		RESISTOR 1000 5% .25W CC TC=-400/+800	01121	CB1025	
A3R41	0698-3113		RESISTOR 100 5% .125W CC TC=0+588	01121	B81015	
A3R42	0698-3113		RESISTOR 100 5% .125W CC TC=0+588	01121	B81015	
A3R43	0698-6984		RESISTOR 470 5% .125W CC TC=0+882	01121	B84715	
A3R44	2100-1788	4	RESISTOR-VAR TRMR 500 OHM 10% C TOP ADJ	84048	170-501	
A3R45	0683-2415		1	RESISTOR 240 5% .25W FC TC=-400/+600	01121	C82415
A3R46	0698-6984		RESISTOR 470 5% .125W CC TC=0+882	01121	B84715	
A3R47	2100-1788		RESISTOR-VAR TRMR 500 OHM 10% C TOP ADJ	84048	170-501	
A3R48	0698-5564		1	RESISTOR 240 5% .125W CC TC=0+882	01121	B82415
A3R49	0698-6283	8	RESISTOR 10 5% .125W CC TC=0+588	01121	B81005	
A3R50	0683-1125		RESISTOR 1.1K 5% .25W FC TC=-400/+700	01121	CB1125	
A3R51 to A3R54	0683-1125		RESISTOR 1.1K 5% .25W FC TC=-400/+700	01121	CB1125	
A3R55	0698-3378		RESISTOR 51 5% .125W CC TC=0+588	01121	B85105	
A3R56	0683-4715		18	RESISTOR 470 5% .25W FC TC=-400/+600	01121	CB4715
A3R57	0698-3378	6	RESISTOR 51 5% .125W CC TC=0+588	01121	B85105	
A3R58	0683-4715		RESISTOR 470 5% .25W FC TC=-400/+600	01121	CB4715	
A3R59 to A3R62	0683-5105		RESISTOR 51 OHM 5% MW CF	01121	CB5105	
A3S1 (FOR S1)	05345-60100		LEVER/SLIDE ASSY	28480	05345-60100	
A3S2 (FOR S2)	1460-0603		SPRING WFRM .014-OD MUM	28480	1460-0603	
A3S3 (FOR S3)	05345-60100	LEVER/SLIDE ASSY	28480	05345-60100		
A3S3 (FOR S3)	1460-0603	SPRING WFRM .014-OD MUM	28490	1460-0603		
A3S4 (FOR S4)	05345-60100	LEVER/SLIDE ASSY	28480	05345-60100		
A3S5 (FOR S5)	1460-0603	SPRING WFRM .014-OD MUM	28480	1460-0603		
A3S6 (FOR S6)	05345-60100	LEVER/SLIDE ASSY	28480	05345-60100		
A3S6 (FOR S6)	1460-0603	SPRING WFRM .014-OD MUM	28480	1460-0603		
A3S7 (FOR S7)	05345-60100	LEVER/SLIDE ASSY	28480	05345-60100		
A3S8	1460-0603	SPRING WFRM .014-OD MUM	28480	1460-0603		
A3S9	3101-1596	2	SWITCH-SL DPDT-NS MINTR 1A 125VAC	28480	3101-1596	
A3U1	1826-0088	2	IC, LIN 114-BIT WIDE BAND AMPL	28480	1826-0088	
A3U2	1826-0088		IC, LIN 114-BIT WIDE BAND AMPL	28480	1826-0088	
A4	05345-40002	4	GUIDE (SWITCH TRACK)	28480	05345-40002	
A4	05345-60004	1	INPUT TRIGGER ASSY (SERIES 1612)	28480	05345-60004	
A4C1	0160-3879	4	CAPACITOR-FXD .01UF +-20% 100WVDC CER	28480	0160-3879	
A4C2	0160-3879		CAPACITOR-FXD .01UF +-20% 100WVDC CER	28480	0160-3879	
A4C3	0160-3879		CAPACITOR-FXD .01UF +-20% 100WVDC CER	28480	0160-3879	
A4C4	0160-3879		CAPACITOR-FXD .01UF +-20% 100WVDC CER	28480	0160-3879	
A4C5	0160-3878		CAPACITOR-FXD 1000PF +-20% 100WVDC CER	28480	0160-3878	
A4C6	0160-3878	4	CAPACITOR-FXD 1000PF +-20% 100WVDC CER	28480	0160-3878	
A4C7	0160-3878		CAPACITOR-FXD 1000PF +-20% 100WVDC CER	28480	0160-3878	
A4C8	0160-3878		CAPACITOR-FXD 1000PF +-20% 100WVDC CER	28480	0160-3878	
A4C9	0160-3878		CAPACITOR-FXD 1000PF +-20% 100WVDC CER	28480	0160-3878	
A4C10	0160-3878		CAPACITOR-FXD 1000PF +-20% 100WVDC CER	28480	0160-3878	
A4C11	0160-3876	4	CAPACITOR-FXD 47PF +-20% 200WVDC CER	28480	0160-3876	
A4C12	0180-0428		CAPACITOR-FXD: 68UF+-20% 6VDC TA-SOLID	28480	0180-0428	
A4C13	0180-0429		CAPACITOR-FXD: 68UF+-20% 6VDC TA-SOLID	28480	0180-0428	
A4C14	0160-3876		CAPACITOR-FXD 47PF +-20% 200WVDC CER	28480	0160-3876	
A4C15	0180-0428		CAPACITOR-FXD: 68UF+-20% 6VDC TA-SOLID	28480	0180-0428	
A4C16	0180-0428	4	CAPACITOR-FXD: 68UF+-20% 6VDC TA-SOLID	28480	0180-0428	
A4C17	0160-3876		CAPACITOR-FXD 47PF +-20% 200WVDC CER	28480	0160-3876	
A4C18	0160-3878		CAPACITOR-FXD 1000PF +-20% 100WVDC CER	28480	0160-3878	
A4C19	0160-3879		CAPACITOR-FXD .01UF +-20% 100WVDC CER	28480	0160-3879	
A4C20	0160-3876		CAPACITOR-FXD 47PF +-20% 200WVDC CER	28480	0160-3876	
A4C21	0160-3878	3	CAPACITOR-FXD 1000PF +-20% 100WVDC CER	28480	0160-3878	
A4C22	0160-3876		CAPACITOR-FXD 47PF +-20% 200WVDC CER	28480	0160-3876	
A4C23	0160-3876		CAPACITOR-FXD 47PF +-20% 200WVDC CER	28480	0160-3876	
A4C24	0160-3876		CAPACITOR-FXD 47PF +-20% 200WVDC CER	28480	0160-3876	
A4C25	0160-3876		CAPACITOR-FXD 47PF +-20% 200WVDC CER	28480	0160-3876	
A4CR1	1902-0074	3	DIODE-ZNR 7.15V 5% DO-7 PD=4W TC=+.047%	04713	SZ 10939-140	
A4CR2	1902-0074		DIODE-ZNR 7.15V 5% DO-7 PD=4W TC=+.047%	04713	SZ 10939-140	

NOT IN OPTION 012.

See introduction to this section for ordering information

Table 7-8. A3/A4 Replaceable Parts (Continued)

Reference Designation	HP Part Number	Qty	Description	Mfr Code	Mfr Part Number
A4CR3	1902-3036	5	DIODE ZENER 3.16V 5% DO-7 .4W	04713	SZ 10939-38
A4CR4	1902-3036		DIODE ZENER 3.16V 5% DO-7 .4W	04713	SZ 10939-38
A4L1	9100-1788		COIL: FXD: NON-MOLDED RF CHOKE: .75UH	02114	VK200-20/48
A4L2	9100-1788		COIL: FXD: NON-MOLDED RF CHOKE: .75UH	02114	VK200-20/48
A4L3	9100-1788		COIL: FXD: NON-MOLDED RF CHOKE: .75UH	02114	VK200-20/48
A4L4	9100-1789	2	COIL: FXD: NON-MOLDED RF CHOKE: .75UH	02114	VK200-20/48
A4L5	9100-1620		COIL-FXD MOLDED RF CHOKE 15UH 10%	24226	15/152
A4L6	9100-1620		COIL-FXD MOLDED RF CHOKE 15UH 10%	24226	15/152
A4L7	9100-0549		COIL-FXD MOLDED RF CHOKE 22UH 10%	06560	4422-8K
A4L8	9100-0549		COIL-FXD MOLDED RF CHOKE 22UH 10%	06560	4422-8K
A4R1	0698-5178	2	RESISTOR 1.5K 5% .125W CC TC=0+882	01121	881525
A4R2	2100-1788		RESISTOR-VAR TRMR 500 OHM 10% C TOP ADJ	84048	170-501
A4R3	0698-5178		RESISTOR 1.5K 5% .125W CC TC=0+882	01121	881525
A4R4	0698-5178		RESISTOR 1.5K 5% .125W CC TC=0+882	01121	881525
A4R5	2100-1788		RESISTOR-VAR TRMR 500 OHM 10% C TOP ADJ	84048	170-501
A4R6	0698-5178	2	RESISTOR 1.5K 5% .125W CC TC=0+882	01121	881525
A4R7	0698-3378		RESISTOR 51 5% .125W CC TC=0+588	01121	885105
A4R8	0698-3378		RESISTOR 51 5% .125W CC TC=0+588	01121	885105
A4R9	0698-3378		RESISTOR 51 5% .125W CC TC=0+588	01121	885105
A4R10	0698-3378		RESISTOR 51 5% .125W CC TC=0+588	01121	885105
A4R11	2100-3216	2	RESISTOR-VAR TRMR 10KOHM 20% C TOP ADJ	32997	3339H-1-103
A4R12	0698-8623		RESISTOR-VAR TRMR 10KOHM 20% C TOP ADJ	28480	0698-8623
A4R13	2100-3216	3	RESISTOR-VAR TRMR 10KOHM 20% C TOP ADJ	32997	3339H-1-103
A4R14	0698-8623		RESISTOR 360 2% .125W F TC=0+-100	28480	0698-8623
A4R15	0757-0913		RESISTOR 360 2% .125W F TC=0+-100	24546	C4-1/8-TO-361-G
A4R16	2100-1984	2	RESISTOR-VAR TRMR 100 OHM 10% C TOP ADJ	84048	170-101
A4R17	0698-5183		RESISTOR 4.3K 5% .125W CC TC=0+882	01121	884325
A4R18	0757-0913	2	RESISTOR 360 2% .125W F TC=0+-100	24546	C4-1/8-TO-361-G
A4R19	2100-1984		RESISTOR-VAR TRMR 100 OHM 10% C TOP ADJ	84048	170-101
A4R20	0698-5183		RESISTOR 4.3K 5% .125W CC TC=0+882	01121	884325
A4R21	0686-6815		RESISTOR 680 5% .5W CC TC=0+529	01121	886815
A4R22	0757-0407	7	RESISTOR 200 1% .125W F TC=0+-100	24546	C4-1/8-TO-201-F
A4R23	0686-6815		RESISTOR 680 5% .5W CC TC=0+529	01121	886815
A4R24	0757-0407		RESISTOR 200 1% .125W F TC=0+-100	24546	C4-1/8-TO-201-F
A4R25	0683-1125		RESISTOR 1.1K 5% .25W FC TC=-400/+700	01121	C81125
A4R26	0683-1125		RESISTOR 1.1K 5% .25W FC TC=-400/+700	01121	C81125
A4R27*	0683-5105	9	RESISTOR 51 5% .25W FC TC=-400/+500 *FACTORY SELECTED PART	01121	C85105
A4R28	0683-1125		RESISTOR 1.1K 5% .25W FC TC=-400/+700	01121	C81125
A4R29*	0683-5105		RESISTOR 51 5% .25W FC TC=-400/+500 *FACTORY SELECTED PART	01121	C85105
A4R30	0683-1125	4	RESISTOR 1.1K 5% .25W FC TC=-400/+700	01121	C81125
A4R31	0698-3378		RESISTOR 51 5% .125W CC TC=0+588	01121	885105
A4R32	0683-4715		RESISTOR 470 5% .25W FC TC=-400/+600	01121	C84715
A4R33	0698-3378		RESISTOR 51 5% .125W CC TC=0+588	01121	885105
A4R34	0683-4715		RESISTOR 470 5% .25W FC TC=-400/+600	01121	C84715
A4R35	0683-2425	4	RESISTOR 2.4K 5% .25W FC TC=-400/+700	01121	C82425
A4R36	0683-2425		RESISTOR 2.4K 5% .25W FC TC=-400/+700	01121	C82425
A4R39	0698-3111	2	RESISTOR 30 5% .125W CC TC=0+-850	01121	883005
A4R40	0698-3111		RESISTOR 30 5% .125W CC TC=0+-850	01121	883005
A4R41	0698-3378		RESISTOR 51 5% .125W CC TC=0+588	01121	885105
A4R42	0683-1615	2	RESISTOR 160 5% .25W FC TC=-400/+600	01121	C81615
A4R43	0698-3378		RESISTOR 51 5% .125W CC TC=0+588	01121	885105
A4R44	0683-1615		RESISTOR 160 5% .25W FC TC=-400/+600	01121	C81615
A4U1	1826-0290	2	IC:AMPLIFIER	28480	1826-0290
A4U2	1826-0290		IC:AMPLIFIER	28480	1826-0290
A4U3	1826-0021	2	IC:LM310H	27014	LM310H
A4U4	1826-0021		IC:LM310H	27014	LM310H

See introduction to this section for ordering information

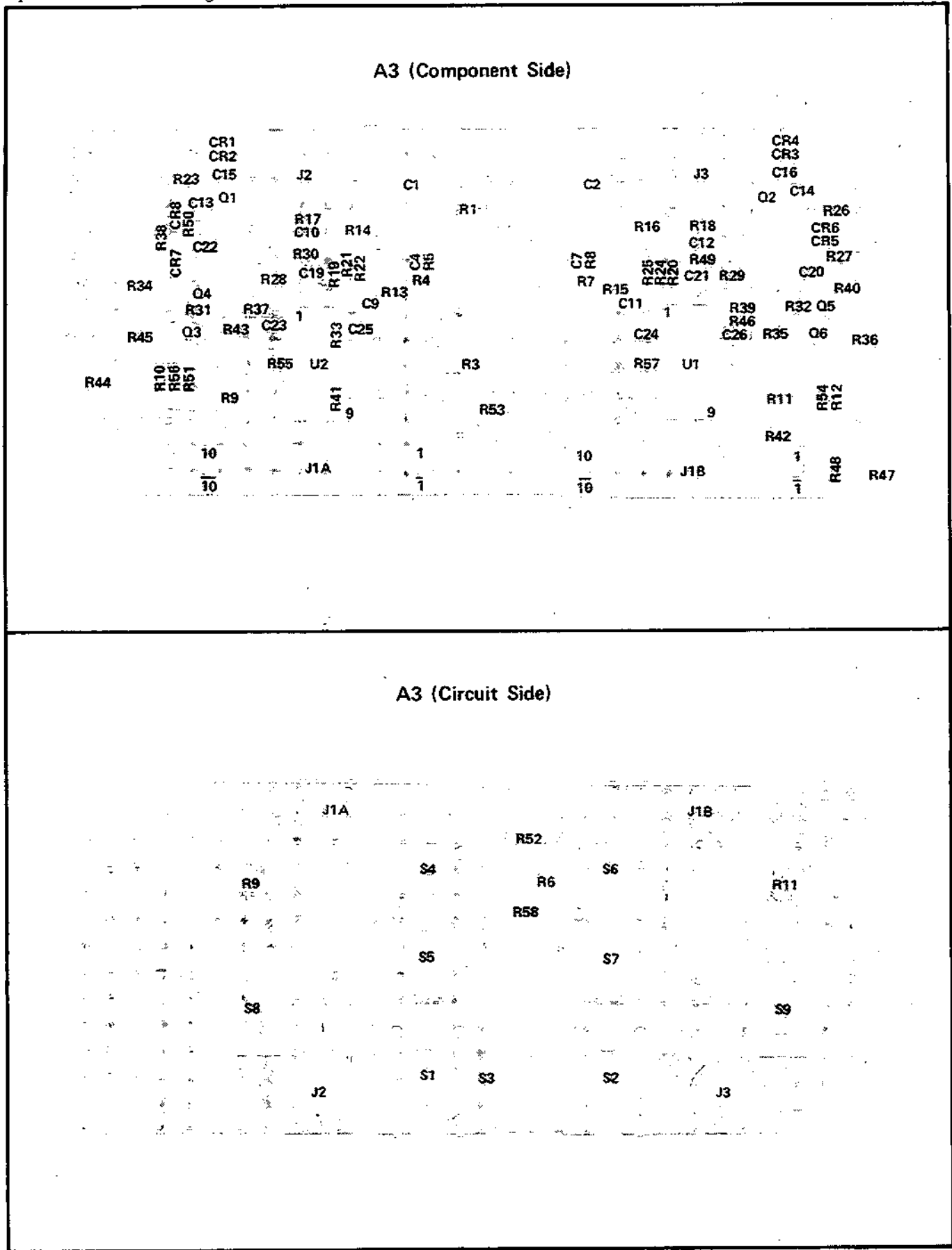
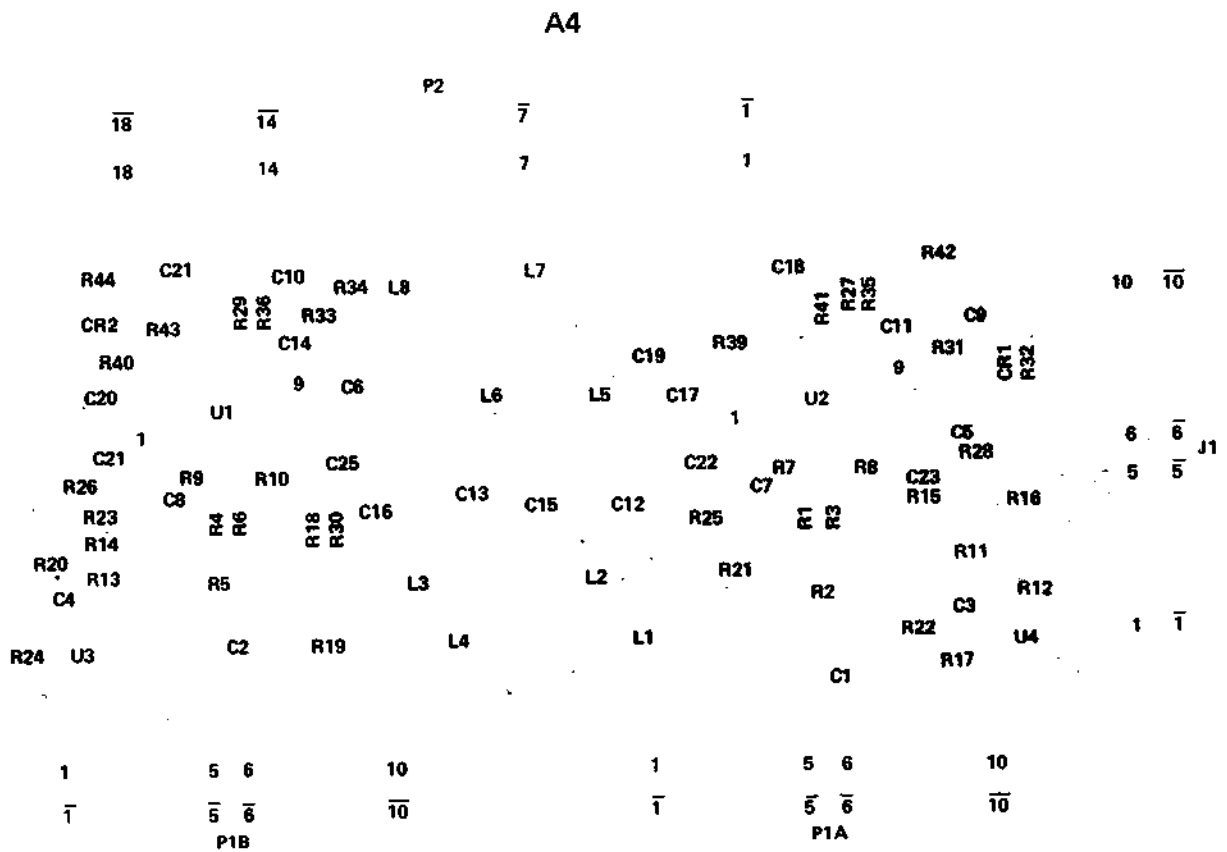


Figure 7-5. A3 Input Attenuator Assembly

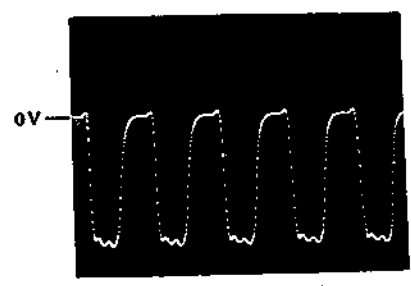


5345-A-30

Equipment: 180A with 1810A

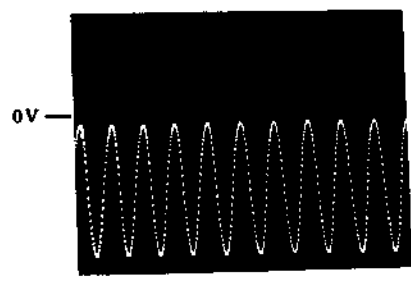
Schmitt trigger output taken from A5 cable, using BNC-to-subminiature adaptor, part number 1250-0831.

Figure 1.
(100 MHz)

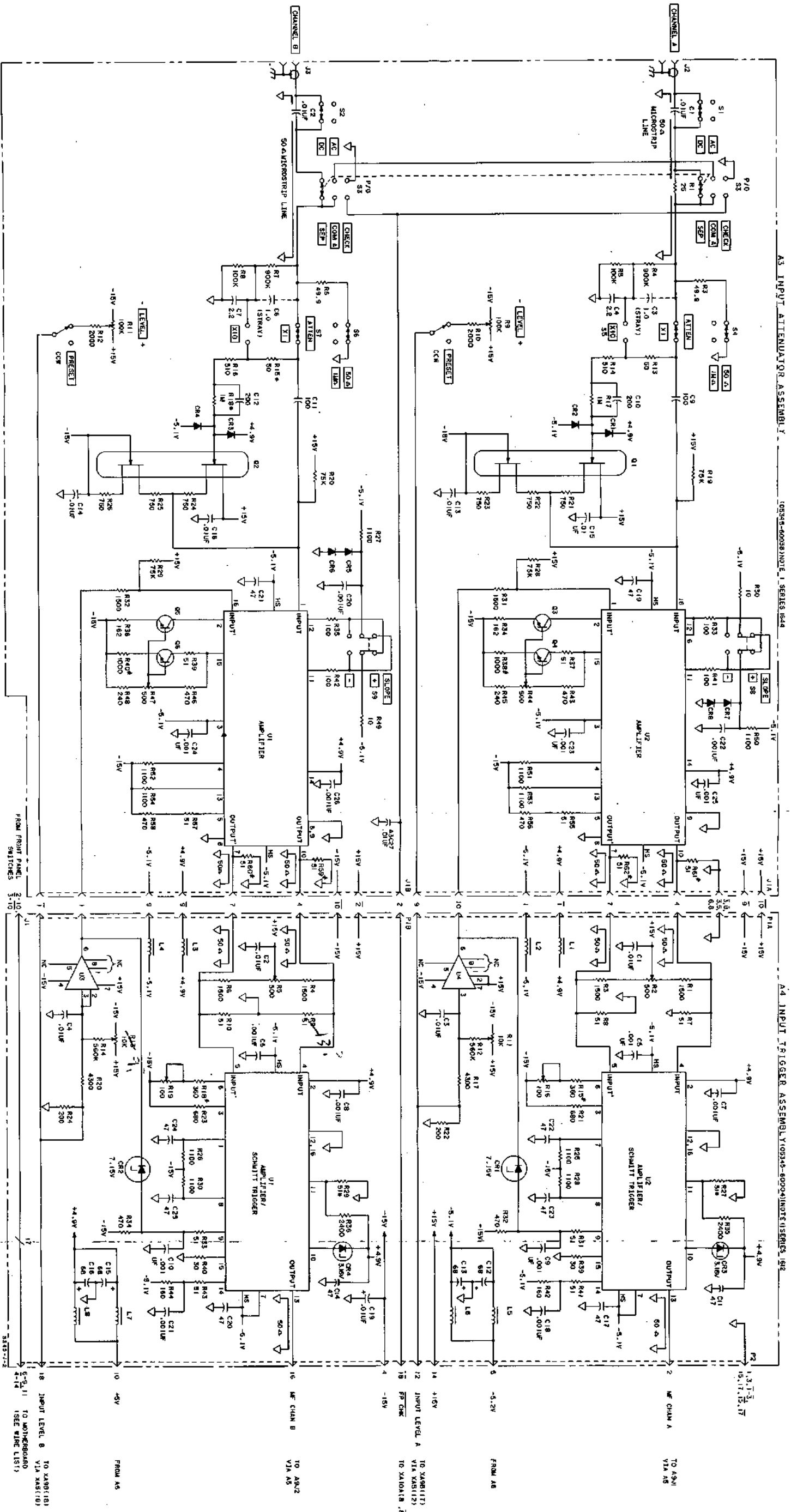


200 mV/DIV,
5 nS/DIV, + SLOPE,
EXPANDED

Figure 2.
(500 MHz)



200 mV/DIV,
2 nS/DIV, + SLOPE,
EXPANDED



- NOTES**
1. REFERENCE DESIGNATIONS WITHIN THIS ASSEMBLY ARE REFERRED TO BY THE OPTION NUMBER AND LETTER DESIGNATION. UNLESS OTHERWISE INDICATED.
 2. RESISTANCE IN OHMS, CAPACITANCE IN MICROFARADS, AND INDUCTANCE IN MICROHENRIES.
 3. ASTERISK (*) INDICATES SELECTED COMPONENT, AVERAGE VALUES SHOWN.
- | REFERENCE DESIGNATIONS | |
|------------------------|-------|
| A3 | A4 |
| C1-27 | C1-25 |
| CR1-4 | CR1-4 |
| J1-3 | J1-4 |
| Q1-5 | Q1-2 |
| R1-30 | R1-4 |
| S1-2 | S1-4 |
| U1-2 | U1-4 |

Figure 7-6. A3 Input Attenuator Assembly
A4 Input Trigger Assembly

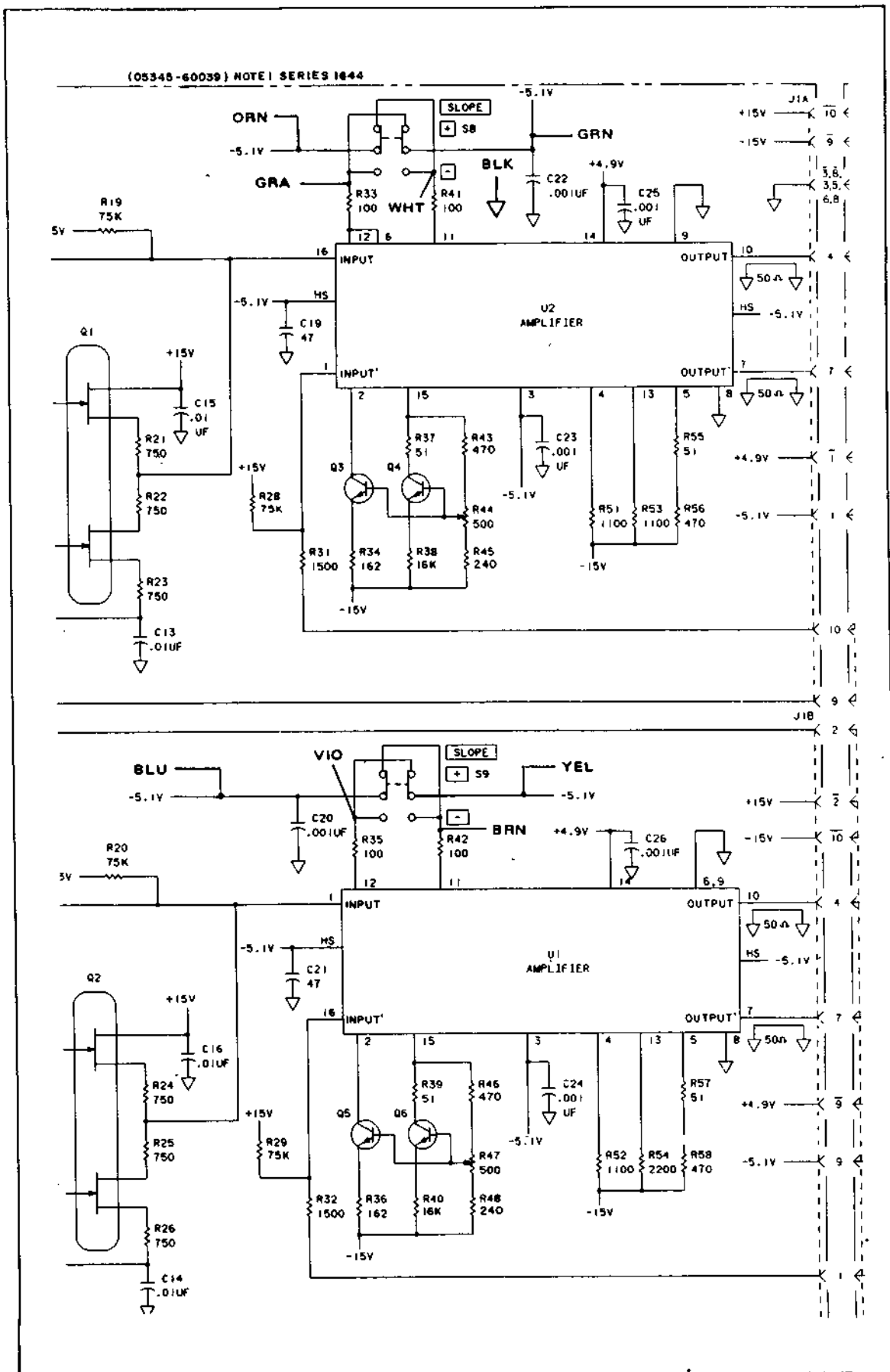


Figure 7-6A. Partial A3 Schematic (05345-60029 or 05345-60039) for Option 012

Figure 7-6
**A/3 INPUT ATTENUATOR ASSEMBLY,
A4 INPUT TRIGGER ASSEMBLY**

(See page 7-51)

Table 7-9. A9 Replaceable Parts

Reference Designation	HP Part Number	Qty	Description	Mfr Code	Mfr Part Number
A9	05345-60009	1	GATE CONTROL ASSY (SERIES 1516A)	28480	05345-60009
A9C1	0160-3060		CAPACITOR-FXD .1UF +-20% 25WVDC CER	28480	0160-3060
A9C2	0180-1714		CAPACITOR-FXD: 330UF+-10% 6VDC TA-SOLID	56289	1500337X900652
A9C3	0190-1702	1	CAPACITOR-FXD: 180UF+-20% 6VDC TA-SOLID	56239	1500187X0006R2
A9C4	0160-3875		CAPACITOR-FXD 22PF +-5% 200WVDC CER	28490	0160-3875
A9C5	0160-3877	6	CAPACITOR-FXD 100PF +-20% 200WVDC CER	28480	0160-3877
A9C6	0160-3877		CAPACITOR-FXD 100PF +-20% 200WVDC CER	28480	0160-3877
A9C7	0160-3877		CAPACITOR-FXD 100PF +-20% 200WVDC CER	28480	0160-3877
A9C8	0160-3877		CAPACITOR-FXD 100PF +-20% 200WVDC CER	28480	0160-3877
A9C9	0150-0050		CAPACITOR-FXD 1000PF +-80-20% 1000WVDC	28480	0150-0050
A9C10	0150-0050		CAPACITOR-FXD 1000PF +-80-20% 1000WVDC	28480	0150-0050
A9C11	0150-0050		CAPACITOR-FXD 1000PF +-80-20% 1000WVDC	28480	0150-0050
A9C12	0160-3879		CAPACITOR-FXD .01UF +-20% 100WVDC CER	28480	0160-3879
A9C13	0160-3879		CAPACITOR-FXD .01UF +-20% 100WVDC CER	28480	0160-3879
A9C14	0160-3879		CAPACITOR-FXD .01UF +-20% 100WVDC CER	28480	0160-3879
A9C15	0150-0050		CAPACITOR-FXD 1000PF +-80-20% 1000WVDC	28480	0150-0050
A9C16	0150-0050		CAPACITOR-FXD 1000PF +-80-20% 1000WVDC	28480	0150-0050
A9C17	0160-3879		CAPACITOR-FXD .01UF +-20% 100WVDC CER	28480	0160-3879
A9C18	0160-3879		CAPACITOR-FXD .01UF +-20% 100WVDC CER	28480	0160-3879
A9C19	0160-3879		CAPACITOR-FXD .01UF +-20% 100WVDC CER	28480	0160-3879
A9C20	0160-3879		CAPACITOR-FXD .01UF +-20% 100WVDC CER	28480	0160-3879
A9C21	0150-0050		CAPACITOR-FXD 1000PF +-80-20% 1000WVDC	28480	0150-0050
A9C22	0150-0050		CAPACITOR-FXD 1000PF +-80-20% 1000WVDC	28480	0150-0050
A9C23	0160-3879		CAPACITOR-FXD .01UF +-20% 100WVDC CER	28480	0160-3879
A9C24	0160-3879		CAPACITOR-FXD .01UF +-20% 100WVDC CER	28480	0160-3879
A9C25	0160-2262	1	CAPACITOR-FXD 16PF +-5% 500WVDC CER	28480	0160-2262
A9C26	0160-3877		CAPACITOR-FXD 100PF +-20% 200WVDC CER	28480	0160-3877
A9C27	0150-0050		CAPACITOR-FXD 1000PF +-80-20% 1000WVDC	28480	0150-0050
A9C28	0160-3879		CAPACITOR-FXD .01UF +-20% 100WVDC CER	28480	0160-3879
A9C29	0160-3879		CAPACITOR-FXD .01UF +-20% 100WVDC CER	28480	0160-3879
A9C30	0160-3879		CAPACITOR-FXD .01UF +-20% 100WVDC CER	28480	0160-3879
A9C31	0160-3879		CAPACITOR-FXD .01UF +-20% 100WVDC CER	28480	0160-3879
A9C32	0160-3879		CAPACITOR-FXD .01UF +-20% 100WVDC CER	28480	0160-3879
A9C33	0160-3877		CAPACITOR-FXD 100PF +-20% 200WVDC CER	28480	0160-3877
A9C34	0160-3879		CAPACITOR-FXD .01UF +-20% 100WVDC CER	28480	0160-3879
A9C35	0160-3879		CAPACITOR-FXD .01UF +-20% 100WVDC CER	28480	0160-3879
A9C36	0150-0050		CAPACITOR-FXD 1000PF +-80-20% 1000WVDC	28480	0150-0050
A9C37	0160-3879		CAPACITOR-FXD .01UF +-20% 100WVDC CER	28480	0160-3879
A9C38	0160-3879		CAPACITOR-FXD .01UF +-20% 100WVDC CER	28480	0160-3879
A9CR1	1901-0040		DIODE-SWITCHING 2N5 30V 50MA	28480	1901-0040
A9CR2	1902-3002	1	DIODE-ZNR 2.97V 5% DO-7 PD=.4W TC=-.074K	04713	S1 10499-2
A9CR3	1901-0040		DIODE-SWITCHING 2N5 30V 50MA	28480	1901-0040
A9CR4	1901-0040		DIODE-SWITCHING 2N5 30V 50MA	28480	1901-0040
A9CR5	1901-0040		DIODE-SWITCHING 2N5 30V 50MA	28480	1901-0040
A9J1	1250-0836		CONNECTOR-RF SMC M PC	2K497	CD-700141
A9J2	1250-0836		CONNECTOR-RF SMC M PC	2K497	CD-700141
A9L1	9100-0346	1	COIL-FXD MOLDED RF CHOKE 110UH 5K	24226	15/113
A9L2	9100-0346		COIL-FXD MOLDED RF CHOKE 50MH 20K	28480	9100-0346
A901	1854-0071		TRANSISTOR NPN SI PD=300MW FT=200MHZ	28480	1854-0071
A902	1854-0071		TRANSISTOR NPN SI PD=300MW FT=200MHZ	28480	1854-0071
A903	1854-0071		TRANSISTOR NPN SI PD=300MW FT=200MHZ	28480	1854-0071
A904	1854-0071		TRANSISTOR NPN SI PD=300MW FT=200MHZ	28480	1854-0071
A905	1854-0071		TRANSISTOR NPN SI PD=300MW FT=200MHZ	28480	1854-0071
A906	1854-0071		TRANSISTOR NPN SI PD=300MW FT=200MHZ	28480	1854-0071
A907	1854-0071		TRANSISTOR NPN SI PD=300MW FT=200MHZ	28480	1854-0071
A908	1853-0020		TRANSISTOR PNP SI PD=300MW FT=150MHZ	28480	1853-0020
A909	1854-0071		TRANSISTOR NPN SI PD=300MW FT=200MHZ	28480	1854-0071
A9010	1853-0020		TRANSISTOR PNP SI PD=300MW FT=150MHZ	28480	1853-0020
A9011	1854-0345		TRANSISTOR NPN 2N5179 SI TD-T2 PD=200MW	04713	2N5179
A9012	1854-0345		TRANSISTOR NPN 2N5179 SI TD-T2 PD=200MW	04713	2N5179
A9013	1854-0092	8	TRANSISTOR NPN SI PD=200MW FT=600MHZ	28480	1854-0092
A9014	1854-0092		TRANSISTOR NPN SI PD=200MW FT=600MHZ	28480	1854-0092
A9015	1854-0071		TRANSISTOR NPN SI PD=300MW FT=200MHZ	28480	1854-0071
A9016	1854-0071		TRANSISTOR NPN SI PD=300MW FT=200MHZ	28480	1854-0071
A9017	1854-0071		TRANSISTOR NPN SI PD=300MW FT=200MHZ	28480	1854-0071
A9018	1854-0071		TRANSISTOR NPN SI PD=300MW FT=200MHZ	28480	1854-0071
A9R1	0757-0940	1	RESISTOR 4.7K 2% .125W F TC=0+-100	24546	C4-1/8-T0-6701-G
A9R2	0757-0931		RESISTOR 2K 2% .125W F TC=0+-100	24546	C4-1/8-T0-2001-G
A9R3	0757-0931		RESISTOR 2K 2% .125W F TC=0+-100	24546	C4-1/8-T0-2001-G
A9R4	0757-0922	2	RESISTOR 820 2% .125W F TC=0+-100	24546	C4-1/8-T0-821-G
A9R5	0757-0931		RESISTOR 2K 2% .125W F TC=0+-100	24546	C4-1/8-T0-2001-G

NOTE 1: ADDITION OF THE 1205-0011 FOR ABU7 IS RECOMMENDED FOR INSTRUMENTS WITH SERIAL PREFIXES BELOW 1604A.

See introduction to this section for ordering information

Table 7-9. A9 Replaceable Parts (Continued)

Reference Designation	HP Part Number	Qty	Description	Mfr Code	Mfr Part Number
A9R6	0757-0931		RESISTOR 2K 2% .125W F TC=0+-100	24546	C4-1/8-T0-2001-G
A9R7	0757-0931		RESISTOR 2K 2% .125W F TC=0+-100	24546	C4-1/8-T0-2001-G
A9R8	0757-0922		RESISTOR 820 2% .125W F TC=0+-100	24546	C4-1/8-T0-821-G
A9R9	0757-0893		RESISTOR 51 2% .125W F TC=0+-100	24546	C4-1/8-T0-51R0-G
A9R10	0757-0893		RESISTOR 51 2% .125W F TC=0+-100	24546	C4-1/8-T0-51R0-G
A9R11	0757-0893		RESISTOR 51 2% .125W F TC=0+-100	24546	C4-1/8-T0-51R0-G
A9R12	0757-0893		RESISTOR 51 2% .125W F TC=0+-100	24546	C4-1/8-T0-51R0-G
A9R13	0757-0893		RESISTOR 51 2% .125W F TC=0+-100	24546	C4-1/8-T0-51R0-G
A9R14	0757-0893		RESISTOR 51 2% .125W F TC=0+-100	24546	C4-1/8-T0-51R0-G
A9R15	0698-7205	9	RESISTOR 51.1 2% .05W F TC=0+-100	24546	C3-1/8-T00-51R1-G
A9R16	0698-7205		RESISTOR 51.1 2% .05W F TC=0+-100	24546	C3-1/8-T00-51R1-G
A9R17	0698-7205		RESISTOR 51.1 2% .05W F TC=0+-100	24546	C3-1/8-T00-51R1-G
A9R18	0698-7205		RESISTOR 51.1 2% .05W F TC=0+-100	24546	C3-1/8-T00-51R1-G
A9R19	0698-7205		RESISTOR 51.1 2% .05W F TC=0+-100	24546	C3-1/8-T00-51R1-G
A9R20	0757-0893		RESISTOR 51 2% .125W F TC=0+-100	24546	C4-1/8-T0-51R0-G
A9R21	0757-0900		RESISTOR 100 2% .125W F TC=0+-100	24546	C4-1/8-T0-101-G
A9R22	0757-0900		RESISTOR 100 2% .125W F TC=0+-100	24546	C4-1/8-T0-101-G
A9R23	0757-0895	2	RESISTOR 62 2% .125W F TC=0+-100	24546	C4-1/8-T0-62R0-G
A9R24	0757-0895		RESISTOR 62 2% .125W F TC=0+-100	24546	C4-1/8-T0-62R0-G
A9R25	0757-0893		RESISTOR 51 2% .125W F TC=0+-100	24546	C4-1/8-T0-51R0-G
A9R26	0757-0893		RESISTOR 51 2% .125W F TC=0+-100	24546	C4-1/8-T0-51R0-G
A9R27	0757-0912	4	RESISTOR 330 2% .125W F TC=0+-100	24546	C4-1/8-T0-331-G
A9R28	0757-0927	4	RESISTOR 1.3K 2% .125W F TC=0+-100	24546	C4-1/8-T0-1301-G
A9R29	2100-2216	3	RESISTOR-VAR TRMR 5KOHM 10% C TOP ADJ	84048	170-502
A9R30	0757-0927		RESISTOR 1.3K 2% .125W F TC=0+-100	24546	C4-1/8-T0-1301-G
A9R31	0757-0893		RESISTOR 51 2% .125W F TC=0+-100	24546	C4-1/8-T0-51R0-G
A9R32	0757-0893		RESISTOR 51 2% .125W F TC=0+-100	24546	C4-1/8-T0-51R0-G
A9R33	0757-0912		RESISTOR 330 2% .125W F TC=0+-100	24546	C4-1/8-T0-331-G
A9R34	0757-0893		RESISTOR 51 2% .125W F TC=0+-100	24546	C4-1/8-T0-51R0-G
A9R35	0757-0893		RESISTOR 51 2% .125W F TC=0+-100	24546	C4-1/8-T0-51R0-G

See introduction to this section for ordering information

Table 7-9. A9 Replaceable Parts (Continued)

Reference Designation	HP Part Number	Qty	Description	Mfr Code	Mfr Part Number
A9R26	0757-0919	3	RESISTOR 620 2% .125W F TC=0+-100	24546	C4-1/8-T0-621-G
A9R27	0757-1094	3	RESISTOR 1.47K 1% .125W F TC=0+-100	24546	C4-1/8-T0-1471-F
A9R28	0757-0927		RESISTOR 1.3K 2% .125W F TC=0+-100	24546	C4-1/8-T0-1301-G
A9R39	0683-1025		RESISTOR 1K 5% .25W FC TC=-400/+600	01121	C81025
A9K43	0757-1094		RESISTOR 1.47K 1% .125W F TC=0+-100	24546	C4-1/8-T0-1471-F
A9F41	0757-0893		RESISTOR 51 2% .125W F TC=0+-100	24546	C4-1/8-T0-51R0-G
A9R42	0683-1015	5	RESISTOR 100 5% .25W FC TC=-400/+500	01121	C81015
A9R43	0757-0917		RESISTOR 510 2% .125W F TC=0+-100	24546	C4-1/8-T0-511-G
A9K44	0757-0893		RESISTOR 51 2% .125W F TC=0+-100	24546	C4-1/8-T0-51R0-G
A9K45	0757-0912		RESISTOR 330 2% .125W F TC=0+-100	24546	C4-1/8-T0-331-G
A9R46	0683-1025		RESISTOR 1K 5% .25W FC TC=-400/+600	01121	C81025
A9F47	0757-0903	3	RESISTOR 130 2% .125W F TC=0+-100	24546	C4-1/8-T0-131-G
A9R48	0757-1094		RESISTOR 1.47K 1% .125W F TC=0+-100	24546	C4-1/8-T0-1471-F
A9R49	0757-0893		RESISTOR 51 2% .125W F TC=0+-100	24546	C4-1/8-T0-51R0-G
A9F50	0757-0823	2	RESISTOR 1.82K 1% .5W F TC=0+-100	19701	MF7C1/2-T0-1821-F
A9R51	0757-0823		RESISTOR 1.82K 1% .5W F TC=0+-100	19701	MF7C1/2-T0-1821-F
A9R52	0757-0903		RESISTOR 130 2% .125W F TC=0+-100	24546	C4-1/8-T0-131-G
A9R53	0757-0893		RESISTOR 51 2% .125W F TC=0+-100	24546	C4-1/8-T0-51R0-G
A9K54	0757-0903		RESISTOR 130 2% .125W F TC=0+-100	24546	C4-1/8-T0-131-G
A9R55	2100-2216		RESISTOR-VAR TRMR 5KOHM 10% C TOP ADJ	84048	170-502
A9R56	2100-2216		RESISTOR-VAR TRMR 5KOHM 10% C TOP ADJ	84048	170-502
A9F57	0757-0927		RESISTOR 1.3K 2% .125W F TC=0+-100	24546	C4-1/8-T0-1301-G
A9R58	0757-0893		RESISTOR 51 2% .125W F TC=0+-100	24546	C4-1/8-T0-51R0-G
A9F59	0757-0912		RESISTOR 330 2% .125W F TC=0+-100	24546	C4-1/8-T0-331-G
A9R60	0757-0893		RESISTOR 51 2% .125W F TC=0+-100	24546	C4-1/8-T0-51R0-G
A9F61	0757-0893		RESISTOR 51 2% .125W F TC=0+-100	24546	C4-1/8-T0-51R0-G
A9R62	0757-0898	1	RESISTOR 82 2% .125W F TC=0+-100	24546	C4-1/8-T0-82P0-G
A9R63	0698-4037	2	RESISTOR 46.4 1% .125W F TC=0+-100	16299	C4-1/8-T0-46R4-F
A9R64	0683-1505	3	RESISTOR 15 5% .25W FC TC=-400/+500	01121	C81505
A9K65	0698-4037		RESISTOR 46.4 1% .125W F TC=0+-100	16299	C4-1/8-T0-46R4-F
A9R66	0757-0893		RESISTOR 51 2% .125W F TC=0+-100	24546	C4-1/8-T0-51R0-G
A9R67	0757-0931		RESISTOR 2K 2% .125W F TC=0+-100	24546	C4-1/8-T0-2001-G
A9R68	0757-0893		RESISTOR 51 2% .125W F TC=0+-100	24546	C4-1/8-T0-51R0-G
A9R69	0757-0893		RESISTOR 51 2% .125W F TC=0+-100	24546	C4-1/8-T0-51R0-G
A9R70	0757-0893		RESISTOR 51 2% .125W F TC=0+-100	24546	C4-1/8-T0-51R0-G
A9R71	0757-0893		RESISTOR 51 2% .125W F TC=0+-100	24546	C4-1/8-T0-51R0-G
A9R72	0757-0931		RESISTOR 2K 2% .125W F TC=0+-100	24546	C4-1/8-T0-2001-G
A9F73	0757-0893		RESISTOR 51 2% .125W F TC=0+-100	24546	C4-1/8-T0-51R0-G
A9R74	0757-0893		RESISTOR 51 2% .125W F TC=0+-100	24546	C4-1/8-T0-51R0-G
A9R75	0698-3378		RESISTOR 51 5% .125W CC TC=0+588	01121	B85105
A9R76	0683-5115		RESISTOR 510 5% .25W FC TC=-400/+600	01121	C85115
A9R77	0683-1505		RESISTOR 15 5% .25W FC TC=-400/+500	01121	C81505
A9R78	0757-0919		RESISTOR 620 2% .125W F TC=0+-100	24546	C4-1/8-T0-621-G
A9F79	0757-0931		RESISTOR 2K 2% .125W F TC=0+-100	24546	C4-1/8-T0-2001-G
A9R80	0757-0931		RESISTOR 2K 2% .125W F TC=0+-100	24546	C4-1/8-T0-2001-G
A9R81	0683-5115		RESISTOR 510 5% .25W FC TC=-400/+600	01121	C85115
A9R82	0757-0893		RESISTOR 51 2% .125W F TC=0+-100	24546	C4-1/8-T0-51R0-G
A9R83	0757-0893		RESISTOR 51 2% .125W F TC=0+-100	24546	C4-1/8-T0-51R0-G
A9R84	0683-1505		RESISTOR 15 5% .25W FC TC=-400/+500	01121	C81505
A9R85	0757-0919		RESISTOR 620 2% .125W F TC=0+-100	24546	C4-1/8-T0-621-G
A9R86	0683-2015	6	RESISTOR 200 5% .25W FC TC=-400/+600	01121	C82015
A9R87	0683-2015		RESISTOR 200 5% .25W FC TC=-400/+600	01121	C82015
A9R88	0683-5115		RESISTOR 510 5% .25W FC TC=-400/+600	01121	C85115
A9R89	0683-5115		RESISTOR 510 5% .25W FC TC=-400/+600	01121	C85115
A9F90	0683-5115		RESISTOR 510 5% .25W FC TC=-400/+600	01121	C85115
A9R91	0683-5115		RESISTOR 510 5% .25W FC TC=-400/+600	01121	C85115
A9R92	0683-5115		RESISTOR 510 5% .25W FC TC=-400/+600	01121	C85115
A9R93	0683-2015		RESISTOR 200 5% .25W FC TC=-400/+600	01121	C82015
A9F94	0683-5115		RESISTOR 510 5% .25W FC TC=-400/+600	01121	C85115
A9R95	0683-5115		RESISTOR 510 5% .25W FC TC=-400/+600	01121	C85115
A9R96	0683-5115		RESISTOR 510 5% .25W FC TC=-400/+600	01121	C85115
A9R97	0683-2015		RESISTOR 200 5% .25W FC TC=-400/+600	01121	C82015
A9R98	0683-1015		RESISTOR 100 5% .25W FC TC=-400/+500	01121	C81015
A9R99	0683-1015		RESISTOR 100 5% .25W FC TC=-400/+500	01121	C81015
A9R100	0683-1015		RESISTOR 100 5% .25W FC TC=-400/+500	01121	C81015
A9R101	0683-1015		RESISTOR 100 5% .25W FC TC=-400/+500	01121	C81015
A9R102	0683-1025		RESISTOR 1K 5% .25W FC TC=-400/+600	01121	C81025
A9R103	0683-1025		RESISTOR 1K 5% .25W FC TC=-400/+600	01121	C81025
A9R104	0683-1025		RESISTOR 1K 5% .25W FC TC=-400/+600	01121	C81025
A9R105	0683-1025		RESISTOR 1K 5% .25W FC TC=-400/+600	01121	C81025
A9R106	0698-7205		RESISTOR 51.1 2% .05W F TC=0+-100	24546	C3-1/8-T00-51R1-G
A9F107	0698-7205		RESISTOR 51.1 2% .05W F TC=0+-100	24546	C3-1/8-T00-51R1-G
A9F108	0698-7205		RESISTOR 51.1 2% .05W F TC=0+-100	24546	C3-1/8-T00-51R1-G
A9F109	0698-7205		RESISTOR 51.1 2% .05W F TC=0+-100	24546	C3-1/8-T00-51R1-G
A9R110	0698-3378		RESISTOR 51 5% .125W CC TC=0+588	01121	B85105

See introduction to this section for ordering information

Table 7-9. A9 Replaceable Parts (Continued)

Reference Designation	HP Part Number	Qty	Description	Mfr Code	Mfr Part Number
A9R111	0698-3378		RESISTOR 51 5% .125W CC TC=0+588	01121	885105
A9R112	0698-3378		RESISTOR 51 5% .125W CC TC=0+588	01121	885105
A9R113	0698-3378		RESISTOR 51 5% .125W CC TC=0+588	01121	885105
A9R114	0898-3378		RESISTOR 51 OHM 5% .125W CC TUBULAR	01121	885105
A9R115	0698-3378		RESISTOR 51 OHM 5% .125W CC TUBULAR	01121	885105
A9R118	0698-3378		RESISTOR 51 OHM 5% .125W CC TUBULAR	01121	885105
A9U1	1820-0753	3	IC GATE	28480	1820-0753
A9U2	1820-0736	2	IC COUNTER	28480	1820-0736
A9U3	1820-1019	2	IC COUNTER	28480	1820-1019
A9U4	1820-0736		IC COUNTER	28480	1820-0736
A9U5	1820-0566	2	IC:DIGITAL	28480	1820-0566
A9U6	1820-0753		IC GATE	28480	1820-0753
A9U7	1820-0566		IC:DIGITAL	28480	1820-0566
A9U8	1820-0996	6	IC MULTIPLEXER	28480	1820-0996
A9U9	1820-1019		IC COUNTER	28480	1820-1019
A9U10	1820-0996		IC MULTIPLEXER	28480	1820-0996
A9U11	1820-0996		IC MULTIPLEXER	28480	1820-0996
A9U12	1820-0753		IC GATE	28480	1820-0753
A9U13	1820-0996		IC MULTIPLEXER	28480	1820-0996
A9U14	1820-0996		IC MULTIPLEXER	28480	1820-0996
A9U15	1820-0996		IC MULTIPLEXER	28480	1820-0996
A9Z1	9100-1788		COIL; FXD; NCM-MOLDED RF CHDKE; .75UH	02114	VK200-20/48
	5040-6843	6	EXTRACTOR, P.-C. BOARD	28480	5040-6843

IMPORTANT

A front panel bandwidth and input sensitivity check should be performed when a defective IC on A9 has been replaced. Proper plug-in operation should be confirmed with 5354A (checks Channel A) and 5353A (checks Channel C Ratio). If IC U8 or U10 through U15 has been replaced and the input specifications are not met, do *not* attempt any adjustments. Substitute another IC in its place and repeat the performance test. A replacement IC that meets the performance tests does not indicate that the previous IC was faulty, only that its characteristics were not in accordance with the factory selected bias resistors. If the counter continues to fail the bandwidth or sensitivity test, the board should be returned to the factory. Send the A9 board to your nearest Hewlett-Packard Sales and Service Office listed at the back of this manual.

Simplified Flow Diagrams of A9 are contained in Figures 5-14 through 5-16.

NOTES

1. REFERENCE DESIGNATIONS WITHIN THIS ASSEMBLY ARE ABBREVIATED. ADD ASSEMBLY NUMBER TO ABBREVIATION FOR COMPLETE DESCRIPTION.
2. UNLESS OTHERWISE INDICATED:
RESISTANCE IN OHMS;
CAPACITANCE IN PICO FARADS;
INDUCTANCE IN MICROHENRIES
3. ASTERISK (*) INDICATES SELECTED COMPONENT, AVERAGE VALUES SHOWN
4. SUPPLY VOLTAGE IS SELECTED AT FACTORY.

REFERENCE DESIGNATIONS

A9
C1-38
CR1-5
J1,2
L1,2
P1
Q1-18
R1-116
U1-15
Z1

5345-D-27

HP 5346A
Options and Manual Change

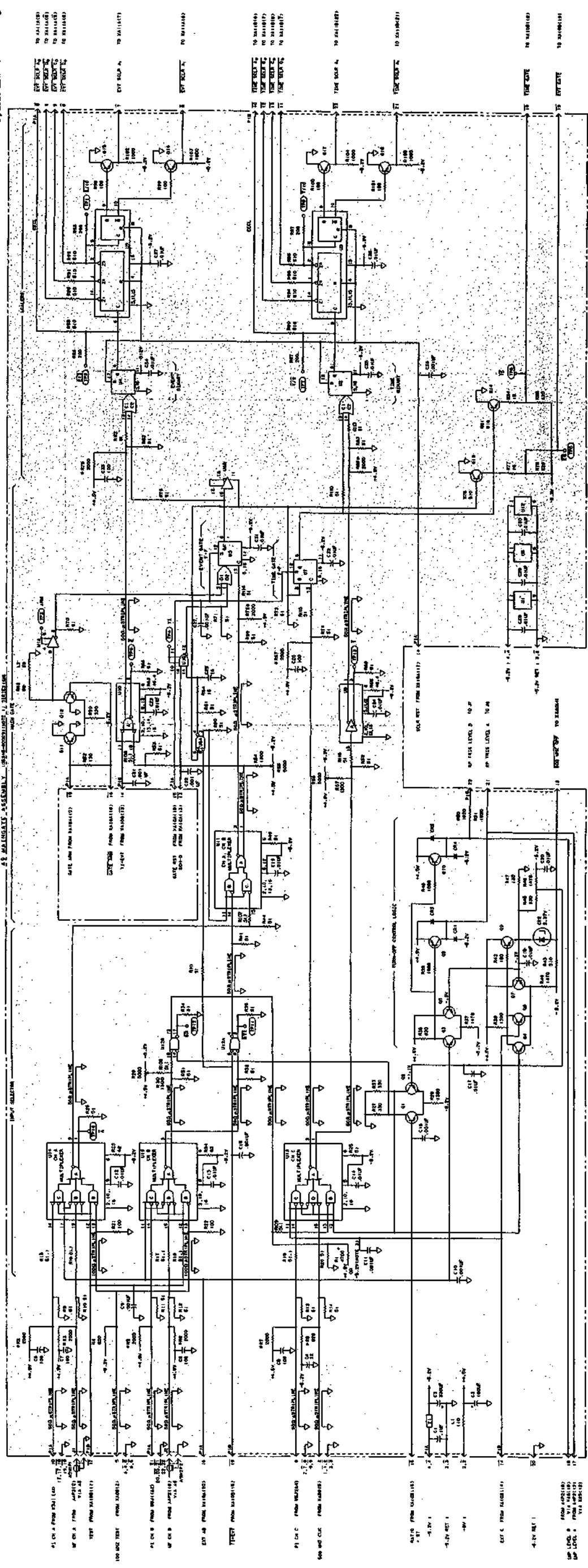
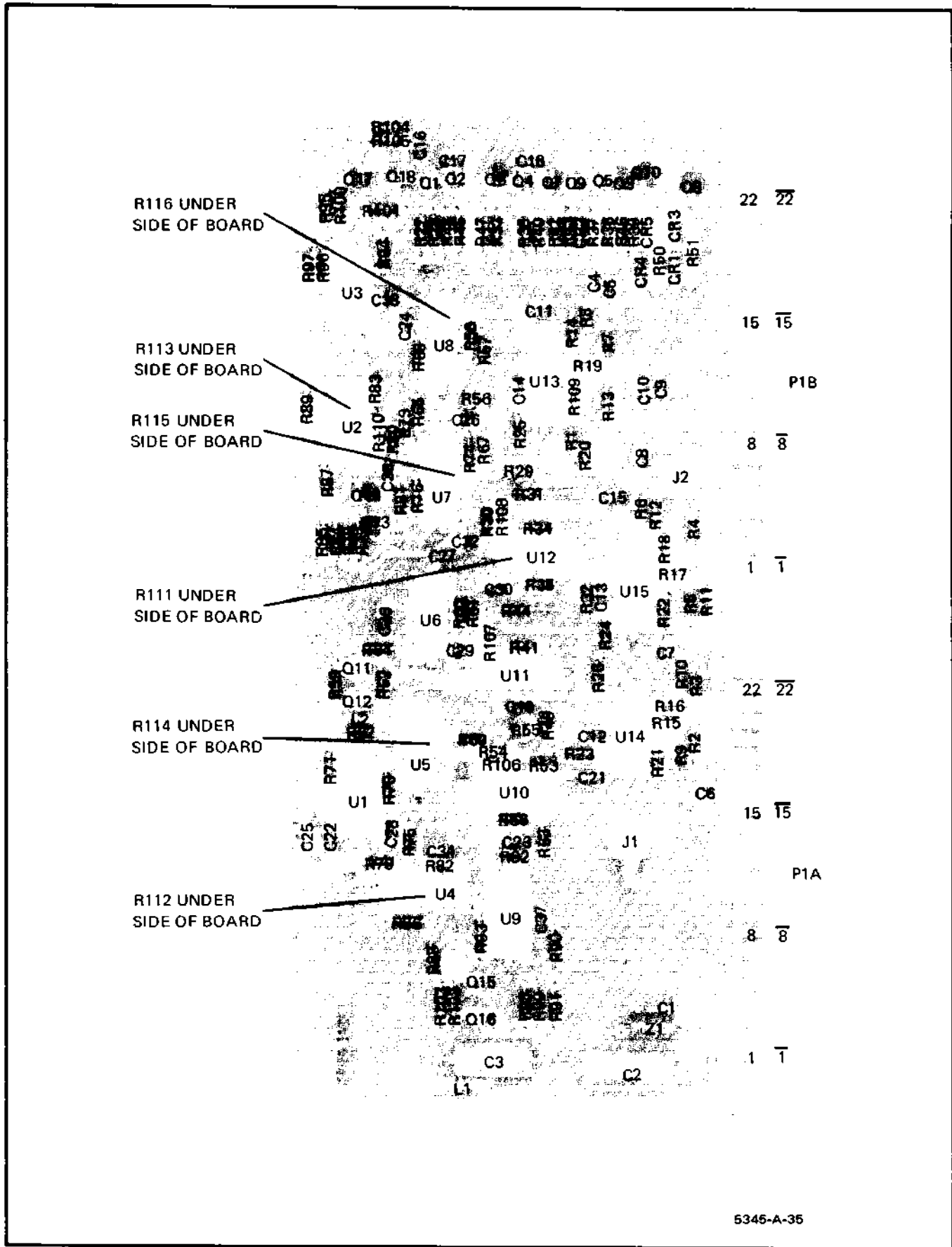


Figure 7-7. A8 Main Gate Assembly
7-57



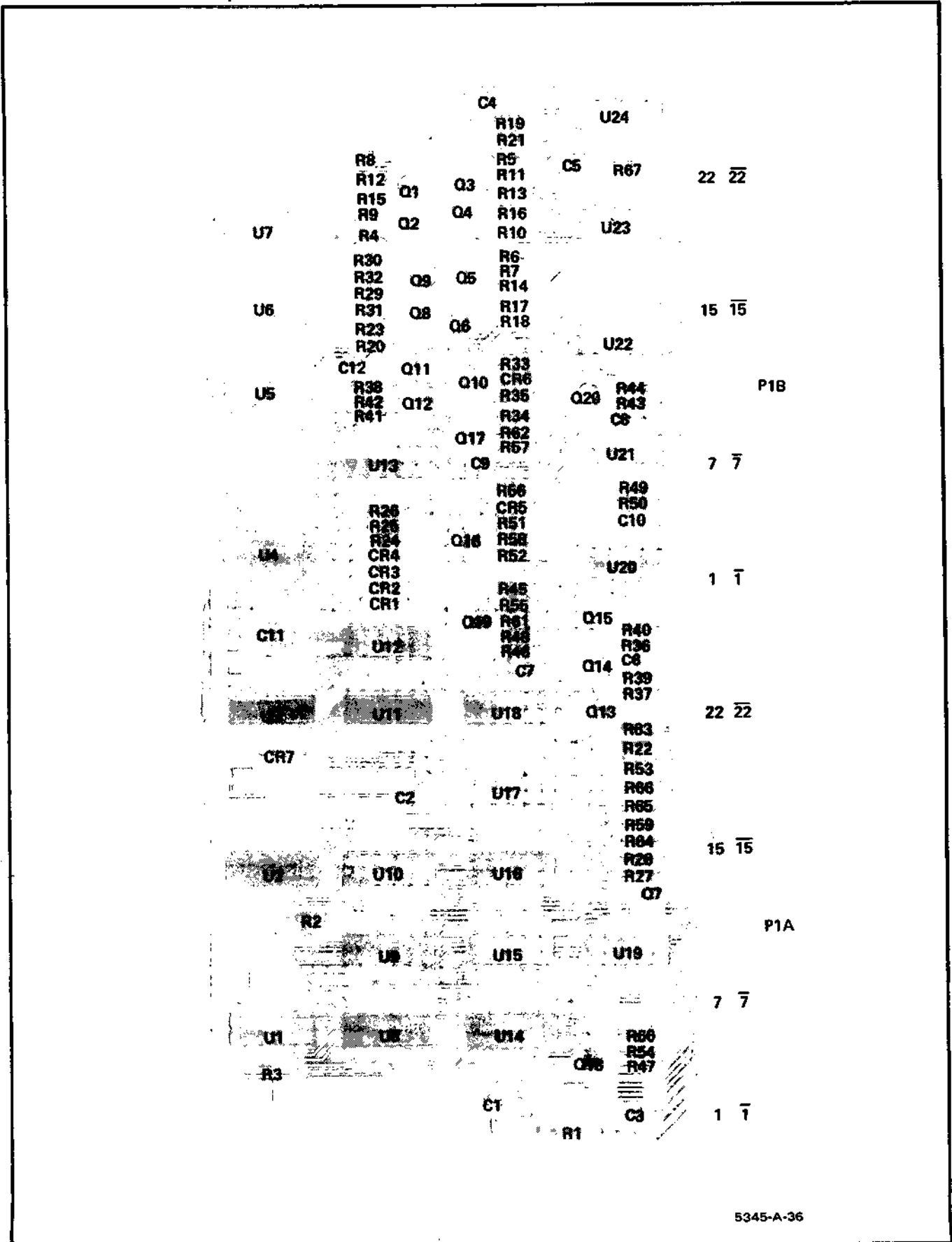
Figure 7-7
A9 MAIN GATE ASSEMBLY

(See page 7-57)



5345-A-35

Part of Figure 7-7. A9 Main Gate Assembly



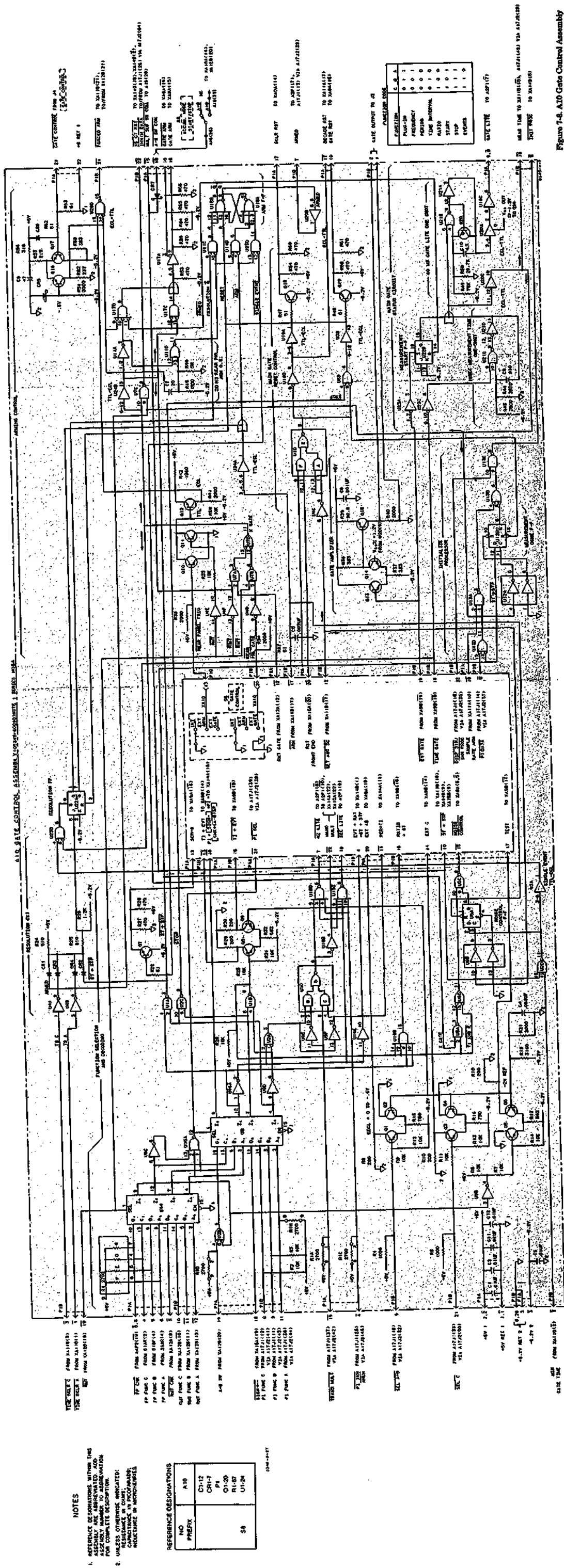


Figure 7-4. A10 Gate Control Assembly

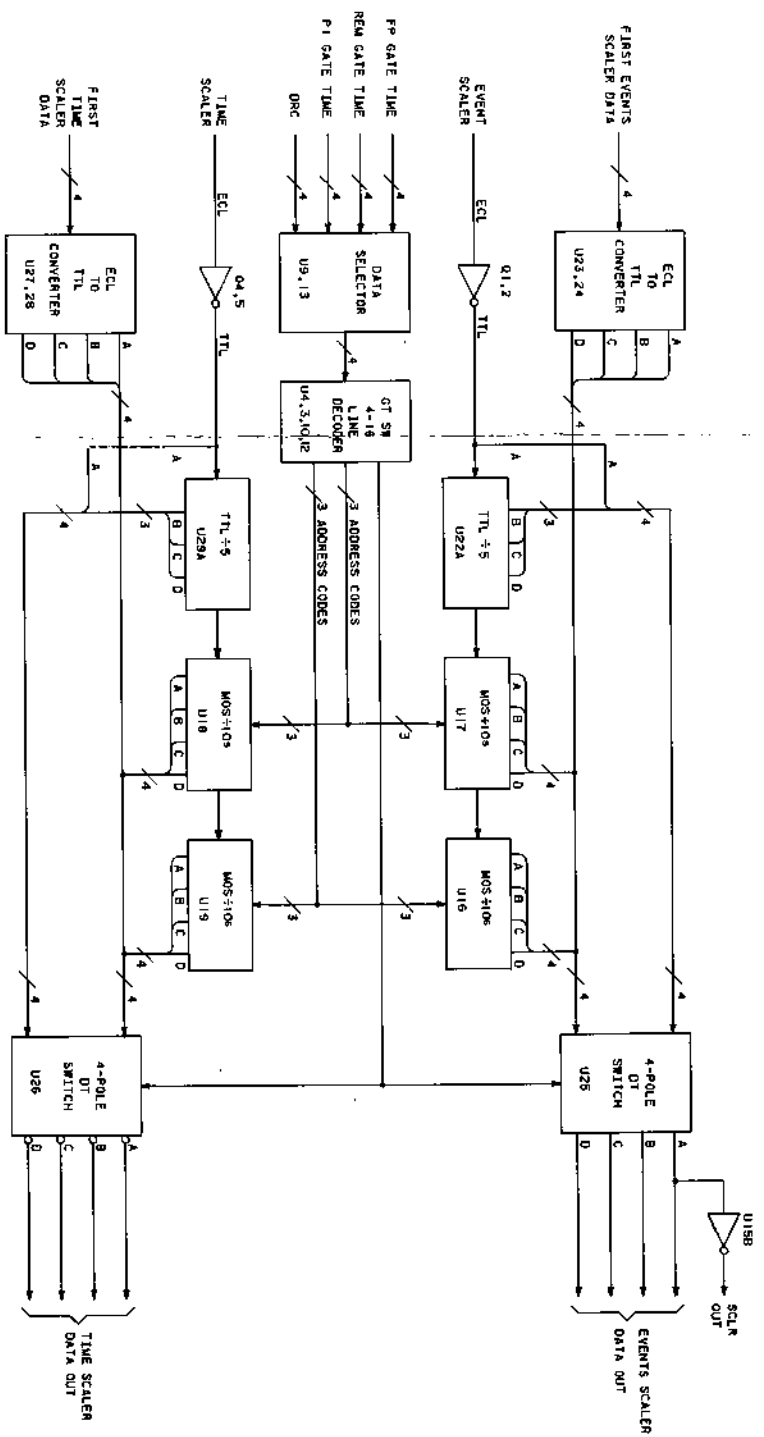
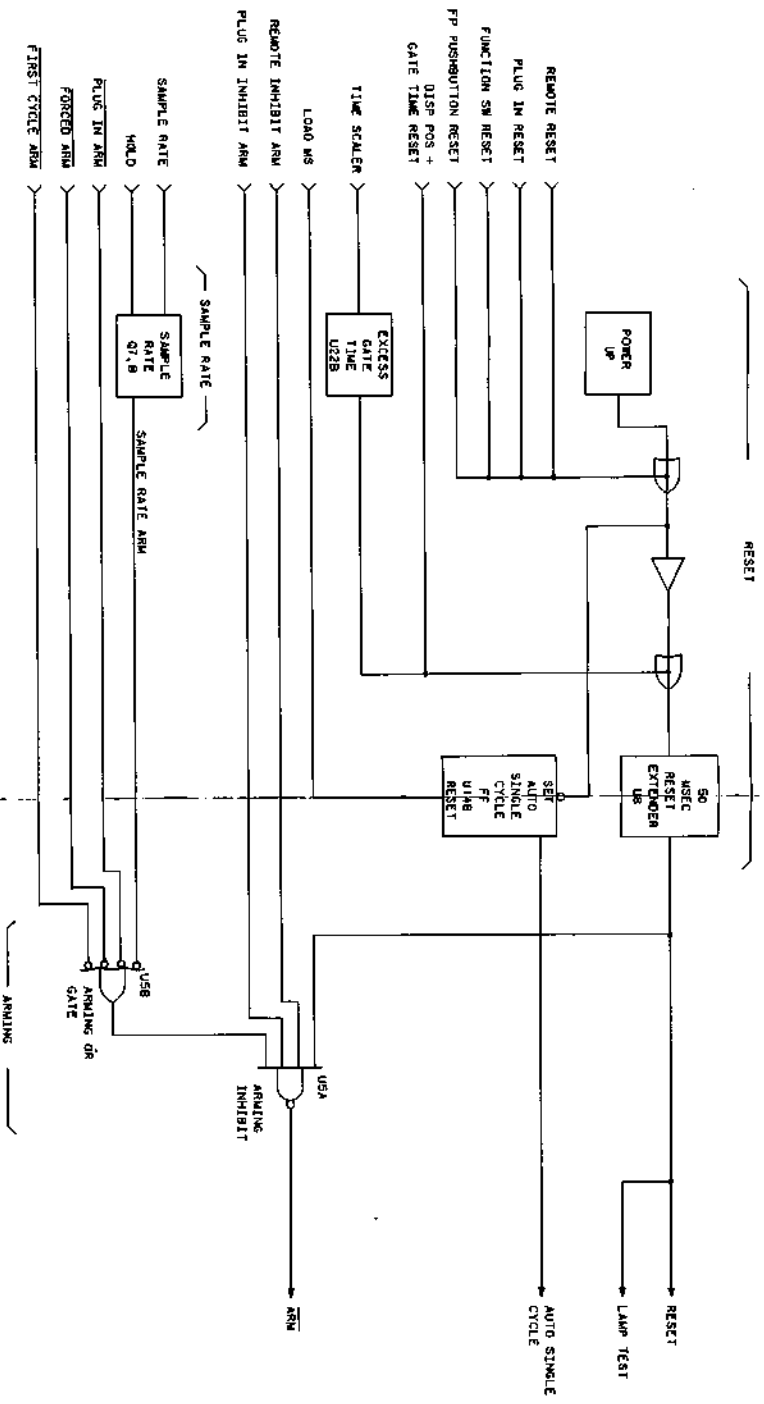


TABLE 1
A111 05346-60011 SCALER ASSEMBLY

GATE TIME SETTINGS	U4 OUTPUT LINES				U17 AND U18 BINARY				U16 AND U19 BINARY				SELECTED BINARY				
	X	Y	Z	W	X	Y	Z	W	X	Y	Z	W	X	Y	Z	W	
100 MS	0	1	1	1	0	1	1	1	0	1	1	1	0	1	1	1	0
10 MS	1	0	0	0	1	0	0	0	1	0	0	0	1	0	0	0	1
100 μS	2	3	4	5	0	1	0	0	1	0	0	0	1	0	0	0	1
1 MS	3	4	5	6	0	1	0	0	1	0	0	0	1	0	0	0	1
10 MS	4	5	6	7	0	1	0	0	1	0	0	0	1	0	0	0	1
100 MS	5	6	7	8	0	1	0	0	1	0	0	0	1	0	0	0	1
1 S	6	7	8	9	0	1	0	0	1	0	0	0	1	0	0	0	1
10 S	7	8	9	10	0	1	0	0	1	0	0	0	1	0	0	0	1
100 S	8	9	10	11	0	1	0	0	1	0	0	0	1	0	0	0	1
1000 S	9	10	11	12	0	1	0	0	1	0	0	0	1	0	0	0	1
MIN	10	11	12	13	0	1	0	0	1	0	0	0	1	0	0	0	1
—	11	12	13	14	0	1	0	0	1	0	0	0	1	0	0	0	1
—	12	13	14	15	0	1	0	0	1	0	0	0	1	0	0	0	1

Figure 7-8
A110 GATE CONTROL ASSEMBLY
(See page 7-89)

Figure 7-9. A11 Scaler Assembly Partial Schematic

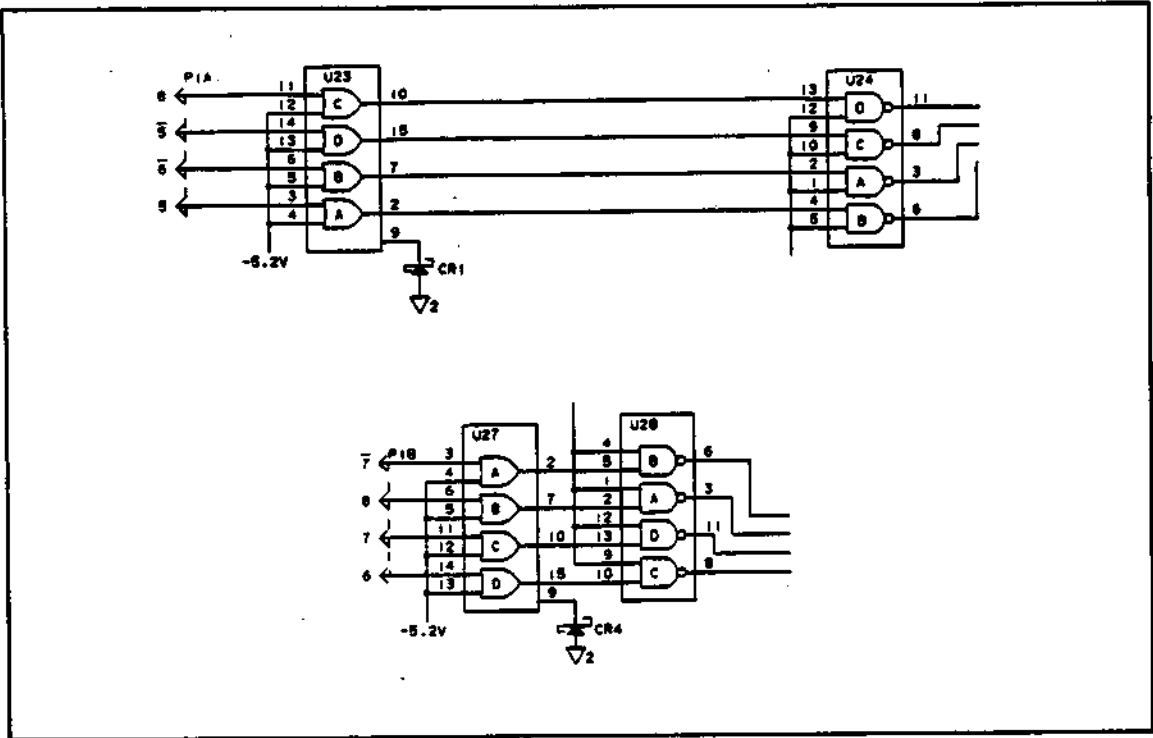


Table 7-10. Processor Flow Test Results

Delay Switch	ROM Address	Processor Operation	Comment
00039	601	NR=0̄, 7th nonzero digit	no
00040	400	Prepare to count 7th digit	yes
00041	440	DPLK=-17	no
00042	601	NR=0̄, 8th nonzero digit	no
00043	400	Prepare to count 8th digit	yes
00044	441	DPLK=-17	yes
00045	221	Period or TI	no
00046	451	Flag = H	yes
00047	051	Plug-in	no
00048	420	Events, Ratio and Start or Stop	no
00049	530	Period or TI	no
00050	341	Display Time Count	no
00051	201	Start or Stop	no
00052	071	N Data	no
00053	671	Divide Routine	
00054	030	Divide Routine	
00055	310	Divide Routine	
00056	460	Divide Routine	
00057	671	Divide Routine	
00058	031	Divide Routine	MSB = 1
00059	671	Divide Routine	
00060	030	Divide Routine	
00061	311	Divide Routine	
00062	460	Divide Routine	1st Remainder
00063	671	Divide Routine	
00064	030	Divide Routine	
00065	311	Divide Routine	
00066	460	Divide Routine	2nd Remainder
00067	671	Divide Routine	
00068	030	Divide Routine	
00069	311	Divide Routine	
00070	460	Divide Routine	3rd Remainder
00071	671	Divide Routine	
00072	030	Divide Routine	
00073	311	Divide Routine	
00074	460	Divide Routine	4th Remainder
00075	671	Divide Routine	
00076	030	Divide Routine	
00077	311	Divide Routine	

Table 7-10. Processor Flow Test Results (Continued)

Delay Switch	ROM Address	Processor Operation	Comment
00078	460	Divide Routine	5th Remainder
00079	671	Divide Routine	
00080	030	Divide Routine	
00081	311	Divide Routine	
00082	460	Divide Routine	6th Remainder
00083	671	Divide Routine	
00084	030	Divide Routine	
00085	311	Divide Routine	
00086	460	Divide Routine	7th Remainder
00087	671	Divide Routine	
00088	030	Divide Routine	
00089	311	Divide Routine	
00090	461	End Divide Routine	
00091	121	FLAG=H, LOAD RESULT to QR	yes
00092	520	K Data	no
00093	551	Start and Stop	no
00094	541	Display Result	no
00095	440	States 440 through 441 are repeated for a second time after the arithmetic routine. The purpose of the processor operations will vary during these operations. Consult flow chart theory 2A (440), if needed.	
00096	600		
00097	440		
00098	600		
00099	440		
00100	600		
00101	440		
00102	600		
00103	440		
00104	600		
00105	440		
00106	600		
00107	440		
00108	600		
00109	440		
00110	600		
00111	440		
00112	601		
00113	400		
00114	440		
00115	601		
00116	400		

Table 7-10. Processor Flow Test Results (Continued)

Delay Switch	ROM Address	Processor Operation	Comment
00117	440	Continued	
00118	601		
00119	400		
00120	440		
00121	601		
00122	400		
00123	440		
00124	601		
00125	400		
00126	440		
00127	601		
00128	400		
00129	440		
00130	601		
00131	400		
00132	440		
00133	601		
00134	400		
00135	441	End of Count digits	
00136	221	Period or TI	no
00137	450	FLAG = H	no
00138	561	Display Storage	no
00139	510	DC = 0	no
00140	500	Determine Auto Multiplier	
00141	270	Determine Auto Multiplier	
00142	711	Determine Auto Multiplier	
00143	741	Determine Auto Multiplier	
00144	770	Determine Auto Multiplier	
00145	741	Determine Auto Multiplier	
00146	770	Determine Auto Multiplier	
00147	741	Determine Auto Multiplier	
00148	770	Determine Auto Multiplier	
00149	740	Determine Auto Multiplier	
00150	500	Determine Auto Multiplier	
00151	270	Determine Auto Multiplier	
00152	710	-1> DPLR-DS>3	Mult. Selected
00153	640	Left justify result	
00154	651	Left justify result	
00155	660	Left justify result	

Table 7-10. Processor Flow Test Results (Continued)

Delay Switch	ROM Address	Processor Operation	Comment
00156	640	Left justify result	
00157	651	Left justify result	
00158	660	Left justify result	
00159	640	Left justify result	
00160	651	Left justify result	
00161	660	Left justify result	
00162	640	Left justify result	
00163	651	Left justify result	
00164	660	Left justify result	
00165	640	Left justify result	
00166	651	Left justify result	
00167	660	Left justify result	
00168	640	Left justify result	
00169	651	Left justify result	
00170	660	Left justify result	
00171	640	Left justify result	
00172	651	Left justify result	
00173	660	Left justify result	
00174	640	Left justify result	
00175	651	Left justify result	
00176	660	Left justify result	
00177	640	Left justify result	
00178	650	Left justify result	
00179	621	End of left justify	
00180	260	Auto Right justify	
00181	610	Auto Right justify	
00182	011	Auto Right justify	
00183	621	Auto Right justify	
00184	260	Auto Right justify	
00185	610	Auto Right justify	
00186	011	Auto Right justify	
00187	621	Auto Right justify	
00188	260	Auto Right justify	
00189	610	Auto Right justify	
00190	011	Auto Right justify	
00191	621	Auto Right justify	
00192	260	Auto Right justify	
00193	610	Auto Right justify	
00194	011	Auto Right justify	

Table 7-10. Processor Flow Test Results (Continued)

Delay Switch	ROM Address	Processor Operation	Comment
00195	621	Auto Right justify	
00196	260	Auto Right justify	
00197	610	Auto Right justify	
00198	011	Auto Right justify	
00199	621	Auto Right justify	
00200	260	Auto Right justify	
00201	610	Auto Right justify	
00202	011	Auto Right justify	
00203	621	Auto Right justify	
00204	260	Auto Right justify	
00205	610	Auto Right justify	
00206	011	Auto Right justify	
00207	621	Auto Right justify	
00208	260	Auto Right justify	
00209	610	Auto Right justify	
00210	011	Auto Right justify	
00211	620	Auto Right justify	
00212	731	Serial Output	no
00213	571	End of Test	

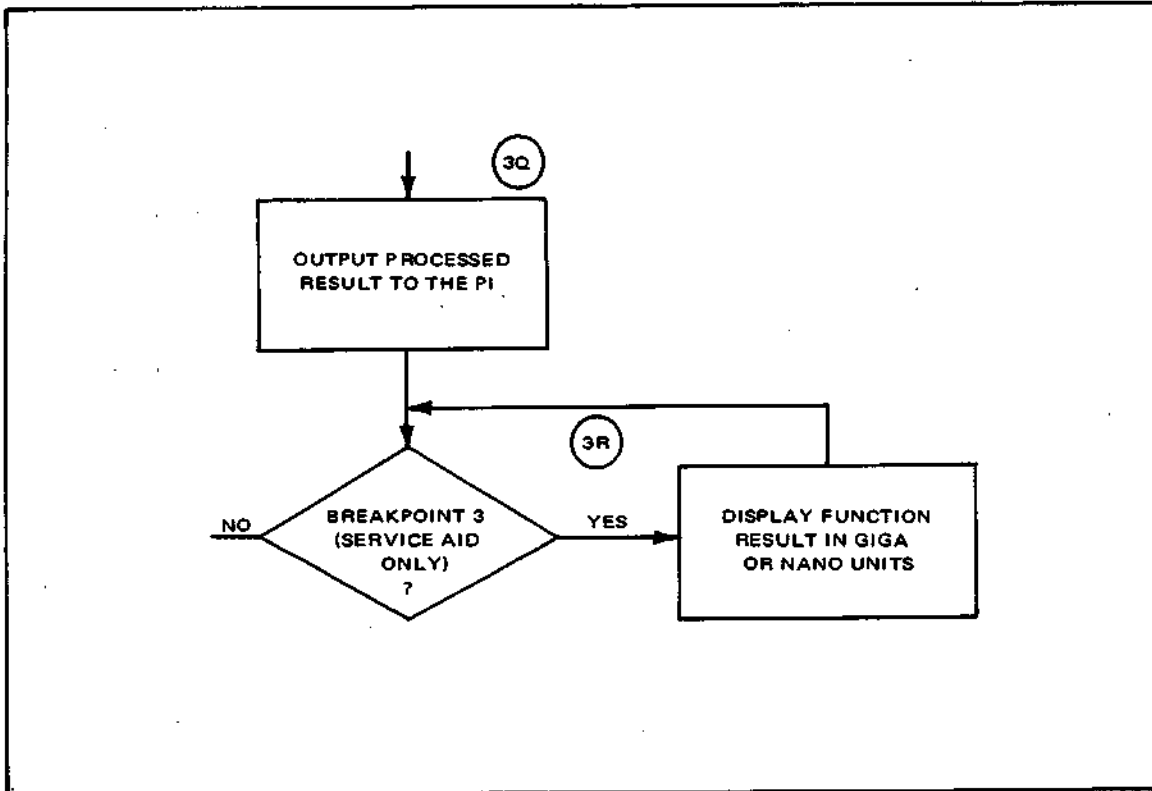
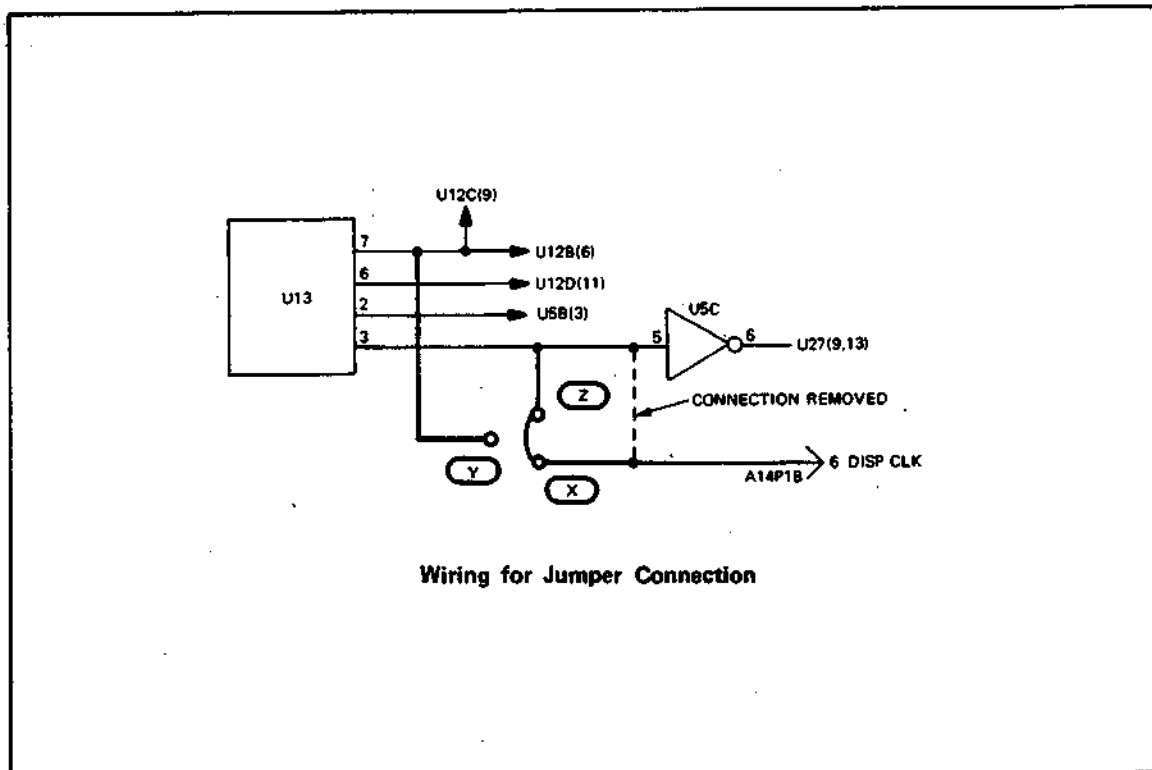


Figure 7-10. Partial Flowchart for Backdating Figure 5-9.



Wiring for Jumper Connection

Figure 7-11. Partial Diagrams Showing Changes on A14 (05345-60014) for Series 1612

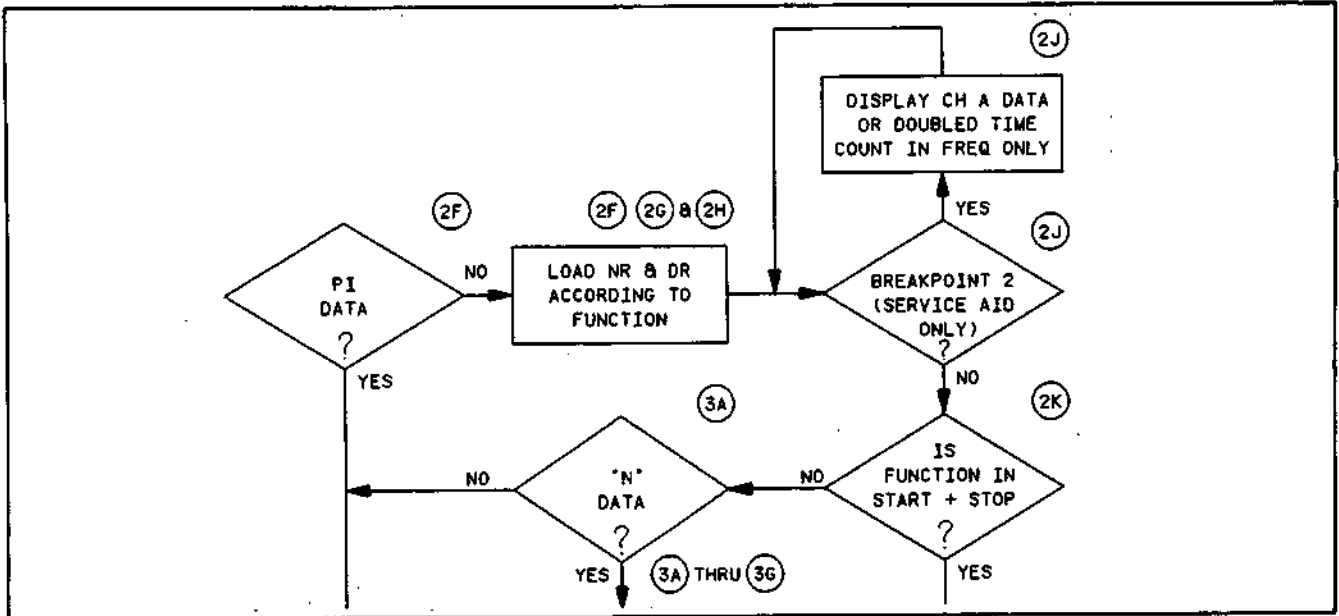


Figure 7-12. Partial of Simplified Processor Flowchart

2J QUALIFIER BREAKPOINT 2 is a service aid switch located on A14(S1-2). For frequency, it enables the counter to display the doubled time count. For functions other than frequency, it enables the counter to display the Channel A event counts. When the switch is enabled, State 340 is selected.

STATE 340 This state rotates the contents of the DR RAM to the display. DISP CLK EN enables the count 11 mode; DPLK-DPLK-1 clocks the DPLK counter to enable the display clock; and PI XMT BUS inhibits plug-in data from the A15 bidirectional bus. The QMC-QMC+1 causes the QMC to be clocked. This is done as a test function to enable its operation to be checked.

STATE 341 QMC-0 resets the QMC (A13) and DRC-0 resets the DRC (A13). This is done in the event the display state was enabled by BREAKPOINT 2(2J). When counters are used during the display, they are always reset after use.

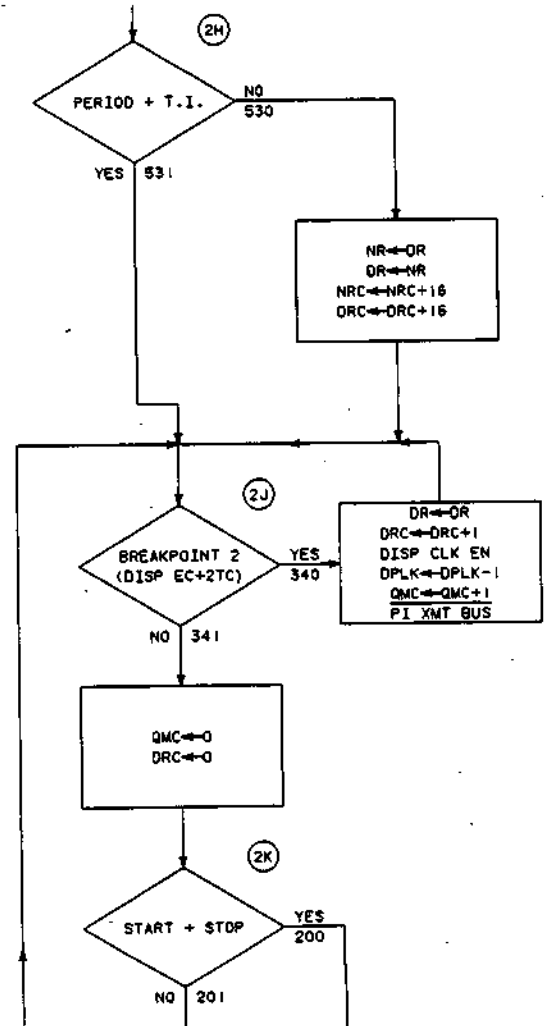
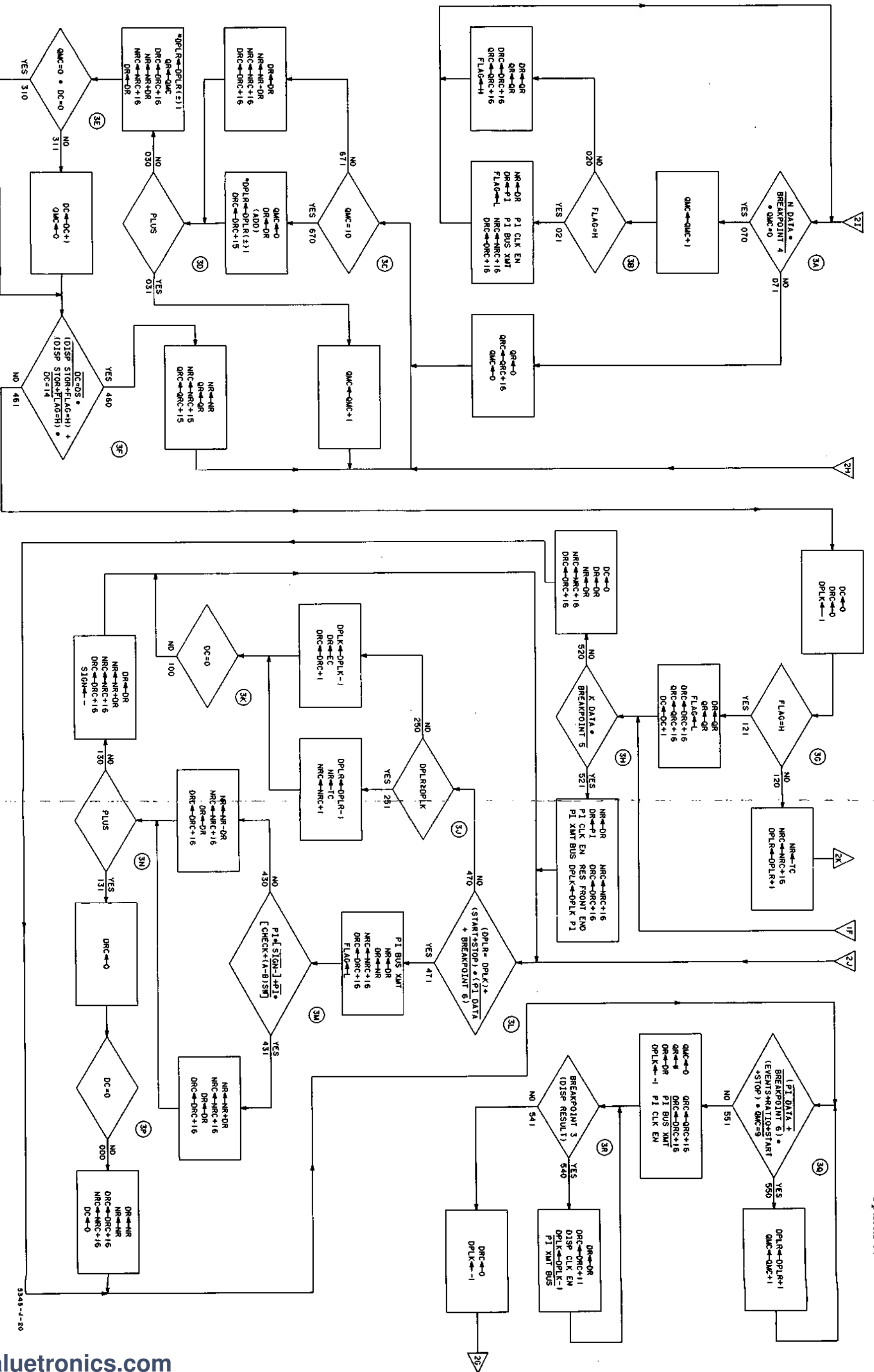


Figure 7-13. Partial of Processor Flowchart, Sheet 2

Figure 7-14
PROCESSOR FLOWCHART, SHEET 3
SERIES 1644A AND BELOW

(See page 7-73)



* SEE NOTE 1 ON TABLE 5-4

Figure 7-14. Processor Flowchart, Sheet 3 Series 1644A and Belton

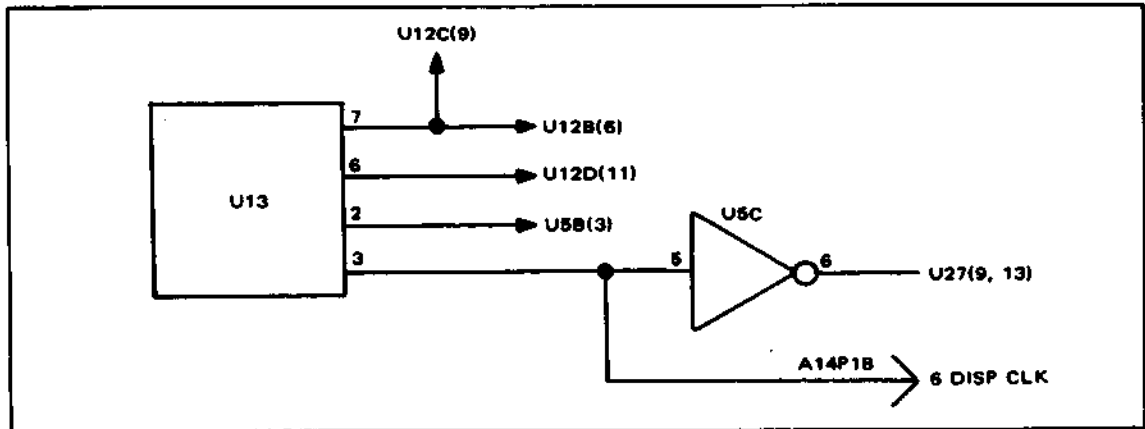


Figure 7-16. Wiring Changes for A14 Series 1604A

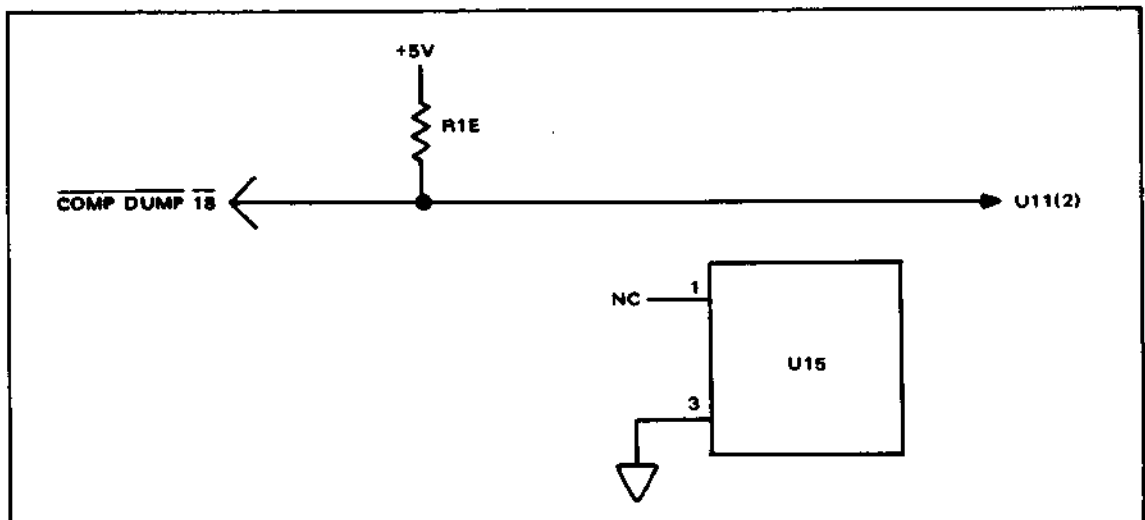


Figure 7-17. Wiring Changes for A14 Series 1604A

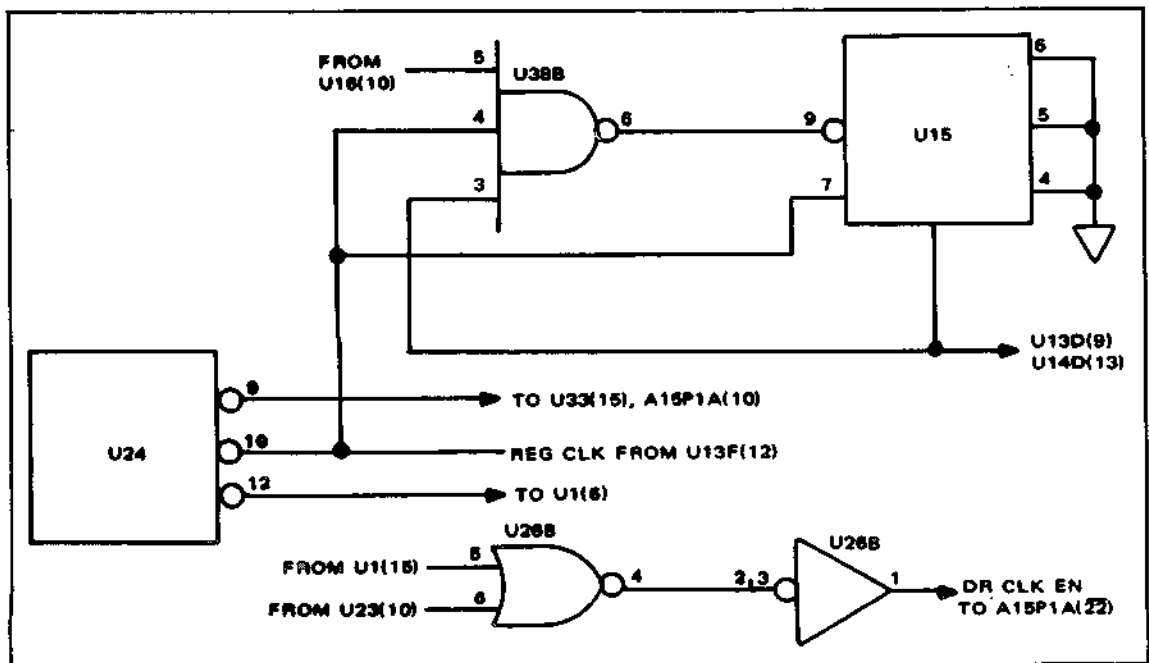


Figure 7-18. A15 Wiring Changes for Series 1604A

Figure 7-15
PROCESSOR FLOWCHART, SHEET 1
SERIES 1612A AND BELOW

(See page 7-77)

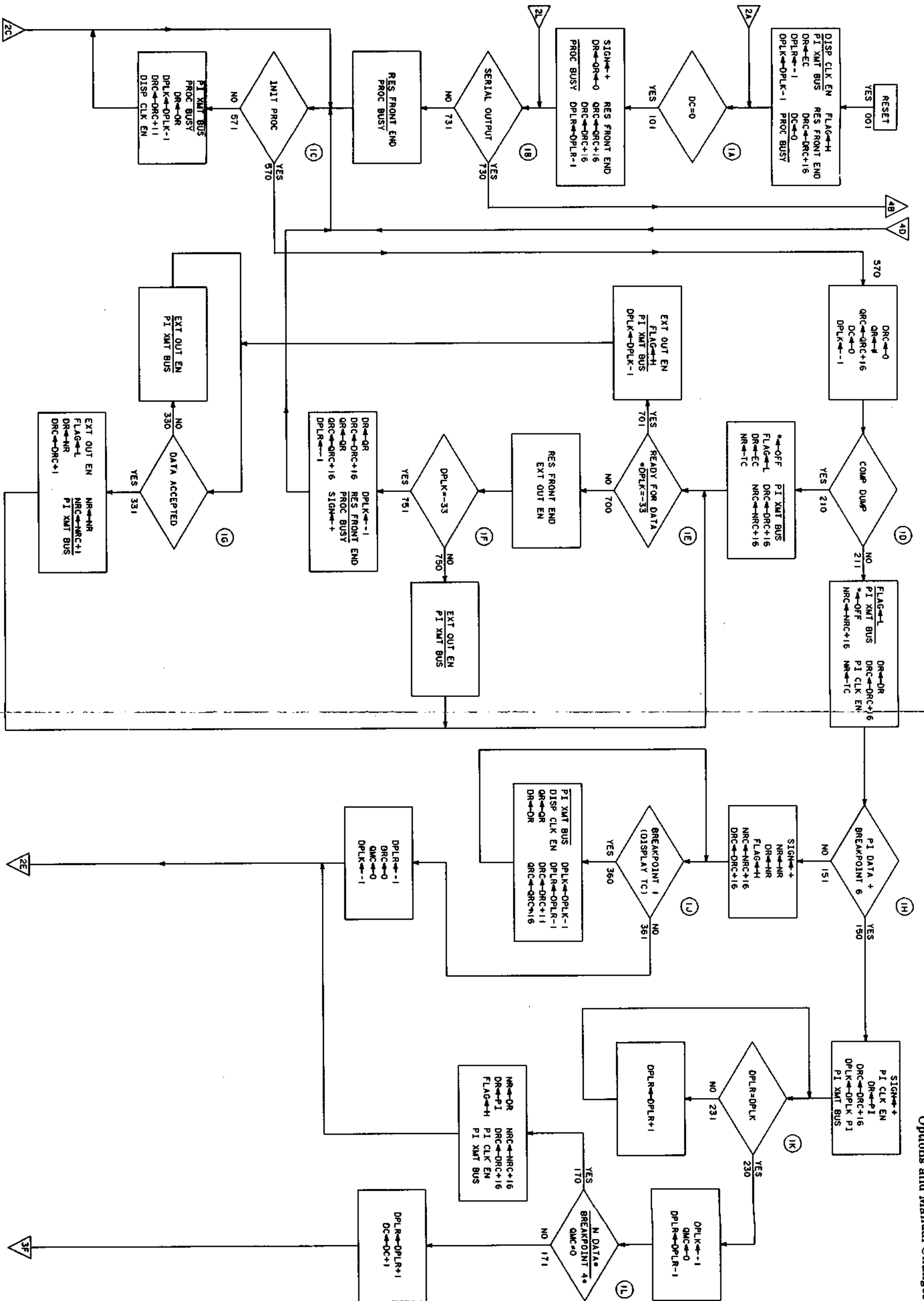


Figure 7-15. Processor Flowchart, Sheet 1 Series 1612A and Below

**Table 7-15. Changes for Standard Instrument
(Serial Numbers 1428A00451 through 1440A00950)**

Page 3-14, Figure 3-11. Rear Panel Controls and Connectors:
Delete FREQUENCY STANDARD INT-EXT switch and description.

Page 6-13, Table 6-2. A8 Parts List:
Change part number of A8 to 05345-60028 in HP and Mfr Part number columns.
Change A8C22 and A8C23 to 0140-0202, Capacitor-fxd 15pf ±5% 500WVDC Mica, 72136, DM15C150J0500WV1CR.
Delete A8C83 and A8C84, A8CR21, A8CR22, A8Q22, and A8R107.

Page 6-29, Table 6-3. Chassis Parts:
Delete C6 and S9.
Change Fig. 8-11, A8 Schematic Diagram as shown in the partial schematic in Fig. 7-19.
Replace A8 Component Locator with Figure 7-20.

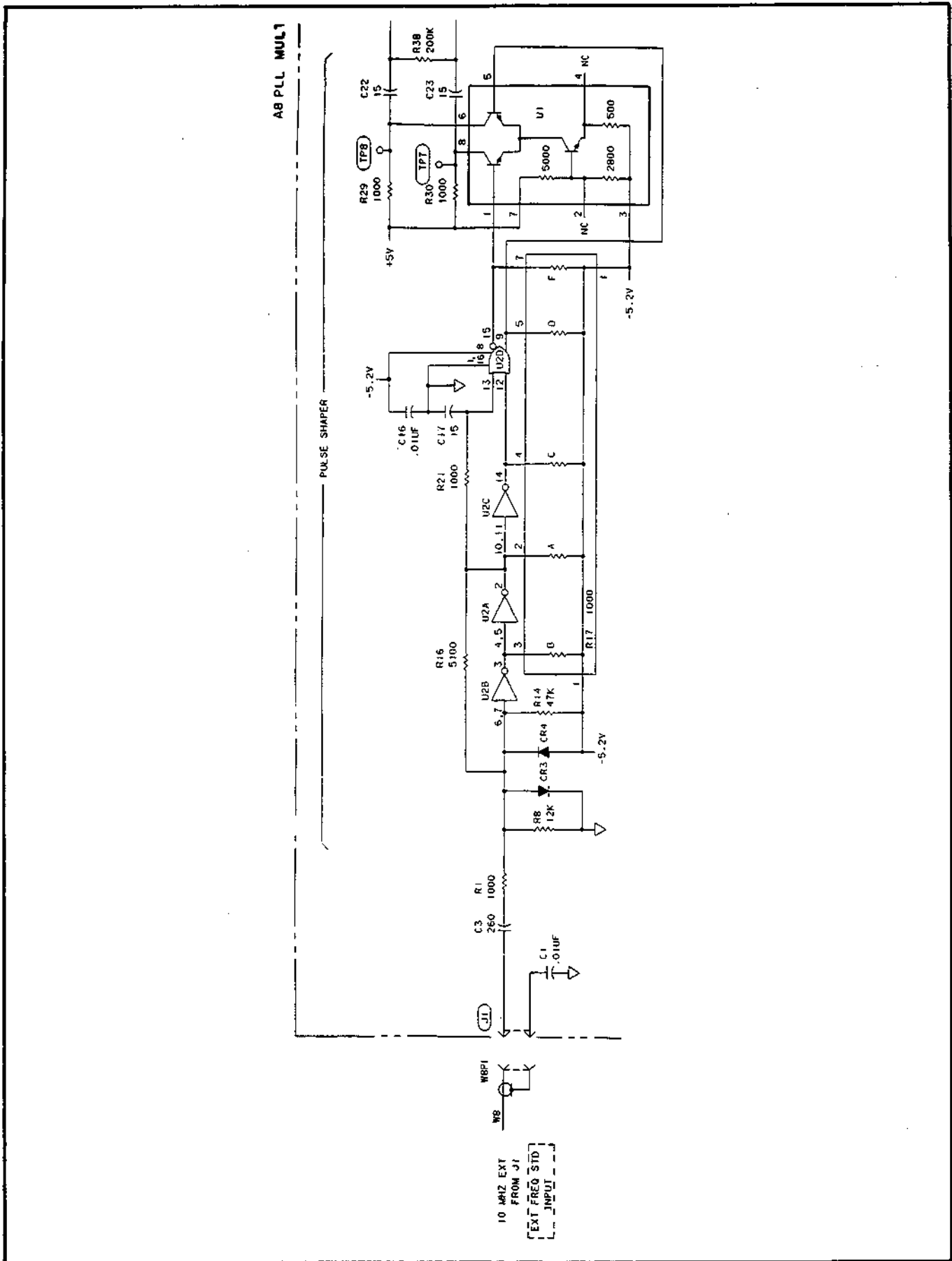
Page 8-57, Figure 8-20. Motherboard wiring:
Delete S9 and C6. Indicate that J1 connects directly to W8 (05345-60078)

**Table 7-16. Changes for Instruments Equipped with Option 001
(Serial Numbers 1428A00451 through 1440A00950)**

Page 6-29, Table 6-3. Chassis Parts:
Delete S9 and C6.

Page 6-34, Table 6-4. Option 001 Parts:
Add A20, 05345-60032, Int-Ext Freq Std Switch Assy, 28480, 05345-60032.
Add A20C1, 0160-2055, Capacitor-fxd .01uf 100V, 28480, 0160-2055.
Add A20S1, 3101-0957, Switch, 28480, 3101-0957
Add A20J1, 1250-0829, Connector Coax RF, 28480, 1250-0829.
Add A20MP1, 05345-00030, Plate Freq Std. 28480, 05345-00030
Add A20MP2, 05345-00031, Bracket-Connector, 28480, 05345-00031.
Add A20W1, 05345-60078, Cable-Coax, 28480, 05345-60078

Page 8-39, Figure 8-11. A8 PLL Multiplier Noise Generator Assembly:
Replace wiring of J1, S9, C6, and W8 with A20 circuitry as shown in Figure 7-21.



A20 INT-EXT FREQUENCY STANDARD SWITCH (OPT. 001) (SERIAL 1428A00451 THRU 1440A00950)

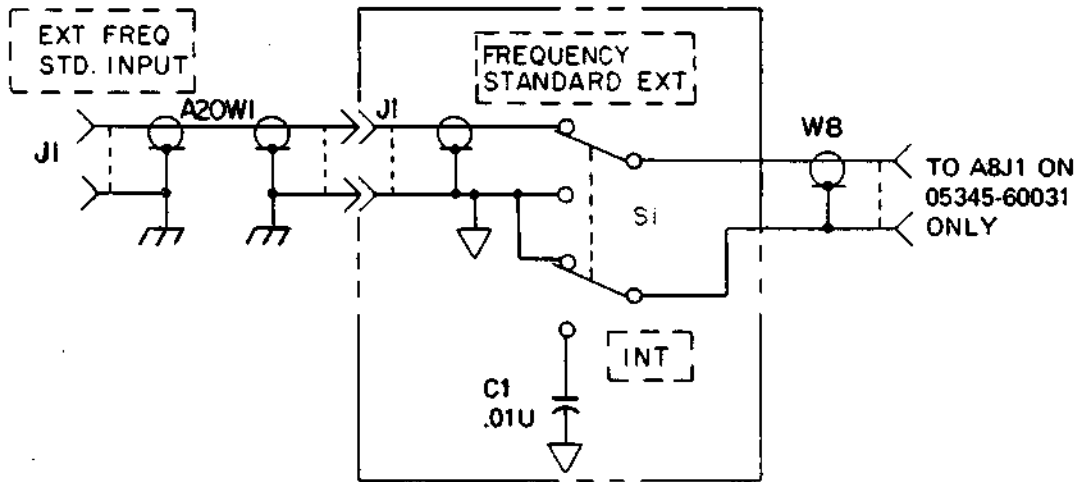


Figure 7-21. A20 INT-EXT FREQ STANDARD Switch Schematic Diagram
for Option 001 Instrument with Serial Numbers 1428A00451 through 1440A00950

Table 7-17. A7 Replaceable Parts for Series 1428A and Below

Reference Designation	HP Part Number	Qty	Description	Mfr Code	Mfr Part Number
A7	05345-60007	1	LINEAR REGULATOR ASSY	28480	05345-60007
A7C1	0150-0012	2	CAPACITOR-FXD .01UF +-20% 1000WVDC CER	56289	C023A102J103M538
A7C2	0150-0012	2	CAPACITOR-FXD .01UF +-20% 1000WVDC CER	56289	C023A102J103M538
A7C3	0150-0084	3	CAPACITOR-FXD .1UF +80-20% 100WVDC CER	28480	0150-0084
A7C4	0160-0161	1	CAPACITOR-FXD .01UF +-10% 200WVDC POLYE	56289	Z92P10392
A7C5	0180-2470	4	CAPACITOR-FXD: 220UF+75-10% 35VDC AL	56289	60102286030654
A7C6	0180-2470		CAPACITOR-FXD: 220UF+75-10% 30VDC AL	56289	60102286030654
A7C7	0180-2470		CAPACITOR-FXD: 220UF+75-10% 30VDC AL	56289	60102286030654
A7C8	0180-2470		CAPACITOR-FXD: 220UF+75-10% 30VDC AL	56289	60102286030654
A7C9	0180-1746	5	CAPACITOR-FXD: 15UF+-10% 20VDC TA-SOLID	56289	1500156X902082
A7C10	0160-0210		CAPACITOR-FXD: 3.3UF+-20% 15VDC TA	56289	1500335X0015A2
A7C11	0150-0050	10	CAPACITOR-FXD 1000PF +80-20% 100WVDC	28480	0150-0050
A7C12	0150-0084		CAPACITOR-FXD .1UF +80-20% 100WVDC CER	28480	0150-0084
A7C13	0180-0228	2	CAPACITOR-FXD: 22UF+-10% 15VDC TA-SOLID	56289	1500228X901582
A7C14	0180-1746		CAPACITOR-FXD: 15UF+-10% 20VDC TA-SOLID	56289	1500156X902082
A7C15	0160-3060		CAPACITOR-FXD .1UF +-20% 25WVDC CER	28480	0160-3060
A7C16	0150-0050		CAPACITOR-FXD 1000PF +80-20% 100WVDC	28480	0150-0050
A7C17	0160-3878		CAPACITOR-FXD 1000PF +-20% 100WVDC CER	28480	0160-3878
A7C18	0160-3060		CAPACITOR-FXD .1UF +-20% 25WVDC CER	28480	0160-3060
A7C19	0160-2141	1	CAPACITOR-FXD 680PF +-20% 100WVDC CER	28480	0160-2141
A7C20	0180-0228		CAPACITOR-FXD: 22UF+-10% 15VDC TA-SOLID	56289	1500228X901582
A7C21	0160-3878		CAPACITOR-FXD 1000PF +-20% 100WVDC CER	28480	0160-3878
A7C22	0150-0084		CAPACITOR-FXD .1UF +80-20% 100WVDC CER	28480	0150-0084
A7C23	0160-3060		CAPACITOR-FXD .1UF +-20% 25WVDC CER	28480	0160-3060
A7C24	0180-0160	1	CAPACITOR-FXD: 22UF+-20% 35VDC TA-SOLID	56289	1500226X0035R2
A7C25	0180-0050	2	CAPACITOR-FXD: 100UF+-20% 20VDC TA	56289	1500107X002052
A7C26	0160-3060		CAPACITOR-FXD .1UF +-20% 25WVDC CER	28480	0160-3060
A7C27	0180-0050		CAPACITOR-FXD: 100UF+-20% 20VDC TA	56289	1500107X002052
A7C28	0160-3060		CAPACITOR-FXD .1UF +-20% 25WVDC CER	28480	0160-3060
A7C29	0180-2472	1	CAPACITOR-FXD: 145UF+75-10% 35VDC AL	28480	0180-2472
A7CR1	1904-0026	1	DIODE: MULT; FULL WAVE BRIDGE RECTIFIER	04713	MOA922-3
A7CR2	1901-0638		DIODE: MULT; FULL WAVE BRIDGE RECTIFIER	28480	1901-0638
A7CR3	1901-0519		DIODE-SWITCHING 50MS 200V	28480	1901-0519
A7CR4	1901-0519		DIODE-SWITCHING 50MS 200V	28480	1901-0519
A7CR5	1902-3171	1	DIODE-ZNR 11V 5% DC-7 PD=.4W TC=+.062%	04713	SZ 10939-194
A7CR6	1884-0217		THYRISTOR: SCR; JECEC	04713	2N5061
A7CR7	1901-0519		DIODE-SWITCHING 50MS 200V	28480	1901-0519
A7CR8	1901-0519		DIODE-SWITCHING 50MS 200V	28480	1901-0519
A7CR9	1902-0041	2	DIODE-ZNR 5.11V 5% DC-7 PD=.4W TC=	04713	SZ 10939-98
A7CR10	1901-0519		DIODE-SWITCHING 50MS 200V	28480	1901-0519
A7CR11	1884-0217		THYRISTOR: SI TRIAC	28480	1884-0217
A7CR12	1884-0217		THYRISTOR: SI TRIAC	28480	1884-0217
A7CR13	1902-0025	2	DIODE-ZNR 10V 5% DC-7 PD=.4W TC=+.06%	04713	SZ 10939-182
A7CR14	1902-3149	2	DIODE-ZNR 9.09V 5% DC-7 PD=.4W	04713	SZ 10939-170
A7CR15	1902-0025		DIODE-ZNR 10V 5% DC-7 PD=.4W TC=+.06%	04713	SZ 10939-182
A7CR16	1902-3149		DIODE-ZNR 9.09V 5% DC-7 PD=.4W	04713	SZ 10939-170
A7F1	2110-0446		FUSE: 10A 125V	28480	2110-0446
A7F2	2110-0446		FUSE: 10A 125V	28480	2110-0446
A7F3	2110-0438	2	FUSE 7A 125V SLC-BLO	28480	2110-0438
A7F4	2110-0438		FUSE 7A 125V SLC-BLO	28480	2110-0438
A7L1	9100-1788		COIL: FXD: NON-MOLDED RF CHOKE: .75UH	02114	VK200-20/48
A7Q1	1854-0574	1	TRANSISTOR NPN SI PD=900MW FT=125MHZ	28480	1854-0574
A7Q2	1853-0364		TRANSISTOR TC-22 PD=40W	04713	MJE-701
A7Q3	1854-0574		TRANSISTOR NPN SI PD=900MW FT=125MHZ	28480	1854-0574
A7Q4	1853-0317		TRANSISTOR PNP SI CNIP PD=625MW	28480	1853-0317
A7Q5	1853-0317		TRANSISTOR PNP SI CNIP PD=625MW	28480	1853-0317
A7Q6	1854-0071		TRANSISTOR NPN SI PD=300MW FT=200MHZ	28480	1854-0071
A7Q7	1854-0071		TRANSISTOR NPN SI PD=300MW FT=200MHZ	28480	1854-0071
A7Q8	1853-0365	1	TRANSISTOR SI PD=90W	04713	MJE2901K
A7Q9	1854-0640	1	TRANSISTOR SI PD=90W	04713	MJE2801K
A7R1	0683-3635	1	RESISTOR 36K 5% .25W CC TUBULAR	01121	C83635
A7R2	0683-5125	1	RESISTOR 5.1K 5% .25W CC TUBULAR	01121	C85125
A7R3	0683-2335	2	RESISTOR 33K 5% .25W CC TUBULAR	01121	C83335
A7R4	0683-3625	1	RESISTOR 3K 5% .25W CC TUBULAR	01121	C83025
A7R5	0683-1045	1	RESISTOR 100K 5% .25W CC TUBULAR	01121	C81045
A7R6	0683-3035	4	RESISTOR 30K 5% .25W CC TUBULAR	01121	C83035
A7R7	0683-3035		RESISTOR 30K 5% .25W CC TUBULAR	01121	C83035
A7R8	0683-6235	2	RESISTOR 62K 5% .25W CC TUBULAR	01121	C86235
A7R9	0683-3035		RESISTOR 30K 5% .25W CC TUBULAR	01121	C83035
A7R10	0683-3035		RESISTOR 30K 5% .25W CC TUBULAR	01121	C83035
A7R11	0811-1827		RESISTOR .1 OHM 10% 3W PW TUBULAR	91637	CW28-1
A7R12	0683-2025		RESISTOR 2K 5% .25W CC TUBULAR	01121	C82025
A7R13	0683-6235		RESISTOR 62K 5% .25W CC TUBULAR	01121	C86235
A7R14	0683-1835	1	RESISTOR 18K 5% .25W CC TUBULAR	01121	C81835
A7R15	0757-0917		RESISTOR 510 OHM 2% .125W F TUBULAR	24546	C4-1/8-T0-511-G

See introduction to this section for ordering information

Table 7-17. A7 Replaceable Parts for Series 1428A and Below (Continued)

Reference Designation	HP Part Number	Qty	Description	Mfr Code	Mfr Part Number
A7R16	0761-0054	1	RESISTOR 330 OHM 5% 1W MC TUBULAR	24546	FP32-1-T00-331-J
A7R17	0757-0439		RESISTOR 6.81K 1% .125W F TUBULAR	24546	C4-1/0-T0-6811-F
A7R18	210C-2457		RESISTOR; VAR; TRMR; 2KOHM 10% C	19701	ET50H202
A7R19	0757-0556	2	RESISTOR 22K 2% .125W F TUBULAR	24546	C4-1/0-T0-2202-G
A7R20	0683-2025		RESISTOR 2K 5% .25W CC TUBULAR	01121	C82025
A7R21	0683-5105		RESISTOR 51 OHM 5% .25W CC TUBULAR	01121	C85105
A7R22	0683-2015	7	RESISTOR 200 OHM 5% .25W CC TUBULAR	01121	C82015
A7R23	0757-0439		RESISTOR 6.81K 1% .125W F TUBULAR	24546	C4-1/0-T0-6811-F
A7R24	210C-2457		RESISTOR; VAR; TRMR; 2KOHM 10% C	19701	ET50H202
A7R25	0757-0556		RESISTOR 22K 2% .125W F TUBULAR	24546	C4-1/0-T0-2202-G
A7R26	0757-0559	1	RESISTOR 30K 2% .125W F TUBULAR	24546	C4-1/0-T0-3002-G
A7R27	0757-0517	1	RESISTOR 510 OHM 2% .125W F TUBULAR	24546	C4-1/0-T0-511-G
A7R28	0683-0565		RESISTOR 5.6 OHM 5% .25W CC TUBULAR	01121	C85665
A7R29	0683-1025		RESISTOR 1K 5% .25W CC TUBULAR	01121	C81025
A7R30	0683-1025		RESISTOR 1K 5% .25W CC TUBULAR	01121	C81025
A7R31	C811-1827		RESISTOR .1 OHM 10% 3W PW TUBULAR	91637	CN20-1
A7R32	0683-2335		RESISTOR 33K 5% .25W CC TUBULAR	01121	C83335
A7R33	0683-2025		RESISTOR 2K 5% .25W CC TUBULAR	01121	C82025
A7R34	0683-1005		RESISTOR 10 OHM 5% .25W CC TUBULAR	01121	C81005
A7R35	0683-1005		RESISTOR 10 OHM 5% .25W CC TUBULAR	01121	C81005
A7S1	3102-0032		SWITCH-THRM FXD 194F 3A OPN ON RISE	28480	3102-0032
A7U1	1826-CC24		IC LIM MC 1469R REGULATOR	04713	MC1469R
A7U2	1826-C147	1	IC LIM REGULATOR	07263	7812UC
A7U3	1205-C219	1	HEAT-DISSIPATOR; SGL; SMUNT PKG	28480	1205-0219
A7U4	1826-0106	2	IC LIM REGULATOR	07263	7815UC
A7U4	1826-C0J2		IC LIM MC 1463R REGULATOR	04713	MC1463R
A7U5	1826-C106		IC LIM REGULATOR	07263	7815UC

See introduction to this section for ordering information

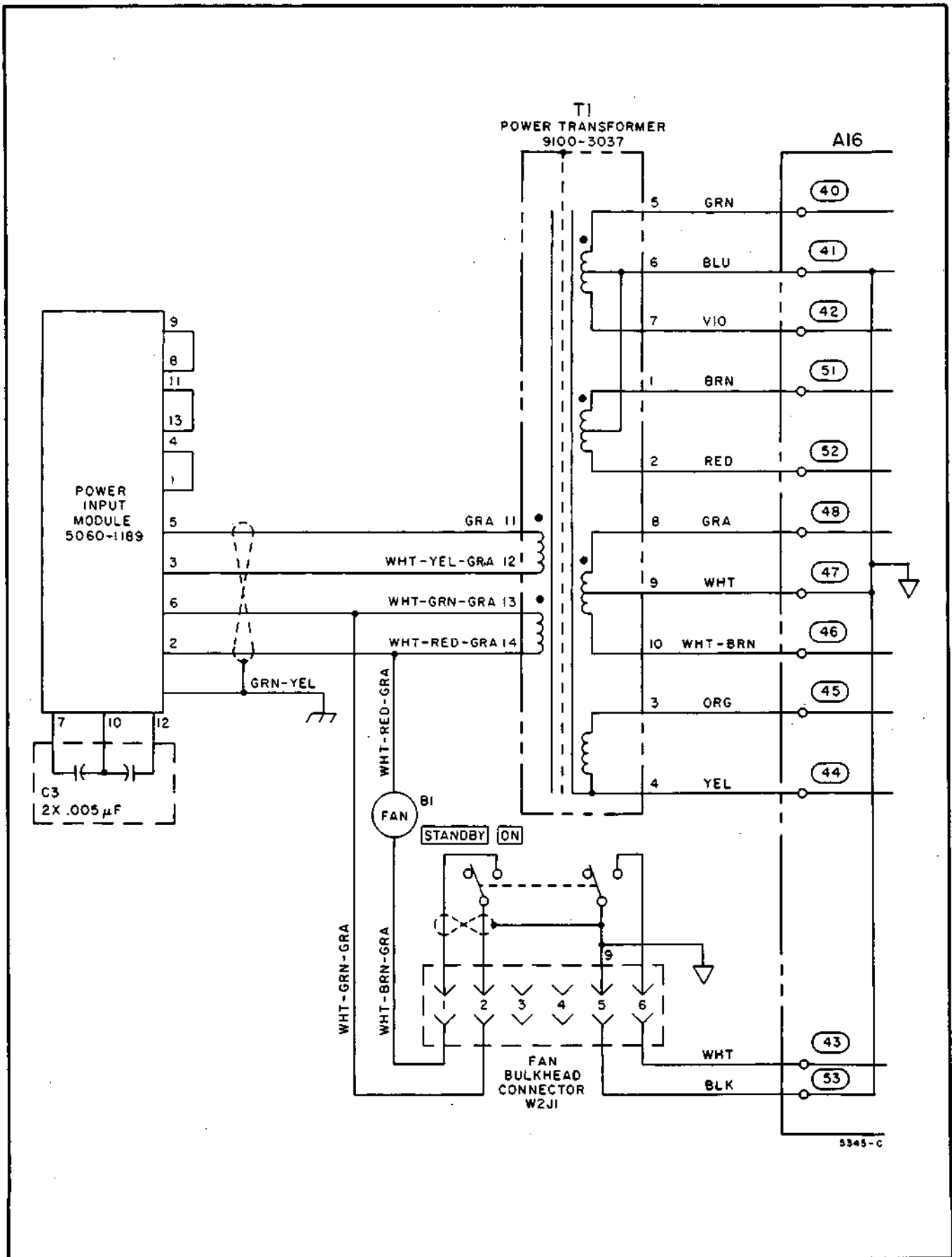


Figure 7-22. Wiring for Primary Power Circuit (Series 1340A through 1438A)

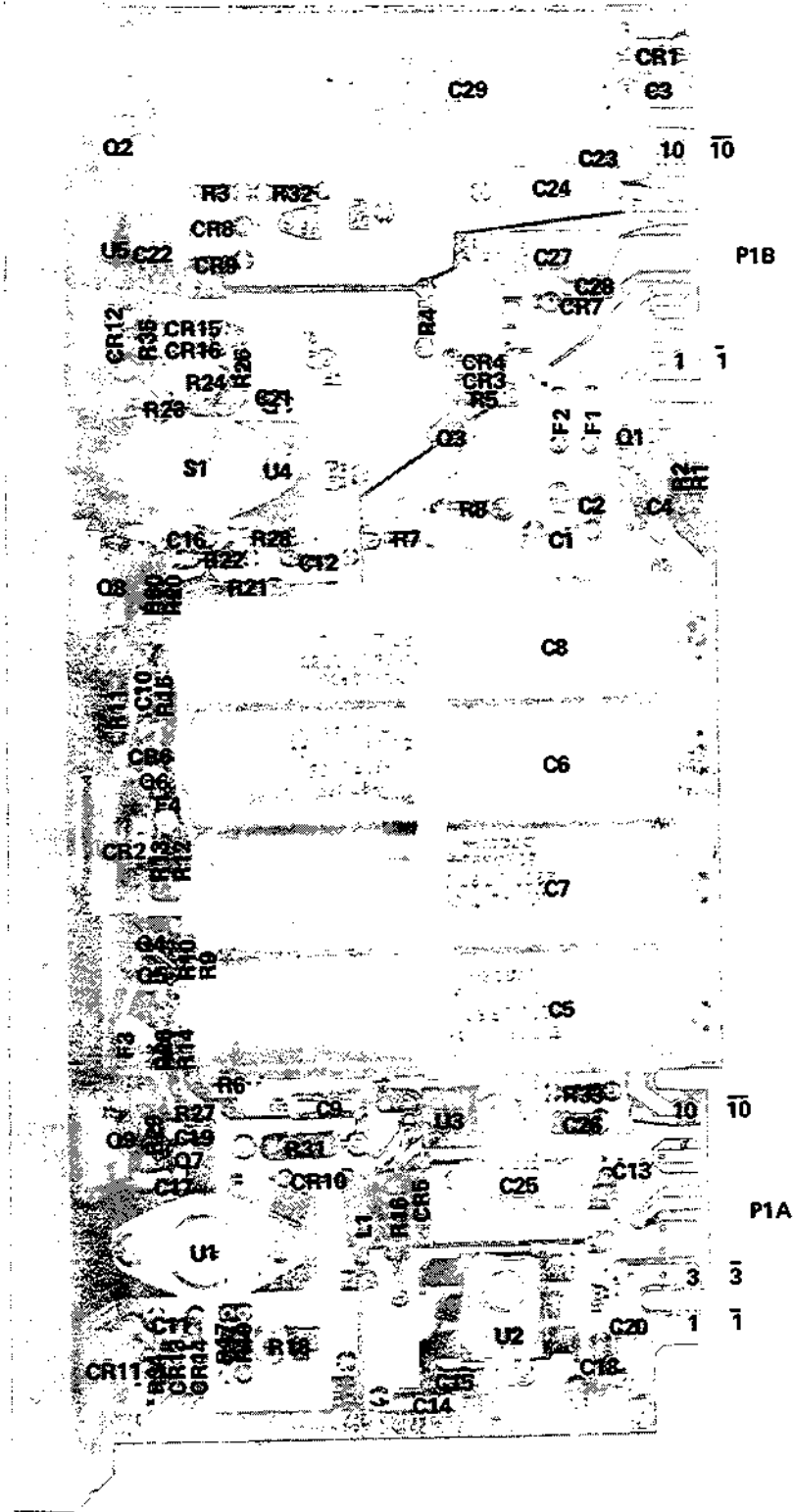


Figure 7-24. A7 Component Locator, Series 1412A

SECTION VIII

SCHEMATIC DIAGRAMS

8-1. SCHEMATIC DIAGRAMS

8-2. This section contains schematic diagrams, assembly and chassis part locators, component locators, block diagrams, waveforms, test points, and troubleshooting information. The schematics are presented in assembly number order A1 through A19. The component, chassis, and assembly locators show the location by reference designator. The block diagrams give a simplified block of the corresponding schematic diagram.

8-3. SCHEMATIC DIAGRAM NOTES, ASSEMBLY NUMBERS, AND REFERENCE DESIGNATORS

8-4. Figure 8-1 shows the symbols used on the schematic diagrams. The bottom of Figure 8-1 shows the method for assigning reference designators, assembly numbers, and subassembly numbers.

8-5. Reference Designations

8-6. Assemblies such as printed-circuit boards are assigned numbers in sequence, A1, A2, etc. As shown in Figure 8-1, subassemblies within an assembly are given a subordinate A number. For example, rectifier subassembly A1 has the complete designator of A25A1. For individual components, the complete designator is determined by adding the assembly number and subassembly number, if any. For example, CR1 on the rectifier assembly is designated A25A1CR1.

8-7. Identification Markings on Printed-Circuit Boards

8-8. HP printed-circuit boards (see Figure 8-1) have four identification numbers; an assembly part number, a series number, a revision letter, and a production code.

8-9. The assembly part number has 10 digits (such as 05345-60009) and is the primary identification. All assemblies with the same part number are interchangeable. When a production change is made on an assembly that makes it incompatible with previous assemblies, a change in part number is required. The series number (such as 1340A) is used to document minor electrical changes. As changes are made, the series number is incremented. When replacement boards are ordered, you may receive a replacement with a different series number. If there is a difference between the series number marked on the board and the schematic in this manual, a minor electrical difference exists. If the number on the printed-circuit board is lower than that on the schematic, refer to Section VII for backdating information. If it is higher, refer to the loose leaf manual change sheets for this manual. If the manual change sheets are missing, contact your local Hewlett-Packard Sales and Service Office. See the listing on the back cover of this manual.

8-10. Revision letters (A, B, etc.) denote changes in printed-circuit layout. For example, if a capacitor type is changed (electrical value may remain the same) and requires different spacing for its leads, the printed-circuit board layout is changed and the revision letter is incremented to the next letter. When a revision letter changes, the series number is also usually changed. The production code is the four-digit, seven-segment number used for production purposes.

Table 8-1. Signal Line Descriptions and Destinations

1. **Static Control Line (SCL).** Stays in one state throughout measurement or while controlled externally.
2. **Dynamic Control Line (DCL).** Changes state during some phase of measurement.
3. **Signal Line (SL).** Dynamic line changing state at some frequency. Directly used in measurement, e.g., Channel A input signal or a derivative, or Time Base signal or a derivative.
4. **Clock Line (CL).** Dynamic line changing state at some frequency. Initiates a sequence of events.
5. **Data Line (DL).** Code line carrying measurement information. Changes state with new data.

MNEMONIC ABBREVIATIONS	CONNECTOR AND PINS		DESCRIPTION
	FROM	TO	
A-B SW	A12B(20), S8	A10A(14), A16(35)	A-B Switch (SCL-TTL). Used in START to totalize Channel A counts plus Channel B counts or Channel A counts minus Channel B counts. In remote operation, line is controlled by A12. When not in remote, line is controlled by S8. A+B mode forces line Low.
ADD	A15A($\bar{11}$)	A13A($\bar{11}$)	(DCL-TTL). Used during process cycle. Instructs Add/Subtract circuit on A13 to perform addition (High) or subtraction (Low).
$\bar{A}RM$	A11B(17)	A10B($\bar{17}$)	(DCL-TTL). Goes Low after rundown of sample rate to set Arm F-F (A10). Can be forced Low by PI ARM, FORCED ARM, ST+STP, or a reset.
ARMED	A10B(7)	A2P1(7), A17J1(13) via A17J2(39), A16(13)	(DCL-TTL). Goes High when Arm F-F (A10) sets. Causes front panel ARM lamp to light. Instructs plug-in that counter is armed.
$\bar{A}STERISK$	A7B($\bar{1}$)	A2P1($\bar{9}$)	(DCL-TTL). A result of the OSC HTR line (A18) going High to indicate that the oscillator oven temperature is too low. Also active from DIG ASTERISK line being set High by Asterisk F-F on A15.
$\bar{A}UT$	A14B(3)	A13B($\bar{3}$)	Automatic (SCL-TTL). When Low, used to select the multiplier from QMC in automatic routine. Goes High when a fixed display position code (manual mode) is selected for use.
$\bar{A}UT + \bar{A}UT\ SC \bullet LOC\ MUL$	A13A($\bar{13}$)	A14A(13)	Auto or Auto Single Cycle and Local Multiplier (DCL-TTL). Causes auto decimal point alignment routine when DISPLAY POSITION switch is set to AUTO. Causes a single auto decimal point alignment routine when switch is not in AUTO (manual) and a reset is generated.
$\bar{A}UT\ DP\ ALN$	A15B($\bar{1}$)	A14B($\bar{1}$)	Auto Decimal Point Align (DCL-TTL). A qualifier line that goes Low to indicate that the decimal point is properly aligned and the correct multiplier is selected during Auto display.

Table 8-1. Signal Line Descriptions and Destinations

MNEMONIC ABBREVIATIONS	CONNECTOR AND PINS		DESCRIPTION
	FROM	TO	
$\overline{\text{AUT SC}}$	A11B(15)	A13B(15)	Auto Single Cycle (DCL-TTL). Generated on A11 when counter is reset while in manual mode and not remotely programmed. Forces one measurement in auto mode to align decimal point and multiplier. Causes generation of $\overline{\text{AUT}} + \overline{\text{AUT SC}} \cdot \overline{\text{LOC MUL}}$ qualifier from A13.
$\overline{\text{COMP DUMP}}$	A12A(18)	A14A($\overline{18}$)	Computer Dump (DCL-TTL). An externally programmed condition. This line is a qualifier signal. It causes the DR to output 32 characters to A12 for the output routine. The first 16 characters are from the DR and the next 16 from the NR.
$\overline{\text{DC}} = \overline{\text{DS}}$	A15A($\overline{17}$)	A14A($\overline{17}$)	Digit Counter Equals Digit Storage (DCL-TTL). Active Low qualifier line, indicating that sufficient divisions have occurred to produce proper resolution for gate time being used. DS contains number of digits that were in time scaler. DC increments with each digit that is resolved during division process.
DC SER OUT A DC SER OUT B DC SER OUT C	A15A($\overline{16}$) A15A($\overline{13}$) A15A($\overline{18}$)	A12A($\overline{15}$) A12A($\overline{13}$) A12A($\overline{12}$)	Digit Counter Serial Output (DCL-TTL). The three line code controls the order of output data from A12. See Table 4-2, A12 ROM Sequence.
DC = 0	A15A(17)	A14A(17)	Digit Counter Equals zero (DCL-TTL). Active High qualifier line. Sometimes used as qualifier director. Also used to determine value of other counters, e.g., $\text{QMC} = \theta \cdot \text{DC} = \theta$.
DC = 8	A15B(4)	A14B($\overline{3}$)	Digit Counter Equals Eight (DCL-TTL). Active High qualifier, indicating the digit counter serial output ROM sequence is complete and processor should return to main processor program.
DECADE RST	A10A($\overline{17}$)	A9A(17)	Decade Reset (DCL-TTL). Resets Time and Events scalers on A11. Goes High with $\overline{\text{SET AUT SC}}$ or RST FRONT END when $\overline{\text{ST}} + \overline{\text{STP}}$ line is Low.
DIG ASTERISK	A15B($\overline{8}$)	A7B(1)	Digit Asterisk (DCL-TTL). A result of setting the Asterisk F-F on A15. Conditions for setting F-F are overflow, underflow, or factitious zeros.
DISP CLK	A14B(6)	A2P1($\overline{3}$), A15B(6)	Display Clock (CL-TTL). Used during display cycle to strobe time and events scalers and data from DR at a slower rate than normally available. The signal is a divided version of $\overline{\text{DPLK CLK}}$, which is, itself, derived from $\overline{\text{ROM CLK}}$. DISP CLK is sent to A15, where it is converted to REG CLK for use in the display cycle strobing.

Table 8-1. Signal Line Descriptions and Destinations

MNEMONIC ABBREVIATIONS	CONNECTOR AND PINS		DESCRIPTION
	FROM	TO	
DISP CLK EN	A15B(9)	A2P1(14) via A16(54), A11B(12), A13B(8)	Display Clock Enable (DCL-TTL). At start of display cycle, goes High to enable anode driver circuit (A2). Turns on Sample Rate circuit (A11). Allows circuit on A13 to decide if it will output a twelfth DRC code to light the minus sign.
<u>DISP STR/INH PROC</u>	A17J1(15) via A17J2(35)	A10B(22), A14A(22)	Display Storage/Inhibit Processor (DCL-TTL). Time shared control line from processor. Active when plug-in is storing the mainframe display. Can cause processor to calculate a 14 digit quotient result when more than one division process is required. When Low, it also prevents a process cycle by keeping the <u>INIT PROC</u> line High.
DP A	A14B(14) A17J1(43) via A17J2(27)	A2P1(15), A15B(14), A16(1)	Decimal Point (DL-TTL). A2 assembly uses code to light decimal point in the display. A15 assembly uses code to help determine placement of decimal point and proper annunciator. The A14 assembly usually outputs the code on these lines, but can also accept a decimal point code from the plug-in on the same lines.
DP B	A14B(17) A17J1(7) via A17J2(51)	A2P1(12), A15B(17), A16(3)	
DP C	A14B(18) A17J1(8) via A17J2(49)	A2P1(16), A15B(18), A16(5)	
DP D	A14B(15) A17J1(20) via A17J2(29)	A2P1(17), A15B(15), A16(2)	
DP E	A14B(13) A17J1(17) via A17J2(33)	A15B(13)	
DP F	A14B(16) A17J1(6) via A17J2(53)		
<u>DPLK CLK</u>	A15B(18)	A14B(18)	Decimal Point Locator for K, Clock (CL-TTL). In the display cycle, this line is divided by 8 and results as DISP CLK. When DPLR < DPLK, the line is used to decrement the DPLK counter until the decimal point codes are equal.
<u>DPLR CLK</u>	A15B(15)	A14B(15)	Decimal Point Locator for Result, Clock (DCL-TTL). This line clocks the DPLR counter. Used in decimal point alignment.
<u>DPLR UP</u>	A15B(7)	A14B(7)	Decimal Point Locator for Result Up (DCL-TTL). When High, allows each <u>DPLR CLK</u> pulse to decrement the DPLR counter (A14). When Low, allows each clock pulse to increment the counter.

Table 8-1. Signal Line Descriptions and Destinations

MNEMONIC ABBREVIATIONS	CONNECTOR AND PINS		DESCRIPTION
	FROM	TO	
$\overline{\text{DPLK}}-1$	A15B(6)	A14B(6)	Decimal Point Locator for K Assign minus one (DCL-TTL). Used as a reset signal for the DPLK counter. Sets the counter's output lines (A,B,C,D,E, and -/+) High.
$\overline{\text{DPLK}}-\text{DPLK_PI}$	A15B(17)	A14B(17)	DPLK Assign DPLK with Plug-In (DCL-TTL). Active Low ROM command. Causes decimal point data from plug-in to be sent to mainframe DPLK counter (A14).
$\overline{\text{DPLR}}-1$	A15B(16)	A14B(16)	Decimal Point Locator for Result Assign minus one (DCL-TTL). Used as a reset signal for the DPLR counter. Sets all counter outputs High.
DPLR=+	A14B(22)	A15B(22)	Decimal Point Locator for Result Equals Plus (DCL-TTL). Goes High to indicate that decimal point is in viewable range. Combines with NANO MULT line (both Low) to force an auto decimal point align (AUTO DP ALN line).
DPLR<16	A14A(20)	A12A(21)	Decimal Point Locator for Result is less than 16 (DCL-TTL). Qualifier used to determine the direction the decimal point is away from the quotient's MSD. Also, used in determining when to output the decimal point in the output routine (A12).
DR A	A13A(7) A17J1(63) via A17J2(21)	A2P1(4), A16(21)	Denominator Register (DL-TTL). When the $\overline{\text{PI}}$ XMT line is High, the DR outputs its data on these lines to the display and the plug-in. When PI XMT is Low, the DR accepts data from the plug-in.
DR B	A13A(5) A17J1(57) via A17J2(19)	A2P1(5), A16(19)	
DR C	A13A(6) A17J1(61) via A17J2(26)	A2P1(4), A16(26)	
DR D	A13A(6) A17J1(59) via A17J2(27)	A2P1(5), A16(27)	
$\overline{\text{DRC}}-0$	A15A(12)	A13A(12)	Denominator Register Counter Assign Zero (DCL-TTL). Active Low ROM command. Resets the DR counter to zero. Required after every display state, since display state could leave counter at any location.
DR CLK EN	A15A(22)	A13B(21)	Denominator Register Clock Enable (DCL-TTL). When High, allows the DR counter outputs to increment with each REG CLK pulse.

Table 8-1. Signal Line Descriptions and Destinations

MNEMONIC ABBREVIATIONS	CONNECTOR AND PINS		DESCRIPTION
	FROM	TO	
DR EN A DR EN B DR EN C	A15B(21) A15A(8) A15A(9)	A13B(21) A13A(8) A13A(8)	Denominator Register Enable (DCL-TTL). Presents a 3-line code to the DR (A13) that controls and directs the shifting of data to and from the register.
DRC A	A13A(19)	A2P1(15) via A16(23), A11A(19)	
DRC B	A13A(20)	A2P1(12) via A16(25), A11A(20)	
DRC C	A13A(21)	A2P1(16) via A16(10), A11A(21)	
DRC D	A13A(13)	A2P1(17) via A16(8), A11A(13)	Denominator Register Counter (DCL-TTL). A 4-line code used to strobe data out of the scalers (A11). Also used to strobe measurement data out of the DR and enable the proper LED in the display for each DR digit.
DS<3	A15A(20)	A14A(20)	
EFC	A8A(4, 4)	A18(6, 6)	Digit Storage Less Than Three (DCL-TTL). A qualifier line that, when High, indicates the resolution of measurement is less than three digits. Causes the decimal point and multiplier to remain in their current positions.
EVT GATE	A9B(19)	A10B(19)	Electronic Frequency Control. Used to control the frequency of the internal oscillator (A18) when using an external standard. Line varies from -10V to +5V and causes VCO on A18 to phase lock internal oscillator to external standard.
EVT+RAT+ST+STP	A10B(4)	A14B(1)	Event Gate (DCL-ECL). Goes Low when the Event Gate F-F sets. Causes front panel GATE lamp to light and MEAS TIME line to enable Excessive Gate Time F-F (A11). Starts process cycle when <u>EVT GATE</u> and <u>TIME GATE</u> go High to cause <u>INIT PROC</u> to go Low. Initiates signal for GATE OUTPUT jack.
EVT SCLR A EVT SCLR B EVT SCLR C EVT SCLR D	A11A(16) A11A(15) A11A(9) A11A(10)	A13A(16) A13A(15) A13A(9) A13A(10)	Events or Ratio or Start or Stop (SCL-TTL). A result of decoding the FUNCTION switch code. Line is High in any of these modes. Used as a qualifier to indicate to the processor which function has been selected.
			Events Scaler (DL-TTL). At beginning of process cycle, these lines transfer Events Scaler data (in BCD) from A11.

Table 8-1. Signal Line Descriptions and Destinations

MNEMONIC ABBREVIATIONS	CONNECTOR AND PINS		DESCRIPTION
	FROM	TO	
$\overline{\text{EVT SCLR A}}_0$	A9A(5)	A11A(5)	Event Scaler (DL-EECL). A four-line code from a divide-by-10 stage in the events scaler (A9). At the end of the gate time, this decade holds the least significant digit in the event count.
$\overline{\text{EVT SCLR B}}_0$	A9A(6)	A11A(6)	
$\overline{\text{EVT SCLR C}}_0$	A9A(5)	A11A(5)	
$\overline{\text{EVT SCLR D}}_0$	A9A(8)	A11A(8)	
EVT SCLR A1	A9A(7)	A11A(7)	Events Scaler A1 (SL-ECL). Derivative of Channel A signal. Has been divided by 20 in scaler on A9 before being sent to remainder of scalers on A11. Complement of $\overline{\text{EVT SCLR A}}_1$.
$\overline{\text{EVT SCLR A}}_1$	A9A(6)	A11A(16)	Events Scaler A1 (SL-ECL). Derivative of Channel A signal. Has been divided by 20 in scaler on A9 before being sent to remainder of scalers on A11. Complement of $\overline{\text{EVT SCLR A}}_1$.
EXT AB	A10A(20)	A9A(16)	External AB (SCL-EECL). Controlled from plug-in by $\overline{\text{SEL A}} \cdot \overline{\text{B}}$. When $\overline{\text{SEL A}} \cdot \overline{\text{B}}$ is High, EXT AB is Low and allows the mainframe's channel A and B signals to be used. When $\overline{\text{SEL A}} \cdot \overline{\text{B}}$ is Low, EXT AB is High and allows the mainframe to use the plug-in's Channel A AND B signals. Also turns off Schmitt trigger circuits on A4, preventing front panel signals from entering control circuits on A9.
EXT C	A10B(14)	A9B(14)	External C (SCL-EECL). Controlled from plug-in by SEL C line. Used when measuring events of Channel C occurring between Channel A pulse and Channel B pulse. Causes Time Scaler to accept Channel C signal instead of Time Base signal.
$\overline{\text{EXT OUT EN}}$	A15A(9)	A12A(8)	External Out Enable (DCL-TTL). An active Low ROM command. Used with FLAG command on A12 to generate Data Valid (DAV) signal to the recording device.
$\overline{\text{FP CHK}}$	A4P2(18)	A10A(8, 8)	Front Panel Check (SCL-TTL). Combined on A10 with the FUNCTION switch codes. Operational only when using front panel controls. Forces selection of A+B, regardless of ACCUM MODE START/STOP switch position. Causes TEST line to select 100 MHz test signal for measurement and turn off front panel input trigger circuits.
FP DISP POS A	S5, A4J1(4), A4J2(12)	A14B(10)	Front Panel Display Position (SCL-TTL). The 4-line code fixes the decimal point position in the display. The DPLR counter is incremented or decremented until its code equals the FP DISP POS code.
FP DISP POS B	S5, A4J1(5), A4J2(11)	A14B(11)	
FP DISP POS C	S5, A4J1(3), A4J2(13)	A14B(9)	
FP DISP POS D	S5, A4J1(4), A4J2(11)	A14B(12)	

Table 8-1. Signal Line Descriptions and Destinations

MNEMONIC ABBREVIATIONS	CONNECTOR AND PINS		DESCRIPTION
	FROM	TO	
FP FUNC A	S1 via A4J1(9), A5(7)	A10A(6)	Front Panel Function (SCL-TTL). When using front panel controls, lines provide a 3-line code to program the desired operating mode (freq, period, TI, etc).* Code list is on the switch schematic. Codes are decoded on A10 to provide several static control lines. *These lines are selected for use when $\overline{\text{RMT}}$ is High.
FP FUNC B		A10A(5)	
FP FUNC C		A10A(4)	
FP GT A	S4 via A4J1(9), A5(5)	A11A(18)	Front Panel Gate Time (SCL-TTL). When using front panel controls, lines provide a 4-line code to program the desired gate time (1s, 1 μ s, etc.). These lines are selected for use when $\overline{\text{RMT}}$, $\overline{\text{PROC BUSY}}$, and $\overline{\text{PI DISP POS/GT SEL}}$ lines are High. Code list is shown on switch schematic. Lines are decoded to enable one of the Time Scalers (A11) to output a 5 code.
FP GT B	S4 via A4J1(7), A5(8)	A11A(19)	
FP GT C	S4 via A4J1(6), A5(8)	A11A(20)	
FP GT D	S4 via A4J1(7), A5(8)	A11A(14)	
$\overline{\text{FORCED ARM}}$	A10B(21), A12B(21)	A11B(21)	(DCC-TTL) Causes counter to arm when EXT CONTROL jack receives an arm pulse with switch in EXT ARM position or in remote operation.
FUNC SW RST	S1 FUNC SW	A11A(21)	Function Switch Reset (DCL-TTL). A reset signal generated between switch positions of FUNCTION switch. Not active when in remote operation. Generates lamp test. Forces a single automatic measurement while in manual by activating AUT SC and SET AUT SC. Causes RST lines to go Low.
GATE ARM	A10A(15)	A9A(15)	(DCL-ECL) When High (-0.7V), enables Event Gate F-F (on A9) to set with next Channel A pulse. Complements GATE ARM line.
$\overline{\text{GATE ARM}}$	A10A(16)	A9A(16)	(DCL-ECL) When Low (-1.4V), enables Event Gate F-F (on A9) to set with next Channel A pulse. Complements GATE ARM line.
$\overline{\text{GATE CONTROL}}$	A10B(12)	J4 (rear panel)	Allows counter's main gate/arm circuits to be controlled from external source. Requires 0V to -1V pulse.
$\overline{\text{GATE LITE}}$	A10A(9, 9)	A2P1(7), A16(7)	Gate Light (DC-TTL). Used to light the GATE lamp on A1. Goes Low with first Channel A pulse after counter is armed. Line stays Low for 40 ms after main gate closes, then returns High to turn off light.
GATE RST	A10A(19)	A9A(15)	Gate Reset (DCL-ECL). Rests the Event Gate and Time Gate flip-flops on A9. Generated by SET AUT SC or RST FRONT END when $\overline{\text{ST+STP}}$ is High.

Table 8-1. Signal Line Descriptions and Destinations

MNEMONIC ABBREVIATIONS	CONNECTOR AND PINS		DESCRIPTION
	FROM	TO	
GATED RFD	A12A(10)	A14A(9)	Gated Ready for Data (DCL-TTL). A qualifier that instructs the processor to output a character from A12 to the Interface Bus.
GATED DAC	A12A(20)	A14A(19)	Gated Data Accepted (DCL-TTL). A qualifier line that indicates to the processor that the recording device has received the character, hence the processor prepares to output the next character.
GT+DISP POS RST	S4, S5 via A5(10)	A10A(22)	Gate Time or Display Position Reset (SCL-TTL). A reset signal generated between switch positions of GATE TIME switch or DISPLAY POSITION switch. Causes RST and LAMP TEST lines to go Low, but does not produce a single auto measurement while in manual mode (AUT SC and SET AUT SC lines) as would the front panel RESET switch.
HOLD	A12A(9), SAMPLE RATE POT via A5(7) & A4(8)	A11A(12)	(SL-TTL) When High, causes counter to hold displayed measurement, indefinitely. Prevents sample rate circuit on A11 from turning on and prevents the counter from rearming (A10).
Hz LITE	A10A(7)	A1J1(21), A2P1(8) via A5(7), A16(20)	Hertz Light (SCL-TTL). A result of decoding the function codes on A10. Goes Low to turn on the front panel Hz light for frequency measurements.
INIT PROC	A10B(5)	A14B(5)	Initialize Processor (DCL-TTL). Signals the beginning of the process cycle. Goes Low when measurement cycle is complete and the main gate closes.
INP LEVEL A	A4P2(12) via A5(12)	A9B(17)	Input Level A. DC voltage that is variable from +0.5V to -0.5V with front panel LEVEL pot. Voltage determines trigger point. Line provides voltage to rear panel jack.
INP LEVEL B	A4P2(18) via A5(18)	A9B(16)	Input Level B. DC voltage that is variable from +0.5V to -0.5V with front panel LEVEL pot. Voltage determines trigger point. Line provides voltage to rear panel jack.
K DATA/PI INH ARM	A17J1(40) via A17J2(36)	A11B(20), A14A(15)	K Data/Plug-In Inhibit Arm (DCL-TTL). Time shared control line from plug-in. K DATA indicates that K data is available from plug-in. Causes processor to select K data routine. PI INH ARM allows plug-in to control counter's measurement phase by inhibiting the arming.
LAMP TEST	A8A(3, 3), A11A(22)	A2P1(3) via A16(9), A13A(22)	(DCL-TTL) When Low, causes lamp test condition. Activated by excessive gate time, a reset signal, or by attempt to lock an external frequency standard to internal oscillator.

Table 8-1. Signal Line Descriptions and Destinations

MNEMONIC ABBREVIATIONS	CONNECTOR AND PINS		DESCRIPTION
	FROM	TO	
LOAD MS	A15B(5)	A11B(16), A13B(6)	Load Multiplier Storage (DCL-TTL). Clocks the annunciator code of QMC or the Remote Multiplier into the Multiplier Storage flip-flops (A13) during auto mode. Clocks Auto Single Cycle flip-flop (A11) after a manual reset to generate one auto measurement while in the manual mode.
LOC MULT	A13B(5)	A14B(4)	Local Multiplier (SCL-TTL). Goes Low only when the RMT MULT lines are <i>not</i> being used. Indicates source of MULT code to qualifier board for purpose of altering internal program flow.
MEAS TIME	A10B(18)	A11B(18), A17J1(42) via A17J2(28)	Measurement Time (DCL-TTL). When Low, prevents Excessive Gate Time F-F from setting as scaler data is fed to processor. When High, enables the Excessive Gate Time F-F (A11). High for duration of actual measurement time. Signal indicates to plug-in that mainframe is in measurement phase.
MIN GATE TIME	A11B(2)	A10B(2), A14B(14)	Minimum Gate Time (SCL-TTL). Goes High when GATE TIME lines are decoded in A11 to detect MIN. Prevents NOISE CONTROL from going Low when not in START or STOP. Used to set Resolution F-F (A10) when TIME GATE goes Low to stop measurement on next channel A pulse. Used as qualifier to A14.
MSB	A15B(20)	A15B(19)	Most Significant Bit (DCL-TTL). Used in conjunction with state variable lines (SV1(T), etc.) to address ROMs. Used with one set of state variable codes to output two sets of ROM program codes. When MSB=1, addresses locations 128 to 256; when MSB=0, addresses locations 0 to 127.
MULT STR A	A13A(3)	A1J1(19), A2P1(11), A12A(3), A16(18) A1J1(18), A2P1(11), A12A(3), A16(22) A1J1(17), A2P1(10), A12A(4), A16(24)	Multiplier Storage (DCL-TTL). Stores the QMC code that represents the annunciator. Sends this code to A1 and A2 to display annunciator and to A12 when outputting measurement result.
MULT STR B	A13A(3)		
MULT STR C	A13A(4)		

Table 8-1. Signal Line Descriptions and Destinations

MNEMONIC ABBREVIATIONS	CONNECTOR AND PINS		DESCRIPTION
	FROM	TO	
MV EXT	External Source	A15B($\overline{16}$)	Multivibrator External (SCL-TTL). An externally applied signal used to step the counter through its timing sequence at a rate convenient for troubleshooting. Must be used with another external signal, MV EXT EN. External signal must be TTL.
$\overline{\text{MV EXT EN}}$	External Source	A15B(11)	Multivibrator External Enable (SCL-TTL). When Low, it disables the MV from generating the processor timing and associated pulses; $\overline{\text{ROM CLK}}$, $\overline{\text{MSB}}$, $\overline{\text{WORD DEL CLK}}$, etc. It allows substitution of an external signal on the MV EXT line to produce these timing pulses at a convenient rate for troubleshooting. External signal must be TTL.
NANO MULT	A10A($\overline{22}$)	A1J1($\overline{17}$), A2P1($\overline{10}$), A12A($\overline{22}$), A14A($\overline{22}$), A15A($\overline{22}$), A16(12)	Nano Multiplier (SCL-TTL). A result of decoding the function codes on A10. High for a period or time interval measurement. Used as a qualifier in A14 to determine whether DPLR should be incremented or decremented. Used in A15 to help force a decimal point alignment for sub-nanosecond T.I. measurements. Used in A1 and A2 to change annunciator coding. Used in A12 talk mode to indicate the exponent is >1 or <1, e.g., M or μ .
$\overline{\text{NOISE CONTROL}}$	A10B($\overline{15}$)	A8A(5, $\overline{5}$)	(SCL-TTL). Goes Low to turn on Noise Generator (A8) to noise modulate the time base signal. Goes Low when GATE TIME switch is not set to MIN while GATE CONTROL switch is set to EXT GATE or when FUNCTION switch is set to TIME INT A to B.
NR CLK EN	A15A(12)	A13A($\overline{10}$)	Numerator Register Clock Enable (DCL-TTL). Active during process cycle for purpose of shifting data. Each time it goes High, it enables the NR counter to be clocked by REG CLK.
NR EN A NR EN B	A15A($\overline{7}$) A15B($\overline{10}$)	A13A($\overline{7}$) A13B($\overline{11}$)	Numerator Register Enable (DCL-TTL). Presents a 2-line code to the NR (A13) that controls and directs the shifting of data to and from the register.
$\overline{\text{NR(NRC)=0}} \cdot \overline{\text{QMC=0}}$	A13A($\overline{19}$)	A14A(19)	Numerator Register (NR Counter) Equals Zero and Quotient Multiplier Counter Equals Zero (DCL-TTL). Used in divide routine to determine when the first quotient digit has been calculated. When this occurs, QMC no longer equals zero and another routine is selected.

Table 8-1. Signal Line Descriptions and Destinations

MNEMONIC ABBREVIATIONS	CONNECTOR AND PINS		DESCRIPTION
	FROM	TO	
NR(NRC) ≥5	A13A($\overline{12}$)	A14A(12)	Numerator Register (NR Counter) Equal to or Greater than five (DCL-TTL). A qualifier signal used to ensure the ±2 count accuracy error is not exceeded. During Period (in MIN) and T.I. (in MIN), only.
$\overline{\text{PB RST}}$	S3 RESET SW	A11A($\overline{7}$) & A12A(14) via A4 & A5	Pushbutton Reset (SCL-TTL). Goes Low when front panel RESET switch is pushed. Not active when in remote operation. Generates lamp test. Forces a single automatic measurement while in manual by activating $\overline{\text{AUT SC}}$ and $\overline{\text{SET AUT SC}}$. Causes $\overline{\text{RST}}$ line to go Low.
PER + TI	A10A($\overline{11}$)	A14A(11)	Period or Time Interval (SCL-TTL). A result of decoding the FUNCTION switch code. Line is High if counter is in either mode. Used as a qualifier to indicate to the processor which function has been selected.
$\overline{\text{PI ARM}}$	A17J1(41) via A17J2(30)	A11B($\overline{19}$)	Plug-In Arm (DCL-TTL). Goes Low to allow plug-in to arm counter.
PI CH A	W5J1(2)	A16J3, A9A(18)	Plug-In Channel A (SL-EECL). Substitutes for mainframe Channel A signal as a measurement signal.
PI CH B	W5J1(5)	A16J2, A9A(21)	Plug-In Channel B (SL-EECL). Substitutes for mainframe Channel B signal as a measurement signal.
PI CH C	W5J1(21)	A16J1, A9B(8)	Plug-In Channel C (SL-EECL). Measurement signal from plug-in. Used for an events measurement, i.e., where PI CH C pulses accumulate in Events Scaler (A11) during time between Channel A pulse and Channel B pulse.
PI CLK	A15B(12)	A17J1(16) via A17J2(34)	Plug-in Clock (CL-TTL). Used to clock K DATA, N DATA, or plug-in data from the plug-in.
$\overline{\text{PI CLK EN}}$	A15A($\overline{6}$)	A17J1(21) via A17J2(26)	Plug-In Clock Enable (DCL-TTL). Enables plug-in's counter to clock K data, N data, or plug-in data from plug-in.
$\overline{\text{PI DATA}}$	A17J1(14) via A17J2(37)	A10B($\overline{8}$), A14B(7)	Plug-In Data (DCL-TTL). Goes Low to request 16 BCD digits and a decimal point code from the plug-in. Data is sent in Giga or Nano units.
$\overline{\text{PI DISP POS/GT SEL}}$	A17J1(10) via A17J2(45)	A11B($\overline{3}$), A14B(20)	Plug-In Display Position/Gate Time Select (SCL-TTL). Enables counter to accept gate time codes or display position codes from plug-in.

Table 8-1. Signal Line Descriptions and Destinations

MNEMONIC ABBREVIATIONS	CONNECTOR AND PINS		DESCRIPTION
	FROM	TO	
PI FUNC A	A17J1(36) via A17J2(44)	A10B(11)	Plug-In Function (SCL-TTL). Used on A10 to operate counter according to selected function of plug-in. Code is enabled for use when 5345 FUNCTION switch is set to PLUG-IN.
PI FUNC B	A17J1(11) via A17J2(43)	A10B(9)	
PI FUNC C	A17J1(12) via A17J2(41)	A10B(8)	
$\overline{\text{PI INH ANUN}}$	A17J1(35) via A17J2(46)	A10A(4)	Plug-In Inhibit Annunciator (DCL-TTL). Goes Low to blank Hz or SEC lamp during display.
$\overline{\text{PI INV SIGN}}$	A17J1(27) via A17J2(62)	A15B(20)	Plug-In Invert Sign (DCL-TTL). Allows plug-in to define sign of result data or displayed data being sent to mainframe.
PI GT/DISP POS A	A17J1(9) via A17J2(47)	A11B(5), A14B(19)	Plug-In Gate Time/Display Position (SCL-TTL). The 4-line code from the plug-in selects the counter's gate time in A11 when enabled by a Low $\overline{\text{PI DISP POS/GT SEL}}$ signal. The code is used with the same enable signal to select the display position in A14. This code may or may not be used, depending on the selected qualifier.
PI GT/DISP POS B	A17J1(28) via A17J2(60)	A11B(6), A14B(20)	
PI GT/DISP POS C	A17J1(30) via A17J2(56)	A11B(9), A14B(22)	
PI GT/DISP POS D	A17J1(29) via A17J2(58)	A11B(11), A14B(21)	
$\overline{\text{PI RST}}$	A17J1(34) via A17J2(48)	A11B(20)	Plug-In Reset (SCL-TTL). Signal from the plug-in. Line goes Low to reset the 5345. Same type of reset as front panel pushbutton reset ($\overline{\text{PB RST}}$).
$\overline{\text{PI SEL}}$	A10A(21)	A17J1(39) via A17J2(38)	Plug-In Select (SCL-TTL). A result of decoding the FUNCTION switch code on A11 (PLUG-IN position code). Enables plug-in measurements to be made.
$\text{PI} \bullet \overline{[\text{SIGN-}] + \overline{\text{PI}} \bullet [\text{CHK} + (\text{A-B}) \text{SW}]}$	A10A(16)	A14A(16)	(SCL-TTL). See Sheet 3M of Processor Flow Chart theory for description.
$\overline{\text{PI XMT}}$	A14A(12)	A13A(18), A15A(19), A17J1(5) via A17J2(55)	Plug-In Transmit (DCL-TTL). Goes Low to allow the plug-in to transmit data and decimal point into the DR via the bidirectional bus. Allows counter to input minus sign from plug-in by turning off internal sign circuit on A15.
PLUS	A13A(14)	A14A(14)	(DCL-TTL). A14 examines state of this line after a subtraction (all 16 digits) in A13. If line is High, subtraction was successful and another subtraction is attempted. If line is Low, DR was greater than NR (unsuccessful); contents of NR must be shifted one place and subtraction tried again. When Low (after 16-digit subtraction) contents of QMC shift into QR.

Table 8-1. Signal Line Descriptions and Destinations

MNEMONIC ABBREVIATIONS	CONNECTOR AND PINS		DESCRIPTION
	FROM	TO	
$\overline{\text{PROC BUSY}}$	A15B(8)	A11B(8), A17J1(32) via A17J2(52)	Processor Busy (DCL-TTL). Goes Low during process cycle. An indirect result of $\overline{\text{INIT PROC}}$. On A11, it causes circuits to select DRC codes for strobing data out of scalars. Inhibits plug-in from sending measurement data.
QMC CLK	A15A(15)	A13A(16)	Quotient Multiplier Counter Clock (CL-TTL). Goes High each time the Add/Subtract circuitry completes a successful subtraction (all 16 digits). The QMC totalizes these subtractions until an unsuccessful subtraction occurs. The count in QMC then shifts into the QR. Also pulses High to determine proper annunciator.
QR EN CLK	A15A(15)	A13A(17)	Quotient Register Enable Clock (DCL-TTL). Active during process cycle for purpose of entering each digit of measurement result into QR. Each time it goes High, it enables the QR counter to be clocked by REG CLK.
$\overline{\text{QMC = MULT STR}}$	A13A(15)	A14A(15)	Quotient Multiplier Counter Equals Multiplier Storage (DCL-TTL). Used when a remote multiplier (M, K, n, etc.) is programmed in the measurement. Even though the decimal point alignment may be correct, the decimal point may not be in the correct placement for the fixed multiplier. The decimal point is shifted and QMC is clocked until QMC equals MULT STR. When this occurs, this line goes Low and signifies that the decimal point and multiplier properly indicate the number's magnitude. The decimal point may be placed several digits away from the MSD.
$\overline{\text{QMC} = 0}$	A15A(14)	A13A(14)	Quotient Multiplier Counter Assign Zero (DCL-TTL). Resets the QMC to a count of zero.
$\text{QMC} = 0$	A13A(21)	A14A(21)	Quotient Multiplier Counter Equals Zero (DCL-TTL). Active High qualifier used to determine when the QM counter equals zero.
$\overline{\text{QMC} = 6}$	A13B(19)	A15B(19)	Quotient Multiplier Counter Equals Six (DCL-TTL). Active Low qualifier used in the multiplier selected routine to indicate that all multipliers have been examined for possible use. Forces processor to accept the last available multiplier.
$\overline{\text{QMC} = 9}$	A13B(2)	A14B(2)	Quotient Multiplier Counter Equals Nine (DCL-TTL). Active Low qualifier used to place result of START + STOP, Events, or RATIO in Giga units.

Table 8-1. Signal Line Descriptions and Destinations

MNEMONIC ABBREVIATIONS	CONNECTOR AND PINS		DESCRIPTION
	FROM	TO	
$\overline{QMC} = 10$	A13B(12)	A14B(12)	Quotient Multiplier Counter Equals 10 (DCL-TTL). An active Low qualifier in the divide routine. Indicates that NR contents are at least 10 times greater than DR contents. Causes the DR contents and decimal point to shift one place to the left.
QR EN A	A14A(12)	A13A(18), A15A(19), A17J1(5) via A17J2(55)	Quotient Register Enable (DCL-TTL). These lines carry a 3-line code used to control data transfer to and from the QR.
QR EN B	A15B(10)		
QR EN C	A15A(21)		
QR EN A/ \overline{PI} XMT	A14A(12)	A13A(18), A15A(19), A17J1(5) via A17J2(55)	Functionally, this line is considered two separate lines. See individual descriptions for each portion of line name.
$\overline{QR(QRC)} = \text{BLNK}$	A13A(9)	A14A(9)	Quotient Register (QR Counter) Equals Blank (DCL-TTL). Active Low qualifier. As the QR outputs the contents of its locations, this line goes Low to indicate blank codes.
RATIO + ST	A10B(16)	A9B(16)	Ratio or Start (SCL-ECL). Result of decoded ratio or start function code. Controls turn off of 500 MHz output of A8. Allows Channel B signal to accumulate counts in Time Scaler (A11).
REG CLK	A15B(4)	A13B(4)	Register Clock (CL-TTL). Clocks the RAM counters on A13 to shift data during process cycle. For one ROM cycle, number of pulses may be 16, 15, or 1.
\overline{RMT}	A12B(19)	A10B(19), A11B(19), A14B(19), A17J1(31) via A17J2(54)	Remote (SCL-TTL). When Low, places counter operation under remote programming control. Line causes A10 to select remote function codes; causes A11 to select remote gate time codes; causes A14 to select remote display position codes. Disables front panel FUNCTION switch reset, GATE TIME switch reset, and push-button RESET switch.
\overline{RMT} CHK	A12A(8)	A10A(5)	Remote Check (SCL-TTL). Combined on A10 with the remote function codes. Operational only when using remote function codes. Forces selection of A+B, regardless of ACCUM MODE START/STOP switch position. Causes TEST line to select 100 MHz test signal for measurement and turn off front panel input trigger circuits.

Table 8-1. Signal Line Descriptions and Destinations

MNEMONIC ABBREVIATIONS	CONNECTOR AND PINS		DESCRIPTION
	FROM	TO	
RMT DISP POS A RMT DISP POS B RMT DISP POS C RMT DISP POS D	A12B($\overline{11}$) A12B($\overline{12}$) A12B($\overline{8}$) A12B($\overline{13}$)	A14B(10) A14B(11) A14B($\overline{8}$) A14B(13)	Remote Display Position (SCL-TTL). When counter is remotely programmed, lines provide a 4-line code to select the desired display position.
RMT FUNC A RMT FUNC B RMT FUNC C	A12B(12) A12B(11) A12B($\overline{10}$)	A10B($\overline{12}$) A10B($\overline{11}$) A10B(10)	Remote Function (SCL-TTL). When counter is being remotely programmed, lines provide a 3-line code to program the desired operation mode (freq, period, TI, etc.). These lines are selected for use when $\overline{\text{RMT}}$ is Low. Code list is same as for FP FUNC (see Switch Schematic). Codes are decoded on A10 to provide several static control lines.
RMT GATE	A12A(12)	A10A($\overline{12}$)	Remote Gate (SCL-TTL). A remote program operation. When High, allows counter's gate time to be controlled by pulses on the GATE CONTROL jack. Performs same function as having switch position in EXT GATE.
RMT GT A RMT GT B RMT GT C RMT GT D	A12B(4) A12B(5) A12B(9) A12B(10)	A11B($\overline{4}$) A11B(5) A11B(9) A11B($\overline{10}$)	Remote Gate Time (SCL-TTL). When counter is being remotely programmed, lines provide a 4-line code to program the desired gate time (1s, 1 μ s, etc.). These lines are selected for use when $\overline{\text{RMT}}$ is Low and $\overline{\text{PROC BUSY}}$ and $\overline{\text{PI DISP POS/GT SEL}}$ are High. Code list is same as for FP GT (see Switch Schematic). Lines are decoded on A11 to enable one of the Time Scalers to output a 5 code.
$\overline{\text{RMT INH ARM}}$	A12A(15)	A11B($\overline{14}$)	Remote Inhibit Arm (DCL-TTL). An externally controlled line that prevents the counter from arming. Prevents the $\overline{\text{ARM}}$ line from going Low.
$\overline{\text{RMT LITE}}$	A12B(3)	A2P1(8)	Remote Light (SCL-TTL). Used to light the display's RMT lamp. Goes Low with the RMT line.
$\overline{\text{RMT MULT A}}$ $\overline{\text{RMT MULT B}}$ $\overline{\text{RMT MULT C}}$	A12B($\overline{21}$) A12B($\overline{22}$) A12B(20)	A13B(21) A13B(22) A13B(20)	Remote Multiplier (SCL-TTL). When counter is in remote operation, these lines provide a 4-line code to program the desired multiplier (K, M, n, etc.). These lines are selected for use when $\overline{\text{RMT}}$ is Low.
$\overline{\text{RMT RST}}$	A12B(13)	A11B($\overline{13}$)	Remote Reset (SCL-TTL). Externally programmed reset. When Low, provides same type of reset as the front panel RESET switch.
$\overline{\text{ROM CLK}}$	A15A(11)	A14A($\overline{11}$)	ROM Clock (DCL-TTL). Pulses Low to initiate a new ROM cycle. Causes the new ROM address codes stored in A14 to be shifted onto the ROM address lines (SV(T)).

Table 8-1. Signal Line Descriptions and Destinations

MNEMONIC ABBREVIATIONS	CONNECTOR AND PINS		DESCRIPTION
	FROM	TO	
$\overline{\text{RST}}$	A11B(4)	A14B(4), A17J1(38) via A14J2(40)	Reset (SCL-TTL). Goes Low with any type of manual reset, plug-in reset, or excessive gate time. Used to clear the present state ROM address codes on A14 and to set the address code to 001. Also, resets the plug-in circuits.
RST FRONT END	A15A($\overline{20}$)	A10A($\overline{20}$)	Reset Front End (DCL-TTL). A ROM command line generated near the end of the process cycle. Causes the scalers on A9 and A11 to reset and causes the Event Gate and Time Gate flip-flops to reset (A9). Line is not functional when counter is in START or STOP.
SAMPLE RATE	S6 via A4 & A5, A12A(11)	A11A(11)	This line connects the front panel SAMPLE RATE pot to the sample rate circuit on A11. This line can also be controlled remotely from A12. Controls the time between measurement cycles.
SAMPLE RATE ARM	A11A(10)	A10A($\overline{10}$)	(DCL-TTL). Used to initialize processor during totalize or when $\overline{\text{PI DATA}}$ is Low. Can be set High by rundown of sample rate, by $\overline{\text{PI ARM}}$, or by a reset.
SCH-O	A10A(13)	A9A($\overline{13}$)	Stop Channel Hold-Off (SCL-TTL). Used only in externally controlled time interval measurement to prevent Channel B pulses from stopping measurement. Controlled by $\overline{\text{GATE CONTROL}}$ signal when rear panel switch is set to EXT GATE. Controlled by RMT GATE line during remote operation.
SCLR RST	A10A(17)	A9A(14)	Scaler Reset (DCL-EECL). Resets Time and Events scalers on A9. Goes High with $\overline{\text{SET AUT SC}}$ line or RST FRONT END when $\overline{\text{ST+STP}}$ line is High.
$\overline{\text{SEC LITE}}$	A10A(10)	A2P1(9), A16(11)	Second Light (SCL-TTL). A result of decoding the FUNCTION switch codes on A10. Goes Low to light the display's SEC lamp.
$\overline{\text{SEL A} \cdot \text{B}}$	A17J1(18) via A17J2(32)	A10B(6)	Select A and B (SCL-TTL). Pulled Low from plug-in. Line is level shifted to EECL and sent to A9 as EXT AB. This signal enables the counter to use the plug-in's A and B channels for a measurement and also shuts off the main-frame's input trigger circuits.
$\overline{\text{SEL C}}$	A17J1(33) via A17J2(50)	A10B(21)	Select C (SCL-TTL). Controls state of EXT C line. Used when measuring events of Channel C signal occurring between Channel A pulse and Channel B pulse. Causes Time Scaler to accept Channel C signal instead of Time Base signal.

Table 8-1. Signal Line Descriptions and Destinations

MNEMONIC ABBREVIATIONS	CONNECTOR AND PINS		DESCRIPTION
	FROM	TO	
$\overline{\text{SER OUT}}$	A12A(4)	A14A(6)	Serial Out (SCL-TTL). A qualifier line that, when called upon, initiates the output data routine (a remote program operation). Set Low when counter is addressed to talk or when rear panel switch is set to TALK ALWAYS.
$\overline{\text{SET AUT SC}}$	A11B(17)	A10B(12), A13B(4), A15B(5)	Set Auto Single Cycle. Goes Low on 1) initial instrument turn-on, 2) with RESET switch when not in remote, 3) between settings of FUNCTION switch (except STOP/START) when not in remote, 4) with plug-in reset, or 5) with remote reset. Generates signals on A10 to reset the scalers on A9 and A11. Resets Noise Control F-F (A10), Asterisk Storage F-F (A15), Multiplier Storage flip-flops (A13), Measurement Done F-F (U12B), and the Event Gate and Time Gate flip-flops (A9) using the GATE RST line. Used to make a single automatic measurement while in manual mode, thereby recalculating the annunciator and decimal point.
$\overline{\text{SIGN-}}$	A15A(19)	A10A(18), A12A(17), A13A(17), A17J1(19) via A17J2(31)	Sign Minus (SCL-TTL). Combines with plug-in function code on A10 to indicate sign of plug-in data. Used in serial output routine of A12 to determine the sign of the data. When Low, instructs DR counter on A13 to supply additional DRC code to light display's minus sign.
$\overline{\text{ST+STP}}$	A10B(10)	A11B(10), A14B(9), A15B(9)	Start or Stop (SCL-TTL). Result of decoded start or stop function code. Permits oscillator noise to be generated in all functions when in EXT GATE. Bypasses Measurement Done F-F (A10) and allows sample rate to cause scaler scanning every 50 ms to update display.
SV1(T) SV2(T) SV3(T) SV4(T) SV5(T) SV6(T)	A14A(4) A14A(4) A14A(5) A14A(6) A14A(3) A14A(3)	A15A(4) A15A(4) A15A(5) A15A(6) A15A(3) A15A(3)	State Variable # (time) (DCL-TTL). Octal coded address lines for the ROMs (A15). Used with the MSB line and SV7(T). See A15 theory for further description.
SV7(T)	A14A(13)	A15A(13)	State Variable 7 (Time) (DCL-TTL). The state of this line is the result of the qualifier. Used as the LSB in the octal code that addresses the next ROM location. Determines the direction of the program flow, e.g., 740 or 741.
SV1(T+1) SV2(T+1) SV3(T+1) SV4(T+1) SV5(T+1) SV6(T+1)	A15A(10) A15A(7) A15A(5) A15A(8) A15A(8) A15A(7)	A14A(10) A14A(7) A14A(5) A14A(8) A14A(8) A14A(7)	State Variable # (Time plus one) (DCL-TTL). These lines are derived from the first group in each set of command lines (MSB=1). While MSB is still "1", the states of the lines are stored. The lines are coded in octal and are used to determine the next ROM location.

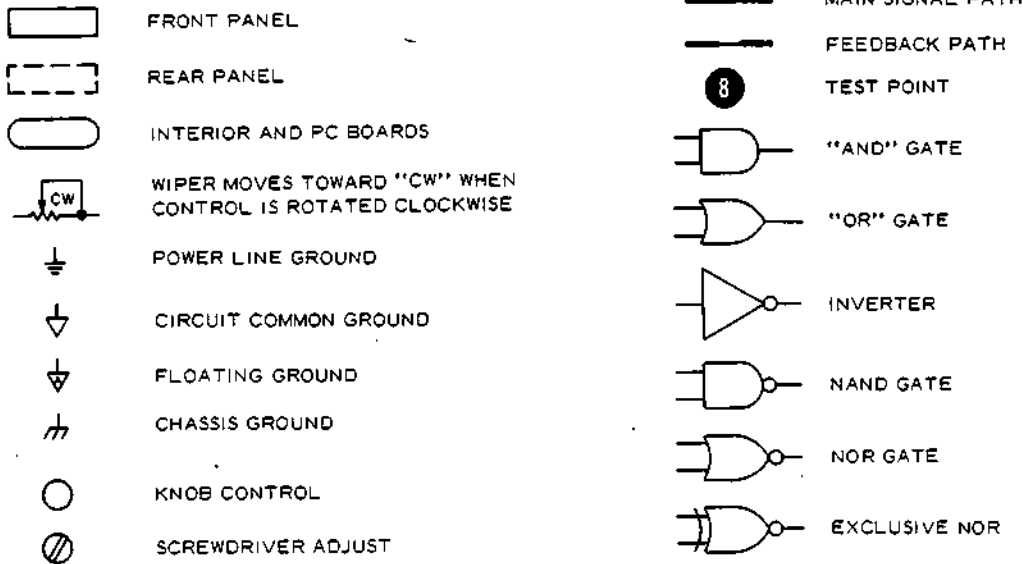
Table 8-1. Signal Line Descriptions and Destinations

MNEMONIC ABBREVIATIONS	CONNECTOR AND PINS		DESCRIPTION
	FROM	TO	
SV4(T+1)/DR EN B	A15A($\bar{8}$)	A13A(8), A14A(8)	This line is considered SV4(T+1) when MSB is "1" and DR EN B when MSB is "0". See separate descriptions for each portion of line name.
SV6(T+1)/NR EN A	A15A($\bar{7}$)	A13A($\bar{7}$), A14A(7)	This line is considered SV6(T+1) when MSB is "1" and NR EN A when MSB is "0". See separate descriptions for each portion of line name.
TEST	A10B(17)	A10B($\bar{17}$)	(SCL-TTL). Controlled by front panel check or remote check. If check is selected, line goes High and causes Events Scaler to accumulate 100 MHz counts.
TI + EVT	A10B($\bar{13}$)	A9B(14)	Time Interval or Events (SCL-EECL). Result of decoded function codes. Goes High during time interval mode or C channel events.
$\overline{\text{TI + EVT}}$	A10B(15)	A9B($\bar{15}$)	Time Interval or Events (SCL-EECL). Result of decoded function codes. Goes Low during time interval mode. Allows passage of Channel B signal to Event Gate F-F (A9) for stopping time interval.
$\overline{\text{TIME GATE}}$	A9B($\bar{18}$)	A10B(18)	(DCL-ECL). Goes Low when $\overline{\text{Time Gate F-F}}$ sets (A9). When $\overline{\text{TIME GATE}}$ and $\overline{\text{EVT GATE}}$ go High, starts process cycle by pulling $\overline{\text{INIT PROC}}$ line Low. In MIN gate time, goes Low to set Resolution F-F (A10) and stop measurement cycle.
$\overline{\text{TIME SCLR A}}$	A11B(1)	A13B(1), A10B($\bar{1}$)	Time Scaler (DL-TTL). At beginning of process cycle, these lines transfer Time Scaler data (in BCD) from A11. During the measurement time, A10 monitors the \bar{A} and \bar{D} lines to detect a 5 code.
$\overline{\text{TIME SCLR B}}$	A11B($\bar{1}$)	A13B(1)	
$\overline{\text{TIME SCLR C}}$	A11B(3)	A13B(3)	
$\overline{\text{TIME SCLR D}}$	A11B(2)	A13B(2), A10B($\bar{3}$)	
$\overline{\text{TIME SCLR A}_0}$	A9B($\bar{10}$)	A11B(6)	Time Scaler (DL-EECL). A four-line code from a divide-by-10 stage in the time scaler (A9). At the end of the gate time, this decade contains the least significant digit in the time count.
$\overline{\text{TIME SCLR B}_0}$	A9B($\bar{12}$)	A11B(7)	
$\overline{\text{TIME SCLR C}_0}$	A9B($\bar{13}$)	A11B(8)	
$\overline{\text{TIME SCLR D}_0}$	A9B($\bar{11}$)	A11B($\bar{7}$)	
TIME SCLR A1	A9B($\bar{22}$)	A11B(22)	Time Scaler A1 (SL-ECL). A derivative of the 500 MHz clock signal, or plug-in Channel C signal, or Channel B signal (ratio or start). Has been divided-by-20 in A9 scaler before being sent to remainder of scalars on A11. Complement of $\overline{\text{TIME SCLR A1}}$.

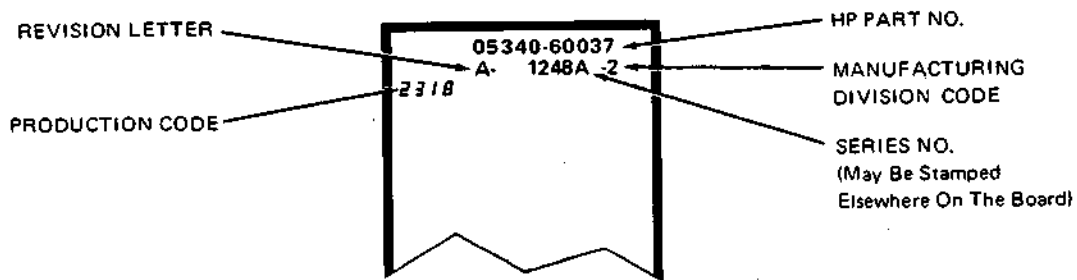
Table 8-1. Signal Line Descriptions and Destinations

MNEMONIC ABBREVIATIONS	CONNECTOR AND PINS		DESCRIPTION
	FROM	TO	
<u>TIME SCLR A1</u>	A9B(21)	A11B(21)	Time Scaler (SL-ECL). A derivative of the 500 MHz clock signal, or plug-in Channel C signal, or Channel B signal (ratio or start). Has been divided by 20 in A9 scaler before being sent to remainder of scalers on A11. Complement of TIME SCLR A1.
<u>TRANS MULT</u>	A17J1(37) via A17J2(42)	A10A(19)	Transpose Multiplier (DCL-TTL). When Low, causes the normal output multiplier to be changed. For data normally expressed in Giga units, the multiplier is changed to nano and vice-versa.
WORD DBL CLK	A15A(21)	A13A(18)	Word Doubling Clock (DCL-TTL). Used to store ROM program codes while MSB is equal to "1". Pulses High for each ROM cycle. Also used to set initial conditions of Add/Subtract circuit on A13.
<u>WORD DBL CLK</u>	A15A(18)	A14A(21)	Word Doubling Clock (DCL-TTL). Used to store ROM program codes while MSB is equal to "1". Pulses Low during each ROM cycle. Used to clock newly generated SV(T+1) lines into storage (A14) for use in next ROM cycle.
<u>XS GT RST INH/N DATA</u>	A10B(22), A17J1(26) via A17J2(64)	A11B(18), A14B(2)	Excessive Gate Time Reset Inhibit/N Data (DCL-TTL). A time shared control line. First portion of line name is active when GATE CONTROL switch is set to EXT GATE. Inhibits counter from resetting itself under excessive gate time conditions. N DATA portion is active Low when plug-in is able to send an "N" to the mainframe.
10 MHz INT CLK	A18A(1, 1)	A8A(1, 1)	10 MHz Internal Clock (CL-TTL). A 10 MHz signal produced by A18 oscillator. Converted to 500 MHz in A8 for use as time base signal. Converted to 100 MHz in A8 for use as a test signal in the CHECK mode.
100 MHz TEST	A8B(2)	A9B(5)	(SL-EECL). Derived from 10 MHz oscillator signal. Used as test signal in the CHECK mode.
<u>500 MHz OFF</u>	A9B(13)	A8B(4)	(SCL). Set Low by RATIO+ST line or EXT C line. Turns off 500 MHz oscillator output of A8 (on = +2V, off = -2V).

SYMBOLS



PRINTED CIRCUIT BOARD IDENTIFICATION



REFERENCE DESIGNATIONS

REFERENCE DESIGNATIONS WITHIN ASSEMBLIES ARE ABBREVIATED. ADD ASSEMBLY NUMBER TO ABBREVIATION FOR COMPLETE DESCRIPTION. JACKS ARE THE STATIONARY CONNECTORS AND PLUGS ARE THE MORE MOVEABLE OF TWO CONNECTORS.

ASSEMBLY	ABBREVIATION	COMPLETE DESCRIPTION
A25	C1	A25C1
A25A1	CR1	A25A1CR1
NO PREFIX	J3	J3

COMPONENT PLACEMENT

△ OR □

IDENTIFIES:

- Pin 1 of dip and flat-pack IC's.
- Tab of TO cases.
- + side of electrolytic capacitors.
- Pin 1 of resistor packs.
- Cathode of diodes.
- Section 1 of dip switches.

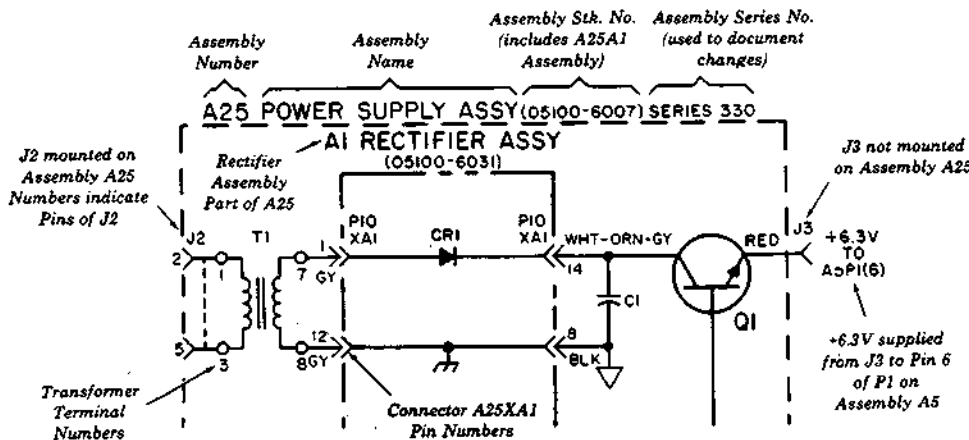


Figure 8-1. Schematic Diagram Notes

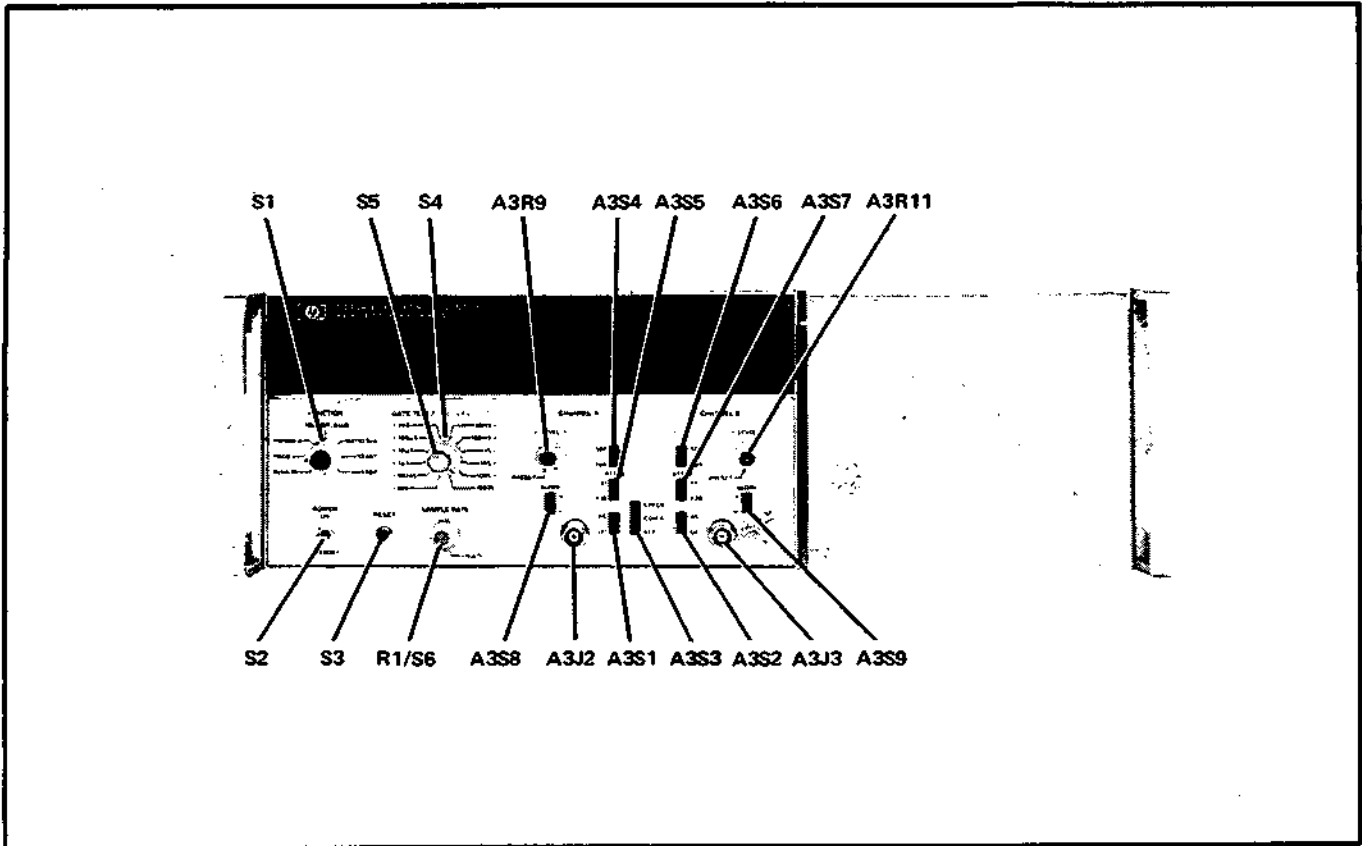


Figure 8-2. Front Panel Designations

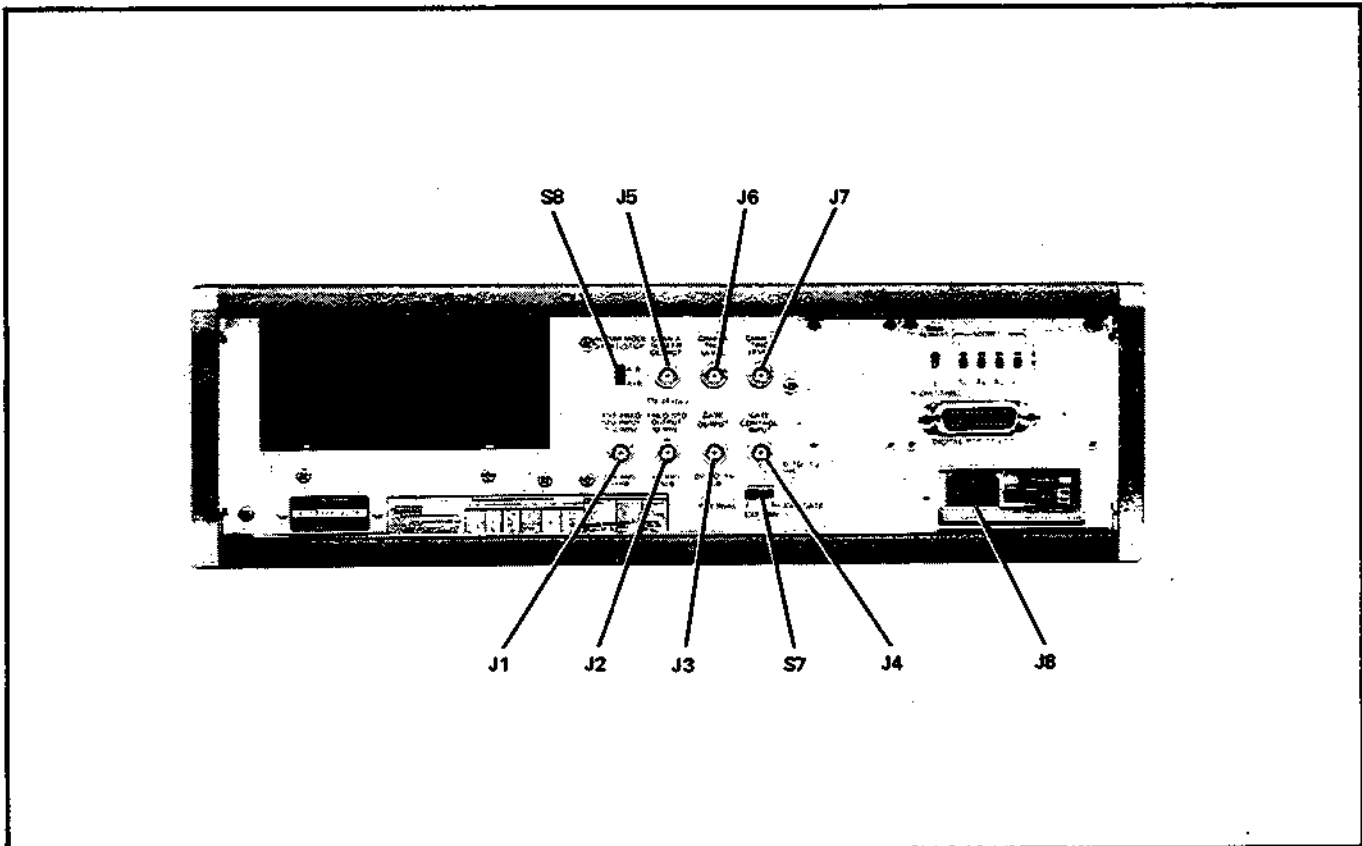


Figure 8-3. Rear Panel Designations

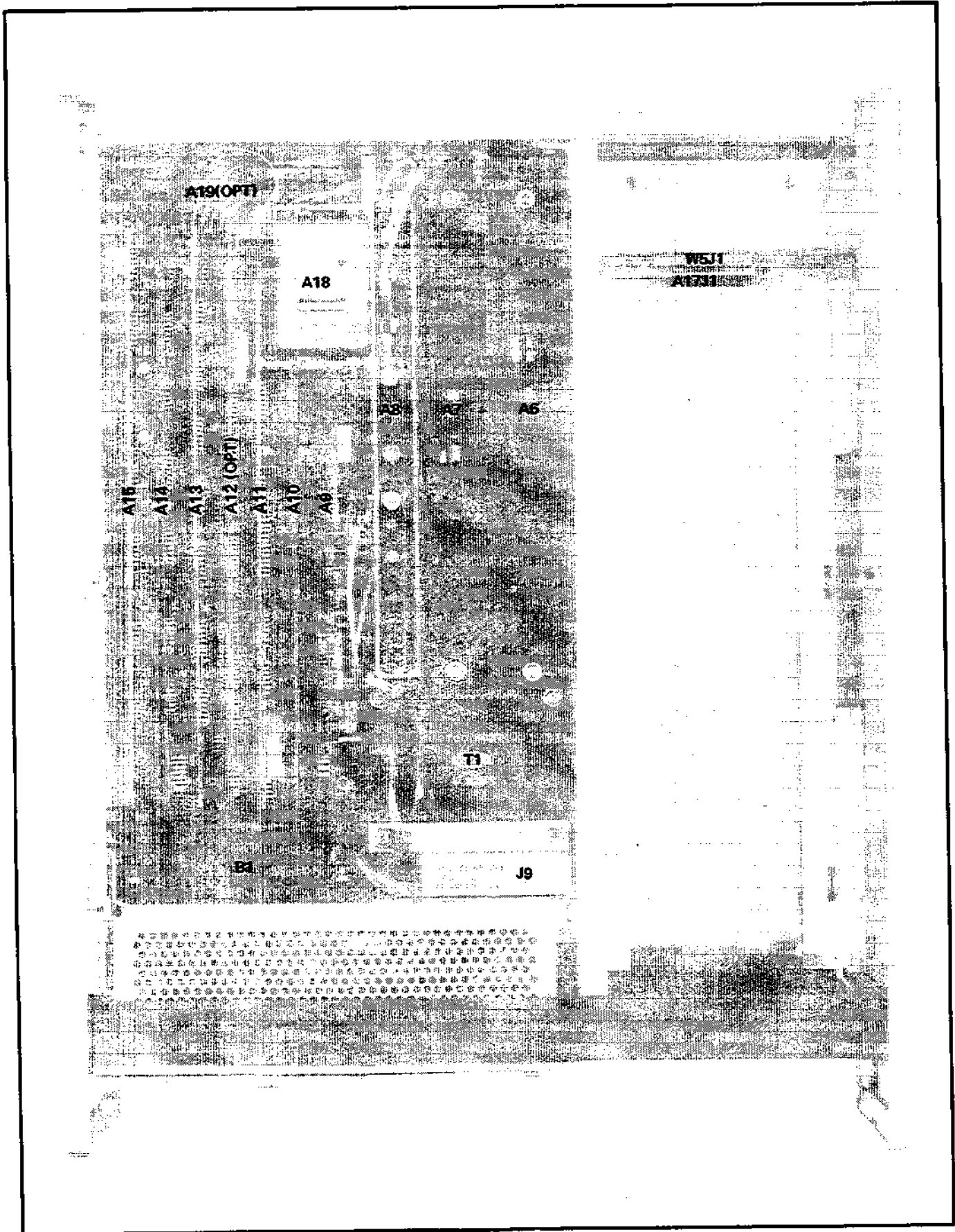


Figure 8-4. Top Internal View

Figure 8-5
OVERALL BLOCK DIAGRAM

(See Page 8-25)

HP 5345A
Schematic Diagram

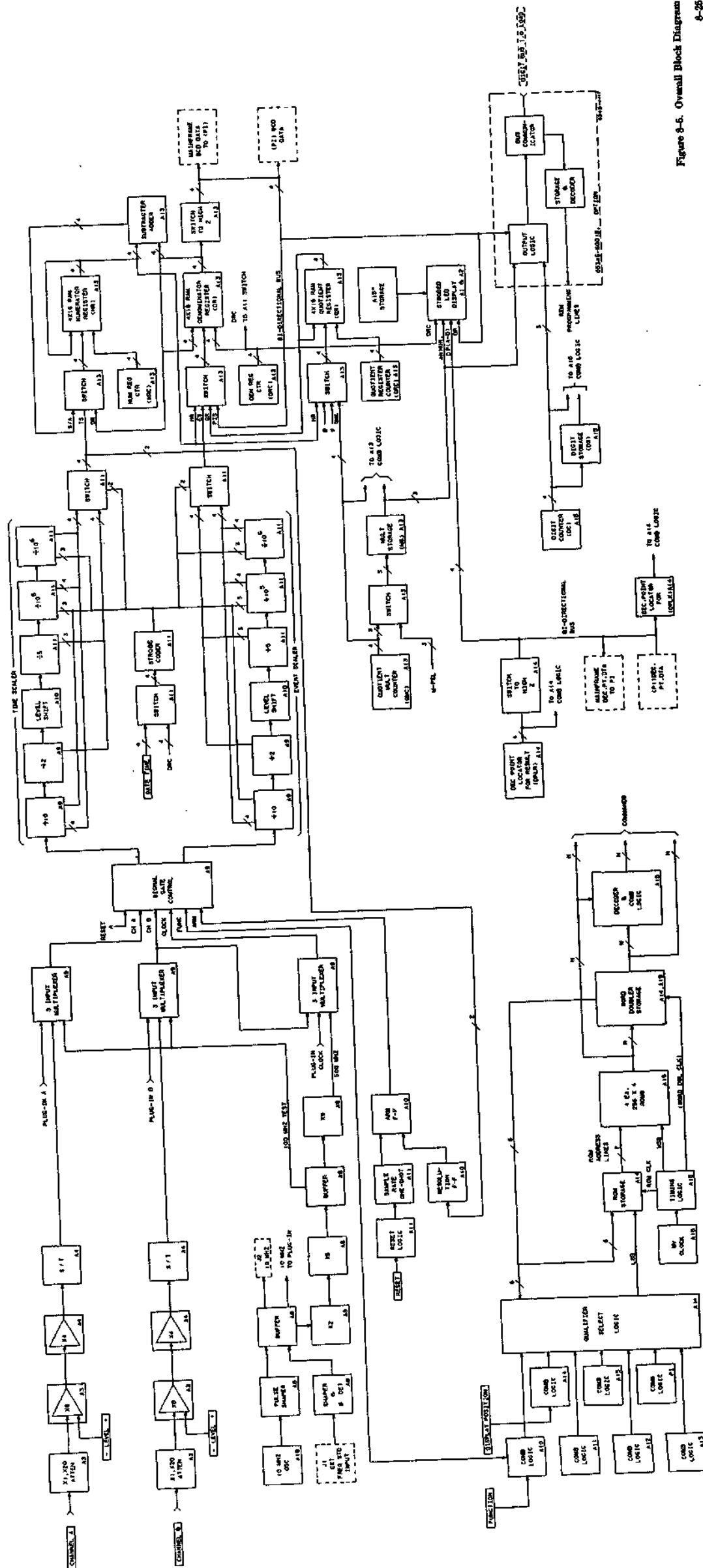
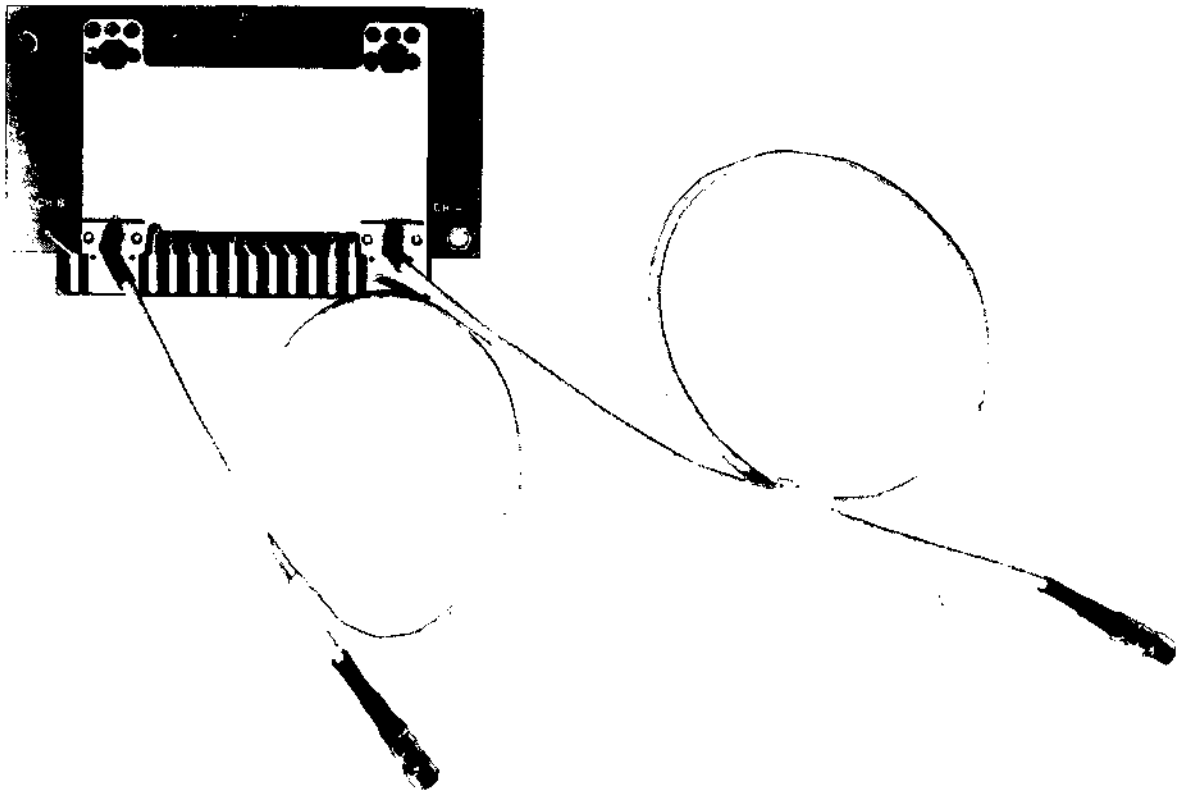
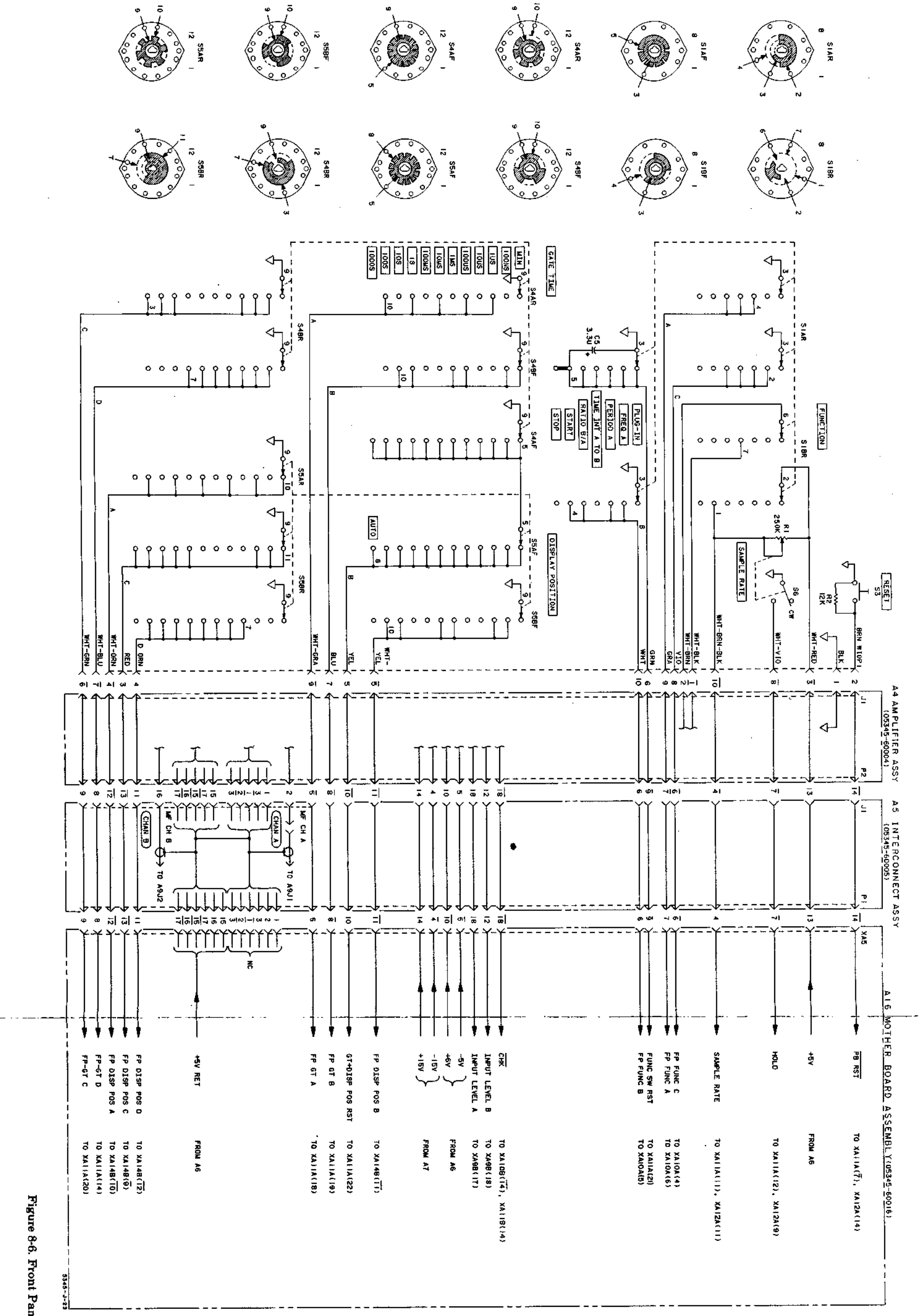


Figure 8-6. Overall Block Diagram
8-25

A5





- NOTES
1. REFERENCE DESIGNATIONS WITHIN THIS ASSEMBLY ARE ABBREVIATED. ADD ASSEMBLY NUMBER TO ABBREVIATION FOR COMPLETE DESCRIPTION.
 2. UNLESS OTHERWISE INDICATED: RESISTANCE IN OHMS; CAPACITANCE IN PICOFARADS; INDUCTANCE IN MICROHENRIES.
 3. ROTARY SWITCH WAFERS ARE SHOWN FROM FRONT PANEL VIEW.
 4. SWITCH CODES ARE: 1= OPEN CIRCUIT AND OR CONNECTION.

FUNCTION SWITCH

FUNCTION	CODE
C B A	
PLUG IN	0 1 1
FREQ A	0 0 1
PERIOD A	0 0 0
TIME INT A TO B	0 1 0
RATIO B/A	1 0 0
START	1 0 1
STOP	1 1 1

NOT SELECTABLE FROM FRONT PANEL-CAN BE FROM PLUG-IN OR REMOTE. INTENDED FOR 3-CHANNEL TIME INTERVALS; I.E., INDICATE NO. OF INPUTS ON 'C' BETWEEN A & B

GATE TIME	DISPLAY POSITION
C B A	0 C B A
1 0 1	1 0 1 0
0 0 1	1 0 0 1
0 0 0	1 0 0 0
0 0 1	1 0 0 0
0 1 0	0 1 1 1
0 1 0	0 1 1 0
0 1 1	0 1 0 1
0 1 1	0 1 0 0
0 1 0	0 0 1 1
0 1 0	0 0 1 0
1 0 0	0 0 0 1
1 0 0	0 0 0 0
1 0 1	1 0 0 0
1 0 1	1 0 0 0

REFERENCE DESIGNATIONS

NO	PREFIX
C5	R2
SI-6	

Figure 8-6. Front Panel Switch Wiring Part of A4/A5/A16

ANNUNCIATOR DECODING

A1U1 INPUTS →	A	B	C	D
SIGNAL LINES →	NANO MULT	MS C	MS B	MS A
ANNUNCIATORS				
G	0	0	0	0
M	0	0	0	1
K	0	0	1	0
BLANK	0	0	1	1
m	0	1	0	0
μ	0	1	0	1
n	0	1	1	0
μ	0	1	1	1
n	1	0	0	0
μ	1	0	0	1
m	1	0	1	0
BLANK	1	0	1	1
K	1	1	0	0
M	1	1	0	1
G	1	1	1	0
M	1	1	1	1

Figure 8-6
FRONT PANEL SWITCH WIRING PART OF A4/A5/A16

(See page 8-27)

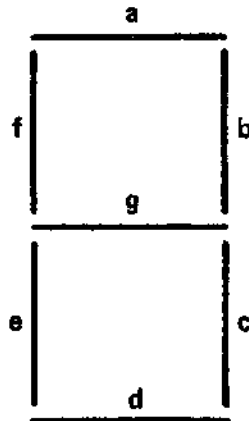
**A2U6
TRUTH TABLE**

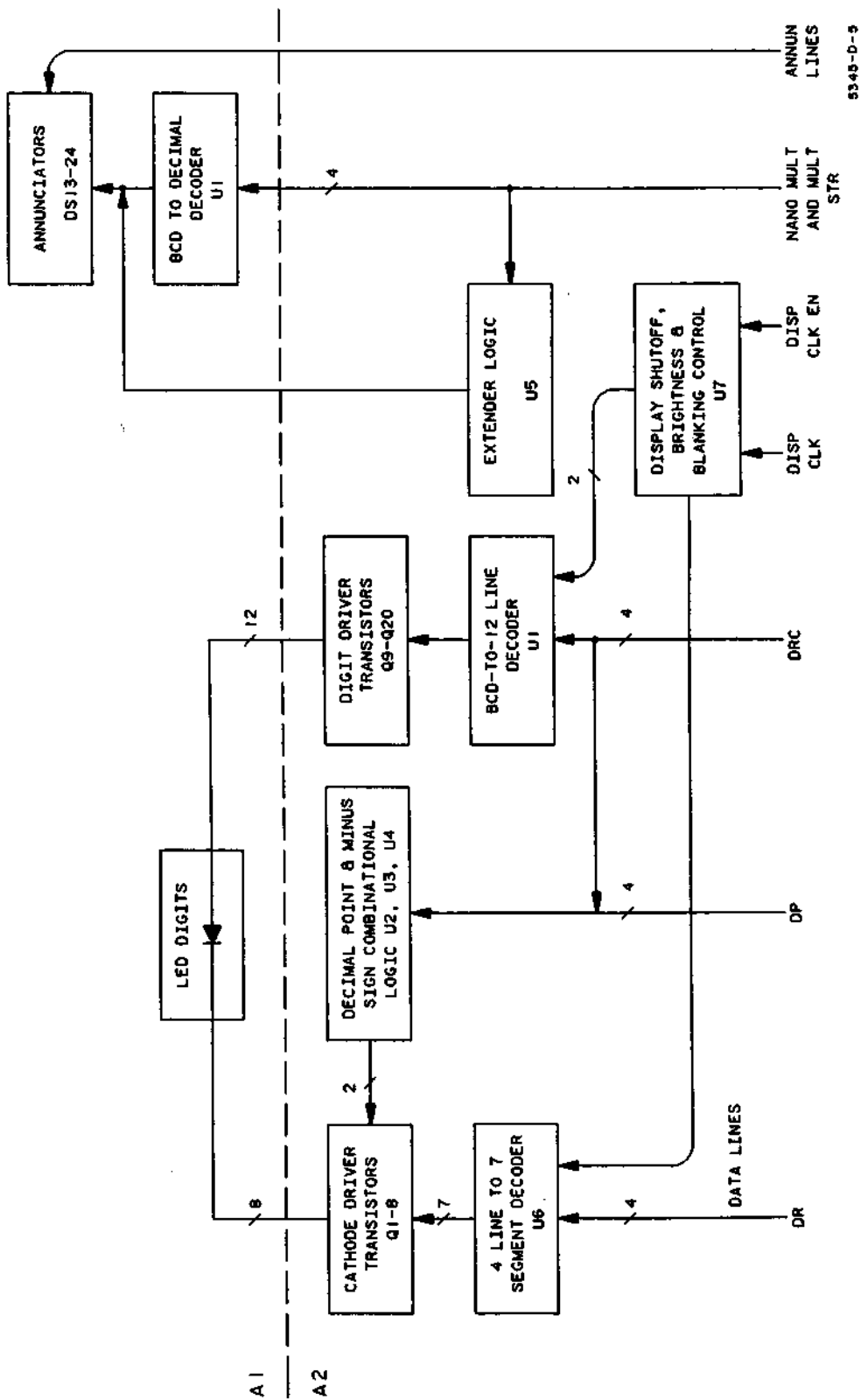
$\overline{\text{LT}}$	$\overline{\text{RB}}$ IN	A	B	C	D	a	b	c	d	e	f	g	$\overline{\text{RB}}$ OUT	
L	X	X	X	X	X	H	H	H	H	H	H	H	H	
H	L	L	L	L	L	L	L	L	L	L	L	L	L	0
H	H	L	L	L	L	H	H	H	H	H	H	L	H	0
	X	H	L	L	L	L	H	H	L	L	L	L	H	1
		L	H	L	L	H	H	L	H	H	L	H	H	2
		H	H	L	L	H	H	H	H	L	L	H	H	3
		L	L	H	L	L	H	H	L	L	L	H	H	4
		H	L	H	L	H	L	H	H	L	H	H	H	5
		L	H	H	L	H	L	H	H	H	H	H	H	6
		H	H	H	L	H	H	H	L	L	L	L	H	7
		L	L	L	H	H	H	H	H	H	H	H	H	8
		H	L	L	H	H	H	H	H	L	H	H	H	9
		L	H	L	H	L	L	L	H	H	L	H	H	10
		H	H	L	H	L	L	H	H	L	L	H	H	11
		L	L	H	H	L	H	H	L	L	H	H	H	12
		H	L	H	H	H	L	H	H	L	H	H	H	13
		L	H	H	H	L	L	L	H	H	H	H	H	14
H	X	H	H	H	H	L	L	L	L	L	L	L	H	15

H = HIGH Voltage Level

L = LOW Voltage Level

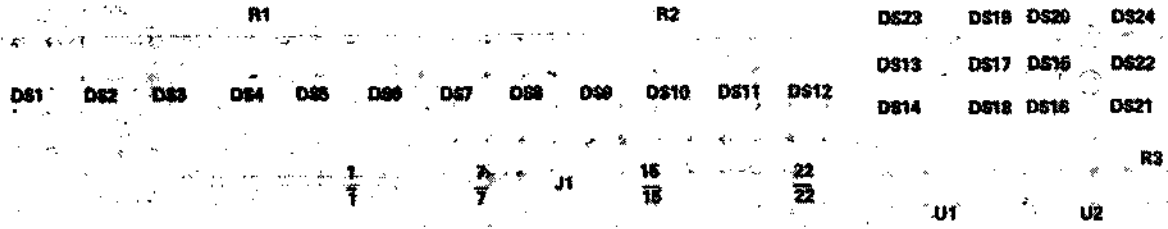
X = Either HIGH or LOW Voltage Level



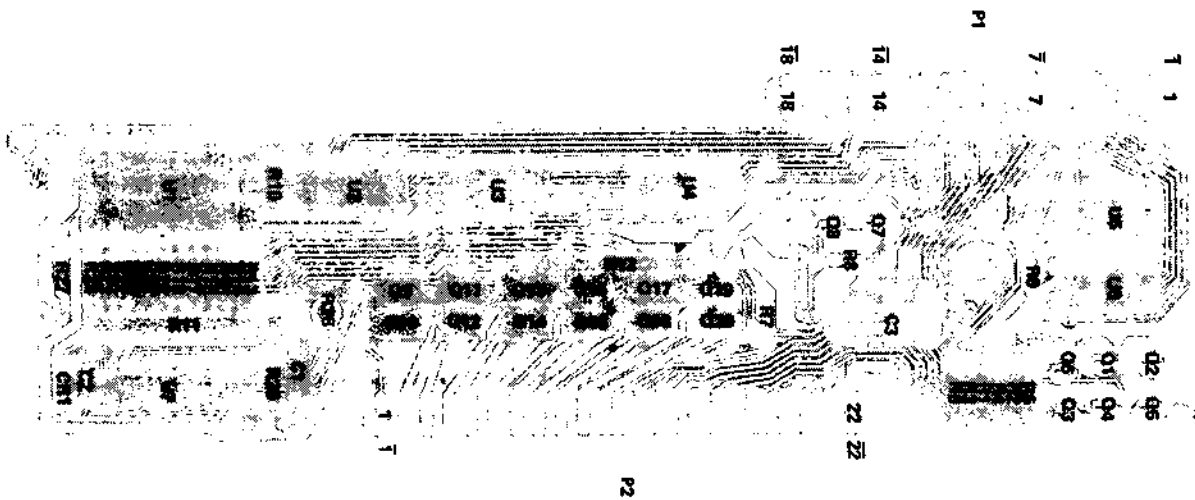


5345-D-9

A1



A2



HP 6345A
Schematic Diagram

- NOTES
1. COMPONENTS INDICATED WITHIN THIS ASSEMBLY ARE ASSUMED TO BE THE STANDARD ISSUE UNLESS OTHERWISE SPECIFIED.
 2. UNLESS OTHERWISE SPECIFIED, CAPACITORS ARE IN MICROFARADS.
 3. (01) THROUGH (012) ARE ALL CATHODE DRIVER ASSEMBLY (TYPE 0001) AND ARE SOCKET MOUNTED.

REFERENCE DESIGNATIONS

NO.	SYMBOL	AI	A2	AME
01	CR	CR-04	CR	CR
		CR-05	CR	CR
		CR-06	CR	CR
		CR-07	CR	CR
		CR-08	CR	CR
		CR-09	CR	CR
		CR-10	CR	CR
		CR-11	CR	CR
		CR-12	CR	CR
		CR-13	CR	CR
		CR-14	CR	CR
		CR-15	CR	CR
		CR-16	CR	CR
		CR-17	CR	CR
		CR-18	CR	CR
		CR-19	CR	CR
		CR-20	CR	CR
		CR-21	CR	CR
		CR-22	CR	CR
		CR-23	CR	CR
		CR-24	CR	CR
		CR-25	CR	CR
		CR-26	CR	CR
		CR-27	CR	CR
		CR-28	CR	CR
		CR-29	CR	CR
		CR-30	CR	CR
		CR-31	CR	CR
		CR-32	CR	CR
		CR-33	CR	CR
		CR-34	CR	CR
		CR-35	CR	CR
		CR-36	CR	CR
		CR-37	CR	CR
		CR-38	CR	CR
		CR-39	CR	CR
		CR-40	CR	CR
		CR-41	CR	CR
		CR-42	CR	CR
		CR-43	CR	CR
		CR-44	CR	CR
		CR-45	CR	CR
		CR-46	CR	CR
		CR-47	CR	CR
		CR-48	CR	CR
		CR-49	CR	CR
		CR-50	CR	CR
		CR-51	CR	CR
		CR-52	CR	CR
		CR-53	CR	CR
		CR-54	CR	CR
		CR-55	CR	CR
		CR-56	CR	CR
		CR-57	CR	CR
		CR-58	CR	CR
		CR-59	CR	CR
		CR-60	CR	CR
		CR-61	CR	CR
		CR-62	CR	CR
		CR-63	CR	CR
		CR-64	CR	CR
		CR-65	CR	CR
		CR-66	CR	CR
		CR-67	CR	CR
		CR-68	CR	CR
		CR-69	CR	CR
		CR-70	CR	CR
		CR-71	CR	CR
		CR-72	CR	CR
		CR-73	CR	CR
		CR-74	CR	CR
		CR-75	CR	CR
		CR-76	CR	CR
		CR-77	CR	CR
		CR-78	CR	CR
		CR-79	CR	CR
		CR-80	CR	CR
		CR-81	CR	CR
		CR-82	CR	CR
		CR-83	CR	CR
		CR-84	CR	CR
		CR-85	CR	CR
		CR-86	CR	CR
		CR-87	CR	CR
		CR-88	CR	CR
		CR-89	CR	CR
		CR-90	CR	CR
		CR-91	CR	CR
		CR-92	CR	CR
		CR-93	CR	CR
		CR-94	CR	CR
		CR-95	CR	CR
		CR-96	CR	CR
		CR-97	CR	CR
		CR-98	CR	CR
		CR-99	CR	CR
		CR-100	CR	CR

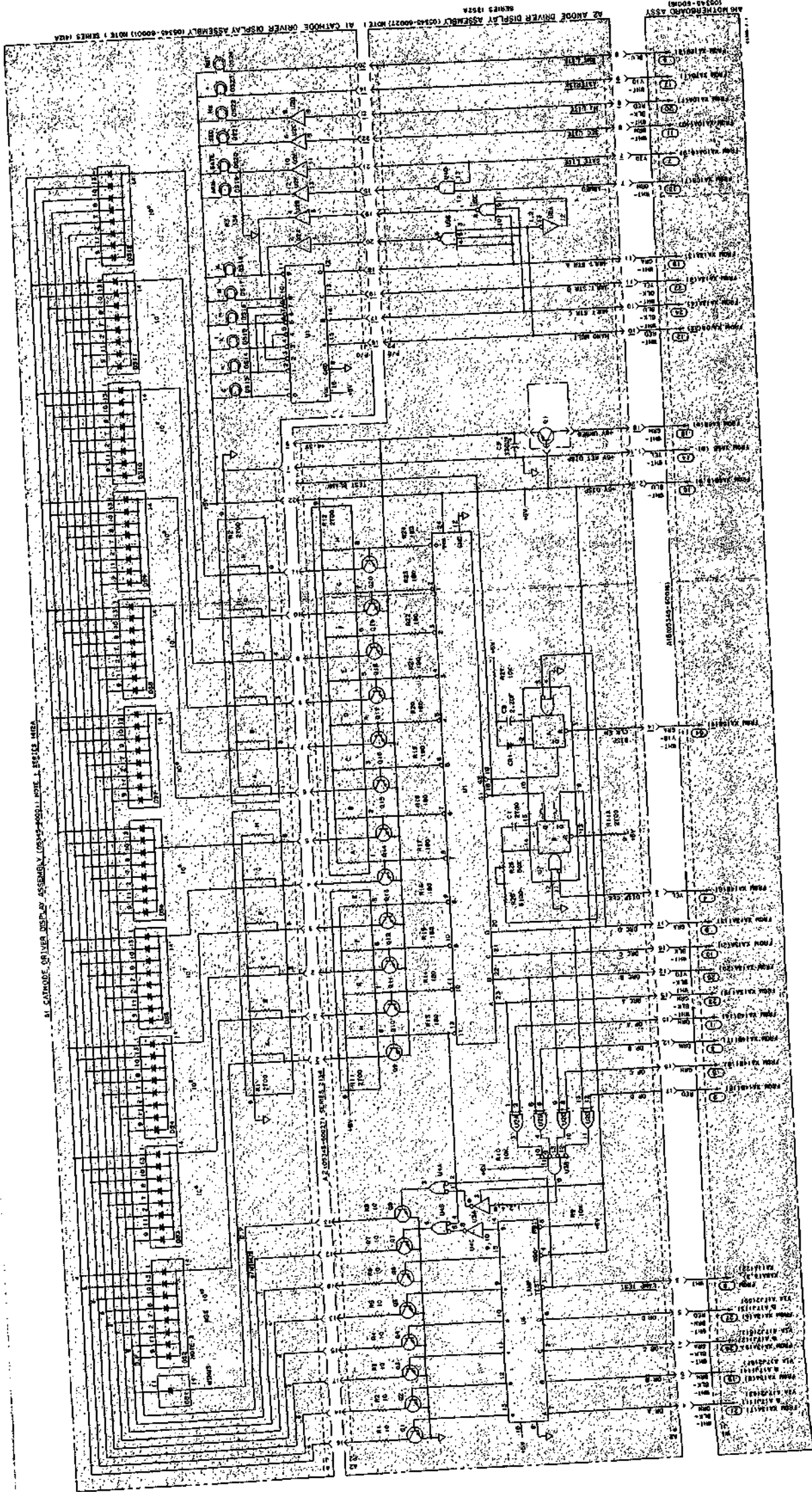


Figure 8-7. A1 Cathode Driver Display Assembly,
A2 Cathode Driver Display Assembly

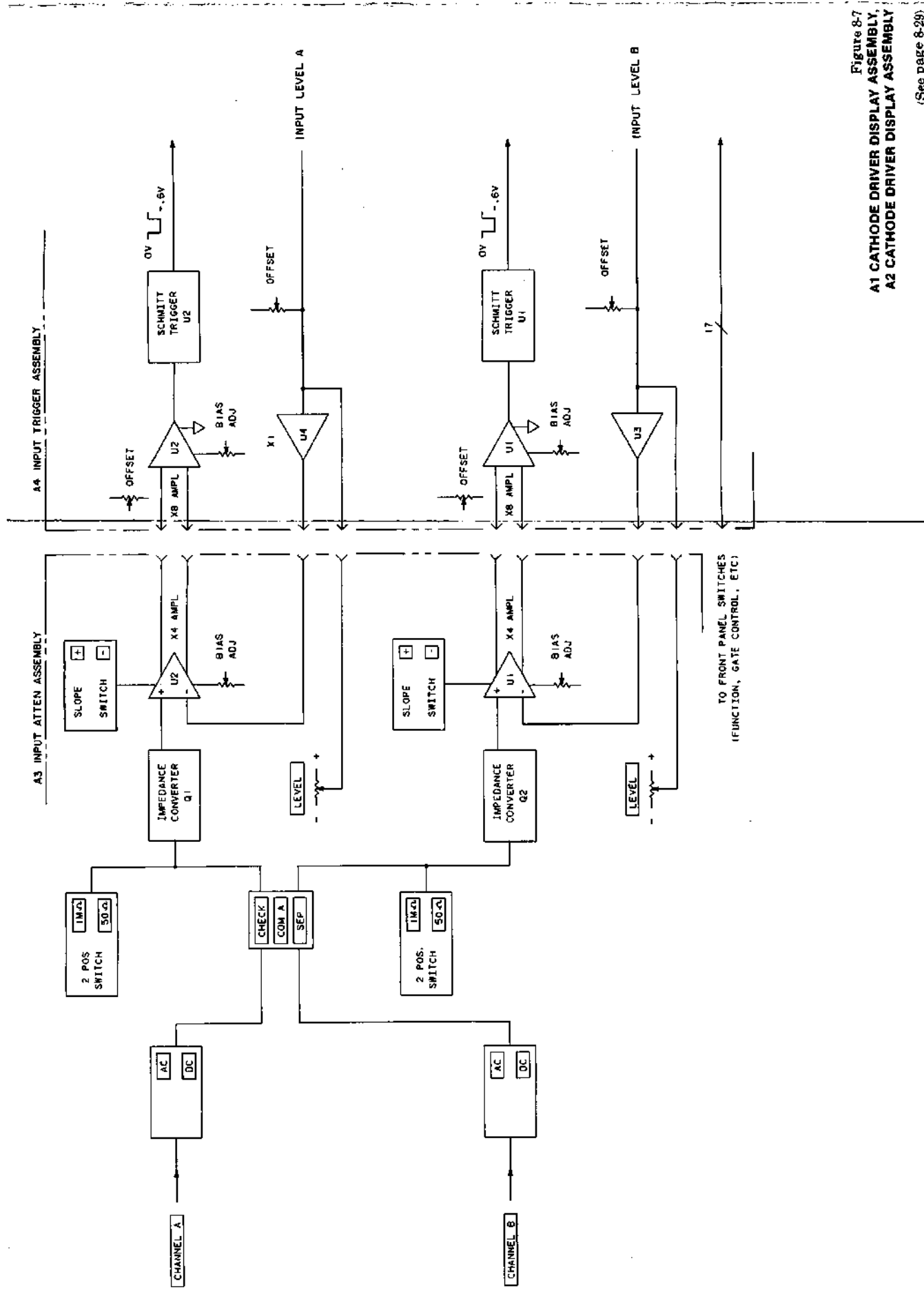
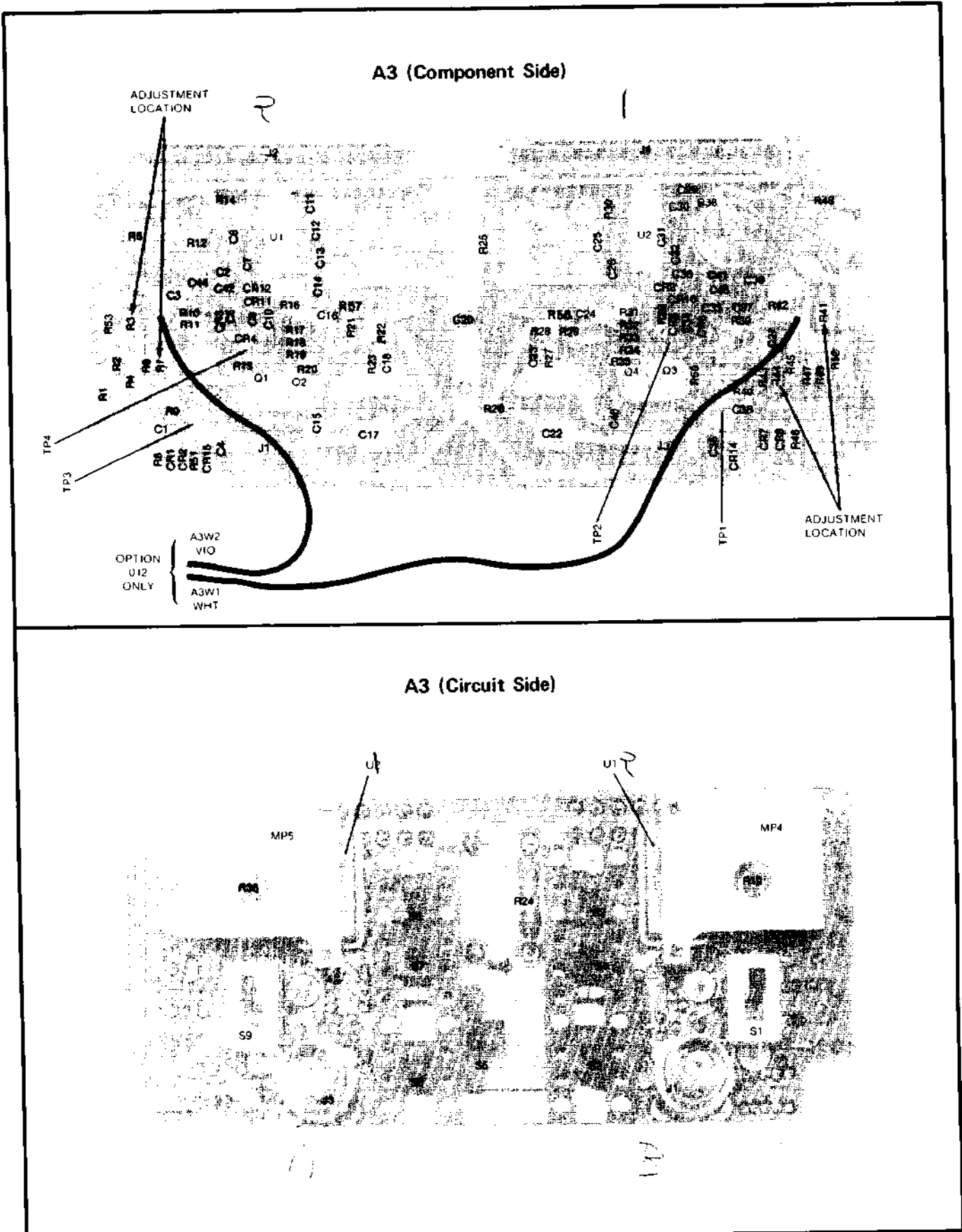


Figure 8-7
 A1 CATHODE DRIVER DISPLAY ASSEMBLY
 A2 CATHODE DRIVER DISPLAY ASSEMBLY
 (See page 8-29)

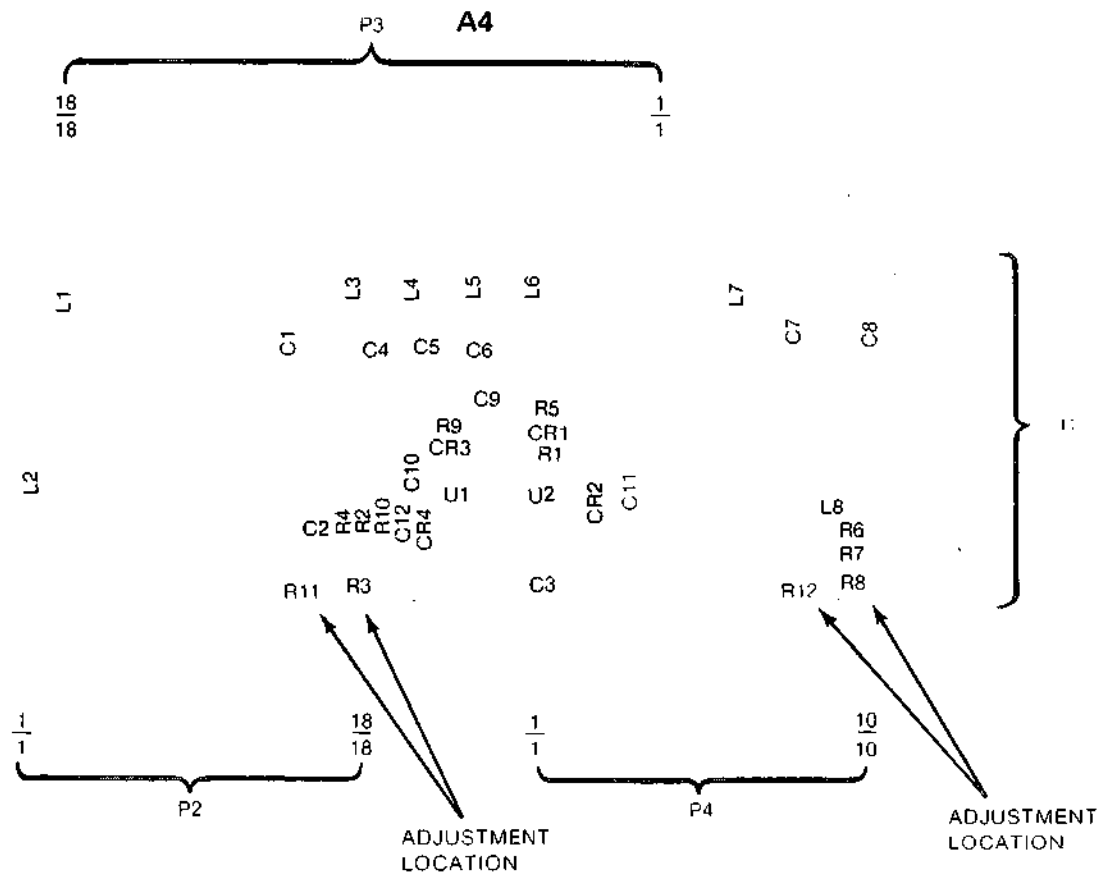


Part of Figure 8-8. A3 Input Attenuator Assembly (Series 2420), A4 Input Trigger Assembly (Series 2316)



Figure 8-8
A3 INPUT ATTENUATOR ASSEMBLY 05345-60238 (SERIES 2420)
A4 INPUT TRIGGER ASSEMBLY 05345-60124 (SERIES 2316)

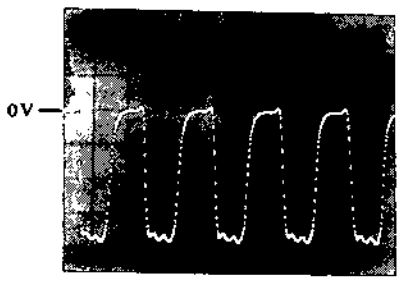
(See page 8-31)



Equipment: 180A with 1810A

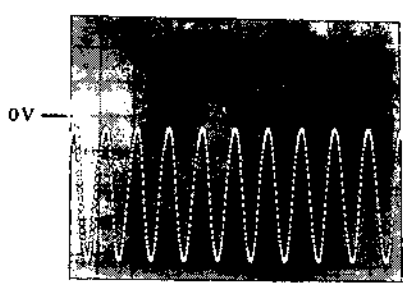
Schmitt trigger output taken from A5 cable, using BNC-to-subminiature adaptor, part number 1250-0831.

Figure 1.
(100 MHz)



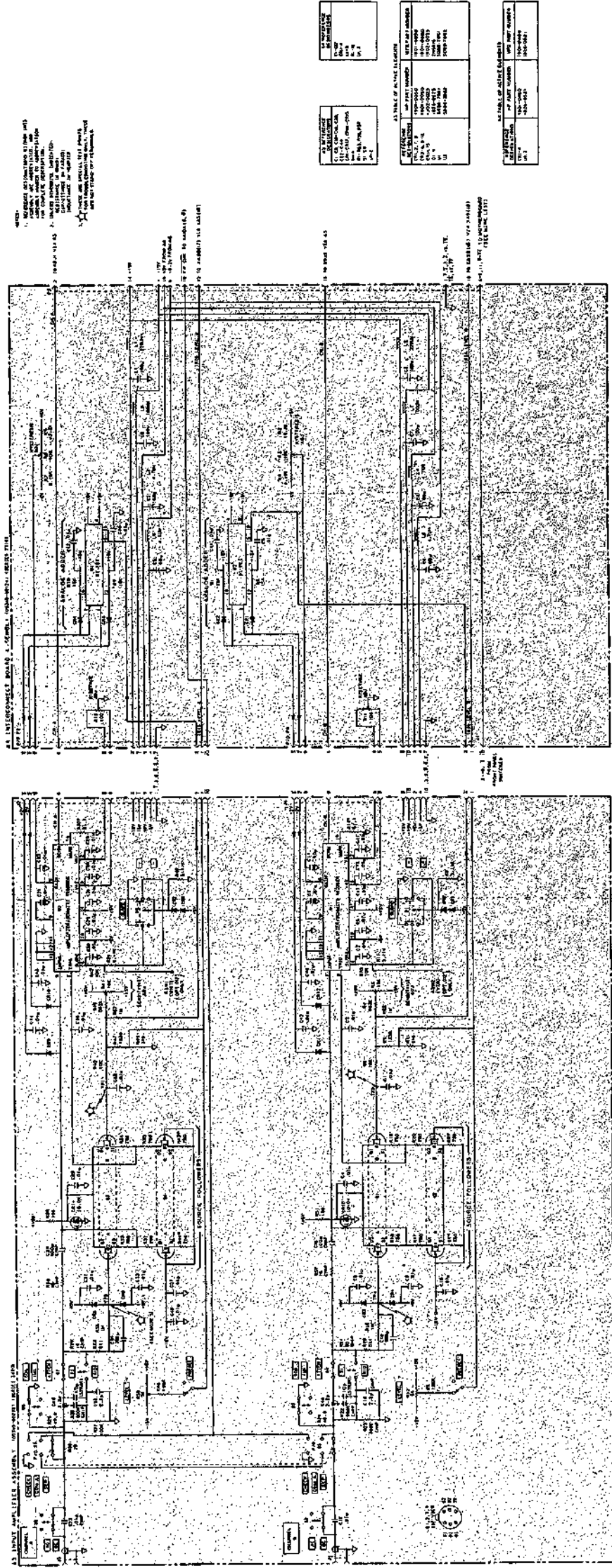
200 mV/DIV,
5 nS/DIV, + SLOPE,
EXPANDED

Figure 2.
(500 MHz)



200 mV/DIV,
2 nS/DIV, + SLOPE,
EXPANDED

HP 8346A
Schematic Diagrams



NOTE
 SEE FIGURE 9-9a, on next page, for A3 Option 012.

Figure 8-8. A3 Input Attenuator Assembly 06345-60238 (Series 2420)
 A1 Input Trigger Assembly 06345-60124 (Series 2316)

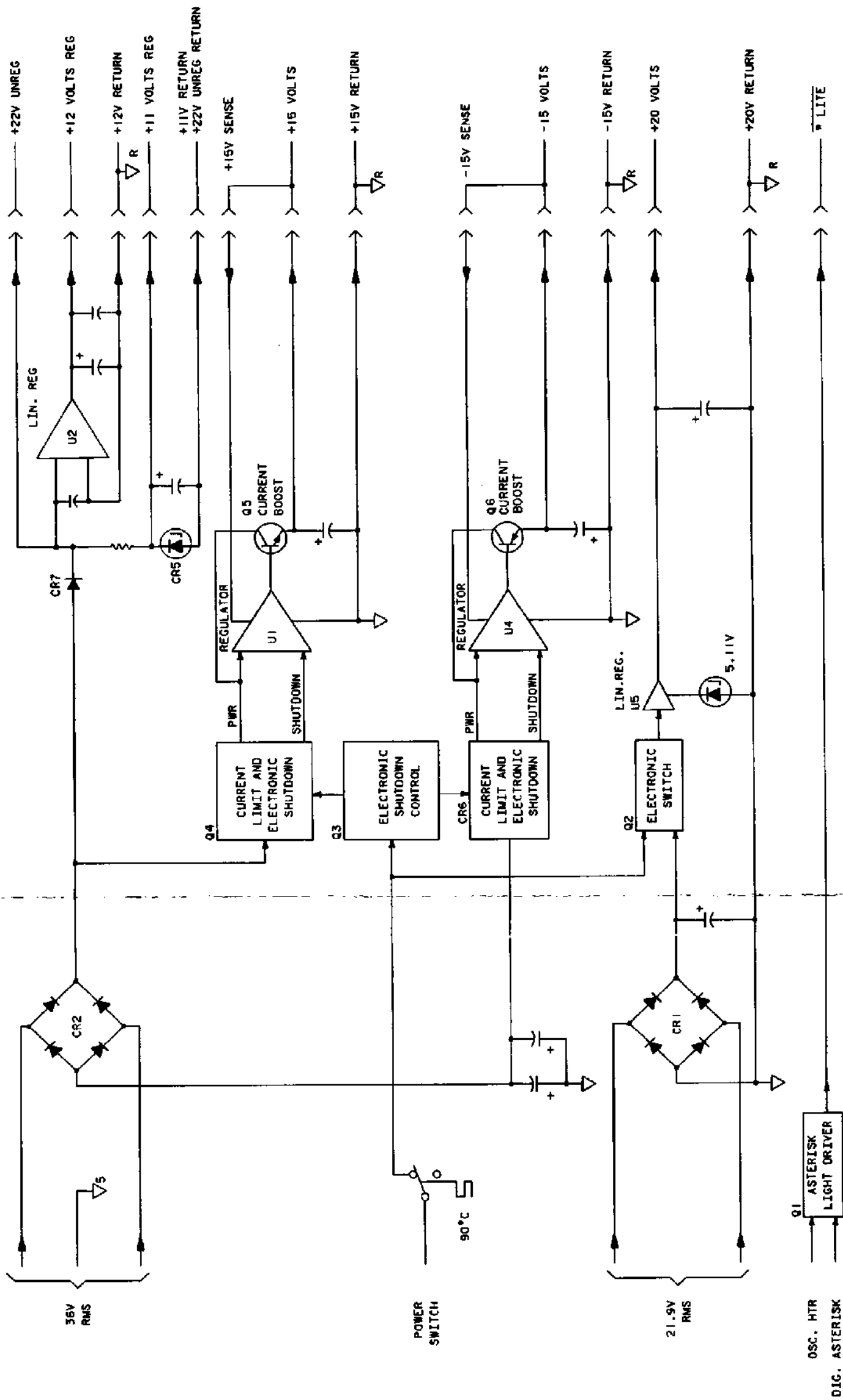
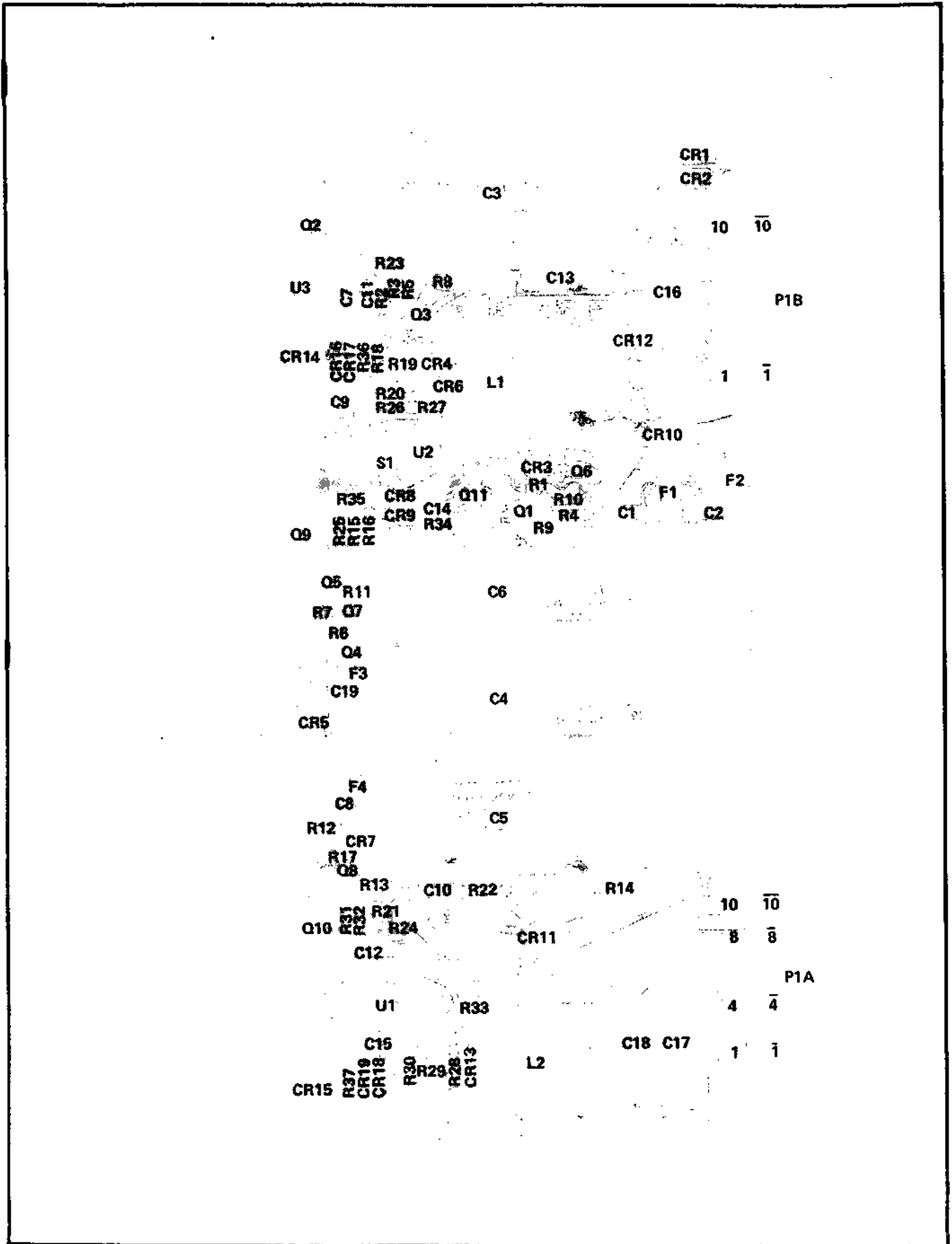
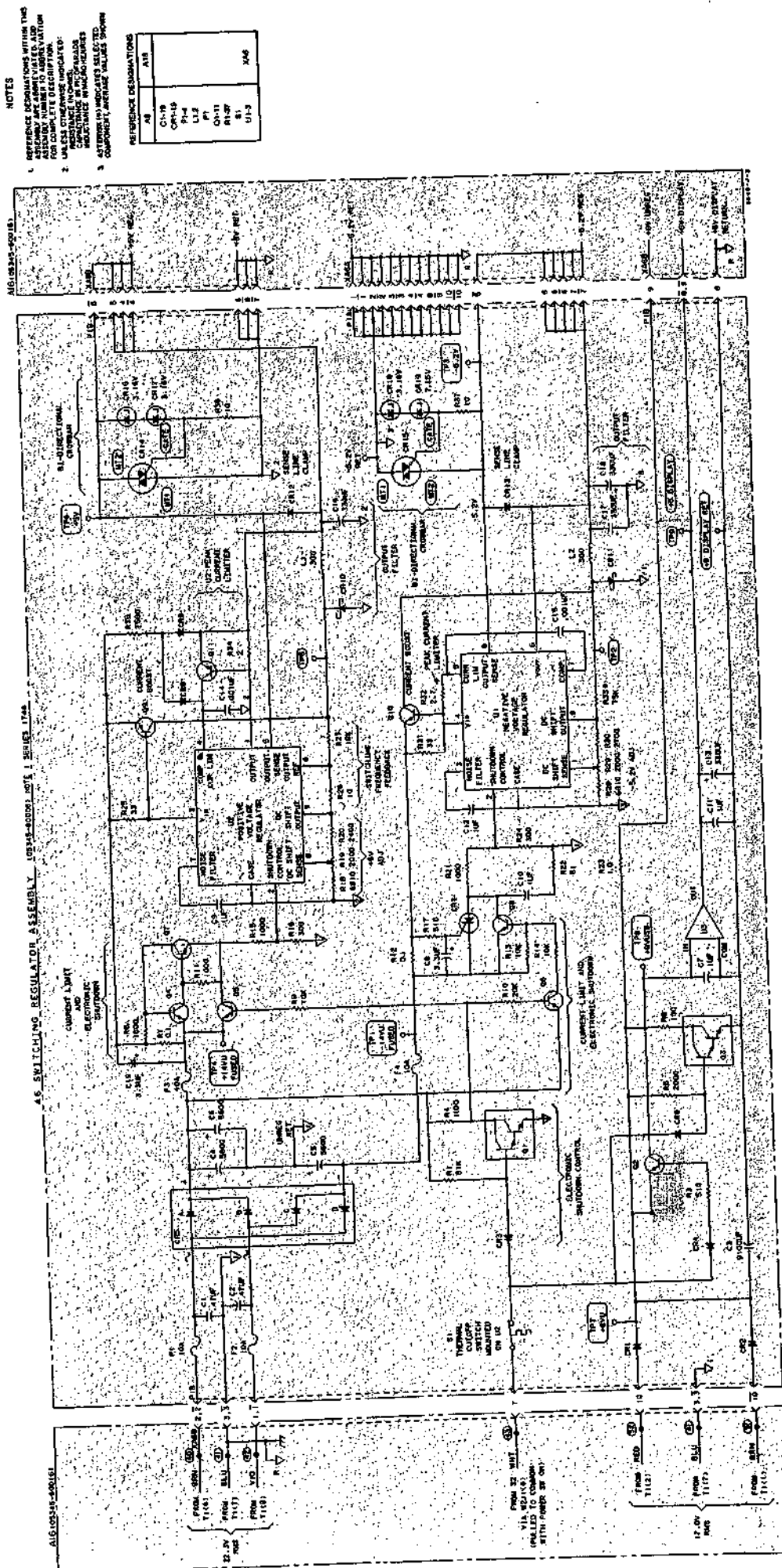


Figure 8-9
A6 SWITCHING REGULATOR ASSEMBLY

(See page 8-33)



HP 5345A
Schematic Diagrams



NOTES

1. REFERENCE DESIGNATIONS WITHIN THE SCHEMATIC DIAGRAMS ARE IDENTICAL TO THOSE SHOWN IN THE PARTS LIST. REFER TO THE PARTS LIST FOR THE COMPLETE LIST OF PARTS AND ASSOCIATED PARTS.
2. USE THE RESISTANCE INDICATED FOR ALL RESISTORS UNLESS OTHERWISE SPECIFIED.
3. ATTENTION TO THE TOLERANCE SPECIFICATIONS OF ALL COMPONENTS IS REQUIRED TO ACHIEVE THE DESIRED PERFORMANCE.

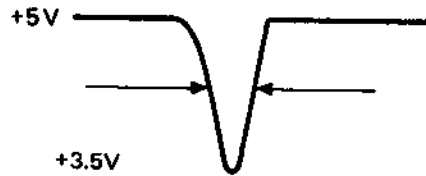
RESISTANCE DESIGNATIONS	VALUE	TOLERANCE
R1	10K	1%
R2	10K	1%
R3	10K	1%
R4	10K	1%
R5	10K	1%
R6	10K	1%
R7	10K	1%
R8	10K	1%
R9	10K	1%
R10	10K	1%
R11	10K	1%
R12	10K	1%
R13	10K	1%
R14	10K	1%
R15	10K	1%
R16	10K	1%

Figure 8-9. AS Switching Regulator Assembly
8-38

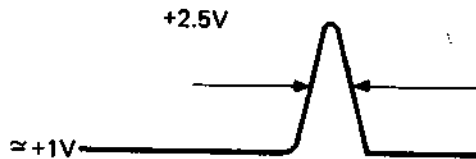
Test Points:

Connect 606A (10 MHz at 1.0V rms) to EXT STD INPUT thru 50Ω.

Test Points	Test Limits
1.	+8.5V to +9.5V DC
2.	10 MHz, 2 to 3 V P-P centered around the DC voltage at T.P. 1.
3.	+0.9V to +1.1V DC.
4.	10 MHz Sine Wave, 1.0 to 1.5 V P-P centered around the DC voltage at T.P. 3.
5.	10 MHz Sine Wave, 3 to 6 V P-P (>1 V rms).
6.	10 MHz Sine Wave, 0.7 to 2.5 V P-P (> .225 V rms).
7.	1 to 2 V Neg. Pulse 20 to 40 nS wide starting from +5V base line.



8. 1 to 2 V Pos. Pulse 20 to 40 nS wide starting from $\approx +1$ V base line.



Check the voltage level of 606 where the above waveform drops out.

TEST LIMIT: .25 to .5 V rms.

Figure 8-10
A7 LINEAR REGULATOR ASSEMBLY

(See page 8-35)

Phase Lock Loop:

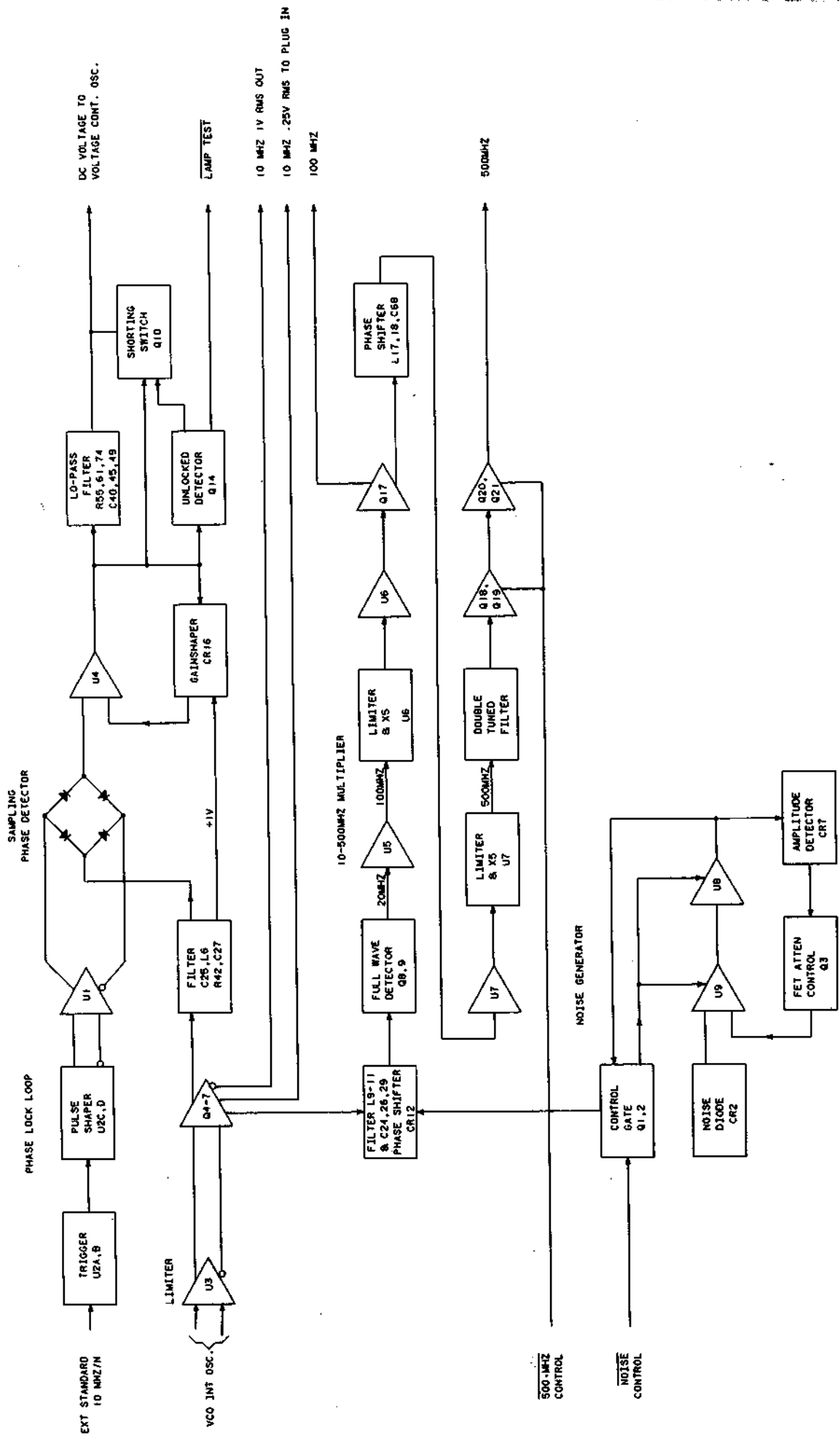
REPLACE: 606 — with 5 MHz House Standard (stable source necessary)
CONNECT: Test Point 11 — to ground with Clip Lead (this unlocks oscillator)
OBSERVE: **DISPLAY** — all readouts should be in LAMP TEST (all segments lit)

Continuing the Test Point Table:

Test Points:	Test Limit:
9.	Low frequency Sine Wave ≈ 1 V P-P Sine Wave centered about +1 V (+0.5 V to +1.5 V).
10.	Distorted low frequency sine wave with positive peak between +4.5 and +6.0 volts and negative peak between -7.0 and -12.0 volts, with breaks at about +1.5 V.



REMOVE: Clip Lead — from Test Point 11.
OBSERVE: Test Point 10 — waveshape changes quickly to a DC Voltage between -5 V and +5 V.
DISPLAY — LAMP TEST condition ceases in 3 sec. or less after clip lead is removed.
Test Point 11 — has less noise than Test Point 10.



DC VOLTAGE TO VOLTAGE CONT. OSC.

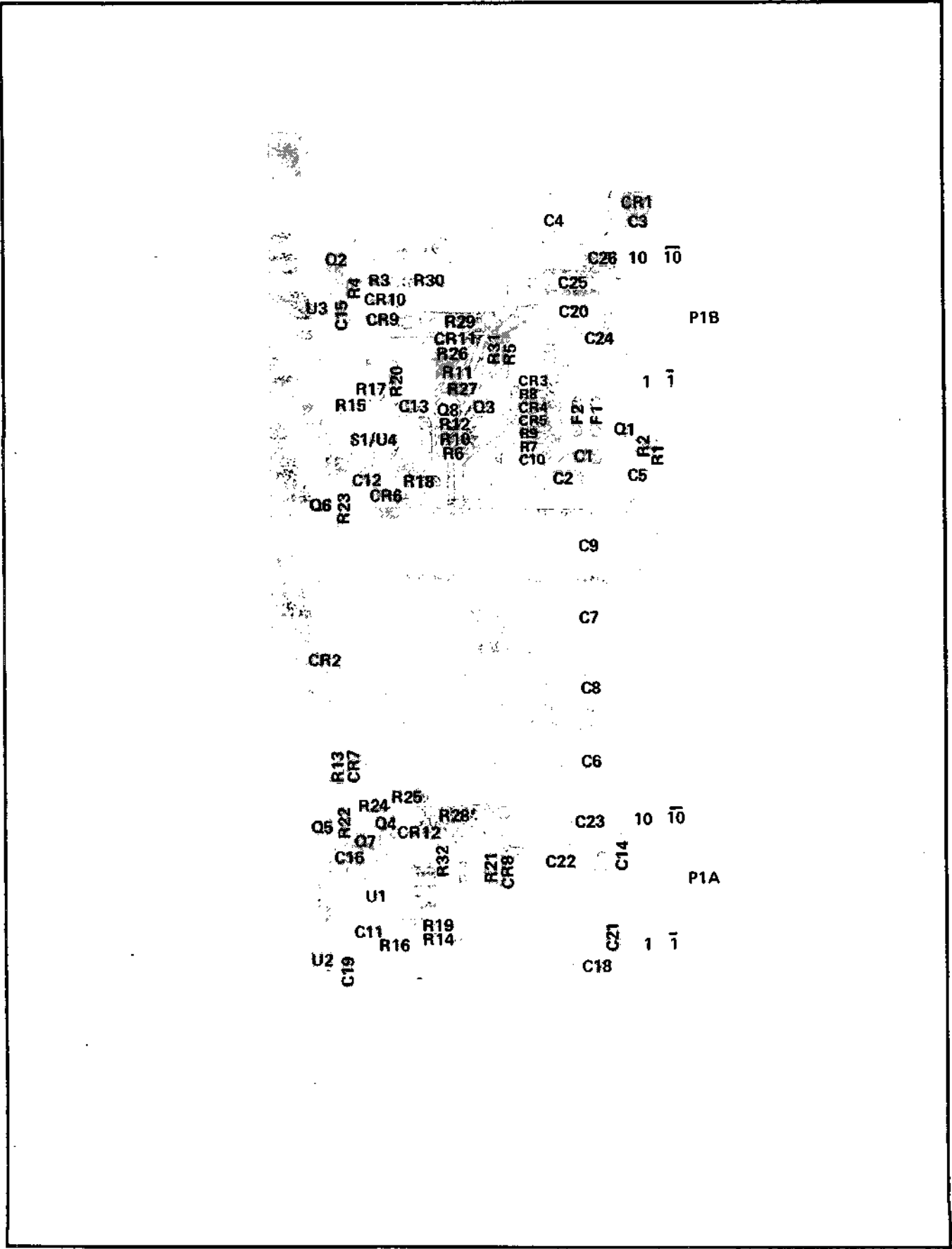
LAMP TEST

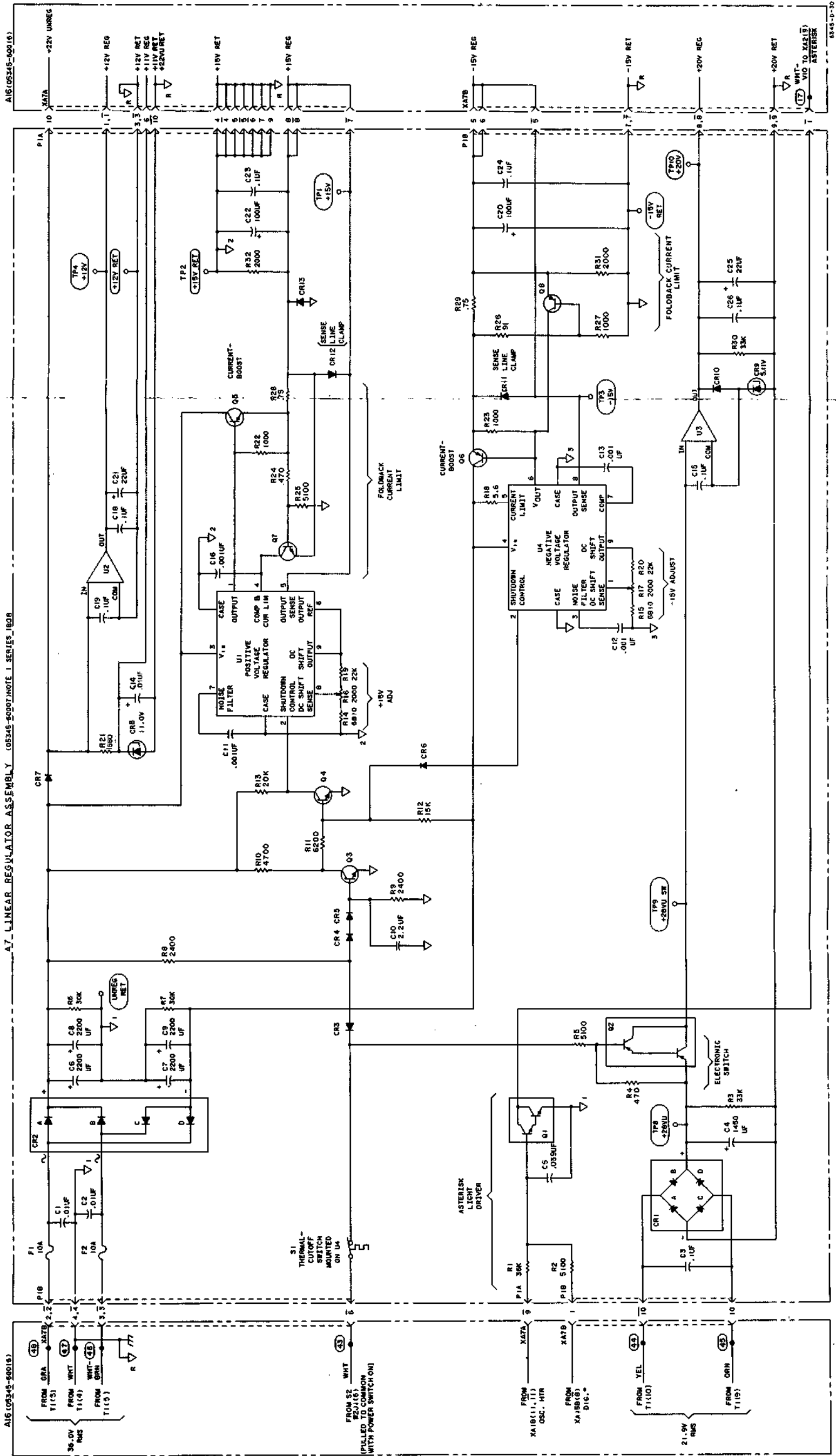
10 MHz 1V RMS OUT
10 MHz .25V RMS TO PLUG IN
100 MHz

500MHz

500 MHz CONTROL

NOISE CONTROL





- NOTES**
1. REFERENCE DESIGNATIONS WITHIN THIS ASSEMBLY ARE ABBREVIATED. ADD ASSEMBLY NUMBER TO ABBREVIATION FOR COMPLETE DESCRIPTION.
 2. UNLESS OTHERWISE INDICATED: RESISTANCE IN OHMS. CAPACITANCE IN MICROFARADS. INDUCTANCE IN MICROHENRIES.

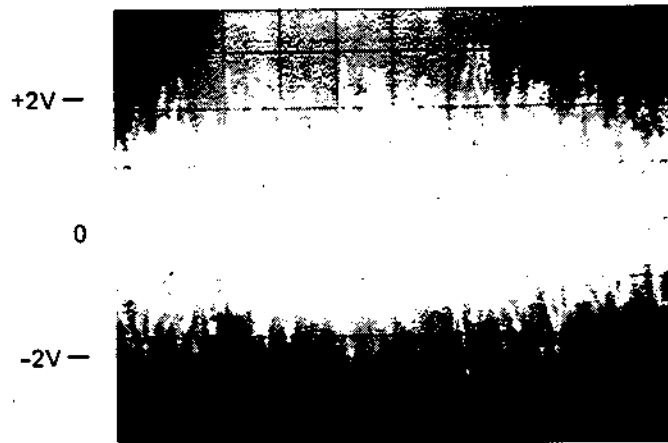
REFERENCE DESIGNATIONS	
A7	A16
CR1-25	
F1-4	
L1	
P1	
Q1-9	
R1-35	
S1	
U1-4	XAT

CIT DELETED

Figure 8-10. A7 Linear Regulator Assembly

Noise Generator:

SET: 5345 FUNCTION — to T.I. position.
MEASURE: DC Voltage at Test Point 12 with scope probe
TEST LIMIT: Between -1.8 and -5 V DC.
CONNECT: Scope probe — to Test Point 13
SET: SCOPE —.1 mS/CM

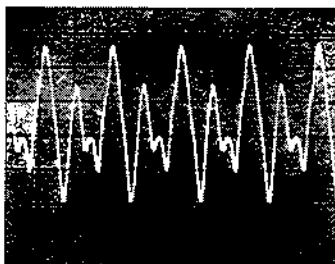


SET: 5345 FUNCTION — to PERIOD
OBSERVE: Test Point 13 — -15 V and no noise with scope probe
NOTE:

Pin 5 XASA Noise Control	Noise
0 to 1 V	ON
+2 to +5 V	OFF

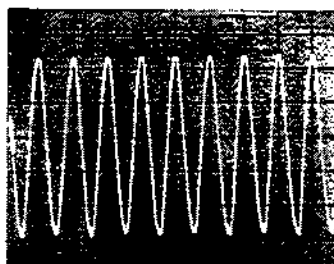
Equipment: 180A with 1810A and 10020A Probe

TP-14



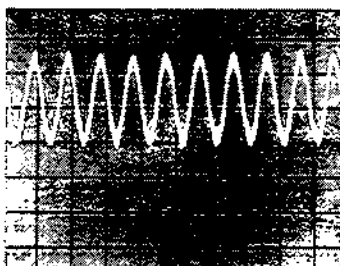
20 mV/div, EXPANDED,
expanded to 50 nsec, direct to
50 nsec TRIGGER-EXT, NORM

TP-15



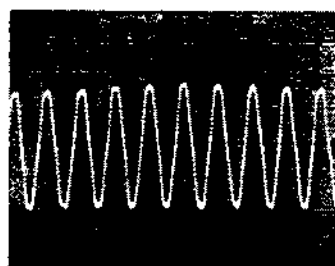
20 mV/div, EXPANDED,
expanded to 50 nsec, direct to
50 nsec TRIGGER-EXT, NORM

TP-16



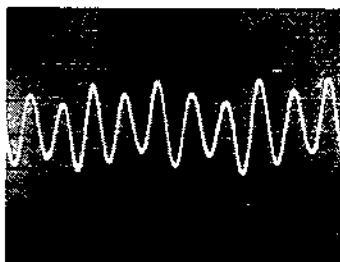
2 mV/div, EXPANDED to
10 nsec, direct to 10 nsec
TRIGGER-EXT, NORM

TP-17



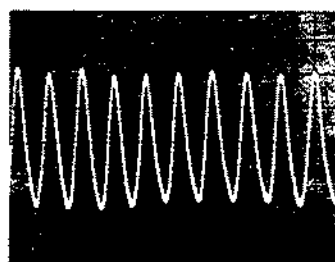
10 mV/div, EXPANDED to
10 nsec, direct to 10 nsec
TRIGGER-EXT, NORM

TP-18



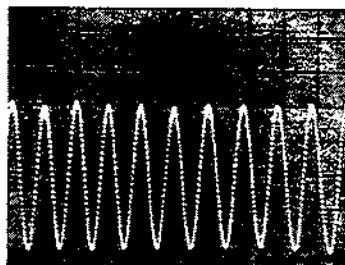
10 mV/div, EXPANDED to
2 nsec, direct to 10 nsec
TRIGGER-EXT, NORM

TP-19



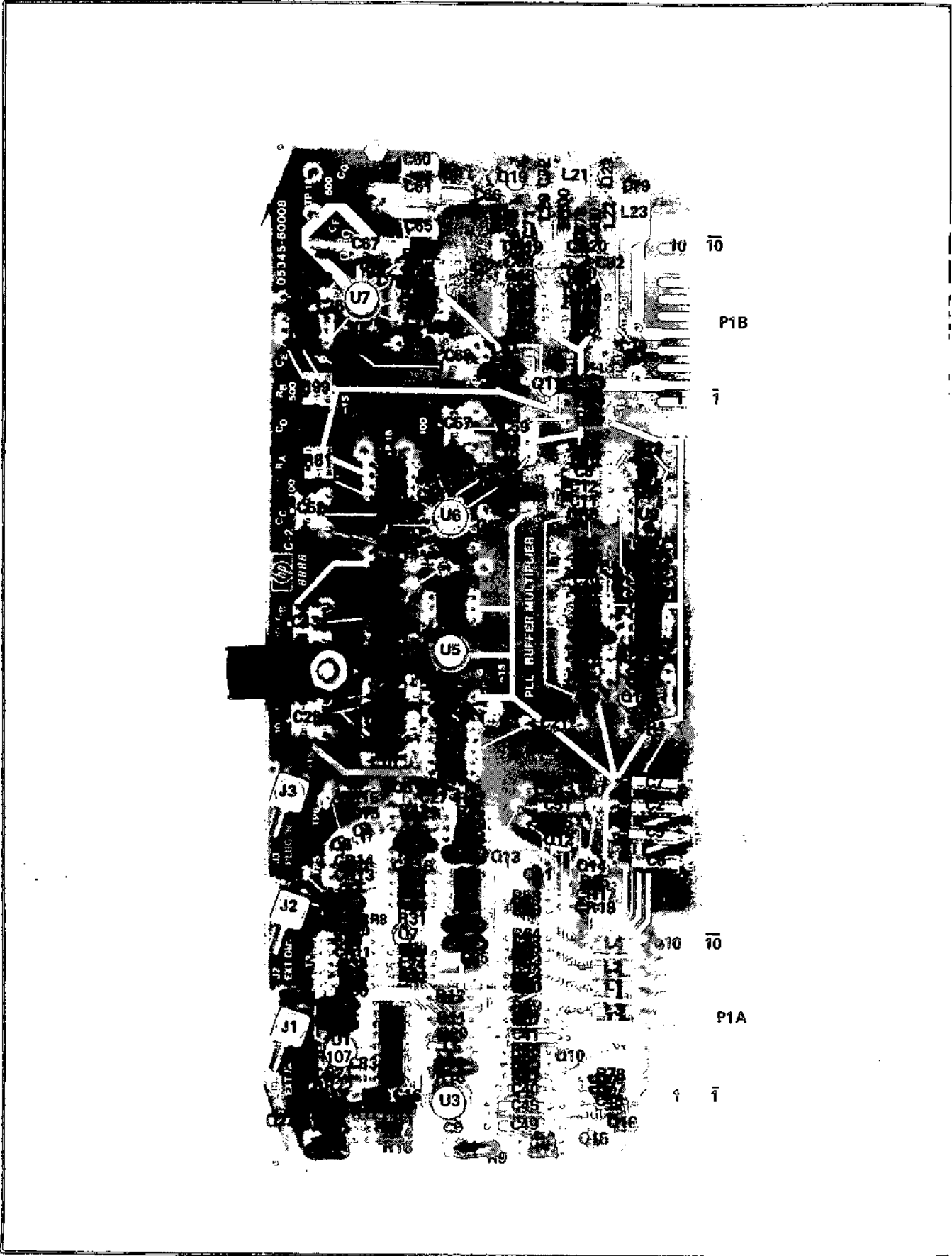
5 mV/div, EXPANDED to
2 ns, direct to 10 nsec
TRIGGER-EXT, NORM

TP-20



10 mV/div, other settings
same as TP-19

Part of Figure 8-11. A8 PLL Multiplier Noise Generator Assembly



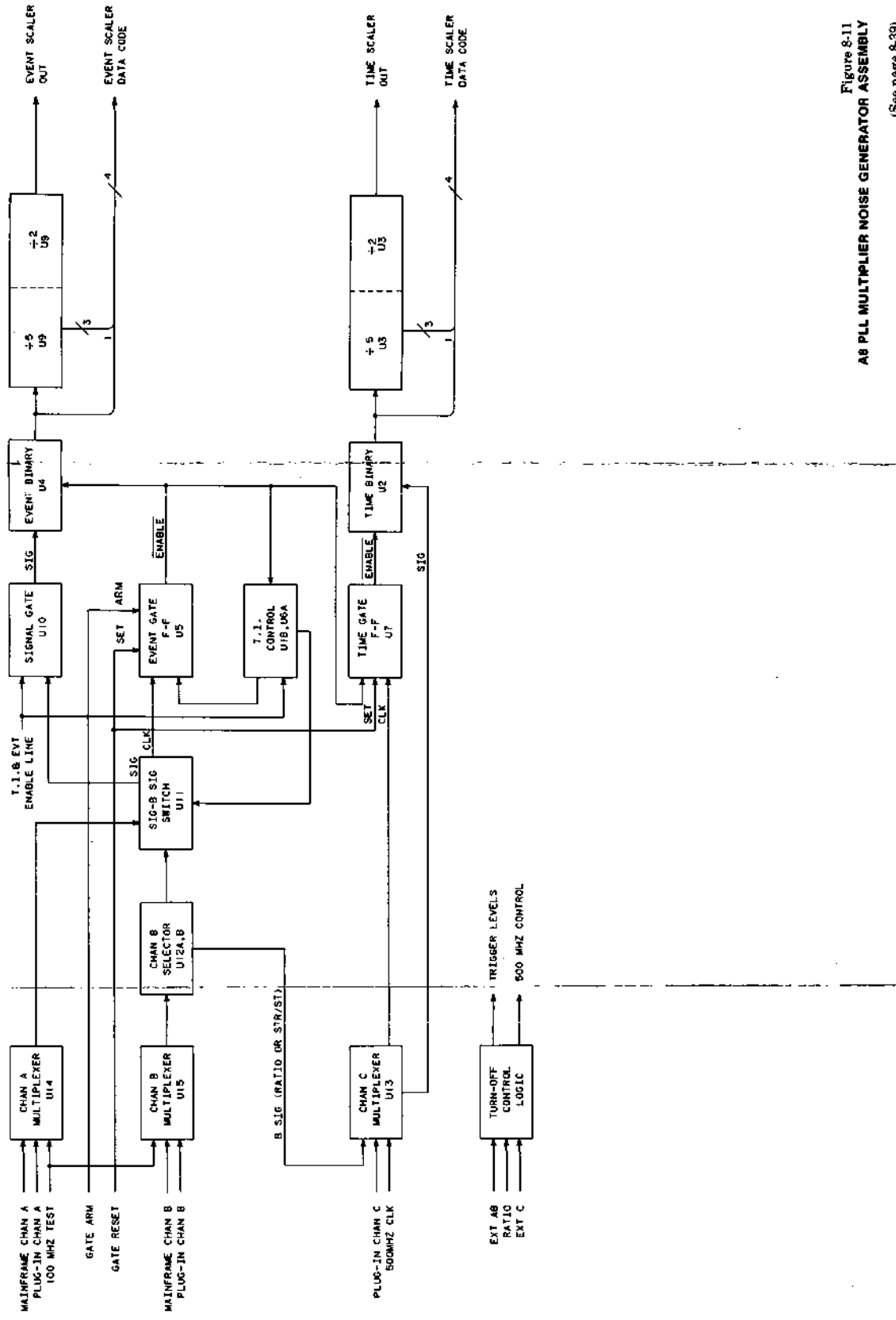
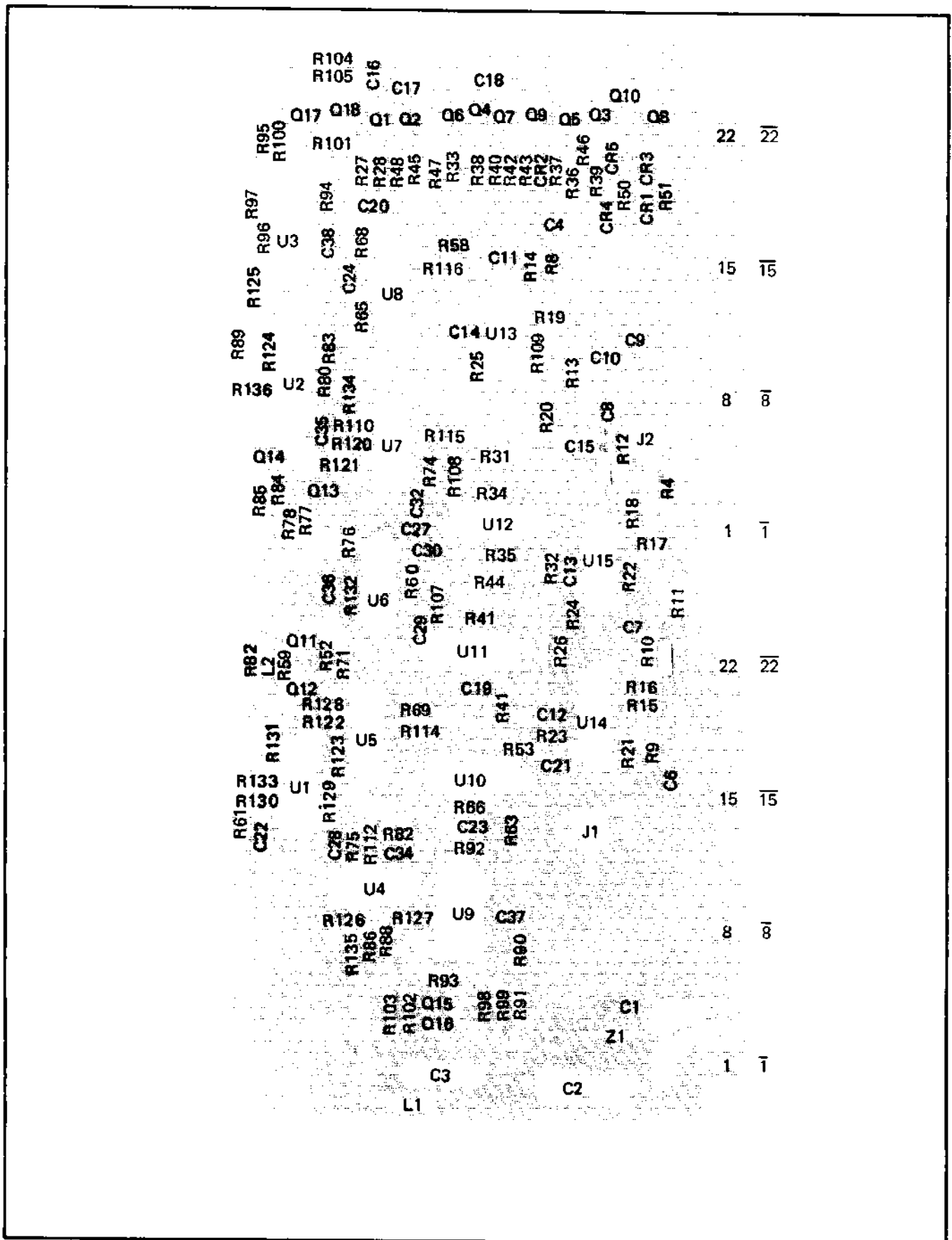


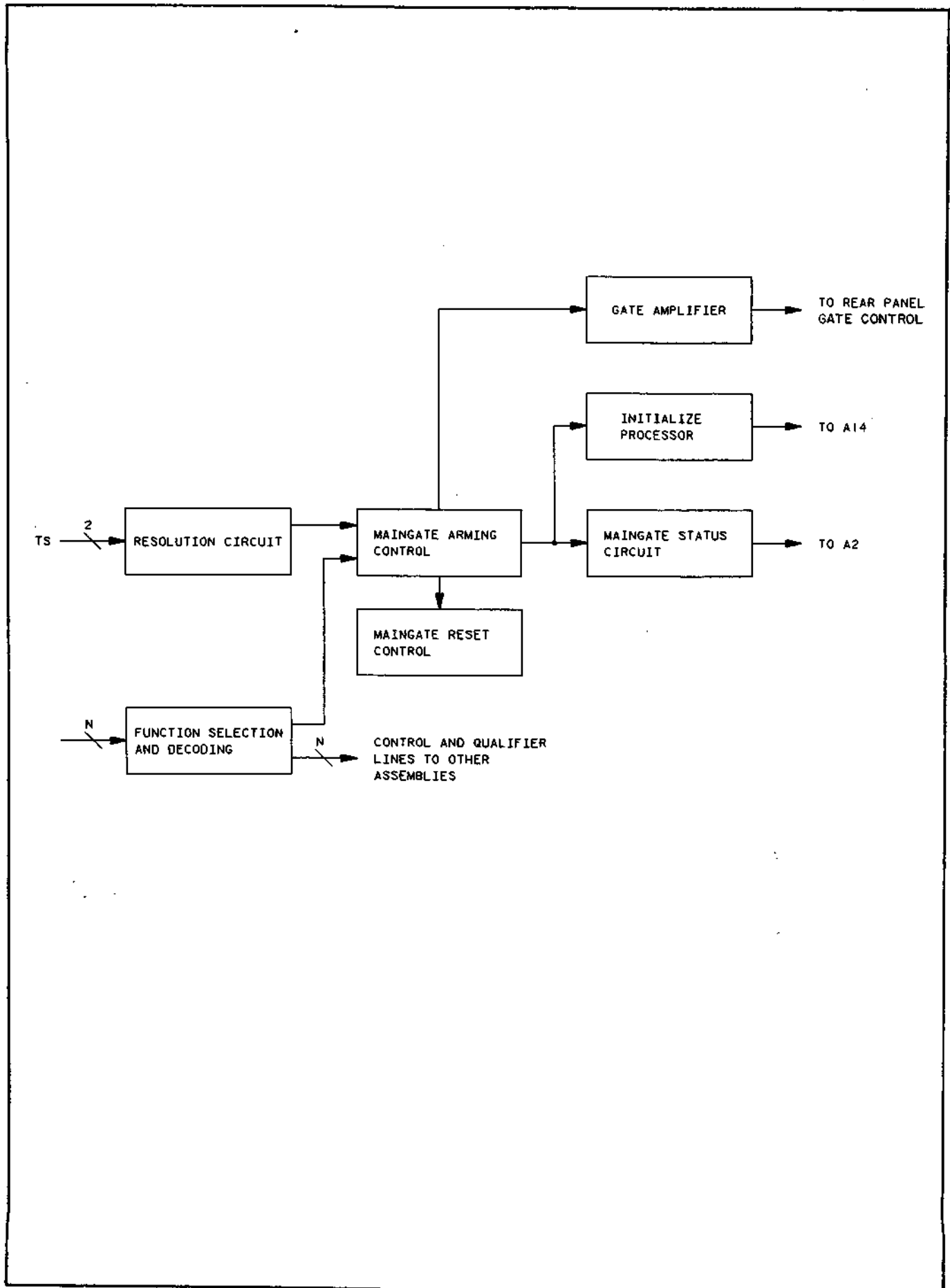
Figure 8-11
 AB PLL MULTIPLIER NOISE GENERATOR ASSEMBLY
 (See page 8-39)



Part of Figure 8-12. A9 Main Gate Assembly

Figure 8-12
A9 MAIN GATE ASSEMBLY

(See page 8-41)



IMPORTANT

A front panel bandwidth and input sensitivity check should be performed when a defective IC on A9 has been replaced. Proper plug-in operation should be confirmed with 5354A (checks Channel A) and 5353A (checks Channel C Ratio). If IC U8 or U10 through U15 has been replaced and the input specifications are not met, do *not* attempt any adjustments. Substitute another IC in its place and repeat the performance test. A replacement IC that meets the performance tests does not indicate that the previous IC was faulty, only that its characteristics were not in accordance with the factory selected bias resistors. If the counter continues to fail the bandwidth or sensitivity test, the board should be returned to the factory. Send the A9 board to your nearest Hewlett-Packard Sales and Service Office listed at the back of this manual.

Simplified Flow Diagrams of A9 are contained in Figures 5-14 through 5-16.

NOTES

1. REFERENCE DESIGNATIONS WITHIN THIS ASSEMBLY ARE ABBREVIATED. ADD ASSEMBLY NUMBER TO ABBREVIATION FOR COMPLETE DESCRIPTION.
2. UNLESS OTHERWISE INDICATED:
RESISTANCE IN OHMS;
CAPACITANCE IN PICO FARADS;
INDUCTANCE IN MICROHENRIES
3. ASTERISK (*) INDICATES SELECTED COMPONENT, AVERAGE VALUES SHOWN
4. SUPPLY VOLTAGE IS SELECTED AT FACTORY.
5. INSTRUMENTS WITH SERIAL NUMBERS 2426A10881 & ABOVE MAY OR MAY NOT HAVE A9C25 INSTALLED.

REFERENCE DESIGNATIONS

A9
C1-38
CR1-5
J1,2
L1,2
P1
Q1-18
R1-118
U1-15
Z1

HP 5945A
Schematic Diagrams

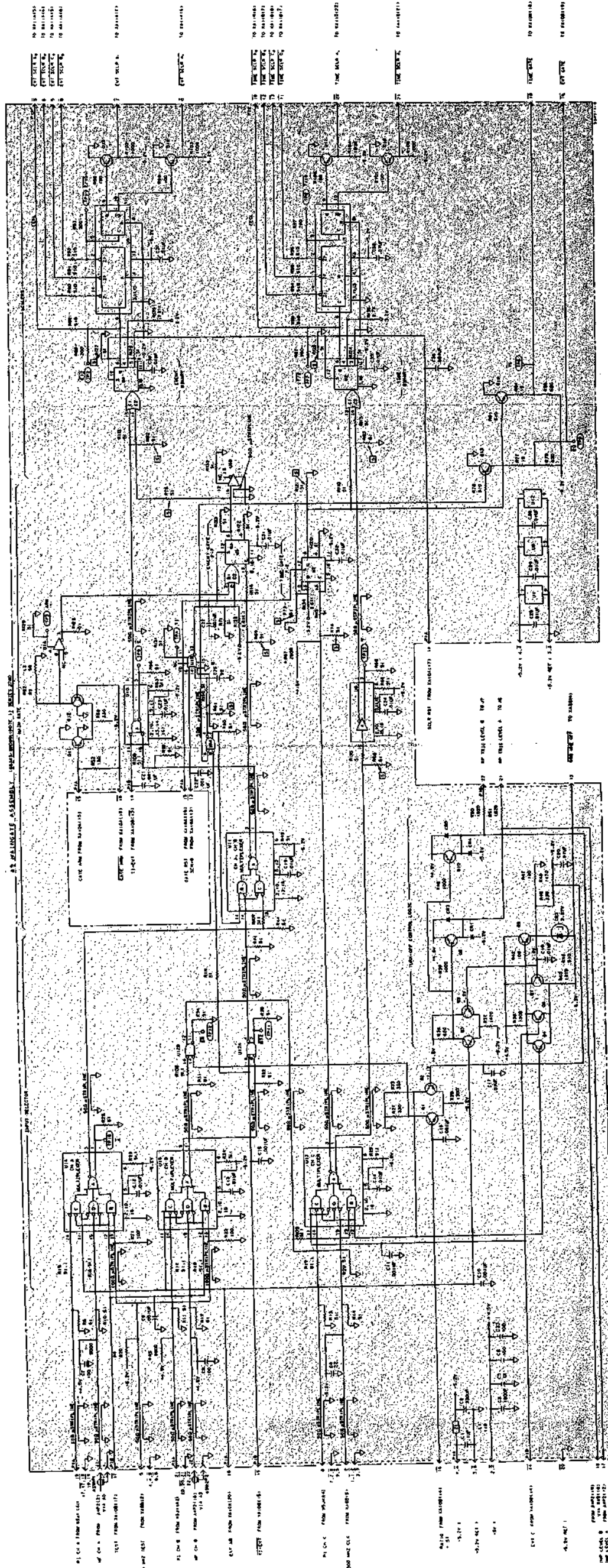


Figure 8-12. A9 Main Gate Assembly
8-41

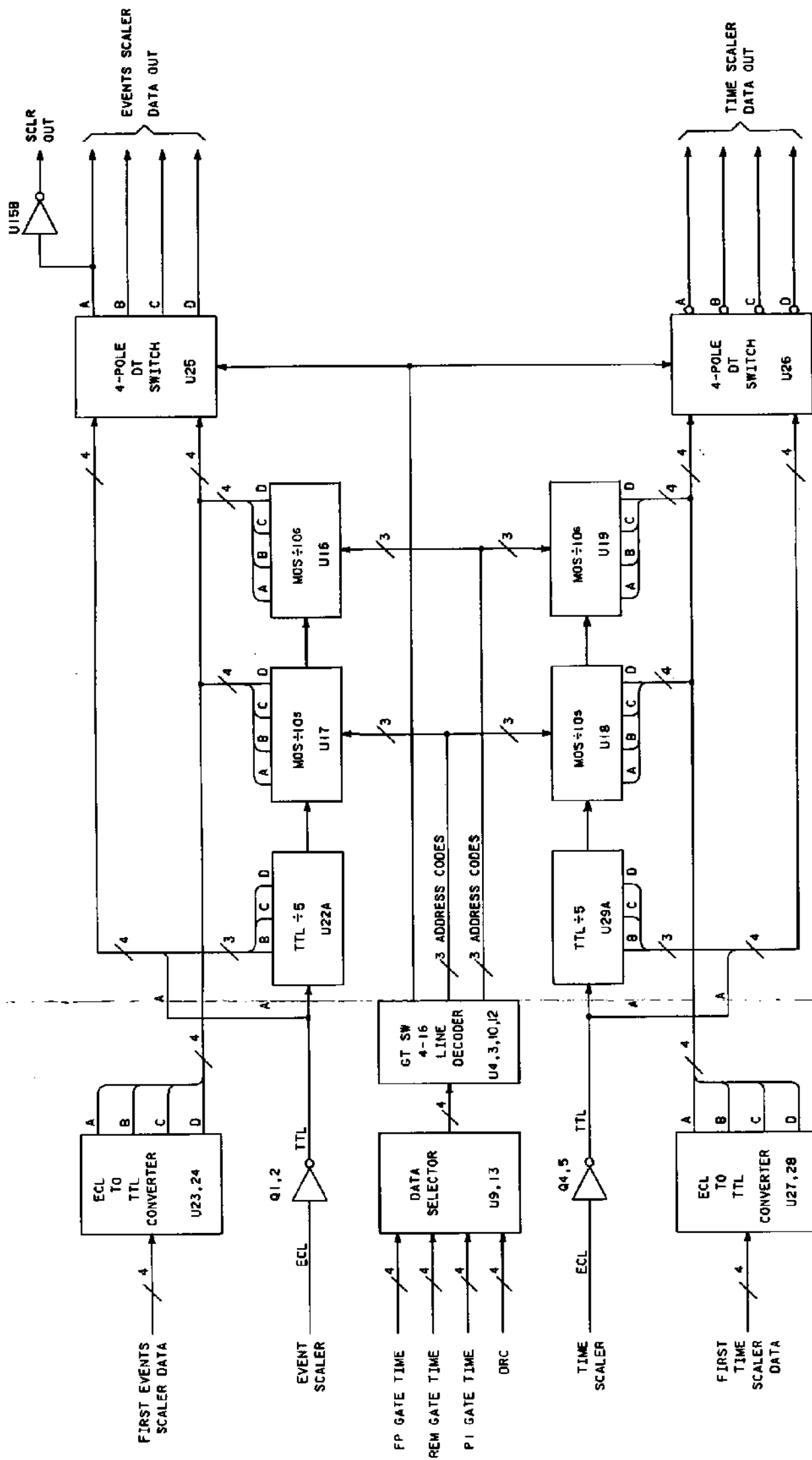
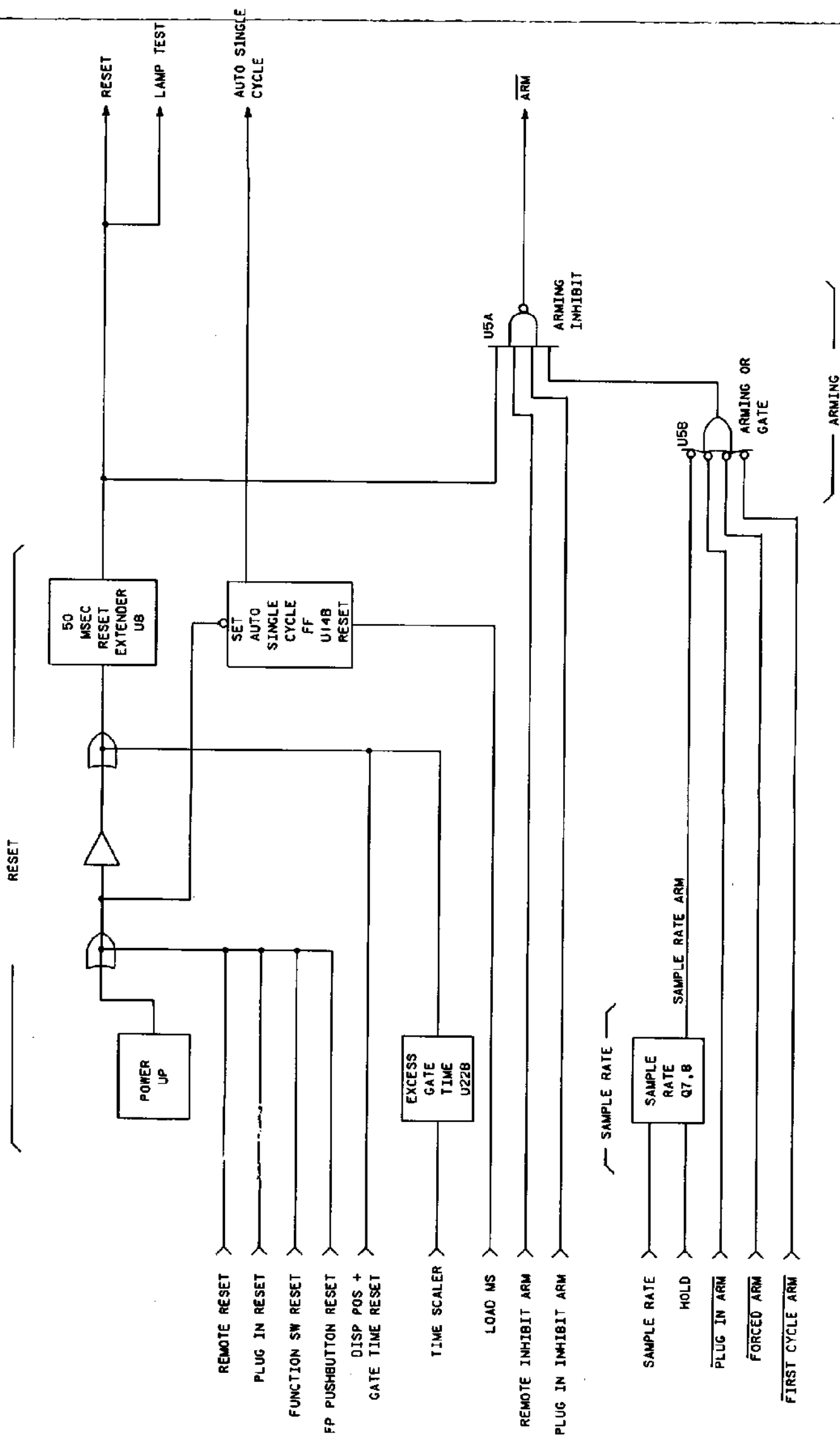


TABLE 1
A11 05345-60011 SCALER ASSEMBLY

GATE TIME SETTING	U4 OUTPUT LINES			U17 AND U18			SELECTED BINARY			U16 AND U19			SELECTED BINARY		
	0	1	2	X	Y	Z	X	Y	Z	X	Y	Z	X	Y	Z
100 NS	0	1	1	0	1	1	0	1	1	1	1	1	1	1	1
1 μS	1	0	0	1	0	0	1	0	0	0	0	0	0	0	0
10 μS	2	1	0	1	0	0	1	0	0	0	0	0	0	0	0
100 μS	3	0	1	0	1	0	0	1	0	0	0	0	0	0	0
1 MS	4	1	1	1	0	0	1	1	1	1	1	1	1	1	1
10 MS	5	0	0	0	1	1	0	0	0	0	0	0	0	0	0
100 MS	6	1	1	1	1	1	1	1	1	1	1	1	1	1	1
1 S	7	0	1	1	1	1	0	1	1	1	1	0	0	0	0
10 S	8	1	0	1	1	1	1	0	1	1	1	1	0	0	0
100 S	9	0	1	1	1	1	0	1	1	1	1	1	0	0	0
1000 S	10	1	1	1	1	1	1	1	1	1	1	1	1	1	1
MIN	11	0	1	1	1	1	0	1	1	1	1	1	0	1	1
-	12	1	1	1	1	1	1	1	1	1	1	1	1	1	1
-	13	0	1	1	1	1	1	1	1	1	1	1	1	1	1
-	14	1	1	1	1	1	0	1	1	1	1	1	0	1	1
-	15	0	1	1	1	1	1	1	1	1	1	1	1	1	1

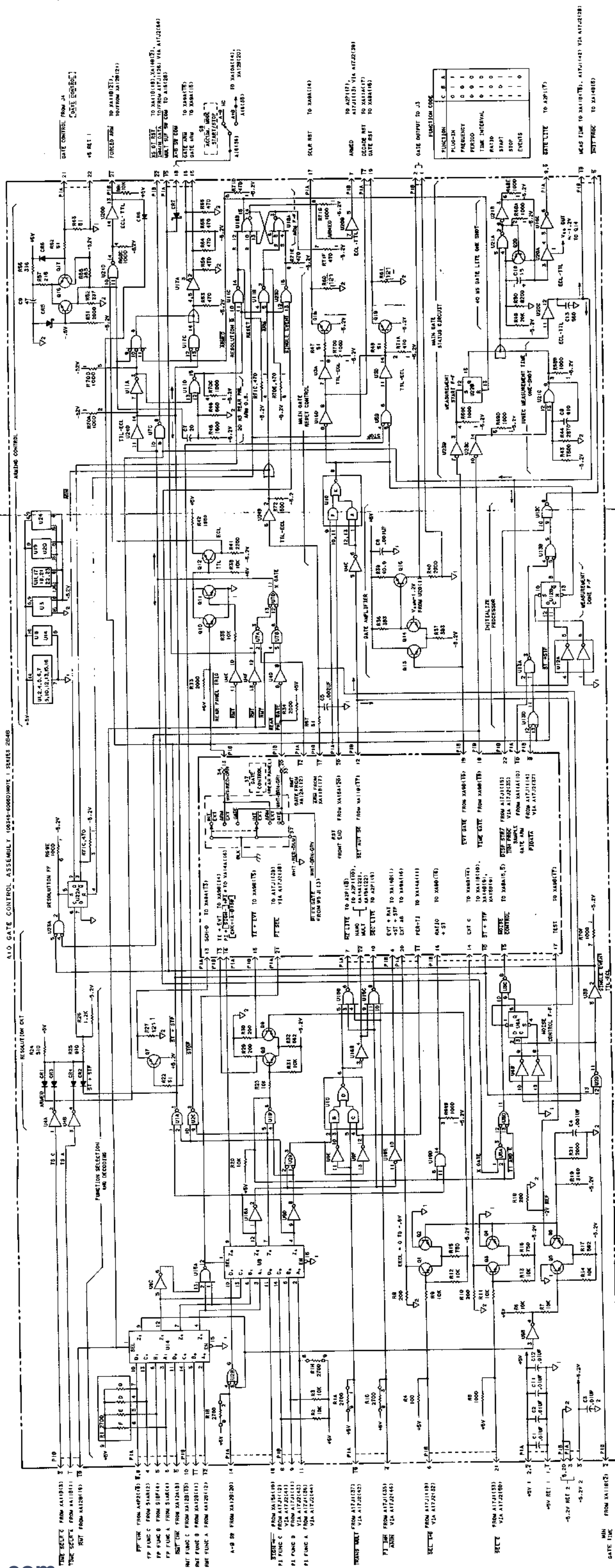
Figure 8-13
A10 GATE CONTROL ASSEMBLY
(See page 8-48)



				C4		U24		
				R19				
				R21				
				R5	C5	R67	22	$\overline{22}$
		R8	Q1	Q3				
		R12						
		R15						
		R9	Q2	Q4				
U7		R4				U23		
		R30						
		R32	Q9	Q5				
		R29				R69		
U8		R31	Q8	Q6			15	$\overline{15}$
		R23						
		R20				U22		
		C12	Q11					
		R38		Q10				
U5		R42				R44		
		R41	Q12		Q20	R43		
						C8		
				Q17		U21	7	$\overline{7}$
		U13		C9				
						R68		
		R26				R49		
		R25				R50		
		R24		Q16		C10		
U4		CR4						
		CR3				U20	1	$\overline{1}$
		CR2						
		CR1						
				R45				
				Q19				
C11				R61	Q15	R40		
		U12		R48		R36		
				R46		C6		
					Q14	R39		
						R37		
				C7		Q13	22	$\overline{22}$
U3		U11		U18		R63		
CR7		R70		R71		R22		
						R53		
		R72				R66		
				U17		R65		
		C2				R59		
						R64	15	$\overline{15}$
U2		U10		U16		R27		
						Q7		
R2								
		U9		U15		U19		
							7	$\overline{7}$
U1		U8		U14		R60		
R3						Q18	R47	
				C1		C3	1	$\overline{1}$
					R1			

P1B

P1A



- NOTES**
1. REFERENCE DESIGNATIONS WITHIN THIS ASSEMBLY ARE ABBREVIATED. ADD ASSEMBLY NUMBER TO ABBREVIATION FOR COMPLETE DESCRIPTION.
 2. UNLESS OTHERWISE INDICATED: RESISTANCE IN OHMS; CAPACITANCE IN PICOFARADS; INDUCTANCE IN MICROHENRIES.

REFERENCE DESIGNATIONS

NO	A10
PREFIX	C1-12 CR1-7 P1 Q1-20 R1-67 U1-24
S8	

Figure 8-13. A10 Gate Control Assembly

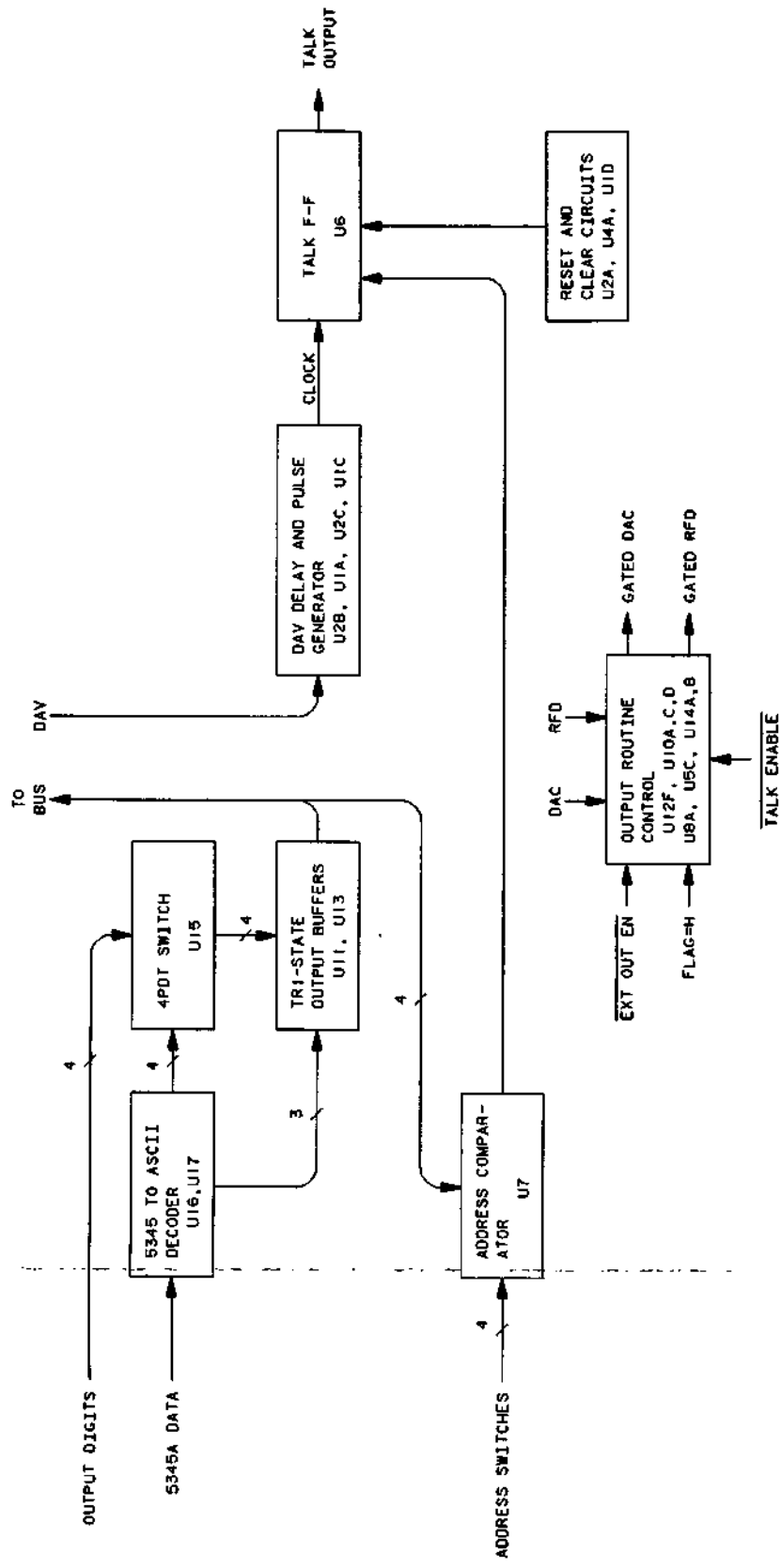
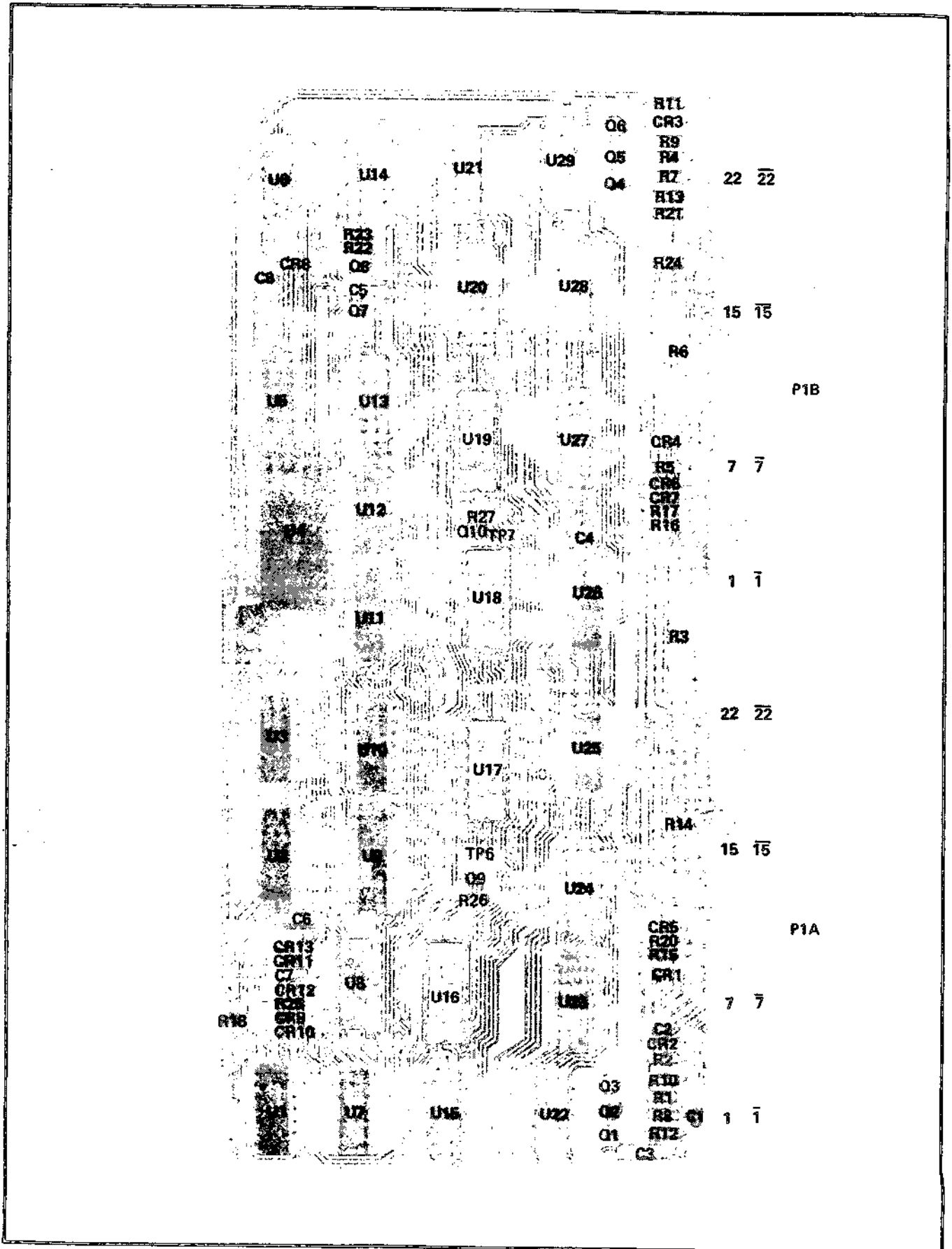


Figure 8-14
A11 SCALER ASSEMBLY
 (See page 8-45)



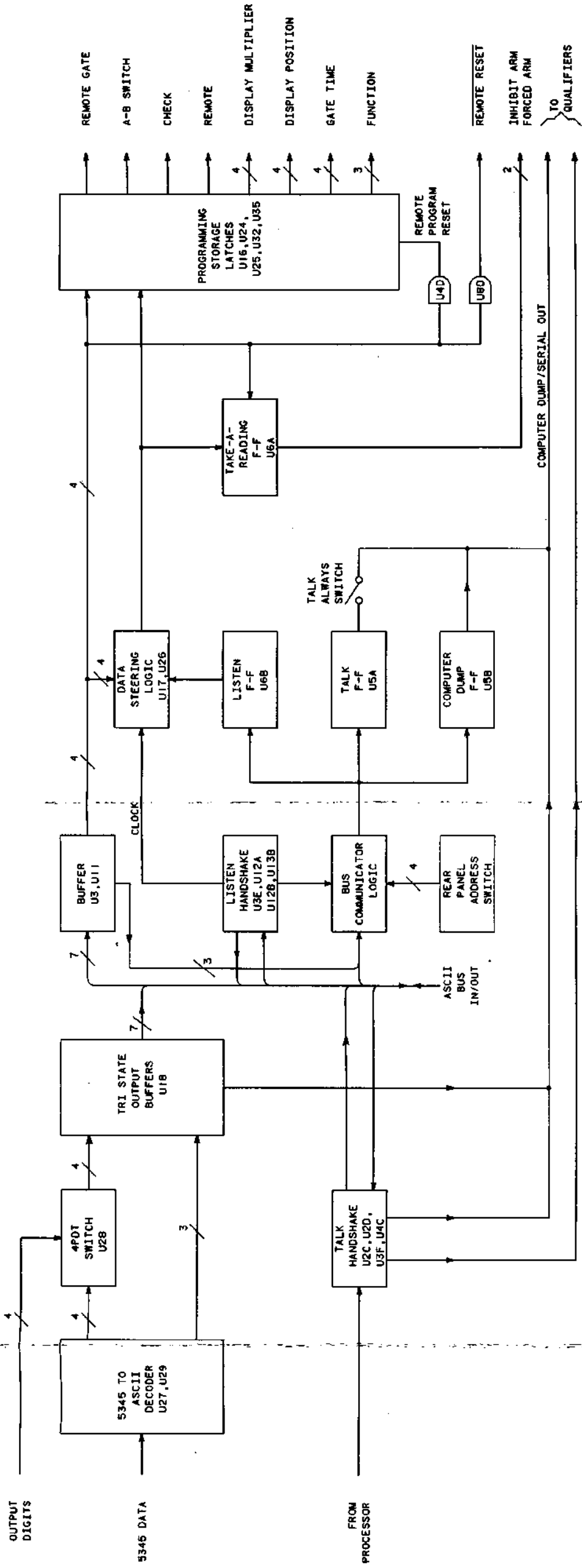


Figure 8-15
A12 OPTION 010 OUTPUT INTERFACE ASSEMBLY
 (See page 8-47)

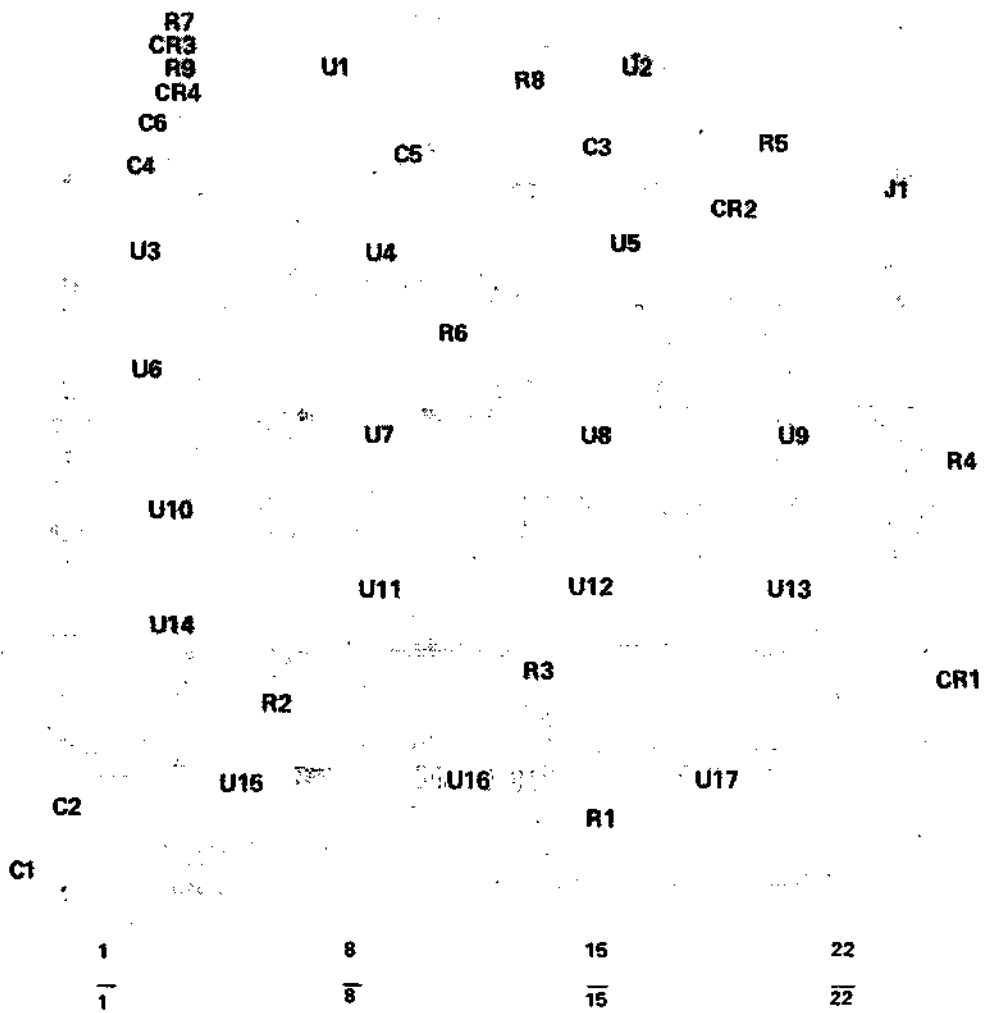
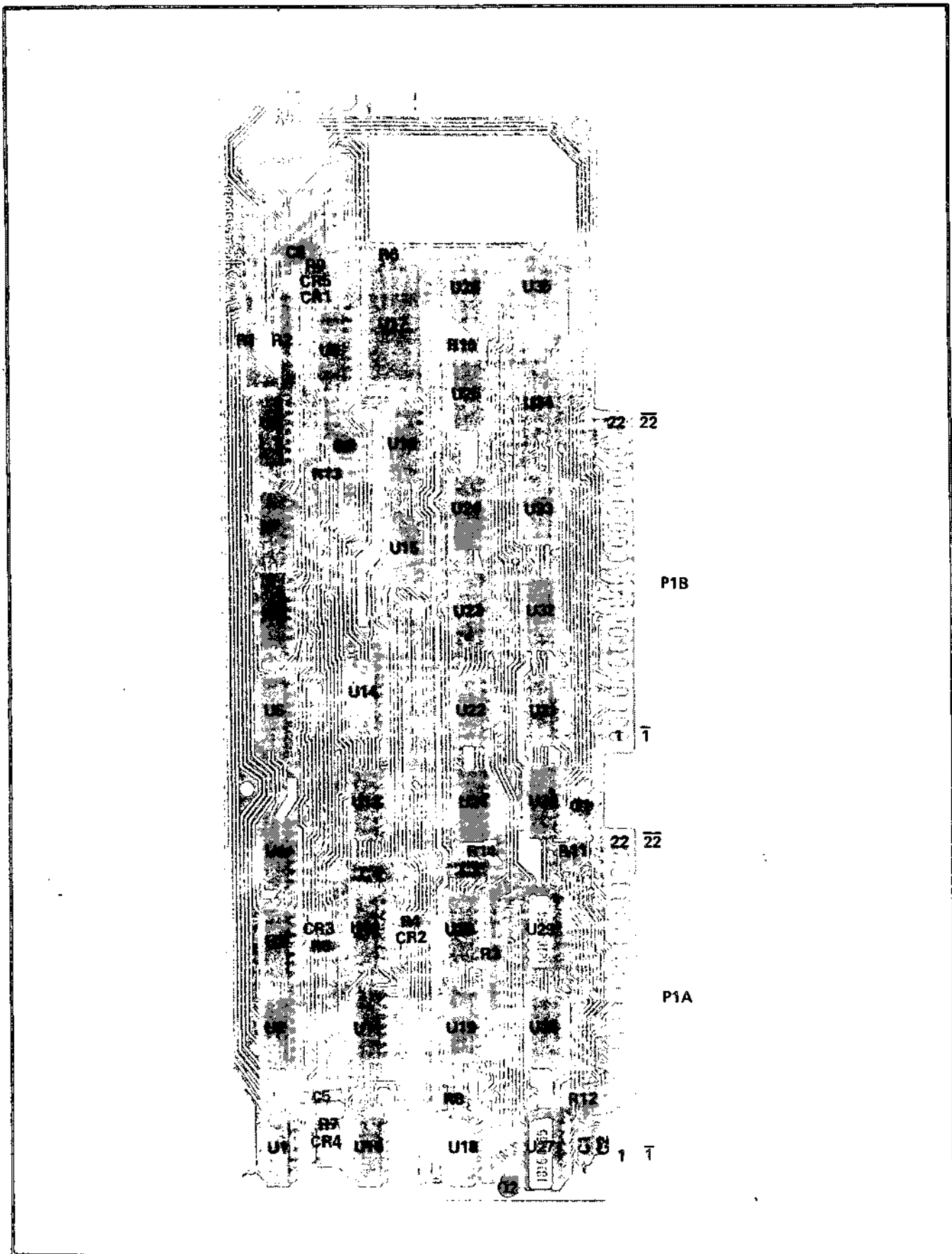


Figure 8-16
A12 OPTION 011 I/O INTERFACE ASSEMBLY

(See page 8-49)

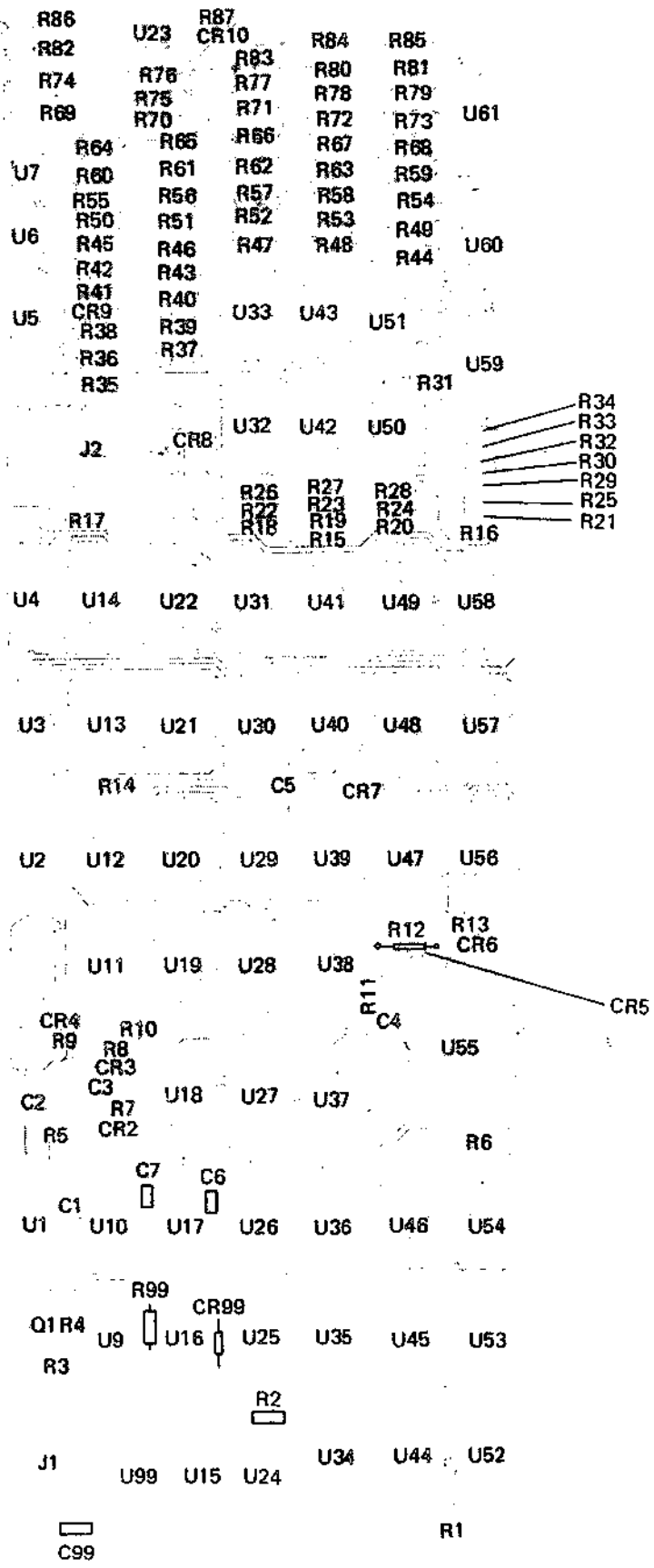


where is sheet 2?

JS

Figure 8-16A
A12 OPTION 012 HP-IB INTERFACE I/O ASSEMBLY
(Sheet 1 of 2)

(See page 8-49A)



NOTE: C12
IS ON CIRCUIT
SIDE OF BOARD
BENEATH U9

HP 8346A
Schematic Diagram

- NOTES
1. REPAIRMENT OPERATIONS SHOULD BE LIMITED TO THE REPAIR OF THE BOARD ASSEMBLY AND NOT TO THE REPAIR OF THE COMPUTER OR PERIPHERAL DEVICES.
2. UNLESS OTHERWISE INDICATED, RESISTOR VALUES ARE IN OHMS.
3. CAPACITANCE VALUES ARE IN MICROSECONDS.

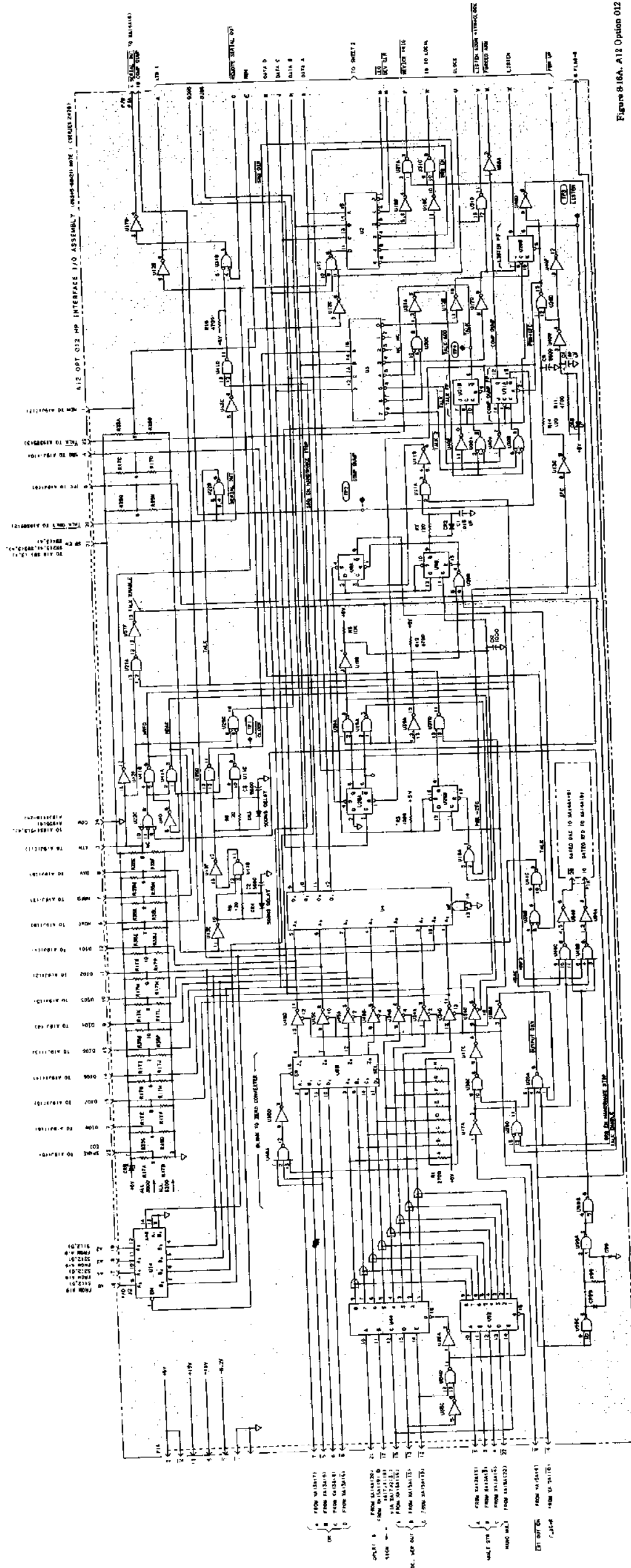
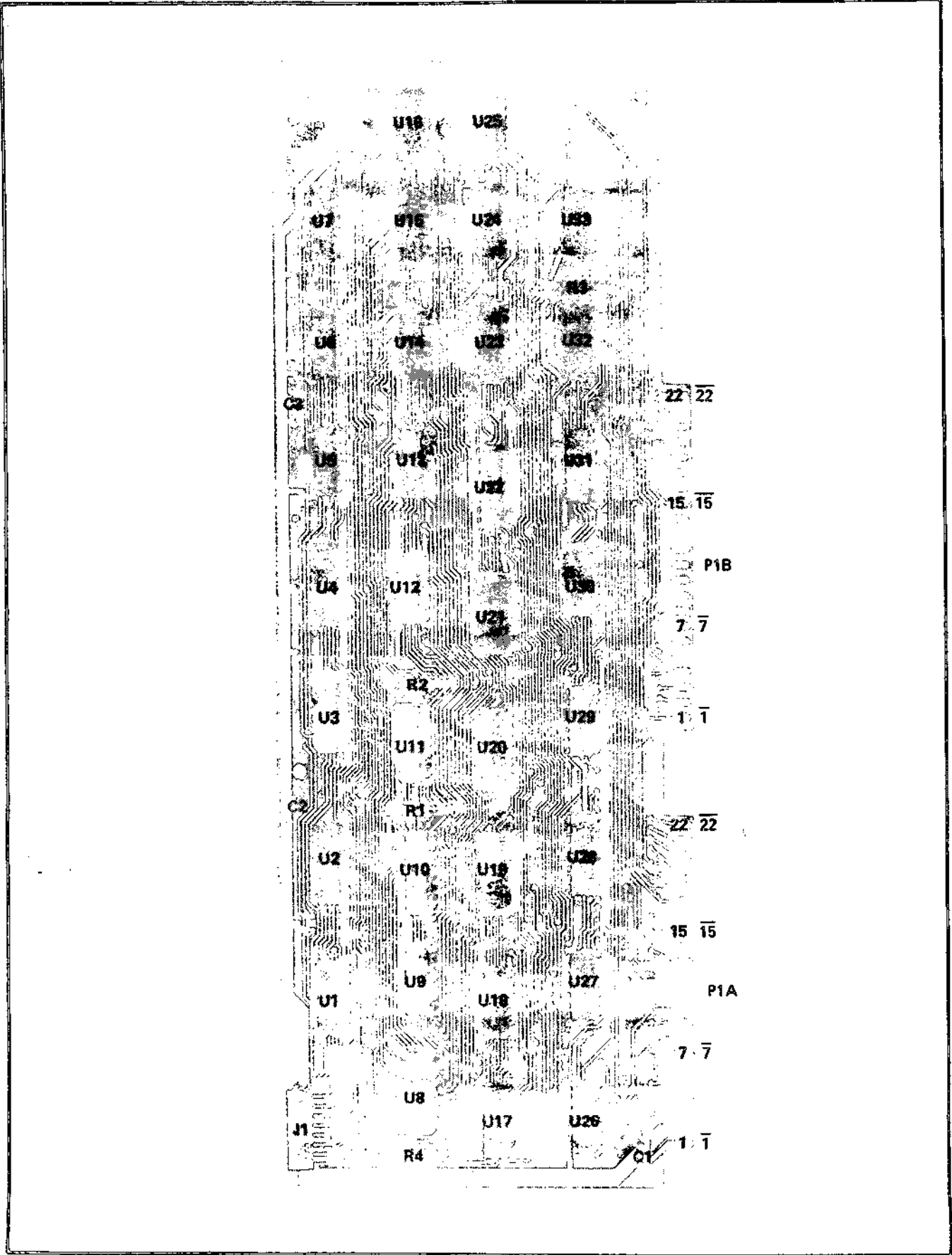


Figure 8-16A. A12 Option 012 HP-IB Interface I/O Assembly
Sheet 1 of 2
8-48A



HP 8545A
Schematic Diagram

- NOTES
1. ALL COMPONENTS SHOWN ARE ASSUMED TO BE IN THE ASSEMBLY UNLESS OTHERWISE NOTED.
 2. ALL COMPONENTS SHOWN ARE ASSUMED TO BE IN THE ASSEMBLY UNLESS OTHERWISE NOTED.
 3. ALL COMPONENTS SHOWN ARE ASSUMED TO BE IN THE ASSEMBLY UNLESS OTHERWISE NOTED.

SYMBOL	DESCRIPTION
○	WIRE
□	WIRE
△	WIRE
◇	WIRE
◇	WIRE
◇	WIRE

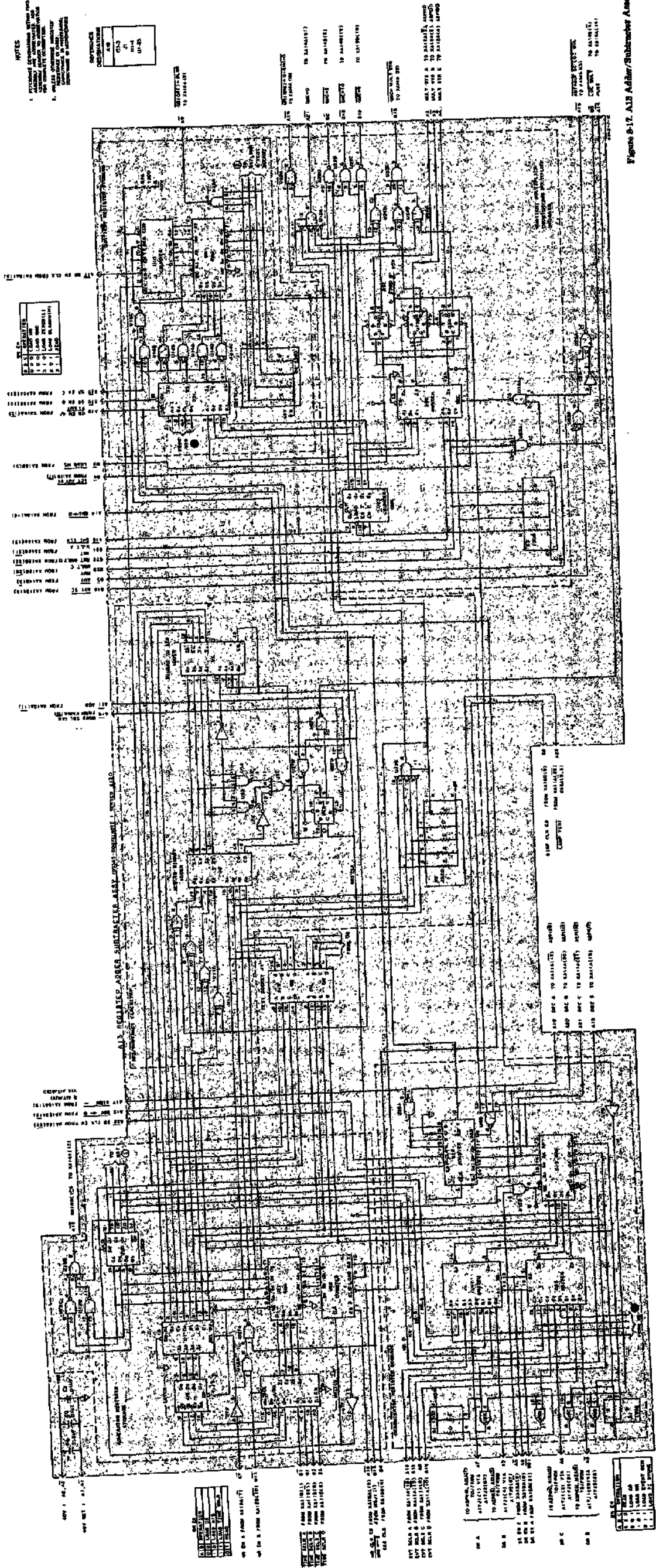
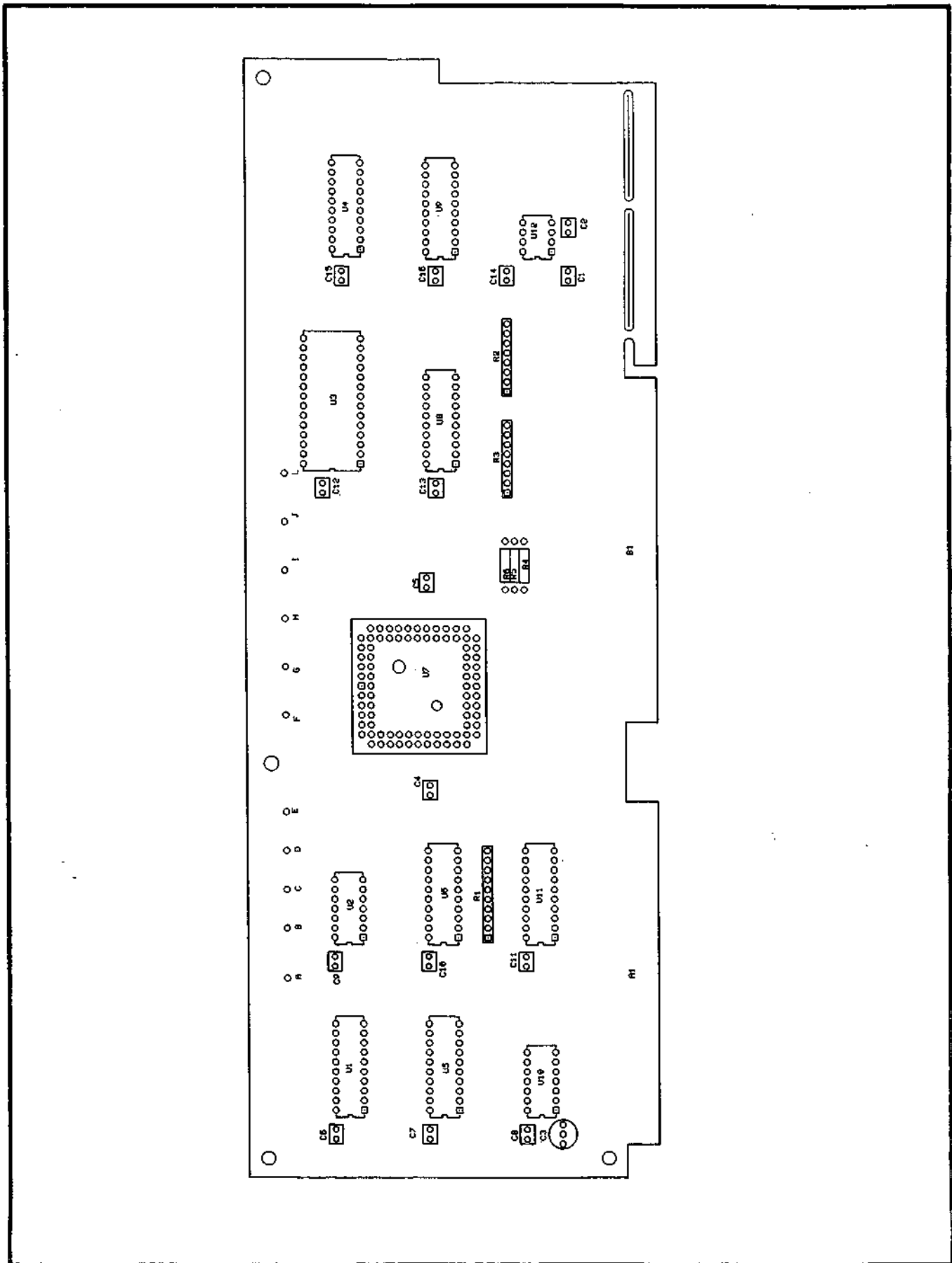


Figure 8-17. A13 Addr/Subscriber Assembly 8-61



Part of Figure 8-18. A14 Qualifier Assembly
(05345-60144, Series 3103A)

NOTES

1. REFERENCE DESIGNATIONS WITHIN THIS ASSEMBLY ARE ABBREVIATED. ADD ASSEMBLY NUMBER TO ABBREVIATION FOR COMPLETE DESCRIPTION.
2. UNLESS OTHERWISE INDICATED:
RESISTANCE IN OHMS;
CAPACITANCE IN PICOFARADS;
INDUCTANCE IN MICROHENRIES

REFERENCE DESIGNATIONS

A14
C1-3
P1
R1,2
S1
U1-38

SERVICE NOTES

The A14 assembly has seven servicing switches (S1-1-7), some of which are related to the plug-in. These switches perform the following actions when selected.

S1-1 (Closest to the display) displays time scaler measurement contents.

S1-2 Displays the complete arithmetic result in Giga or Nano units.

S1-4 Has the effect of nullifying the N DATA request from the plug-in. Useful for observing S1-2 arithmetic result without an N.

S1-5 Has the effect of nullifying the K DATA request from the plug-in. Useful for observing S1-2 arithmetic result without a K.

S1-6 Activates PI DATA without regard to plug-in status. Useful for a special servicing routine where a plug-in could display its internal data.

S1-7 Forces an INITIALIZE PROCESSOR qualifier. Would prevent a display cycle during a START, STOP, or PI DATA routine. Useful for viewing the processing cycle's behavior with an oscilloscope. The display cycle lasts a minimum of 50 msec making the cycle time of the processing cycle once every ~53 msec. The cycle time with S1-7 is about once every 3 msec.

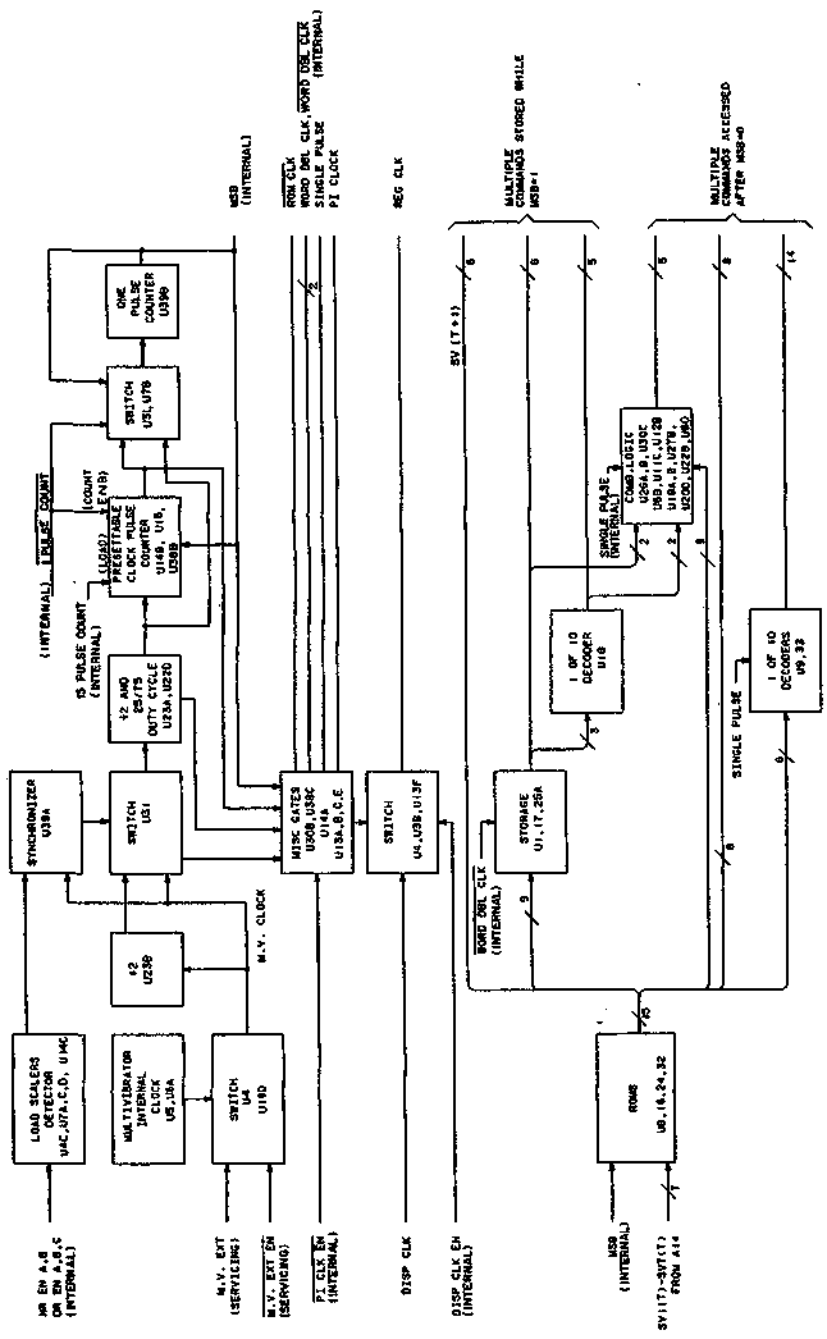
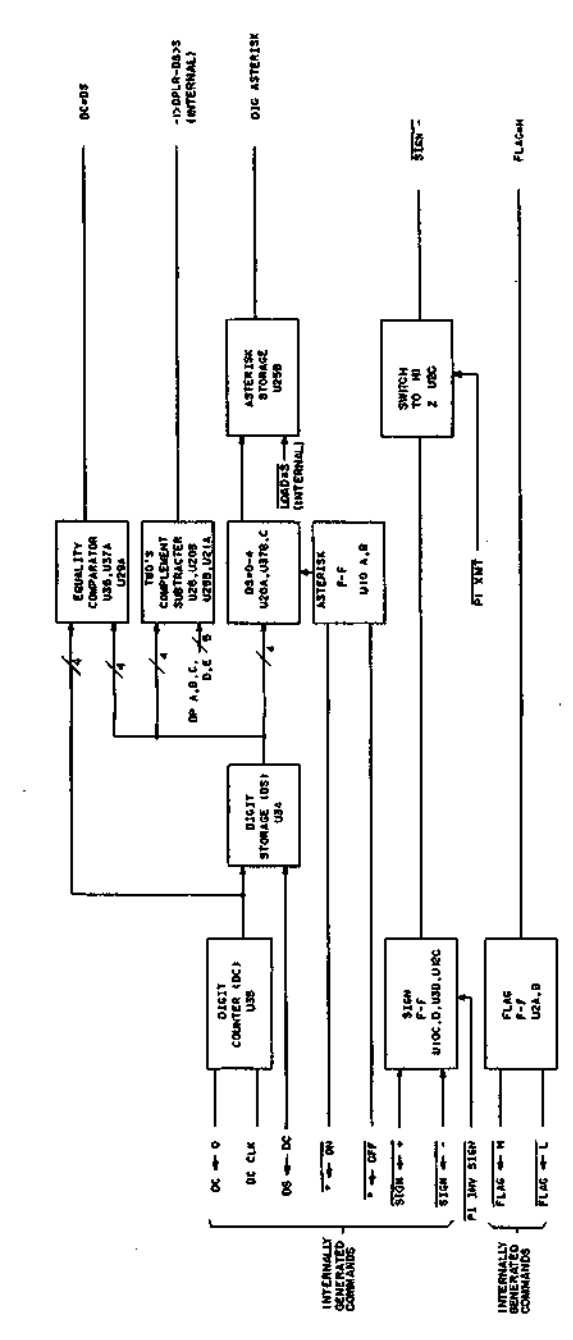
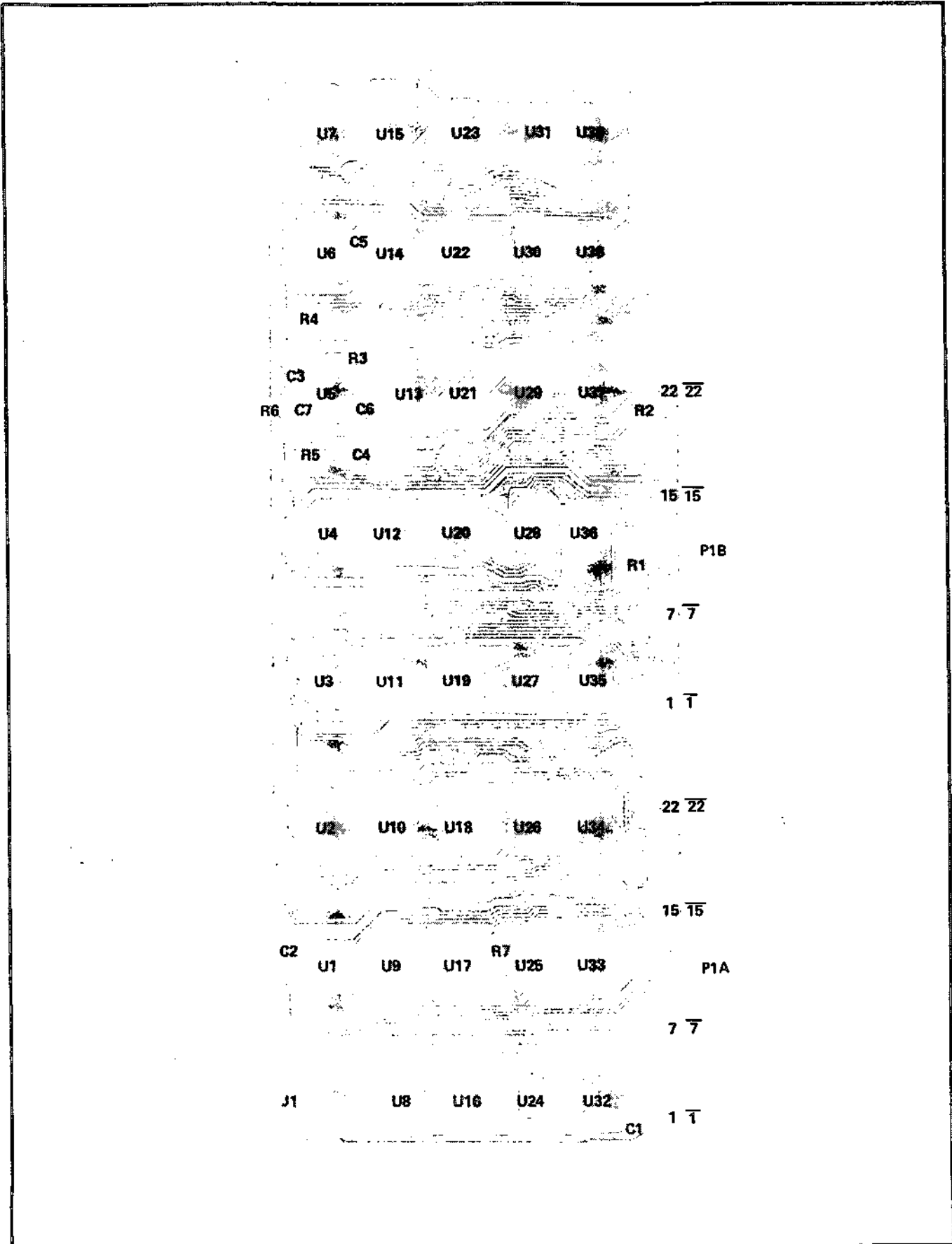


FIGURE 8-18
A14 QUALIFIER ASSEMBLY
(See page 8-53)





Part of Figure 8-19. A15 ROM Assembly

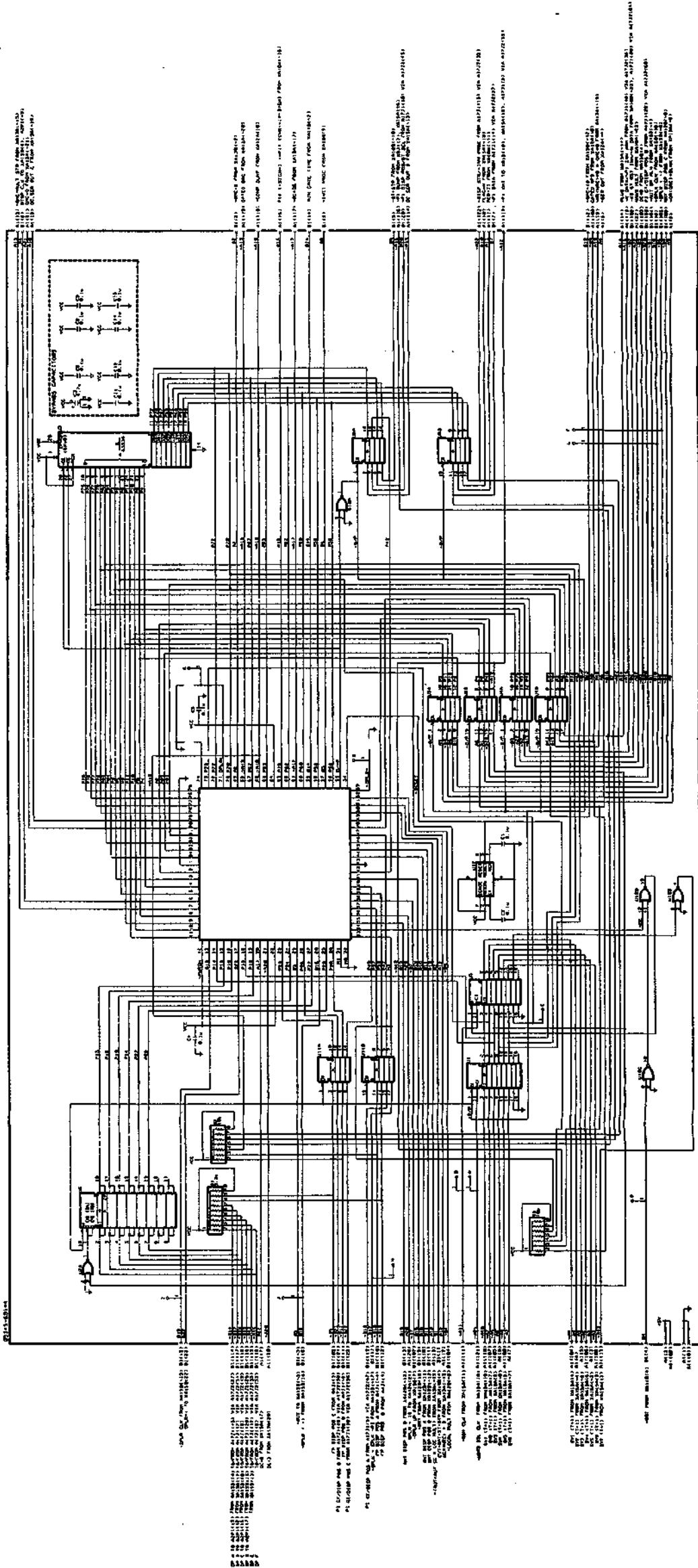


Figure 6-18. A14 Qualifier Assembly
6-63

Figure 8-19
A15 ROM ASSEMBLY

(See page 8-55)

1P 8304A
Schematic Diagram

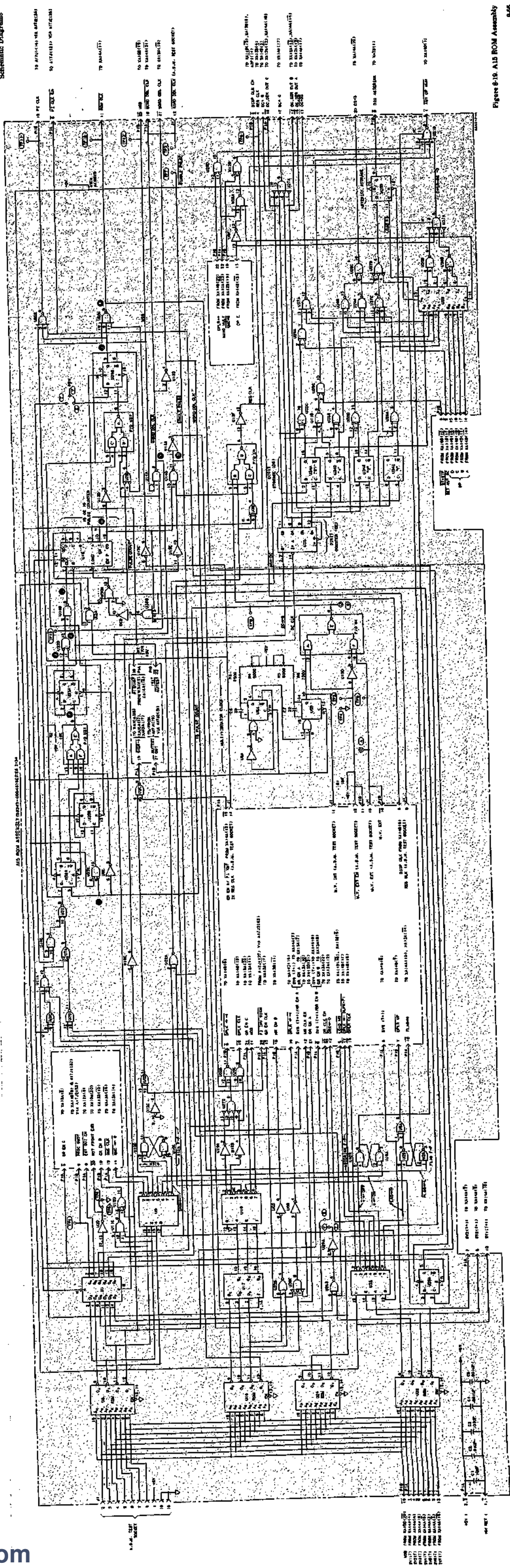
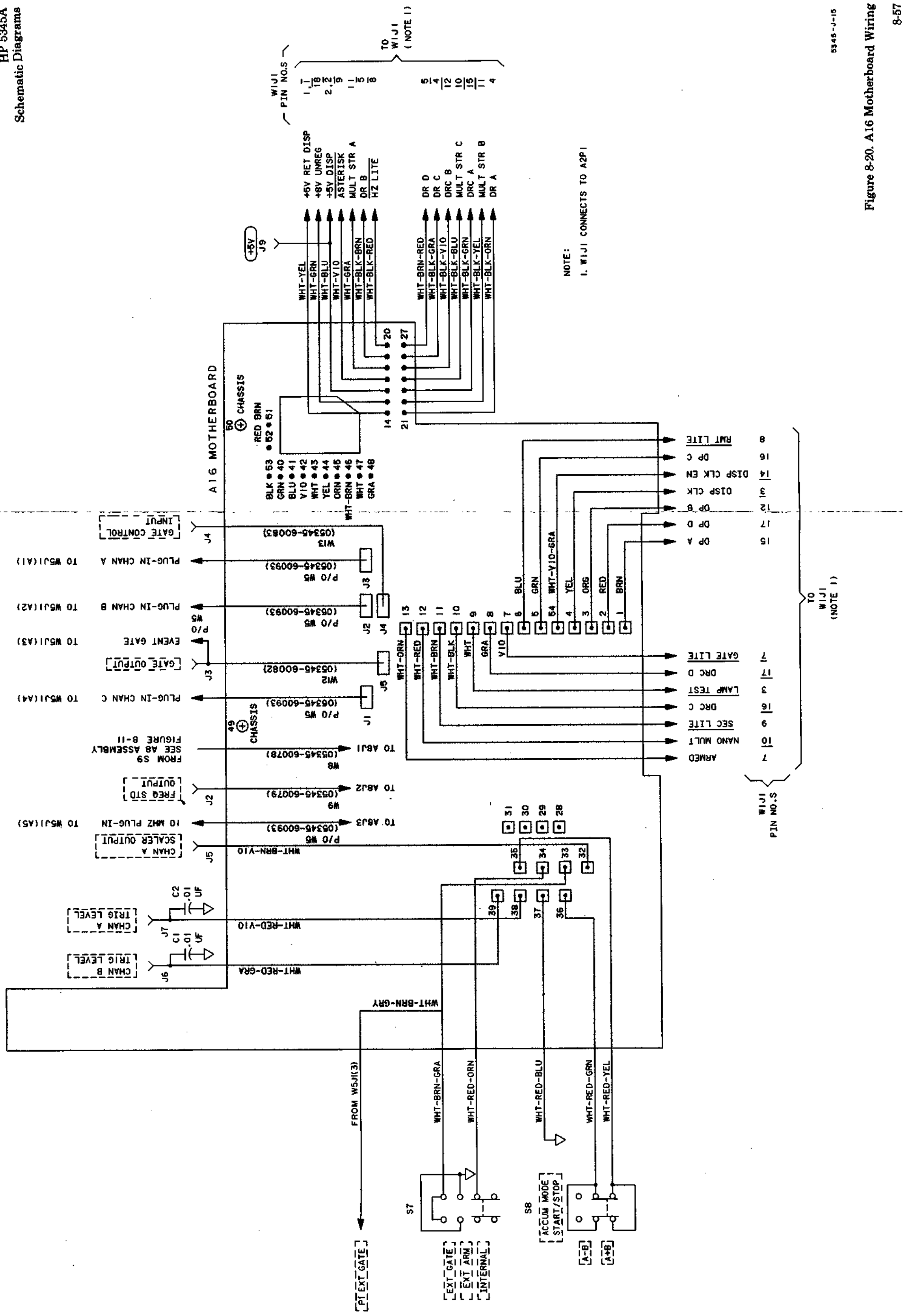


Figure 8-18. A13 ROM Assembly

Figure 8-20
A16 MOTHERBOARD WIRING

(See page 8-57)



NOTE:
1. W1J1 CONNECTS TO A2P1

Figure 8-20. A16 Motherboard Wiring

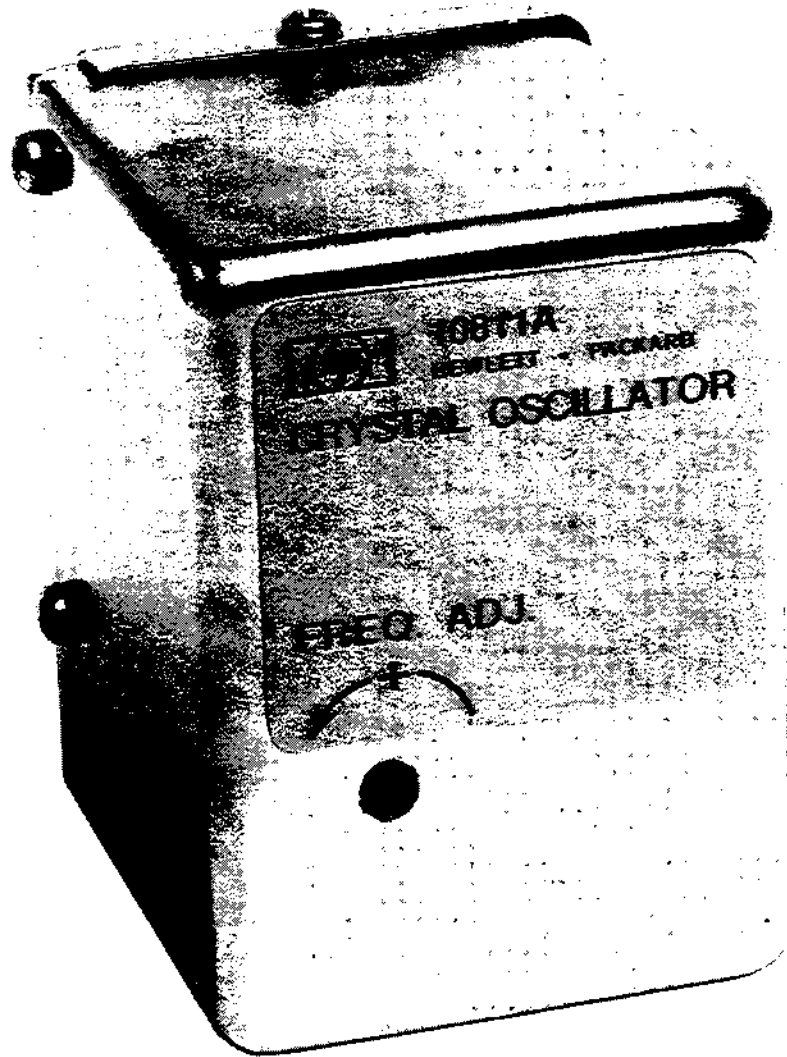
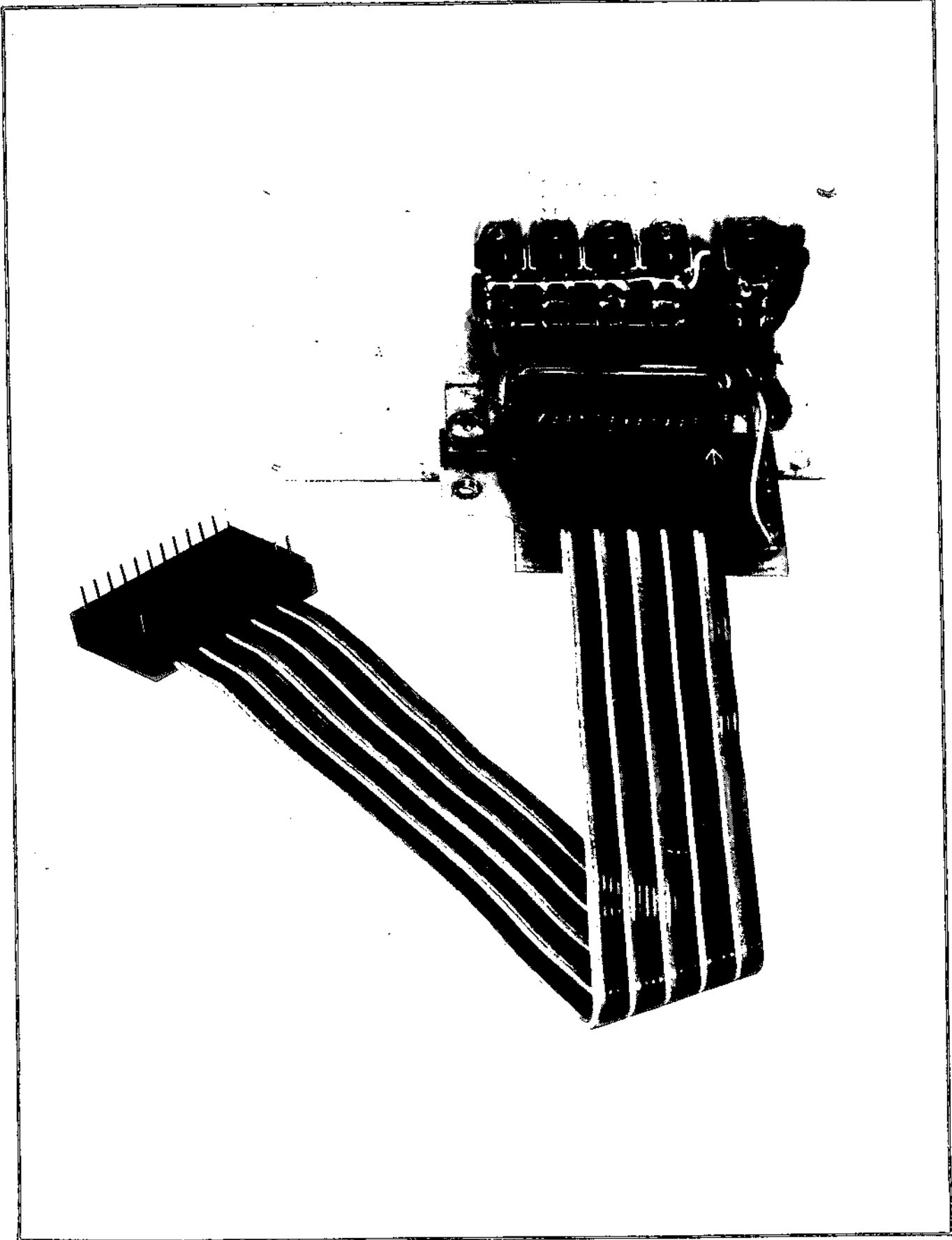


Figure 8-21. A18 10 MHz Oscillator (Oven) Assembly — Standard

Figure 8-22
A19 OPTION 011 INTERFACE PANEL ASSEMBLY

(See page 8-61)



A19 OPTIONS 011 AND 012 INTERFACE ASSEMBLY
(OPTION 011, 05345-60019)
(OPTION 012, 05345-60022) NOTE 1



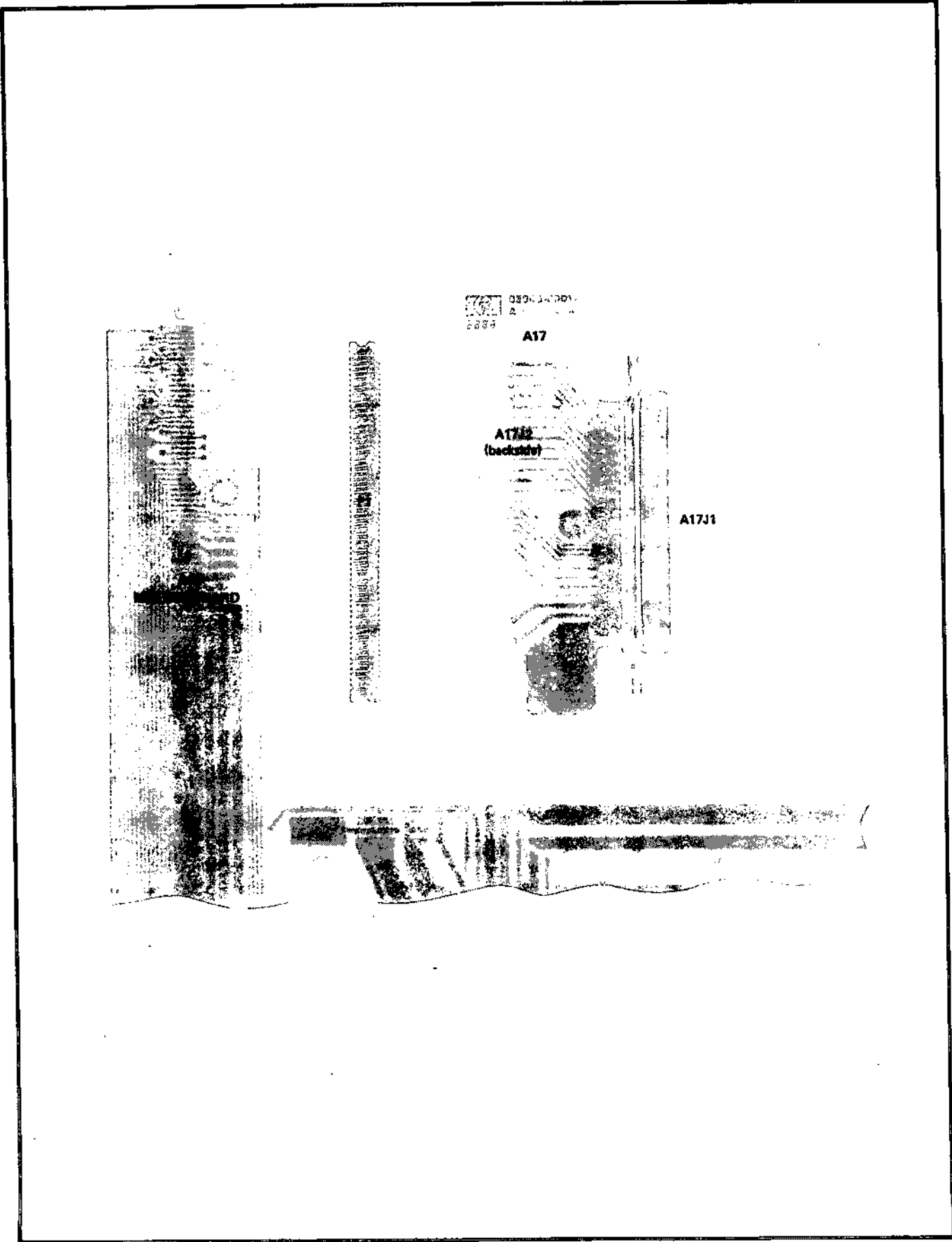
NOTES

1. REFERENCE DESIGNATIONS WITHIN THIS ASSEMBLY ARE ABBREVIATED. ADD ASSEMBLY NUMBER TO ABBREVIATION FOR COMPLETE DESCRIPTION.

Figure 8-22. A19 Option 011 Interface Panel Assembly
8-61

Figure 8-23
WIRING: POWER TRANSFORMER, A17J1 AND W5J1

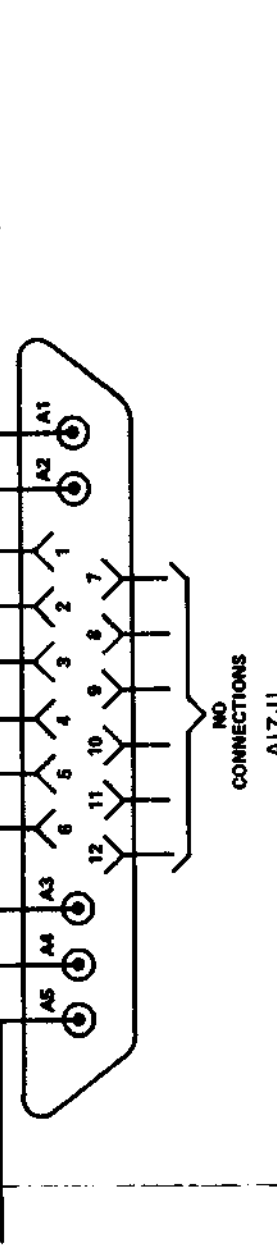
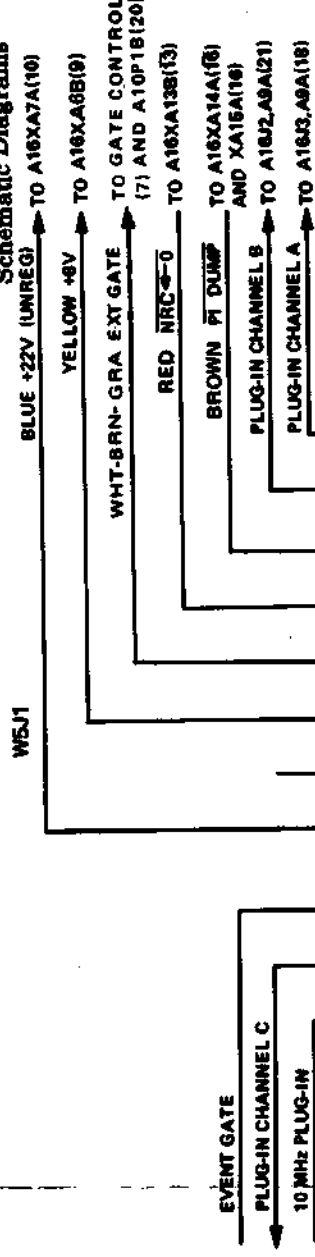
(See page 8-63)



020014001
A
2000
A17

A17J2
(backside)

A17J1



LINE NAME	A17J1 PIN #	A16J6 PIN #	FROM	TO
ARMED	13	39	A16(13), A108(7)	
DR A	1	63	A16(21), A13A(7)	A108(22), A14A(22)
DR B	4	57	A16(18), A13A(5)	A148(14), A158(14), A16(1), A2P1(15)
DR C	2	61	A16(26), A13A(6)	A148(17), A158(17), A16(3), A2P1(12)
DR D	3	59	A16(27), A13A(6)	A148(18), A158(18), A16(5), A2P1(16)
DISP STR/INH PROC	15	35		A148(15), A158(15), A16(2), A2P1(17)
DP A	43	27		TO A158(13), TO/FROM A148(13)
DP B	7	51		A118(20), A14A(15)
DP C	8	49		A118(18)
DP D	20	29		A108(11)
DP E	17	33		A108(9)
DP F	6	53		A108(8)
K DATA/PI INH ARM	42	36		A118(5), A148(15)
MEAS TIME	41	30		A118(6), A148(16)
PI ARM	16	34		A118(9), A148(20)
PI CLK	21	26		A108(11)
PI CLK EN	14	37		A108(9)
PI DATA	10	45		A118(5), A148(15)
PI DISP POS/GT SEL	46	44		A118(6), A148(16)
PI FUNC A	11	43		A118(9), A148(20)
PI FUNC B	12	41		A108(8)
PI GT/DISP POS A	9	47		A118(5), A148(15)
PI GT/DISP POS B	28	50		A118(6), A148(16)
PI GT/DISP POS C	30	60		A118(9), A148(20)
PI GT/DISP POS D	29	58		A118(11), A148(21)
PI INH ANUN	35	46		A10A(4)
PI INV SIGN	62	42		A158(20)
PI RST	34	48		A118(20)
PI SEL	38	38		A108(6)
PROC BUSY	32	62		
OR EN A/PI XMT	5	55		
RMT	31	54		
RST	38	40		
SEL A/B	18	32		
SEL C	33	50		
SIGN	19	31		
TRANS MULT	37	42		
XS GT RST INH/N DATA	26	64		
+5V REG	23	10,11		
+5V RET	24,25	1-5		
+15V REG	50	6,7		
+15V RET	49	6,9		
-5.2V REG	47	16,17,18		
-5.2V RET	46	19,20,21		
-15V REG	48	12,13		
-15V RET	22	14,15		
+20V REG	45	22,23		
+20V RET	44	24,25		

FROM A16A5, A108(2) TO A16J1, A88(8) FROM A8J2

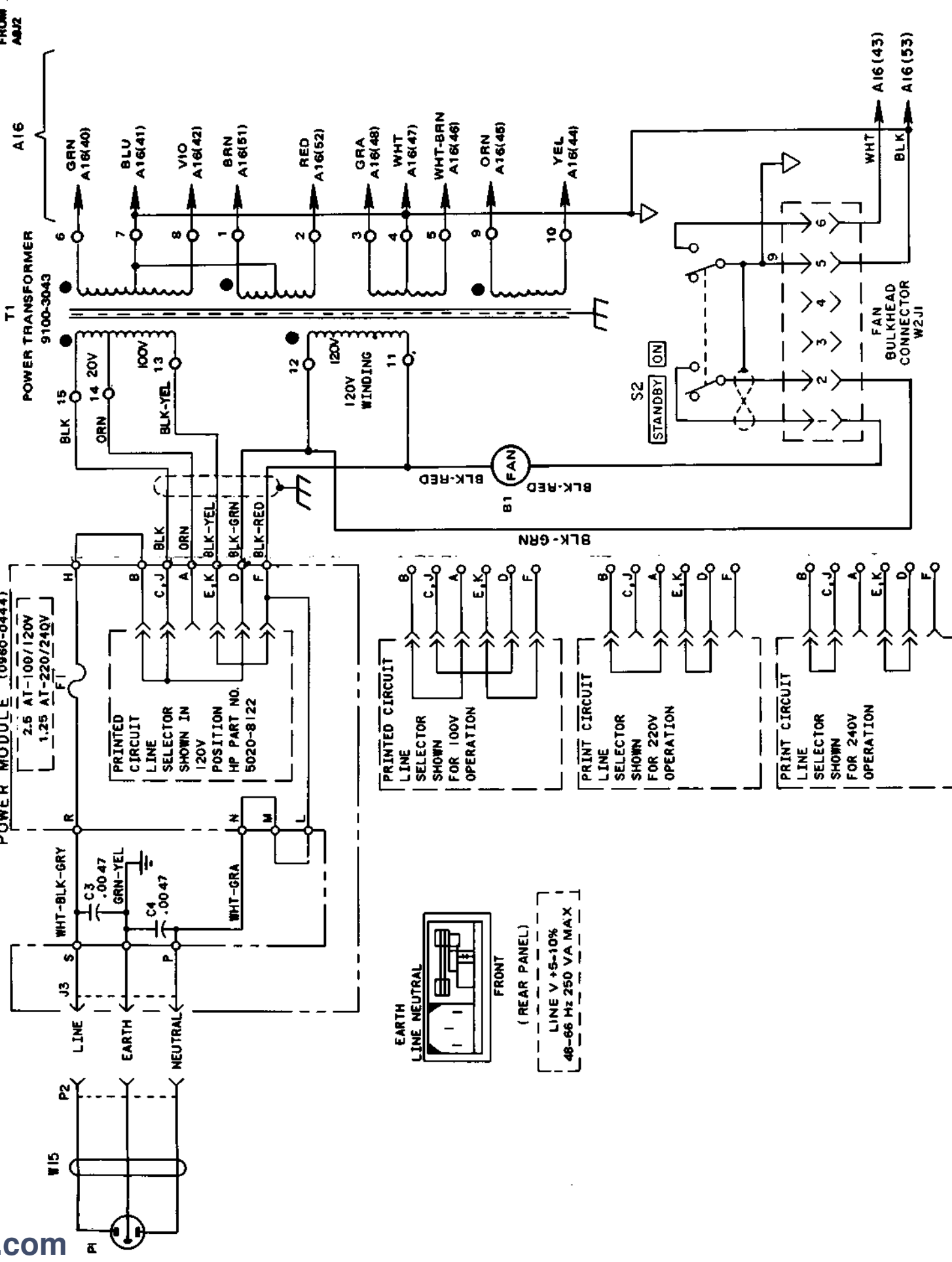


Figure 8-23. Wiring: Power Transformer, A17J1 and W5J1